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M16C/29 Group

Hardware Manual
RENESAS MCU
M16C FAMILY / M16C/Tiny SERIES

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General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

 The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

 The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

— When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.

— The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.

How to Use This Manual

1. Purpose and Target Readers

This manual is designed to provide the user with an understanding of the hardware functions and electrical characteristics of the MCU. It is intended for users designing application systems incorporating the MCU. A basic knowledge of electric circuits, logical circuits, and MCUs is necessary in order to use this manual.

The manual comprises an overview of the product; descriptions of the CPU, system control functions, peripheral functions, and electrical characteristics; and usage notes.

Particular attention should be paid to the precautionary notes when using the manual. These notes occur within the body of the text, at the end of each section, and in the Usage Notes section.

The revision history summarizes the locations of revisions and additions. It does not list all revisions. Refer to the text of the manual for details.

The following documents apply to the M16C/29 Group. Make sure to refer to the latest versions of these documents. The newest versions of the documents listed may be obtained from the Renesas Technology Web site.

			1
Document Type	Description	Document Title	Document No.
Hardware manual	Hardware specifications (pin assignments,	M16C/29 Group	This hardware
	memory maps, peripheral function	Hardware Manual	manual
	specifications, electrical characteristics, timing		
	charts) and operation description		
	Note: Refer to the application notes for details on		
	using peripheral functions.		
Software manual	Description of CPU instruction set	M16C/60,	REJ09B0137
		M16C/20,	
		M16C/Tiny Series	
		Software Manual	
Application note	Information on using peripheral functions and	Available from Ren	esas
	application examples	Technology Web si	te.
	Sample programs		
	Information on writing programs in assembly		
	language and C		
Renesas	Product specifications, updates on documents,		
technical update	etc.		

2. Notation of Numbers and Symbols

The notation conventions for register names, bit names, numbers, and symbols used in this manual are described below.

(1) Register Names, Bit Names, and Pin Names

Registers, bits, and pins are referred to in the text by symbols. The symbol is accompanied by the word "register," "bit," or "pin" to distinguish the three categories.

Examples the PM03 bit in the PM0 register

P3_5 pin, VCC pin

(2) Notation of Numbers

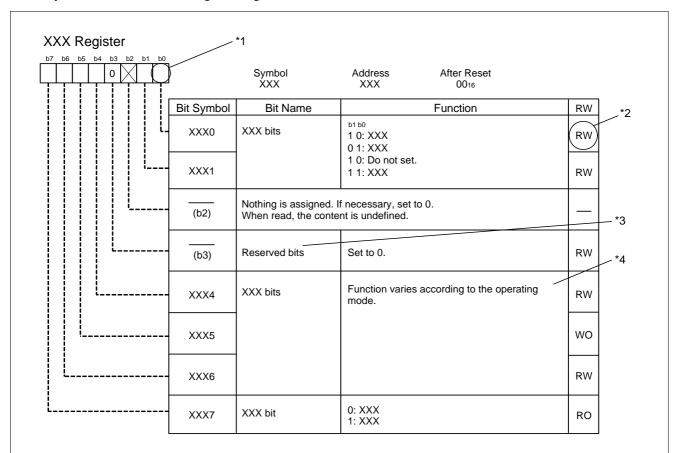
The indication "2" is appended to numeric values given in binary format. However, nothing is appended to the values of single bits. The indication "16" is appended to numeric values given in hexadecimal format. Nothing is appended to numeric values given in decimal format.

Examples Binary: 112

Hexadecimal: EFA0₁₆ Decimal: 1234

3. Register Notation

The symbols and terms used in register diagrams are described below.



*1

Blank: Set to 0 or 1 according to the application.

0: Set to 0.

1: Set to 1.

X: Nothing is assigned.

*2

RW: Read and write.

RO: Read only.

WO: Write only.

-: Nothing is assigned.

*3

• Reserved bit

Reserved bit. Set to specified value.

*4

• Nothing is assigned

Nothing is assigned to the bit. As the bit may be used for future functions, if necessary, set to 0.

• Do not set to a value

Operation is not guaranteed when a value is set.

• Function varies according to the operating mode.

The function of the bit varies with the peripheral function mode. Refer to the register diagram for information on the individual modes.

4. List of Abbreviations and Acronyms

Abbreviation	Full Form
ACIA	Asynchronous Communication Interface Adapter
bps	bits per second
CRC	Cyclic Redundancy Check
DMA	Direct Memory Access
DMAC	Direct Memory Access Controller
GSM	Global System for Mobile Communications
Hi-Z	High Impedance
IEBus	Inter Equipment bus
I/O	Input/Output
IrDA	Infrared Data Association
LSB	Least Significant Bit
MSB	Most Significant Bit
NC	Non-Connection
PLL	Phase Locked Loop
PWM	Pulse Width Modulation
SFR	Special Function Registers
SIM	Subscriber Identity Module
UART	Universal Asynchronous Receiver/Transmitter
VCO	Voltage Controlled Oscillator

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Note 1: The blank areas are reserved and cannot be accessed by users. Note 2: This register is included in the flash memory version.

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03AC16 03AD16 03AE16 03AF16 03B16 03B16 03B216 03B316 03B316 03B316 03B316 03B316 03B316 03B316	UART1 transmit/receive control register 0 UART1 transmit/receive control register 1 UART1 receive buffer register UART transmit/receive control register 2 CRC snoop address register CRC mode register DMA0 request cause select register	U1C1 U1RB UCON CRCSAR CRCMR DM0SL	177 174 176 314 314 93
03AC16 03AD18 03AE16 03AF16 03B016 03B116 03B216 03B316 03B316 03B516 03B516 03B716 03B816 03B816 03B816 03B816	UART1 transmit/receive control register 0 UART1 transmit/receive control register 1 UART1 receive buffer register UART transmit/receive control register 2 CRC snoop address register CRC mode register DMA0 request cause select register	U1C1 U1RB UCON CRCSAR CRCMR DM0SL	177 174 176 314 314 93
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03D3 ₁₆ 03D4 ₁₆	A/D convert status register 0 A/D control register 2	ADSTAT0 ADCON2	226 224
03D416 03D516	A D COILLOI TEGISTEI 2	ADCONZ	<u> </u>
	A/D control register 0	ADCON0	224
	A/D control register 1	ADCON1	224
03D8 ₁₆	- Contract of the contract of		
03D9 ₁₆			
03DA ₁₆			
03DB ₁₆			
03DC ₁₆			
03DD ₁₆			
03DE ₁₆			
03DF ₁₆	D 100 11	D0	
1	Port P0 register	P0	324
1	Port P1 register Port P0 direction register	P1 PD0	324 323
1	Port P1 direction register	PD0 PD1	323
1	Port P2 register	P2	324
03E516	Port P3 register	P3	324
03E616	Port P2 direction register	PD2	323
03E7 ₁₆	Port P3 direction register	PD3	323
03E8 ₁₆	T OILT O GIROSHOTT TOGISTO	. 50	020
03E9 ₁₆			
03EA ₁₆			
03EB ₁₆			
03EC ₁₆	Port P6 register	P6	324
	Port P7 register	P7	324
03EE ₁₆	Port P6 direction register	PD6	323
03EF ₁₆	Port P7 direction register	PD7	323
03F0 ₁₆	Port P8 register	P8	324
03F1 ₁₆	Port P9 register	P9	324
03F2 ₁₆	Port P8 direction register	PD8	323
03F3 ₁₆	Port P9 direction register	PD9	323
03F4 ₁₆	Port P10 register	P10	324
03F516	Port P10 direction register	DD10	300
03F6 ₁₆	For Fire direction register	PD10	323
03F716 03F816			
03F9 ₁₆			
03FA ₁₆			
03FB ₁₆			
03FC ₁₆	Pull-up control register 0	PUR0	325
03FD ₁₆	Pull-up control register 1	PUR1	325
03FE ₁₆	Pull-up control register 2	PUR2	325
03FF ₁₆	Port control register	PCR	326



M16C/29 Group

SINGLE-CHIP 16-BIT CMOS MICROCOMPUTER

1. Overview

1.1 Features

The M16C/29 Group of single-chip control MCU incorporates the M16C/60 series CPU core, employing the high-performance silicon gate CMOS technology and sophisticated instructions for a high level of efficiency. The M16C/29 Group is housed in 64-pin and 80-pin plastic molded LQFP packages. These single-chip MCUs operate using sophisticated instructions featuring a high level of instruction efficiency. This MCU is capable of executing instructions at high speed and it has one CAN module, makes it suitable for control of cars and LAN system of FA. In addition, the CPU core boasts a multiplier and DMAC for high-speed processing to make adequate for office automation, communication devices, and other high-speed processing applications.

1.1.1 Applications

Automotive body, car audio, LAN system of FA, etc.

1.1.2 Specifications

Table 1.1 lists performance overview of M16C/29 Group 80-pin package.

Table 1.2 lists performance overview of M16C/29 Group 64-pin package.

Table 1.1 Performance Overview of M16C/29 Group (T-ver./V-ver.) (80-Pin Package)

	Item	Performance	
CPU	Number of basic instructions	91 instructions	
0.0	Shortest instruction	50 ns (f(BCLK) = 20MHz, Vcc = 3.0 to 5.5 V) (Normal-ver./T-ver.)	
	excution time	100 ns(f(BCLK) = 10MHz, Vcc = 2.7 to 5.5 V) (Normal-ver.)	
	excution time	50 ns (f(BCLK) = 20MHz, Vcc = 4.2 to 5.5 V, -40 to 105°C) (V-ver.)	
		62.5 ns (f(BCLK) = 16MHz, VCC = 4.2 to 5.5 V, -40 to 125°C) (V-ver.)	
	Operation mode	, , ,	
	Operation mode	Single chip mode	
	Address space	1 Mbyte	
D : 1 1	Memory capacity	ROM/RAM: See Tables 1.3 to 1.5	
Peripheral	Port	Input/Output: 71 lines	
Function	Multifunction timer	TimerA:16 bits x 5 channels, TimerB:16 bits x 3 channels	
		Three-phase Motor Control Timer	
		TimerS (Input Capture/Output Compare):	
		16 bit base timer x 1 channel (Input/Output x 8 channels)	
	Serial I/O	2 channels (UART, clock synchronous serial I/O)	
		1 channel (UART, clock synchronous serial I/O, I ² C bus, or IEbus ⁽¹⁾)	
		2 channels (Clock synchronous serial I/O)	
		1 channel (Multi- master I ² C bus)	
	A/D converter	10 bits x 27 channels	
	DMAC	2 channels	
	CRC calculation circuit	2 polynomial (CRC-CCITT and CRC-16) with MSB/LSB selectable	
	CAN module	1 channel, supporting CAN 2.0B specification	
	Watchdog timer	15 bits x 1 channel (with prescaler)	
	Interrupt	29 internal and 8 external sources, 4 software sources,	
		interrupt priority level: 7	
	Clock generation circuit	4 circuits	
		Main clock (These circuits contain a built-in feedback	
		• Sub-clock fresistor)	
		On-chip oscillator(main-clock oscillation stop detect function)	
		PLL frequency synthesizer	
	Oscillation stop detect Function	Main clock oscillation stop, re-oscillation detect function	
	Voltage detection circuit	Available (Normal-ver.) / Not available (T-ver., V-ver.)	
Electrical	Power supply voltage	Vcc = 3.0 to 5.5 V (f(BCLK) = 20 MHz) (Normal-ver.)	
Charact-		Vcc = 2.7 to 5.5 V (f(BCLK) = 10 MHz)	
eristics		Vcc = 3.0 to 5.5 V (T-ver.)	
		Vcc = 4.2 to 5.5 V (V-ver.)	
	Power consumption	18 mA (Vcc = 5 V, f(BCLK) = 20 MHz)	
		25 μA ($f(X_{CIN})$ = 32 kHz on RAM)	
		$3 \mu A (VCC = 5 V, f(X_{CIN}) = 32 kHz, in wait mode)$	
		0.8 μA (Vcc = 5 V, in stop mode)	
Flash	Program/erase supply voltage	2.7 to 5.5 V (Normal-ver.), 3.0 to 5.5 V (T-ver.), 4.2 to 5.5 V (V-ver.)	
memory	Program and erase endurance	100 times (all space) or 1,000 times (blocks 0 to 5)/	
		10,000 times (blocks A and B ⁽²⁾)	
Operating	ambient temperature	-20 to 85°C/-40 to 85°C ⁽²⁾ (Normal-ver.)	
operating ambient temperature		-40 to 85°C (T-ver.), -40 to 125°C (V-ver.)	
Package		80-pin plastic mold LQFP	
NOTES:			

NOTES:

- 1. IEBus is a trademark of NEC Electronics Corporation.
- 2. Refer to Table 1.6 to Table 1.8 Product code.

Table 1.2 Performance Overview of M16C/29 Group (64-Pin Package)

	Item	Performance		
CPU Number of basic instructions		91 instructions		
	Shortest instruction	50 ns (f(BCLK) = 20MHz, Vcc = 3.0 to 5.5 V) (Normal-ver./T-ver.)		
	excution time	100 ns(f(BCLK) = 10MHz, Vcc = 2.7 to 5.5 V) (Normal-ver.)		
	excution time	$50 \text{ ns} (f(BCLK) = 20MHz, VCC = 4.2 \text{ to } 5.5 \text{ V}, -40 \text{ to } 105^{\circ}\text{C})$ (V-ver.)		
		62.5 ns (f(BCLK) = 16MHz, Vcc = 4.2 to 5.5 V, -40 to 125°C) (V-ver.)		
	Operation mode	Single chip mode		
	Address space	1 Mbytes		
	Memory capacity	ROM/RAM: See Tables 1.3 to 1.5		
Periphera		Input/Output: 55 lines		
function	Multifunction timer	TimerA:16 bits x 5 channels, TimerB:16 bits x 3 channels		
lunction	Waltiful Clion time	Three-phase Motor Control Timer		
		TimerS (Input Capture/Output Compare):		
		16bit base timer x 1 channel (Input/Output x 8 channels)		
	Serial I/O	2 channels (UART, clock synchronous serial I/O)		
		1 channel (UART, clock synchronous serial I/O, I ² C bus, or IEbus ⁽¹⁾)		
		1 channel (Clock synchronous serial I/O)		
		1 channel (Multi-master I ² C bus)		
	A/D converter	10 bits x 16 channels		
	DMAC	2 channels		
	CRC calculation circuit	2 polynomial (CRC-CCITT and CRC-16) with MSB/LSB selectable		
	CAN module	1 channel, supporting CAN 2.0B specification		
	Watchdog timer	15 bits x 1 channel (with prescaler)		
	Interrupt	28 internal and 8 external sources, 4 software sources,		
		interrupt priority level: 7		
	Clock generation circuit	4 circuits		
		Main clock (These circuits contain a built-in feedback		
		• Sub-clock resistor)		
		On-chip oscillator(main-clock oscillation stop detect function)		
		PLL frequency synthesizer		
	Oscillation stop detect function	Main clock oscillation stop, re-oscillation detect function		
	Voltage detection circuit	Available (Normal-ver.) / Not available (T-ver., V-ver.)		
Electrical	Power supply voltage	Vcc = 3.0 to 5.5 V (f(BCLK) = 20 MHz) (Normal-ver.)		
Charact- eristics		Vcc = 2.7 to 5.5 V (f(BCLK) = 10 MHz) Vcc = 3.0 to 5.5 V (T-ver.)		
ensucs		Vcc = 4.2 to 5.5 V (V-ver.)		
	Power consumption	18 mA (Vcc = 5 V, f(BCLK) = 20 MHz)		
	l ower consumption	$25 \mu\text{A} (f(X_{CIN}) = 32 \text{kHz on RAM})$		
		$3 \mu A (VCC = 5 V, f(X_{CIN}) = 32 kHz, in wait mode)$		
		0.8 μA (Vcc = 5 V, in stop mode)		
Flash	Program/erase supply voltage	2.7 to 5.5 V (Normal-ver.), 3.0 to 5.5 V (T-ver.), 4.2 to 5.5 V (V-ver.)		
memory	Program and erase endurance	100 times (all space) or 1,000 times (blocks 0 to 5)/		
		10,000 times (blocks A and B ⁽²⁾)		
Operating	ambient temperature	-20 to 85°C/-40 to 85°C ⁽²⁾ (Normal-ver.)		
'		-40 to 85°C (T-ver.), -40 to 125°C (V-ver.)		
Package		64-pin plastic mold LQFP		
NOTEC				

NOTES:

- 1. IEBus is a trademark of NEC Electronics Corporation.
- 2. Refer to Table 1.6 to Table 1.8 Product code.

1.2 Block Diagram

Figure 1.1 is a block diagram of the M16C/29 Group, 80-pin package.

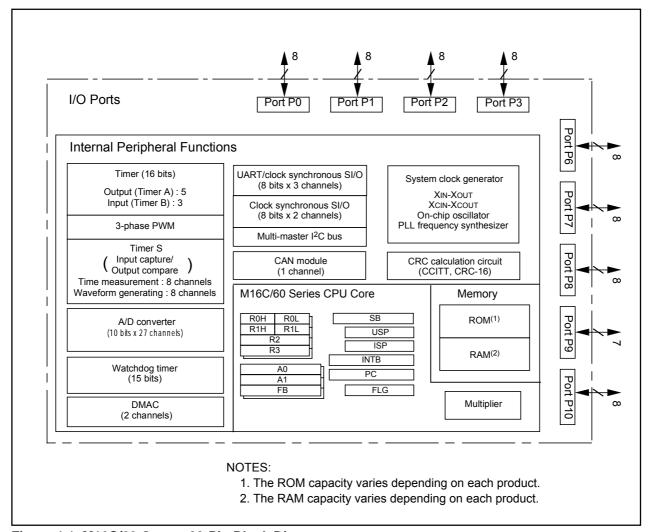


Figure 1.1 M16C/29 Group, 80-Pin Block Diagram

Figure 1.2 is a block diagram of the M16C/29 Group, 64-pin package.

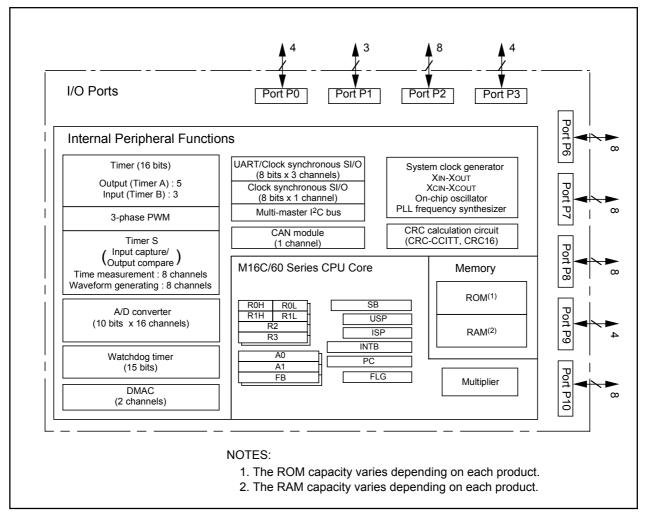


Figure 1.2 M16C/29 Group, 64-Pin Block Diagram

1.3 Product List

Tables 1.3 to 1.5 list the M16C/29 Group products and **Figure 1.3** shows the type numbers, memory sizes and packages. **Tables 1.6 to 1.8** list the product code of flash memory version for M16C/29 Group. **Figure 1.4 to Figure 1.6** show the marking diagram of flash memory version for M16C/29 Group.

Table 1.3 Product List (1) -Normal Version

As of March, 2007

Table 110 1 Teader Elect (1)		•••		, 10 O. III.	a. o, 2001
Type Number	ROM Capacity	RAM Capacity	Package Type	Remarks	Product Code
M30290FAHP	96 K + 4 K	8 K	PLQP0080KB-A (80P6Q-A)		U3, U5, U7, U9
M30290FCHP	128 K + 4 K	12 K	FLQF0000NB-A (00F0Q-A)	Flash	
M30291FAHP	96 K + 4 K	8 K	PLQP0064KB-A (64P6Q-A)	Memory	
M30291FCHP	128 K + 4 K	12 K	PLQP0004NB-A (04P0Q-A)		
M30290M8-XXXHP	64 K	4 K		Mask	112 115
M30290MA-XXXHP	96 K	8 K	PLQP0080KB-A (80P6Q-A)		
M30290MC-XXXHP	128 K	12 K			
M30291M8-XXXHP	64 K	4 K		ROM	U3, U5
M30291MA-XXXHP	96 K	8 K	PLQP0064KB-A (64P6Q-A)		
M30291MC-XXXHP	128 K	12 K			

Table 1.4 Product List (2) -T Version

As of March, 2007

Type Number	ROM Capacity	RAM Capacity	Package Type	Remarks	Product Code	
M30290FATHP	96 K + 4 K	8 K	PLQP0080KB-A (80P6Q-A)			
M30290FCTHP	128 K + 4 K	12 K	F EQF 0000ND-A (00F 0Q-A)	Flash	U3, U5,	
M30291FATHP	96 K + 4 K	8 K	PLQP0064KB-A (64P6Q-A)	Memory	U7, U9	
M30291FCTHP	128 K + 4 K	12 K	FLQF0004NB-A (04F0Q-A)			
M30290M8T-XXXHP	64 K	4 K				
M30290MAT-XXXHP	96 K	8 K	PLQP0080KB-A (80P6Q-A)	Mask	U0	
M30290MCT-XXXHP	128 K	12 K				
M30291M8T-XXXHP	64 K	4 K		ROM		
M30291MAT-XXXHP	96 K	8 K	PLQP0064KB-A (64P6Q-A)			
M30291MCT-XXXHP	128 K	12 K				

Table 1.5 Product List (3) -V Version

As of March, 2007

Type Number	ROM Capacity	RAM Capacity	Package Type	Remarks	Product Code	
M30290FAVHP	96 K + 4 K	8 K	PLQP0080KB-A (80P6Q-A)			
M30290FCVHP	128 K + 4 K	12 K	FLQF0000NB-A (00F0Q-A)	Flash	U3, U5,	
M30291FAVHP	96 K + 4 K	8 K	PLQP0064KB-A (64P6Q-A)	Memory	U7, U9	
M30291FCVHP	128 K + 4 K	12 K	PLQP0004NB-A (04P0Q-A)			
M30290M8V-XXXHP	64 K	4 K				
M30290MAV-XXXHP	96 K	8 K	PLQP0080KB-A (80P6Q-A)			
M30290MCV-XXXHP	128 K	12 K		Mask	UO	
M30291M8V-XXXHP	64 K	4 K		ROM		
M30291MAV-XXXHP	96 K	8 K	PLQP0064KB-A (64P6Q-A)			
M30291MCV-XXXHP	128 K	12 K				

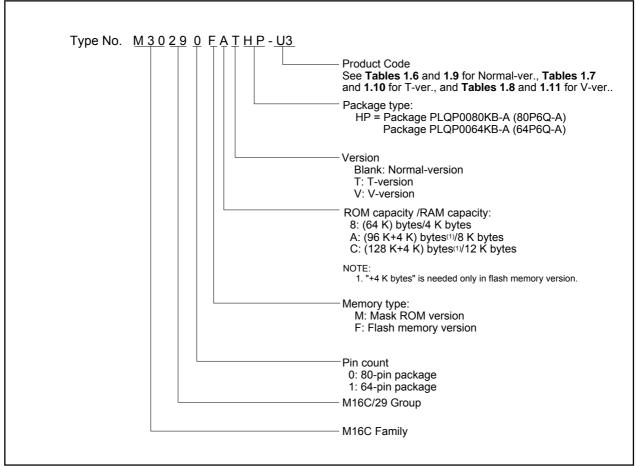


Figure 1.3 Type No., Memory Size, and Package

Table 1.6 Product Codes of Flash Memory Version -M16C/29 Group, Normal-ver.

			····, ····			
Product		(User Prog	Internal ROM ram Space: Blocks 0 to 5)		rnal ROM : Blocks A and B)	Operating Ambient
Code	Package	Program and Erase Endurance	Temperature Range	Program and Erase Endurance	Temperature Range	Temperature
U3		100		100	0 to 60℃	-40 to 85℃
U5	Lead-free	100	0 to 60℃	100	0 10 00 C	-20 to 85℃
U7		0 10 00 C	10,000	-40 to 85℃	-40 to 85℃	
U9	1,000			10,000	-20 to 85℃	-20 to 85℃

Table 1.7 Product Codes of Flash Memory Version -M16C/29 Group, T-ver.

Product		(User Prog	Internal ROM ram Space: Blocks 0 to 5)		rnal ROM :: Blocks A and B)	Operating Ambient
Code	Package Program and Erase Endurance	Temperature Range	Program and Erase Endurance	Temperature Range	Temperature	
U3	Lead-free	100	0 to 60℃	100	-40 to 85℃	-40 to 85℃
U7	1,000	0 to 00 C	10,000	-40 10 65 0	-40 to 65 C	

Table 1.8 Product Codes of Flash Memory Version -M16C/29 Group, V-ver.

	· · · · · · · · · · · · · · · · · · ·					
Product		(User Prog	Internal ROM ram Space: Blocks 0 to 5)		ernal ROM ce: Blocks A and B)	Operating
Code	Package	Program and Erase Endurance	Temperature Range	Program and Erase Endurance	Temperature Range	Ambient Temperature
U3	Lead-free	100	0 to 60°C	100	-40 to 125℃	-40 to 125℃
U7	Leau-liee	1,000	0 to 60 C	10,000	-40 to 125 C	-40 to 125 C

Table 1.9 Product Codes of Mask ROM Version -M16C/29 Group, Normal-ver.

Product Code	Package	Operating Ambient Temperature
U3	Lead-free	-40 to 85℃
U5	Leau-liee	-20 to 85℃

Table 1.10 Product Code of Mask ROM Version -M16C/29 Group, T-ver.

Product Code	Package	Operating Ambient Temperature
U0	Lead-free	-40 to 85℃

Table 1.11 Product Code of Mask ROM Version -M16C/29 Group, V-ver.

Product Code	Package	Operating Ambient Temperature
U0	Lead-free	-40 to 125℃

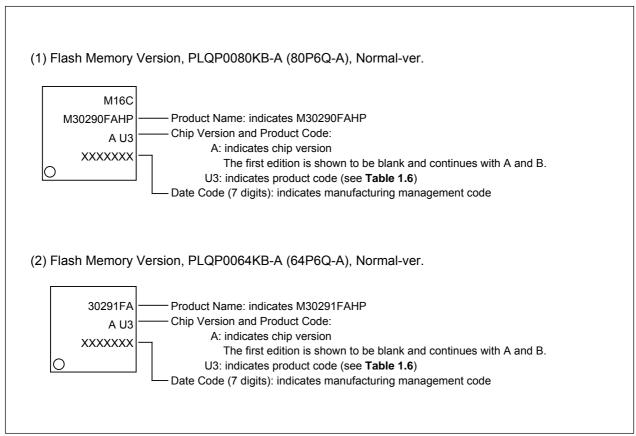


Figure 1.4 Marking Diagrams of Flash Memory Version - M16C/29 Group Normal-ver. (Top View)

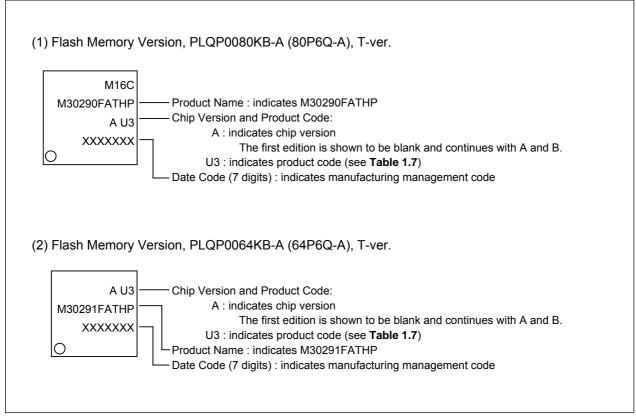


Figure 1.5 Marking Diagrams of Flash Memory Version - M16C/29 Group T-ver. (Top View)

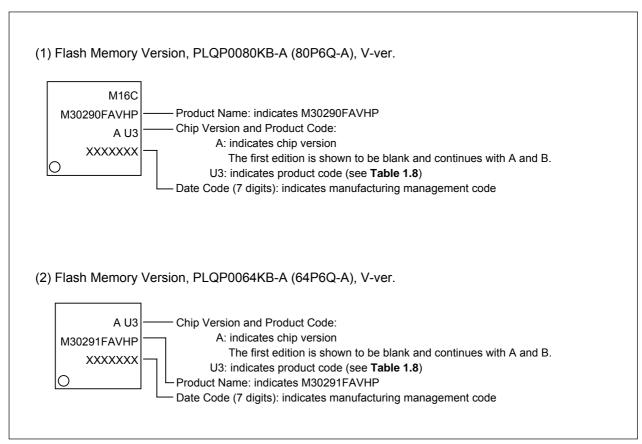


Figure 1.6 Marking Diagrams of Flash Memory Version - M16C/29 Group V-ver. (Top View)

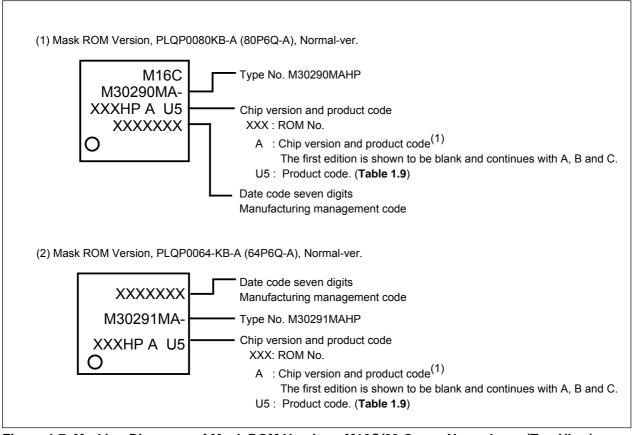


Figure 1.7 Marking Diagrams of Mask ROM Version - M16C/29 Group Normal-ver. (Top View)

1.4 Pin Assignments

Figures 1.7 and 1.8 show the pin assignments (top view).

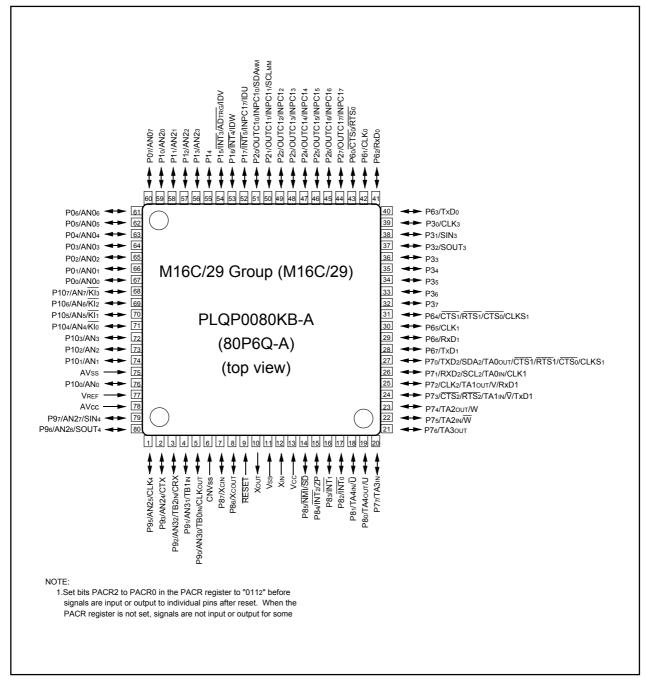


Figure 1.8 Pin Assignment (Top View) of 80-Pin Package

Table 1.12 Pin Characteristics for 80-Pin Package

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART/CAN Pin	Multi-master I ² C bus Pin	Analog Pin
1		P95				CLK4		AN25
2		P93				CTX		AN24
3		P92		TB2IN		CRX		AN32
4		P91		TB1IN				AN31
5	СЬКоит	P90		TBoin				AN30
6	CNVss							
7	XCIN	P87						
8	Хсоит	P86						
9	RESET							
10	Хоит							
11	Vss							
12	XIN							
13	Vcc							
14		P85	NMI	SD				
15		P84	ĪNT ₂	ZP				
16		P83	INT ₁					
17		P82	INT ₀					
18		P81		TA4IN / U				
19		P80		TA40UT / U				
20		P77		TA3IN				
21		P76		ТАзоит				
22		P75		TA2IN / W				
23		P74		TA2OUT / W				
24		P73		TA1IN / V		CTS2 / RTS2 / TxD1		
25		P72		TA10UT / V		CLK2 / RxD1		
26		P71		TAOIN		RxD2 / SCL2 / CLK1		
27		P70		ТАооит		TxD2 / SDA2 / RTS1 / CTS1 / CTS0 / CLKS1		
28		P67				TxD1		
29		P66				RxD1		
30		P65				CLK1		
31		P64				RTS1 / CTS1/ CTS0 / CLKS1		
32		P37						
33		P36						
34		P35						
35		P34						
36		P33						
37		P32				Sout3		
38		P31				SIN3		
39		P30				CLK3		
40		P63				TxD0		

Table 1.12 Pin Characteristics for 80-Pin Package (continued)

Pin No.	Control Pin	Port	Interrupt Pin		Timer S Pin	UART/CAN Pin	Multi-master I ² C bus Pin	Analog Pin
41		P62				RxD0		
42		P61				CLK ₀		
43		P60				RTS0 / CTS0		
44		P27			OUTC17 / INPC17			
45		P26			OUTC16 / INPC16			
46		P25			OUTC15 / INPC15			
47		P24			OUTC14 / INPC14			
48		P23			OUTC13 / INPC13			
49		P22			OUTC12 / INPC12			
50		P21			OUTC11 / INPC11		SCLMM	
51		P20			OUTC10 / INPC10		SDAMM	
52		P17	ĪNT5	IDU	INPC17			
53		P16	ĪNT4	IDW				
54		P15	ĪNT3	IDV				ADTRG
55		P14						
56		P13						AN23
57		P12						AN22
58		P11						AN21
59		P10						AN20
60		P07						AN07
61		P06						AN06
62		P05						AN05
63		P04						AN04
64		P03						AN03
65		P02						AN02
66		P01						AN01
67		P00						AN00
68		P107	KI3					AN7
69			Kl ₂					AN6
70		P105	KI ₁					AN ₅
71		P104	KI ₀					AN4
72		P103						AN3
73		P102						AN ₂
74		P101						AN1
75	AVss							
76		P10 ₀						AN ₀
77	VREF							
	AVcc							
79		P97				SIN4		AN27
80		P96				SOUT4		AN26

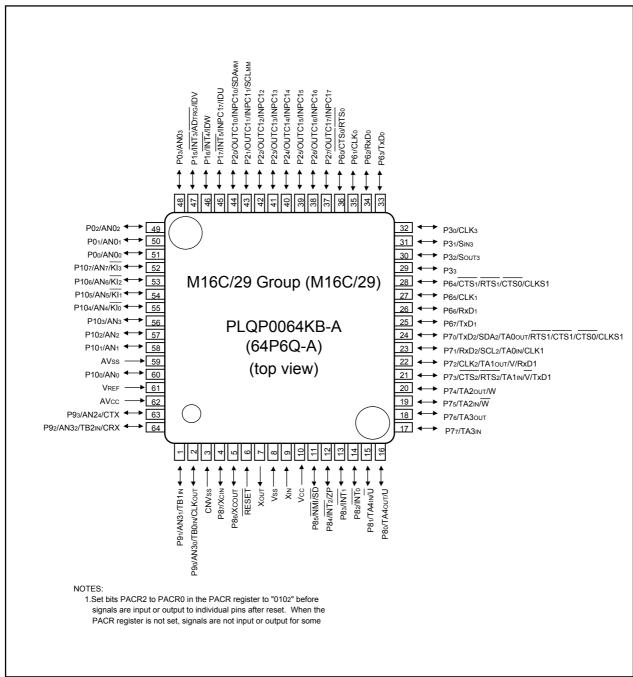


Figure 1.9 Pin Assignment (Top View) of 64-Pin Package

Table 1.13 Pin Characteristics for 64-Pin Package

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART/CAN Pin	Mult-master I ² C bus Pin	Analog Pin
1		P91		TB1IN				AN31
2	CLKout	P90		TBoin				AN30
3	CNVss							
4	XCIN	P87						
5	Хсоит	P86						
6	RESET							
7	Хоит							
8	Vss							
9	XIN							
10	Vcc							
11		P85	NMI	SD				
12		P84	ĪNT2	ZP				
13		P83	ĪNT1					
14		P82	ĪNT ₀					
15		P81		TA4IN / Ū				
16		P80		TA40UT / U				
17		P 7 7		TA3IN				
18		P76		ТАзоит				
19		P75		TA2IN / W				
20		P74		TA2OUT / W				
21		P73		TA1IN / \overline{V}		CTS2 / RTS2 / TxD1		
22		P72		TA10UT / V		CLK2 / RxD1		
23		P71		TAOIN		RxD2 / SCL2 / CLK1		
24		P70		ТАооит		TxD2 / SDA2 / RTS1 / CTS1 / CTS0 / CLKS1		
25		P67				TxD1		
26		P66				RxD1		
27		P65				CLK1		
28		P64				RTS1 / CTS1/ CTS0 / CLKS1		
29		P33						
30		P32				Sоит3		
31		P31				SIN3		
32		P30				CLK3		
33		P63				TxD0		
34		P62				RxD0		
35		P61				CLK0		
36		P60				RTS0 / CTS0		
37		P27			OUTC17 / INPC17			
38		P26			OUTC16 / INPC16			
39		P25			OUTC15 / INPC15			
40		P24			OUTC14 / INPC14			

Table 1.13 Pin Characteristics for 64-Pin Package (continued)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART/CAN Pin	Multi-master I ² C bus Pin	Analog Pin
41		P23			OUTC13 / INPC13			
42		P22			OUTC12 / INPC12			
43		P21			OUTC11 / INPC11		SCLMM	
44		P20			OUTC10 / INPC10		SDAMM	
45		P17	ĪNT5	IDU	INPC17			
46		P16	ĪNT4	IDW				
47		P15	ĪNT3	IDV				ADTRG
48		P03						AN03
49		P02						AN02
50		P01						AN01
51		P00						AN0 ₀
52		P107	KI3					AN7
53		P106	Kl ₂					AN6
54		P105	KI ₁					AN ₅
55		P104	KI ₀					AN4
56		P103						AN ₃
57		P102						AN ₂
58		P101						AN1
59	AVss							
60		P100						AN ₀
61	VREF							
62	AVcc							
63		P93				СТХ		AN24
64		P92		TB2IN		CRX		AN32

1. Overview M16C/29 Group

1.5 Pin Description

Classification	Symbol	I/O Type	n and 80-pin packages) Function
Power supply	Vcc, Vss	I ,	Apply 0V to the Vss pin. Apply following voltage to the Vcc pin.
			2.7 to 5.5 V (Normal), 3.0 to 5.5 V (T-ver.), 4.2 to 5.5 V (V-ver.)
Analog power	AVcc	I	Supplies power to the A/D converter. Connect the AVcc pin to Vcc and
supply	AVss		the AVss pin to Vss
Reset input	RESET	ı	The microcomputer is in a reset state when "L" is applied to the RESET pin
CNVss	CNVss	I	Connect the CNVss pin to Vss
Main clock	XIN	ı	I/O pins for the main clock oscillation circuit. Connect a ceramic resonator
input	AIN	.	or crystal oscillator between Xin and Xou⊤. To apply external clock, apply
Main clock			it to XIN and leave XOUT open. If XIN is not used (for external oscillator or
output	Xout	0	external clock) connect XIN pin to VCC and leave XOUT open
Sub clock input	XCIN	ı	I/O pins for the sub clock oscillation circuit. Connect a crystal oscillator
Sub clock output	XCOUT	0	between XCIN and XCOUT
Clock output	CLKout	0	Outputs the clock having the same frequency as f1, f8, f32, or fc
INT interrupt	INTO to INT5	1	Input pins for the INT interrupt. INT2 can be used for Timer A Z-phase
input	11410 10 11413	•	function
NMI interrupt	NMI	ı	Input pin for the NMI interrupt. NMI cannot be used as I/O port while the three-
-	INIVII		phase motor control is enabled. Apply a stable "H" to NMI after setting it's
input			direction register to "0" when the three-phase motor control is enabled
Kov input interrupt	Klo to Kl3	l	Input pins for the key input interrupt
Key input interrupt		-	
Timer A	TA0out to	I/O	I/O pins for the timer A0 to A4
	TA40UT		Institution for the times AO to AA
	TA0IN to	Į.	Input pins for the timer A0 to A4
	TA4IN		Leader Control of the
	ZP	l	Input pin for Z-phase
Timer B	TB0IN to TB2IN	I	Input pins for the timer B0 to B2
Three-phase	$U, \overline{U}, V, \overline{V},$	0	Output pins for the three-phase motor control timer
motor control	W, W		
timer output	IDU, IDW, IDV, SD	I/O	Input and output pins for the three-phase motor control timer
Serial I/O	CTS0 to CTS2	I	Input pins for data transmission control
	RTS0 to RTS2	0	Output pins for data reception control
	CLK0 to CLK3	I/O	Inputs and outputs the transfer clock
	RxD0 to RxD2	I	Inputs serial data
	SIN3	I	Inputs serial data
	TxD0 to TxD2	0	Outputs serial data
	Sout3	0	Outputs serial data
	CLKS1	0	Output pin for transfer clock
I ² C bus Mode	SDA2	I/O	Inputs and outputs serial data
	SCL2		Inputs and outputs the transfer clock
Multi-master	SDAMM	I/O	Inputs and outputs serial data
I ² C bus	SCLMM		Inputs and outputs the transfer clock
Reference	VREF	I	Applies reference voltage to the A/D converter
voltage input			
A/D converter	AN0 to AN7 AN00 to AN03 AN24	I	Analog input pins for the A/D converter
	AN30 to AN32		
	100 10 / 11102	I	

I: Input O: Output I/O: Input and output

Table 1.14 Pin Description (64-pin and 80-pin packages) (Continued)

Classification	Symbol	I/O Type	Function
Timer S	INPC10 to INPC17	I	Input pins for the time measurement function
	OUTC10 to OUTC17	0	Output pins for the waveform generating function
CAN	CRX	I	Input pin for the CAN communication function
	CTX	0	Output pin for the CAN communication function
I/O Ports	P00 to P03	I/O	CMOS I/O ports which have a direction register determines an individual
	P15 to P17		pin is used as an input port or an output port. A pull-up resistor is select-
	P20 to P27		able for every 4 input ports.
	P30 to P33		
	P60 to P67		
	P70 to P77		
	P80 to P87		
	P90 to P93		
	P100 to P107		

I: Input O: Output I/O: Input and output

Table 1.14 Pin Description (80-pin packages only) (Continued)

Classification	Symbol	I/O Type	Function
Serial I/O	CLK4	I/O	Inputs and outputs the transfer clock
	SIN4	I	Inputs serial data
	SOUT4	0	Outputs serial data
A/D Converter	AN04 to AN07	I	Analog input pins for the A/D converter
	AN20 to AN23		
	AN25 to AN27		
I/O Ports	P04 to P07	I/O	CMOS I/O ports which have a direction register determines an individual
	P10 to P14		pin is used as an input port or an output port. A pull-up resistor is select-
	P34 to P37		able for every 4 input ports.
	P95 to P97		

I : Input O : Output I/O : Input and output

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU registers. The CPU has 13 registers. Of these, R0, R1, R2, R3, A0, A1 and FB comprise a register bank. There are two register banks.

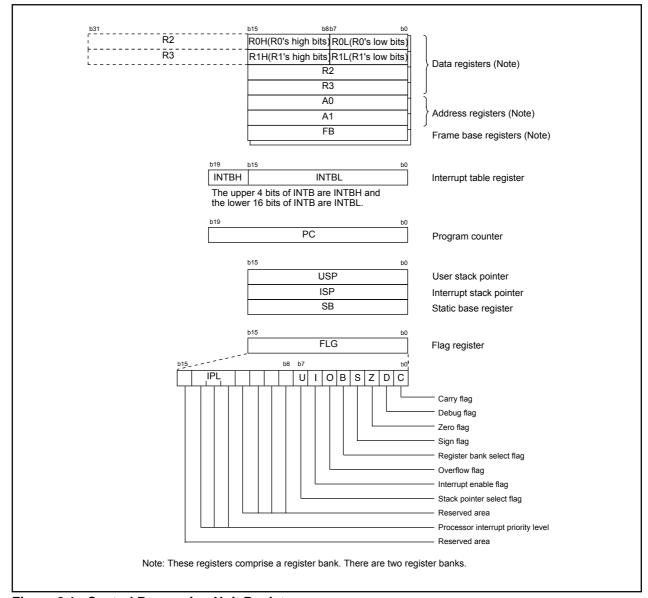


Figure 2.1. Central Processing Unit Register

2.1 Data Registers (R0, R1, R2 and R3)

The R0 register consists of 16 bits, and is used mainly for transfers and arithmetic/logic operations. R1 to R3 are the same as R0.

The R0 register can be separated between high (R0H) and low (R0L) for use as two 8-bit data registers. R1H and R1L are the same as R0H and R0L. Conversely, R2 and R0 can be combined for use as a 32-bit data register (R2R0). R3R1 is the same as R2R0.

2.2 Address Registers (A0 and A1)

The register A0 consists of 16 bits, and is used for address register indirect addressing and address register relative addressing. They also are used for transfers and arithmetic/logic operations. A1 is the same as A0.

In some instructions, registers A1 and A0 can be combined for use as a 32-bit address register (A1A0).

2.3 Frame Base Register (FB)

FB is configured with 16 bits, and is used for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB is configured with 20 bits, indicating the start address of an interrupt vector table.

2.5 Program Counter (PC)

PC is configured with 20 bits, indicating the address of an instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

Stack pointer (SP) comes in two types: USP and ISP, each configured with 16 bits.

Your desired type of stack pointer (USP or ISP) can be selected by the U flag of FLG.

2.7 Static Base Register (SB)

SB is configured with 16 bits, and is used for SB relative addressing.

2.8 Flag Register (FLG)

FLG consists of 11 bits, indicating the CPU status.

2.8.1 Carry Flag (C Flag)

This flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic/logic unit.

2.8.2 Debug Flag (D Flag)

The D flag is used exclusively for debugging purpose. During normal use, it must be set to 0.

2.8.3 Zero Flag (Z Flag)

This flag is set to 1 when an arithmetic operation resulted in 0; otherwise, it is 0.

2.8.4 Sign Flag (S Flag)

This flag is set to 1 when an arithmetic operation resulted in a negative value; otherwise, it is 0.

2.8.5 Register Bank Select Flag (B Flag)

Register bank 0 is selected when this flag is 0; register bank 1 is selected when this flag is 1.

2.8.6 Overflow Flag (O Flag)

This flag is set to 1 when the operation resulted in an overflow; otherwise, it is 0.

2.8.7 Interrupt Enable Flag (I Flag)

This flag enables a maskable interrupt.

Maskable interrupts are disabled when the I flag is 0, and are enabled when the I flag is 1.

The I flag is cleared to 0 when the interrupt request is accepted.

2.8.8 Stack Pointer Select Flag (U Flag)

ISP is selected when the U flag is 0; USP is selected when the U flag is 1.

The U flag is cleared to 0 when a hardware interrupt request is accepted or an INT instruction for software interrupt Nos. 0 to 31 is executed.

2.8.9 Processor Interrupt Priority Level (IPL)

IPL is configured with three bits, for specification of up to eight processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has priority greater than IPL, the interrupt is enabled.

2.8.10 Reserved Area

When write to this bit, write 0. When read, its content is undefined.



M16C/29 Group 3. Memory

3. Memory

Figure 3.1 is a memory map of the M16C/29 Group. M16C/29 Group provides 1-Mbyte address space from addresses 0000016 to FFFFF16. The internal ROM is allocated lower addresses beginning with address FFFFF16. For example, 64-Kbytes internal ROM is allocated addresses F000016 to FFFFF16.

Two 2-Kbyte internal ROM areas, block A and block B, are available in the flash memory version. The blocks are allocated addresses F00016 to FFFF16.

The fixed interrupt vector tables are allocated addresses FFFDC16 to FFFFF16. It stores the starting address of each interrupt routine. See the section on interrupts for details.

The internal RAM is allocated higher addresses beginning with address 0040016. For example, 4-Kbytes internal RAM is allocated addresses 0040016 to 013FF16. Besides sotring data, it becomes stacks when the subroutines is called or an interrupt is acknowledged.

SFR, consisting of control registers for peripheral functions such as I/O port, A/D converter, serial I/O, timers is allocated addresses 0000016 to 003FF16. All blank spaces within SFR are reserved and cannot be accessed by users.

The special page vector table is allocated to the addresses FFE0016 to FFFDB16. This vector is used by the JMPS or JSRS instruction. For details, refer to the *M16C/60 and M16C/20 Series Software Manual*.

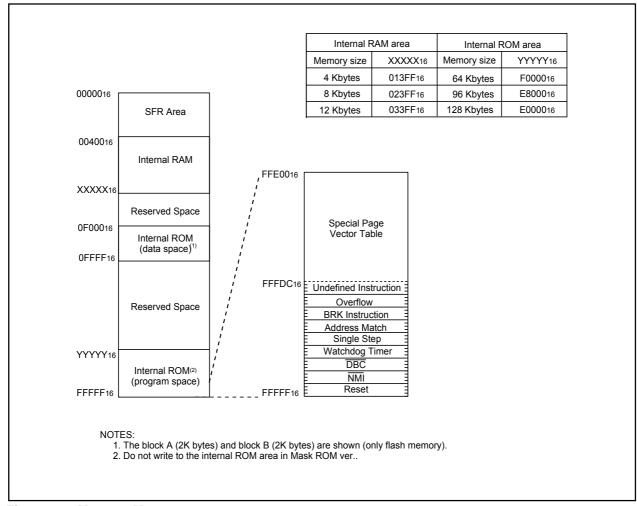


Figure 3.1 Memory Map

4. Special Function Registers (SFRs)

SFRs (Special Function Registers) are the control registers of peripheral functions. **Table 4.1** to **4.11** list the SFR address map.

Table 4.1 SFR Information (1)

016 116 216 316 418 Processor mode register 0 516 Processor mode register 1 616 System clock control register 0 716 System clock control register 1			
216 316 416 Processor mode register 0 516 Processor mode register 1 616 System clock control register 0			
316 416 Processor mode register 0 516 Processor mode register 1 516 System clock control register 0			
416 Processor mode register 0 516 Processor mode register 1 516 System clock control register 0			
Processor mode register 1 System clock control register 0			
System clock control register 0		PM0	0016
System clock control register 0		PM1	000010002
7 ₁₆ System clock control register 1		CM0	010010002
		CM1	001000002
816			
Address match interrupt enable register		AIER	XXXXXX002
A ₁₆ Protect register		PRCR	XX0000002
B ₁₆			70.0000002
C ₁₆ Oscillation stop detection register	(Note 2)	CM2	0X0000102
D16	(11010 _)		
E ₁₆ Watchdog timer start register		WDTS	XX16
Fig. Watchdog timer control register		WDC	00XXXXXX2
One Address match interrupt register 0		RMAD0	0016
1 ₁₆		KWADO	0016
			X016
216			A016
Address match interrupt register 1		DMADA	0040
Address match interrupt register 1		RMAD1	0016
516			0016
616			X016
716			
816			
Voltage detection register 1	(Note 3,4)	VCR1	000010002
A ₁₆ Voltage detection register 2	(Note 3,4)	VCR2	0016
B16			
C16 PLL control register 0		PLC0	0001X0102
D16			
E ₁₆ Processor mode register 2		PM2	XXX000002
F ₁₆ Low voltage detection interrupt register	(Note 4)	D4INT	0016
DMA0 source pointer	` '	SAR0	XX16
116			XX16
216			XX16
316			70110
416 DMA0 destination pointer		DAR0	XX16
516		<i>D7</i> (110	XX16
616			XX16 XX16
716 DMA0 transfer counter		TCDO	VV4C
B ₁₆ DMA0 transfer counter		TCR0	XX16
916			XX16
A ₁₆			
B16		D. 10	22222165
C ₁₆ DMA0 control register		DM0CON	00000X002
D16			
E16			
F16			
DMA1 source pointer		SAR1	XX16
116			XX16
216			XX16
316			
416 DMA1 destination pointer		DAR1	XX16
516			XX16
616			XX16
716			,,,,,,
		TCR1	XX16
		IUNI	
916			XX16
A ₁₆			
B ₁₆			
C ₁₆ DMA1 control register		DM1CON	00000X002
D ₁₆			
E16			
F16			

Note 1: The blank areas are reserved and cannot be used by users.

Note 2: Bits CM20, CM21, and CM27 do not change at oscillation stop detection reset.

Note 3: This register does not change at software reset, watchdog timer reset and oscillation stop detection reset.

Note 4: This registe can not use for T-ver. and V-ver.

Table 4.2 SFR Information (2)

Address	Register	Symbol	After reset
004016			
004116	CAN0 wakeup interrupt control register	C01WKIC	XXXXX0002
004216	CAN0 successful reception interrupt control register	C0RECIC	XXXXX0002
004316	CAN0 successful transmission interrupt control register	COTRMIC	XXXXX0002
004416	INT3 interrupt control register	INT3IC	XX00X0002
004516	ICOC 0 interrupt control register	ICOC0IC	XXXXX0002
004616	ICOC 1 interrupt control register, I ² C bus interface interrupt control register 1	ICOC1IC,IICIC	XXXXX0002
004716	ICOC base timer interrupt control register, ScL/SDA interrupt control register 2	BTIC,SCLDAIC S4IC, INT5IC	XXXXX0002 XX00X0002
004816	SI/O4 interrupt control register, INT5 interrupt control register SI/O3 interrupt control register, INT4 interrupt control register	S3IC, INT4IC	XX00X0002 XX00X0002
0049 ₁₆	UART2 Bus collision detection interrupt control register	BCNIC	XXXXX0002
004A16	DMA0 interrupt control register	DM0IC	XXXXX0002 XXXXXX0002
004B16	DMA1 interrupt control register	DM1IC	XXXXX0002
004D ₁₆	CANO error interrupt control register	C01ERRIC	XXXXX0002
004E ₁₆	AD conversion interrupt control register, Key input interrupt control register (Note 2)	ADIC, KUPIC	XXXXX0002
004F ₁₆	UART2 transmit interrupt control register	S2TIC	XXXXX0002
005016	UART2 receive interrupt control register	S2RIC	XXXXX0002
005116	UART0 transmit interrupt control register	SOTIC	XXXXX0002
005216	UART0 receive interrupt control register	S0RIC	XXXXX0002
005316	UART1 transmit interrupt control register	S1TIC	XXXXX0002
005416	UART1 receive interrupt control register	S1RIC	XXXXX0002
005516	TimerA0 interrupt control register	TA0IC	XXXXX0002
005616	TimerA1 interrupt control register	TA1IC	XXXXX0002
005716	TimerA2 interrupt control register	TA2IC	XXXXX0002
005816	TimerA3 interrupt control register	TA3IC	XXXXX0002
005916	TimerA4 interrupt control register	TA4IC	XXXXX0002
005A ₁₆	TimerB0 interrupt control register	TB0IC	XXXXX0002
005B ₁₆	TimerB1 interrupt control register	TB1IC	XXXXX0002
005C ₁₆	TimerB2 interrupt control register	TB2IC	XXXXX0002
005D ₁₆	INTO interrupt control register	INTOIC	XX00X0002 XX00X0002
005E ₁₆	INT1 interrupt control register INT2 interrupt control register	INT1IC INT2IC	XX00X0002 XX00X0002
005F ₁₆	CAN0 message box 0: Identifier/DLC	INTZIC	XX16
006016	CANO Message box of Identifier/DEC		XX16
006216			XX16
006316			XX16
006416			XX16
006516			XX16
006616	CAN0 message box 0 : Data field		XX16
006716	-		XX16
006816			XX16
006916			XX16
006A ₁₆			XX16
006B ₁₆			XX16
006C ₁₆			XX16
006D ₁₆	OANO		XX16
006E ₁₆	CAN0 message box 0 : Time stamp		XX16
006F ₁₆	CAND manage boy 1 : Identifier/DLC		XX16 XX16
007016	CAN0 message box 1 : Identifier/DLC		XX16 XX16
0071 ₁₆ 0072 ₁₆			XX16 XX16
007216			XX16
007316			XX16
007416			XX16
007516	CAN0 message box 1 : Data field		XX16
007716			XX16
007716			XX16
007916			XX16
007A ₁₆			XX16
007B ₁₆			XX16
007C ₁₆			XX16
007D ₁₆			XX16
007E ₁₆	CAN0 message box 1 : Time stamp		XX16
007F ₁₆			XX16



Note 1: The blank areas are reserved and cannot be used by users.

Note 2: A/D conversion interrupt control register is effective when the bit1(Interrupt source select register (address 35Eh IFSR2A) is set to "0". Key input interrupt control register is effective when the bit1 is set to "1".

Table 4.3 SFR Information (3)

Address	Register	Symbol	After reset
008016	CAN0 message box 2: Identifier/DLC		XX16
008116			XX16
008216			XX16
008316			XX16
008416			XX16
008516			XX16
008616	CAN0 message box 2 : Data field		XX16
008716			XX16
008816			XX16
008916			XX16
008A ₁₆			XX16
008B ₁₆			XX16
008C ₁₆			XX16
008D ₁₆	0.1112		XX16
008E ₁₆	CAN0 message box 2 : Time stamp		XX16
008F ₁₆			XX16
009016	CAN0 message box 3 : Identifier/DLC		XX16
009116			XX16
009216			XX16
009316			XX16
009416			XX16
009516			XX16
009616	CAN0 message box 3 : Data field		XX16
009716			XX16
009816			XX16
009916			XX16
009A ₁₆			XX16
009B ₁₆			XX16
009C ₁₆			XX16
009D ₁₆			XX16
009E ₁₆	CAN0 message box 3 : Time stamp		XX16
009F ₁₆			XX16
00A0 ₁₆	CAN0 message box 4: Identifier/DLC		XX16
00A1 ₁₆			XX16
00A2 ₁₆			XX16
00A3 ₁₆			XX16
00A4 ₁₆			XX16
00A5 ₁₆	CANO have A a Data field		XX16
00A6 ₁₆	CAN0 message box 4 : Data field		XX16
00A7 ₁₆			XX16
00A8 ₁₆			XX16
00A9 ₁₆			XX16
00AA ₁₆			XX16
00AB ₁₆			XX16 XX16
00AC16			XX16 XX16
00AD ₁₆	CAN0 message box 4 : Time stamp		XX16 XX16
00AE ₁₆	Onivo message box 4. Time stamp		XX16 XX16
00AF ₁₆	CAN0 message box 5 : Identifier/DLC		XX16 XX16
00B0 ₁₆ 00B1 ₁₆	Onivo message box 5 . Identifie/DLC		XX16
			XX16
00B216			XX16
00B3 ₁₆ 00B4 ₁₆			XX16
			XX16 XX16
00B516	CAN0 message box 5 : Data field		XX16
00B6 ₁₆ 00B7 ₁₆	DANO MESSAGE DUX 3 . Data Helu		XX16
			XX16
00B816			XX16 XX16
00B916			XX16 XX16
00BA ₁₆			
00BB ₁₆			XX16
00BC ₁₆			XX16
00BD ₁₆	CANO magazana hay F , Time a stance		XX16
00BE ₁₆	CAN0 message box 5 : Time stamp		XX16
00BF ₁₆			XX16

Note 1: The blank areas are reserved and cannot be used by users.

Table 4.4 SFR Information (4)

Address	- 3	Symbol	After reset
00C0 ₁₆	CAN0 message box 6: Identifier/DLC		XX16
00C1 ₁₆			XX16
00C2 ₁₆			XX16
00C3 ₁₆			XX16
00C4 ₁₆			XX16
00C5 ₁₆			XX16
00C6 ₁₆	CAN0 message box 6 : Data field		XX16
00C7 ₁₆			XX16
00C8 ₁₆			XX16
00C9 ₁₆			XX16
00CA ₁₆			XX16
00CB ₁₆			XX16
00CC16			XX16
00CD ₁₆			XX16
00CE ₁₆	CAN0 message box 6 : Time stamp		XX16
00CF16			XX16
00D0 ₁₆	CAN0 message box 7 : Identifier/DLC		XX16
00D1 ₁₆			XX16
00D216			XX16
00D216			XX16
00D416			XX16
00D416			XX16
00D516 00D616	CAN0 message box 7 : Data field		XX16
00D016	S. 1.13300ago box 7 . Bata nota		XX16
00D716 00D816			XX16
00D616			XX16
00D916 00DA16			XX16 XX16
00DA16			XX16
			XX16 XX16
00DC ₁₆			XX16
00DD16	CANO magaza bay 7 : Time stamp		XX16
00DE ₁₆	CAN0 message box 7 : Time stamp		
00DF ₁₆	CANO magaza bay 9: Identifica/DLC		XX16 XX16
00E0 ₁₆	CAN0 message box 8: Identifier/DLC		
00E1 ₁₆			XX16
00E2 ₁₆			XX16
00E3 ₁₆			XX16
00E4 ₁₆			XX16
00E5 ₁₆			XX16
00E6 ₁₆	CAN0 message box 8: Data field		XX16
00E7 ₁₆			XX16
00E8 ₁₆			XX16
00E9 ₁₆			XX16
00EA ₁₆			XX16
00EB ₁₆			XX16
00EC ₁₆			XX16
00ED ₁₆			XX16
00EE ₁₆	CAN0 message box 8 : Time stamp		XX16
00EF ₁₆			XX16
00F0 ₁₆	CAN0 message box 9 : Identifier/DLC		XX16
00F1 ₁₆			XX16
00F2 ₁₆			XX16
00F3 ₁₆			XX16
0F4 ₁₆			XX16
0F516			XX16
0F6 ₁₆	CAN0 message box 9 : Data field		XX16
0F7 ₁₆			XX16
0F8 ₁₆			XX16
00F9 ₁₆			XX16
0FA ₁₆			XX16
. J. ∩10			XX16
UNEB44			
		I I	Y Y 16
00FC ₁₆			XX16
00FB ₁₆ 00FC ₁₆ 00FD ₁₆ 00FE ₁₆	CAN0 message box 9 : Time stamp		XX16 XX16 XX16

Note 1: The blank areas are reserved and cannot be used by users.



Table 4.5 SFR Information (5)

Address		Symbol	After reset
010016	CAN0 message box 10: Identifier/DLC		XX16
010116			XX16
010216			XX16
010316			XX16
010416			XX16
010516			XX16
010616	CAN0 message box 10 : Data field		XX16
010716			XX16
010816			XX16
010916			XX16
010A ₁₆			XX16
010B ₁₆			XX16
010C ₁₆			XX16
			XX16 XX16
010D ₁₆	CANO massage have 40 v. Times atoms		XX16
010E ₁₆	CAN0 message box 10 : Time stamp		I
010F ₁₆	0.110		XX16
011016	CAN0 message box 11 : Identifier/DLC		XX16
)111 ₁₆			XX16
011216			XX16
011316			XX16
011416			XX16
011516			XX16
011616	CAN0 message box 11 : Data field		XX16
011716			XX16
011816			XX16
011916			XX16
011A ₁₆			XX16
			XX16 XX16
011B ₁₆			
011C ₁₆			XX16
011D ₁₆	0.000		XX16
011E ₁₆	CAN0 message box 11 : Time stamp		XX16
011F ₁₆			XX16
012016	CAN0 message box 12: Identifier/DLC		XX16
012116			XX16
012216			XX16
012316			XX16
012416			XX16
012516			XX16
012616	CAN0 message box 12: Data field		XX16
012716			XX16
012816			XX16
012916			XX16
			XX16 XX16
012A ₁₆			I
012B ₁₆			XX16
012C ₁₆			XX16
012D ₁₆	0.000		XX16
012E ₁₆	CAN0 message box 12 : Time stamp		XX16
)12F ₁₆			XX16
013016	CAN0 message box 13 : Identifier/DLC		XX16
013116			XX16
13216			XX16
13316			XX16
13416			XX16
13516			XX16
13616	CAN0 message box 13 : Data field		XX16 XX16
	Or 1140 message box 10 . Data neta		XX16 XX16
013716			I
013816			XX16
13916			XX16
)13A ₁₆			XX16
013B ₁₆			XX16
013C ₁₆			XX16
013D ₁₆			XX16
013E ₁₆	CAN0 message box 13 : Time stamp		XX16
			XX16

Note 1: The blank areas are reserved and cannot be used by users.



Table 4.6 SFR Information (6)

Address	Register		Symbol	After reset
014016	CAN0 message box 14: Identifier/DLC			XX16
14116				XX16
14216				XX16
14316				XX16
14416				XX16
14516				XX16
14616	CAN0 message box 14 : Data field			XX16
)14716	ŭ			XX16
14816				XX16
014916				XX16
014A ₁₆				XX16
14B ₁₆				XX16
)14C ₁₆				XX16
)14D ₁₆				XX16
)14E ₁₆	CAN0 message box 14 : Time stamp			XX16
14F ₁₆	or the message box 11. Time stamp			XX16
15016	CAN0 message box 15 : Identifier/DLC			XX16
15116	Or the message box to : Identificing 20			XX16
15216				XX16 XX16
15316				XX16 XX16
I				XX16
15416				XX16 XX16
15516	CANO massage hay 15 : Data field			XX16 XX16
15616	CAN0 message box 15 : Data field			
15716				XX16
15816				XX16
15916				XX16
15A ₁₆				XX16
15B ₁₆				XX16
15C ₁₆				XX16
15D ₁₆				XX16
15E ₁₆	CAN0 message box 15 : Time stamp			XX16
15F ₁₆				XX16
16016	CAN0 global mask register		C0GMR	XX16
16116				XX16
16216				XX16
16316				XX16
16416				XX16
16516				XX16
16616	CAN0 local mask A register		C0LMAR	XX16
16716				XX16
16816				XX16
16916				XX16
16A ₁₆				XX16
16B ₁₆				XX16
16C ₁₆	CAN0 local mask B register		C0LMBR	XX16
16D ₁₆				XX16
16E ₁₆				XX16 XX16
16F ₁₆				XX16 XX16
17016				XX16 XX16
17116				XX16 XX16
17 110				70010
1B3 ₁₆	Flash memory control register 4	(Note 2)	FMR4	0100000X2
IB316 IB416	Tradit momenty control register 4	(14016 2)	1 (1) (1)	010000072
	Flash memory control register 1	(Note 2)	FMR1	000XXX0X2
1B5 ₁₆	riasir memory control register 1	(NOLE Z)	L MINI J	υυυλλλυλ2
1B6 ₁₆	Floch moment control register 0	(Mate O)	EMDO	0140
1B7 ₁₆	Flash memory control register 0	(Note 2)	FMR0	0116
IFD ₁₆				
FE ₁₆				
FF16				i e

Note 1: The blank areas are reserved and cannot be used by users. Note 2: This register is included in the flash memory version.

Table 4.7 SFR Information (7)

DIC 4.7	SEK IIIIOIIIIalioii (1)		
Address	Register	Symbol	After reset
020016	CAN0 message control register 0	C0MCTL0	0016
020116	CAN0 message control register 1	C0MCTL1	0016
020216	CAN0 message control register 2	C0MCTL2	0016
020316	CAN0 message control register 3	COMCTL3	0016
020416	CAN0 message control register 4	C0MCTL4	0016
020516	CAN0 message control register 5	COMCTL5	0016
020616	CAN0 message control register 6	COMCTL6	0016
020716	CAN0 message control register 7	COMCTL7	0016
020816	CAN0 message control register 8	COMCTL8	0016
020916	CAN0 message control register 9	COMCTL9	0016
020A ₁₆	CANO message control register 10	COMCTL10	0016
020B ₁₆	CAN0 message control register 11 CAN0 message control register 12	C0MCTL11 C0MCTL12	0016 0016
020C ₁₆	CANO message control register 12 CANO message control register 13	COMCTL12	0016
020D ₁₆			0016
020E16	CAN0 message control register 14 CAN0 message control register 15	C0MCTL14 C0MCTL15	0016
020F ₁₆		CONCILIS	X00000012
021016	CAN0 control register	CUCTER	
021116	CANO status register	COSTD	XX0X00002
021216	CAN0 status register	C0STR	0016 V000001a
021316	CANIO elet etatue register	COCCED	X00000012
021416	CAN0 slot status register	C0SSTR	0016
021516	CANO interment control register	COLCD	0016
021616	CAN0 interrupt control register	C0ICR	0016
021716	CANIO sistemated ID resisters	COLDE	0016
021816	CAN0 extended ID register	C0IDR	0016
021916	CANIO configuration anniator	0000015	0016
021A ₁₆	CAN0 configuration register	C0CONR	XX16
021B ₁₆	CANIO receive agree count register	000500	XX16
021C ₁₆	CANO receive error count register	CORECR	0016
021D ₁₆	CANO transmit error count register	COTECR	0016
021E ₁₆	CAN0 time stamp register	C0TSR	0016
021F ₁₆			0016
,			,
			·
2040	CANO accontance filter cumpert register	C0AFS	XX16
024216	CAN0 acceptance filter support register	CUAFS	XX16 XX16
024316			VV10
			;
025A ₁₆	Three-phase protect control register	TPRC	0016
)25A16)25B16	Three phase protest control register	11 110	0010
025B16 025C16	On-chip oscillator control register	ROCR	000001012
	Pin assignment control register	PACR	0016
		PCLKR	000000112
025E ₁₆ 025F ₁₆	Peripheral clock select register CANO clock select register	CCLKR	0016
12JI 16	O/ 1140 GIOGR DOIGOT TOGISTOI	OOLAIN	0010
•			;
			•
1250	I ² C0 data-shift register	S00	XX16
	1 Oo data-smit register	300	W10
02E1 ₁₆ 02E2 ₁₆	I ² C0 address register	S0D0	0016
	1 ² C0 control register 0	S1D0	0016
	1ºC0 control register 0	S1D0 S20	0016
	1 ² C0 start/stop condition control register	S2D0	000110102
	1 ² C0 control register 1	S3D0	00110102
	1 ² C0 control register 2	S4D0	001100002
	1 ² C0 status register	S10	0001000X2
02E8 ₁₆	1 OU SIGIUS TEYISIET	310	0001000Λ2
			,
2250			
JZ⊏⊏16			
02FD ₁₆ 02FE ₁₆			

Note 1: The blank areas are reserved and cannot be used by users.

Table 4.8 SFR Information (8)

Address	Register	Symbol	After reset
0300 ₁₆	Time measurement, Pulse generation register 0	G1TM0,G1PO0	XX16 XX16
030216	Time measurement, Pulse generation register 1	G1TM1,G1PO1	XX16
)303 ₁₆)304 ₁₆	Time measurement, Pulse generation register 2	G1TM2,G1PO2	XX16 XX16
)305 ₁₆)306 ₁₆	Time measurement, Pulse generation register 3	G1TM3,G1PO3	XX16 XX16
30716			XX16
0308 ₁₆ 0309 ₁₆	Time measurement, Pulse generation register 4	G1TM4,G1PO4	XX16 XX16
030A ₁₆	Time measurement, Pulse generation register 5	G1TM5,G1PO5	XX16 XX16
030C ₁₆	Time measurement, Pulse generation register 6	G1TM6,G1PO6	XX16 XX16
030E ₁₆	Time measurement, Pulse generation register 7	G1TM7,G1PO7	XX16 XX16
	Pulse generation control register 0	G1POCR0	0X00XX002
	Pulse generation control register 1	G1POCR1	0X00XX002
	Pulse generation control register 2	G1POCR2	0X00XX002
031316	Pulse generation control register 3	G1POCR3	0X00XX002
	Pulse generation control register 4	G1POCR4	0X00XX002
031516	Pulse generation control register 5	G1POCR5	0X00XX002
031616	Pulse generation control register 6	G1POCR6	0X00XX002
031716	Pulse generation control register 7	G1POCR7	0X00XX002
031816	Time measurement control register 0	G1TMCR0	0016
031916	Time measurement control register 1	G1TMCR1	0016
031A ₁₆	Time measurement control register 2	G1TMCR2	0016
031B ₁₆	Time measurement control register 3	G1TMCR3	0016
031C ₁₆	Time measurement control register 4	G1TMCR4	0016
031D ₁₆	Time measurement control register 5	G1TMCR5	0016
031E ₁₆	Time measurement control register 6	G1TMCR6	0016
031F ₁₆	Time measurement control register 7	G1TMCR7	0016
032016	Base timer register	G1BT	XX16 XX16
032216	Base timer control register 0	G1BCR0	0016
032316	Base timer control register 1	G1BCR1	0016
032416	Time measurement prescale register 6	G1TPR6	0016
032516	Time measurement prescale register 7	G1TPR7	0016
	Function enable register	G1FE	0016
	Function enable register	G1FS	0016
	Base timer reset register	G1BTRR	XX16
032916			XX16
032A ₁₆	Count source division register	G1DV	0016
032B ₁₆			
032C ₁₆			
032D ₁₆			
032E ₁₆			
032F ₁₆			
	Interrupt request register	G1IR	XX16
033116	Interrupt enable register 0	G1IE0	0016
033216	Interrupt enable register 1	G1IE1	0016
033316			
033416			
033516			
033616			
033716			
033816			
033916			
033A ₁₆			
033B ₁₆			
033C ₁₆			
033D ₁₆			
	NMI digital debounce register	NDDR	FF16

Note 1: The blank areas are reserved and cannot be used by users.



Table 4.9 SFR Information (9)

	4.9 SFR Information (9)	O:h - I	A #
Address	Register	Symbol	After reset
034016			
034116	Timer A1-1 register	TA11	XX16
0342 ₁₆ 0343 ₁₆	Time A1-1 register	IAII	XX16 XX16
034316	Timer A2-1 register	TA21	XX16 XX16
034516	Timer Az-1 register	IAZI	XX16 XX16
034616	Timer A4-1 register	TA41	XX16
034716	Times 711 Trogistis		XX16
034816	Three phase PWM control register 0	INVC0	0016
034916	Three phase PWM control register 1	INVC1	0016
034A ₁₆	Three phase output buffer register 0	IDB0	0016
034B ₁₆	Three phase output buffer register 1	IDB1	0016
034C ₁₆	Dead time timer	DTT	XX16
034D ₁₆	Timer B2 Interrupt occurrence frequency set counter	ICTB2	XX16
034E ₁₆	Position - data - retain function control register	PDRF	XXXX00002
034F ₁₆			
035016			
035116		 	
035216		+	
035316			
035416			
035516		<u> </u>	
035716			
035816	Port function control register	PFCR	001111112
035916	3		
035A ₁₆			
035B ₁₆			
035C ₁₆			
035D ₁₆			
035E ₁₆	Interrupt cause select register 2 ⁽²⁾	IFSR2A	00XXX0002
035F ₁₆	Interrupt cause select register	IFSR	0016
036016	SI/O3 transmit/receive register	S3TRR	XX16
036116	CI/O2 control register	S3C	010000002
036216	SI/O3 control register SI/O3 bit rate register	S3BRG	XX16
0363 ₁₆ 0364 ₁₆	SI/O3 bit rate register SI/O4 transmit/receive register	S4TRR	XX16
036516	On O4 transmitreceive register	OTITAL	70(10
036616	SI/O4 control register	S4C	010000002
036716	SI/O4 bit rate register	S4BRG	XX16
036816			
036916			
036A ₁₆			
036B ₁₆			
036C ₁₆			
036D ₁₆			
036E ₁₆		-	
036F ₁₆		-	
037016			
037116		+	
037216			
037316	UART2 special mode register 4	U2SMR4	0016
037416	UART2 special mode register 3	U2SMR3	000X0X0X2
037516	UART2 special mode register 2	U2SMR2	X00000002
037716	UART2 special mode register	U2SMR	X00000002 X00000002
037816	UART2 transmit/receive mode register	U2MR	0016
037916	UART2 bit rate register	U2BRG	XX16
037A ₁₆	UART2 transmit buffer register	U2TB	XX16
037B ₁₆			XX16
037C ₁₆	UART2 transmit/receive control register 0	U2C0	000010002
037D ₁₆	UART2 transmit/receive control register 1	U2C1	00000102
037E ₁₆	UART2 receive buffer register	U2RB	XX16
037F ₁₆			XX16

Note 1: The blank areas are reserved and cannot be used by users. Note 2: Write 0 to the bit 0 after reset.



Table 4.10 SFR Information (10)

	4.10 SFR Information (10)		Г
Address	Register	Symbol	After reset
038016	Count start flag	TABSR	0016
038116	Clock prescaler reset flag	CPSRF	0XXXXXXX2
038216	One-shot start flag	ONSF	0016
038316	Trigger select register	TRGSR	0016
038416	Up-dowm flag	UDF	0016
038516	Timer A0 register	TA0	XX16
0386 ₁₆ 0387 ₁₆	Tiller Au register	TAU	XX16
038816	Timer A1 register	TA1	XX16 XX16
038916	Timer At register	IAI	XX16
038A ₁₆	Timer A2 register	TA2	XX16
038B ₁₆		··· ·	XX16
038C ₁₆	Timer A3 register	TA3	XX16
038D ₁₆			XX16
038E ₁₆	Timer A4 register	TA4	XX16
038F ₁₆			XX16
039016	Timer B0 register	TB0	XX16
039116			XX16
039216	Timer B1 register	TB1	XX16
039316			XX16
039416	Timer B2 register	TB2	XX16
039516		T	XX16
039616	Timer A0 mode register	TA0MR	0016
039716	Timer A1 mode register	TA1MR	0016
039816	Timer A2 mode register	TA2MR	0016
039916	Timer A3 mode register Timer A4 mode register	TA3MR TA4MR	0016 0016
039A ₁₆	Timer B0 mode register	TB0MR	00XX00002
039B ₁₆ 039C ₁₆	Timer B1 mode register	TB1MR	00XX00002 00XX00002
039D ₁₆	Timer B2 mode register	TB2MR	00XX00002
039E ₁₆	Timer B2 special mode register	TB2SC	X00000002
039F ₁₆	Timor B2 openiar mode regional	10200	710000002
03A0 ₁₆	UART0 transmit/receive mode register	U0MR	0016
03A1 ₁₆	UART0 bit rate register	U0BRG	XX16
03A2 ₁₆	UART0 transmit buffer register	U0TB	XX16
03A3 ₁₆	·		XX16
03A4 ₁₆	UART0 transmit/receive control register 0	U0C0	000010002
03A5 ₁₆	UART0 transmit/receive control register 1	U0C1	000000102
03A6 ₁₆	UART0 receive buffer register	U0RB	XX16
03A7 ₁₆			XX16
03A8 ₁₆	UART1 transmit/receive mode register	U1MR	0016
03A9 ₁₆	UART1 bit rate register	U1BRG	XX16
03AA ₁₆	UART1 transmit buffer register	U1TB	XX16
03AB ₁₆	LIADTA transportition control register C	1400	XX16
03AC ₁₆	UART1 transmit/receive control register 0	U1C0	000010002
03AD ₁₆	UART1 transmit/receive control register 1	U1C1 U1RB	000000102
03AE ₁₆	UART1 receive buffer register	UIKB	XX16 XX16
03AF ₁₆ 03B0 ₁₆	UART transmit/receive control register 2	UCON	X00000002
03B016 03B116	OAITT HAIISTIIVIEGEIVE COITHOLIEGISTEI 2	UCUN	700000002
03B116			
03B216			
03B4 ₁₆	CRC snoop address register	CRCSAR	XX16
03B516			00XXXXXX2
03B6 ₁₆	CRC mode register	CRCMR	0XXXXXX02
03B7 ₁₆	<u> </u>		
03B8 ₁₆	DMA0 request cause select register	DM0SL	0016
03B9 ₁₆			
03BA ₁₆	DMA1 request cause select register	DM1SL	0016
03BB ₁₆		<u></u>	
03BC ₁₆	CRC data register	CRCD	XX16
03BD ₁₆			XX16
03BE ₁₆	CRC input register	CRCIN	XX16
03BF ₁₆			

Note 1: The blank areas are reserved and cannot be used by users.

Table 4.11 SFR Information (11)

Address	Register	Symbol	After reset
	A/D register 0	AD0	XX16 XX16
3C1 ₁₆	A/D ve siste v 1	AD4	XX16
3C2 ₁₆ 3C3 ₁₆	A/D register 1	AD1	XX16 XX16
3C4 ₁₆	A/D register 2	AD2	XX16
3C5 ₁₆			XX16
3C6 ₁₆	A/D register 3	AD3	XX16 XX16
3C7 ₁₆	A/D register 4	AD4	XX16
03C916	AD register 4	704	XX16 XX16
3CA ₁₆	A/D register 5	AD5	XX16
03CB ₁₆			XX16
03CC ₁₆	A/D register 6	AD6	XX16
03CD ₁₆	A/D register 7	AD7	XX16 XX16
03CF ₁₆	70D Togistor 7	7.57	XX16
03D0 ₁₆			
)3D1 ₁₆			
	A/D trigger control register	ADTRGCON	XXXX00002
)3D3 ₁₆	A/D status register 0	ADSTATO	00000X002
03D4 ₁₆ 03D5 ₁₆	A/D control register 2	ADCON2	0016
03D516 03D616	A/D control register 0	ADCON0	00000XXX2
03D016	A/D control register 1	ADCON1	0016
03D8 ₁₆	*		
03D9 ₁₆			
03DA ₁₆			
03DB ₁₆			
03DC ₁₆			
03DD16 03DE16			
03DE16			
03E0 ₁₆	Port P0 register	P0	XX16
03E1 ₁₆	Port P1 register	P1	XX16
03E2 ₁₆	Port P0 direction register	PD0	0016
03E3 ₁₆	Port P1 direction register	PD1	0016
03E4 ₁₆	Port P3 register	P2 P3	XX16 XX16
03E5 ₁₆	Port P3 register Port P2 direction register	PD2	0016
03E7 ₁₆	Port P3 direction register	PD3	0016
03E8 ₁₆			
03E9 ₁₆			
03EA ₁₆			
03EB ₁₆	Dort DC register	50	VV.
03EC ₁₆ 03ED ₁₆	Port P6 register Port P7 register	P6 P7	XX16 XX16
03ED16 03EE16	Port P6 direction register	PD6	0016
3EF ₁₆	Port P7 direction register	PD7	0016
03F0 ₁₆	Port P8 register	P8	XX16
03F1 ₁₆	Port P9 register	P9	XX16
03F2 ₁₆	Port P8 direction register	PD8	0016
03F3 ₁₆	Port P40 register	PD9	000X00002
3F4 ₁₆	Port P10 register	P10	XX16
)3F5 ₁₆)3F6 ₁₆	Port P10 direction register	PD10	0016
)3F7 ₁₆	, ore to an obtain register	1 510	3010
03F8 ₁₆			
03F9 ₁₆			
701 010			
)3FA ₁₆)3FB ₁₆			
)3FA ₁₆)3FB ₁₆)3FC ₁₆	Pull-up control register 0	PUR0	0016
03FA ₁₆ 03FB ₁₆ 03FC ₁₆ 03FD ₁₆ 03FE ₁₆	Pull-up control register 0 Pull-up control register 1 Pull-up control register 2	PUR0 PUR1 PUR2	0016 0016 0016

Note 1: The blank areas are reserved and cannot be used by users.

 \boldsymbol{X} : Undefined



5. Resets

Hardware reset 1, brown-out detection reset (hardware reset 2), software reset, watchdog timer reset, and oscillation stop detection reset are implemented to reset the MCU.

5.1 Hardware Reset

Hardware reset 1 and brown-out detection reset are available as the hardware reset.

5.1.1 Hardware Reset 1

Pins, CPU, and SFRs are reset by using the RESET pin. When a low-level ("L") signal is applied to the RESET pin while the supply voltage meets the recommended operating condition, pins, CPU, and SFRs are reset (see **Table 5.1** Pin Status When RESET Pin Level is "L"). The oscillation circuit is also reset and the on-chip oscillator starts oscillating as the CPU clock. CPU and SFRs re reset when the signal applied to the RESET pin changes from "L" to high ("H"). The MCU executes a program beginning with the address indicated by the reset vector. The internal RAM is not reset. When an "L" signal is applied to the RESET pin while writing data to the internal RAM, the content of internal RAM is undefined.

Figure 5.1 shows an example of the reset circuit. **Figure 5.2** shows a reset sequence. **Table 5.1** shows status of the other pins while the RESET pin is held "L". **Figure 5.3** shows CPU register states after reset. Refer to **4. Special Function Register (SFR)** about SFR states after reset.

- 1. Reset on a stable supply voltage
- (1) Apply an "L" signal to the RESET pin
- (2) Wait td(ROC) or more
- (3) Apply an "H" signal to the RESET pin
- 2. Power-on reset
- (1) Apply an "L" signal to the RESET pin
- (2) Increase the supply voltage until it meets the the recommended performance condition
- (3) Wait for td(P-R) or more to allow the internal power supply to stabilize
- (4) Wait td(ROC) or more
- (5) Apply an "H" signal to the RESET pin

5.1.2 Brown-Out Detection Reset (Hardware Reset 2)

Note

Brown-out detection reset in the M16C/29 Group, T-ver. and V-ver. cannot be used.

Pins, CPU, and SFR are reset by using the on-chip voltage detection circuit, which monitors the voltage applied to Vcc pin.

When the VC26 bit in the VCR2 register is set to 1 (reset level detection circuit enabled), pins, CPU, and SFR are reset as soon as the voltage applied to the Vcc pin drops to Vdet3 or below.

Then, pins, CPU, and SFR are reset as soon as the voltage applied to the VCC pin reaches Vdet3r or above. The MCU executes the program in an address determined by the reset vector.

The MCU executes the program after detecting Vdet3r and waiting td(S-R) ms. The same pins and registers are reset by the hardware reset 1 and brown-out detection reset, and are also placed in the same reset state.

The MCU cannot exit stop mode by brown-out detection reset.



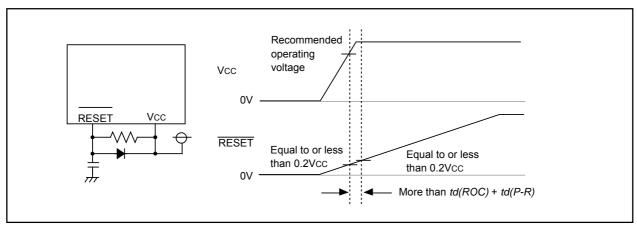


Figure 5.1 Example Reset Circuit

5.2 Software Reset

The MCU resets its pins, CPU, and SFRs when the PM03 bit in the PM0 register is set to 1 (reset) and the MCU executes a program in an address indicated by the reset vector. Then the on-chip oscillator is selected as the CPU clock.

The software reset does not reset some portions of the SFRs. Refer to **4. Special Function Registers** (SFRs) for details.

5.3 Watchdog Timer Reset

The MCU resets its pins, CPU, and SFRs when the PM12 bit in the PM1 register is set to 1 (watchdog timer reset) and the watchdog timer underflows. The MCU executes a program in an address indicated by the reset vector. Then the on-chip oscillator is selected as the CPU clock.

The watchdog timer reset does not reset some portions of the SFRs. Refer to **4. Special Function Registers (SFRs)** for details.

5.4 Oscillation Stop Detection Reset

The MCU resets its pins, CPU, and SFRs and stops if the main clock stop is detected when the CM20 bit in the CM2 register is set to 1 (oscillation stop, re-oscillation detection function enabled) and the CM27 bit in the CM2 register is 0 (reset at oscillation stop detection). Refer to the section **7.8 oscillation stop**, **re-oscillation detection function** for details.

The oscillation stop detection reset does not reset some portions of the SFRs. Refer to **4. Special Function Registers (SFRs)**.

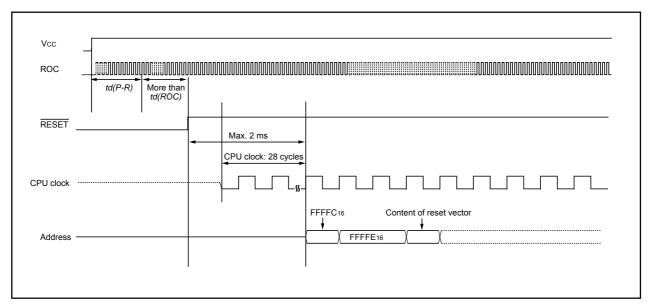


Figure 5.2 Reset Sequence

Table 5.1 Pin Status When RESET Pin Level is "L"

Pin name	Status
P0 to P3, P6 to P10	Input port (high impedance)

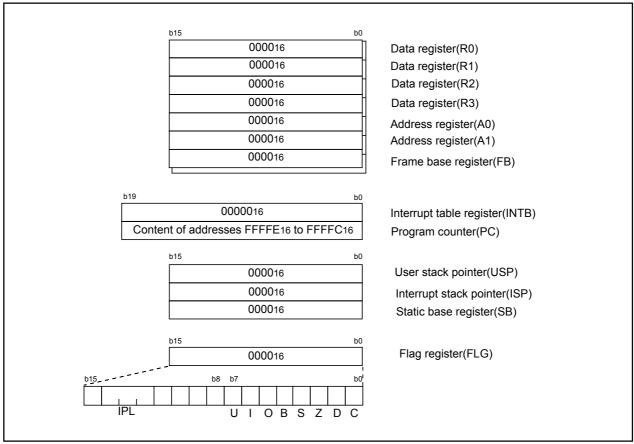


Figure 5.3 CPU Register Status After Reset

5.5 Voltage Detection Circuit

Note '

Vcc = 5 V is assumed in **5.5 Voltage Detection Circuit**.

Voltage detection circuit in the M16C/29 Group, T-ver. and V-ver. cannot be used.

The voltage detection circuit has the reset level detection circuit and the low voltage detection circuit. The reset level detection circuit monitors the voltage applied to the VCC pin. The MCU is reset if the reset level detection circuit detects VCC is Vdet3 or below. Use bits VC27 and VC26 in the VCR2 register to determine whether the individual circuit is enabled.

Use the reset level detection circuit for brown-out detection reset.

The low voltage detection circuit also monitors the voltage applied to the Vcc pin. The low voltage detection circuit use the VC13 bit in the VCR1 register to detect Vcc is above or below Vdet4. The low voltage detection interrupt can be used in the voltage detection circuit.

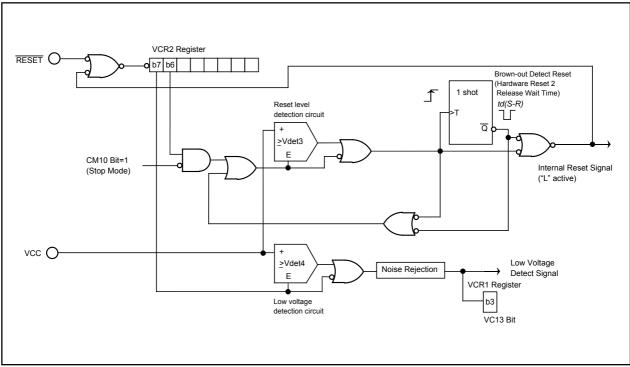
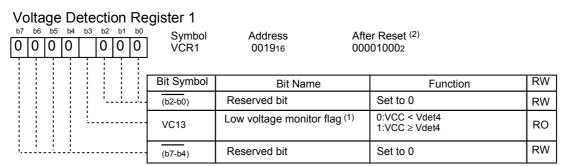


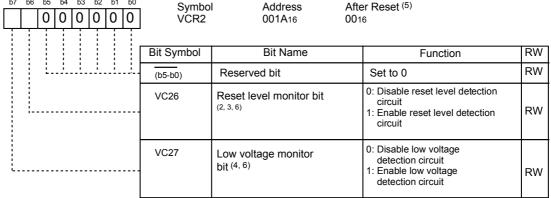
Figure 5.4 Voltage Detection Circuit Block



NOTES:

- The VC13 bit is useful when the VC27 bit of VCR2 register is set to 1 (low voltage detection circuit enable).
 The VC13 bit is always 1 (Vcc≥ Vdet4) when the VC27 bit in the VCR2 register is set to 0 (low voltage detection circuit disable).
- 2. This register does not change at software reset, watchdog timer reset and oscillation stop detection reset.

Voltage Detection Register 2 (1)



NOTES:

- 1. Write to this register after setting the PRC3 bit in the PRCR register to 1 (write enable).
- 2. Set the VC26 bit to 1 to use brown-out reset.
- 3. VC26 bit is disabled in stop mode. (The MCU is not reset even if the voltage input to Vcc pin becomes lower than Vdet3.)
- 4. When the VC13 bit in the VCR1 register and D42 bit in the D4INT register are used or the D40 bit is set to 1 (low voltage detection interrupt enable), set the VC27 bit to 1.
- This register does not change at software reset, watchdog timer reset and oscillation stop detection reset.
- The detection circuit does not start operation until td(E-A) elapses after the VC26 bit or VC27 bit is set to 1.

Figure 5.5 VCR1 Register and VCR2 Register

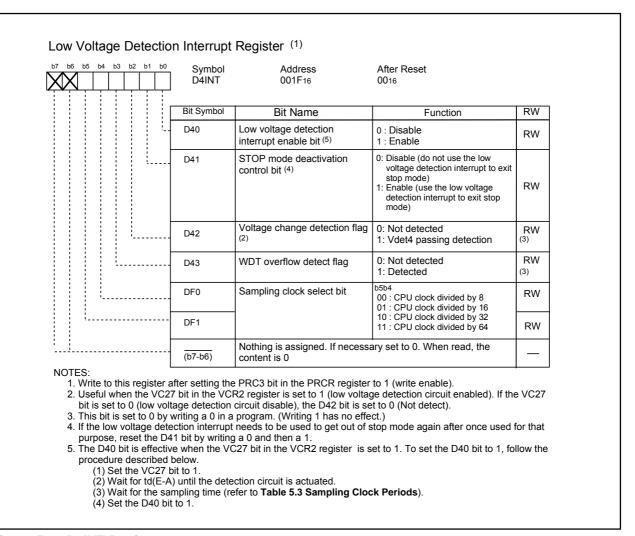


Figure 5.6 D4INT Register

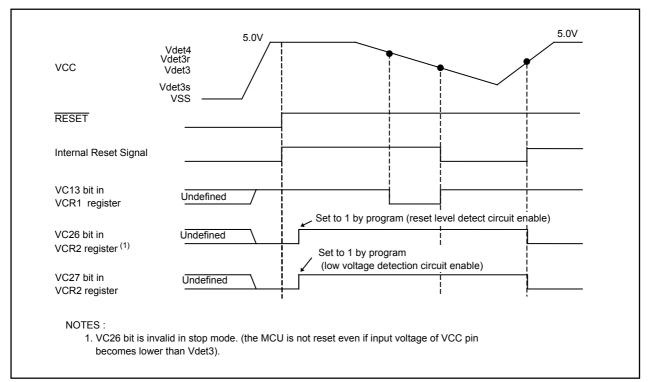


Figure 5.7 Typical Operation of Brown-Out Detection Reset (Hardware Reset 2)

5.5.1 Low Voltage Detection Interrupt

If the D40 bit in the D4INT register is set to 1 (low voltge detection interrupt enabled), a low voltage detection interrupt request is generated when voltage applied to the VCC pin is above or below Vdet4. The low voltage detection interrupt shares the same interrupt vector with watchdog timer interrupt and oscillation stop, re-oscillation detection interrupt.

Set the D41 bit in the D4INT register to 1 (enabled) to use the low voltage detection interrupt to exit stop mode, set the D41 bit in the D4INT register to 1 (enable).

The D42 bit in the D4INT register is set to 1 (above or below Vdet4 detected) as soon as voltage applied to the Vcc pin goes above or below Vdet4 due to the voltage change. When the D42 bit setting changes 0 to 1, a low voltage detection interrupt is generated. Set the D42 bit to 0 (not detected) by program. However, when the D41 bit is set to 1 and the MCU is in stop mode, a low voltage detection interrupt request is generated, regardless of the D42 bit setting, if voltage applies to the Vcc pin is detected to rise above or drop below Vdet4. The MCU then exits stop mode.

Table 5.2 shows how a low voltage detection interrupt request is generated.

Bits DF1 and DF0 in the D4INT register determine sampling period that detects voltage applied to the Vcc pin rises above or drops below Vdet4. **Table 5.3** shows sampling periods.

Table 5.2 Voltage Detection Interrupt Request Generation Conditions

Operation Mode	VC27 bit	D40 bit	D41 bit	D42 bit	CM02 bit	VC13 bit
Normal operation mode(1)			_	0 to 1	_	0 to 1 ⁽³⁾ 1 to 0 ⁽³⁾
Wait mode	1	1		0 to 1	0	0 to 1 (3)
(2)		·			1	0 to 1
Stop mode (2)			1	_	0	0 to 1

– : 0 or 1

NOTES:

- 1. The status except the wait mode and stop mode is handled as the normal mode. (Refer to 7. Clock generating circuit)
- 2. Refer to 5.5.2 Limitations on stop mode and 5.5.3 Limitations on wait mode.
- 3. An interrupt request for voltage reduction is generated a sampling time after the value of the VC13 bit has changed. Refer to the **Figure 5.9** for details.

Table 5.3 Sampling Clock Periods

CPU	Sampling clock (µs)				
clock (MHz)	DF1 to DF0=00 (CPU clock divided by 8)	DF1 to DF0=01 (CPU clock divided by 16)	DF1 to DF0=10 (CPU clock divided by 32)	DF1 to DF0=11 (CPU clock divided by 64)	
16	3.0	6.0	12.0	24.0	

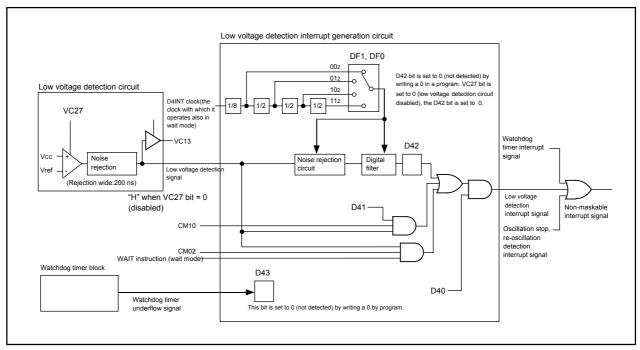


Figure 5.8 Low Voltage Detection Interrupt Generation Block

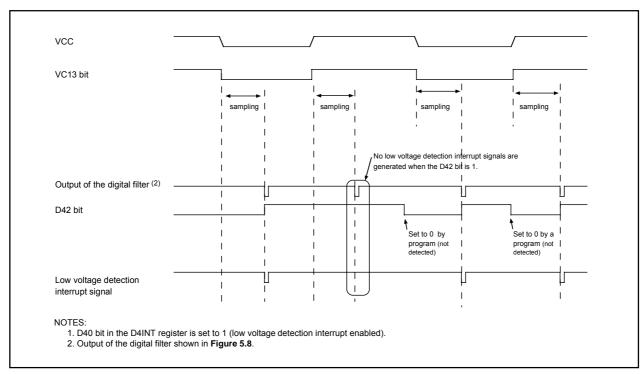


Figure 5.9 Low voltage Detection Interrupt Generation Circuit Operation Example

5.5.2. Limitations on Stop Mode

When all the conditions below are met, the low voltage detection interrupt is generated and the MCU exits stop mode as soon as the CM10 bit in the CM1 register is set to 1 (all clocks stopped).

- the VC27 bit in the VCR2 register is set to 1 (low voltage detection circuit enabled)
- the D40 bit in the D4INT register is set to 1 (low voltage detection interrupt enabled)
- the D41 bit in the D4INT register is set to 1 (low voltage detection interrupt is used to exit stop mode)
- the voltage applied to the VCC pin is higher than Vdet4 (the VC13 bit in the VCR1 register is 1)

Set the CM10 bit to 1 when the VC13 bit is set to set to 0 (Vcc < Vdet4), if the MCU is configured to enter stop mode when voltage applied to the Vcc pin drops Vdet4 or below and to exit stop mode when the voltage applied rises to Vdet4 or above.

5.5.3. Limitations on WAIT Instruction

When all the conditions below are met, the low voltage detection interrupt is generated and the MCU exits wait mode as soon as WAIT instruction is executed.

- the CM02 bit in the CM0 register is set to 1 (stop peripheral function clock)
- the VC27 bit in the VCR2 register is set to 1 (low voltage detection circuit enabled)
- the D40 bit in the D4INT register is set to 1 (low voltage detection interrupt enabled)
- the D41 bit in the D4INT register is set to 1 (low voltage detection interrupt is used to exit wait mode)
- the voltage applied to the Vcc pin is higher than Vdet4 (the VC13 bit in the VCR1 register is 1)

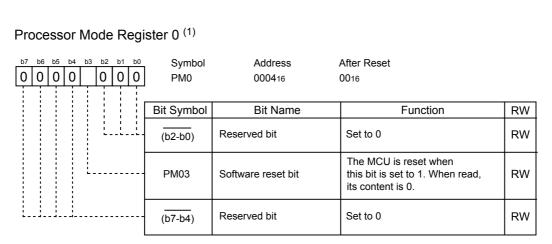
Execute the WAIT instruction when the VC13 bit is set to set to 0 (Vcc < Vdet4), if the MCU is configured to enter wait mode when voltage applied to the Vcc pin drops Vdet4 or below and to exit wait mode when the voltage applied rises to Vdet4 or above.



M16C/29 Group 6. Processor Mode

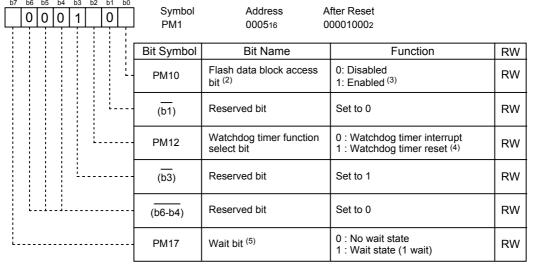
6. Processor Mode

The MCU supports single-chip mode only. Figures 6.1 and 6.2 show the associated registers.



NOTES:

Processor Mode Register 1 (1)



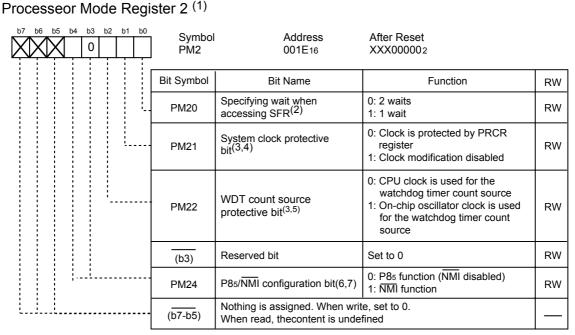
NOTES:

- 1. Rewrite the PM1 register after the PRC1 bit in the PRCR register is set to 1 (write enable).
- 2. To access the two 2K-byte data spaces in data block A and data block B, set the PM10 bit to 1. The PM10 bit is not available in mask version.
- 3. When the FMR01 bit in the FMR0 register is set to 1 (enables CPU rewrite mode), the PM10 bit is automatically set to 1.
- 4. Set the PM12 bit to 1 by program. (Writing 0 by program has no effect)
- 5. When the PM17 bit is set to 1 (wait state), one wait is inserted when accessing the internal RAM or the internal ROM.

Figure 6.1 PM0 Register and PM1 Register

^{1.} Set the PM0 register after the PRC1 bit in the PRCR register is set to 1 (write enable).

M16C/29 Group 6. Processor Mode



NOTES:

- 1. Write to this register after setting the PRC1 bit in the PRCR register to 1 (write enable).
- 2. The PM20 bit becomes effective when PLC07 bit in the PLC0 register is set to 1 (PLL on). Change the PM20 bit when the PLC07 bit is set to 0 (PLL off). Set the PM20 bit to 0 (2 waits) when PLL clock > 16MHz.
- 3. Once this bit is set to 1, it cannot be cleared to 0 by program.
- 4. Writting to the following bits has no effect when the PM21 bit is set to 1:

CM02 bit in the CM0 register

CM05 bit in the CM0 register (main clock is not halted)

CM07 bit in the CM0 register (CPU clock source does not change)

CM10 bit in the CM1 register (stop mode is not entered)

CM11 bit in the CM1 register (CPU clock source does not change)

CM20 bit in the CM2 register (oscillation stop, re-oscillation detection function settings do not change)

All bits in the PLC0 register (PLL frequency synthesizer setting do not change)

Do not execute WAIT instruction when the PM21 bit is set to 1.

- 5. Setting the PM22 bit to 1 results in the following conditions:
 - The on-chip oscillator continues oscillating even if the CM21 bit in the CM2 register is set to "0" (main clock or PLL clock) (system clock of count source selected by the CM21 bit is valid)
 - The on-chip oscillator starts oscillating, and the on-chip oscillator clock becomes the watchdog timer count source.
 - The CM10 bit in the CM1 register cannnot be written. (Writing 1 has no effect, stop mode is not entered.)
 - The watchdog timer does not stop in wait mode.
- 6. For NMI function, the PM24 bit must be set to 1(NMI function). Once this bit is set to 1, it cannot be set to 0 by program.
- 7. SD input is valid regardless of the PM24 setting.

Figure 6.2 PM2 Register

M16C/29 Group 6. Processor Mode

The internal bus consists of CPU bus, memory bus, and peripheral bus. Bus Interface Unit (BIU) is used to interfere with CPU, ROM/RAM, and peripheral functions by controling CPU bus, memory bus, and peripheral bus. **Figure 6.3** shows the block diagram of the internal bus.

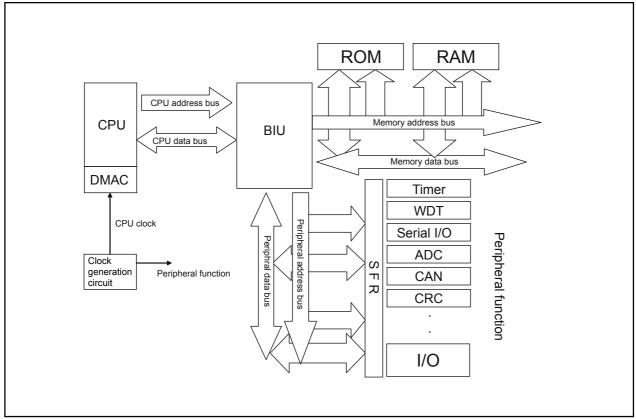


Figure 6.3 Bus Block Diagram

The number of bus cycle varies by the internal bus. Table 6.1 lists the accessible area and bus cycle.

Table 6.1 Accessible Area and Bus Cycle

	Accessible Area	Bus Cycle	
SFR	PM20 bit = 0 (2 waits)	3 CPU clock cycles	
	PM20 bit = 1 (1 wait)	2 CPU clock cycles	
ROM/RAM	PM17 bit = 0 (no wait)	1 CPU clock cycle	
	PM17 bit = 1 (1 wait)	2 CPU clock cycles	

7. Clock Generation Circuit

7. Clock Generation Circuit

The clock generation circuit contains four oscillator circuits as follows:

- (1) Main clock oscillation circuit
- (2) Sub clock oscillation circuit
- (3) Variable on-chip oscillators
- (4) PLL frequency synthesizer

Table 7.1 lists the specifications of the clock generation circuit. **Figure 7.1** shows the clock generation circuit. **Figures 7.2** to **7.7** show clock-associated registers.

Table 7.1 Clock Generation Circuit Specifications

Item	Main Clock Oscillation Circuti	Sub Clock Oscillation Circuit	Variable On-chip Oscillator	PLL Frequency Synthesizer
Use of clock	- CPU clock source - Peripheral function clock source	- CPU clock source - Timer A, B's clock source	 CPU clock source Peripheral function clock source CPU and peripheral function clock sources when the main clock stops oscillating 	- CPU clock source - Peripheral function clock source
Clock frequency	0 to 20 MHz	32.768 kHz	Selectable source frequency: f1(ROC), f2(ROC), f3(ROC) Selectable divider: by 2, by 4, by 8	10 to 20 MHz
Usable oscillator	- Ceramic oscillator - Crystal oscillator	- Crystal oscillator		
Pins to connect oscillator	XIN, XOUT	XCIN, XCOUT		
Oscillation stop, restart function	Available	Available	Available	Available
Oscillator status after reset	Oscillating	Stopped	Oscillating (CPU clock source)	Stopped
Other	Externally derived clo	ock can be input		

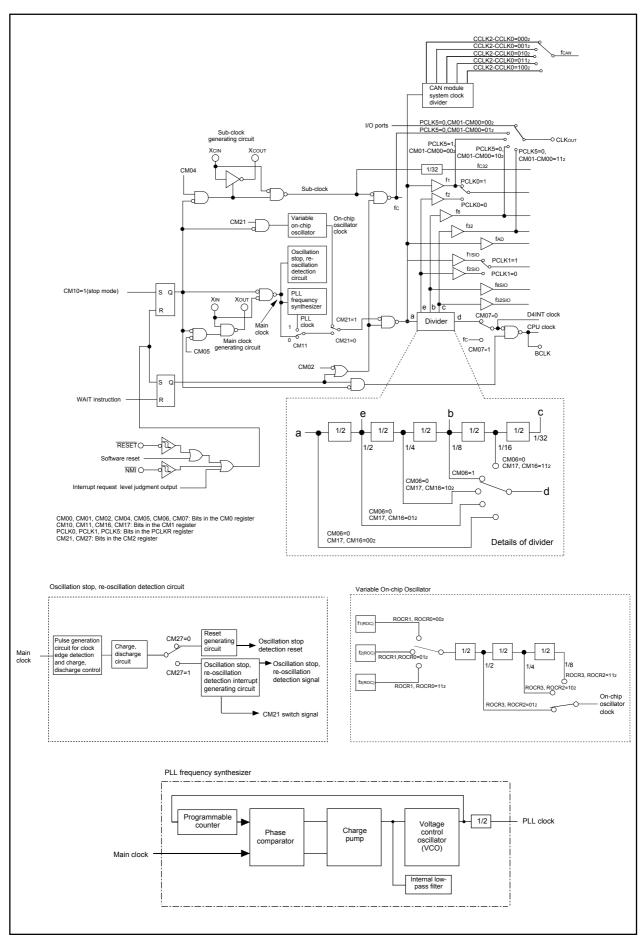
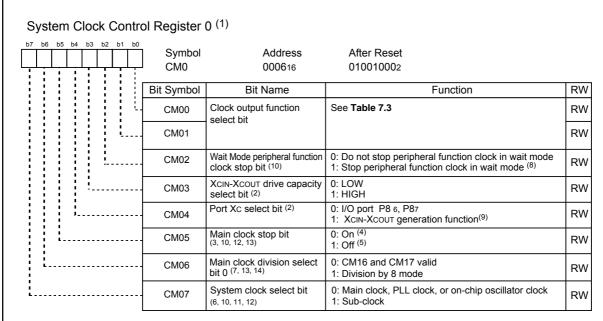
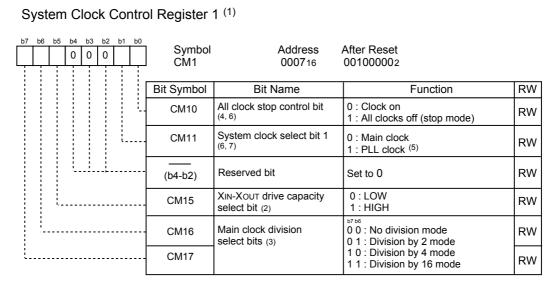


Figure 7.1 Clock Generation Circuit



- 1. Write to this register after setting the PRC0 bit in the PRCR register to 1 (write enable).
- 2. The CM03 bit is set to 1 (high) when the CM04 bit is set to 0 (I/O port) or the MCU goes to a stop mode.
- 3. This bit is provided to stop the main clock when the low power dissipation mode or on-chip oscillator low power dissipation mode is selected. This bit cannot be used for detection as to whether the main clock stopped or not. To stop the main clock, the following setting is required:
 - (1) Set the CM07 bit to 1 (Sub-clock select) or the CM21 bit in the CM2 register to 1 (on-chip oscillator select) with the sub-clock stably oscillating.
 - (2) Set the CM20 bit in the CM2 register to 0 (Oscillation stop, re-oscillation detection function disabled).
 - (3) Set the CM05 bit to 1 (Stop).
- 4. During external clock input, set the CM05 bit to 0 (On).
- 5. When CM05 bit is set to 1, the XOUT pin goes "H". Futhermore, because the internal feedback resistor remains connectes, the XIN pin is pulled "H" to the same level as XOUT via the feedback resistor.
- 6. After setting the CM04 bit to 1 (XCIN-XCOUT oscillator function), wait until the sub-clock oscillates stably before switching the CM07 bit from 0 to 1 (sub-clock).
- 7. When entering stop mode from high or middle speed mode, on-chip oscillator mode or on-chip oscillator low power mode, the CM06 bit is set to 1 (divided-by-8 mode).
- 8. The fc32 clock does not stop. During low speed or low power dissipation mode, do not set this bit to 1(peripheral clock turned off in wait mode).
- 9. To use a sub-clock, set this bit to 1. Also, make sure ports P86 and P87 are directed for input, with no pull-ups.
- When the PM21 bit in the PM2 register is set to 1 (clock modification disable), writing to bits CM02, CM05, and CM07 has no effect.
- 11. If the PM21 bit needs to be set to 1, set the CM07 bit to 0 (main clock) before setting it.
- 12. To use the main clock a the clock source for the CPU clock, follow the procedure below.
 - (1) Set the CM05 bit to 0 (oscillate).
 - (2) Wait the main clock oscillation stabilized
 - (3) Set all bits CM11, CM21, and CM07 to 0.
- 13. When the CM21 bit is set to 0 (on-chip oscillaor turned off) and the CM05 bit is set to 1 (main clock turned off), the CM06 bit is fixed to 1 (divide-by-8 mode) and the CM15 bit is fixed to 1 (drive capability High).
- 14. To return from on-chip oscillator mode to high-speed or middle-speed mode set both bits CM06 and CM15 to 1.

Figure 7.2 CM0 Register



- 1. Write to this register after setting the PRC0 bit in the PRCR register to 1 (write enable).
- 2. When entering stop mode from high or middle speed mode, or when the CM05 bit is set to 1 (main clock turned off) in low speed mode, the CM15 bit is set to 1 (drive capability high).
- 3. Effective when the CM06 bit is 0 (bits CM16 and CM17 enable).
- 4. If the CM10 bit is 1 (stop mode), XOUT goes "H" and the internal feedback resistor is disconnected. The XCIN and XCOUT pins are placed in the high-impedance state. When the CM11 bit is set to 1 (PLL clock), or the CM20 bit in the CM2 register is set to 1 (oscillation stop, re-oscillation detection function enabled), do not set the CM10 bit to 1.
- After setting the PLC07 bit in the PLC0 register to 1 (PLL operation), wait until tsu (PLL) elapses before setting the CM11 bit to 1 (PLL clock).
- 6. When the PM21 bit in the PM2 register is set to 1 (clock modification disable), writing to bits CM10, CM11 has no effect. When the PM22 bit in the PM2 register is set to 1 (watchdog timer count source is on-chip oscillator clock), writing to the CM10 bit has no effect.
- 7. Effective when CM07 bit is 0 and CM21 bit is 0

Figure 7.3 CM1 Register

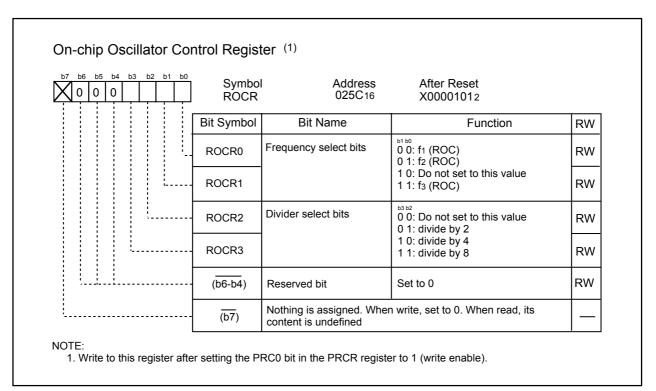
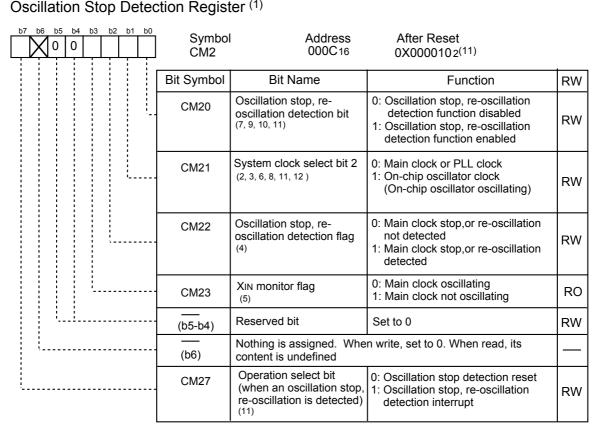


Figure 7.4 ROCR Register



- 1. Write to this register after setting the PRC0 bit in the PRCR register to 1 (write enable).
- 2. When the CM20 bit is 1 (oscillation stop, re-oscillation detection function enabled), the CM27 bit is set to 1 (oscillation stop, re-oscillation detection interrupt), and the CPU clock source is the main clock, the CM21 bit is automatically set to 1 (on-chip oscillator clock) if the main clock stop is detected.
- 3. If the CM20 bit is set to 1 and the CM23 bit is set to 1 (main clock not oscillating), do not set the CM21 bit to 0.
- 4. This flag is set to 1 when the main clock is detected to have stopped or when the main clock is detected to have restarted oscillating. When this flag changes state from 0 to 1, an oscillation stop, reoscillation restart detection interrupt is generated. Use this flag in an interrupt routine to discriminate the causes of interrupts between the oscillation stop, reoscillation detection interrupts and the watchdog timer interrupt. The flag is cleared to 0 by writing 0 by program. (Writing 1 has no effect. Nor is it cleared to 0 by an oscillation stop or an oscillation restart detection interrupt request acknowledged.) If when the CM22 bit is set to 1 an oscillation stoppage or an oscillation restart is detected, no oscillation stop, reoscillation restart detection interrupts are generated.
- 5. Read the CM23 bit in an oscillation stop, re-oscillation detection interrupt handling routine to determine the main clock status
- 6. Effective when the CM07 bit in the CM0 register is set to 0.
- 7. When the PM21 bit in the PM2 register is 1 (clock modification disabled), writing to the CM20 bit has no effect.
- 8. When the CM20 bit is set to 1 (oscillation stop, re-oscillation detection function enabled), the CM27 bit is set 1 (oscillation stop, re-oscillation detection interrupt), and the CM11 bit is 1 (the CPU clock source is PLL clock), the CM21 bit remains unchanged even when main clock stop is detected. If the CM22 bit is set to 0 under these conditions, oscillation stop, re-oscillation detection interrupt occur at main clock stop detection; it is, therefore, necessary to set the CM21 bit to 1 (on-chip oscillator clock) inside the interrupt routine.
- 9. Set the CM20 bit to 0 (disable) before entering stop mode. After exiting stop mode, set the CM20 bit back to 1 (enable).
- 10. Set the CM20 bit to 0 (disable) before setting the CM05 bit in the CM0 register.
- 11. Bits CM20, CM21 and CM27 do not change at oscillation stop detection reset.
- 12. When the CM21 bit is set to 0 (on-chip oscillator turned off) and the CM05 bit is set to 1 (main clock turned off), the CM06 bit is fixed to 1 (divide-by-8 mode) and the CM15 bit is fixed to 1 (drive capability High).

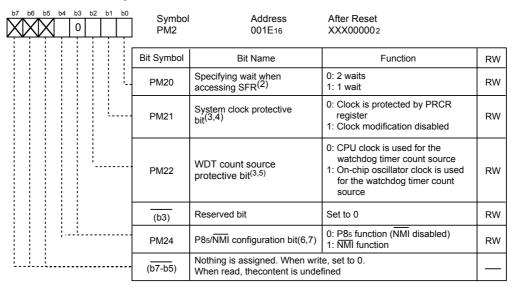
Figure 7.5 CM2 Register



Peripheral Clock Select Register (1) Symbol Address After Reset 0 0 0 0 **PCLKR** 025E₁₆ 000000112 0 Bit Symbol Bit Name Function RW Timers A. B clock select bit (Clock source for the timers A. 0: f2 PCLK0 B, the timer S, the dead timer, RW 1: f1 SI/O3, SI/O4 and multi-master I²C bus) SI/O clock select bit 0: f2SIO PCLK1 (Clock source for UART0 to RW 1: f1SIO UART2) (b4-b2) Reserved bit Set to 0 RW Clock output function PCI K5 Refer to Table 7.3 RW expansion select bit RW Reserved bit Set to 0 (b7-b6)

NOTE

Processeor Mode Register 2 (1)



NOTES:

- 1. Write to this register after setting the PRC1 bit in the PRCR register to 1 (write enable).
- 2. The PM20 bit becomes effective when PLC07 bit in the PLC0 register is set to 1 (PLL on). Change the PM20 bit when the PLC07 bit is set to 0 (PLL off). Set the PM20 bit to 0 (2 waits) when PLL clock > 16MHz.
- 3. Once this bit is set to 1, it cannot be cleared to 0 by program.
- 4. Writting to the following bits has no effect when the PM21 bit is set to 1:

CM02 bit in the CM0 register

CM05 bit in the CM0 register (main clock is not halted)

CM07 bit in the CM0 register (CPU clock source does not change)

CM10 bit in the CM1 register (stop mode is not entered)

CM11 bit in the CM1 register (CPU clock source does not change)

CM20 bit in the CM2 register (oscillation stop, re-oscillation detection function settings do not change)

All bits in the PLC0 register (PLL frequency synthesizer setting do not change)

Do not execute WAIT instruction when the PM21 bit is set to 1.

- 5. Setting the PM22 bit to 1 results in the following conditions:
 - The on-chip oscillator continues oscillating even if the CM21 bit in the CM2 register is set to "0" (main clock or PLL clock) (system clock of count source selected by the CM21 bit is valid)
 - The on-chip oscillator starts oscillating, and the on-chip oscillator clock becomes the watchdog timer count source.
 - The CM10 bit in the CM1 register cannnot be written. (Writing 1 has no effect, stop mode is not entered.)
 - The watchdog timer does not stop in wait mode.
- 6. For NMI function, the PM24 bit must be set to 1(NMI function). Once this bit is set to 1, it cannot be set to 0 by program.
- 7. SD input is valid regardless of the PM24 setting.

Figure 7.6 PCLKR Register and PM2 Register

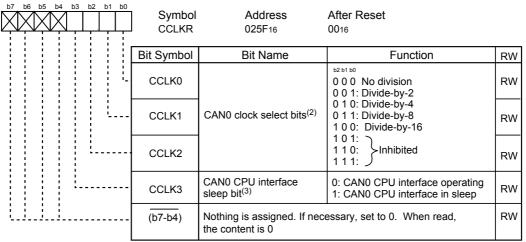
^{1.} Write to this register after setting the PRC0 bit in PRCR register to 1 (write enable).

PLL Control Register 0 (1,2) Symbol Address After Reset 0 0 1 PLC0 0001X0102 001C₁₆ Bit Bit Name **Function** RW b2 b1b0 PLL multiplying factor PLC00 0 0 0: Do not set RW select bit 0 0 1: Multiply by 2 0 1 0: Multiply by 4 PLC01 0 1 1 RW 1 0 0: 1 0 1: Do not set 1 1 0: PLC02 RW 1 1 1: Nothing is assigned. If necessary, set to 0. When read, the content is undefined (b3) Set to 1 RW Reserved bit (b4) Reserved bit Set to 0 RW (b6-b5) 0: PLL Off Operation enable bit (4) PLC07 RW 1: PLL On

NOTES:

- 1. Write to this register after setting the PRC0 bit in the PRCR register to 1 (write enable).
- 2. When the PM21 bit in the PM2 register is 1 (clock modification disable), writing to this register has no effect.
- 3. These three bits can only be modified when the PLC07 bit is set to 0 (PLL turned off). The value once written to this bit cannot be modified.
- 4. Before setting this bit to 1, set the CM07 bit to 0 (main clock), set bits CM17 to CM16 bits to 002 (main clock undivided mode), and set the CM06 bit to 0 (CM16 and CM17 bits enable).





- 1. Write to this register after setting the PRC0 bit in the PRCR register to 1 (write enable).
- Configuration of bits CCLK2 to CCLK0 can be done only when the Reset bit in the C0CTLR register is set to 1 (Reset/Initialization mode).
- Before setting this bit to 1(CAN0 CPU interface in sleep), set the Sleep bit in COCTLR register to 1 (Sleep mode).

Figure 7.7 PLC0 Register and CCLKR register



The following describes the clocks generated by the clock generation circuit.

7.1 Main Clock

The main clock is generated by the main clock oscillation circuit. This clock is used as the clock source for the CPU and peripheral function clocks. The main clock oscillator circuit is configured by connecting a resonator between the XIN and XOUT pins. The main clock oscillator circuit contains a feedback resistor, which is disconnected from the oscillator circuit during stop mode in order to reduce the amount of power consumed in the chip. The main clock oscillator circuit may also be configured by feeding an exter nally generated clock to the XIN pin. **Figure 7.8** shows the examples of main clock connection circuit.

The power consumption in the chip can be reduced by setting the CM05 bit in the CM0 register to 1 (main clock oscillator circuit turned off) after switching the clock source for the CPU clock to a sub clock or on-chip oscillator clock. In this case, XOUT goes "H". Furthermore, because the internal feedback resistor remains on, XIN is pulled "H" to XOUT via the feedback resistor.

During stop mode, all clocks including the main clock are turned off. Refer to "power control".

If the main clock is not used, it is recommended to connect the XIN pin to VCC to reduce power consumption during reset.

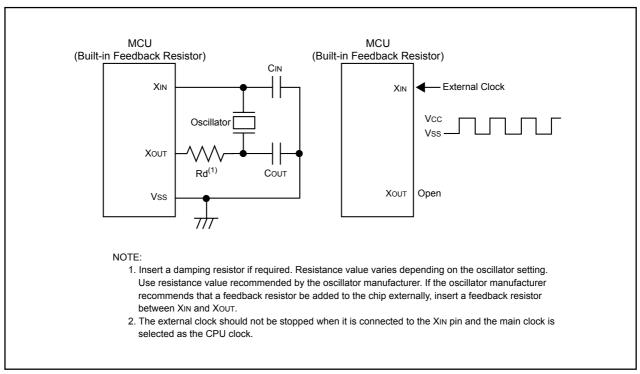


Figure 7.8 Examples of Main Clock Connection Circuit

7. Clock Generation Circuit

7.2 Sub Clock

The sub clock is generated by the sub clock oscillation circuit. This clock is used as the clock source for the CPU clock, as well as the timer A and timer B count sources.

The sub clock oscillator circuit is configured by connecting a crystal resonator between the XCIN and XCOUT pins. The sub clock oscillator circuit contains a feedback resistor, which is disconnected from the oscillator circuit during stop mode in order to reduce the amount of power consumed in the chip. The sub clock oscillator circuit may also be configured by feeding an externally generated clock to the XCIN pin. **Figure 7.9** shows the examples of sub clock connection circuit.

After reset, the sub clock is turned off. At this time, the feedback resistor is disconnected from the oscillator circuit

To use the sub clock for the CPU clock, set the CM07 bit in the CM0 register to 1 (sub clock) after the sub clock becomes oscillating stably.

During stop mode, all clocks including the sub clock are turned off. Refer to "power control".

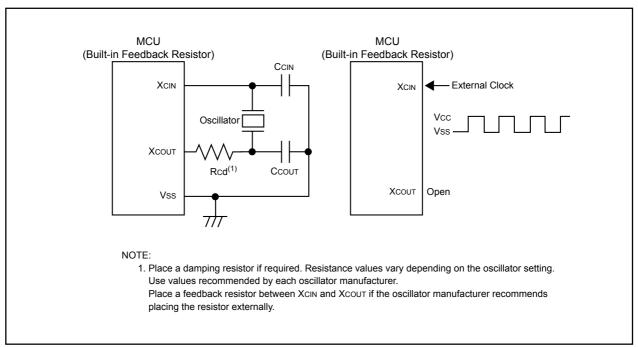


Figure 7.9 Examples of Sub Clock Connection Circuit

M16C/29 Group 7. Clock Generation Circuit

7.3 On-chip Oscillator Clock

This clock is supplied by a variable on-chip oscillator. This clock is used as the clock source for the CPU and peripheral function clocks. In addition, if the PM22 bit in the PM2 register is 1 (on-chip oscillator clock for the watchdog timer count source), this clock is used as the count source for the watchdog timer (Refer to 10. Watchdog Timer • Count source protective mode").

After reset, the on-chip oscillator clock divided by 16 is used for the CPU clock. It can also be turned on by setting the CM21 bit in the CM2 register to 1 (on-chip oscillator clock), and is used as the clock source for the CPU and peripheral function clocks. If the main clock stops oscillating when the CM20 bit in the CM2 register is 1 (oscillation stop, re-oscillation detection function enabled) and the CM27 bit is 1 (oscillation stop, re-oscillation detection interrupt), the on-chip oscillator automatically starts operating, supplying the necessary clock for the MCU.

7.4 PLL Clock

The PLL clock is generated from the main clock by a PLL frequency synthesizer. This clock is used as the clock source for the CPU and peripheral function clocks. After reset, the PLL clock is turned off. The PLL frequency synthesizer is activated by setting the PLC07 bit to 1 (PLL operation). When the PLL clock is used as the clock source for the CPU clock, wait tsu(PLL) for the PLL clock to be stable, and then set the CM11 bit in the CM1 register to 1.

Before entering wait mode or stop mode, be sure to set the CM11 bit to 0 (CPU clock source is the main clock). Furthermore, before entering stop mode, be sure to set the PLC07 bit in the PLC0 register to 0 (PLL stops). **Figure 7.10** shows the procedure for using the PLL clock as the clock source for the CPU.

The PLL clock frequency is determined by the equation below.

PLL clock frequency=f(XIN) X (multiplying factor set by bits PLC02 to PLC00 in the PLC0 register (However, 10 MHz ≤ PLL clock frequency ≤ 20 MHz)

Bits PLC02 to PLC00 can be set only once after reset. **Table 7.2** shows the example for setting PLL clock frequencies.

Table 7.2 Example for Setting PLL Clock Frequencies

XIN (MHz)	PLC02	PLC01	PLC00	Multiplying factor	PLL clock (MHz) ⁽¹⁾
10	0	0	1	2	00
5	0	1	0	4	20

NOTE:

1. 10MHz ≤ PLL clock frequency ≤ 20MHz.



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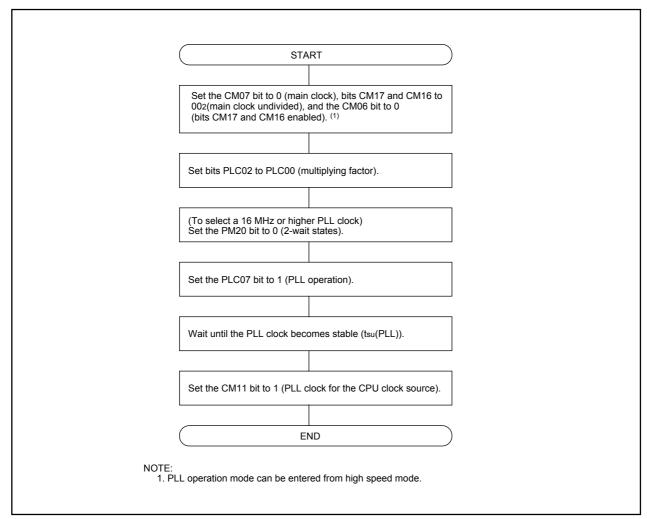


Figure 7.10 Procedure to Use PLL Clock as CPU Clock Source

7. Clock Generation Circuit

7.5 CPU Clock and Peripheral Function Clock

The CPU clock is used to operate the CPU and peripheral function clocks are used to operate the peripheral functions.

7.5.1 CPU Clock

This is the operating clock for the CPU and watchdog timer.

The clock source for the CPU clock can be chosen to be the main clock, sub clock, on-chip oscillator clock or the PLL clock.

If the main clock or on-chip oscillator clock is selected as the clock source for the CPU clock, the selected clock source can be divided by 1 (undivided), 2, 4, 8 or 16 to produce the CPU clock. Use the CM06 bit in CM0 register and bits CM17 to CM16 in CM1 register to select the divide-by-n value.

When the PLL clock is selected as the clock source for the CPU clock, the CM06 bit should be set to 0 and bits CM17 and CM16 to 002 (undivided).

After reset, the on-chip oscillator clock divided by 16 provides the CPU clock.

Note that when entering stop mode from high or middle speed mode, on-chip oscillator mode or on-chip oscillator low power dissipation mode, or when the CM05 bit in the CM0 register is set to 1 (main clock turned off) in low-speed mode, the CM06 bit in the CM0 register is set to 1 (divide-by-8 mode).

7.5.2 Peripheral Function Clock(f1, f2, f8, f32, f1SIO, f2SIO, f8SIO, f32SIO, fAD, fC32, fCAN0)

These are operating clocks for the peripheral functions.

Of these, fi (i = 1, 2, 8, 32) and fisio are derived from the main clock, PLL clock, or on-chip oscillator clock divided by i. The clock fi is used for Timer A, Timer B, SI/O3 and SI/O4 while fiSIO is used for UART0 to UART2. Additionally, the f1 and f2 clocks are also used for dead time timer, Timer S, multi-master I²C bus. The fAD clock is produced from the main clock, PLL clock or on-chip oscillator clock, and is used for the A/D converter.

The fCAN0 clock is derived from the main clock, PLL clock or on-chip oscillator clock devided by 1 (undivided), 2, 4, 8, or 16, and is used for the CAN module.

When the WAIT instruction is executed after setting the CM02 bit in the CM0 register to 1 (peripheral function clock turned off during wait mode), or when the MCU is in low power dissipation mode, the fi, fisio, fAD, and fCAN0 clocks are turned off. (Note 1)

The fc32 clock is produced from the sub clock, and is used for timers A and B. This clock can only be used when the sub clock is on.

Note 1: fCAN0 clock stops at "H" in CAN0 sleep mode.

7.5.3 ClockOutput Function

The f₁, f₈, f₃₂ or f_C clock can be output from the CLK_{OUT} pin. Use the PCLK₅ bit in the PCLK_R register and bits CM₀₁ to CM₀₀ in the CM₀ register to select. **Table 7.3** shows the function of the CLK_{OUT} pin.

Table 7.3 The function of the CLKout pin

PCLK5	CM01	CM00	The function of the CLKout pin
0	0	0	I/O port P90
0	0	1	fc
0	1	0	f8
0	1	1	f32
1	0	0	f1
1	0	1	Do not set
1	1	0	Do not set
1	1	1	Do not set



7.6 Power Control

There are three power control modes. In this chapter, all modes other than wait and stop modes are referred to as normal operation mode.

7.6.1 Normal Operation Mode

Normal operation mode is further classified into seven modes.

In normal operation mode, because the CPU clock and the peripheral function clocks both are on, the CPU and the peripheral functions are operating. Power control is exercised by controlling the CPU clock frequency. The higher the CPU clock frequency, the greater the processing capability. The lower the CPU clock frequency, the smaller the power consumption in the chip. If the unnecessary oscillator circuits are turned off, the power consumption is further reduced.

Before the clock sources for the CPU clock can be switched over, the new clock source must be in stable oscillation. If the new clock source is the main clock, sub clock or PLL clock, allow a sufficient wait time in a program until it becomes oscillating stably.

Note that operation modes cannot be changed directly from low power dissipation mode to on-chip oscillator mode or on-chip oscillator low power dissipation mode. Nor can operation modes be changed directly from on-chip oscillator mode or on-chip oscillator low power dissipation mode to low power dissipation mode.

When the CPU clock source is changed from the on-chip oscillator to the main clock, change the operation mode to the medium speed mode (divided by 8 mode) after the clock was divided by 8 (the CM06 bit in the CM0 register was set to 1) in the on-chip oscillator mode.

7.6.1.1 High-speed Mode

The main clock divided by 1 provides the CPU clock. If the sub clock is on, fc32 can be used as the count source for timers A and B.

7.6.1.2 PLL Operation Mode

The main clock multiplied by 2 or 4 provides the PLL clock, and this PLL clock serves as the CPU clock. If the sub clock is on, fc32 can be used as the count source for timers A and B. PLL operation mode can be entered from high speed mode. If PLL operation mode is to be changed to wait or stop mode, first go to high speed mode before changing.

7.6.1.3 Medium-speed Mode

The main clock divided by 2, 4, 8 or 16 provides the CPU clock. If the sub clock is on, fC32 can be used as the count source for timers A and B.

7.6.1.4 Low-speed Mode

The sub clock provides the CPU clock. The main clock is used as the clock source for the peripheral function clock when the CM21 bit is set to 0 (on-chip oscillator turned off), and the on-chip oscillator clock is used when the CM21 bit is set to 1 (on-chip oscillator oscillating).

The fc32 clock can be used as the count source for timers A and B.

7.6.1.5 Low Power Dissipation Mode

In this mode, the main clock is turned off after being placed in low speed mode. The sub clock provides the CPU clock. The fc32 clock can be used as the count source for timers A and B. Peripheral function clock can use only fc32.

Simultaneously when this mode is selected, the CM06 bit in the CM0 register becomes 1 (divided by 8 mode). In the low power dissipation mode, do not change the CM06 bit. Consequently, the medium speed (divided by 8) mode is to be selected when the main clock is operated next.



7.6.1.6 On-chip Oscillator Mode

The selected on-chip oscillator clock divided by 1 (undivided), 2, 4, 8 or 16 provides the CPU clock. The on-chip oscillator clock is also the clock source for the peripheral function clocks. If the sub clock is on, fc32 can be used as the count source for timers A and B. The on-chip oscillator frequency can be selected by bits ROCR3 to ROCR0 in the ROCR register. When the operation mode is returned to the high and medium speed modes, set the CM06 bit to 1 (divided by 8 mode).

7.6.1.7 On-chip Oscillator Low Power Dissipation Mode

The main clock is turned off after being placed in on-chip oscillator mode. The CPU clock can be selected as in the on-chip oscillator mode. The on-chip oscillator clock is the clock source for the peripheral function clocks. If the sub clock is on, fc32 can be used as the count source for timers A and B.

Table 7.4 Setting Clock Related Bit and Modes

Modes		CM2 Register	CN	//1 Register		CM0 Re	egister	
		CM21	CM11	CM17, CM16	CM07	CM06	CM05	CM04
PLL operati	on mode	0	1	002	0	0	0	
High-speed	l mode	0	0	002	0	0	0	
Medium-	divided by 2	0	0	012	0	0	0	
speed	divided by 4	0	0	102	0	0	0	
mode	divided by 8	0	0		0	1	0	
	divided by 16	0	0	112	0	0	0	
Low-speed i	mode				1		0	1
Low power	dissipation mode	_			1	1 ⁽¹⁾	1 ⁽¹⁾	1
	divided by 1	1		002	0	0	0	
On-chip	divided by 2	1		012	0	0	0	
oscillator mode(3)	divided by 4	1		102	0	0	0	
mode(3)	divided by 8	1		-	0	1	0	
	divided by 16	1	_	112	0	0	0	
On-chip oscillator low power dissipation mode		1		(2)	0	(2)	1	

NOTES:

- 1. When the CM05 bit is set to 1 (main clock turned off) in low-speed mode, the mode goes to low power dissipation mode and CM06 bit is set to 1(divided by 8 mode) simultaneously.
- 2. The divide-by-n value can be selected the same way as in on-chip oscillator mode.
- 3. On-chip oscillator frequency can be any of those described in the section 7.6.1.6 On-chip Oscillator Mode.

7.6.2 Wait Mode

In wait mode, the CPU clock is turned off, so are the CPU (because operated by the CPU clock) and the watchdog timer. However, if the PM22 bit in the PM2 register is 1 (on-chip oscillator clock for the watchdog timer count source), the watchdog timer remains active. Because the main clock, sub clock, on-chip oscillator clock and PLL clock all are on, the peripheral functions using these clocks keep operating.

7.6.2.1 Peripheral Function Clock Stop Function

When the CM02 bit is 1 (peripheral function clocks turned off during wait mode), f1, f2, f8, f32, f1SIO, f2SIO, f8SIO, f32SIO, and fAD stop running in wait mode to reduce power consumption. However, fC32 remains active.

7.6.2.2 Entering Wait Mode

The MCU enters wait mode by executing the WAIT instruction.

When the CM11 bit is set to 1 (CPU clock source is the PLL clock), be sure to clear the CM11 bit to 0 (CPU clock source is the main clock) before going to wait mode. The power consumption of the chip can be reduced by clearing the PLC07 bit to 0 (PLL stops).



7.6.2.3 Pin Status During Wait Mode

Table 7.5 lists pin status during wait mode.

Table 7.5 Pin Status in Wait Mode

Pin		Status
I/O ports		Retains status before wait mode
	When fC selected	Does not stop
CLKout	When f1, f8, f32 selected	Does not stop when the CM02 bit is set to 0
		Retains status before wait mode when the CM02 bit is set to 1

7.6.2.4 Exiting Wait Mode

The MCU exits from wait mode by a hardware reset, $\overline{\text{NMI}}$ interrupt, or peripheral function interrupt. If wait mode is exited by a hardware reset or $\overline{\text{NMI}}$ interrupt, set the peripheral function interrupt priority bits ILVL2 to ILVL0 to 0002 (interrupts disabled) before executing the WAIT instruction.

The CM02 bit affects the peripheral function interrupts. If the CM02 bit is 0 (peripheral function clocks not turned off during wait mode), all peripheral function interrupts can be used to exit wait mode. If the CM02 bit is 1 (peripheral function clock stops during wait mode), the peripheral functions using the peripheral function clock stops operating, so that only the peripheral functions clocked by external signals can be used to exit wait mode.

Table 7.6 lists the interrupts to exit wait mode.

Table 7.6 Interrupts to Exit Wait Mode

Interrupt	CM02 = 0	CM02 = 1
NMI interrupt	Available	Available
Serial I/O interrupt	Available when internal and external	Available when external clock is used
	clocks are used	
Multi-master I ² C interrupt	Available	Do not used
Key input interrupt	Available	Available
A/D conversion interrupt	Available in one-shot or single sweep	Do not use
	mode	
Timer A interrupt Timer B interrupt	Available in all modes	Available in event counter mode or when count source is fC32
Timer S interrupt	Available in all modes	Do not use
INT interrupt	Available	Available
CAN0 wake_up interrupt	Available in CAN sleep mode	Available in CAN sleep mode

To use peripheral function interrupts to exit wait mode, set the followings before executing the WAIT instruction.

- 1. Set the interrupt priority level to the bits ILVL2 to ILVL0 in the interrupt control register of the peripheral function interrupts that are used to exit wait mode. Also, set bits ILVL2 to ILVL0 of all peripheral function interrupts that are not used to exit wait mode to 0002 (interrupt disabled).
- 2. Set the I flag to 1.
- 3. Operate the peripheral functions that are used to exit wait mode.

When the peripheral function interrupts are used to exit wait mode, an interrupt routine is executed after an interrupt request is generated and the CPU is clocked.

The CPU clock used when exiting wait mode by a peripheral function interrupt is the same CPU clock that is used when executing the WAIT instruction.



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7.6.3 Stop Mode

In stop mode, all oscillator circuits are turned off, so are the CPU clock and the peripheral function clocks. Therefore, the CPU and the peripheral functions clocked by these clocks stop operating. The least amount of power is consumed in this mode. If the voltage applied to Vcc pin is VRAM or more, the internal RAM is retained. When applying 2.7 or less voltage to Vcc pin, make sure Vcc≥VRAM.

However, the peripheral functions clocked by external signals keep operating. The following interrupts can be used to exit stop mode.

- NMI interrupt
- Key interrupt
- INT interrupt
- Timer A, Timer B interrupt (when counting external pulses in event counter mode)
- Serial I/O interrupt (when external clock is selected)
- Low voltage detection interrup (refer to "Low Voltage Detection Interrupt" for an operating condition)
- CAN0 Wake_up interrupt (in CAN sleep mode)

7.6.3.1 Entering Stop Mode

The MCU is placed into stop mode by setting the CM10 bit in the CM1 register to 1 (all clocks turned off). At the same time, the CM06 bit in the CM0 register is set to 1 (divide-by-8 mode) and the CM15 bit in the CM10 register is set to 1 (main clock oscillator circuit drive capability high).

Before entering stop mode, set the CM20 bit to 0 (oscillation stop, re-oscillation detection function disable).

Also, if the CM11 bit is 1 (PLL clock for the CPU clock source), set the CM11 bit to 0 (main clock for the CPU clock source) and the PLC07 bit to 0 (PLL turned off) before entering stop mode.

7.6.3.2 Pin Status during Stop Mode

The I/O pins retain their status held just prior to entering stop mode.

7.6.3.3 Exiting Stop Mode

The MCU is moved out of stop mode by a hardware reset, $\overline{\text{NMI}}$ interrupt or peripheral function interrupt. If the MCU is to be moved out of stop mode by a hardware reset or $\overline{\text{NMI}}$ interrupt, set the peripheral function interrupt priority bits ILVL2 to ILVL0 to 0002 (interrupts disable) before setting the CM10 bit to 1. If the MCU is to be moved out of stop mode by a peripheral function interrupt, set up the following before setting the CM10 bit to 1.

- 1. In bits ILVL2 to ILVL0 of the interrupt control register, set the interrupt priority level of the peripheral function interrupt to be used to exit stop mode.
 - Also, for all of the peripheral function interrupts not used to exit stop mode, set bits ILVL2 to ILVL0 to 0002.
- 2. Set the I flag to 1.
- Enable the peripheral function whose interrupt is to be used to exit stop mode.
 In this case, when an interrupt request is generated and the CPU clock is thereby turned on, an interrupt service routine is executed.

Which CPU clock will be used after exiting stop mode by a peripheral function or $\overline{\text{NMI}}$ interrupt is determined by the CPU clock that was on when the MCU was placed into stop mode as follows:

If the CPU clock before entering stop mode was derived from the sub clock: sub clock

If the CPU clock before entering stop mode was derived from the main clock: main clock divide-by-8 If the CPU clock before entering stop mode was derived from the on-chip oscillator clock: on-chip oscillator clock divide-by-8



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Figure 7.11 shows the state transition from normal operation mode to stop mode and wait mode. **Figure 7.12** shows the state transition in normal operation mode.

Table 7.7 shows a state transition matrix describing allowed transition and setting. The vertical line shows current state and horizontal line shows state after transition.

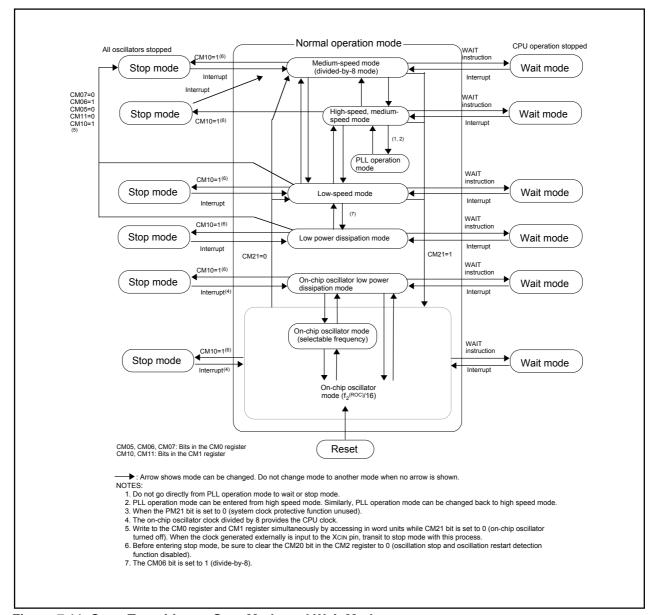


Figure 7.11 State Transition to Stop Mode and Wait Mode

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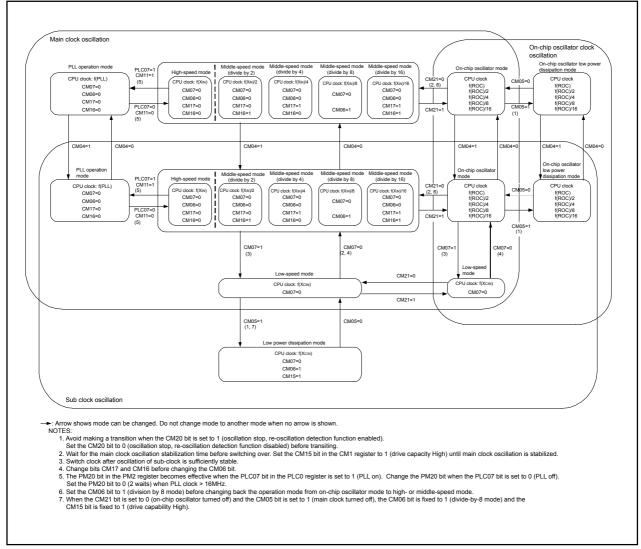


Figure 7.12 State Transition in Normal Mode

--: Cannot transit

Table 7.7 Allowed Transition and Setting

			State after transition								
		High-speed mode, middle-speed mode	Low-speed mode ²	Low power dissipation mode	PLL operation mode ²	On-chip oscillator mode	On-chip oscillator low power dissipation mode	Stop mode	Wait mode		
	High-speed mode, middle-speed mode	8	(9) ⁷		(13) ³	(15)		(16) ¹	(17)		
	Low-speed mode ²	(8)		(11)1, 6		(8)		(16) ¹	(17)		
ate	Low power dissipation mode		(10)					(16) ¹	(17)		
Current state	PLL operation mode ²	(12) ³									
Curre	On-chip oscillator mode	(14) ⁴	(9)7			8	(11) ¹	(16) ¹	(17)		
	On-chip oscillator low power dissipation mode					(10)	8	(16) ¹	(17)		
	Stop mode	(18) ⁵	(18)	(18)		(18) ⁵	(18) ⁵				
	Wait mode	(18)	(18)	(18)		(18)	(18)				

--: Cannot transit

Avoid making a transition when the CM20 bit is set to 1 (oscillation stop, re-oscillation detection function enabled).

Avoid making a transition when the CM20 bit is set to 1 (oscillation stop, re-oscillation detection function enabled).
 Set the CM20 bit to 0 (oscillation stop, re-oscillation detection function disabled) before transiting.
 On-chip oscillator clock oscillates and stops in low-speed mode. In this mode, the on-chip oscillator can be used as peripheral function clock. Sub clock oscillates and stops in PLL operation mode. In this mode, sub clock can be used as a clock for the timers A and B.
 PLL operation mode can only be entered from and changed to high-speed mode.
 Set the CM06 bit to 1 (division by 8 mode) before transiting from on-chip oscillator mode to high- or middle-speed mode.
 When exiting stop mode, the CM06 bit is set to 1 (division by 8 mode).
 If the CM05 bit is set to 1 (main clock stop), then the CM06 bit is set to 1 (division by 8 mode).
 A transition can be made only when sub clock is oscillating.
 State transitions within the same mode (divide-by-n values changed or subclock oscillation turned on or off) are shown in the table below.

			Sub clock oscillating					Sub clock turned off			
		No division	Divided by 2	Divided by 4	Divided by 8	Divided by 16	No division	Divided by 2	Divided by 4	Divided by 8	Divided by 16
	No division		(4)	(5)	(7)	(6)	(1)				
×ο	Divided by 2	(3)		(5)	(7)	(6)		(1)			
clock	Divided by 4	(3)	(4)		(7)	(6)			(1)		
Sub clock oscillating	Divided by 8	(3)	(4)	(5)		(6)				(1)	
"	Divided by 16	(3)	(4)	(5)	(7)						(1)
	No division	(2)						(4)	(5)	(7)	(6)
dock ed off	Divided by 2		(2)				(3)	/	(5)	(7)	(6)
	Divided by 4			(2)			(3)	(4)		(7)	(6)
Sub	Divided by 8				(2)		(3)	(4)	(5)		(6)
	Divided by 16				-	(2)	(3)	(4)	(5)	(7)	

Operation

Setting

Operation	
clock turned off	CM04, CM05, CM06, CM07 : Bits in the CM0 regi CM10, CM11, CM16, CM17 : Bits in the CM1 regi
clock oscillating	CM20, CM21 : Bits in the CM2 reging PLC07 : Bit in the PLC0 region PLC07 : Bit in the PLC0 region PLC07 : Bit in the CM2 region PLC07 : Bit in the PLC07 : Bi
clock no division mode	
clock division by 2 mode	
clock division by 4 mode	
clock division by 16 mode	
clock division by 8 mode	
clock, PLL clock,	

	Setting	Operation
(1)	CM04 = 0	Sub clock turned off
(2)	CM04 = 1	Sub clock oscillating
(3)	CM06 = 0, CM17 = 0 , CM16 = 0	CPU clock no division mode
(4)	CM06 = 0, CM17 = 0 , CM16 = 1	CPU clock division by 2 mode
(5)	CM06 = 0, CM17 = 1 , CM16 = 0	CPU clock division by 4 mode
(6)	CM06 = 0, CM17 = 1 , CM16 = 1	CPU clock division by 16 mode
(7)	CM06 = 1	CPU clock division by 8 mode
(8)	CM07 = 0	Main clock, PLL clock, or on-chip oscillator clock selected
(9)	CM07 = 1	Sub clock selected
(10)	CM05 = 0	Main clock oscillating
(11)	CM05 = 1	Main clock turned off
(12)	PLC07 = 0, CM11 = 0	Main clock selected
(13)	PLC07 = 1, CM11 = 1	PLL clock selected
(14)	CM21 = 0	Main clock or PLL clock selected
(15)	CM21 = 1	On-chip oscillator clock selected
(16)	CM10 = 1	Transition to stop mode
(17)	wait instruction	Transition to wait mode
(18)	Hardware interrupt	Exit stop mode or wait mode

^{9. ():} setting method. Refer to following table.

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7.7 System Clock Protective Function

When the main clock is selected for the CPU clock source, this function protects the clock from modifications in order to prevent the CPU clock from becoming halted by run-away.

If the PM21 bit in the PM2 register is set to 1 (clock modification disabled), the following bits are protected against writes:

- Bits CM02, CM05, and CM07 in CM0 register
- Bits CM10 and CM11 in CM1 register
- CM20 bit in CM2 register
- · All bits in the PLC0 register

Before the system clock protective function can be used, the following register settings must be made while the CM05 bit in the CM0 register is 0 (main clock oscillating) and CM07 bit is 0 (main clock selected for the CPU clock source):

- (1) Set the PRC1 bit in the PRCR register to 1 (enable writes to PM2 register).
- (2) Set the PM21 bit in the PM2 register to 1 (disable clock modification).
- (3) Set the PRC1 bit in the PRCR register to 0 (disable writes to PM2 register).

Do not execute the WAIT instruction when the PM21 bit is 1.

7.8 Oscillation Stop and Re-oscillation Detect Function

The oscillation stop and re-oscillation detect function detects the re-oscillation after stop of main clock oscillation circuit. When the oscillation stop and re-oscillation detection occurs, the oscillation stop detect function is reset or oscillation stop and re-oscillation detection interrupt is generated, depending on the CM27 bit set in the CM2 register. The oscillation stop detect function is enabled or disabled by the CM20 bit in the CM2 register. **Table 7.8** lists a specification overview of the oscillation stop and re-oscillation detect function.

Table 7.8 Specification Overview of Oscillation Stop and Re-oscillation Detect Function

Item	Specification
Oscillation stop detectable clock and	$f(X_{IN}) \ge 2 \text{ MHz}$
frequency bandwidth	
Enabling condition for oscillation stop,	Set CM20 bit to 1(enable)
re-oscillation detection function	
Operation at oscillation stop,	•Reset occurs (when CM27 bit =0)
re-oscillation detection	Oscillation stop, re-oscillation detection interrupt occurs(when CM27 bit =1)



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7.8.1 Operation When CM27 bit = 0 (Oscillation Stop Detection Reset)

When main clock stop is detected when the CM20 bit is 1 (oscillation stop, re-oscillation detection function enabled), the MCU is initialized, coming to a halt (oscillation stop reset; refer to "SFR", "Reset"). This status is reset with hardware reset 1. Also, even when re-oscillation is detected, the MCU can be initialized and stopped; it is, however, necessary to avoid such usage. (During main clock stop, do not set the CM20 bit to 1 and the CM27 bit to 0.)

7.8.2 Operation When CM27 bit = 1 (Oscillation Stop and Re-oscillation Detect Interrupt)

When the main clock corresponds to the CPU clock source and the CM20 bit is 1 (oscillation stop and reoscillation detect function enabled), the system is placed in the following state if the main clock comes to a halt:

- Oscillation stop and re-oscillation detect interrupt request occurs.
- The on-chip oscillator starts oscillation, and the on-chip oscillator clock becomes the CPU clock and clock

source for peripheral functions in place of the main clock.

- CM21 bit = 1 (on-chip oscillator clock for CPU clock source)
- CM22 bit = 1 (main clock stop detected)
- CM23 bit = 1 (main clock stopped)

When the PLL clock corresponds to the CPU clock source and the CM20 bit is 1, the system is placed in the following state if the main clock comes to a halt: Since the CM21 bit remains unchanged, set it to 1 (on-chip oscillator clock) inside the interrupt routine.

- Oscillation stop and re-oscillation detect interrupt request occurs.
- CM22 bit = 1 (main clock stop detected)
- CM23 bit = 1 (main clock stopped)
- CM21 bit remains unchanged

When the CM20 bit is 1, the system is placed in the following state if the main clock re-oscillates from the stop condition:

- Oscillation stop and re-oscillation detect interrupt request occurs.
- CM22 bit = 1 (main clock re-oscillation detected)
- CM23 bit = 0 (main clock oscillation)
- CM21 bit remains unchanged



7.8.3 How to Use Oscillation Stop and Re-oscillation Detect Function

- The oscillation stop and re-oscillation detect interrupt shares the vector with the watchdog timer interrupt. If the oscillation stop, re-oscillation detection and watchdog timer interrupts both are used, read the CM22 bit in an interrupt routine to determine which interrupt source is requesting the interrupt.
- Where the main clock re-oscillated after oscillation stop, return the main clock to the CPU clock and peripheral function clock source by program. Figure 7.13 shows the procedure for switching the clock source from the on-chip oscillator to the main clock.
- Simultaneously with oscillation stop, re-oscillation detection interrupt occurrence, the CM22 bit becomes 1. When the CM22 bit is set at 1, oscillation stop, re-oscillation detection interrupt are disabled. By setting the CM22 bit to 0 by program, oscillation stop, re-oscillation detection interrupt are enabled.
- If the main clock stops during low speed mode where the CM20 bit is 1, an oscillation stop, re-oscillation detection interrupt request is generated. At the same time, the on-chip oscillator starts oscillating. In this case, although the CPU clock is derived from the sub clock as it was before the interrupt occurred, the peripheral function clocks now are derived from the on-chip oscillator clock.
- To enter wait mode while using the oscillation stop, re-oscillation detection function, set the CM02 bit to 0 (peripheral function clocks not turned off during wait mode).
- Since the oscillation stop, re-oscillation detection function is provided in preparation for main clock stop due to external factors, set the CM20 bit to 0 (Oscillation stop, re-oscillation detection function disabled) where the main clock is stopped or oscillated by program, that is where the stop mode is selected or the CM05 bit is altered.
- This function cannot be used if the main clock frequency is 2 MHz or less. In that case, set the CM20 bit to 0.

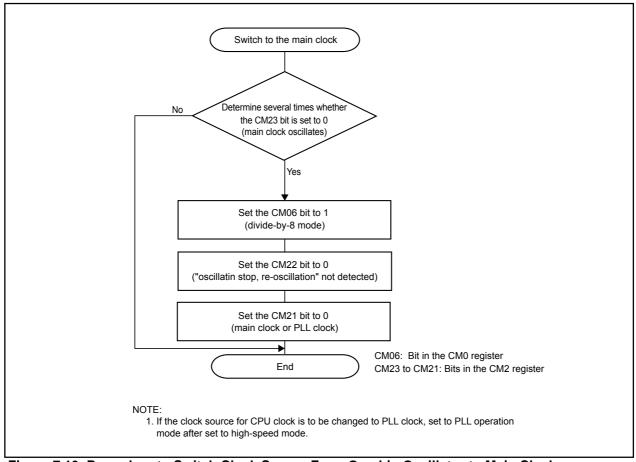


Figure 7.13 Procedure to Switch Clock Source From On-chip Oscillator to Main Clock

M16C/29 Group 8. Protection

8. Protection

In the event that a program runs out of control, this function protects the important registers so that they will not be rewritten easily. **Figure 8.1** shows the PRCR register. The following lists the registers protected by the PRCR register.

- Registers protected by the PRC0 bit: CM0, CM1, CM2, PLC0, ROCR, PCLKR, and CCLKR
- Registers protected by the PRC1 bit: PM0, PM1, PM2, TB2SC, INVC0, and INVC1
- Registers protected by the PRC2 bit: PD9 , PACR, S4C, and NDDR
- Registers protected by the PRC3 bit: VCR2 and D4INT

The PRC2 bit is set to 0 (write enabled) when data is written to the SFR area after setting the PRC2 bit to 1 (write enable). Set registers PD9, PACR, S4C and NDDR immediately after setting the PRC2 bit in the PRCR register to 1 (write enable). Do not generate an interrupt or a DMA transfer between the instruction to set the PRC2 bit to 1 and the following instruction. Bits PRC3, PRC1, and PRC0 are not set to 0 even if data is written to the SFR area. Set bits PRC3, PRC1, and PRC0 to 0 by program.

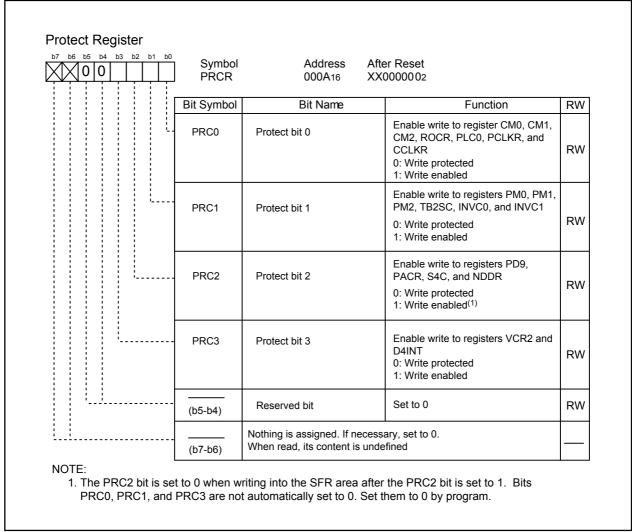


Figure 8.1 PRCR Register

9. Interrupts

Note

The SI/O4 interrupt of peripheral function interrupts is not available in the 64-pin package. The low voltage detection function is not available in M16C/29 T-ver. and V-ver..

9.1 Type of Interrupts

Figure 9.1 shows types of interrupts.

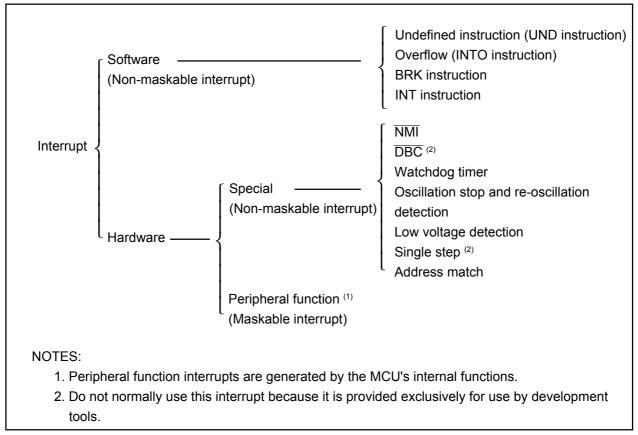


Figure 9.1 Interrupts

- Maskable Interrupt: An interrupt which can be enabled (disabled) by the interrupt enable flag (I flag) or whose interrupt priority <u>can be changed</u> by priority level.
- Non-maskable Interrupt: An interrupt which cannot be enabled (disabled) by the interrupt enable flag
 (I flag) or whose interrupt priority <u>cannot be changed</u> by priority level.

9.1.1 Software Interrupts

A software interrupt occurs when executing certain instructions. Software interrupts are non-maskable interrupts.

9.1.1.1 Undefined Instruction Interrupt

An undefined instruction interrupt occurs when executing the UND instruction.

9.1.1.2 Overflow Interrupt

An overflow interrupt occurs when executing the INTO instruction with the O flag set to 1 (the operation resulted in an overflow). The following are instructions whose O flag changes by arithmetic: ABS, ADC, ADCF, ADD, CMP, DIV, DIVU, DIVX, NEG, RMPA, SBB, SHA, SUB

9.1.1.3 BRK Interrupt

A BRK interrupt occurs when executing the BRK instruction.

9.1.1.4 INT Instruction Interrupt

An INT instruction interrupt occurs when executing the INT instruction. Software interrupt Nos. 0 to 63 can be specified for the INT instruction. Because software interrupt Nos. 1 to 31 are assigned to peripheral function interrupts, the same interrupt routine as for peripheral function interrupts can be executed by executing the INT instruction.

In software interrupt Nos. 0 to 31, the U flag is saved to the stack during instruction execution and is cleared to 0 (ISP selected) before executing an interrupt sequence. The U flag is restored from the stack when returning from the interrupt routine. In software interrupt Nos. 32 to 63, the U flag does not change state during instruction execution, and the SP then selected is used.



Interrupts M16C/29 Group

9.1.2 Hardware Interrupts

Hardware interrupts are classified into two types — special interrupts and peripheral function interrupts.

9.1.2.1 Special Interrupts

Special interrupts are non-maskable interrupts.

9.1.2.1.1 **NMI** Interrupt

An $\overline{\text{NMI}}$ interrupt is generated when input on the $\overline{\text{NMI}}$ pin changes state from high to low. For details about the NMI interrupt, refer to the section "NMI interrupt".

9.1.2.1.2 DBC Interrupt

This interrupt is exclusively for debugger, do not use in any other circumstances.

9.1.2.1.3 Watchdog Timer Interrupt

Generated by the watchdog timer. Once a watchdog timer interrupt is generated, be sure to initialize the watchdog timer. For details about the watchdog timer, refer to the section "watchdog timer".

9.1.2.1.4 Oscillation Stop and Re-oscillation Detection Interrupt

Generated by the oscillation stop and re-oscillation detection function. For details about the oscillation stop and re-oscillation detection function, refer to the section "clock generating circuit".

9.1.2.1.5 Low Voltage Detection Interrupt

Generated by the voltage detection circuit. For details about the voltage detection circuit, refer to the section "voltage detection circuit".

9.1.2.1.6 Single-step Interrupt

Do not normally use this interrupt because it is provided exclusively for use by development tools.

9.1.2.1.7 Address Match Interrupt

An address match interrupt is generated immediately before executing the instruction at the address indicated by the RMAD0 or RMAD1 register, if the corresponding enable bit (AIER0 or AIER1 bit in the AIER register) is set to 1. For details about the address match interrupt, refer to the section "address match interrupt".

9.1.2.2 Peripheral Function Interrupts

Peripheral function interrupts are maskable interrupts and generated by the MCU's internal functions. The interrupt sources for peripheral function interrupts are listed in Table 9.2 Relocatable Vector Tables. For details about the peripheral functions, refer to the description of each peripheral function in this manual.



9.2 Interrupts and Interrupt Vector

One interrupt vector consists of 4 bytes. Set the start address of each interrupt routine in the respective interrupt vectors. When an interrupt request is accepted, the CPU branches to the address set in the corresponding interrupt vector. **Figure 9.2** shows the interrupt vector.

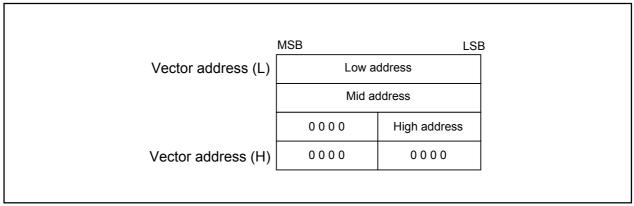


Figure 9.2 Interrupt Vector

9.2.1 Fixed Vector Tables

The fixed vector tables are allocated to the addresses from FFFDC16 to FFFFF16. **Table 9.1** lists the fixed vector tables. In the flash memory version of MCU, the vector addresses (H) of fixed vectors are used by the ID code check function. For details, refer to the section "flash memory rewrite disabling function".

Table 9.1 Fixed Vector Tables

Interrupt source	Vector table addresses	Remarks	Reference
	Address (L) to address (H)		
Undefined instruction	FFFDC16 to FFFDF16	Interrupt on UND instruction	M16C/60, M16C/20
Overflow	FFFE016 to FFFE316	Interrupt on INTO instruction	serise software
BRK instruction	FFFE416 to FFFE716	If the contents of address FFFE716 is FF16, program execution starts from the address shown by the vector in the relocatable vector table	maual
Address match	FFFE816 to FFFEB16		Address match interrupt
Single step (1)	FFFEC16 to FFFEF16		
Watchdog timer Oscillation stop and re-oscillation detection, low voltage detection	FFFF016 to FFFF316		Watchdog timer, clock generating circuit, voltage detection circuit
DBC (1)	FFFF416 to FFFF716		
NMI	FFFF816 to FFFFB16		NMI interrupt
Reset(2)	FFFFC16 to FFFFF16		Reset

^{1.} Do not normally use this interrupt because it is provided exclusively for use by development tools.

9.2.2 Relocatable Vector Tables

The 256 bytes beginning with the start address set in the INTB register comprise a reloacatable vector table area. **Table 9.2** lists the relocatable vector tables. Setting an even address in the INTB register results in the interrupt sequence being executed faster than in the case of odd addresses.

Table 9.2 Relocatable Vector Tables

Table 3.2 Relocatable vector	Tables			
Interrupt source	Vector address ⁽¹⁾ Address (L) to address (H)	Software interrupt number	Reference	
BRK instruction (2)	+0 to +3 (000016 to 000316)	0	M16C/60, M16C/20 series software manual	
CAN0 wakeup ⁽³⁾	+4 to +7 (000416 to 000716)	1		
CAN0 receive completion	+8 to +11 (000816 to 000B16)	2	CAN module	
CAN0 transmit completion	+12 to +15 (000C 16 to 000F16)	3	1	
ĪNT3	+16 to +19 (001016 to 001316)	4	INT interrupt	
IC/OC interrupt 0	+20 to +23 (001416 to 001716)	5	Timer S	
IC/OC interrupt 1, I2C bus interface (4)	+24 to +27 (001816 to 001B16)	6	Timer S	
IC/OC base timer, ScL/SDA(4)	+28 to +31 (001C 16 to 001F16)	7	Multi-Master I ² C bus interface	
SI/O4, ĪNT5 ⁽⁵⁾	+32 to +35 (002016 to 002316)	8	INT interrupt	
SI/O3, ĪNT4 (5)	+36 to +39 (002416 to 002716)	9	Serial I/O	
UART 2 bus collision detection (6)	+40 to +43 (002816 to 002B16)	10	Serial I/O	
DMA0	+44 to +47 (002C 16 to 002F16)	11	DMAG	
DMA1	+48 to +51 (003016 to 003316)	12	DMAC	
CAN0 state, error	+52 to +55 (003416 to 003716)	13	CAN module	
A/D, Key input interrupt (7)	+56 to +59 (003816 to 003B16)	14	A/D convertor, Key input interrupt	
UART2 transmit, NACK2 (8)	+60 to +63 (003C 16 to 003F16)	15	- Serial I/O	
UART2 receive, ACK2 (8)	+64 to +67 (0040 16 to 0043 16)	16		
UART0 transmit	+68 to +71 (004416 to 004716)	17		
UART0 receive	+72 to +75 (004816 to 004B16)	18		
UART1 transmit	+76 to +79 (004C 16 to 004F16)	19		
UART1 receive	+80 to +83 (005016 to 005316)	20		
Timer A0	+84 to +87 (005416 to 005716)	21		
Timer A1	+88 to +91 (005816 to 005B16)	22		
Timer A2	+92 to +95 (005C 16 to 005F16)	23	- Timer	
Timer A3	+96 to +99 (0060 16 to 0063 16)	24		
Timer A4	+100 to +103 (0064 16 to 006716)	25		
Timer B0	+104 to +107 (0068 16 to 006B16)	26		
Timer B1	+108 to +111 (006C 16 to 006F16)	27		
Timer B2	+112 to +115 (0070 16 to 007316)	28		
ĪNT0	+116 to +119 (007416 to 007716)	29		
ĪNT1	+120 to +123 (0078 16 to 007B16)	30	INT interrupt	
ĪNT2	+124 to +127 (007C 16 to 007F16)	31	·	
Software interrupt ⁽²⁾	+128 to +131 (0080 16 to 008316) to +252 to +255 (00FC 16 to 00FF16)	32 to 63	M16C/60, M16C/20 series software manual	

- 1. Address relative to address in INTB.
- 2. These interrupts cannot be disabled using the I flag.
- 3. Set the IFSR22 bit in the IFSR register to 0.
- 4. Use bits IFSR26 and IFSR27 in the IFSR2A register to select.
- 5. Use bits IFSR6 and IFSR7 in the IFSR register to select.
- 6. Bus collision detection: In IEBus mode, this bus collision detection constitutes the cause of an interrupt. In I²C bus mode, however, a start condition or a stop condition detection constitutes the cause of an interrupt.
- 7. Use the IFSR21 bit in the IFSR2A register to select.
- 8. During I²C bus mode, NACK and ACK interrupts comprise the interrupt source.



9.3 Interrupt Control

The following describes how to enable/disable the maskable interrupts, and how to set the priority in which order they are accepted. What is explained here does not apply to nonmaskable interrupts.

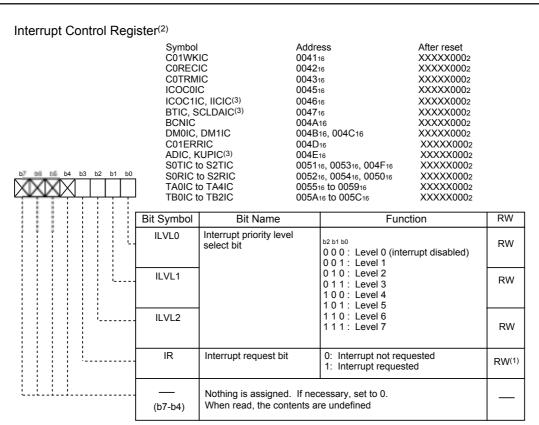
Use I flag in the the FLG register, IPL, and bits ILVL2 to ILVL0 in the each interrupt control register to enable/disable the maskable interrupts. Whether an interrupt is requested is indicated by the IR bit in each interrupt control register.

Figure 9.3 shows the interrupt control registers.

Also, the following interrupts share a vector and an interrupt control register.

- •INT4 and SIO3
- •INT5 and SIO4
- •A/D converter and key input interrupt
- •IC/OC base timer and ScL/SDA
- •IC/OC interrupt 1 and I²C bus interface

An interrupt request is set by bits IFSR6 and IFSR7 in the IFSR register and bits IFSR27, IFSR26, and IFSR21 in the IFSR2A register. **Figure 9.4** shows registers IFSR register and IFSR2A.



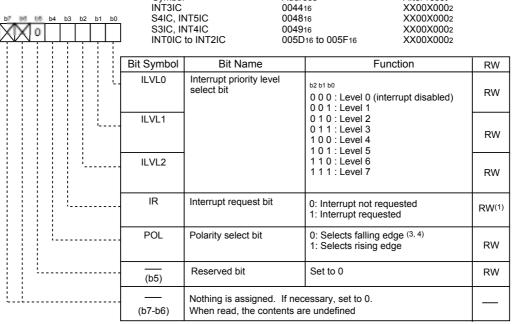
NOTES:

- 1. This bit can only be reset by writing 0 (Do not write 1).
- 2. To rewrite the interrupt control registers, do so at a point that does not generate the interrupt request for that register. For details, refer to 22. 4 Interrupts.

Address

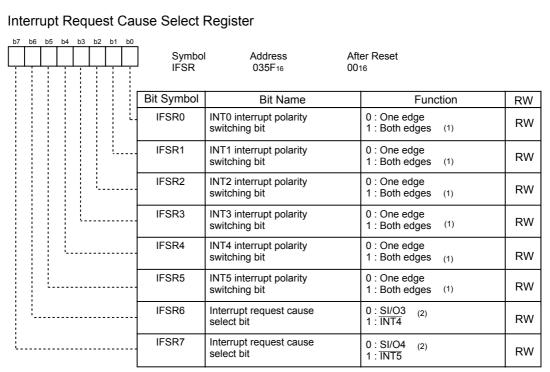
After reset

Use the IFSR2A register to select.
 Symbol



- 1. This bit can only be reset by writing 0 (Do not write 1).
- To rewrite the interrupt control register, do so at a point that does not generate the interrupt request for that register. For details, refer to 22.4 Interrupts.
- 3. If the IFSRi bit in the IFSR register (i = 0 to 5) is 1 (both edges), set the POL bit in the INTilC register to 0 (falling edge).
- 4. Set the POL bit in register S3IC or S4IC to 0 (falling edge) when the IFSR6 bit in the IFSR register is set to 0 (SI/O3 selected) or IFSR7 bit in the IFSR register to 0 (SI/O4 selected), respectively.

Figure 9.3 Interrupt Control Registers



NOTES:

- 1. When setting this bit to 1 (both edges), make sure the POL bit in registers INT0IC to INT5IC is set to 0 (falling edge).
- 2. When setting this bit to 0 (SI/O3, SI/O4), make sure the POL bit in registers S3IC and S4IC is set to 0 (falling edge).

Interrupt Request Cause Select Register 2

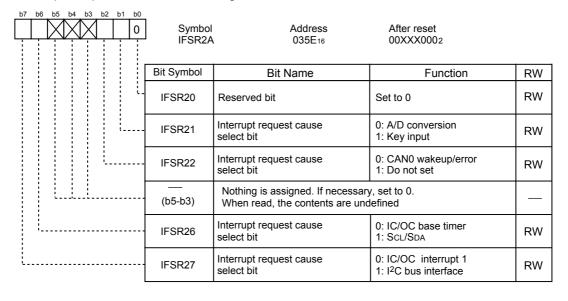


Figure 9.4 IFSR Register and IFSR2A Register

9.3.1 I Flag

The I flag enables or disables the maskable interrupt. Setting the I flag to 1 (= enabled) enables the maskable interrupt. Setting the I flag to 0 (= disabled) disables all maskable interrupts.

9.3.2 IR Bit

The IR bit is set to 1 (= interrupt requested) when an interrupt request is generated. Then, when the interrupt request is accepted and the CPU branches to the corresponding interrupt vector, the IR bit is cleared to 0 (= interrupt not requested).

The IR bit can be cleared to 0 in a program. Note that do not write 1 to this bit.

9.3.3 ILVL2 to ILVL0 Bits and IPL

Interrupt priority levels can be set using bits ILVL2 to ILVL0.

Table 9.3 shows the settings of interrupt priority levels and **Table 9.4** shows the interrupt priority levels enabled by the IPL.

The following are conditions under which an interrupt is accepted:

- · I flag = 1
- \cdot IR bit = 1
- · interrupt priority level > IPL

The I flag, IR bit, bits ILVL2 to ILVL0, and IPL are independent of each other. In no case do they affect one another.

Table 9.3 Settings of Interrupt Priority Levels

ILVL2 to ILVL0 bits	Interrupt priority level	Priority order
0002	Level 0 (interrupt disabled)	
0012	Level 1	Low
0102	Level 2	
0112	Level 3	
1002	Level 4	
1012	Level 5	
1102	Level 6	₩
1112	Level 7	High

Table 9.4 Interrupt Priority Levels
Enabled by IPL

IPL	Enabled interrupt priority levels	
0002	Interrupt levels 1 and above are enabled	
0012	Interrupt levels 2 and above are enabled	
0102	Interrupt levels 3 and above are enabled	
0112	Interrupt levels 4 and above are enabled	
1002	Interrupt levels 5 and above are enabled	
1012	Interrupt levels 6 and above are enabled	
1102	Interrupt levels 7 and above are enabled	
1112	All maskable interrupts are disabled	

9.4 Interrupt Sequence

An interrupt sequence (the device behavior from the instant an interrupt is accepted to the instant the interrupt routine is executed) is described here.

If an interrupt occurs during execution of an instruction, the processor determines its priority when the execution of the instruction is completed, and transfers control to the interrupt sequence from the next cycle. If an interrupt occurs during execution of either the SMOVB, SMOVF, SSTR or RMPA instruction, the processor temporarily suspends the instruction being executed, and transfers control to the interrupt sequence.

The CPU behavior during the interrupt sequence is described below. **Figure 9.5** shows time required for executing the interrupt sequence.

- (1) The CPU gets interrupt information (interrupt number and interrupt request priority level) by reading the address 0000016. Then it clears the IR bit for the corresponding interrupt to 0 (interrupt not requested).
- (2) The FLG register immediately before entering the interrupt sequence is saved to the CPU's internal temporary register^(Note).
- (3) The I, D and U flags in the FLG register become as follows:
 - The I flag is cleared to 0 (interrupts disabled).
 - The D flag is cleared to 0 (single-step interrupt disabled).
 - The U flag is cleared to 0 (ISP selected).
 - However, the U flag does not change state if an INT instruction for software interrupt Nos. 32 to 63 is executed.
- (4) The CPU's internal temporary register⁽¹⁾ is saved to the stack.
- (5) The PC is saved to the stack.
- (6) The interrupt priority level of the accepted interrupt is set in the IPL.
- (7) The start address of the relevant interrupt routine set in the interrupt vector is stored in the PC.

After the interrupt sequence is completed, the processor resumes executing instructions from the start address of the interrupt routine.

NOTE:

1. This register cannot be used by user.

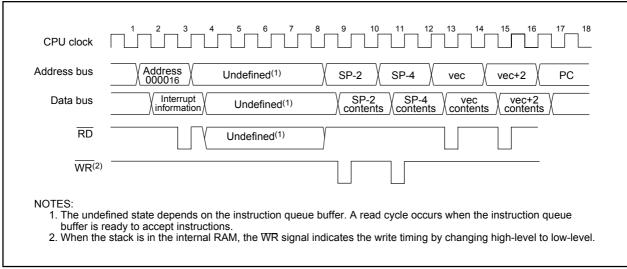


Figure 9.5 Time Required for Executing Interrupt Sequence

9.4.1 Interrupt Response Time

Figure 9.6 shows the interrupt response time. The interrupt response or interrupt acknowledge time denotes time from when an interrupt request is generated till when the first instruction in the interrupt routine is executed. Specifically, it consists of the time from when an interrupt request is generated till when the instruction then executing is completed ((a) in **Figure 9.6**) and the time during which the interrupt sequence is executed ((b) in **Figure 9.6**).

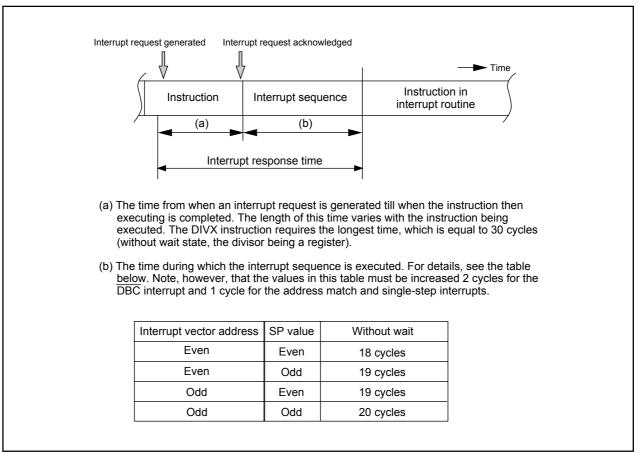


Figure 9.6 Interrupt response time

9.4.2 Variation of IPL when Interrupt Request is Accepted

When a maskable interrupt request is accepted, the interrupt priority level of the accepted interrupt is set in the IPL.

When a software interrupt or special interrupt request is accepted, one of the interrupt priority levels listed in **Table 9.5** is set in the IPL. Shown in **Table 9.5** are the IPL values of software and special interrupts when they are accepted.

Table 9.5 IPL Level That is Set to IPL When A Software or Special Interrupt Is Accepted

Interrupt sources	
Watchdog timer, NMI, Oscillation stop and re-oscillation detection, Low volage detection	7
Software, address match, DBC, single-step	No change

9.4.3 Saving Registers

In the interrupt sequence, the FLG register and PC are saved to the stack.

At this time, the 4 high-order bits of the PC and the 4 high-order (IPL) and 8 low-order bits of the FLG register, 16 bits in total, are saved to the stack first. Next, the 16 low-order bits of the PC are saved.

Figure 9.7 shows the stack status before and after an interrupt request is accepted.

The other necessary registers must be saved in a program at the beginning of the interrupt routine. Use the PUSHM instruction, and all registers except SP can be saved with a single instruction.

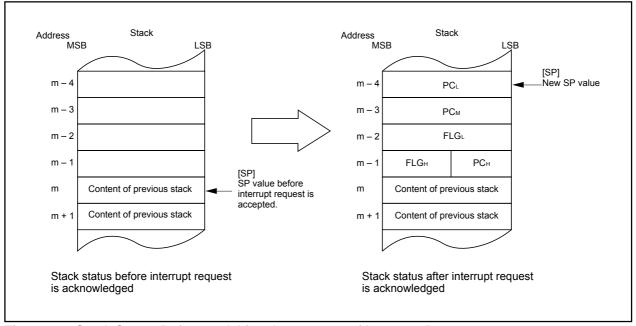


Figure 9.7 Stack Status Before and After Acceptance of Interrupt Request

The operation of saving registers carried out in the interrupt sequence is dependent on whether the SP⁽¹⁾, at the time of acceptance of an interrupt request, is even or odd. If the stack pointer ⁽¹⁾ is even, the FLG register and the PC are saved, 16 bits at a time. If odd, they are saved in two steps, 8 bits at a time. **Figure 9.8** shows the operation of the saving registers.

NOTE:

1. When any INT instruction in software numbers 32 to 63 has been executed, this is the SP indicated by the U flag. Otherwise, it is the ISP.

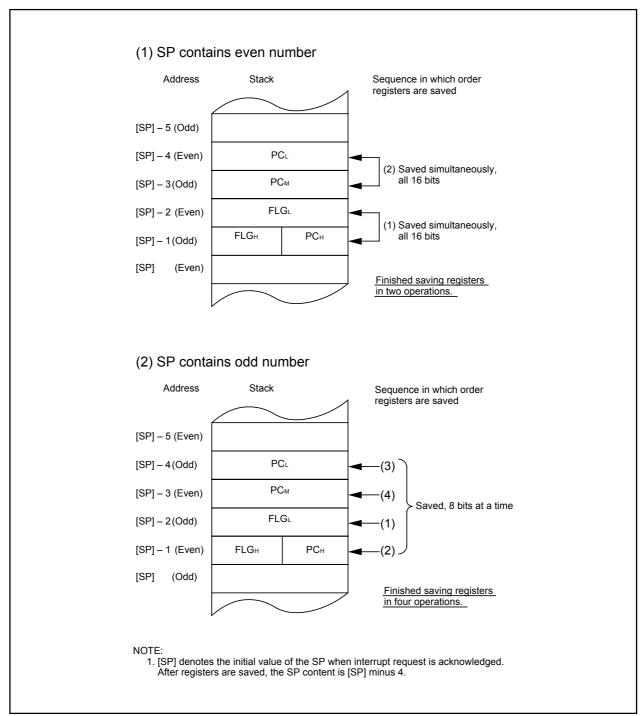


Figure 9.8 Operation of Saving Register

9.4.4 Returning from an Interrupt Routine

The FLG register and PC in the state in which they were immediately before entering the interrupt sequence are restored from the stack by executing the REIT instruction at the end of the interrupt routine. Thereafter the CPU returns to the program which was being executed before accepting the interrupt request.

Return the other registers saved by a program within the interrupt routine using the POPM or similar instruction before executing the REIT instruction.

9.5 Interrupt Priority

If two or more interrupt requests are generated while executing one instruction, the interrupt request that has the highest priority is accepted.

For maskable interrupts (peripheral functions), any desired priority level can be selected using bits ILVL2 to ILVL0. However, if two or more maskable interrupts have the same priority level, their interrupt priority is resolved by hardware, with the highest priority interrupt accepted.

The watchdog timer and other special interrupts have their priority levels set in hardware. **Figure 9.9** shows the priorities of hardware interrupts.

Software interrupts are not affected by the interrupt priority. If an instruction is executed, control branches invariably to the interrupt routine.

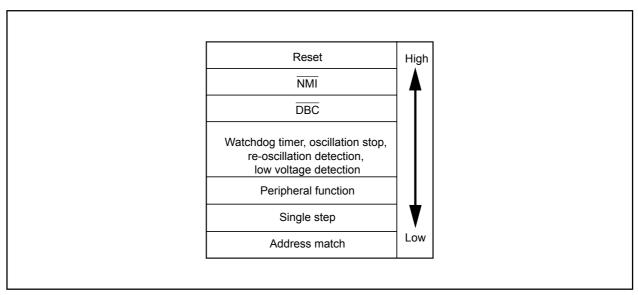


Figure 9.9 Hardware Interrupt Priority

9.5.1 Interrupt Priority Resolution Circuit

The interrupt priority resolution circuit is used to select the interrupt with the highest priority among those requested.

Figure 9.10 shows the circuit that judges the interrupt priority level.

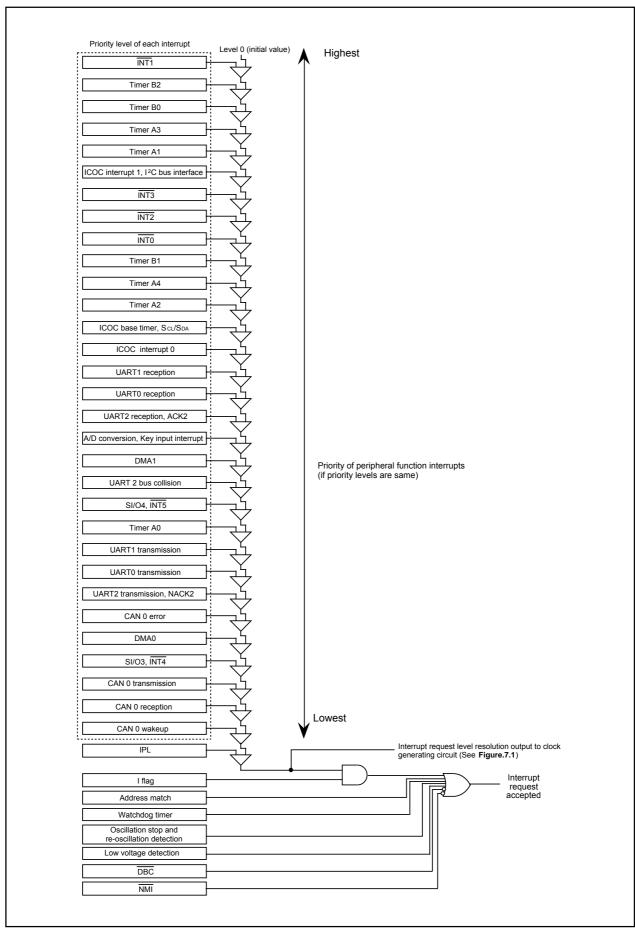


Figure 9.10 Interrupts Priority Select Circuit

9.6 INT Interrupt

INTi interrupt (i=0 to 5) is triggered by the edges of external inputs. The edge polarity is selected using the IFSRi bit in the IFSR register.

The INT5 input has an effective digital debounce function for a noise rejection. Refer to "19.6 Digital Debounce function" for this detail. When using INT5 interrupt to exit stop mode, set the P17DDR register to FF16 before entering stop mode.

To use the $\overline{\text{INT4}}$ interrupt, set the IFSR6 bit in the IFSR register to 1 ($\overline{\text{INT4}}$). To use the $\overline{\text{INT5}}$ interrupt, set the IFSR7 bit in the IFSR register to 1 ($\overline{\text{INT5}}$).

After modifying bit IFSR6 or IFSR7, clear the corresponding IR bit to 0 (interrupt not requested) before enabling the interrupt.

Figure 9.11 shows the IFSR registers.

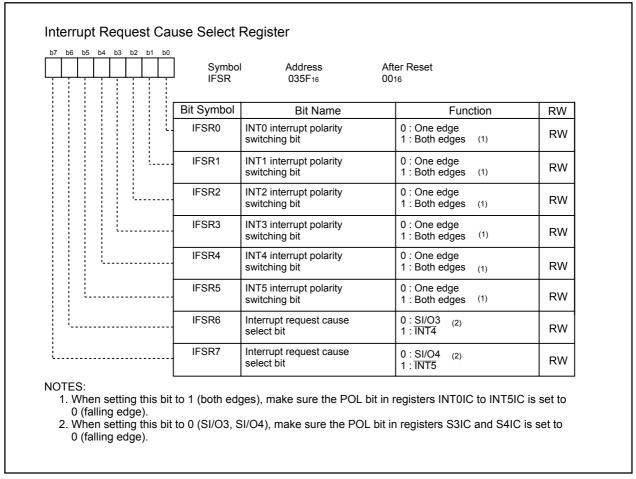


Figure 9.11 IFSR Register

9.7 NMI Interrupt

An $\overline{\text{NMI}}$ interrupt request is generated when input on the $\overline{\text{NMI}}$ pin changes state from high to low, after the $\overline{\text{NMI}}$ interrupt was enabled by writing a 1 to bit 4 in the register PM2. The $\overline{\text{NMI}}$ interrupt is a non-maskable interrupt, once it is enabled.

The input level of this $\overline{\text{NMI}}$ interrupt input pin can be read by accessing the P8_5 bit in the P8 register.

NMI is disabled by default after reset (the pin is a GPIO pin, P85) and can be enabled using bit 4 in the PM2 register. Once enabled, it can only be disabled by a reset signal.

The NMI input has a digital debounce function for noise rejection. Refer to "19.6 Digital Debounce function" for details. When using NMI interrupt to exit stop mode, set the NDDR register to FF16 before entering stop mode.

9.8 Key Input Interrupt

A key input interrupt is generated when input on any of the P104 to P107 pins which has had bits PD10_7 to PD10_4 in the PD10 register set to 0 (= input) goes low. Key input interrupts can be used for a key-on wakeup function to get the MCU to exit stop or wait modes. However, if you intend to use the key input interrupt, do not use P104 to P107 as analog input ports. **Figure 9.12** shows the block diagram of the key input interrupt. Note, however, that while input on any pin which has had bits PD10_7 to PD10_4 set to 0 (= input mode) is pulled low, inputs on all other pins of the port are not detected as interrupts.

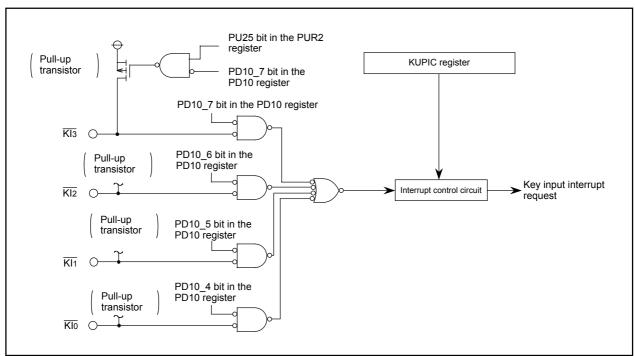


Figure 9.12 Key Input Interrupt

9.9 CAN0 Wake-up Interrupt

CAN0 wake-up interrupt occurs when a falling edge is input to CRX. The CAN0 wake-up interrupt is enabled when the PortEn bit is set to 1 (CTX/CRX function) and Sleep bit is set to 1(Sleep mode enabled) in the C0CTLR register. **Figure 9.13** shows the block diagram of the CAN0 wake-up interrupt.

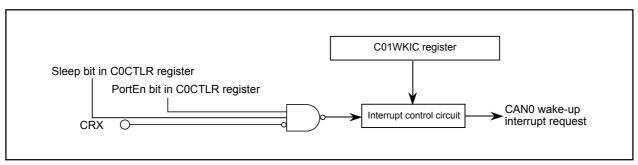


Figure 9.13 CAN0 Wake-up Interrupt Block Diagram

9.10 Address Match Interrupt

An address match interrupt request is generated immediately before executing the instruction at the address indicated by the RMADi register (i=0 to 1). Set the start address of any instruction in the RMADi register. Use bits AIER1 and AIER0 in the AIER register to enable or disable the interrupt. Note that the address match interrupt is unaffected by the I flag and IPL. For address match interrupts, the value of the PC that is saved to the stack area varies depending on the instruction being executed (refer to "Saving Registers").

(The value of the PC that is saved to the stack area is not the correct return address.) Therefore, follow one of the methods described below to return from the address match interrupt.

- Rewrite the content of the stack and then use the REIT instruction to return.
- Restore the stack to its previous state before the interrupt request was accepted by using the POP or similar other instruction and then use a jump instruction to return.

Table 9.6 shows the value of the PC that is saved to the stack area when an address match interrupt request is accepted.

aFigure 9.14 shows registers AIER, RMAD0, and RMAD1.

Table 9.6 PC Value Saved in Stack Area When Address Match Interrupt Request Is Acknowledged

Instruction at the address indicated by the RMADi register				Value of the PC that is saved to the stack area
2-byte op-code instruction 1-byte op-code instructions which are followed: ADD.B:S #IMM8,dest SUB.B:S #IMM8,dest AND.B:S #IMM8,dest OR.B:S #IMM8,dest MOV.B:S #IMM8,dest STZ.B #IMM8,dest STZ.B #IMM8,dest STZX.B #IMM81,#IMM82,dest CMP.B:S #IMM8,dest PUSHM src POPM dest JMPS #IMM8 JSRS #IMM8 MOV.B:S #IMM,dest (However, dest=A0 or A1)			The address indicated by the RMADi register +2	
Instructions other than the above			The address indicated by the RMADi register +1	

Value of the PC that is saved to the stack area: Refer to "Saving Registers".

Table 9.7 Relationship Between Address Match Interrupt Sources and Associated Registers

Address match interrupt sources	Address match interrupt enable bit	Address match interrupt register
Address match interrupt 0	AIER0	RMAD0
Address match interrupt 1	AIER1	RMAD1

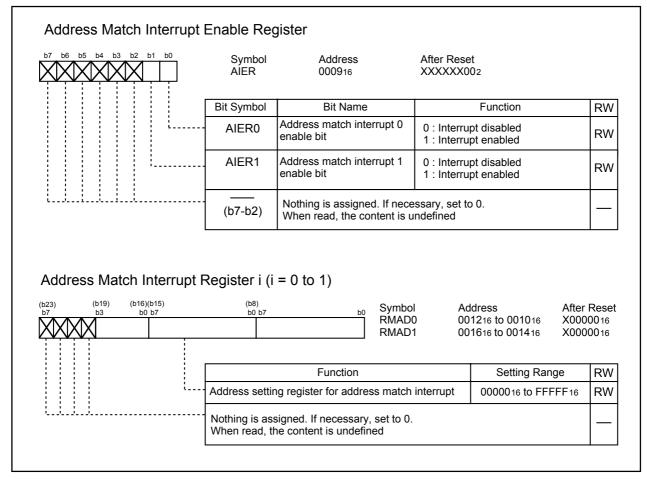


Figure 9.14 AIER Register, RMAD0 and RMAD1 Registers

Op-code is an abbreviation of Operation Code. It is a portion of instruction code.

Refer to Chapter 4 Instruction Code/Number of Cycles in M16C/60, M16C/20 Series Software Manual. Op-code is shown as a bold-framed figure directly below the Syntax.

10. Watchdog Timer M16C/29 Group

10. Watchdog Timer

The watchdog timer is the function of detecting when the program is out of control. Therefore, we recommend using the watchdog timer to improve reliability of a system. The watchdog timer contains a 15-bit counter which counts down the clock derived by dividing the CPU clock using the prescaler. Whether to generate a watchdog timer interrupt request or apply a watchdog timer reset as an operation to be performed when the watchdog timer underflows after reaching the terminal count can be selected using the PM12 bit in the PM1 register. The PM12 bit can only be set to 1 (reset). Once this bit is set to 1, it cannot be set to 0 (watchdog timer interrupt) in a program. Refer to 5.3 Watchdog Timer Reset for the details of watchdog timer reset.

When the main clock source is selected for CPU clock, on-chip oscillator clock, PLL clock, the WDC7 bit in the WDC register value for prescaler can be chosen to be 16 or 128. If a sub-clock is selected for CPU clock, the prescaler is always 2 no matter how the WDC7 bit is set. The period of watchdog timer can be calculated as given below. The period of watchdog timer is, however, subject to an error due to the prescaler.

With main clock source chosen for CPU clock, on-chip oscillator clock, PLL clock

Prescaler dividing (16 or 128) X Watchdog timer count (32768) Watchdog timer period = CPU clock

With sub-clock chosen for CPU clock

Prescaler dividing (2) X Watchdog timer count (32768) Watchdog timer period = CPU clock

For example, when CPU clock is set to 16 MHz and the divide-by-N value for the prescale ris set to 16, the watchdog timer period is approx. 32.8 ms.

The watchdog timer is initialized by writing to the WDTS register. The prescaler is initialized after reset. Note that the watchdog timer and the prescaler both are inactive after reset, so that the watchdog timer is activated to start counting by writing to the WDTS register.

Write the WDTS register with shorter cycle than the watchdog timer cycle. Set the WDTS register also in the beginning of the watchdog timer interrupt routine.

In stop mode and wait mode, the watchdog timer and prescaler are stopped. Counting is resumed from the held value when the modes or state are released.

Figure 10.1 shows the block diagram of the watchdog timer. Figure 10.2 shows the watchdog timer-related registers.

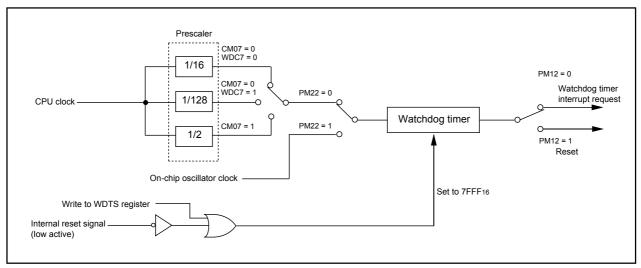


Figure 10.1 Watchdog Timer Block Diagram

M16C/29 Group 10. Watchdog Timer

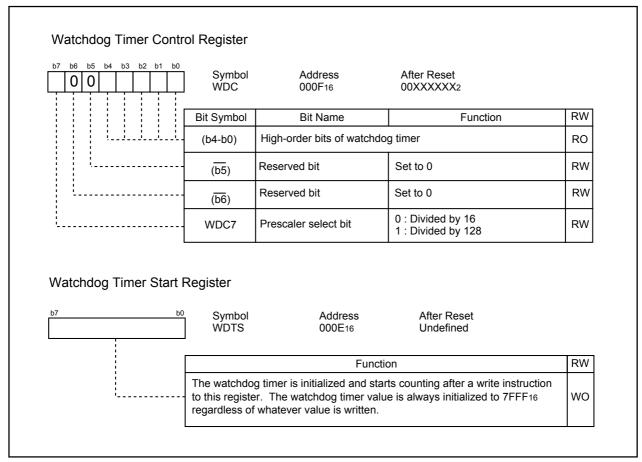


Figure 10.2 WDC Register and WDTS Register

10.1 Count Source Protective Mode

In this mode, a on-chip oscillator clock is used for the watchdog timer count source. The watchdog timer can be kept being clocked even when CPU clock stops as a result of run-away.

Before this mode can be used, the following register settings are required:

- (1) Set the PRC1 bit in the PRCR register to 1 (enable writes to PM1 and PM2 registers).
- (2) Set the PM12 bit in the PM1 register to 1 (reset when the watchdog timer underflows).
- (3) Set the PM22 bit in the PM2 register to 1 (on-chip oscillator clock used for the watchdog timer count source).
- (4) Set the PRC1 bit in the PRCR register to 0 (disable writes to PM1 and PM2 registers).
- (5) Write to the WDTS register (watchdog timer starts counting).

Setting the PM22 bit to 1 results in the following conditions

- The on-chip oscillator continues oscillating even if the CM21 bit in the CM2 register is set to "0" (main clock or PLL clock) (system clock of count source selected by the CM21 bit is valid)
- The on-chip oscillator starts oscillating, and the on-chip oscillator clock becomes the watchdog timer count source.

Watchdog timer count (32768)

on-chip oscillator clock

- The CM10 bit in the CM1 register is disabled against write. (Writing a 1 has no effect, nor is stop mode entered.)
- The watchdog timer does not stop when in wait mode.



11. DMAC

Note

Do not use SI/O4 interrupt request as a DMA request in the 64-pin package.

The DMAC (Direct Memory Access Controller) allows data to be transferred without the CPU intervention. Two DMAC channels are included. Each time a DMA request occurs, the DMAC transfers one (8 or 16-bit) data from the source address to the destination address. The DMAC uses the same data bus as used by the CPU. Because the DMAC has higher priority of bus control than the CPU and because it makes use of a cycle steal method, it can transfer one word (16 bits) or one byte (8 bits) of data within a very short time after a DMA request is generated. **Figure 11.1** shows the block diagram of the DMAC. **Table 11.1** shows the DMAC specifications. **Figures 11.2** to **11.4** show the DMAC-related registers.

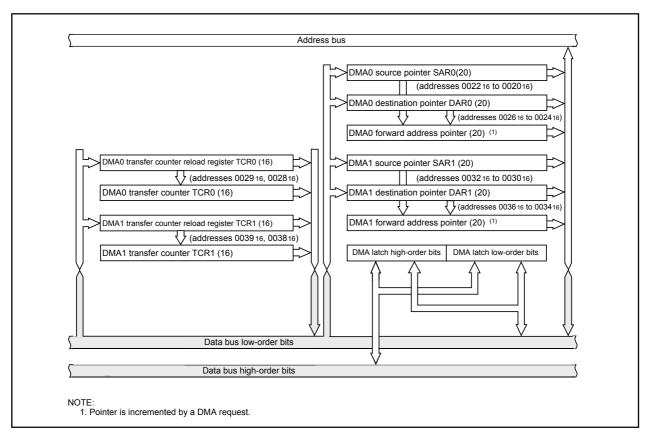


Figure 11.1 DMAC Block Diagram

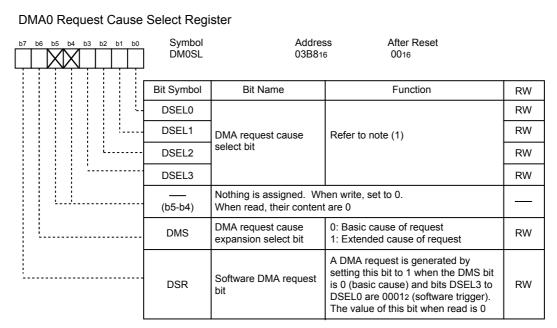
A DMA request is generated by a write to the DSR bit in the DMiSL register (i = 0,1), as well as by an interrupt request which is generated by any function specified by the DMS and bits DSEL3 to DSEL0 in the DMiSL register. However, unlike in the case of interrupt requests, DMA requests are not affected by the I flag and the interrupt control register, so that even when interrupt requests are disabled and no interrupt request can be accepted, DMA requests are always accepted. Furthermore, because the DMAC does not affect interrupts, the IR bit in the interrupt control register does not change state due to a DMA transfer. A data transfer is initiated each time a DMA request is generated when the DMAE bit in the DMiCON register is set to 1 (DMA enabled). However, if the cycle in which a DMA request is generated is faster than the DMA transfer cycle, the number of transfer requests generated and the number of times data is transferred may not match. For details, refer to "DMA Requests".

Table 11.1 DMAC Specifications

No. of channels Transfer memory space • From any address in the 1M bytes space to a fixed address • From a fixed address to any address in the 1M bytes space • From a fixed address to a fixed address Maximum No. of bytes transferred DMA request factors (1, 2) Falling edge of INTO or INT1 Both edge of INTO or INT1 Timer A0 to timer A4 interrupt requests Timer B0 to timer B2 interrupt requests UARTO transfer, UARTO reception interrupt requests
From a fixed address to any address in the 1M bytes space From a fixed address to a fixed address Maximum No. of bytes transferred DMA request factors (1, 2) Falling edge of INT0 or INT1 Both edge of INT0 or INT1 Timer A0 to timer A4 interrupt requests Timer B0 to timer B2 interrupt requests
From a fixed address to a fixed address Maximum No. of bytes transferred 128K bytes (with 16-bit transfers) or 64K bytes (with 8-bit transfers) DMA request factors (1, 2) Falling edge of INTO or INT1 Both edge of INTO or INT1 Timer A0 to timer A4 interrupt requests Timer B0 to timer B2 interrupt requests
Maximum No. of bytes transferred 128K bytes (with 16-bit transfers) or 64K bytes (with 8-bit transfers) DMA request factors (1, 2) Falling edge of INT0 or INT1 Both edge of INT0 or INT1 Timer A0 to timer A4 interrupt requests Timer B0 to timer B2 interrupt requests
DMA request factors ^(1, 2) Falling edge of INT0 or INT1 Both edge of INT0 or INT1 Timer A0 to timer A4 interrupt requests Timer B0 to timer B2 interrupt requests
Both edge of INTO or INT1 Timer A0 to timer A4 interrupt requests Timer B0 to timer B2 interrupt requests
Timer A0 to timer A4 interrupt requests Timer B0 to timer B2 interrupt requests
Timer B0 to timer B2 interrupt requests
· · ·
UART0 transfer, UART0 reception interrupt requests
· · ·
UART1 transfer, UART1 reception interrupt requests
UART2 transfer, UART2 reception interrupt requests
SI/O3, SI/O4 interrupt requests
A/D conversion interrupt requests
Timer S(IC/OC) requests
Software triggers
Channel priority DMA0 > DMA1 (DMA0 takes precedence)
Transfer unit 8 bits or 16 bits
Transfer address direction forward or fixed (The source and destination addresses cannot both
in the forward direction)
Transfer mode Single transfer Transfer is completed when the DMAi transfer counter (i = 0,1)
underflows after reaching the terminal count
Repeat transfer When the DMAi transfer counter underflows, it is reloaded with the value
of the DMAi transfer counter reload register and a DMA transfer is co
tinued with it
DMA interrupt request generation timing When the DMAi transfer counter underflowed
DMA startup Data transfer is initiated each time a DMA request is generated who
the DMAE bit in the DMAiCON register = 1 (enabled)
DMA shutdown Single transfer • When the DMAE bit is set to 0 (disabled)
After the DMAi transfer counter underflows
Repeat transfer When the DMAE bit is set to 0 (disabled)
Reload timing for forward ad-When a data transfer is started after setting the DMAE bit to 1 (en
dress pointer and transfer abled), the forward address pointer is reloaded with the value of the
counter SARi or the DARi pointer whichever is specified to be in the forward
direction and the DMAi transfer counter is reloaded with the value of the
DMAi transfer counter reload register

NOTES:

- 1. DMA transfer is not effective to any interrupt. DMA transfer is affected neither by the I flag nor by the interrupt control register.
- 2. The selectable causes of DMA requests differ with each channel.
- 3. Make sure that no DMAC-related registers (addresses 002016 to 003F16) are accessed by the DMAC.



NOTE:

1. The causes of DMA0 requests can be selected by a combination of DMS bit and bits DSEL3 to DSEL0 in the manner described below.

DSEL3 to DSEL0	DMS=0(basic cause of request)	DMS=1(extended cause of request)
0 0 0 02	Falling edge of INTO pin	IC/OC base timer
0 0 0 12	Software trigger	_
0 0 1 02	Timer A0	IC/OC channel 0
0 0 1 12	Timer A1	IC/OC channel 1
0 1 0 02	Timer A2	_
0 1 0 12	Timer A3	_
0 1 1 02	Timer A4	Two edges of INTO pin
0 1 1 12	Timer B0	_
1 0 0 02	Timer B1	_
1 0 0 12	Timer B2	_
1 0 1 02	UART0 transmit	IC/OC channel 2
1 0 1 12	UART0 receive	IC/OC channel 3
1 1 0 02	UART2 transmit	IC/OC channel 4
1 1 0 12	UART2 receive	IC/OC channel 5
1 1 1 02	A/D conversion	IC/OC channel 6
1 1 1 12	UART1 transmit	IC/OC channel 7

Figure 11.2 DM0SL Register

11. DMAC M16C/29 Group

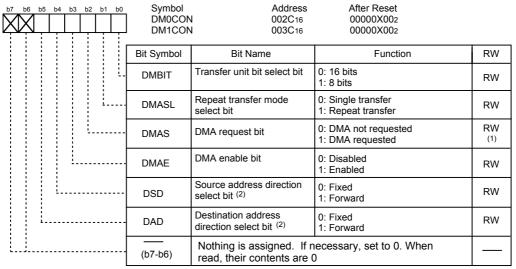
DMA1 Request Cause Select Register After Reset Symbol Address DM1SL 03BA16 0016 Bit Name Function Bit Symbol RW DSEL0 RW DMA request cause Refer to note (1) select bit DSEL1 RW DSEL2 RW DSEL3 RW Nothing is assigned. If necessary, set (b5-b4) to 0. When read, their contents are 0 DMA request cause DMS 0: Basic cause of request RW expansion select bit 1: Extended cause of request A DMA request is generated by setting this bit to 1 when the DMS bit Software DMA request bit is 0 (basic cause) and the DSEL3 to DSR RW DSEL0 bits are 00012 (software trigger). The value of this bit when read is 0

NOTES:

^{1.} The causes of DMA1 requests can be selected by a combination of DMS bit and bits DSEL3 to DSEL0 in the manner described below.

DSEL3 to DSEL0	DMS=0(basic cause of request)	DMS=1(extended cause of request)
0 0 0 02	Falling edge of INT1 pin	IC/OC base timer
0 0 0 12	Software trigger	_
0 0 1 02	Timer A0	IC/OC channel 0
0 0 1 12	Timer A1	IC/OC channel 1
0 1 0 02	Timer A2	_
0 1 0 12	Timer A3	SI/O3
0 1 1 02	Timer A4	SI/O4
0 1 1 12	Timer B0	Two edges of INT1
1 0 0 02	Timer B1	_
1 0 0 12	Timer B2	_
1 0 1 02	UART0 transmit	IC/OC channel 2
1 0 1 12	UART0 receive	IC/OC channel 3
1 1 0 02	UART2 transmit	IC/OC channel 4
1 1 0 12	UART2 receive/ACK2	IC/OC channel 5
1 1 1 02	A/D conversion	IC/OC channel 6
1 1 1 12	UART1 receive	IC/OC channel 7

DMAi Control Register(i=0,1)



NOTES:

- The DMAS bit can be set to 0 by writing 0 by program (This bit remains unchanged even if 1 is written).
 At least one of bits DAD and DSD must be set to 0 (address direction fixed).

Figure 11.3 DM1SL Register, DM0CON Register, and DM1CON Registers

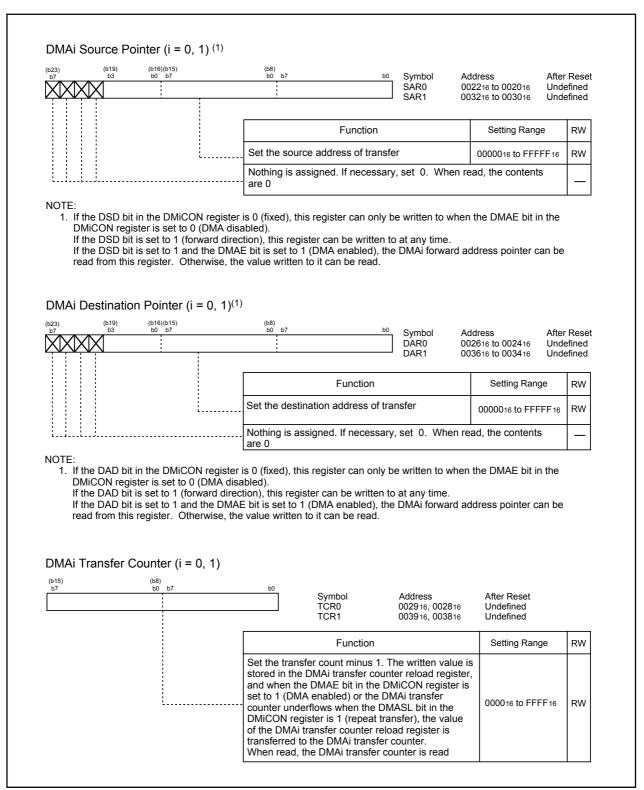


Figure 11.4 SAR0, SAR1, DAR0, DAR1, TCR0, and TCR1 Registers

11.1 Transfer Cycles

The transfer cycle consists of a memory or SFR read (source read) bus cycle and a write (destination write) bus cycle. The number of read and write bus cycles is affected by the source and destination addresses of transfer. Furthermore, the bus cycle itself is extended by a software wait.

11.1.1 Effect of Source and Destination Addresses

If the transfer unit is 16 bits and the source address of transfer begins with an odd address, the source read cycle consists of one more bus cycle than when the source address of transfer begins with an even address.

Similarly, if the transfer unit is 16 bits and the destination address of transfer begins with an odd address, the destination write cycle consists of one more bus cycle than when the destination address of transfer begins with an even address.

11.1.2 Effect of Software Wait

For memory or SFR accesses in which one or more software wait states are inserted, the number of bus cycles required for that access increases by an amount equal to software wait states.

Figure 11.5 shows the example of the cycles for a source read. For convenience, the destination write cycle is shown as one cycle and the source read cycles for the different conditions are shown. In reality, the destination write cycle is subject to the same conditions as the source read cycle, with the transfer cycle changing accordingly. When calculating transfer cycles, take into consideration each condition for the source read and the destination write cycle, respectively. For example, when data is transferred in 16 bit units and when both the source address and destination address are an odd address ((2) in **Figure 11.5**), two source read bus cycles and two destination write bus cycles are required.

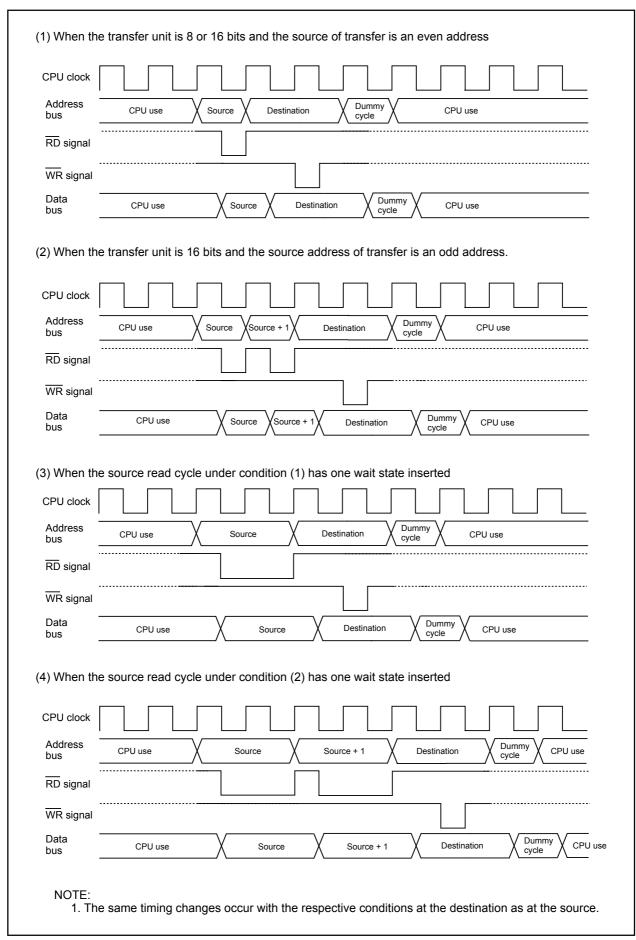


Figure 11.5 Transfer Cycles for Source Read

11.2. DMA Transfer Cycles

Any combination of even or odd transfer read and write adresses is possible. **Table 11.2** shows the number of DMA transfer cycles. **Table 11.3** shows the Coefficient j, k.

The number of DMAC transfer cycles can be calculated as follows:

No. of transfer cycles per transfer unit = No. of read cycles x j + No. of write cycles x k

Table 11.2 DMA Transfer Cycles

Transfer unit	Access address	No. of read cycles	No. of write cycles
8-bit transfers	Even	1	1
(DMBIT= 1)	Odd	1	1
16-bit transfers	Even	1	1
(DMBIT= 0)	Odd	2	2

Table 11.3 Coefficient j, k

	Internal Area			
	Internal R	OM, RAM	SF	R
	No wait	With wait	1 wait	2 wait
j	1	2	2	3
k	1	2	2	3

NOTE:

^{1.} Depends on the set value of PM20 bit in PM2 register

11.3 DMA Enable

When a data transfer starts after setting the DMAE bit in the DMiCON register (i = 0, 1) to 1 (enabled), the DMAC operates as follows:

- (a) Reload the forward address pointer with the SARi register value when the DSD bit in DMiCON register is 1 (forward) or the DARi register value when the DAD bit in the DMiCON register is 1 (forward).
- (b) Reload the DMAi transfer counter with the DMAi transfer counter reload register value.

If the DMAE bit is set to 1 again while it remains set, the DMAC performs the above operation. However, if a DMA request may occur simultaneously when the DMAE bit is being written, follow the steps below.

- (1) Write 1 to bits DMAE and DMAS in DMiCON register simultaneously.
- (2) Make sure that the DMAi is in an initial state as described above (a) and (b) by program.

If the DMAi is not in an initial state, the above steps should be repeated.

11.4 DMA Request

The DMAC can generate a DMA request as triggered by the cause of request that is selected with the DMS bit and bits DSEL3 to DSEL0 in the DMiSL register (i = 0, 1) on either channel. **Table 11.4** shows the timing at which the DMAS bit changes state.

Whenever a DMA request is generated, the DMAS bit is set to 1 (DMA requested) regardless of whether or not the DMAE bit is set. If the DMAE bit was set to 1 (enabled) when this occurred, the DMAS bit is set to 0 (DMA not requested) immediately before a data transfer starts. This bit cannot be set to 1 by program (it can only be set to 0).

The DMAS bit may be set to 1 when the DMS or the DSEL3 to DSEL0 bits change state. Therefore, always be sure to set the DMAS bit to 0 after changing the DMS or the DSEL3 to DSEL0 bits.

Because if the DMAE bit is set to 1, a data transfer starts immediately after a DMA request is generated, the DMAS bit in almost all cases is 0 when read by program. Read the DMAE bit to determine whether the DMAC is enabled.

Table 11.4 Timing at Which the DMAS Bit Changes State

DMA Factor	DMAS Bit in the DMiCON Register		
DIVIT COLO	Timing at which the bit is set to 1	Timing at which the bit is set to 0	
Software trigger	When the DSR bit in the DMiSL register is set to 1	Immediately before a data transfer starts When set by writing 0 by program	
Peripheral function	When the interrupt control register for the peripheral function that is selected by bits DSEL3 to DSEL0 and the DMS bit in the DMiSL register has its IR bit set to 1		

11.5 Channel Priority and DMA Transfer Timing

If both DMA0 and DMA1 are enabled and DMA transfer request signals from DMA0 and DMA1 are detected active in the same sampling period (one period from a falling edge to the next falling edge of CPU clock), the DMAS bit on each channel is set to 1 (DMA requested) at the same time. In this case, the DMA requests are arbitrated according to the channel priority, DMA0 > DMA1. The following describes DMAC operation when DMA0 and DMA1 requests are detected active in the same sampling period. **Figure 11.6** shows an example of DMA transfer effected by external factors.

DMA0 request having priority is received first to start a transfer when a DMA0 request and DMA1 request are generated simultanelously. After one DMA0 transfer is completed, a bus arbitration is returned to the CPU. When the CPU has completed one bus access, a DMA1 transfer starts. After one DMA1 transfer is completed, the bus arbitration is again returned to the CPU.

In addition, DMA requests cannot be counted up since each channel has one DMAS bit. Therefore, when DMA requests, as DMA1 in **Figure 11.6** occurs more than one time, the DAMS bit is set to 0 as soon as getting the bus arbitration. The bus arbitration is returned to the CPU when one transfer is completed.

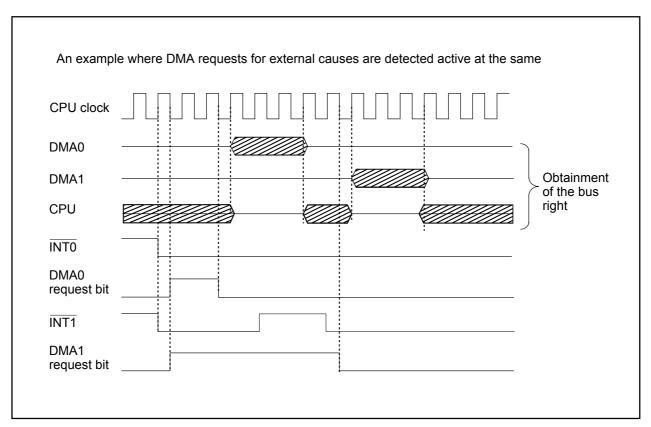


Figure 11.6 DMA Transfer by External Factors

12. Timers

Eight 16-bit timers, each capable of operating independently of the others, can be classified by function as either timer A (five) and timer B (three). The count source for each timer acts as a clock, to control such timer operations as counting, reloading, etc. **Figures 12.1** and **12.2** show block diagrams of timer A and timer B configuration, respectively.

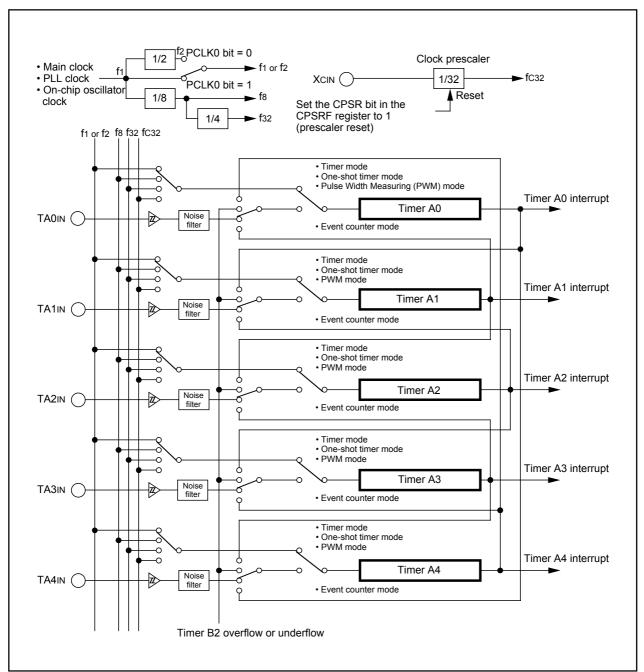


Figure 12.1 Timer A Configuration

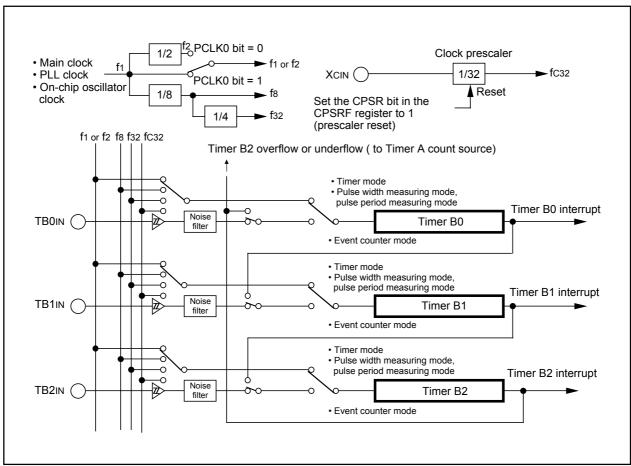


Figure 12.2. Timer B Configuration

12.1 Timer A

Figure 12.3 shows a block diagram of the timer A. **Figures 12.4** to **12.6** show registers related to the timer A. The timer A supports the following four modes. Except in event counter mode, timers A0 to A4 all have the same function. Use bits TMOD1 to TMOD0 in the TAiMR register (i = 0 to 4) to select the desired mode.

- Timer mode: The timer counts an internal count source.
- Event counter mode: The timer counts pulses from an external device or overflows and underflows of other timers
- One-shot timer mode: The timer outputs a pulse only once before it reaches the minimum count 000016.
- Pulse width modulation (PWM) mode: The timer outputs pulses in a given width successively.

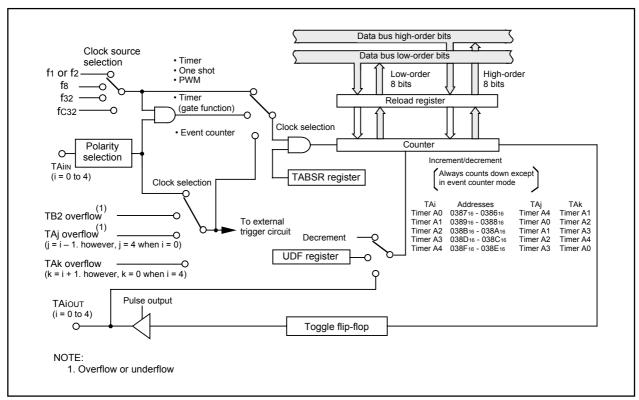


Figure 12.3 Timer A Block Diagram

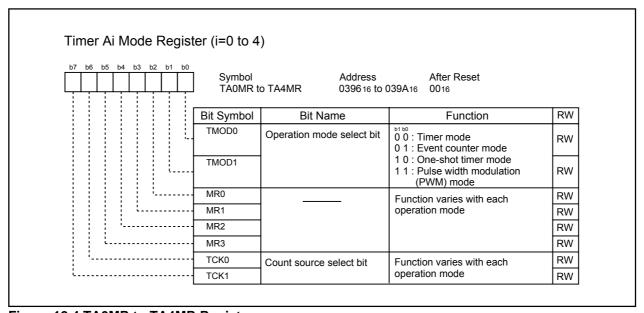
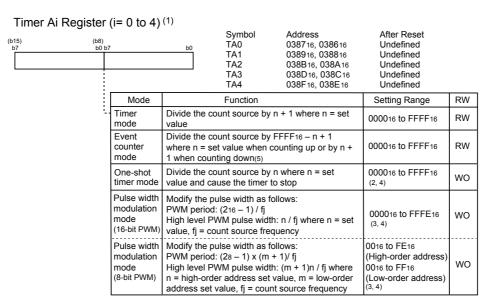
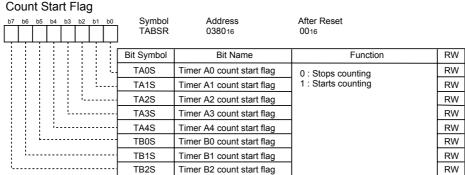


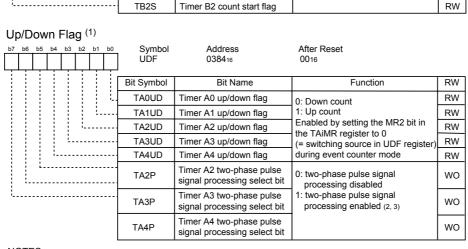
Figure 12.4 TA0MR to TA4MR Registers



NOTES:

- 1. The register must be accessed in 16 bit units.
- 2. If the TAi register is set to 000016, the counter does not work and timer Ai interrupt requests are not generated either. Furthermore, if "pulse output" is selected, no pulses are output from the TAiOUT pin.
- 3. If the TAi register is set to 000016, the pulse width modulator does not work, the output level on the TAiOUT pin remains low, and timer Ai interrupt requests are not generated either. The same applies when the 8 high-order bits of the timer TAi register are set to 000016 while operating as an 8-bit pulse width modulator.
- 4. Use the MOV instruction to write to the TAi register.
- 5. The timer counts pulses from an external device or overflows or underflows in other timers.

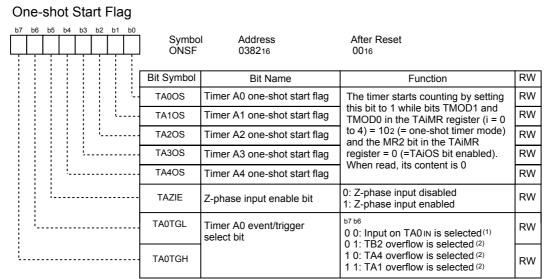




NOTES:

- 1. Use MOV instruction to write to this register.
- Make sure the port direction bits for the TA2IN to TA4IN and TA2OUT to TA4OUT pins are set to 0 input mode.
- 3. When the two-phase pulse signal processing function is not used, set the corresponding bit to 0.

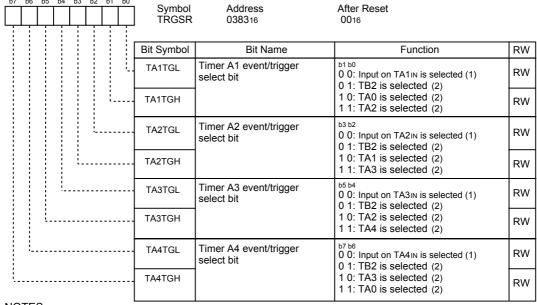
Figure 12.5 TA0 to TA4 Registers, TABSR Register, and UDF Register



NOTES:

- 1. Make sure the PD7_1 bit in the PD7 register is set to 0 (input mode).
- 2. Overflow or underflow.

Trigger Select Register



NOTES:

- 1. Make sure the port direction bits for the TA1IN to TA4IN pins are set to 0 (input mode).
- 2. Overflow or underflow.

Clock Prescaler Reset Flag

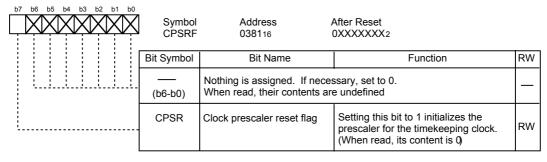


Figure 12.6 ONSF Register, TRGSR Register, and CPSRF Register

12.1.1 Timer Mode

In timer mode, the timer counts a count source generated internally (see **Table 12.1**). **Figure 12.7** shows TAiMR register in timer mode.

Table 12.1 Specifications in Timer Mode

Item	Specification		
Count source	f1, f2, f8, f32, fC32		
Count operation	Decrement		
	When the timer underflows, it reloads the reload register contents and continues counting		
Divide ratio	1/(n+1) n: set value of TAi register (i= 0 to 4) 000016 to FFFF16		
Count start condition	Set TAiS bit in the TABSR register to 1 (start counting)		
Count stop condition	Set TAiS bit to 0 (stop counting)		
Interrupt request generation timing	Timer underflow		
TAilN pin function	I/O port or gate input		
TAiout pin function	I/O port or pulse output		
Read from timer	Count value can be read by reading TAi register		
Write to timer	When not counting and until the 1st count source is input after counting start		
	Value written to TAi register is written to both reload register and counter		
	When counting (after 1st count source input)		
	Value written to TAi register is written to only reload register		
	(Transferred to counter when reloaded next)		
Select function	Gate function		
	Counting can be started and stopped by an input signal to TAilN pin		
	Pulse output function		
	Whenever the timer underflows, the output polarity of TAio∪⊤ pin is inverted.		
	When not counting, the pin outputs a low.		

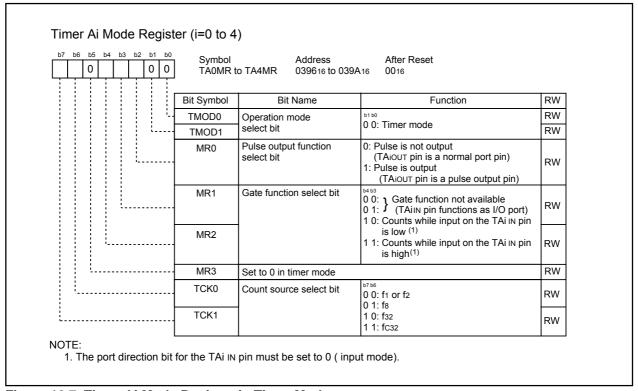


Figure 12.7 Timer Ai Mode Register in Timer Mode

12.1.2 Event Counter Mode

In event counter mode, the timer counts pulses from an external device or overflows and underflows of other timers. Timers A2, A3, and A4 can count two-phase external signals. **Table 12.2** lists specifications in event counter mode (when <u>not</u> processing two-phase pulse signal). **Table 12.3** lists specifications in event counter mode (when processing two-phase pulse signal with the timers A2, A3 and A4). **Figure 12.8** shows TAiMR register in event counter mode (when <u>not</u> processing two-phase pulse signal). **Figure 12.9** shows TA2MR to TA4MR registers in event counter mode (when processing two-phase pulse signal with the timers A2, A3 and A4).

Table 12.2 Specifications in Event Counter Mode (when not processing two-phase pulse signal)

Item	Specification		
Count source	• External signals input to TAilN pin (i=0 to 4) (effective edge can be selected		
	in program)		
	Timer B2 overflows or underflows,		
	timer Aj (j=i-1, except j=4 if i=0) overflows or underflows,		
	timer Ak (k=i+1, except k=0 if i=4) overflows or underflows		
Count operation	Increment or decrement can be selected by external signal or program		
	When the timer overflows or underflows, it reloads the reload register con-		
	tents and continues counting. When operating in free-running mode, the		
	timer continues counting without reloading.		
Divided ratio	1/ (FFFF ₁₆ - n + 1) for increment		
	1/ (n + 1) for down-count n : set value of TAi register 000016 to FFFF16		
Count start condition	Set TAiS bit in the TABSR register to 1 (start counting)		
Count stop condition	Set TAiS bit to 0 (stop counting)		
Interrupt request generation timing	Timer overflow or underflow		
TAilN pin function	I/O port or count source input		
TAiout pin function	I/O port, pulse output, or up/down-count select input		
Read from timer	Count value can be read by reading TAi register		
Write to timer	When not counting and until the 1st count source is input after counting start		
	Value written to TAi register is written to both reload register and counter		
	When counting (after 1st count source input)		
	Value written to TAi register is written to only reload register		
	(Transferred to counter when reloaded next)		
Select function	Free-run count function		
	Even when the timer overflows or underflows, the reload register content is		
	not reloaded to it		
	Pulse output function		
	Whenever the timer underflows or underflows, the output polarity of TAio∪⊤		
	pin is inverted . When not counting, the pin outputs a low.		

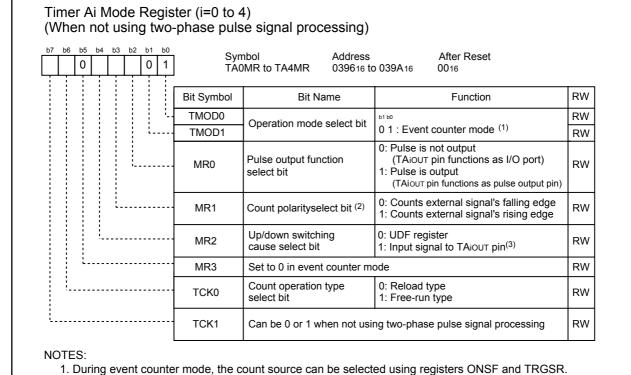


Figure 12.8 TAiMR Register in Event Counter Mode (when not using two-phase pulse signal processing)

direction bit for TAiouT pin must be set to 0 (input mode).

2. Effective when bits TAiTGH and TAiTGL in the ONSF or TRGSR register are 002 (TAiN pin input).
3. Decrement when input on TAiOUT pin is low or increment when input on that pin is high. The port

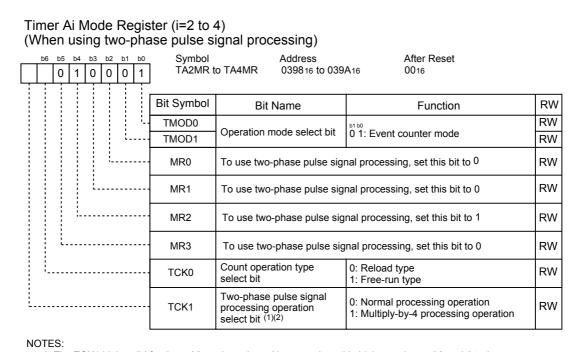
Table 12.3 Specifications in Event Counter Mode (when processing two-phase pulse signal with timers A2, A3 and A4)

Item	Specification		
Count source	• Two-phase pulse signals input to TAilN or TAiOUT pins (i = 2 to 4)		
Count source Count operation			
Count operation	 Increment or down-count can be selected by two-phase pulse signal When the timer overflows or underflows, it reloads the reload register con- 		
	tents and continues counting. When operating in free-running mode, the		
	timer continues counting without reloading.		
Divide ratio	1/ (FFFF16 - n + 1) for increment		
Divide ratio	1/ (n + 1) for down-count n : set value of TAi register 000016 to FFFF16		
Count start condition	Set TAIS bit in the TABSR register to 1 (start counting)		
Count start condition	Set TAIS bit to 0 (stop counting)		
<u> </u>	Timer overflow or underflow		
Interrupt request generation timing			
TAin pin function	Two-phase pulse input		
TAiout pin function	Two-phase pulse input		
Read from timer	Count value can be read by reading timer A2, A3 or A4 register		
Write to timer	• When not counting and until the 1st count source is input after counting start		
	Value written to TAi register is written to both reload register and counter		
	When counting (after 1st count source input)		
	Value written to TAi register is written to reload register		
	(Transferred to counter when reloaded next)		
Select function (Note)	Normal processing operation (timer A2 and timer A3)		
	The timer counts up rising edges or counts down falling edges on TAjiN pin		
	when input signals on TAjo∪⊤ pin is "H".		
	TAjout		
	TAjIN Increment Increment Decrement Decrement Decrement		
	• Multiply-by-4 processing operation (timer A3 and timer A4) If the phase relationship is such that TAkin(k=3, 4) pin goes "H" when the input signal on TAkout pin is "H", the timer counts up rising and falling edges on TAkout and TAkin pins. If the phase relationship is such that TAkin pin goes "L" when the input signal on TAkout pin is "H", the timer counts down rising and falling edges on TAkout and TAkin pins.		
	TAKOUT Increment all edges Decrement all edges		
	TAkin (k=3,4) Increment all edges Decrement all edges		
	• Counter initialization by 7 phase input (timer 43)		
	Counter initialization by Z-phase input (timer A3) The timer count value is initialized to 0 by Z-phase input.		
	i The timer count value is initialized to 0 by Z-phase input.		

NOTE:

1. Only timer A3 is selectable. Timer A2 is fixed to normal processing operation, and timer A4 is fixed to multiply-by-4 processing operation.

12. Timer A M16C/29 Group



- 1. The TCK1 bit is valid for timer A3 mode register. No matter how this bit is set, timers A2 and A4 always operate in normal processing mode and x4 processing mode, respectively.

 2. If two-phase pulse signal processing is desired, following register settings are required:
- - Set the TAiP bit in the UDF register to 1 (two-phase pulse signal processing function enabled).
 - Set bits TAiTGH and TAiTGL in the TRGSR register to 002 (TAilN pin input).
 - Set the port direction bits for TAin and TAiout to 0 (input mode).

Figure 12.9 TA2MR to TA4MR Registers in Event Counter Mode (when using two-phase pulse signal processing with timer A2, A3 or A4)

12.1.2.1 Counter Initialization by Two-Phase Pulse Signal Processing

This function initializes the timer count value to 0 by Z-phase (counter initialization) input during two-phase pulse signal processing.

This function can only be used in timer A3 event counter mode during two-phase pulse signal processing, free-running type, x4 processing, with Z-phase entered from the INT2 pin.

Counter initialization by Z-phase input is enabled by writing 000016 to the TA3 register and setting the TAZIE bit in ONSF register to 1 (Z-phase input enabled).

Counter initialization is accomplished by detecting Z-phase input edge. The active edge can be chosen to be the rising or falling edge by using the POL bit in the INT2IC register. The Z-phase pulse width applied to the INT2 pin must be equal to or greater than one clock cycle of the timer A3 count source.

The counter is initialized at the next count timing after recognizing Z-phase input. **Figure 12.10** shows the relationship between the two-phase pulse (A phase and B phase) and the Z phase.

If timer A3 overflow or underflow coincides with the counter initialization by Z-phase input, a timer A3 interrupt request is generated twice in succession. Do not use the timer A3 interrupt when using this function.

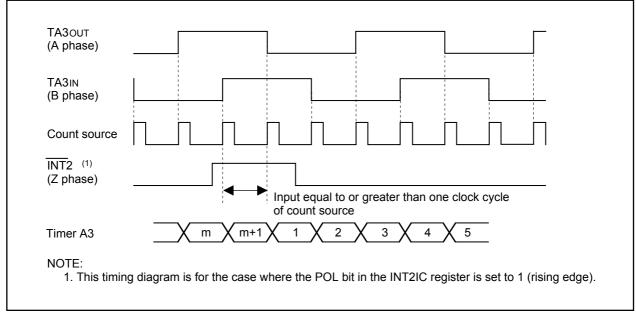


Figure 12.10 Two-phase Pulse (A phase and B phase) and the Z Phase

12.1.3 One-shot Timer Mode

In one-shot timer mode, the timer is activated only once by one trigger. (See **Table 12.4**) When the trigger occurs, the timer starts up and continues operating for a given period. **Figure 12.11** shows the TAiMR register in one-shot timer mode.

Table 12.4 Specifications in One-shot Timer Mode

Item	Specification	
Count source	f1, f2, f8, f32, fC32	
Count operation	Decrement	
	When the counter reaches 000016, it stops counting after reloading a new value	
	If a trigger occurs when counting, the timer reloads a new count and restarts counting	
Divide ratio	1/n n: set value of TAi register 000016 to FFFF16	
	However, the counter does not work if the divide-by-n value is set to 000016.	
Count start condition	TAiS bit in the TABSR register is set to 1 (start counting) and one of the	
	following triggers occurs.	
	• External trigger input from the TAilN pin	
	Timer B2 overflow or underflow,	
	timer Aj (j=i-1, except j=4 if i=0) overflow or underflow,	
	timer Ak (k=i+1, except k=0 if i=4) overflow or underflow	
	The TAiOS bit in the ONSF register is set to 1 (timer starts)	
Count stop condition	When the counter is reloaded after reaching 000016	
	TAiS bit is set to 0 (stop counting)	
Interrupt request generation timing	When the counter reaches 000016	
TAilN pin function	I/O port or trigger input	
TAiout pin function	I/O port or pulse output	
Read from timer	An undefined value is read by reading TAi register	
Write to timer	When not counting and until the 1st count source is input after counting start	
	Value written to TAi register is written to both reload register and counter	
	When counting (after 1st count source input)	
	Value written to TAi register is written to only reload register	
	(Transferred to counter when reloaded next)	
Select function	Pulse output function	
	The timer outputs a low when not counting and a high when counting.	

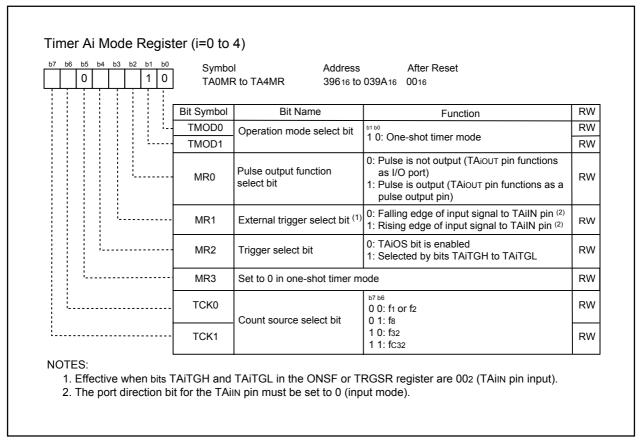


Figure 12.11 TAiMR Register in One-shot Timer Mode

12.1.4 Pulse Width Modulation (PWM) Mode

In PWM mode, the timer outputs pulses of a given width in succession (see **Table 12.5**). The counter functions as either 16-bit pulse width modulator or 8-bit pulse width modulator. **Figure 12.12** shows TAiMR register in pulse width modulation mode. **Figures 12.13** and **12.14** show examples of how a 16-bit pulse width modulator operates and how an 8-bit pulse width modulator operates.

Table 12.5 Specifications in Pulse Width Modulation Mode

Item	Specification
Count source	f1, f2, f8, f32, fC32
Count operation	Decrement (operating as an 8-bit or a 16-bit pulse width modulator)
	The timer reloads a new value at a rising edge of PWM pulse and continues counting
	The timer is not affected by a trigger that occurs during counting
16-bit PWM	High level width
	• Cycle time (2 ¹⁶ -1) / fj fixed fj: count source frequency (f1, f2, f8, f32, fC32)
8-bit PWM	High level width n x (m+1) / fj n : set value of TAi register high-order address
	Cycle time (2 ⁸ -1) x (m+1) / fj m : set value of TAi register low-order address
Count start condition	TAiS bit in the TABSR register is set to 1 (= start counting)
	• The TAiS bit = 1 and external trigger input from the TAiIN pin
	The TAiS bit = 1 and one of the following external triggers occurs
	Timer B2 overflow or underflow,
	timer Aj (j=i-1, except j=4 if i=0) overflow or underflow,
	timer Ak (k=i+1, except k=0 if i=4) overflow or underflow
Count stop condition	TAiS bit is set to 0 (stop counting)
Interrupt request generation timing	PWM pulse goes "L"
TAilN pin function	I/O port or trigger input
TAiout pin function	Pulse output
Read from timer	An undefined value is read by reading TAi register
Write to timer	When not counting and until the 1st count source is input after counting start
	Value written to TAi register is written to both reload register and counter
	When counting (after 1st count source input)
	Value written to TAi register is written to only reload register
	(Transferred to counter when reloaded next)

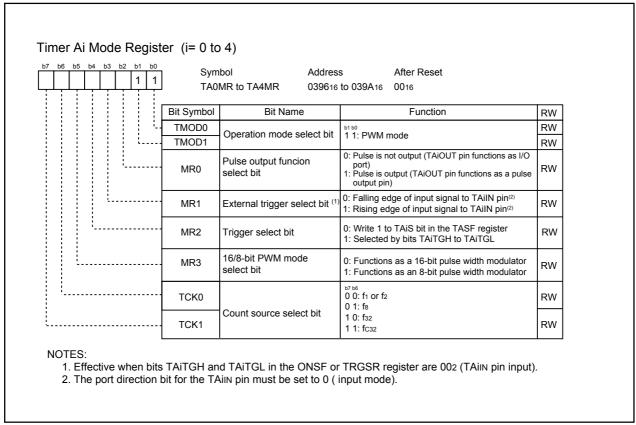


Figure 12.12 TAiMR Register in Pulse Width Modulation Mode

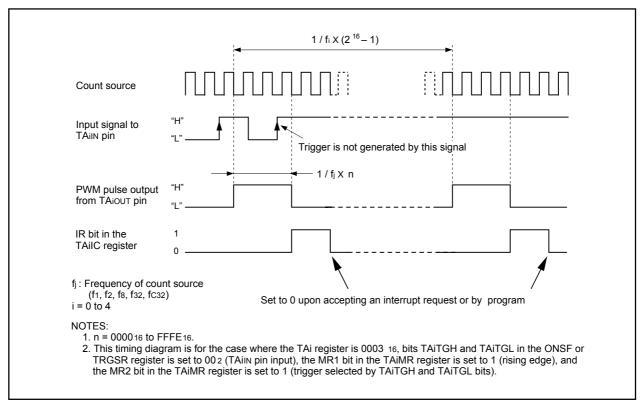


Figure 12.13 Example of 16-bit Pulse Width Modulator Operation

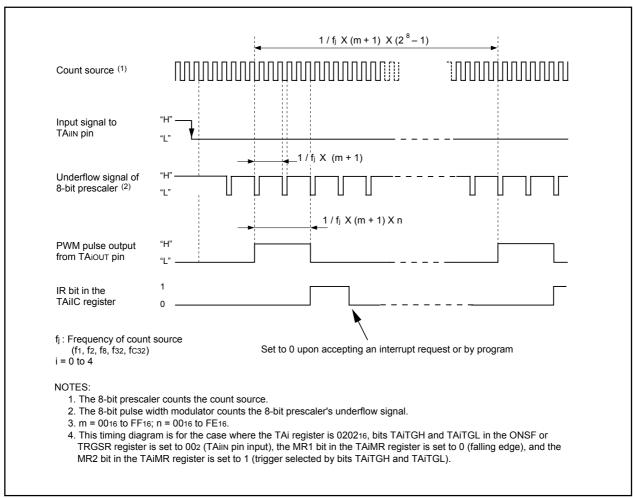


Figure 12.14 Example of 8-bit Pulse Width Modulator Operation

12.2 Timer B

Figure 12.15 shows a block diagram of the timer B. **Figures 12.16** and **12.17** show registers related to the timer B.

Timer B supports the following four modes. Use bits TMOD1 and TMOD0 in the TBiMR register (i = 0 to 2) to select the desired mode.

- Timer mode: The timer counts the internal count source.
- Event counter mode: The timer counts the external pulses or overflows and underflows of other timers.
- Pulse period/pulse width measurement mode: The timer measures the pulse period or pulse width of external signal.
- A/D trigger mode: The timer starts counting by one trigger until the count value becomes 000016.
 This mode is used together with simultaneous sample sweep mode or delayed trigger mode 0 of A/D converter to start A/D conversion.

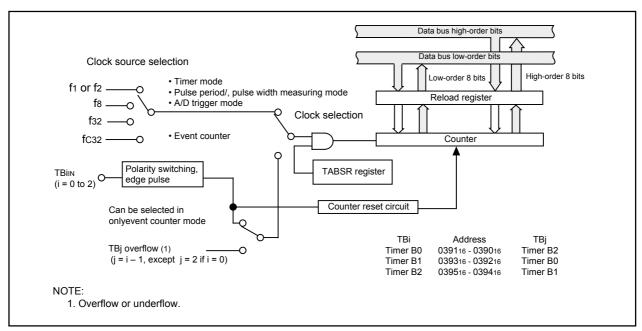


Figure 12.15 Timer B Block Diagram

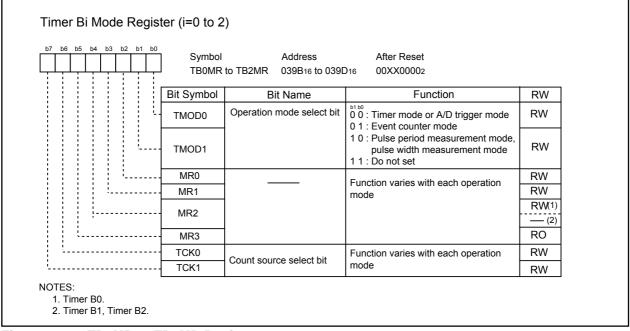
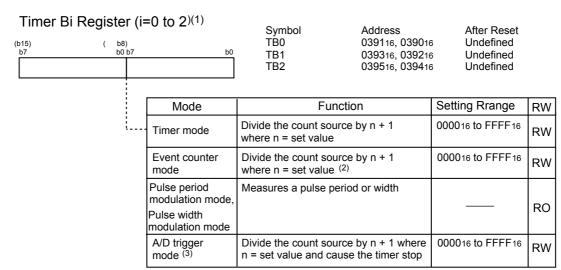


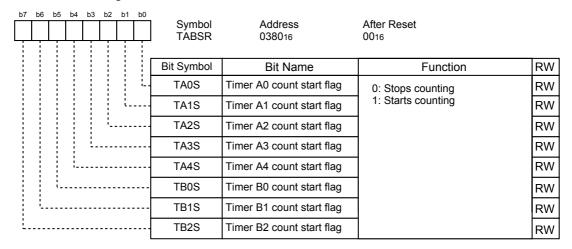
Figure 12.16 TB0MR to TB2MR Registers



NOTES:

- 1. The register must be accessed in 16 bit units.
- 2. The timer counts pulses from an external device or overflows or underflows of other timers.
- 3. When this mode is used combining delayed trigger mode 0, set the larger value than the value in the timer B0 register to the timer B1 register.

Count Start Flag



Clock Prescaler Reset flag

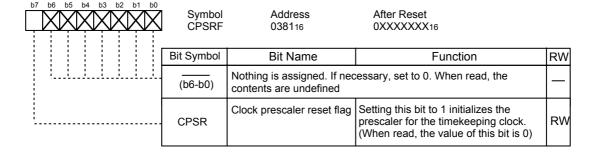


Figure 12.17 TB0 to TB2 Registers, TABSR Register, CPSRF Register

12.2.1 Timer Mode

In timer mode, the timer counts a count source generated internally (see **Table 12.6**). **Figure 12.18** shows TBiMR register in timer mode.

Table 12.6 Specifications in Timer Mode

Item	Specification	
Count source	f1, f2, f8, f32, fC32	
Count operation	Decrement	
	When the timer underflows, it reloads the reload register contents and	
	continues counting	
Divide ratio	1/(n+1) n: set value of TBi register (i= 0 to 2) 000016 to FFFF16	
Count start condition	Set TBiS bit ⁽¹⁾ to 1 (start counting)	
Count stop condition	Set TBiS bit to 0 (stop counting)	
Interrupt request generation timing	Timer underflow	
TBilN pin function	I/O port	
Read from timer	Count value can be read by reading TBi register	
Write to timer	When not counting and until the 1st count source is input after counting start	
	Value written to TBi register is written to both reload register and counter	
	When counting (after 1st count source input)	
	Value written to TBi register is written to only reload register	
	(Transferred to counter when reloaded next)	

NOTE:

1. Bits TB0S to TB2S are assigned to the bit 7 to bit 5 in the TABSR register.

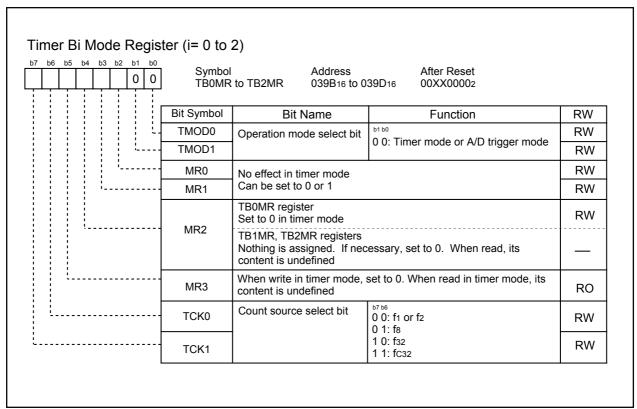


Figure 12.18 TBiMR Register in Timer Mode

12.2.2 Event Counter Mode

In event counter mode, the timer counts pulses from an external device or overflows and underflows of other timers (see **Table 12.7**). **Figure 12.19** shows the TBiMR register in event counter mode.

Table 12.7 Specifications in Event Counter Mode

Item	Specification	
Count source	• External signals input to TBiln pin (i=0 to 2) (effective edge can be selected	
	in program)	
	• Timer Bj overflow or underflow (j=i-1, except j=2 if i=0)	
Count operation	Decrement	
	When the timer underflows, it reloads the reload register contents and	
	continues counting	
Divide ratio	1/(n+1) n: set value of TBi register 000016 to FFFF16	
Count start condition	Set TBiS bit ⁽¹⁾ to 1 (start counting)	
Count stop condition	Set TBiS bit to 0 (stop counting)	
Interrupt request generation timing	Timer underflow	
TBilN pin function	Count source input	
Read from timer	Count value can be read by reading TBi register	
Write to timer	When not counting and until the 1st count source is input after counting start	
	Value written to TBi register is written to both reload register and counter	
	When counting (after 1st count source input)	
	Value written to TBi register is written to only reload register	
	(Transferred to counter when reloaded next)	

NOTE:

1. Bits TB2S to TB0S are assigned to the bit 7 to bit 5 in the TABSR register.

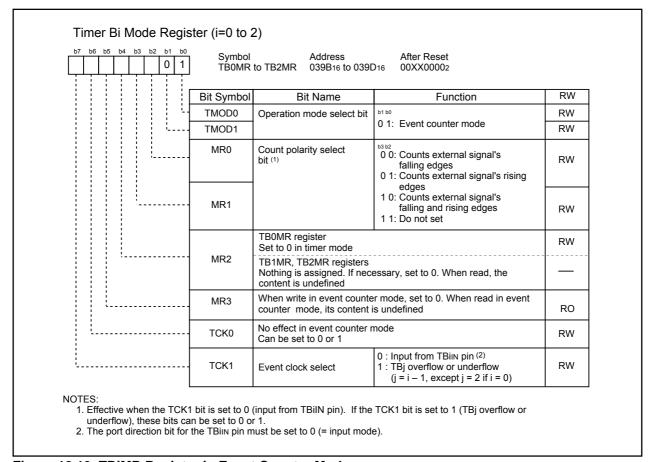


Figure 12.19 TBiMR Register in Event Counter Mode

12.2.3 Pulse Period and Pulse Width Measurement Mode

In pulse period and pulse width measurement mode, the timer measures pulse period or pulse width of an external signal (see **Table 12.8**). **Figure 12.20** shows the TBiMR register in pulse period and pulse width measurement mode. **Figure 12.21** shows the operation timing when measuring a pulse period. **Figure 12.22** shows the operation timing when measuring a pulse width.

Table 12.8 Specifications in Pulse Period and Pulse Width Measurement Mode

Item	Specification
Count source	f1, f2, f8, f32, fC32
Count operation	Increment
	Counter value is transferred to reload register at an effective edge of mea-
	surement pulse. The counter value is set to 000016 to continue counting.
Count start condition	Set TBiS (i=0 to 2) bit ⁽³⁾ to 1 (start counting)
Count stop condition	Set TBiS bit to 0 (stop counting)
Interrupt request generation timing	When an effective edge of measurement pulse is input (1)
	Timer overflow. When an overflow occurs, MR3 bit in the TBiMR register is set to
	1 (overflowed) simultaneously. MR3 bit is cleared to 0 (no overflow) by writing
	to TBiMR register at the next count timing or later after MR3 bit was set to 1. At
	this time, make sure TBiS bit is set to 1 (start counting).
TBiin pin function	Measurement pulse input
Read from timer	Contents of the reload register (measurement result) can be read by reading TBi register (2)
Write to timer	Value written to TBi register is written to neither reload register nor counter

NOTES:

- 1. Interrupt request is not generated when the first effective edge is input after the timer started counting.
- 2. Value read from TBi register is undefined until the second valid edge is input after the timer starts counting.
- 3. Bits TB0S to TB2S are assigned to the bit 5 to bit 7 in the TABSR register.

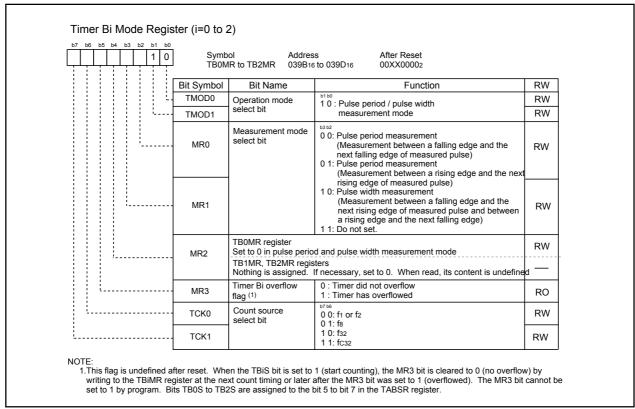


Figure 12.20 TBiMR Register in Pulse Period and Pulse Width Measurement Mode

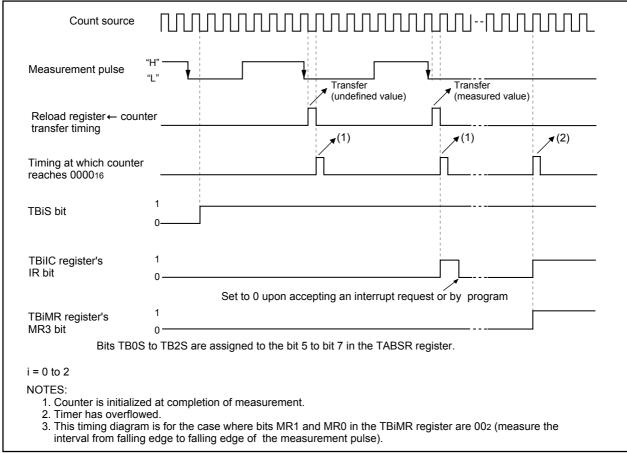


Figure 12.21 Operation timing when measuring a pulse period

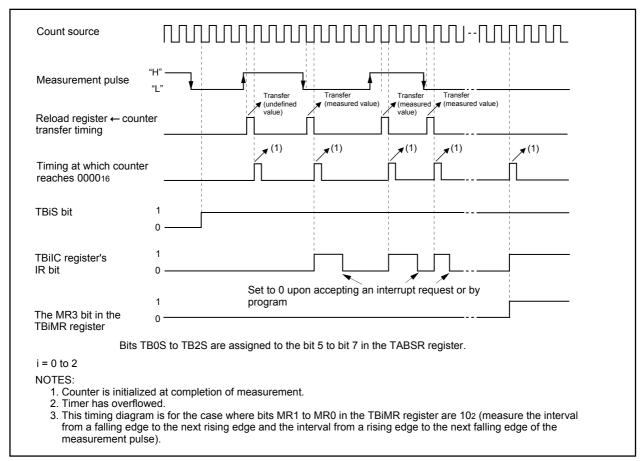


Figure 12.22 Operation timing when measuring a pulse width

12.2.4 A/D Trigger Mode

A/D trigger mode is used together with simultaneous sample sweep mode or delayed trigger mode 0 of A/D conversion to start A/D conversion. It is used in timer B0 and timer B1 only. In this mode, the timer starts counting by one trigger until the count value becomes 000016. **Figure 12.23** shows the TBiMR register in A/D trigger mode and **Figure 12.24** shows the TB2SC register.

Table 12.9 Specifications in A/D Trigger Mode

Item	Specification	
Count Source	f1, f2, f8, f32, and fC32	
Count Operation	Decrement	
	When the timer underflows, reload register contents are reloaded before	
	stopping counting	
	When a trigger is generated during the count operation, the count is not	
	affected	
Divide Ratio	1/(n+1) n: Setting value of TBi register (i=0,1)	
	000016-FFFF16	
Count Start Condition	When the TBiS (i=0,1) bit in the TABSR register is 1(count started),	
	TBiEN(i=0,1) in TB2SC register is 1 (A/D trigger mode) and the following	
	trigger is generated.(Selection based on bits TB2SEL in the TB2SC)	
	Timer B2 interrupt	
	Underflow of Timer B2 interrupt generation frequency counter setting	
Count Stop Condition	After the count value is 000016 and reload register contents are reloaded	
	Set the TBiS bit to 0 (count stopped)	
Interrupt Request	Timer underflows (1)	
Generation Timing		
TBiIN Pin Function	I/O port	
Read From Timer	Count value can be read by reading TBi register	
Write To Timer (2)	When writing in the TBi register during count stopped.	
	Value is written to both reload register and counter	
	When writing in the TBi register during count.	
NOTES	Value is written to only reload register (Transfered to counter when reloaded next)	

NOTES:

- 1: A/D conversion is started by the timer underflow. For details refer to **15. A/D Converter**.
- 2: When using in delayed trigger mode 0, set the larger value than the value of the timer B0 register to the timer B1 register.

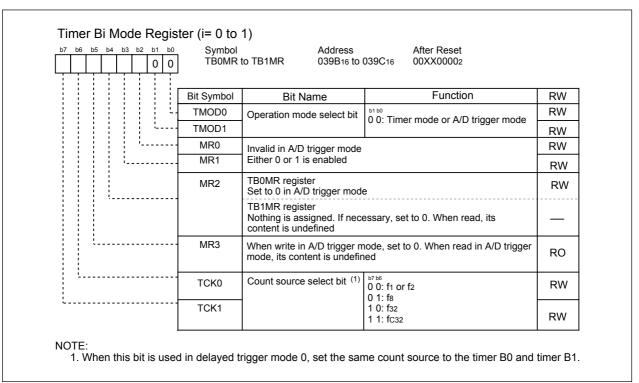
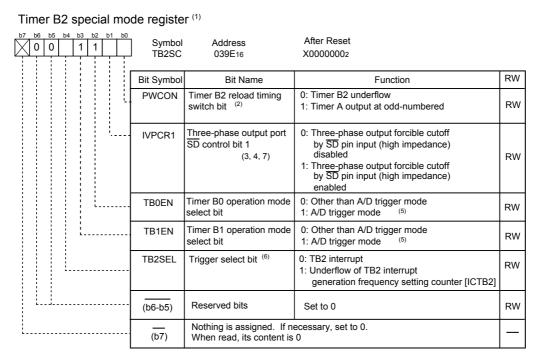


Figure 12.23 TBiMR Register in A/D Trigger Mode



NOTES:

- 1. Write to this register after setting the PRC1 bit in the PRCR register to 1 (write enabled).
- 2. If the INV11 bit is 0 (three-phase mode 0) or the INV06 bit is 1 (triangular wave modulation mode), set this bit to 0 (timer B2 underflow).
- 3. When setting the IVPCR1 bit to 1 (three-phase output forcible cutoff by $\overline{\text{SD}}$ pin input enabled), Set the PD85 bit to 0 (= input mode).
- 4. Related pins are U(P8₀), Ū(P8₁), V(P7₂), ∇(P7₃), W(P7₄), W(P7₅). When a high-level ("H") signal is applied to the SD pin and set the IVPCR1 bit to 0 after forcible cutoff, pins U, Ū, V, ∇, W, and ∇ are exit from the high-impedance state. If a low-level ("L") signal is applied to the SD pin, three-phase motor control timer output will be disabled (INV03=0). At this time, when the IVPCR1 bit is 0, pins U, Ū, V, ∇, W, and ∇ become programmable I/O ports. When the IVPCR1 bit is set to 1, pins U, Ū, V, ∇, W, and ∇ are placed in a high-impedance state regardless of which function of those pins is used.
- 5. When this bit is used in delayed trigger mode 0, set bits TB0EN and TB1EN to 1 (A/D trigger mode).
- 6. When setting the TB2SEL bit to 1 (underflow of TB2 interrupt generation frequency setting counter[ICTB2]), set the INV02 bit to 1 (three-phase motor control timer function).

Figure 12.24 TB2SC Register in A/D Trigger Mode

12.3 Three-phase Motor Control Timer Function

Timers A1, A2, A4 and B2 can be used to output three-phase motor drive waveforms. **Table 12.10** lists the specifications of the three-phase motor control timer function. **Figure 12.24** shows the block diagram for three-phase motor control timer function. Also, the related registers are shown on **Figures 12.26** to **12.32**.

Table 12.10 Three-phase Motor Control Timer Function Specifications

Item	Specification	
Three-phase waveform output pin	Six pins $(U, \overline{U}, V, \overline{V}, W, \overline{W})$	
Forced cutoff input (1)	Input "L" to SD pin	
Used Timers	Timer A4, A1, A2 (used in the one-shot timer mode)	
	Timer A4: U- and U-phase waveform control	
	Timer A1: V- and \overline{V} -phase waveform control	
	Timer A2: W- and W-phase waveform control	
	Timer B2 (used in the timer mode)	
	Carrier wave cycle control	
	Dead time timer (3 eight-bit timer and shared reload register)	
	Dead time control	
Output waveform	Triangular wave modulation, Sawtooth wave modification	
	Enable to output "H" or "L" for one cycle	
	Enable to set positive-phase level and negative-phase	
	level respectively	
Carrier wave cycle	Triangular wave modulation: count source x (m+1) x 2	
	Sawtooth wave modulation: count source x (m+1)	
	m: Setting value of TB2 register, 0 to 65535	
	Count source: f1, f2, f8, f32, fC32	
Three-phase PWM output width	Triangular wave modulation: count source x n x 2	
	Sawtooth wave modulation: count source x n	
	n: Setting value of TA4, TA1 and TA2 register (of TA4,	
	TA41, TA1, TA11, TA2 and TA21 registers when setting	
	the INV11 bit to 1), 1 to 65535	
	Count source: f1, f2, f8, f32, fC32	
Dead time	Count source x p, or no dead time	
	p: Setting value of DTT register, 1 to 255	
	Count source: f1, f2, f1 divided by 2, f2 divided by 2	
Active level	Eable to select "H" or "L"	
Positive and negative-phase concurrent	Positive and negative-phases concurrent active disable	
	function	
	Positive and negative-phases concurrent active detect func-	
Intermediate from the property	tion	
Interrupt frequency	For Timer B2 interrupt, select a carrier wave cycle-to-cycle	
	basis through 15 times carrier wave cycle-to-cycle basis	

NOTE:

1. When the INV02 bit in the INVC0 register is set to 1 (three-phase motor control timer function), the \overline{SD} function of the P85/ \overline{SD} pin is enabled. At this time, the P85 pin cannot be used as a programmable I/O port. When the \overline{SD} function is not used, apply "H" to the P85/ \overline{SD} pin.

When the IVPCR1 bit in the TB2SC register is set to 1 (enable three-phase output forced cutoff by \overline{SD} pin input), and "L" is applied to the \overline{SD} pin, the related pins enter high-impedance state regardless of the functions which are used. When the IVPCR1 bit is set to 0 (disabled three-phase output forced cutoff by \overline{SD} pin input) and "L" is applied to the \overline{SD} pin, the related pins can be selected as a programmable I/O port and the setting of the port and port direction registers are enable.

Related pins: P72/CLK2/TA1out/V/RXD1 P73/CTS2/RTS2/TA1in/V/TXD1

P74/TA20UT/W P75/TA2IN/W P80/TA40UT/U P81/TA4IN/U



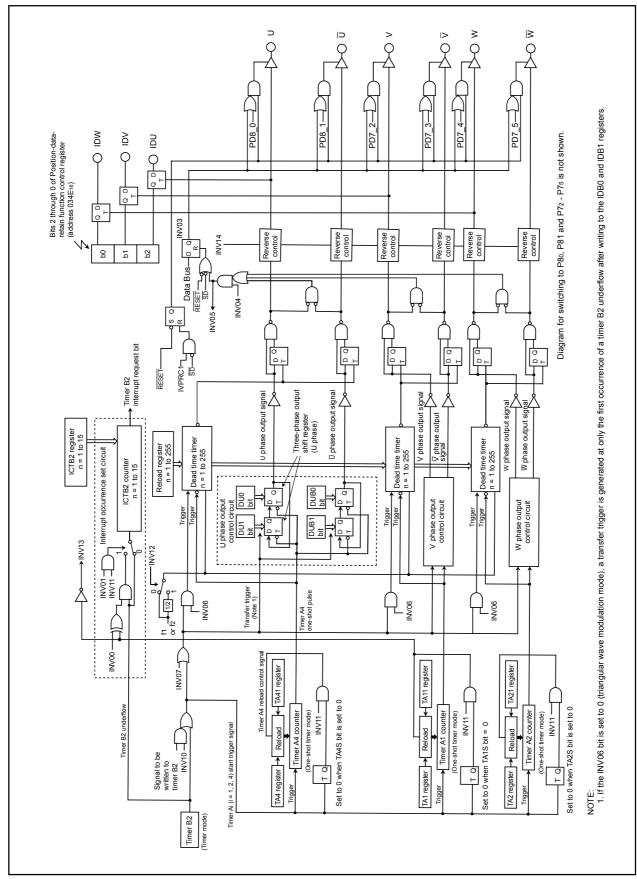


Figure 12.25 Three-phase Motor Control Timer Functions Block Diagram

Three-phase PWM C	ontrol Regi	ster 0 ⁽¹⁾		
b7 b6 b5 b4 b3 b2 b1 b0	Symbol INVC0	Address 0348 ₁₆	After Reset 0016	
	Bit Symbol	Bit Name	Function	RW
	INV00	Effective interrupt output polarity select bit ⁽³⁾	O: ICTB2 counter is incremented by 1 on the rising edge of timer A1 reload control signal 1: ICTB2 counter is incremented by 1 on the falling edge of timer A1 reload control signal	RW
	INV01	Effective interrupt output specification bit ^(2, 3)	0: ICTB2 counter incremented by 1 at a timer B2 underflow 1: Selected by INV00 bit	RW
	INV02	Mode select bit ⁽⁴⁾	Three-phase motor control timer function unused Three-phase motor control timer function (5)	RW
	INV03	Output control bit ⁽⁶⁾	Three-phase motor control timer output disabled (5) Three-phase motor control timer output enabled	RW
	INV04	Positive and negative phases concurrent output disable bit	Simultaneous active output enabled Simultaneous active output disabled	RW
	INV05	Positive and negative phases concurrent output detect flag	0: Not detected yet 1: Already detected (7)	RW
	INV06	Modulation mode select bit(8)	0: Triangular wave modulation mode 1: Sawtooth wave modulation mode ⁽⁹⁾	RW
	INV07	Software trigger select bit	Setting this bit to 1 generates a transfer trigger. If the INV06 bit is 1, a trigger for the dead time timer is also generated. The value of this bit when read is 0	RW

NOTES:

- 1. Write to this register after setting the PRC1 bit in the PRCR register to 1 (write enable). Note also that bits INV00 to INV02, bits INV04 and INV06 can only be rewritten when timers A1, A2, A4 and B2 are idle.
- 2. If this bit needs to be set to 1, set any value in the ICTB2 register before writing to it.
- 3. Effective when the INV11 bit in the INV1 register is 1 (three-phase mode 1). If INV11 is set to 0 (three-phase mode 0), the ICTB2 counter is incremented by 1 each time the timer B2 underflows, regardless of whether the INV00 and INV01 bits are set. When setting the INV01 bit to 1, the first interrupt is generated when the timer B2 underflows n-1 times, if n is the value set in the ICTB2 counter. Subsequent interrupts are generated every n times the timer B2 underflow.
- 4. Setting the INV02 bit to 1 activates the dead time timer, U/V/W-phase output control circuits and ICTB2 counter.
- 5. When the INV02 bit is set to 1 and the INV03 bit is set to 0, Ū, Ū, ∇, V, ₩, W pins, including pins shared with other output functions, enter a high-impedance state. When INV03 is set to 1, U/V/W corresponding pins generate the three-phase PWM output.
- 6. The INV03 bit is set to 0 in the following cases:
 - When reset
 - \bullet When positive and negative go active (INV05 = 1) simultaneously while INV04 bit is 1
 - When set to 0 by program
 - When input on the \overline{SD} pin changes state from "H" to "L" regardless of the value of the INVCR1 bit. (The INV03 bit cannot be set to 1 when \overline{SD} input is "L".) INV03 is set to 0 when both bits INV05 and INV04 are set to 1.

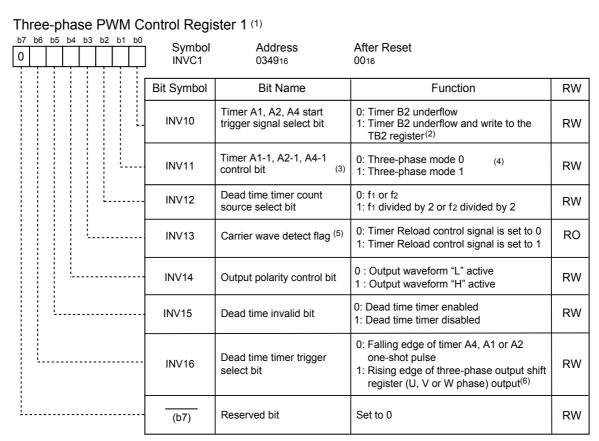
Item	INV06=0	INV06=1
Mode	Triangular wave modulation mode	Sawtooth wave modulation mode
Timing at which transferred from registers IDB0 to IDB1 to three-phase output shift register	Transferred only once synchronously with the transfer trigger after writing to registers IDB0 to IDB1	Transferred every transfer trigger
Timing at which dead time timer trigger is generated when INV16 bit is 0	Synchronous with the falling edge of timer A1, A2, or A4 one-shot pulse	Synchronous with the transfer trigger and the falling edge of timer A1, A2, or A4 one-shot pulse
INV13 bit	Effective when INV11 is set to 1 and INV06 is set to 0	No effect

Transfer trigger: Timer B2 underflow, write to the INV07 bit or write to the TB2 register when the INV10 bit is set to 1.

- 9: If the INV06 bit is set to 1, set the INV11 bit to 0 (three-phase mode 0) and set the PWCON bit to 0 (timer B2 reloaded by a timer B2 underflow)
- 10. When the PFCi (i = 0 to 5) bit in the PFCR register is set to 1 (three-phase PWM output), individual pins are enabled to output.

Figure 12.26 INVC0 Register





NOTES:

- 1. Write to this register after setting the PRC1 bit in the PRCR register to 1 (write enable). Note also that this register can only be rewritten when timers A1, A2, A4 and B2 are idle.
- 2. A start trigger is generated by writing to the TB2 register only while timer B2 stops.
- 3. The effects of the INV11 bit are described in the table below.

Item	INV11=0	INV11=1
Mode	Three-phase mode 0	Three-phase mode 1
TA11, TA21, TA41 registers	Not Used	Used
INV00 bit, INV01 bit	Has no effect. ICTB2 counted every time timer B2 underflows regardless of whether bits INV00 and INV01 are set	Effect
INV13 bit	Has no effect	Effective when INV11 bit is 1 and INV06 bit is 0

- 4. If the INV06 bit is 1 (sawtooth wave modulation mode), set this bit to 0 (three-phase mode 0). Also, if the INV11 bit is 0, set the PWCON bit to 0 (timer B2 reloaded by a timer B2 underflow).
- 5. The INV13 bit is effective only when the INV06 bit is set to 0 (triangular wave modulation mode) and the INV11 bit is set to 1 (three-phase mode 1).
- 6. If all of the following conditions hold true, set the INV16 bit to 1 (dead time timer triggered by the rising edge of threephase output shift register output)
 - The INV15 bit is 0 (dead time timer enabled)
 - When the INV03 bit is set to 1 (three-phase motor control timer output enabled), the Dij bit and DiBj bit (i:U, V, or W, j: 0 to 1) have always different values (the positive-phase and negative-phase always output different levels during the period other than dead time).

Conversely, if either one of the above conditions holds false, set the INV16 bit to 0 (dead time timer triggered by the falling edge of one-shot pulse).

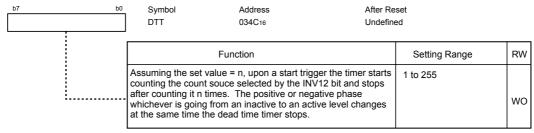
Figure 12.27 INVC1 Register

Three-phase Output Buffer Register(i=0,1) (1) Symbol Address After Reset 0 0 IDB0 034A₁₆ 001111112 IDR1 034B₁₆ 001111112 Bit Symbol Bit Name RW Function U phase output buffer i Write the output level RW 0. Active level 1: Inactive level DUBi U phase output buffer i RW When read, these bits show the three-phase DVi RW V phase output buffer i output shift register value. DVBi V phase output buffer i RW DWi W phase output buffer i RW DWBi RW W phase output buffer i Nothing is assigned. If necessary, set to 0. When read, RO (b7-b6) these contents are 0

NOTE:

1. Registers IDB0 and IDB1 values are transferred to the three-phase shift register by a transfer trigger. The value written to the IDB0 register aftera transfer trigger represents the output signal of each phase, and the next value written to the IDB1 register at the falling edge of the timer A1, A2, or A4 one-shot pulse represents the output signal of each phase

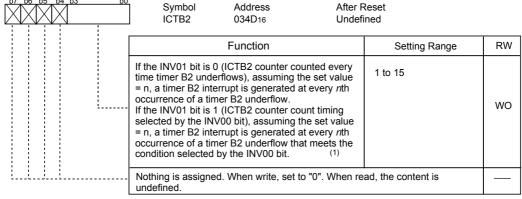
Dead Time Timer (1, 2)



NOTES:

- 1. Use MOV instruction to write to this register.
- 2. Effective when the INV15 bit is set to 0 (dead time timer enable). If the INV15 bit is set to 1, the dead time timer is disabled and has no effect.

Timer B2 Interrupt Occurrences Frequency Set Counter



1. Use MOV instruction to write to this register. If the INV01 bit is set to 1, make sure the TB2S bit also is set to 0 (timer B2 count stopped) when writing to this register. If the INV01 bit is set to 0, although this register can be written even when the TB2S bit is set to 1 (timer B2 count start), do not write synchronously with a timer B2 underflow.

Figure 12.28 IDB0 Register, IDB1Register, DTT Register, and ICTB2 Register

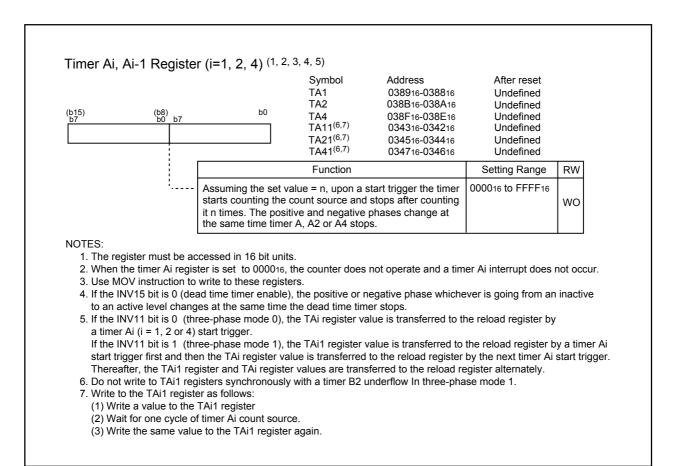


Figure 12.29 TA1, TA2, TA4, TA11, TA21, and TA41 Registers

Timer B2 Special Mode Register (1) After Reset Address 0 10 TB2SC 039E₁₆ X0000002 RW Bit Symbol Bit Name Function **PWCON** Timer B2 reload timing 0: Timer B2 underflow RW switch bit (2) 1: Timer A output at odd-numbered Three-phase output port IVPCR1 0: Three-phase output forcible cutoff by \$\overline{SD}\$ pin input SD control bit 1 (high impedance) disabled (3, 4, 7)1: Three-phase output forcible cutoff by SD pin input RW (high impedance) enabled Timer B0 operation mode 0: Other than A/D trigger mode TB0EN RW select hit 1: A/D trigger mode 0: Other than A/D trigger mode Timer B1 operation mode TB1EN RW select hit 1: A/D trigger mode TB2SEL Trigger select bit (6) 0: TB2 interrupt RW 1: Underflow of TB2 interrupt generation frequency setting counter [ICTB2] (b6-b5) Reserved bits Set to 0 RW Nothing is assigned. If necessary, set to 0. (b7) When read, the content is 0.

NOTES

- 1. Write to this register after setting the PRC1 bit in the PRCR register to 1 (write enabled).
- 2. If the INV11 bit is 0 (three-phase mode 0) or the INV06 bit is 1 (triangular wave modulation mode), set this bit to 0 (timer B2 underflow)
- 3. When setting the IVPCR1 bit to 1 (three-phase output forcible cutoff by $\overline{\text{SD}}$ pin input enabled), Set the PD8s bit to 0 (= input
- 4. Related pins are U(P8₀), \overline{U} (P8₁), V(P7₂), \overline{V} (P7₃), W(P7₄), \overline{W} (P7₅). When a high-level ("H") signal is applied to the \overline{SD} pin and set the IVPCR1 bit to 0 after forcible cutoff, pins U, \overline{U} , V, \overline{V} , W, and \overline{W} are exit from the high-impedance state. If a lowlevel ("L") signal is applied to the $\overline{\text{SD}}$ pin, three-phase motor control timer output will be disabled (INV03=0). At this time, when the IVPCR1 bit is $\underline{0}$, pins U, \overline{U} , V, \overline{V} , W, and \overline{W} become programmable I/O ports. When the IVPCR1 bit is set to 1, pins $U, \overline{U}, V, \overline{V}, W$, and \overline{W} are placed in a high-impedance state regardless of which function of those pins is used
- 5. When this bit is used in delayed trigger mode 0, set bits TB0EN and TB1EN to 1 (A/D trigger mode).
- 6. When setting the TB2SEL bit to 1 (underflow of TB2 interrupt generation frequency setting counter[ICTB2]), set the INV02 bit to 1 (three-phase motor control timer function).
- 7. Refer to "19.6 Digital Debounce Function" for the SD input.

The effect of \overline{SD} pin input is below.

1.Case of INV03 = 1(Three-phase motor control timer output enabled)

IVPCR1 bit	SD pin inputs ⁽³⁾	Status of U/V/W pins	Remarks
1 (Three-phase output	Н	Three-phase PWM output	
forcrible cutoff enable)	L(1)	High impedance ⁽⁴⁾	Three-phase output forcrible cutoff
(Three phase output	Н	Three-phase PWM output	
(Three-phase output forcrible cutoff disable)	L(1)	Input/output port(2)	

NOTES:

- 1. When "L" is applied to the SD pin, INV03 bit is changed to 0 at the same time.
- 2. The value of the port register and the port direction register becomes effective.
- 3. When \$\overline{SD}\$ function is not used, set to 0 (Input) in PD8₅ and pullup to "H" in \$\overline{SD}\$ pin from outside.
- 4. To leave the high-impedance state and restart the three-phase PWM signal output after the three-phase PWM signal output forced cutoff, set the IVPCR1 bit to 0 after the SD pin input level becomes high ("H").

2 Case of INV03 = 0(Three-phase motor control timer output disabled)

2.0000 of it voo of the phase moter centrer timer output disabled)				
IVPCR1 bit	SD pin inputs	Status of U/V/W pins	Remarks	
1 (Three-phase output	Н	Peripheral input/output or input/output port		
forcrible cutoff enable)	L	High impedance	Three-phase output forcrible cutoff ⁽¹⁾	
(Three phase output	Н	Peripheral input/output or input/output port		
(Three-phase output forcrible cutoff disable)	L	Peripheral input/output		

NOTE

1. The three-phase output forcrible cutoff function becomes effective if the INPCR1 bit is set to 1 (three-phase output forcrible cutoff function enable) even when the INV03 bit is 0 (three-phase motor control timer output disalbe)

Figure 12.30 TB2SC Register



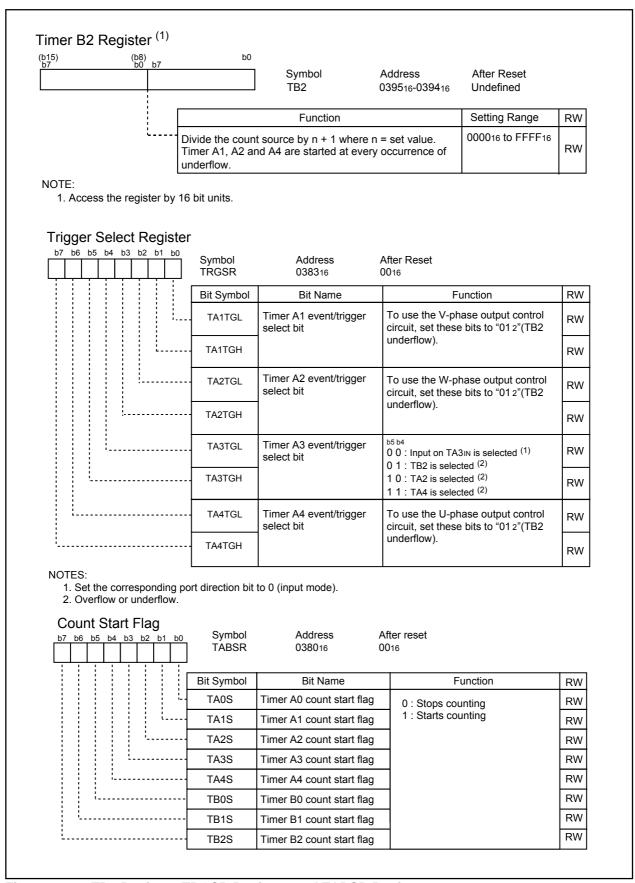


Figure 12.31 TB2 Register, TRGSR Register, and TABSR Register

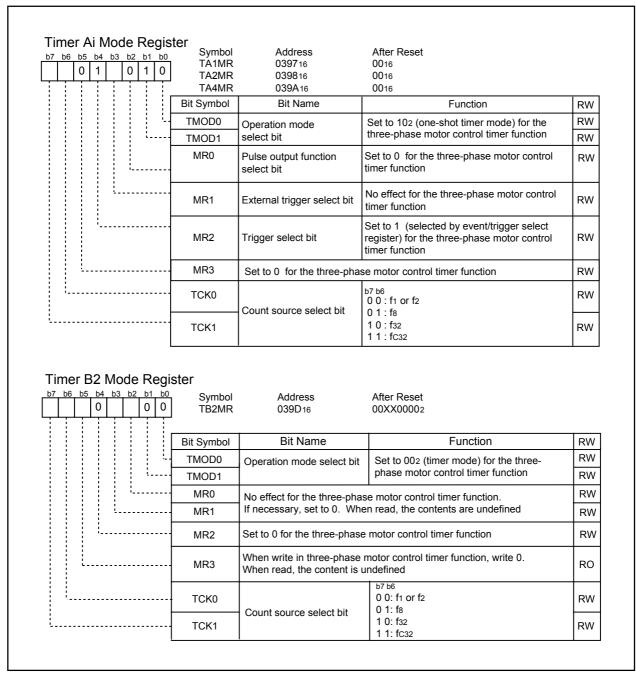


Figure 12.32 TA1MR, TA2MR, TA4MR, and TB2MR Registers

The three-phase motor control timer function is enabled by setting the INV02 bit in the INVC0 register to 1. When this function is on, timer B2 is used to control the carrier wave, and timers A4, A1 and A2 are used to control three-phase PWM outputs $(U, \overline{U}, V, \overline{V}, W \text{ and } \overline{W})$. The dead time is controlled by a dedicated dead-time timer. **Figure 12.33** shows the example of triangular modulation waveform, and **Figure 12.34** shows the example of sawtooth modulation waveform.

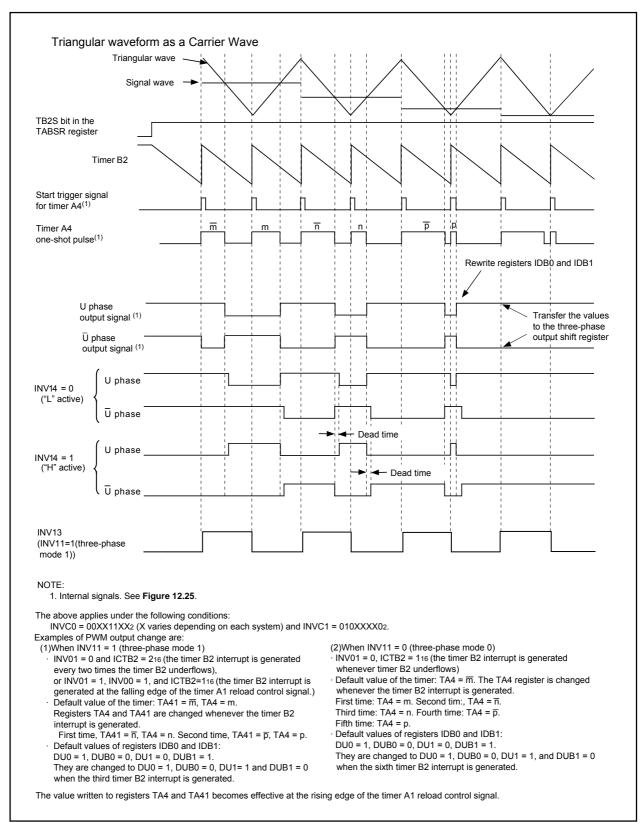


Figure 12.33 Triangular Wave Modulation Operation

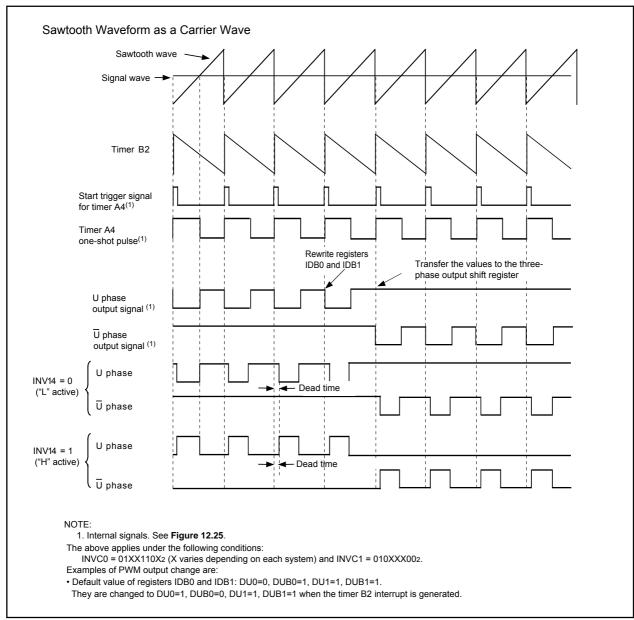


Figure 12.34 Sawtooth Wave Modulation Operation

12.3.1 Position-Data-Retain Function

This function is used to retain the position data synchronously with the three-phase waveform output. There are three position-data input pins for U, V, and W phases.

A trigger to retain the position data (hereafter, this trigger is referred to as "retain trigger") can be selected by the PDRT bit in the PDRF register. This bit selects the retain trigger to be the falling edge of each positive phase, or the rising edge of each positive phase.

12.3.1.1 Operation of the Position-data-retain Function

Figure 12.35 shows a usage example of the position-data-retain function (U phase) when the retain trigger is selected as the falling edge of the positive signal.

- (1) At the falling edge of the U-phase waveform ouput, the state at pin IDU is transferred to the PDRU bit in the PDRF register.
- (2) Until the next falling edge of the Uphase waveform output, the above value is retained.

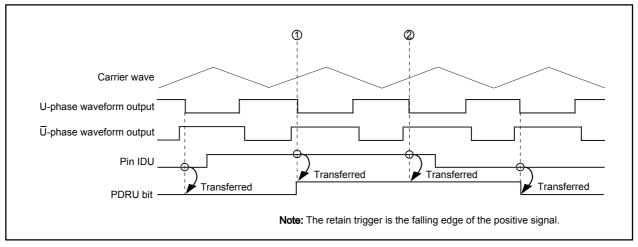


Figure 12.35 Usage Example of Position-data-retain Function (U phase)

12.3.1.2 Position-data-retain Function Control Register

Figure 12.36 shows the structure of the position-data-retain function contol register.

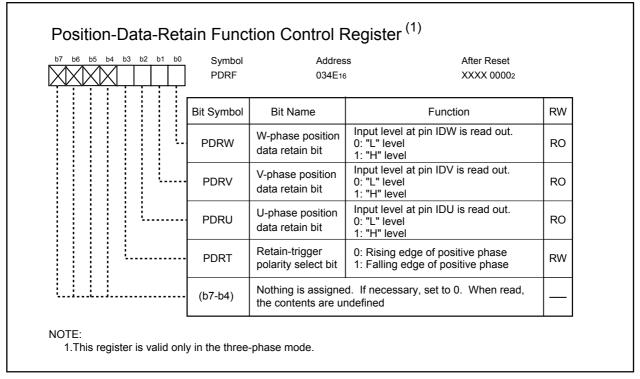


Figure 12.36 PDRF Register

12.3.1.2.1 W-phase Position Data Retain Bit (PDRW)

This bit is used to retain the input level at pin IDW.

12.3.1.2.2 V-phase Position Data Retain Bit (PDRV)

This bit is used to retain the input level at pin IDV.

12.3.1.2.3 U-phase Position Data Retain Bit (PDRU)

This bit is used to retain the input level at pin IDU.

12.3.1.2.4 Retain-trigger Polarity Select Bit (PDRT)

This bit is used to select the trigger polarity to retain the position data.

When this bit is set to 0, the rising edge of each positive phase selected.

When this bit is set to 1, the falling edge of each pocitive phase selected.



12.3.2 Three-phase/Port Output Switch Function

When the INVC03 bit in the INVC0 register set to 1 (Timer output enabled for three-phase motor control) and setting the PFCi (i=0 to 5) in the PFCR register to 0 (I/O port), the three-phase PWM output pin (U, \overline{U} , \overline{V} , \overline{V} and \overline{W}) functions as I/O port. Each bit of the PFCi bits (i=0 to 5) is applicable for each one of three-phase PWM output pins. **Figure 12.37** shows the example of three-phase/port output switch function. **Figure 12.38** shows the PFCR register and the three-phase protect control register.

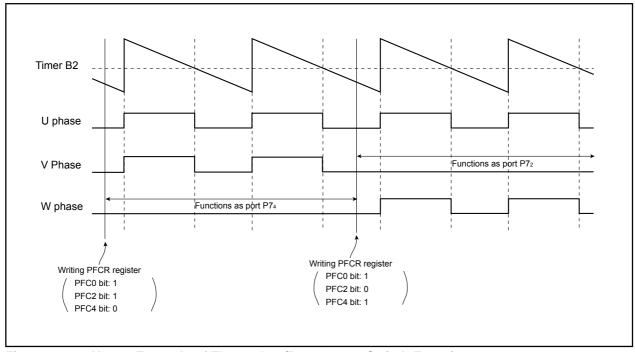


Figure 12.37 Usage Example of Three-phse/Port Output Switch Function

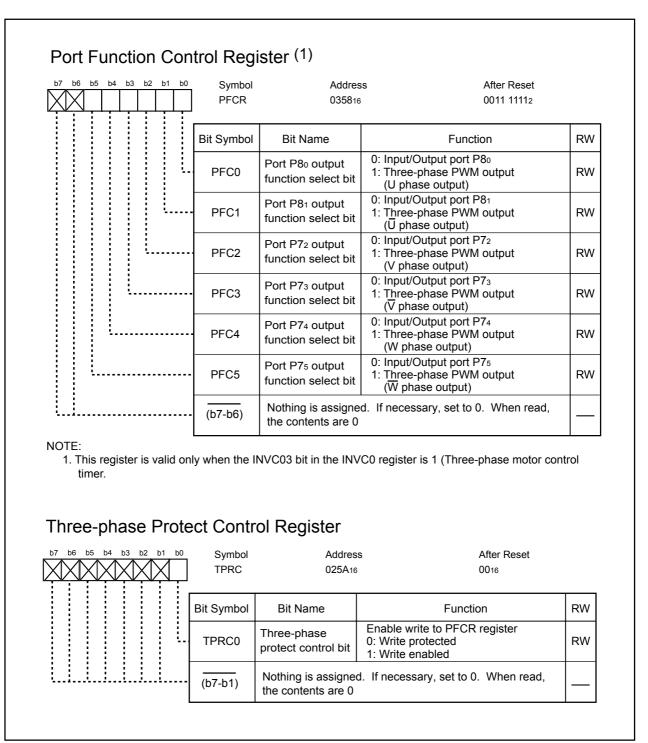


Figure 12.38 PFCR Register, and TPRC Register

13. Timer S

The Timer S (Input Capture/Output Compare: here after, Timer S is referred to as "IC/OC".) is a high-performance I/O port for time measurement and waveform generation.

The IC/OC has one 16-bit base timer for free-running operation and eight 16-bit registers for time measurement and waveform generation.

Table 13.1 lists functions and channels of the IC/OC.

Table 13.1 IC/OC Functions and Channels

	Function	Description
Time measurement (1)		8 channels
	Digital filter	8 channels
	Trigger input prescaler	2 channels
	Trigger input gate	2 channels
Waveform generation ⁽¹⁾		8 channels
	Single-phase waveform output	Available
	Phase-delayed waveform output	Available
	Set/Reset waveform output	Available

NOTE:

1. The time measurement function and the waveform generating function share a pin.

The time measurement function or waveform generating function can be selected for each channel.

Figure 13.1 shows the block diagram of the IC/OC.

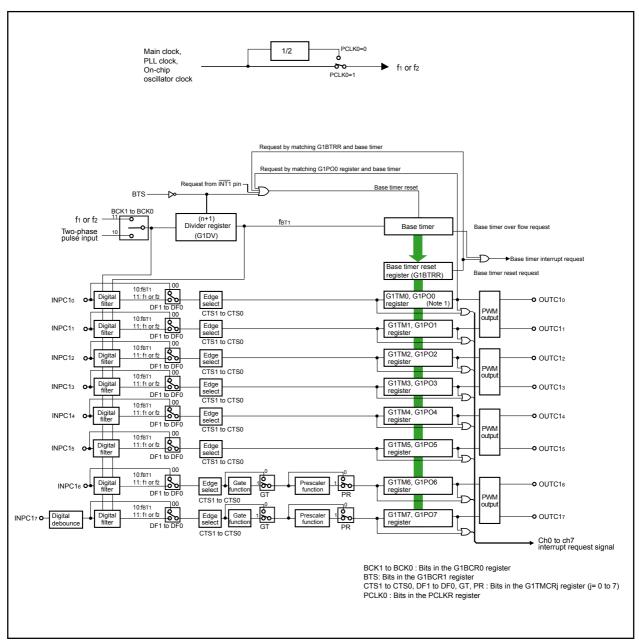
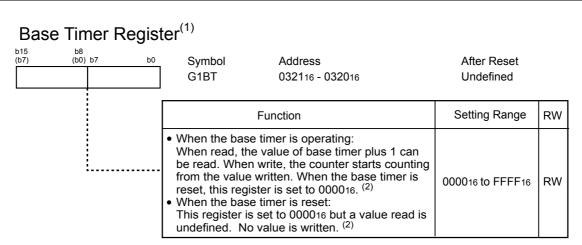


Figure 13.1 IC/OC Block Diagram

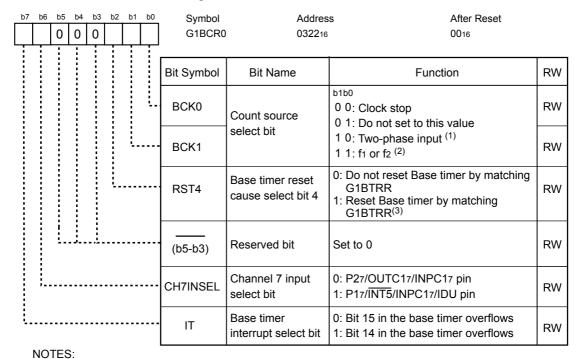
Figures 13.2 to **13.10** show registers associated with the IC/OC base timer, the time measurement function, and the waveform generating function.



NOTES:

- 1. The G1BT register reflects the value of the base timer, synchronizing with the count source fbt1 cycles.
- 2. This base timer stops only when bits BCK1 to BCK0 in the G1BCR0 register are set to 002 (count source clock stop). The base timer operates when bits BCK1 to BCK0 are set to other than 002. When the BTS bit in the G1BCR1 register is set to 0, the base timer is reset continuously, and remaining set to 000016. When the BTS bit is set to 1, this state is cleared and the timer starts counting.

Base Timer Control Register 0

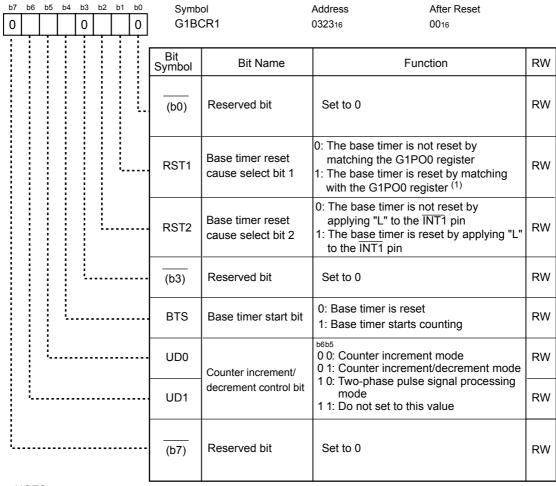


- 1. This setting can be used when bits UD1 to UD0 in the G1BCR1 register are set to 102 (two-phase signal processing mode). Do not set bits BCK1 and BCK0 to 102 in other modes.
- 2. When the PCLK0 bit in the PCLKR register is set to 0, the count source is f2 cycles. And when the PCLK0 bit is set to set to 1, the count source is f1 cycles.
- 3. When the RST4 bit is set to 1, set the RST1 bit in the G1BCR1 register to 0.

Figure 13.2 G1BT and G1BCR0 Registers

Divider Register b7 b6 b5 b4 b3 b2 b1 b0 Symbol Address After Reset G1DV 032A₁₆ 0016 **Function** Setting range RW Divide f1, f2 or two-phase pulse input by (n+1) 0016 to FF16 RW for fBT1 clock cycles generation. n: the setting value of the G1DV register

Base Timer Control Register 1



NOTS:

When the RST1 bit is set to 1, set the RST4 bit in the G1BCR0 register to 0.

Figure 13.3 G1DV Register and G1BCR1 Register

^{1.} The base timer is reset two fBT1 clock cycles after the base timer matches the value set in the G1PO0 register. (See **Figure 13.7** for details on the G1PO0 register) When the RST1 bit is set to 1, the value of the G1POj register (j=1 to 7) for the waveform generating function must be set to a value smaller than that of the G1PO0 register.

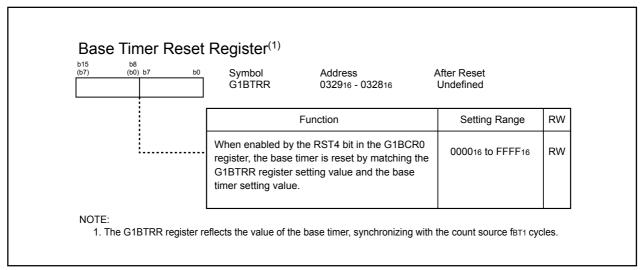
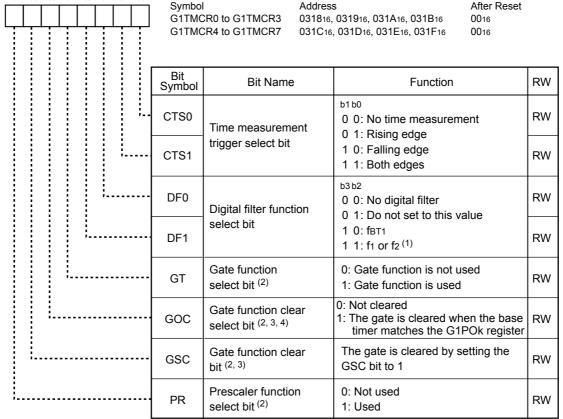


Figure 13.4 G1BTRR Register

Time Measurement Control Register j (j=0 to 7)



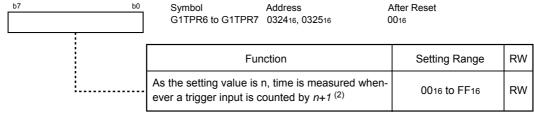
NOTES:

b6

b5 b4 b3 b2 b1 b0

- 1. When the PCLK0 bit in the PCLKR register is set to 0, the count source is f2 cycles. And when the PCLK0 bit is set to 1, the count source is f1 cycles.
- 2. These bits are in registers G1TMCR6 and G1TMCR7. Set all bits 4 to 7 in registers G1TMCR0 to G1TMCR5 to 0.
- 3. These bits are enabled when the GT bit is set to 1.
- 4. The GOC bit is set to 0 after the gate function is cleared. See **Figure 13.7** for details on the G1POk register (k=4 when j=6 and k=5 when j=7).

Time Measurement Prescale Register j (j=6,7)⁽¹⁾



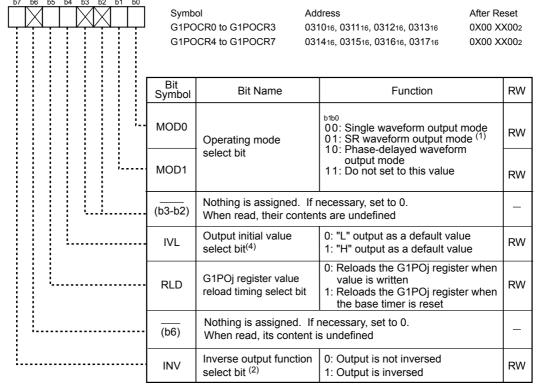
NOTES:

- 1. The G1TPR6 to G1TPR7 registers reflect the base timer value, synchronizing with the count source fbt1 cycles.
- 2. The first prescaler, after the PR bit in the G1TMCRj register is changed from 0 (not used) to 1 (used), may be divided by n, rather than n+1. The subsequent prescaler is divided by n+1.

Figure 13.5 G1TMCR0 to G1TMCR7 Registers, and G1TPR6 to G1TPR7 Registers

Waveform Generation Register j (j=0 to 7) Symbol After Reset (b0) b7 (b7) G1TM0 to G1TM2 $030116\text{-}030016,\ 030316\text{-}030216,\ 030516\text{-}030416$ Indeterminte G1TM3 to G1TM5 030716-030616, 030916-030816, 030B16-030A16 Indeterminte G1TM6 to G1TM7 030D16-030C16, 030F16-030E16 Indeterminte **Function** Setting Range RW The base timer value is stored every RO measurement timing

Waveform Generation Control Register j (j=0 to 7)



NOTES:

- This setting is enabled only for even channels. In SR waveform output mode, values written to the corresponding odd channel (next channel after an even channel) are ignored. Even channels provide waveform output. Odd channels provide no waveform output.
- 2. The inverse output function is the final step in waveform generating process. When the INV bit is set to 1, and "H" signal is provided a default output by setting the IVL bit to 0, and an "L" signal is provided by setting it to 1.
- 3. In the SR waveform output mode, set not only the even channel but also the correspoinding even channel (next channel after the even channel).
- 4. To provide either "H" or "L" signal output set in the IVL bit, set the FSCj bit in the G1FS register to 0 (select waveform generating function) and IFEj bit in the G1FE register to 1 (functions for channel j enabled). Then set the IVL bit to 0 or 1.

Figure 13.6 G1TM0 to G1TM7 Registers, and G1POCR0 to G1POCR7 Registers

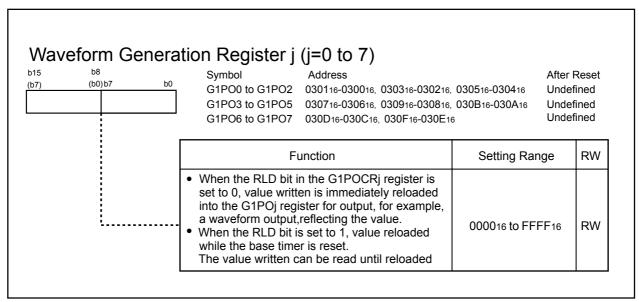


Figure 13.7 G1PO0 to G1PO7 Registers

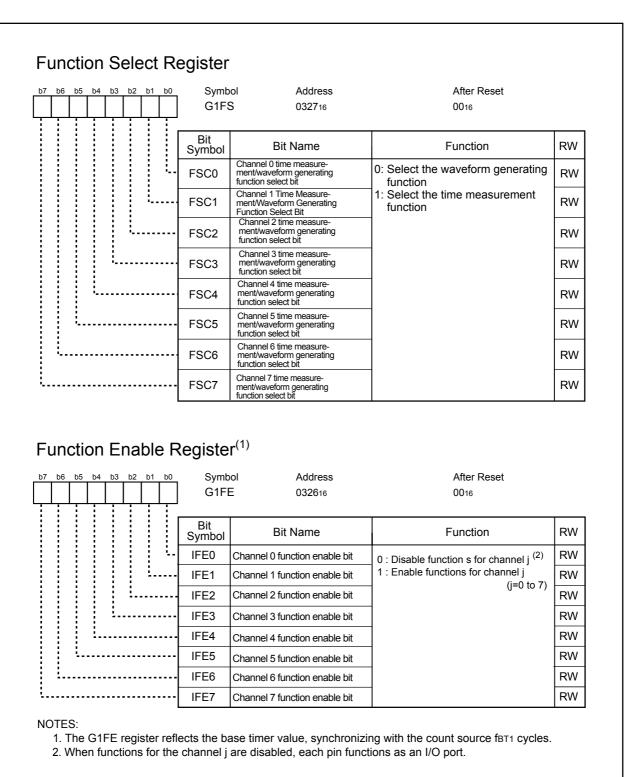


Figure 13.8 G1FS and G1FE Registers

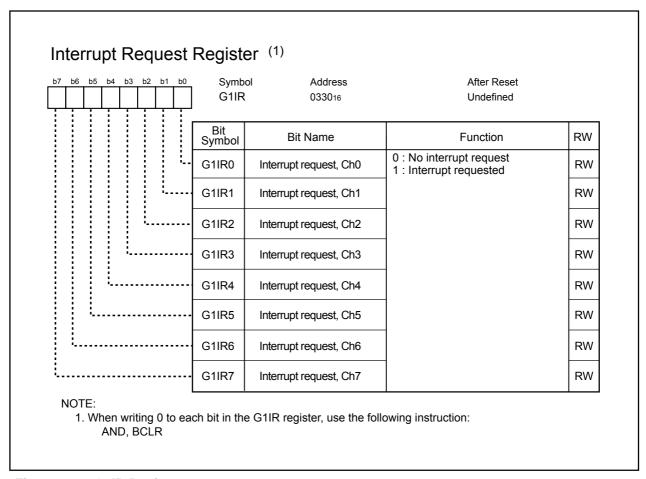


Figure 13.9 G1IR Register

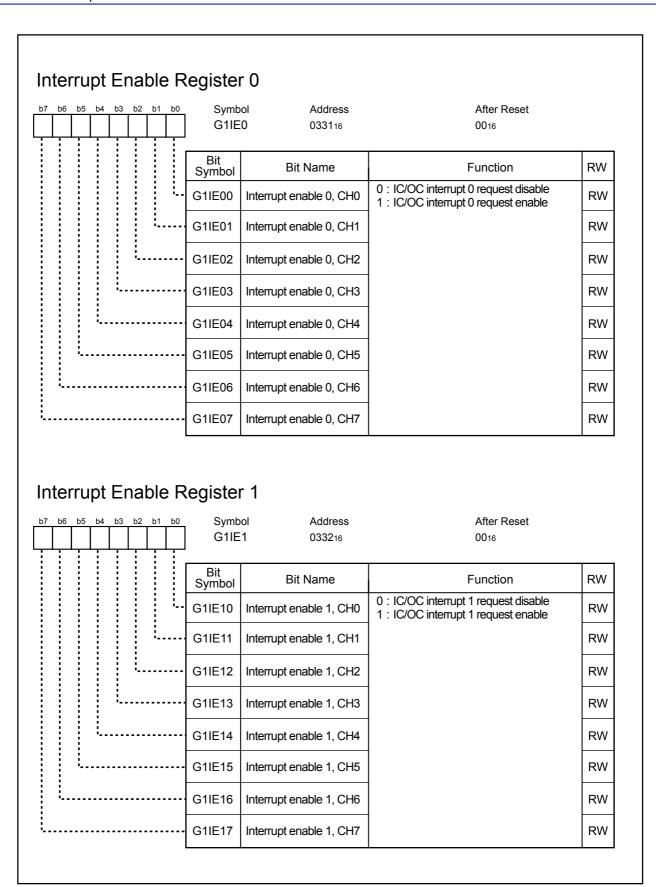


Figure 13.10 G1IE0 and G1IE1 Registers

13.1 Base Timer

The base timer is a free-running counter that counts an internally generated count source.

Table 13.2 lists specifications of the base timer. **Table 13.3** shows registers associated with the base timer. **Figure 13.11** shows a block diagram of the base timer. **Figure 13.12** shows an example of the base timer in counter increment mode. **Figure 13.13** shows an example of the base timer in counter increment/decrement mode. **Figure 13.14** shows an example of two-phase pulse signal processing mode.

Table 13.2 Base Timer Specifications

Item	Specification	
Count source(fBT1)	f1 or f2 divided by (n+1), two-phase pulse input divided by (n+1) n: determined by the DIV7 to DIV0 bits in the G1DV register. n=0 to 255 However, no division when n=0	
Counting operation	The base timer increments the counter value The base timer increments/decrements the counter value Two-phase pulse signal processing	
Count start condition	The BTS bit in the G1BCR1 register is set to 1 (base timer starts counting)	
Count stop condition	The BTS bit in the G1BCR1 register is set to 0 (base timer reset)	
Base timer reset condition	(1) The value of the base timer matches the value of the G1BTRR register (2) The value of the base timer matches the value of G1PO0 register. (3) Apply a low-level signal ("L") to external interrupt pin, INT1 pin	
Value for base timer reset	000016	
Interrupt request	The base timer interrupt request is generated: (1) When the bit 14 or bit 15 in the base timer overflows (2) The value of the base timer value matches the value of the base timer reset register	
Read from timer	The G1BT register indicates a counter value while the base timer is running The G1BT register is undefined when the base timer is reset	
Write to timer	When a value is written while the base timer is running, the timer counter immediately starts counting from this value. No value can be written while the base timer is reset.	
Selectable function	Counter increment/decrement mode The base timer starts counting from 000016. After incrementing to FFFF16, the timer counter is then decremented back to 000016. The base timer increments the counter value again when the timer counter reaches 000016. (See Figure 13.13)	
	Two-phase pulse processing mode Two-phase pulse signals from pins P80 and P81 are counted (See Figure 13.14)	
	P80	
	P81	
	The timer increments a counter on all edges a counter on all edges	

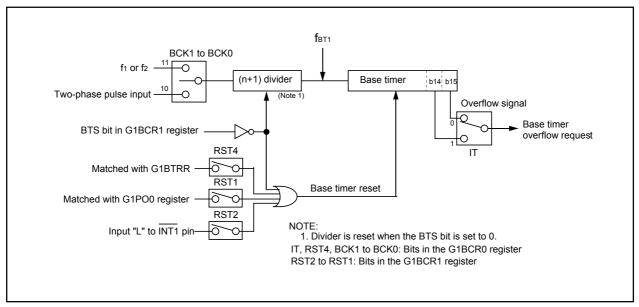


Figure 13.11 Base Timer Block Diagram

Table 13.3 Base Timer Associated Register Settings (Time Measurement Function, Waveform Generation Function, Communication Function)

Register	Bit	Function
G1BCR0	BCK1 to BCK0	Select a count source
	RST4	Select base timer reset timing
	IT	Select the base timer overflow
G1BCR1	RST2 to RST1	Select base timer reset timing
	BTS	Used to start the base timer
	UD1 to UD0	Select how to count
G1BT	-	Read or write base timer value
G1DV	-	Divide ratio of a count source

Set the following registers to set the RST1 bit to 1 (base timer reset by matching the base timer with the G1PO0 register)

G1POCR0	MOD1 to MOD0	Set to 002 (single-phase waveform output mode)
G1P00	-	Set reset cycle
G1FS	FSC0	Set to 0 (waveform generating function)
G1FE	IFE0	Set to 1 (channel operation start)

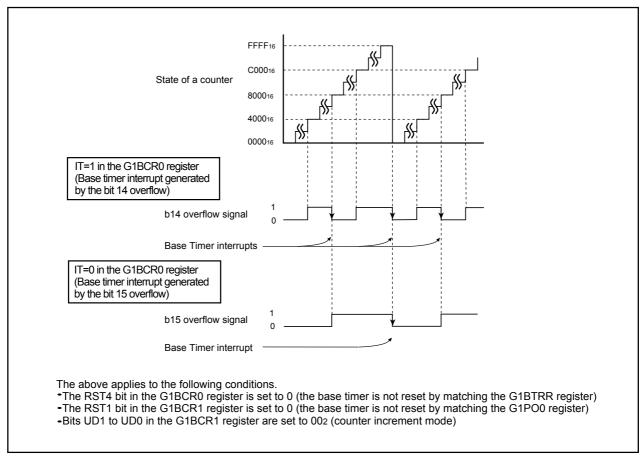


Figure 13.12 Counter Increment Mode

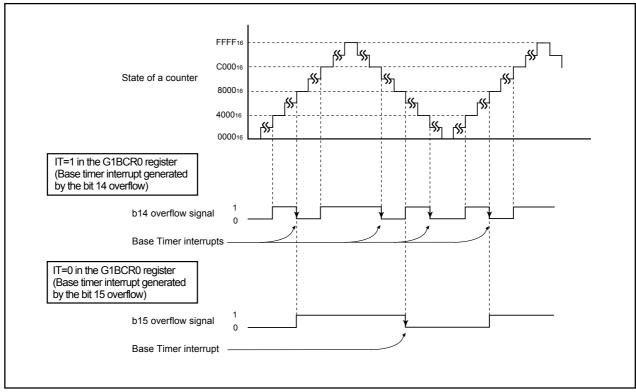


Figure 13.13 Counter Increment/Decrement Mode

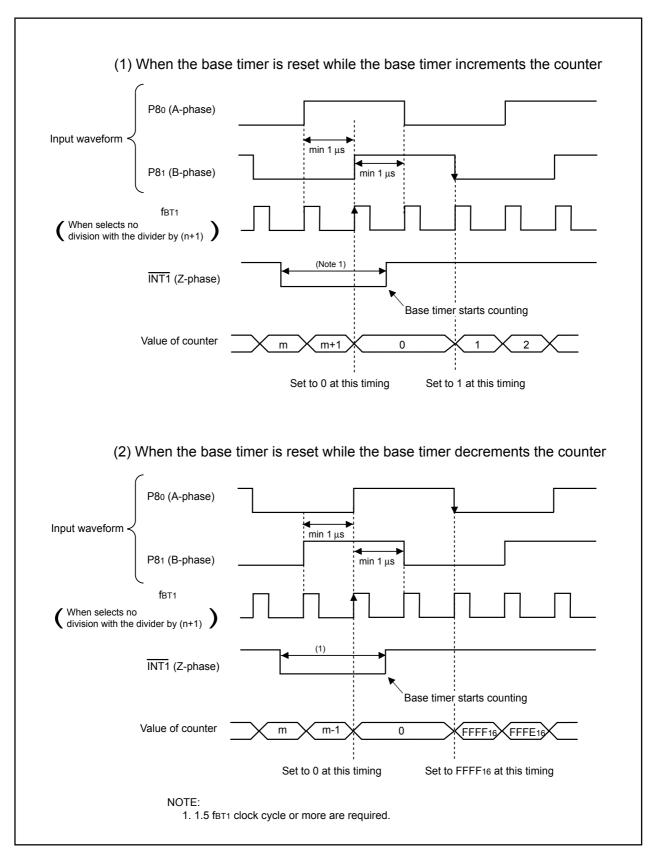


Figure 13.14 Base Timer Operation in Two-phase Pulse Signal Processing Mode

13.1.1 Base Timer Reset Register(G1BTRR)

The G1BTRR register provides the capability to reset the base timer when the base timer count value matches the value stored in the G1BTRR register. The G1BTRR register is enabled by the RST4 bit in the G1BCR0 register. This function is identical in operation to the G1PO0 base timer reset that is enabled by the RST1 bit in the G1BCR0 register. If the free-running operation is not selected, the channel 0 can be used for a waveform generation when the base timer is reset by the G1BTRR register. Do not enable bits RST1 and RST4 simultaneously.

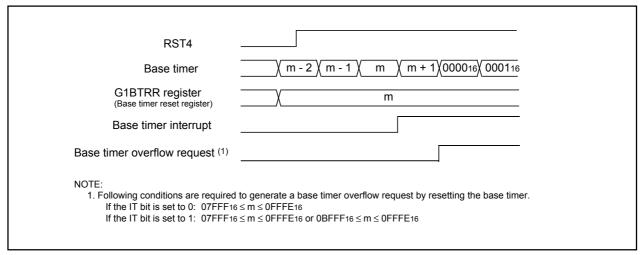


Figure 13.15 Base Timer Reset operation by Base Timer Reset Register

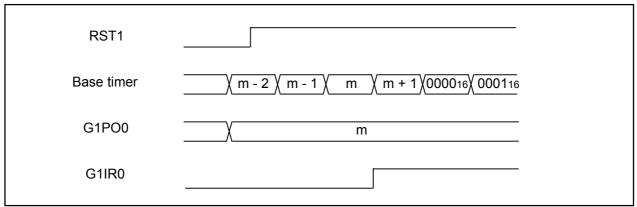


Figure 13.16 Base Timer Reset operation by G1PO0 register

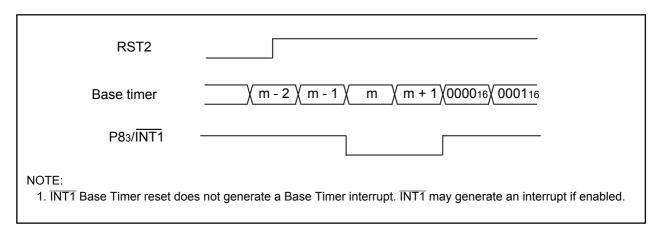


Figure 13.17 Base Timer Reset operation by INT1

13.2 Interrupt Operation

The IC/OC interrupt contains several request causes. **Figure 13.18** shows the IC/OC interrupt block diagram and **Table 13.4** shows the IC/OC interrupt assignation.

When either the base timer reset request or base timer overflow request is generated, the IR bit in the BTIC register corresponding to the IC/OC base timer interrupt is set to 1 (with an interrupt request). Also when an interrupt request in each eight channels (channel i) is generated, the bit i in the G1IR register is set to 1 (with an interrupt request). At this time, if the bit i in the G1IE0 register is 1 (IC/OC interrupt 0 request enabled), the IR bit in the ICOC0IC register corresponding to the IC/OC interrupt 0 is set to 1 (with an interrupt request). And if the bit i in the G1IE1 register is 1 (IC/OC interrupt 1 request enabled), the IR bit in the ICOC1IC register corresponding to the IC/OC interrupt 1 is set to 1 (with an interrupt request).

Additionally, because each bit in the G1IR register is not automatically set to 0 even if the interrupt is acknowledged, set to 0 by program. If these bits are left as 1, all IC/OC channel interrupt causes, which are generated after setting the IR bit to 1, will be disabled.

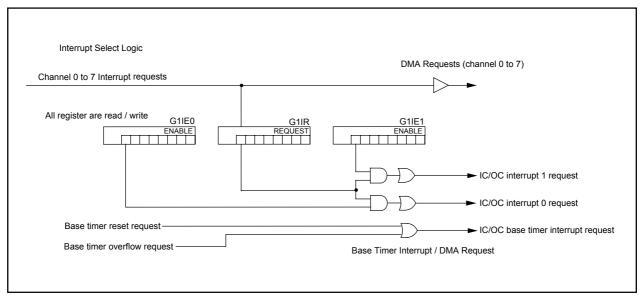


Figure 13.18 IC/OC Interrupt and DMA request generation

Table 13.4 Interrupt Assignment

Interrupt	Interrupt control register
IC/OC base timer interrupt	BTIC(004716)
IC/OC interrupt 0	ICOC0IC(004516)
IC/OC interrupt 1	ICOC0IC(004616)

13.3 DMA Support

Each of the interrupt sources - the eight IC/OC channel interrupts and the one Base Timer interrupt - are capable of generating a DMA request.

13.4 Time Measurement Function

In synchronization with an external trigger input, the value of the base timer is stored into the G1TMj register (j=0 to 7). **Table 13.5** shows specifications of the time measurement function. **Table 13.6** shows register settings associated with the time measurement function. **Figures 13.19** and **13.20** display operational timing of the time measurement function. **Figure 13.21** shows operational timing of the prescaler function and the gate function.

Table 13.5 Time Measurement Function Specifications

Item	Specification	
Measurement channel	Channels 0 to 7	
Selecting trigger input polarity	Rising edge, falling edge, both edges of the INPC1j pin (1)	
Measurement start condition	The IFEj bit in the G1FE register should be set to 1 (channels j function enabled) when the FSCj bit (j=0 to 7) in the G1FS register is set to 1 (time measurement function selected).	
Measurement stop condition	The IFEj bit should be set to 0 (channel j function disabled)	
Time measurement timing	 No prescaler: every time a trigger signal is applied Prescaler (for channel 6 and channel 7): every G1TPRk (k=6,7) register value +1 times a trigger signal is applied 	
Interrupt request generation timing	The G1IRi bit (i=0 to 7) in the interrupt request register (See Figure 13.9) is set to 1 at time measurement timing	
INPC1j pin function (1)	Trigger input pin	
Selectable function	 Digital filter function The digital filter samples a trigger input signal level every f1, f2 or fBT1 cycles and passes pulse signal matching trigger input signal level three times 	
	 Prescaler function (for channel 6 and channel 7) Time measurement is executed every G1TPRk register value +1 times a trigger signal is applied 	
	 Gate function (for channel 6 and channel 7) After time measurement by the first trigger input, trigger input cannot be accepted. However, while the GOC bit in the G1TMCRk register is set to 1 (gate cleared by matching the base timer with the G1POp register (p=4 when k=6, p=5 when k=7)), trigger input can be accepted again by matching the base timer value with the G1POp register setting Digital Debounce function (for channel7) See 13.6.2 Digital Debounce Function for P17/INT5/INPC17 and 19.6 Digital Debounce Function for details 	

NOTE:

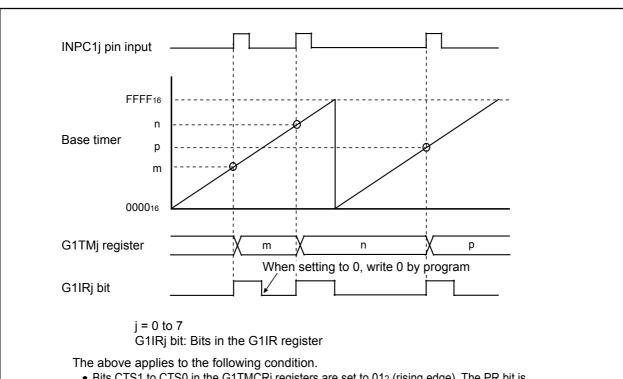
1. The INPC10 to INPC17 pins

Register	Bit	Function
G1TMCRj	CTS1 to CTS0	Select time measurement trigger
	DF1 to DF0	Select the digital filter function
	GT, GOC, GSC	Select the gate function
	PR	Select the prescaler function
G1TPRk	-	Setting value of prescaler
G1FS	FSCj	Set to 1 (time measurement function)
G1FE	IFEj	Set to 1 (channel j function enabled)

j = 0 to 7 k = 6, 7

Bit configurations and function varys with channels used.

Registers associated with the time measurement function must be set after setting registers associated with the base timer.



- Bits CTS1 to CTS0 in the G1TMCRj registers are set to 012 (rising edge). The PR bit is set to 0 (no prescaler used) and the GT bit is set to 0 (no gate function used).
- Bits RTS4, RTS2, and RTS1 in registers G1BCR0 and G1BCR1 are set to 0 (no base timer reset). Bits UD1 to UD0 bits are set to 002 (counter increment mode).

Set the base timer to 000016 (setting the RST1 bit to 1, and bits RST4 and RST2 to 0), when the base timer value matches the G1PO0 register setting. The base timer is set to 000016 after it reaches the G1PO0 register value + 2.

Figure 13.19 Time Measurement Function (1)

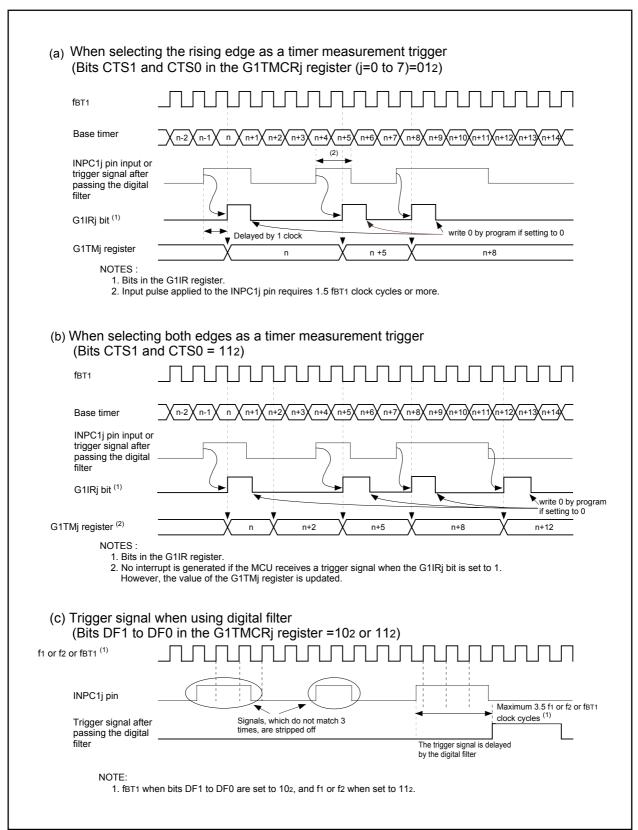


Figure 13.20 Time Measurement Function (2)

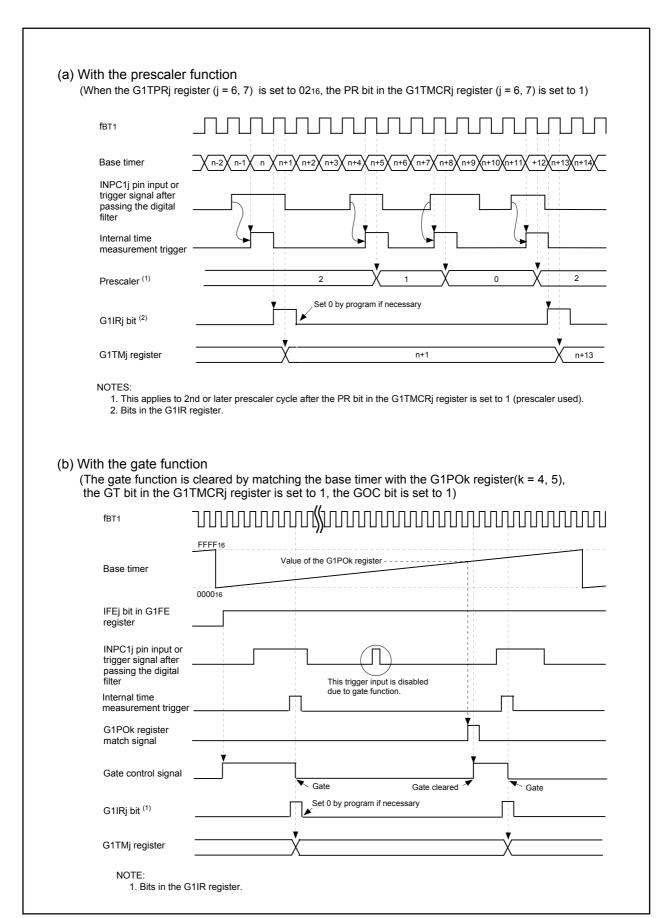


Figure 13.21 Prescaler Function and Gate Function

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13.5 Waveform Generating Function

Waveforms are generated when the base timer value matches the G1POj (j=0 to 7) register value.

The waveform generating function has the following three modes :

- · Single-phase waveform output mode
- · Phase-delayed waveform output mode
- Set/Reset waveform output (SR waveform output) mode

Table 13.7 lists registers associated with the waveform generating function.

Table 13.7 Registers Related to the Waveform Generating Function Settings

Register	Bit	Function
G1POCRj	MOD1 to MOD0	Select output waveform mode
	IVL	Select default value
	RLD	Select G1POj register value reload timing
	INV	Select inverse output
G1POj	-	Select timing to output waveform inverted
G1FS	FSCj	Set to 0 (waveform generating function)
G1FE	IFEj	Set to 1 (enables function on channel j)

j = 0 to 7

Bit configurations and functions vary with channels used.

Registers associated with the waveform generating function must be set after setting registers associated with the base timer.

13.5.1 Single-Phase Waveform Output Mode

Output signal level of the OUTC1j pin becomes high ("H") when the INV bit in the G1POCRj (j=0 to 7) register is set to 0(output is not reversed) and the base timer value matches the G1POj (j=0 to 7) register value. The "H" signal switches to a low-level ("L") signal when the base timer reaches 000016. **Table 13.8** lists specifications of single-phase waveform mode. **Figure 13.22** lists an example of single-phase waveform mode operation.

Table 13.8 Single-phase Waveform Output Mode Specifications

Item	Specification
Output waveform	Free-running operation
	(bits RST1, RST2, and RST4 of registers G1BCR1 and G1BCR0 are set to 0
	(no reset))
	Cycle : 65536 fBT1
	Default output level width : m fbT1
	Inverse level width : 65536-m fBT1
	The base timer is cleared to 000016 by matching the base timer with either
	following register
	(a) G1PO0 register (enabled by setting RST1 bit to 1, and RST4 and RST2 bits to 0), or
	(b) G1BTRR register (enabled by setting RST4 bit to 1, and RST2 and RST1 bits to 0)
	Cycle : n+2 fBT1
	Default output level width :mfBT1
	Inverse level width n+2-m fbT1
	m : setting value of the G1POj register (j=0 to 7), 000116 to FFFD16
	n : setting value of the G1PO0 register or the G1BTRR register, 000116 to FFFD16
Waveform output start condition	The IFEj bit in the G1FE register is set to 1 (channel j function enabled)
Waveform output stop condition	The IFEj bit is set to 0 (channel j function disabled)
Interrupt request	The G1IRj bit in the G1IR register is set to 1 when the base timer value
	matches the G1POj register value (See Figure 13.22)
OUTC1j pin (1)	Pulse signal output pin
Selectable function	Default value set function: Set starting waveform output level
	Inverse output function: Waveform output signal is inversed and provided from the OUTC1j pin

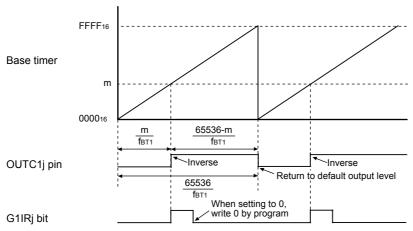
NOTE:

1. Pins OUTC10 to OUTC17.



(1) Free-running operation

(The RST4, RST2, and RST1 bits in the G1BCR0 and G1BCR1 registers are set to 0)

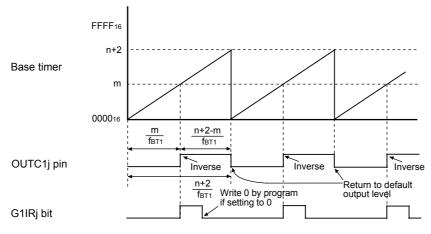


j=0 to 7

m : Setting value of the G1POj register G1IRj bit : Bits in the G1IR register

The above applies under the following conditions.

- -The IVL bit in the G1POCRj register is set to 0 ("L" output as a default value) and the INV bit is set to 0 (not inversed).
- -Bits UD1 to UD0 are set to 002 (counter increment mode).
- (2) The base timer is reset when the base timer matches either following register
 - (a) G1PO0 (enabled by setting bit RST1 to 1, and bits RST4 and RST2 to 0), or
 - (b) G1BTRR (enabled by setting bit RST4 to 1, and bits RST2 and RST1 to 0)



j=1 to 7

m : Setting value of the G1POj register

n: Setting value of either G1PO0 register or G1BTRR register

G1IRj bit : Bits in the G1IR register

The above applies under the following conditions.

- -The IVL bit in the G1POCRj register is set to 0 ("L" output as a default value) and the INV bit is set to 0 (not inversed).
- -Bits UD1 to UD0 are set to 002 (counter increment mode).

Figure 13.22 Single-phase Waveform Output Mode

13.5.2 Phase-Delayed Waveform Output Mode

Output signal level of the OUTC1j pin is inversed every time the base timer value matches the G1POj register value (j=0 to 7). **Table 13.9** lists specifications of phase-delayed waveform mode. **Figure 13.23** shows an example of phase-delayed waveform mode operation.

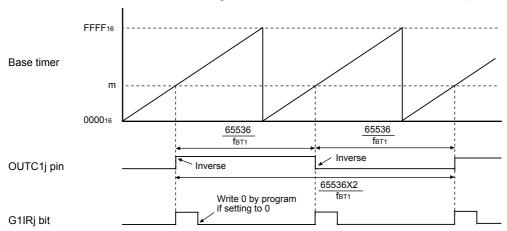
Table 13.9 Phase-delayed Waveform Output Mode Specifications

Item	Specification		
Output waveform	Free-running operation		
	(bits RST1, RST2, and RST4 in registers G1BCR1 and G1BCR0 are set to 0		
	(no reset))		
	Cycle : 65536 x 2 / fBT1		
	"H" and "L" width : 65536 fBT1		
	The base timer is cleared to 000016 by matching the base timer with either		
	following register		
	(a) G1PO0 register (enabled by setting RST1 bit to 1, and bits RST4 and RST2 to 0), or		
	(b) G1BTRR register (enabled by setting RST4 bit to 1, and bits RST2 and RST1 to 0)		
	Cycle : 2(n+2) fBT1		
	"H" and "L" width :		
	n : setting value of either G1PO0 register or G1BTRR register		
Waveform output start condition	The IFEj bit in the G1FE register is set to 1 (channel j function enabled)		
Waveform output stop condition	The IFEj bit is set to 0 (channel j function disabled)		
Interrupt request	The G1IRj bit in the interrupt request register is set to 1 when the base timer		
	value matches the G1POj register value. (See Figure 13.23)		
OUTC1j pin (1)	Pulse signal output pin		
Selectable function	Default value set function: Set starting waveform output level		
	Inverse output function : Waveform output signal is inversed and provided		
	from the OUTC1j pin		

NOTE:

1. Pins OUTC10 to OUTC17.

(1) Free-running operation (Bits RST4, RST2, and RST1 in the registers G1BCR0 and G1BCR1 are set to 0)

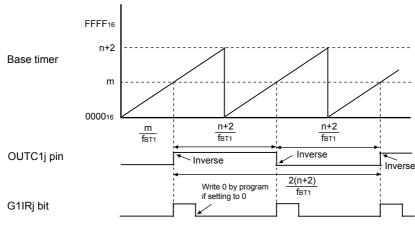


i=0 to 7

m : Setting value of the G1POj register G1IRj bit : Bits in the G1IR register

The above applies under the following conditions.

- The IVL bit in the G1POCRj register is set to 0 (L output as a default value). The INV bit is set to 0 (not inversed).
- Bits UD1 to UD0 are set to 002 (counter increment mode).
- (2) Base timer is reset when the base timer matches either following register
 - (a) G1PO0 (enabled by setting bit RST1 to 1, and bits RST4 and RST2 to 0), or
 - (b) G1BTRR (enabled by setting bit RST4 to 1, and bits RST2 and RST1 to 0)



i=1 to 7

m : Setting value of the G1POj register G1IRj bit : Bits in the G1IR register

n: Setting value of either register G1PO0 or G1BTRR

The above applies under the following conditions.

- The IVL bit in the G1POCRj register is set to 0 (L output as a default value).
 The INV bit is set to 0 (not inversed).
- Bits UD1 to UD0 are set to 002 (counter increment mode).

Figure 13.23 Phase-delayed Waveform Output Mode

13.5.3 Set/Reset Waveform Output (SR Waveform Output) Mode

Output signal level of the OUTC1j pin becomes high ("H") when the INV bit in the G1POCRi (i=0 to 7) is set to 0 (output is not reversed) and the base timer value matches the G1POj register value (j=0, 2, 4, 6). The "H" signal switches to a low-level ("L") signal when the base timer value matches the G1POk (k=j+1) register value. **Table 13.10** lists specifications of SR waveform mode. **Figure 13.24** shows an example of the SR waveform mode operation.

Table 13.10 SR Waveform Output Mode Specifications

Item	Specification
Output waveform	Free-running operation
	(the RST1, RTS2, and RST4 bits of the G1BCR1 and G1BCR0 registers are set
	to 0 (no reset))
	Cycle : 65536 fBT1
	Inverse level width ⁽¹⁾ : n-m fBT1
	The base timer is cleared to 000016 by matching the base timer with either
	following register
	(a) G1PO0 register (enabled by setting RST1 bit to 1, and bits RST4 and RST2 to 0) ⁽²⁾ , or
	(b) G1BTRR register (enabled by setting RST4 bit to 1, and bits RST2 and RST1 to 0)
	Cycle : p+2 fBT1
	Inverse level width ⁽¹⁾ : n-m fBT1
	m : setting value of the G1POj register (j=0, 2, 4, 6)
	n : setting value of the G1POk register (k=j+1)
	p : setting value of the G1PO0 register or G1BTRR register
	value range of m, n, p: 000116 to FFFD16
Waveform output start condition	Bits IFEj and IFEk in the G1FE register is set to 1 (channel j function enabled)
Waveform output stop condition	Bits IFEj and IFEk are set to 0 (channel j function disabled)
Interrupt request	The G1IRj bit in the G1IR register is set to 1 when the base timer value
	matches the G1POj register value.
	The G1IRk bit in the interrupt request register is set to 1 when the base timer
	value matches the G1POk register value (See Figure 13.24)
OUTC1j pin (3)	Pulse signal output pin
Selectable function	Default value set function : Set starting waveform output level
	Inverse output function: Waveform output signal is inversed and provided from the OUTC1j pin

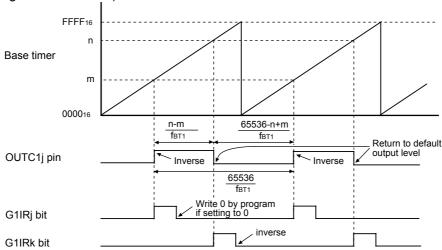
NOTES:

- 1. The odd channel's waveform generating register must have greater value than the even channel's.
- 2. When the G1PO0 register resets the base timer, the channel 0 and channel 1 SR waveform generating functions are not available.
- 3. Pins OUTC10, OUTC12, OUTC14, OUTC16.



(1) Free-running operation

(Bits RST2 and RST1 in the G1BCR0 register and the RST4 bit in the G1BCR1 register are set to 0)

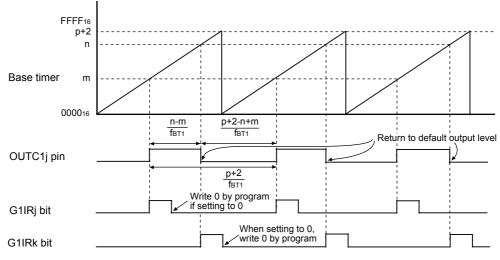


j=0, 2, 4, 6 k=j+1

m : Setting value of the G1POj register n: Setting value of the G1POk register G1IRj, G1IRk bits: Bits in the G1IR register

The above applies under the following conditions.

- The IVL bit in the G1POCRj register is set to 0 (L output as a default value). The INV bit is set to 0 (not inversed).
- Bits UD1 and UD0 are set to 002 (counter increment mode).
- (2) Base timer is reset when the base timer matches either following register
 - (a) G1PO0 (enabled by setting bit RST1 to 1, and bits RST4 and RST2 to 0), or
 - (b) G1BTRR (enabled by setting bit RST4 to 1, and bits RST2 and RST1 to 0)



j=2, 4, 6 k=j+1

m : Setting value of the G1POj register n: Setting value of the G1POk register p: Setting value of either register G1PO0 or G1BTRR

G1IRj, G1IRk bits: Bits in the G1IR register

The above applies under the following conditions.

- The IVL bit in the G1POCRj register is set to 0 (L output as a default value). The INV bit is set to 0 (not inversed).
- Bits UD1 and UD0 are set to 002 (counter increment mode).

Figure 13.24 Set/Reset Waveform Output Mode

13.6 I/O Port Function Select

The value in the G1FE and G1FS registers decides which IC/OC pin to be an input or output pin. In SR waveform generating mode, two channels, a set of even channel and odd channel, are used every output waveform, however, the waveform is output from an even channel only. In this case, the corresponding pin to the odd channel can be used as an I/O port.

Table 13.11 Pin setting for Time Measurement and Waveform Generating Functions

Pin	IFE	FSC	MOD1	MOD0	Port Direction Port Da	
P27/INPC17/	0	Х	Х	Х	Determined by PD27	P27
OUTC17	1	1	Х	Х	Determined by PD27, Input to INPC17 is always active	P27 or INPC17
	1	0	0	0	Single-phase Waveform Output	OUTC17
	1	0	0	1	Determined by PD27, SR waveform output mode	P27
	1	0	1	0	Phase-delayed Waveform Output	OUTC17
P26/INPC16/	0	Х	Х	Х	Determined by PD26	P26
OUTC16	1	1	X	Х	Determined by PD26, Input to INPC16 is always active	P26 or INPC16
	1	0	0	0	Single-phase Waveform Output	OUTC16
	1	0	0	1	SR Waveform Output	OUTC16
	1	0	1	0	Phase-delayed Waveform Output	OUTC16
P25/INPC15/	0	Х	Х	Х	Determined by PD25	P2 ₅
OUTC15	1	1	Х	Х	Determined by PD25, Input to INPC15 is always active	P25 or INPC15
	1	0	0	0	Single-phase Waveform Output	OUTC15
	1	0	0	1	Determined by PD25, SR Waveform Output mode	P2 ₅
	1	0	1	0	Phase-delayed Waveform Output	OUTC15
P24/INPC14/	0	Х	Х	Х	Determined by PD24	P2 ₄
OUTC14	1	1	Х	Х	Determined by PD24, Input to INPC14 is always active	P24 or INPC14
	1	0	0	0	Single-phase Waveform Output	OUTC14
	1	0	0	1	SR Waveform Output	OUTC14
	1	0	1	0	Phase-delayed Waveform Output	OUTC14
P23/INPC13/	0	Х	Х	Х	Determined by PD2 ₃ P2 ₃	
OUTC13	1	1	Х	Х	Determined by PD23, Input to INPC13 is always active	P23 or INPC13
		Single-phase Waveform Output	OUTC13			
	1	0 0 1 Determined by		1	Determined by PD23, SR waveform output mode	P2 ₃
	1	0	1	0	Phase-delayed Waveform Output	OUTC13
P22/INPC12/	0	Х	Х	Х	Determined by PD22 P22	
OUTC12	1	1	Х	Х	Determined by PD22, Input to INPC12 is always active	P22 or INPC12
	1	0	0	0	Single-phase Waveform Output	OUTC12
	1	0	0	1	SR Waveform Output	OUTC12
	1	0	1	0	Phase-delayed Waveform Output	OUTC12
P21/INPC11/	0	Х	Х	Х	Determined by PD2 ₁	P2 ₁
		Determined by PD2 ₁ , Input to INPC1 ₁ is always active	P21 or INPC11			
	1	0	0	0	Single-phase Waveform Output	OUTC1 ₁
	1	0	0	1	Determined by PD2 ₁ , SR waveform output mode	P2 ₁
	1	0	1	0	Phase-delayed Waveform Output	OUTC1 ₁
P2o/INPC1o/	0	Х	Х	Х	Determined by PD2 ₀ P2 ₀	
OUTC10	1	1	Х	X Determined by PD2o, Input to INPC1o is always acti		P20 or INPC10
1 0 0 Single-phase Waveform Output 1 0 0 1 SR Waveform Output			OUTC10			
		1	• .	OUTC10		
	1	0	1	0	Phase-delayed Waveform Output	OUTC10

IFE: IFEj (j=0 to 7) bits in the G1FE register.

FSC: FSCj (j=0 to 7) bits in the G1FS register.

MOD2 to MOD1: Bits in the G1POCRj (j=0 to 7) register.



13.6.1 INPC17 Alternate Input Pin Selection

The input capture pin for IC/OC channel 7 can be assigned to one of two package pins. The CH7INSEL bit in the G1BCR0 register selects IC/OC INPC17 from P27/OUTC17/INPC17 or P17/INT5/INPC17/IDU.

13.6.2 Digital Debounce Function for Pin P17/INT5/INPC17

The INT5/INPC17 input from the P17/INT5/INPC17/IDU pin has an effective digital debounce function against a noise rejection. Refer to **19.6 Digital Debounce function** for this detail.



14. Serial I/O

Note

The SI/O4 interrupt of peripheral function interrupt is not available in the 64-pin package.

Serial I/O is configured with five channels: UART0 to UART2, SI/O3 and SI/O4.

14.1 UARTi (i=0 to 2)

UARTi each have an exclusive timer to generate a transfer clock, so they operate independently of each other.

Figure 14.1 shows the block diagram of UARTi. **Figures 14.2** and **14.3** shows the block diagram of the UARTi transmit/receive.

UARTi has the following modes:

- · Clock synchronous serial I/O mode
- Clock asynchronous serial I/O mode (UART mode).
- Special mode 1 (I²C bus mode): UART2
- Special mode 2: UART2
- Special mode 3 (Bus collision detection function, IEBus mode): UART2
- Special mode 4 (SIM mode): UART2

Figures 14.4 to 14.9 show the UARTi-related registers.

Refer to tables listing each mode for register setting.

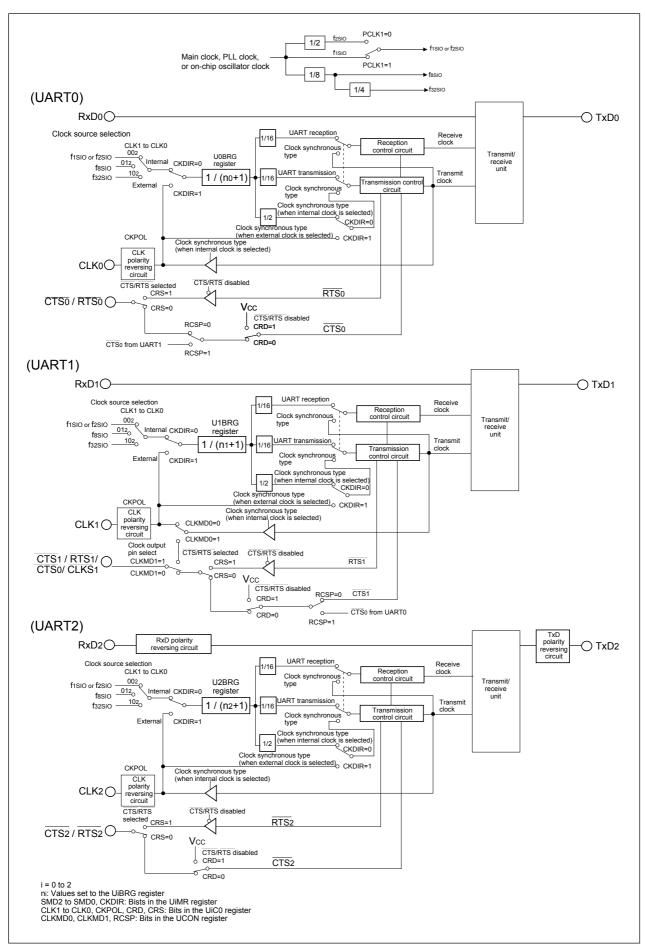


Figure 14.1 Block diagram of UARTi (i = 0 to 2)

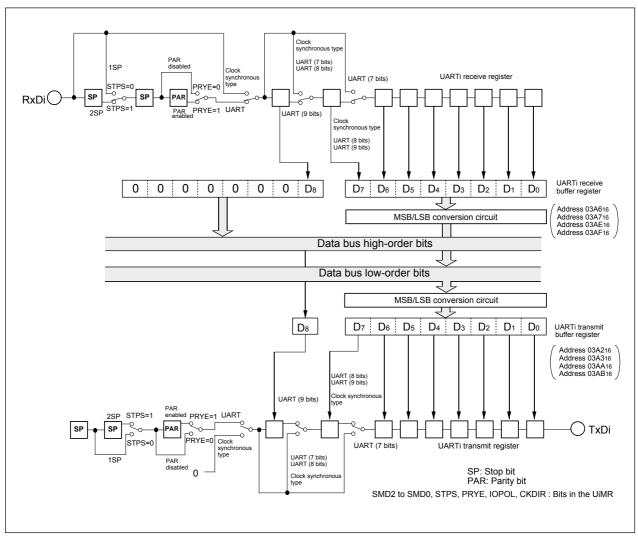


Figure 14.2 Block diagram of UARTi (i = 0, 1) transmit/receive unit

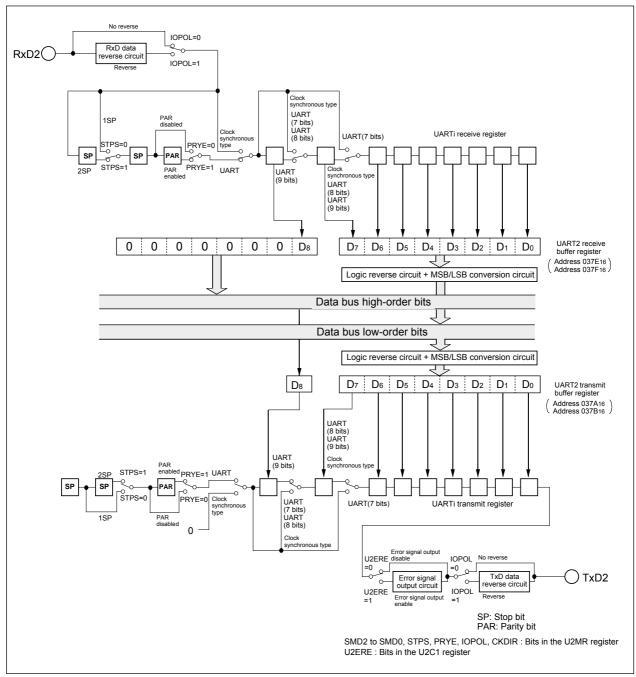
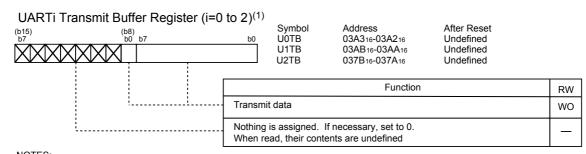


Figure 14.3 Block diagram of UART2 transmit/receive unit

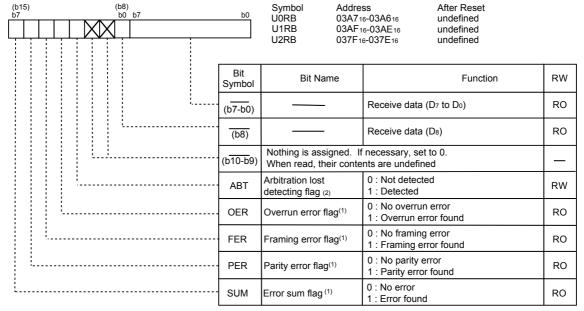
14.Serial I/O M16C/29 Group



NOTES:

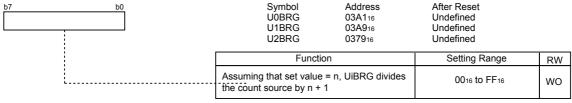
1. Use MOV instruction to write to this register.

UARTi Receive Buffer Register (i=0 to 2)



- 1. When the SMD2 to SMD0 bits in the UiMR register are set to 0002 (serial I/O disabled) or the RE bit in the UiC1 register is set to 0 (reception disabled), all bits SUM, PER, FER and OER are set to 0 (no error). The SUM bit is set to 0 (no error) when all of the PER, FER and OER bits are set to 0 (no error). Also, bits PER and FER are set to 0 by reading the lower byte of the UiRB reaister
- 2. The ABT bit is set to 0 by setting to 0 by program. (Writing 1 has no effect.) Nothing is assigned at the bit 11 in the U0RB and U1RB registers. If necessary, set to 0. When read, its content is 0.

UARTi Baud Rate Generation Register (i=0 to 2)(1, 2, 3)



NOTES

- 1. Write to this register while serial I/O is neither transmitting nor receiving.
- 2. Use MOV instruction to write to this register.

The transfer clock is shown below when the setting value in the UiBRG register is set as n.

- (1) When the CKDIR bit in the UiMR register to 0 (internal clock)
 - Clock synchronous serial I/O mode : fj/(2(n+1)) • Clock asynchronous serial I/O (UART) mode
- : fj/(16(n+1))
- (2) When the CKDIR bit in the UiMR register to 1 (external clock)

 Clock synchronous serial I/O mode

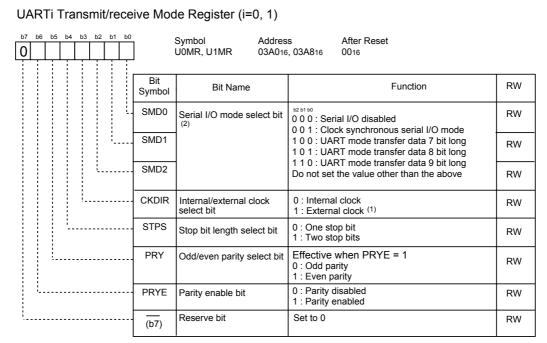
 : fext
 - · Clock asynchronous serial I/O (UART) mode : fext/(16(n+1))

fj: f1SIO, f2SIO, f8SIO, f32SIO

fext: Input from CLKi pin

3. Set the UiBRG register after setting bits CLK1 and CLK0 in the registers UiC0.

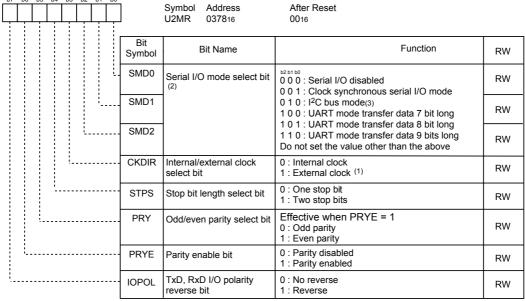
Figure 14.4 U0TB to U2TB, U0RB to U2RB, U0BRG to U2BRG Registers



NOTES:

- 1. Set the corresponding port direction bit for each CLKi pin to 0 (input mode).
- 2. To receive data, set the corresponding port direction bit for each RxDi pin to 0.

UART2 Transmit/receive Mode Register



NOTES:

- 1. Set the corresponding port direction bit for each CLK2 pin to 0 (input mode).
- 2. To receive data, set the corresponding port direction bit for each RxD2 pin to 0 (input mode).
- 3. Set the corresponding port direction bit for SCL2 and SDA2 pins to 0 (input mode).

Figure 14.5 U0MR to U2MR Registers

14.Serial I/O M16C/29 Group

Address

After Reset

UARTi Transmit/receive Control Rregister 0 (i=0 to 2)

Symbol

b7 b6 b5 b4 b3 b2 b1 b0

	Uo	C0 to U2C0 03A416, 03A	AC16, 037C16 000010002	
	Bit Symbol	Bit Name	Function	RW
	CLK0	BRG count source select bit ⁽⁷⁾	b1b0 0 0 : f1slo or f2slo is selected 0 1 : fsslo is selected	RW
· · · · · · · · · · · · · · · · · · ·	CLK1		1 0 : f32SIO is selected 1 1 : Do not set	RW
	CRS	CTS/RTS function select bit (3)	Effective when CRD is set to 0 0 : CTS function is selected (1) 1 : RTS function is selected	RW
1	TXEPT	Transmit register empty flag	Data present in transmit register (during transmission) No data present in transmit register (transmission completed)	RO
	CRD	CTS/RTS disable bit	0 : CTS/RTS function enabled 1 : CTS/RTS function disabled (P60, P64 and P73 can be used as I/O ports) ⁽⁶⁾	RW
	NCH	Data output select bit ⁽⁵⁾	0 : TxD2/SDA2 and SCLi pins are CMOS output 1 : TxD2/SDA2 and SCLi pins are N-channel open-drain output $^{(4)}$	RW
	CKPOL	CLK polarity select bit	Transmit data is output at falling edge of transfer clock and receive data is input at rising edge Transmit data is output at rising edge of transfer clock and receive data is input at falling edge	RW
	UFORM	Transfer format select bit (2)	0 : LSB first 1 : MSB first	RW

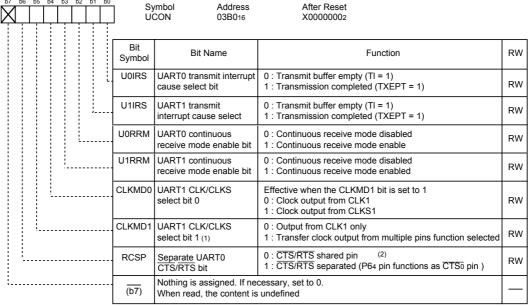
NOTES:

- 1. Set the corresponding port direction bit for each CTSi pin to 0 (input mode).
- 2. Effective when bits SMD2 to SMD0 in the UMR register to 0012 (clock synchronous serial I/O mode) or 0102 (UART mode transfer
- data 8 bits long). Set the UFORM bit to 1 when bits SMD2 to SMD0 are set to 1012 (I2C bus mode) and 0 when they are set to 1002.

 3. CTS1/RTS1 can be used when the CLKMD1 bit in the UCON register is set to 0 (only CLK1 output) and the RCSP bit in the UCON register is set to 0 (CTSo/RTSo not separated).
- 4. SDA2 and SCL2 are effective when i = 2.

 5. When bits SMD2 to SMD in the UiMR regiser are set to 0002 (serial I/O disable), do not set NCH bit to 1 (TxDi/SDA2 and SCL2 pins are N-channel open-drain output).
- 6. When the U1MAP bit in PACR register is 1 (P73 to P70), P70 functions as CTS/RTS pin in UART1. 7. When the CLK1 and CLK0 bit settings are changed, set the UiBRG register.

UART Transmit/receive Control Register 2



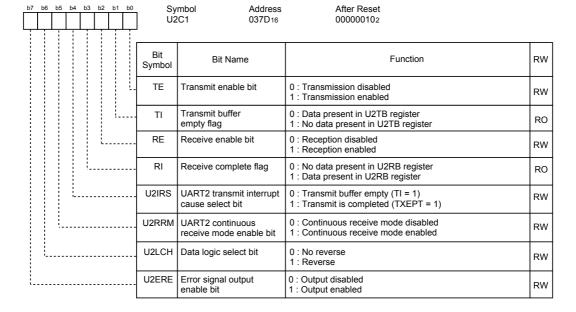
NOTES:

- 1. When using multiple transfer clock output pins, make sure the following conditions are met:set the CKDIR bit in the U1MR register to 0 (internal clock)
- 2. When the U1MAP bit in PACR register is set to 1 (P73 to P70), P70 pin functions as CTS0 pin.

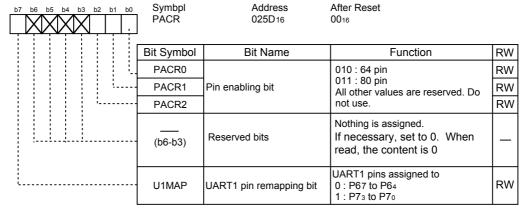
Figure 14.6 U0C0 to U2C0 and UCON Registers

UARTi Transmit/receive Control Register 1 (i=0, 1) Symbol U0C1, U1C1 Address After Reset 03A516,03AD16 00000102 Bit Function RW Bit Name Symbol Transmit enable bit 0 : Transmission disabled RW 1: Transmission enabled ΤI Transmit buffer 0 : Data present in UiTB register RO 1 : No data present in UiTB register empty flag Receive enable bit RE 0: Reception disabled RW 1: Reception enabled RI 0 : No data present in UiRB register Receive complete flag RO 1 : Data present in UiRB register Nothing is assigned. If necessary, set to 0. When read, the content is 0(b7-b4)

UART2 Transmit/receive Control Register 1



Pin Assignment Control Register (1)



NOTE:

Figure 14.7 U0C1 to U2C1 Register, and PACR Register

^{1.} Set the PACR register by the next instruction after setting the PRC2 bit in the PRCR register to 1(write enable).

UART2 Special Mode Register Symbol Address After Reset U2SMR 037716 X00000002 Bit RW Bit Name Function Symbol 0 : Other than I2C bus mode IICM I²C bus mode select bit RW 1: I2C bus mode Arbitration lost detecting 0 : Update per bit RW flag control bit 1: Update per byte 0 : STOP condition detected 1 : START condition detected (busy) Bus busy flag RW⁽¹ Reserved bit RW (b3) Bus collision detect sampling clock select bit 0 : Rising edge of transfer clock 1 : Underflow signal of timer A0 **ABSCS** RW ACSE Auto clear function 0: No auto clear function select bit of transmit 1 : Auto clear at occurrence of bus collision RW enable bit 0: Not synchronized to RxD2 Transmit start condition SSS RW 1 : Synchronized to RxD2⁽²⁾ select bit Nothing is assigned. If necessary, set to 0. When read, the content is undefined (b7) NOTES:

UART2 Special Mode Register 2

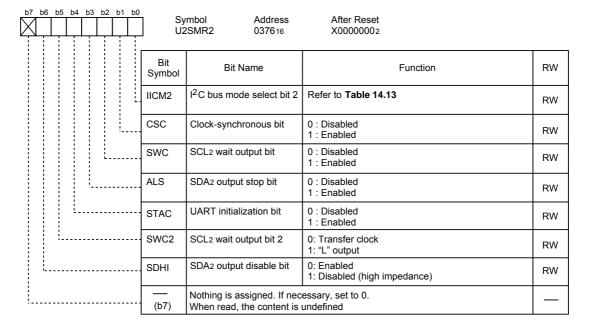
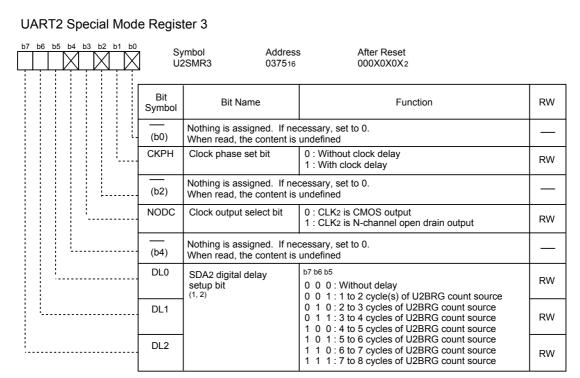


Figure 14.8 U2SMR and U2SMR2 Registers

^{1:} The BBS bit is set to 0 by writing 0 by program. (Writing 1 has no effect).
2: When a transfer begins, the SSS bit is set to 0 (Not synchronized to RxD2).

^{2.} When a transfer begins, the ede bit to dot to a (Not dynamicinized to rotal



NOTES:

- 1. Bits DL2 to DL0 are used to generate a delay in SDA output by digital means during I²C bus mode. In other than I²C bus mode,set these bits to 0002 (no delay).
- 2. The amount of delay varies with the load on pins SCL2 and SDA2. Also, when using an external clock, the amount of delay increases by about 100 ns.

UART2 Special Mode Register 4

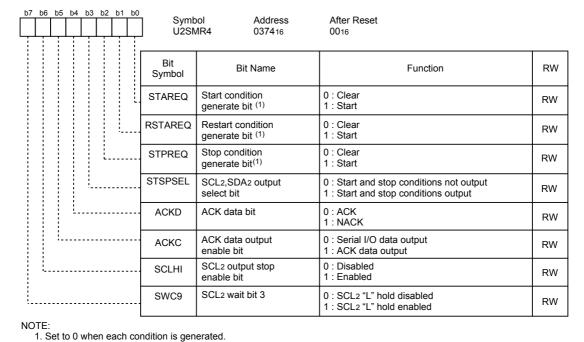


Figure 14.9 U2SMR3 and U2SMR4 Registers

14.1.1 Clock Synchronous serial I/O Mode

The clock synchronous serial I/O mode uses a transfer clock to transmit and receive data. **Table 14.1** lists the specifications of the clock synchronous serial I/O mode. **Table 14.2** lists the registers used in clock synchronous serial I/O mode and the register values set.

Table 14.1 Clock Synchronous Serial I/O Mode Specifications

Item	Specification
Transfer data format	Transfer data length: 8 bits
Transfer clock	• The CKDIR bit in the UiMR(i=0 to 2) register is set to 0 (internal clock) : fj/ (2(n+1))
	fj = f1SIO, f2SIO, f8SIO, f32SIO. n: Setting value of UiBRG register 0016 to FF16
	CKDIR bit is set to 1 (external clock): Input from CLKi pin
Transmission, reception control	Selectable from CTS function, RTS function or CTS/RTS function disable
Transmission start condition	Before transmission can start, the following requirements must be met (1)
	 The TE bit in the UiC1 register is set to 1 (transmission enabled)
	- The TI bit in the UiC1 register is set to 0 (data present in UiTB register)
	 If CTS function is selected, input on the CTSi pin is set to "L"
Reception start condition	Before reception can start, the following requirements must be met (1)
	 The RE bit in the UiC1 register is set to 1 (reception enabled)
	- The TE bit in the UiC1 register is set to 1 (transmission enabled)
	 The TI bit in the UiC1 register is set to 0 (data present in the UiTB register)
Interrupt request	For transmission, one of the following conditions can be selected
generation timing	– The UilRS bit ⁽³⁾ is set to 0 (transmit buffer empty): when transferring data from the
	UiTB register to the UARTi transmit register (at start of transmission)
	- The UilRS bit is set to 1 (transfer completed): when the serial I/O finished sending
	data from the UARTi transmit register
	For reception
	When transferring data from the UARTi receive register to the UiRB register (at
	completion of reception)
Error detection	Overrun error (2)
	This error occurs if the serial I/O started receiving the next data before reading the
	UiRB register and received the 7th bit in the the next data
Select function	CLK polarity selection
	Transfer data input/output can be chosen to occur synchronously with the rising or
	the falling edge of the transfer clock
	LSB first, MSB first selection
	Whether to start sending/receiving data beginning with bit 0 or beginning with bit 7
	can be selected
	Continuous receive mode selection
	Reception is enabled immediately by reading the UiRB register
	Switching serial data logic (UART2) The first serial data logic (UART2) The fi
	This function reverses the logic value of the transmit/receive data
	Transfer clock output from multiple pins selection (UART1) The put to be and a selected in a great from the UART4 transfer all all pins that
	The output pin can be selected in a program from two UART1 transfer clock pins that
	have been set
	Separate CTS/RTS pins (UART0) OTO- and DTO- are insent/autout form a separate rise.
	CTSo and RTSo are input/output from separate pins
	UART1 pin remapping selection The UART1 rin can be calculated from the PC7 to PC4 or P76 to P76.
	The UART1 pin can be selected from the P67 to P64 or P73 to P70

NOTES

- 1. When an external clock is selected, the conditions must be met while if the CKPOL bit in the UiC0 register is set to 0 (transmit data output at the falling edge and the receive data taken in at the rising edge of the transfer clock), the external clock is in the high state; if the CKPOL bit in the UiC0 register is set to 1 (transmit data output at the rising edge and the receive data taken in at the falling edge of the transfer clock), the external clock is in the low state.
- 2. If an overrun error occurs, bits 8 to 0 in the UiRB register are undefined. The IR bit in the SiRIC register remains unchanged.
- 3. The U0IRS and U1IRS bits respectively are the bits 0 and 1 in the UCON register; the U2IRS bit is bit 4 in the U2C1 register.

Table 14.2 Registers to Be Used and Settings in Clock Synchronous Serial I/O Mode

Register	Bit	Function	
UiTB ⁽³⁾	0 to 7	Set transmission data	
UiRB ⁽³⁾	0 to 7	Reception data can be read	
	OER	Overrun error flag	
UiBRG	0 to 7	Set bit rate	
UiMR ⁽³⁾	SMD2 to SMD0	Set to 0012	
	CKDIR	Select the internal clock or external clock	
	IOPOL(i=2) (4)	Set to 0	
UiC0	CLK1 to CLK0	Select the count source for the UiBRG register	
	CRS	Select CTS or RTS to use	
	TXEPT	Transmit register empty flag	
	CRD	Enable or disable the CTS or RTS function	
	NCH	Select TxDi pin output mode	
	CKPOL	Select the transfer clock polarity	
	UFORM	Select the LSB first or MSB first	
UiC1	TE	Set this bit to 1 to enable transmission/reception	
	TI	Transmit buffer empty flag	
	RE	Set this bit to 1 to enable reception	
	RI	Reception complete flag	
	U2IRS (1)	Select the source of UART2 transmit interrupt	
	U2RRM ⁽¹⁾	Set this bit to 1 to use UART2 continuous receive mode	
	U2LCH (3)	Set this bit to 1 to use UART2 inverted data logic	
	U2ERE (3)	Set to 0	
U2SMR	0 to 7	Set to 0	
U2SMR2	0 to 7	Set to 0	
U2SMR3	0 to 2	Set to 0	
	NODC	Select clock output mode	
	4 to 7	Set to 0	
U2SMR4	0 to 7	Set to 0	
UCON	U0IRS, U1IRS	Select the source of UART0/UART1 transmit interrupt	
-	U0RRM, U1RRM	Set this bit to 1 to use continuous receive mode	
	CLKMD0	Select the transfer clock output pin when CLKMD1 is set to 1	
	CLKMD1	Set this bit to 1 to output UART1 transfer clock from two pins	
	RCSP	Set this bit to 1 to accept as input the UART0 CTS0 signal from the P64 pin	
	7	Set to 0	

NOTES:

- 1. Set bits 5 and 4 in registers U0C1 and U1C1 to 0. Bits U0IRS, U1IRS, U0RRM, and U1RRM are in the UCON register.
- 2. Not all register bits are described above. Set those bits to 0 when writing to the registers in clock synchronous serial I/O mode.
- 3. Set bits 7 and 6 in registers U0C1 and U1C1 to 0.
- 4. Set the bit 7 in registers U0MR and U1MR to 0.

i=0 to 2

Table 14.3 lists pin functions for the case where the multiple transfer clock output pin select function is deselected. **Table 14.4** lists the P64 pin functions during clock synchronous serial I/O mode.

Note that for a period from when the UARTi operation mode is selected to when transfer starts, the TxDi pin outputs an "H". (If the N-channel open-drain output is selected, this pin is in a high-impedance state.)

Table 14.3 Pin Functions (When Not Select Multiple Transfer Clock Output Pin Function)⁽¹⁾

Pin Name	Function	Method of Selection		
TxDi (i = 0 to 2) (P63, P67, P70)	Serial data output	(Outputs dummy data when performing reception only)		
RxDi (P62, P66, P71)	Serial data input	Set the PD6_2 bit and PD6_6 bit in the PD6 register, and PD7_1 bit in the PD7 register to 0 (Can be used as an input port when performing transmission only)		
CLKi	Transfer clock output	Set the CKDIR bit in the UiMR register to 0		
(P61, P65, P72)	Transfer clock input	Set the CKDIR bit in the UiMR register to 1 Set the PD6_1 bit and PD6_5 bit in the PD6 register, and the PD7_2 bit in the PD7 register to 0		
CTSi/RTSi (P60, P64, P73)	CTS input	Set the CRD bit in the UiC0 register to 0 Set the CRS bit in the UiC0 register to 0 Set the PD6_0 bit and PD6_4 bit in the PD6 register is set to 0, the PD7_3 bit in the PD7 register to 0		
	RTS output	Set the CRD bit in the UiC0 register to 0 Set the CRS bit in the UiC0 register to 1		
	I/O port	Set the CRD bit in the UiC0 register to 1		

NOTE:

Table 14.4 P64 Pin Functions⁽¹⁾

	Bit Set Value					
Pin Function	U1C0 register		UCON register			PD6 register
	CRD	CRS	RCSP	CLKMD1	CLKMD0	PD6_4
P64	1	_	0	0	_	Input: 0, Output: 1
CTS ₁	0	0	0	0	_	0
RTS ₁	0	1	0	0		_
CTS ₀ (2)	0	0	1	0	_	0
CLKS1		_	_	1 ⁽³⁾	1	_

NOTES:

- 1. When the U1MAP bit in PACR register is 1 (P73 to P70), this table lists the P70 functions.
- 2. In addition to this, set the CRD bit in the U0C0 register to 0 (CT00/RT00 enabled) and the CRS bit in the U0C0 register to 1 (RTS0 selected).
- 3. When the CLKMD1 bit is set to 1 and the CLKMD0 bit is set to 0, the following logic levels are output:
 - High if the CLKPOL bit in the U1C0 register is set to 0
 - Low if the CLKPOL bit in the U1C0 register is set to 1

^{1:} When the U1MAP bit in PACR register is 1 (P73 to P70), UART1 pin is assgined to P73 to P70.

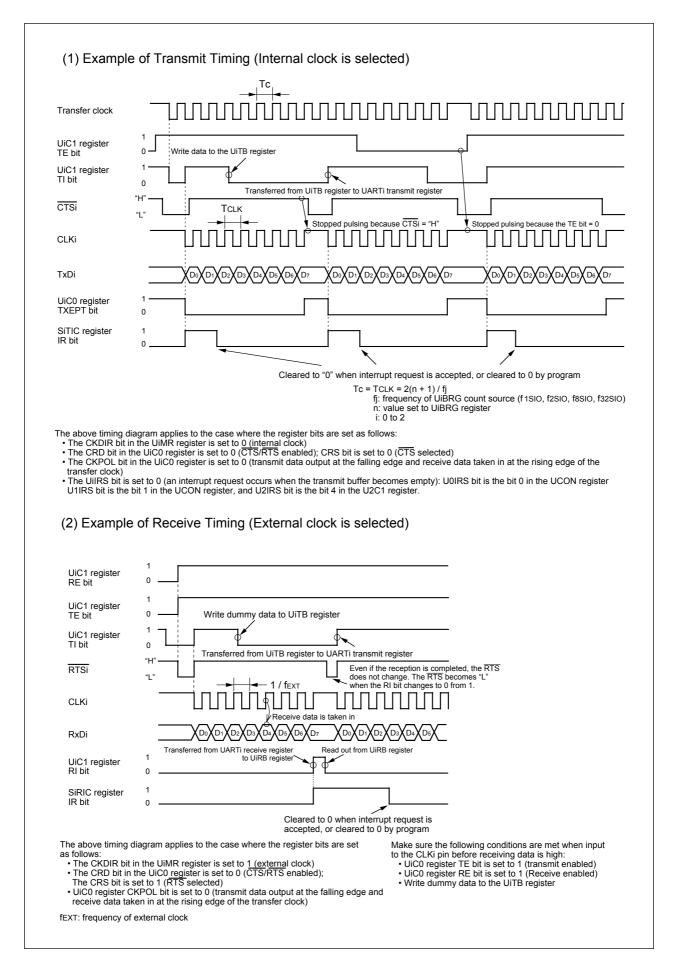


Figure 14.10 Typical transmit/receive timings in clock synchronous serial I/O mode

14.1.1.1 Counter Measure for Communication Error Occurs

If a communication error occurs while transmitting or receiving in clock synchronous serial I/O mode, follow the procedures below.

- •Resetting the UiRB register (i=0 to 2)
- (1) Set the RE bit in the UiC1 register to 0 (reception disabled)
- (2) Set bits SMD2 to SMD0 in the UiMR register to 0002 (Serial I/O disabled)
- (3) Set bits SMD2 to SMD0 in the UiMR register to 0012 (Clock synchronous serial I/O mode)
- (4) Set the RE bit in the UiC1 register to 1 (reception enabled)
- •Resetting the UiTB register (i=0 to 2)
- (1) Set bits SMD2 to SMD0 in the UiMR register to 0002 (Serial I/O disabled)
- (2) Set bits SMD2 to SMD0 in the UiMR register to 0012 (Clock synchronous serial I/O mode)
- (3) 1 is written to TE bit in the UiC1 register (reception enabled), regardless to the TE bit.



14.1.1.2 CLK Polarity Select Function

Use the CKPOL bit in the UiC0 register (i=0 to 2) to select the transfer clock polarity. **Figure 14.11** shows the polarity of the transfer clock.

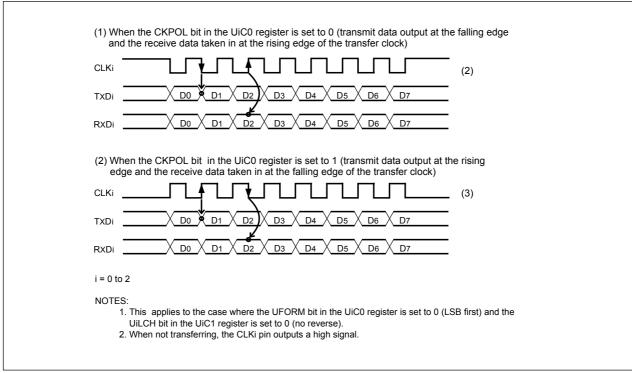


Figure 14.11 Polarity of transfer clock

14.1.1.3 LSB First/MSB First Select Function

Use the UFORM bit in the UiC0 register (i=0 to 2) to select the transfer format. **Figure 14.12** shows the transfer format.

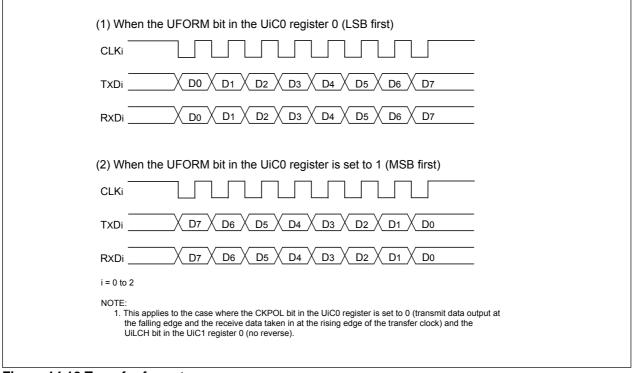


Figure 14.12 Transfer format

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14.1.1.4 Continuous receive mode

When the UiRRM bit (i=0 to 2) is set to 1 (continuous receive mode), the TI bit in the UiC1 register is set to 0 (data present in the UiTB register) by reading the UiRB register. In this case, i.e., UiRRM bit is set to 1, do not write dummy data to the UiTB register in a program. The U0RRM and U1RRM bits are the bit 2 and bit 3 in the UCON register, respectively, and the U2RRM bit is the bit 5 in the U2C1 register.

14.1.1.5 Serial data logic switch function (UART2)

When the U2LCH bit in the U2C1 register is set to 1 (reverse), the data written to the U2TB register has its logic reversed before being transmitted. Similarly, the received data has its logic reversed when read from the U2RB register. Figure 14.13 shows serial data logic.

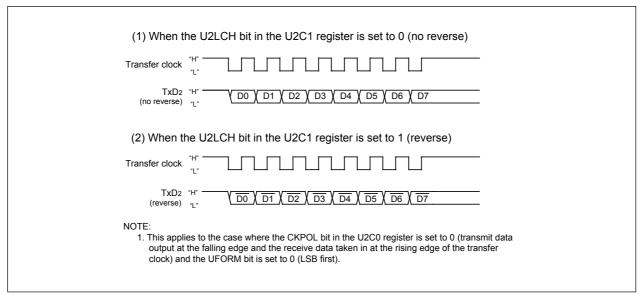


Figure 14.13 Serial data logic switch timing

14.1.1.6 Transfer clock output from multiple pins function (UART1)

The CLKMD1 to CLKMD0 bits in the UCON register can choose one from two transfer clock output pins. (See Figure 14.14) This function is valid when the internal clock is selected for UART1.

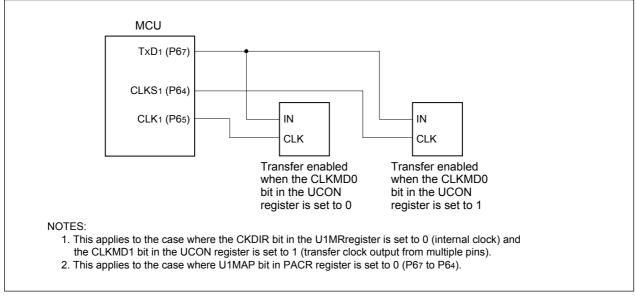


Figure 14.14 Transfer Clock Output From Multiple Pins

14.1.1.7 CTS/RTS separate function (UART0)

This function separates $\overline{\text{CTS}}_0/\overline{\text{RTS}}_0$, outputs $\overline{\text{RTS}}_0$ from the P60 pin, and accepts as input the $\overline{\text{CTS}}_0$ from the P64 pin or P70 pin. To use this function, set the register bits as shown below.

- The CRD bit in the U0C0 register is set to 0 (enables UART0 CTS/RTS)
- The CRS bit in the U0C0 register is set to 1 (outputs UART0 RTS)
- The CRD bit in the U1C0 register is set to 0 (enables UART1 CTS/RTS)
- The CRS bit in the U1C0 register is set to 0 (inputs UART1 CTS)
- The RCSP bit in the UCON register is set to 1 (inputs CTSo from the P64 pin or P70 pin)
- The CLKMD1 bit in the UCON register is set to 0 (CLKS1 not used)

 Note that when using the CTS/RTS separate function, UART1 CTS/RTS separate function cannot be used.

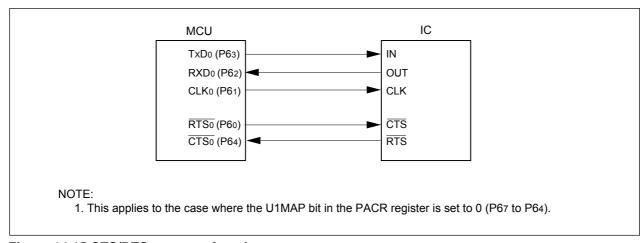


Figure 14.15 CTS/RTS separate function usage

14.Serial I/O M16C/29 Group

14.1.2 Clock Asynchronous Serial I/O (UART) Mode

The UART mode allows transmitting and receiving data after setting the desired bit rate and transfer data format. Table 14.5 lists the specifications of the UART mode.

Table 14.5 UART Mode Specifications

Item	Specification			
Transfer data format	Character bit (transfer data): Selectable from 7, 8 or 9 bits			
	Start bit: 1 bit			
	Parity bit: Selectable from odd, even, or none			
	Stop bit: Selectable from 1 or 2 bits			
Transfer clock	• The CKDIR bit in the UiMR(i=0 to 2) register is set to 0 (internal clock) : fj/ (16(n+1))			
	fj = f1SiO, f2SiO, f8SiO, f32SiO. n: Setting value of UiBRG register 0016 to FF16			
	CKDIR bit is set to 1 (external clock): fext/16(n+1)			
	fEXT: Input from CLKi pin. n:Setting value of UiBRG register 0016 to FF16			
Transmission, reception control	Selectable from CTS function, RTS function or CTS/RTS function disable			
Transmission start condition	Before transmission can start, the following requirements must be met			
	- The TE bit in the UiC1 register is set to 1 (transmission enabled)			
	- The TI bit in the UiC1 register is set to 0 (data present in UiTB register) - The TI bit in the UiC1 register is set to 0 (data present in UiTB register)			
	- If CTS function is selected, input on the CTSi pin is set to "L"			
Reception start condition	Before reception can start, the following requirements must be met			
	- The RE bit in the UiC1 register is set to 1 (reception enabled)			
	- Start bit detection			
	For transmission, one of the following conditions can be selected			
Into word was used	– The UilRS bit ⁽²⁾ is set to 0 (transmit buffer empty): when transferring data from the			
Interrupt request	UiTB register to the UARTi transmit register (at start of transmission)			
generation timing	The UilRS bit is set to 1 (transfer completed): when the serial I/O finished sending			
	data from the UARTi transmit register			
	For reception			
	When transferring data from the UARTi receive register to the UiRB register (at			
	completion of reception)			
Error detection	Overrun error (1)			
Error detection	This error occurs if the serial I/O started receiving the next data before reading the			
	UiRB register and received the bit one before the last stop bit in the the next data			
	• Framing error			
	This error occurs when the number of stop bits set is not detected			
	Parity error			
	This error occurs when if parity is enabled, the number of 1 in parity and			
	character bits does not match the number of 1 set			
	Error sum flag			
	This flag is set to 1 when any of the overrun, framing, and parity errors is encountered			
Coloct function				
Select function	• LSB first, MSB first selection			
	Whether to start sending/receiving data beginning with bit 0 or beginning with bit 7			
	can be selected			
	Serial data logic switch (UART2) This function reverses the logic of the transmit/receive data. The start and stan hitself.			
	This function reverses the logic of the transmit/receive data. The start and stop bits			
	are not reversed.			
	• TxD, RxD I/O polarity switch (UART2)			
	This function reverses the polarities of hte TxD pin output and RxD pin input. The			
	logic levels of all I/O data is reversed.			
	Separate CTS/RTS pins (UART0)			
	CTS ₀ and RTS ₀ are input/output from separate pins			
	UART1 pin remapping selection			
	The UART1 pin can be selected from the P67 to P64 or P73 to P70			

NOTES:

- 1. If an overrun error occurs, bits 8 to 0 in the UiRB register are undefined. The IR bit in the SiRIC register remains unchange.
- 2. Bits U0IRS and U1IRS respectively are the UCON register bits 0 and 1; the U2IRS bit is the U2C1 register bit 4.



Table 14.6 Registers to Be Used and Settings in UART Mode

Register	Bit	Function			
UiTB	0 to 8	Set transmission data ⁽¹⁾			
UiRB	0 to 8	Reception data can be read ⁽¹⁾			
	OER,FER,PER,SUM	Error flag			
UiBRG	0 to 7	Set bit rate			
UiMR	SMD2 to SMD0	Set these bits to 1002 when transfer data is 7 bits long			
		Set these bits to 1012 when transfer data is 8 bits long			
		Set these bits to 1102 when transfer data is 9 bits long			
	CKDIR	Select the internal clock or external clock			
	STPS	Select the stop bit			
	PRY, PRYE	Select whether parity is included and whether odd or even			
	IOPOL(i=2) (4)	Select the TxD/RxD input/output polarity			
UiC0	CLK0, CLK1	Select the count source for the UiBRG register			
	CRS	Select CTS or RTS to use			
	TXEPT	Transmit register empty flag			
	CRD	Enable or disable the CTS or RTS function			
	NCH	Select TxDi pin output mode			
	CKPOL	Set to 0			
	UFORM	LSB first or MSB first can be selected when transfer data is 8 bits long. Set this			
		bit to 0 when transfer data is 7 or 9 bits long.			
UiC1	TE	Set this bit to 1 to enable transmission			
	TI	Transmit buffer empty flag			
	RE	Set this bit to 1 to enable reception			
	RI	Reception complete flag			
	U2IRS (2)	Select the source of UART2 transmit interrupt			
	U2RRM ⁽²⁾	Set to 0			
	UiLCH (3)	Set this bit to 1 to use UART2 inverted data logic			
	UiERE (3)	Set to 0			
UiSMR	0 to 7	Set to 0			
UiSMR2	0 to 7	Set to 0			
UiSMR3	0 to 7	Set to 0			
UiSMR4	0 to 7	Set to 0			
UCON	U0IRS, U1IRS	Select the source of UART0/UART1 transmit interrupt			
	U0RRM, U1RRM	Set to 0			
	CLKMD0	Invalid because CLKMD1 is set to 0			
	CLKMD1	Set to 0			
	RCSP	Set this bit to 1 to accept as input the UART0 CTS0 signal from the P64 pin			
	7	Set to 0			

NOTES:

- 1. The bits used for transmit/receive data are as follows: Bit 0 to bit 6 when transfer data is 7 bits long; bits 7 to 0 when transfer data is 8 bits long; bit 0 to bit 8 when transfer data is 9 bits long.
- 2. Set bits 5 and 4 in registers U0C1 and U1C1 to 0. Bits U0IRS, U1IRS, U0RRM and U1RRM are included in the UCON register.
- 3. Set bits 7 and 6 in registers U0C1 and U1C1 to 0.
- 4. Set the bit 7 in registers U0MR and U1MR to 0.

i=0 to 2

Table 14.7 lists the functions of the input/output pins in UART mode. **Table 14.8** lists the P64 pin functions during UART mode. Note that for a period from when the UARTi operation mode is selected to when transfer starts, the TxDi pin outputs an "H". (If the N-channel open-drain output is selected, this pin is in a high-impedance state.)

Table 14.7 I/O Pin Functions in UART mode⁽¹⁾

Pin Name	Function	Method of Selection		
TxDi (i = 0 to 2) (P63, P67, P70)	Serial data output	(Outputs "H" when performing reception only)		
RxDi (P62, P66, P71)	Serial data input	PD6_2 bit, PD6_6 bit in the PD6 register and the PD7_1 bit in the PD7 register (Can be used as an input port when performing transmission only)		
CLKi	Input/output port	Set the CKDIR bit in the UiMR register to 0		
(P61, P65, P72)	Transfer clock input	the CKDIR bit in the UiMR register to 1 the PD6_1 bit and PD6_5 bit in the PD6 register to 0, PD7_2 bit in the PD7 ister to 0		
CTSi/RTSi (P60, P64, P73)	CTS input	Set the CRD bit in the UiC0 register to 0 Set the CRS bit in the UiC0 register to 0 Set the PD6_0 bit and PD6_4 bit in the PD6 register to 0, the PD7_3 bit in the PD7 register 0		
	RTS output	Set the CRD bit in the UiC0 register to 0 Set the CRS bit in the UiC0 register to 1		
	Input/output port	Set the CRD bit in the UiC0 register 1		

NOTE:

Table 14.8 P64 Pin Functions in UART mode (1)

	Bit Set Value					
Pin Function	U1C0 register		UCON register		PD6 register	
	CRD	CRS	RCSP	CLKMD1	PD6_4	
P64	1	_	0	0	Input: 0, Output: 1	
CTS ₁	0	0	0	0	0	
RTS ₁	0	1	0	0		
CTS ₀ (2)	0	0	1	0	0	

NOTES:

- 1. When the U1MAP bit in PACR register is 1 (P73 to P70), this table lists the P70 functions.
- 2. In addition to this, set the CRD bit in the U0C0 register to 0 (CTSo/RTSo enabled) and the CRS bit in the U0C0 register to 1 (RTSo selected).

^{1.} When the U1MAP bit in PACR register is set to 1 (P73 to P70), UART1 pin is assgined to P73 to P70.

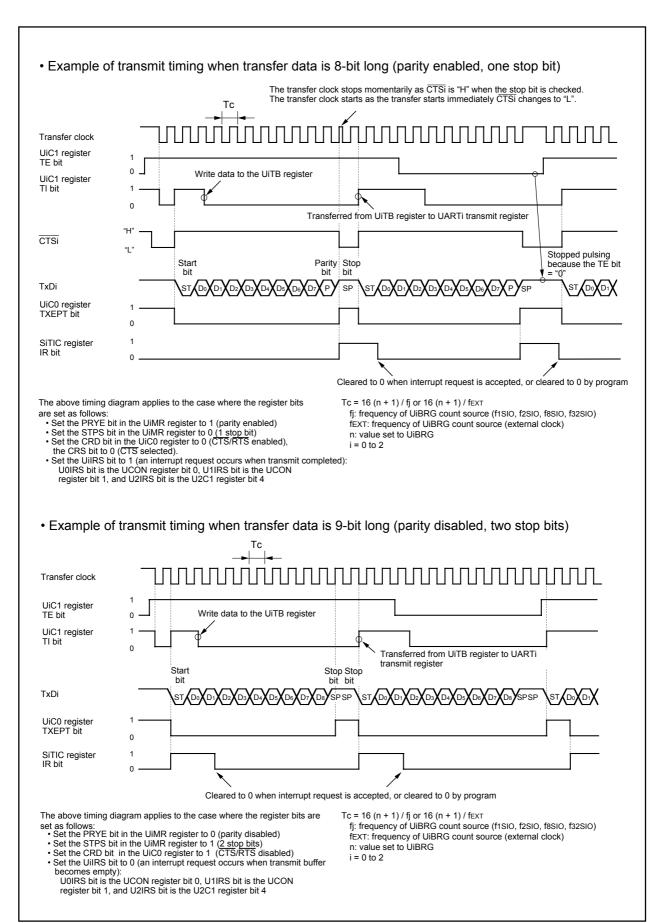


Figure 14.16 Typical transmit timing in UART mode (UART0, UART1)

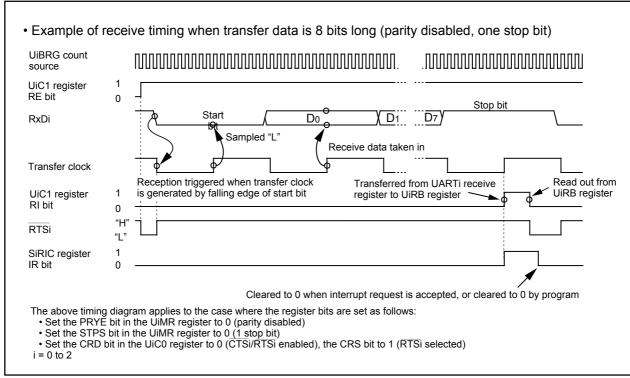


Figure 14.17 Receive Operation

14.1.2.1 Bit Rates

In UART mode, the frequency set by the UiBRG register (i=0 to 2) divided by 16 become the bit rates. **Table 14.9** lists example of bit rate and settings.

Table 14.9 Example of Bit Rates and Settings

Bit Rate	Count Source	Peripheral Function Clock : 16MHz		Peripheral Function Clock : 20MHz	
(bps)	of BRG	Set Value of BRG : n	Actual Time (bps)	Set Value of BRG : n	Actual Time (bps)
1200	f8	103(67h)	1202	129(81h)	1202
2400	f8	51(33h)	2404	64(40h)	2404
4800	f8	25(19h)	4808	32(20h)	4735
9600	f1	103(67h)	9615	129(81h)	9615
14400	f1	68(44h)	14493	86(56h)	14368
19200	f1	51(33h)	19231	64(40h)	19231
28800	f1	34(22h)	28571	42(2Ah)	29070
31250	f1	31(1Fh)	31250	39(27h)	31250
38400	f1	25(19h)	38462	32(20h)	37879
51200	f1	19(13h)	50000	24(18h)	50000

14.1.2.2 Counter Measure for Communication Error

If a communication error occurs while transmitting or receiving in UART mode, follow the procedure below.

- Resetting the UiRB register (i=0 to 2)
- (1) Set the RE bit in the UiC1 register to 0 (reception disabled)
- (2) Set the RE bit in the UiC1 register to 1 (reception enabled)
- Resetting the UiTB register (i=0 to 2)
- (1) Set bits SMD2 to SMD0 in UiMR register 0002 (Serial I/O disabled)
- (2) Set bits SMD2 to SMD0 in UiMR register 0012, 1012, 1102
- (3) 1 is written to TE bit in the UiC1 register (reception enabled), regardless of the TE bit

14.1.2.3 LSB First/MSB First Select Function

As shown in **Figure 14.18**, use the UFORM bit in the UiC0 register to select the transfer format. This function is valid when transfer data is 8 bits long.

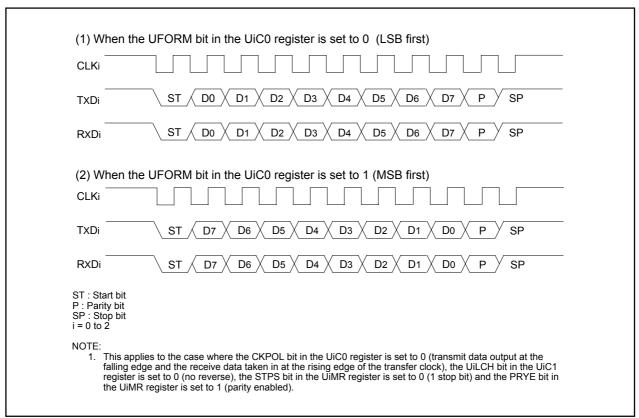


Figure 14.18 Transfer Format

14.1.2.4 Serial Data Logic Switching Function (UART2)

The data written to the U2TB register has its logic reversed before being transmitted. Similarly, the received data has its logic reversed when read from the U2RB register. **Figure 14.19** shows serial data logic.

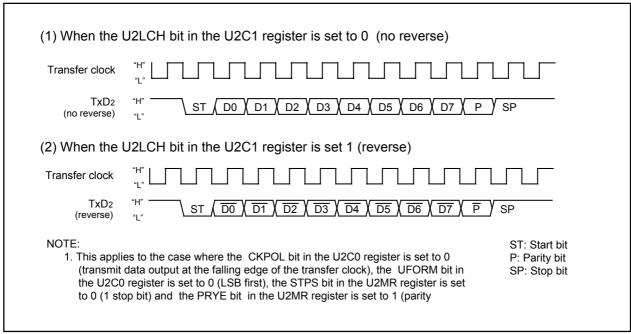


Figure 14.19 Serial Data Logic Switching

14.1.2.5 TxD and RxD I/O Polarity Inverse Function (UART2)

This function inverses the polarities of the TxD2 pin output and RxD2 pin input. The logic levels of all input/output data (including the start, stop and parity bits) are inversed. **Figure 14.20** shows the TxD pin output and RxD pin input polarity inverse.

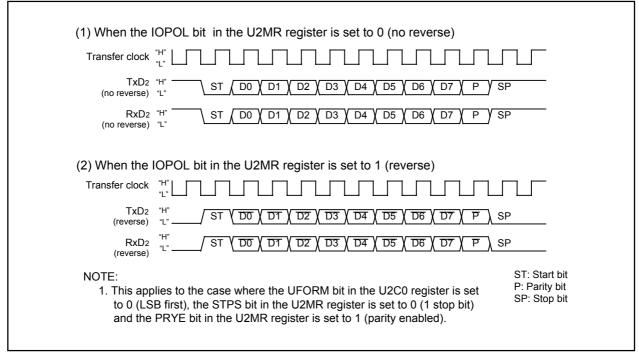


Figure 14.20 TxD and RxD I/O Polarity Inverse

14.1.2.6 CTS/RTS Separate Function (UART0)

This function separates $\overline{\text{CTS}}_0/\overline{\text{RTS}}_0$, outputs $\overline{\text{RTS}}_0$ from the P60 pin, and accepts as input the $\overline{\text{CTS}}_0$ from the P64 pin or P70 pin. To use this function, set the register bits as shown below.

- The CRD bit in the U0C0 register is set to 0 (enables UART0 CTS/RTS)
- The CRS bit in the U0C0 register is set to 1 (outputs UART0 RTS)
- The CRD bit in the U1C0 register is set to 0 (enables UART1 CTS/RTS)
- The CRS bit in the U1C0 register is set to 0 (inputs UART1 CTS)
- The RCSP bit in the UCON register is set to 1 (inputs CTS0 from the P64 pin or P70 pin)
- The CLKMD1 bit in the UCON register is set to 0 (CLKS1 not used)

Note that when using the $\overline{CTS}/\overline{RTS}$ separate function, UART1 $\overline{CTS}/\overline{RTS}$ separate function cannot be used.

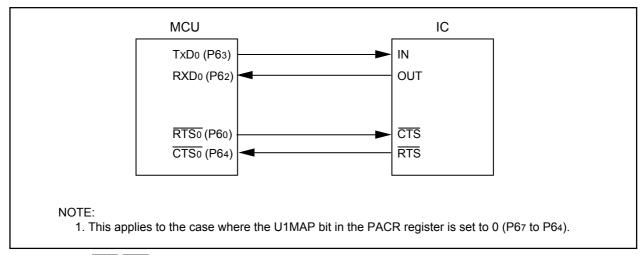


Figure 14.21 CTS/RTS Separate Function

14.1.3 Special Mode 1 (I²C bus mode)(UART2)

 I^2C bus mode is provided for use as a simplified I^2C bus interface compatible mode. **Table 14.10** lists the specifications of the I^2C bus mode. **Tables 14.11** and **14.12** list the registers used in the I^2C bus mode and the register values set. **Table 14.13** lists the I^2C bus mode fuctions. **Figure 14.22** shows the block diagram for I^2C bus mode. **Figure 14.23** shows SCL2 timing.

As shown in **Table 14.13**, the MCU is placed in I^2C bus mode by setting bits SMD2 to SMD0 to 0102 and the IICM bit to 1. Because SDA2 transmit output has a delay circuit attached, SDA output does not change state until SCL2 goes low and remains stably low.

Table 14.10 I²C bus mode Specifications

Item	Specification
Transfer data format	Transfer data length: 8 bits
Transfer clock	During master
	the CKDIR bit in the U2MR register is set to 0 (internal clock) : fj/ (2(n+1))
	fj = f1SIO, f2SIO, f8SIO, f32SIO. n: Setting value in the U2BRG register 0016 to FF16
	During slave
	CKDIR bit is set to 1 (external clock): Input from SCL2 pin
Transmission start condition	Before transmission can start, the following requirements must be met (1)
	– The TE bit in the U2C1 register is set to 1 (transmission enabled)
	– The TI bit in the U2C1 register is set to 0 (data present in U2TB register)
Reception start condition	Before reception can start, the following requirements must be met (1)
	- The RE bit in the U2C1 register is set to 1 (reception enabled)
	– The TE bit in the U2C1 register is set to 1 (transmission enabled)
	– The TI bit in the U2C1 register is set to 0 (data present in the UiTB register)
Interrupt request	When start or stop condition is detected, acknowledge undetected, and acknowledge
generation timing	detected
Error detection	Overrun error (2)
	This error occurs if the serial I/O started receiving the next data before reading the
	U2RB register and received the 8th bit in the the next data
Select function	Arbitration lost
	Timing at which the ABT bit in the U2RB register is updated can be selected
	SDA digital delay
	No digital delay or a delay of 2 to 8 U2BRG count source clock cycles selectable
	Clock phase setting
	With or without clock delay selectable

NOTES:

- 1. When an external clock is selected, the conditions must be met while the external clock is in the high state.
- 2. If an overrun error occurs, bits 8 to 0 in the U2RB register are undefined. The IR bit in the S2RIC register remains unchange.

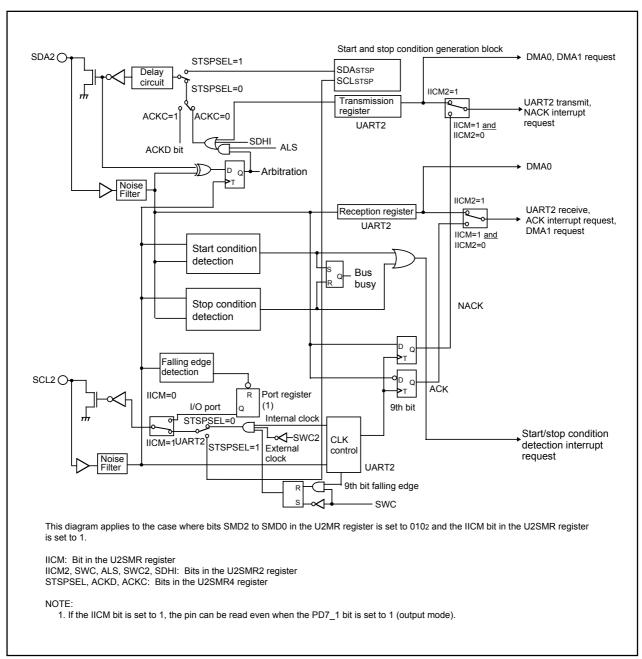


Figure 14.22 I²C bus mode Block Diagram

Table 14.11 Registers to Be Used and Settings in I²C bus mode (1) (Continued)

Register	Bit	Fund	Function			
·		Master Slave				
U2TB	0 to 7	Set transmission data	Set transmission data			
U2RB ⁽¹⁾	0 to 7	Reception data can be read	Reception data can be read			
	8	ACK or NACK is set in this bit	ACK or NACK is set in this bit			
	ABT	Arbitration lost detection flag	Invalid			
	OER	Overrun error flag	Overrun error flag			
U2BRG	0 to 7	Set bit rate	Invalid			
U2MR ⁽¹⁾	SMD2 to SMD0	Set to 0102	Set to 0102			
	CKDIR	Set to 0	Set to 1			
	IOPOL	Set to 0	Set to 0			
U2C0	CLK1, CLK0	Select the count source for the U2BRG register	Invalid			
	CRS	Invalid because CRD = 1	Invalid because CRD = 1			
	TXEPT	Transmit buffer empty flag	Transmit buffer empty flag			
	CRD	Set to 1	Set to 1			
	NCH	Set to 1	Set to 1			
	CKPOL	Set to 0	Set to 0			
	UFORM	Set to 1	Set to 1			
U2C1	TE	Set this bit to 1 to enable transmission	Set this bit to 1 to enable transmission			
	TI	Transmit buffer empty flag	Transmit buffer empty flag			
	RE	Set this bit to 1 to enable reception	Set this bit to 1 to enable reception			
	RI	Reception complete flag	Reception complete flag			
	U2IRS	Invalid	Invalid			
	U2RRM, U2LCH, U2ERE	Set to 0	Set to 0			
U2SMR	IICM	Set to 1	Set to 1			
	ABC	Select the timing at which arbitration-lost is detected	Invalid			
	BBS	Bus busy flag	Bus busy flag			
	3 to 7	Set to 0	Set to 0			
U2SMR2	IICM2	Refer to Table 14.13	Refer to Table 14.13			
	CSC	Set this bit to 1 to enable clock synchronization	Set to 0			
	SWC	Set this bit to 1 to have SCL2 output fixed to L at the falling edge of the 9th	Set this bit to 1 to have SCL2 output fixed to "L" at the falling edge of the 9 th			
		bit of clock	bit of clock			
	ALS	Set this bit to 1 to have SDA2 output	Set to 0			
	/	stopped when arbitration-lost is detected	331.13 3			
	STAC	Set to 0	Set this bit to 1 to initialize UART2 at			
	CMC3	Cot this hit to 1 to have COL a sustaint	start condition detection			
	SWC2	Set this bit to 1 to have SCL2 output	Set this bit to 1 to have SCL2 output			
	CDIII	forcibly pulled low	forcibly pulled low			
	SDHI	Set this bit to 1 to disable SDA2 output	Set this bit to 1 to disable SDA2 output			
11001155	7	Set to 0	Set to 0			
U2SMR3	0, 2, 4 and NODC	Set to 0	Set to 0			
	CKPH	Refer to Table 14.13	Refer to Table 14.13			
	DL2 to DL0	Set the amount of SDA2 digital delay	Set the amount of SDA2 digital delay			

NOTE:

^{1.} Not all bits in the register are described above. Set those bits to 0 when writing to the registers in I²C bus mode.

Table 14.12 Registers to Be Used and Settings in I²C bus Mode (2) (Continued)

Register	Bit	Function		
		Master	Slave	
U2SMR4	STAREQ	Set this bit to 1 to generate start	Set to 0	
		condition		
	RSTAREQ	Set this bit to 1 to generate restart	Set to 0	
		condition		
	STPREQ	Set this bit to 1 to generate stop	Set to 0	
		condition		
	STSPSEL	Set this bit to 1 to output each condition	Set to 0	
	ACKD	Select ACK or NACK	Select ACK or NACK	
	ACKC	Set this bit to 1 to output ACK data	Set this bit to 1 to output ACK data	
	SCLHI	Set this bit to 1 to have SCL2 output	Set to 0	
		stopped when stop condition is detected		
	SWC9	Set to 0	Set this bit to 1 to set the SCL2 to "L"	
			hold at the falling edge of the 9th bit of	
			clock	

NOTE:

^{1:} Not all bits in the register are described above. Set those bits to 0 when writing to the registers in I^2C bus mode.

14. Serial I/O M16C/29 Group

Table 14.13 I²C bus mode Functions

Function	Clock synchronous serial I/O	I ² C bus mode (SMD2 to SMD	0 = 0102, IICM = 1)		
	mode (SMD2 to SMD0 = 0012, IICM = 0)	I -		IICM2 = 1	UART transmit/ receive interrupt)	
		CKPH = 0	CKPH = 1	CKPH = 0	CKPH = 1	
		(No clock delay)	, ,,	. , , , , , , , , , , , , , , , , , , ,	(Clock delay)	
Factor of interrupt number 10 ⁽¹⁾ (Refer to Fig.14.23)		(Refer to Table		pp condition detection		
Factor of interrupt number 15 ⁽¹⁾ (Refer to Fig.14.23)	UART2 transmission Transmission started or completed (selected by U2IRS)	No acknowledgr detection (NACk Rising edge of S	<)	UART2 transmission Rising edge of SCL2 9th bit	UART2 transmission Falling edge of SCL2 next to the 9th bit	
Factor of interrupt number 16 ⁽¹⁾ (Refer to Fig.14.23)	UART2 reception When 8th bit received CKPOL = 0 (rising edge) CKPOL = 1 (falling edge)	(ACK)	Acknowledgment detection			
Timing for transferring data from the UART reception shift register to the U2RB register	CKPOL = 0 (rising edge) CKPOL = 1 (falling edge)	Rising edge of S	SCL2 9th bit	Falling edge of SCL2 9th bit	Falling and rising edges of SCL2 9th bit	
UART2 transmission output delay	Not delayed	Delayed				
Functions of P70 pin	TxD2 output	SDA2 input/outp	SDA2 input/output			
Functions of P71 pin	tions of P71 pin RxD2 input		SCL2 input/output			
Functions of P72 pin	Functions of P72 pin CLK2 input or output selected		——— (Cannot be used in I ² C bus mode)			
Noise filter width 15ns		200ns				
Read RxD2 and SCL2 pin levels	Possible when the corresponding port direction bit = 0	Always possible no matter how the corresponding port direction bit		ort direction bit is set		
Initial value of TxD2 and SDA2 outputs	CKPOL = 0 (H) CKPOL = 1 (L)	The value set in the port register before setting I ² C bus mode ⁽²⁾			ous mode ⁽²⁾	
Initial and end values of SCL2		Н	L	Н	L	
DMA1 factor (Refer to Fig. 14.23)	UART2 reception	Acknowledgment detection (ACK) UART2 reception Falling edge of SCL2 9th		2 9th bit		
Store received data	1st to 8th bits are stored in bits bit 7 to 0 in the U2RB register	1st to 8th bits ar bits bit 7 to 0 in register		1st to 7th bits are sto bit 0 in the U2RB restored in the bit 8 in	gister, with 8th bit	
					1st to 8th bits are stored in U2RB register bit 7 to bit 0	
Read received data	U2RB register status is read directly as is				Read U2RB register Bit 6 to bit 0 as bit 7 to bit 1, and bit 8 as	

NOTES:

- 1. If the source or cause of any interrupt is changed, the IR bit in the interrupt control register for the changed interrupt may inadvertently be set to 1 (interrupt requested). (Refer to "Notes on interrupts" in Precautions.) If one of the bits shown below is changed, the interrupt source, the interrupt timing, etc. change. Therefore, always be sure to clear the IR bit to 0 (interrupt not requested) after changing those bits
 - Bits SMD2 to the SMD0 in the U2MR register, the IICM bit in the U2SMR register,
 - the IICM2 bit in the U2SMR2 register, the CKPH bit in the U2SMR3 register
- 2. Set the initial value of SDA2 output while bits SMD2 to SMD0 in the U2MR register is set to 0002 (serial I/O disabled).
- 3. Second data transfer to U2RB register (Rising edge of SCL2 9th bit)
- 4. First data transfer to U2RB register (Falling edge of SCL2 9th bit)



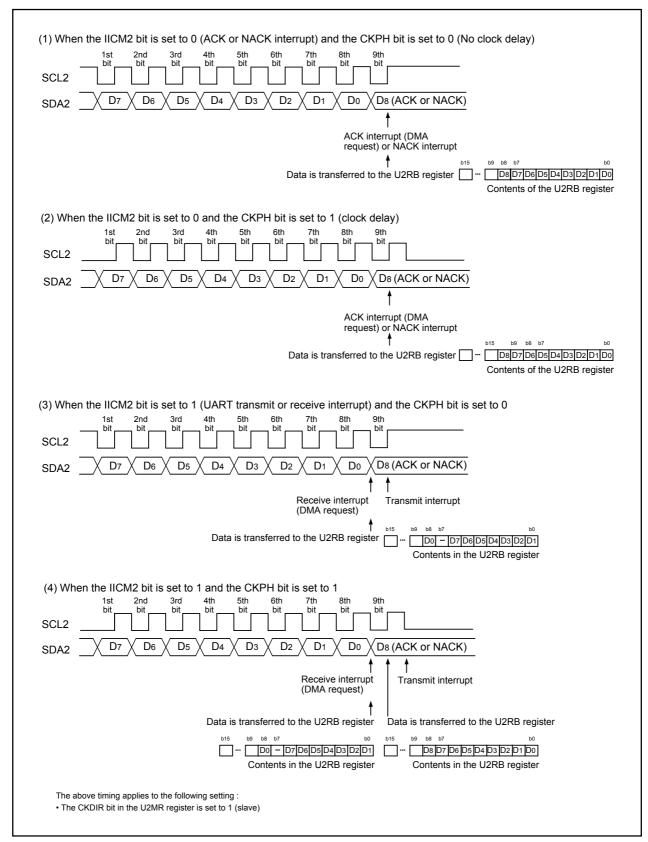


Figure 14.23 Transfer to U2RB Register and Interrupt Timing

14.1.3.1 Detection of Start and Stop Condition

Whether a start or a stop condition has been detected is determined.

A start condition-detected interrupt request is generated when the SDA2 pin changes state from high to low while the SCL2 pin is in the high state. A stop condition-detected interrupt request is generated when the SDA2 pin changes state from low to high while the SCL2 pin is in the high state.

Because the start and stop condition-detected interrupts share the interrupt control register and vector, check the BBS bit in the U2SMR register to determine which interrupt source is requesting the interrupt.

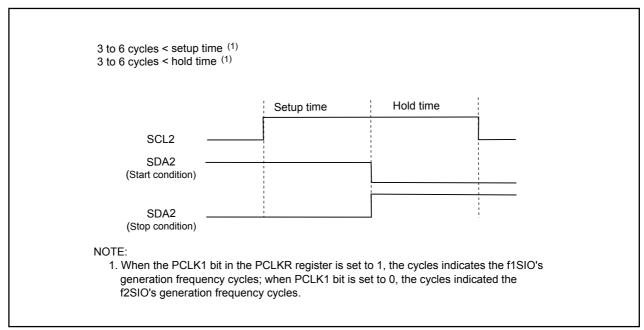


Figure 14.24 Detection of Start and Stop Condition

14.1.3.2 Output of Start and Stop Condition

A start condition is generated by setting the STAREQ bit in the U2SMR4 register to 1 (start).

A restart condition is generated by setting the RSTAREQ bit in the U2SMR4 register to 1 (start).

A stop condition is generated by setting the STPREQ bit in the U2SMR4 register to 1 (start).

The output procedure is described below.

- (1) Set the STAREQ bit, RSTAREQ bit or STPREQ bit to 1 (start).
- (2) Set the STSPSEL bit in the U2SMR4 register to 1 (output).

Make sure that no interrupts or DMA transfers will occur between (1) and (2).

The function of the STSPSEL bit is shown in Table 14.14 and Figure 14.25.

Table 14.14 STSPSEL Bit Functions

Function	STSPSEL = 0	STSPSEL = 1
Output of SCL2 and SDA2 pins	Output transfer clock and data/	The STAREQ, RSTAREQ and
	Program with a port determines	STPREQ bit determine how the
	how the start condition or stop	start condition or stop condition is
	condition is output	output
Start/stop condition interrupt	Start/stop condition are detec-	Start/stop condition generation
request generation timing	ted	are completed

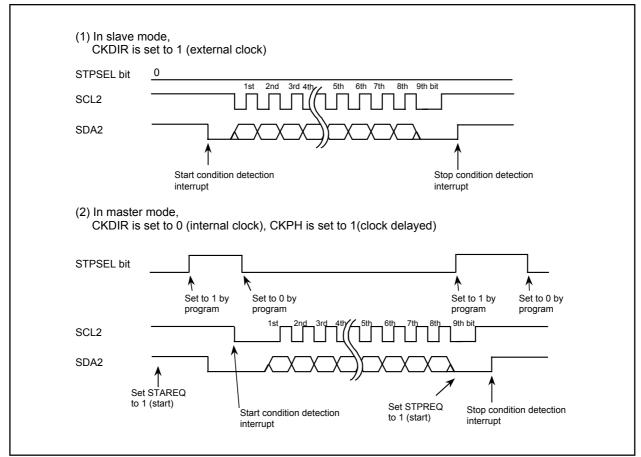


Figure 14.25 STSPSEL Bit Functions

14.1.3.3 Arbitration

Unmatching of the transmit data and SDA2 pin input data is checked synchronously with the rising edge of SCL2. Use the ABC bit in the U2SMR register to select the timing at which the ABT bit in the U2RB register is updated. If the ABC bit is set to 0 (updated bitwise), the ABT bit is set to 1 at the same time unmatching is detected during check, and is cleared to 0 when not detected. In cases when the ABC bit is set to 1, if unmatching is detected even once during check, the ABT bit is set to 1 (unmatching detected) at the falling edge of the clock pulse of 9th bit. If the ABT bit needs to be updated bytewise, clear the ABT bit to 0 (undetected) after detecting acknowledge in the first byte, before transferring the next byte.

Setting the ALS bit in the U2SMR2 register to 1 (SDA2 output stop enabled) causes arbitration-lost to occur, in which case the SDA2 pin is placed in the high-impedance state at the same time the ABT bit is set to 1 (unmatching detected).

14.1.3.4 Transfer Clock

Data is transmitted/received using a transfer clock like the one shown in Figure 14.25.

The CSC bit in the U2SMR2 register is used to synchronize the internally generated clock (internal SCL2) and an external clock supplied to the SCL2 pin. In cases when the CSC bit is set to 1 (clock synchronization enabled), if a falling edge on the SCL2 pin is detected while the internal SCL2 is high, the internal SCL2 goes low, at which time the U2BRG register value is reloaded with and starts counting in the low-level interval. If the internal SCL2 changes state from low to high while the SCL2 pin is low, counting stops, and when the SCL2 pin goes high, counting restarts.

In this way, the UART2 transfer clock is comprised of the logical product of the internal SCL2 and SCL2 pin signal. The transfer clock works from a half period before the falling edge of the internal SCL2 1st bit to the rising edge of the 9th bit. To use this function, select an internal clock for the transfer clock. The SWC bit in the U2SMR2 register allows to select whether the SCL2 pin should be fixed to or freed from low-level output at the falling edge of the 9th clock pulse.

If the SCLHI bit in the U2SMR4 register is set to 1 (enabled), SCL2 output is turned off (placed in the high-impedance state) when a stop condition is detected.

Setting the SWC2 bit in the U2SMR2 register is set to 1 (0 output) makes it possible to forcibly output a low-level signal from the SCL2 pin even while sending or receiving data. Clearing the SWC2 bit to 0 (transfer clock) allows the transfer clock to be output from or supplied to the SCL2 pin, instead of outputting a low-level signal.

If the SWC9 bit in the U2SMR4 register is set to 1 (SCL2 hold low enabled) when the CKPH bit in the U2SMR3 register is set to 1, the SCL2 pin is fixed to low-level output at the falling edge of the clock pulse next to the ninth. Setting the SWC9 bit to 0 (SCL2 hold low disabled) frees the SCL2 pin from low-level output.

14.1.3.5 SDA Output

The data written to the bit 7 to bit 0 (D7 to D0) in the U2TB register is sequentially output beginning with D7. The ninth bit (D8) is ACK or NACK.

The initial value of SDA2 transmit output can only be set when IICM is set to 1 (I²C bus mode) and bits SMD2 to SMD0 in the U2MR register is set to 0002 (serial I/O disabled).

Bits DL2 to DL0 in the U2SMR3 register allow to add no delays or a delay of 2 to 8 U2BRG count source clock cycles to SDA2 output.

Setting the SDHI bit in the U2SMR2 register to 1 (SDA2 output disabled) forcibly places the SDA2 pin in the high-impedance state. Do not write to the SDHI bit synchronously with the rising edge of the UART2 transfer clock. This is because the ABT bit may inadvertently be set to 1 (detected).

14.1.3.6 SDA Input

When the IICM2 bit is set to 0, the 1st to 8th bits (D7 to D0) in the received data are stored in bits 7 to 0 in the U2RB register. The 9th bit (D8) is ACK or NACK.

When the IICM2 bit is set to 1, the 1st to 7th bits (D7 to D1) in the received data are stored in the bit 6 to bit 0 in the U2RB register and the 8th bit (D0) is stored in the bit 8 in the U2RB register. Even when the IICM2 bit is set to 1, providing the CKPH bit is set to 1, the same data as when the IICM2 bit is set to 0 can be read out by reading the U2RB register after the rising edge of the corresponding clock pulse of 9th bit.



14.1.3.7 ACK and NACK

If the STSPSEL bit in the U2SMR4 register is set to 0 (start and stop conditions not generated) and the ACKC bit in the U2SMR4 register is set to 1 (ACK data output), the value of the ACKD bit in the U2SMR4 register is output from the SDA2 pin.

If the IICM2 bit is set to 0, a NACK interrupt request is generated if the SDA2 pin remains high at the rising edge of the 9th bit of transmit clock pulse. An ACK interrupt request is generated if the SDA2 pin is low at the rising edge of the 9th bit of transmit clock pulse.

If ACK2 is selected for the cause of DMA1 request, a DMA transfer can be activated by detection of an acknowledge.

14.1.3.8 Initialization of Transmission/Reception

If a start condition is detected while the STAC bit is set to 1 (UART2 initialization enabled), the serial I/O operates as described below.

- The transmit shift register is initialized, and the content of the U2TB register is transferred to the transmit shift register. In this way, the serial I/O starts sending data synchronously with the next clock pulse applied. However, the UART2 output value does not change state and remains the same as when a start condition was detected until the first bit in the data is output synchronously with the input clock.
- The receive shift register is initialized, and the serial I/O starts receiving data synchronously with the next clock pulse applied.
- The SWC bit is set to 1 (SCL2 wait output enabled). Consequently, the SCL2 pin is pulled low at the falling edge of the ninth clock pulse.

Note that when UART2 transmission/reception is started using this function, the TI does not change state. Note also that when using this function, the selected transfer clock should be an external clock.



14.1.4 Special Mode 2 (UART2)

Multiple slaves can be serially communicated from one master. Transfer clock polarity and phase are selectable. **Table 14.15** lists the specifications of Special Mode 2. **Table 14.16** lists the registers used in Special Mode 2 and the register values set. **Figure 14.26** shows communication control example for Special Mode 2.

Table 14.15 Special Mode 2 Specifications

Item	Specification		
Transfer data format	Transfer data length: 8 bits		
Transfer clock	Master mode		
	the CKDIR bit in the U2MR register is set to 0 (internal clock) : fj/ (2(n+1))		
	fj = f1SiO, f2SiO, f8SiO, f32SiO. n: Setting value in the U2BRG register 0016 to FF16		
	Slave mode		
	CKDIR bit is set to 1 (external clock selected): Input from CLK2 pin		
Transmit/receive control	Controlled by input/output ports		
Transmission start condition	Before transmission can start, the following requirements must be met (1)		
	 The TE bit in the U2C1 register is set to 1 (transmission enabled) 		
	 The TI bit in the U2C1 register is set to 0 (data present in U2TB register) 		
Reception start condition	Before reception can start, the following requirements must be met (1)		
	 The RE bit in the U2C1 register is set to 1 (reception enabled) 		
	 The TE bit in the U2C1 register is set to 1 (transmission enabled) 		
	 The TI bit in the U2C1 register is set to 0 (data present in the U2TB register) 		
Interrupt request	For transmission, one of the following conditions can be selected		
generation timing	– The U2IRS bit in the U2C1 register is set to 0 (transmit buffer empty): when trans		
	ferring data from the U2TB register to the UART2 transmit register (at start of transmission)		
	– The U2IRS bit is set to 1 (transfer completed): when the serial I/O finished sending		
	data from the UART2 transmit register		
	For reception		
	When transferring data from the UART2 receive register to the U2RB register (at		
	completion of reception)		
Error detection	Overrun error (2)		
	This error occurs if the serial I/O started receiving the next data before reading the		
	U2RB register and received the 7th bit in the the next data		
Select function	Clock phase setting		
	Selectable from four combinations of transfer clock polarities and phases		

NOTES:

- 1. When an external clock is selected, the conditions must be met while if the CKPOL bit in the U2C0 register is set to 0 (transmit data output at the falling edge and the receive data taken in at the rising edge of the transfer clock), the external clock is in the high state; if the CKPOL bit in the U2C0 register is set to 1 (transmit data output at the rising edge and the receive data taken in at the falling edge of the transfer clock), the external clock is in the low state.
- 2. If an overrun error occurs, bits 8 to 0 in the U2RB register are undefined. The IR bit in the S2RIC register remains unchanged.

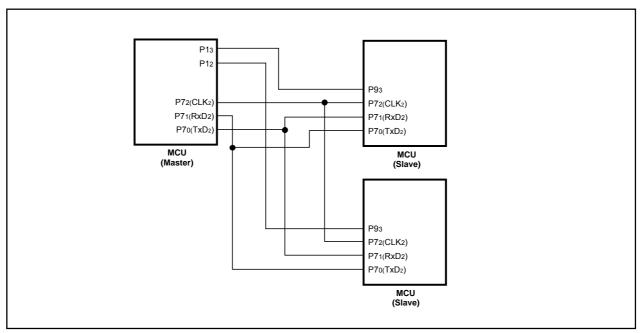


Figure 14.26 Serial Bus Communication Control Example (UART2)

Table 14.16 Registers to Be Used and Settings in Special Mode 2

Register	Bit	Function
U2TB ⁽¹⁾	0 to 7	Set transmission data
U2RB ⁽¹⁾	0 to 7	Reception data can be read
	OER	Overrun error flag
U2BRG	0 to 7	Set bit rate
U2MR ⁽¹⁾	SMD2 to SMD0	Set to 0012
	CKDIR	Set this bit to 0 for master mode or 1 for slave mode
	IOPOL	Set to 0
U2C0	CLK1, CLK0	Select the count source for the U2BRG register
	CRS	Invalid because CRD is set to 1
	TXEPT	Transmit register empty flag
	CRD	Set to 1
	NCH	Select TxD2 pin output format
	CKPOL	Clock phases can be set in combination with the CKPH bit in the U2SMR3 register
	UFORM	Select the LSB first or MSB first
U2C1	TE	Set this bit to 1 to enable transmission
	TI	Transmit buffer empty flag
	RE	Set this bit to 1 to enable reception
	RI	Reception complete flag
	U2IRS	Select UART2 transmit interrupt cause
	U2RRM,	Set to 0
	U2LCH, U2ERE	
U2SMR	0 to 7	Set to 0
U2SMR2	0 to 7	Set to 0
U2SMR3	СКРН	Clock phases can be set in combination with the CKPOL bit in the U2C0 register
	NODC	Set to 0
	0, 2, 4 to 7	Set to 0
U2SMR4	0 to 7	Set to 0
NOTE:	•	

NOTE:

^{1.}Not all bits in the registers are described above. Set those bits to 0 when writing to the registers in Special Mode 2.

14.1.4.1 Clock Phase Setting Function

One of four combinations of transfer clock phases and polarities can be selected using the CKPH bit in the U2SMR3 register and the CKPOL bit in the U2C0 register.

Make sure the transfer clock polarity and phase are the same for the master and slave to communicate.

14.1.4.1.1 Master (Internal Clock)

Figure 14.27 shows the transmission and reception timing in master (internal clock).

14.1.4.1.2 Slave (External Clock)

Figure 14.28 shows the transmission and reception timing (CKPH=0) in slave (external clock) while **Figure 14.29** shows the transmission and reception timing (CKPH=1) in slave (external clock).

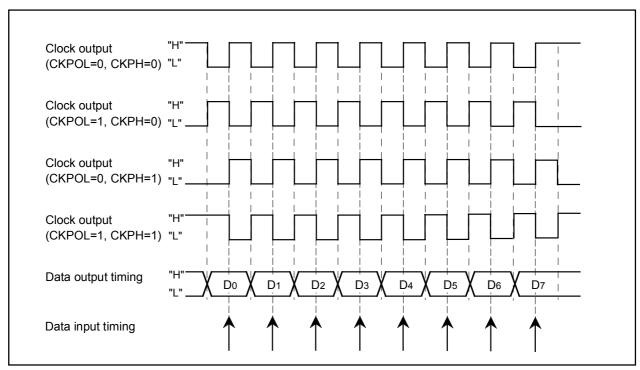


Figure 14.27 Transmission and Reception Timing in Master Mode (Internal Clock)

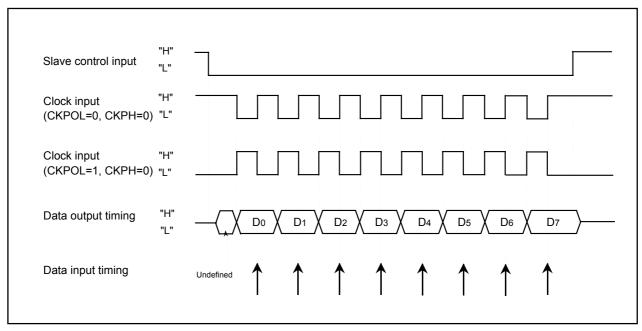


Figure 14.28 Transmission and Reception Timing (CKPH=0) in Slave Mode (External Clock)

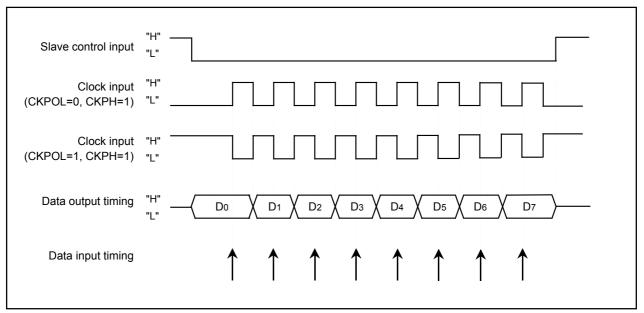


Figure 14.29 Transmission and Reception Timing (CKPH=1) in Slave Mode (External Clock)

14.1.5 Special Mode 3 (IEBus mode)(UART2)

In this mode, one bit in the IEBus is approximated with one byte of UART mode waveform.

Table 14.17 lists the registers used in IEBus mode and the register values set. **Figure 14.30** shows the functions of bus collision detect function related bits.

If the TxD2 pin output level and RxD2 pin input level do not match, a UART2 bus collision detect interrupt request is generated.

Table 14.17 Registers to Be Used and Settings in IEBus Mode

Register	Bit	Function
U2TB	0 to 8	Set transmission data
U2RB ⁽¹⁾	0 to 8	Reception data can be read
	OER,FER,PER,SUM	Error flag
U2BRG	0 to 7	Set bit rate
U2MR	SMD2 to SMD0	Set to 1102
	CKDIR	Select the internal clock or external clock
	STPS	Set to 0
	PRY	Invalid because PRYE is set to 0
	PRYE	Set to 0
	IOPOL	Select the TxD/RxD input/output polarity
U2C0	CLK1, CLK0	Select the count source for the U2BRG register
	CRS	Invalid because CRDis set to 1
	TXEPT	Transmit register empty flag
	CRD	Set to 1
	NCH	Select TxD2 pin output mode
	CKPOL	Set to 0
	UFORM	Set to 0
U2C1	TE	Set this bit to 1 to enable transmission
	TI	Transmit buffer empty flag
	RE	Set this bit to 1 to enable reception
	RI	Reception complete flag
	U2IRS	Select the source of UART2 transmit interrupt
	U2RRM,	Set to 0
	U2LCH, U2ERE	
U2SMR	0 to 3, 7	Set to 0
	ABSCS	Select the sampling timing at which to detect a bus collision
	ACSE	Set this bit to 1 to use the auto clear function of transmit enable bit
	SSS	Select the transmit start condition
U2SMR2	0 to 7	Set to 0
U2SMR3	0 to 7	Set to 0
U2SMR4	0 to 7	Set to 0

NOTE:

1. Not all register bits are described above. Set those bits to 0 when writing to the registers in IEBus mode.

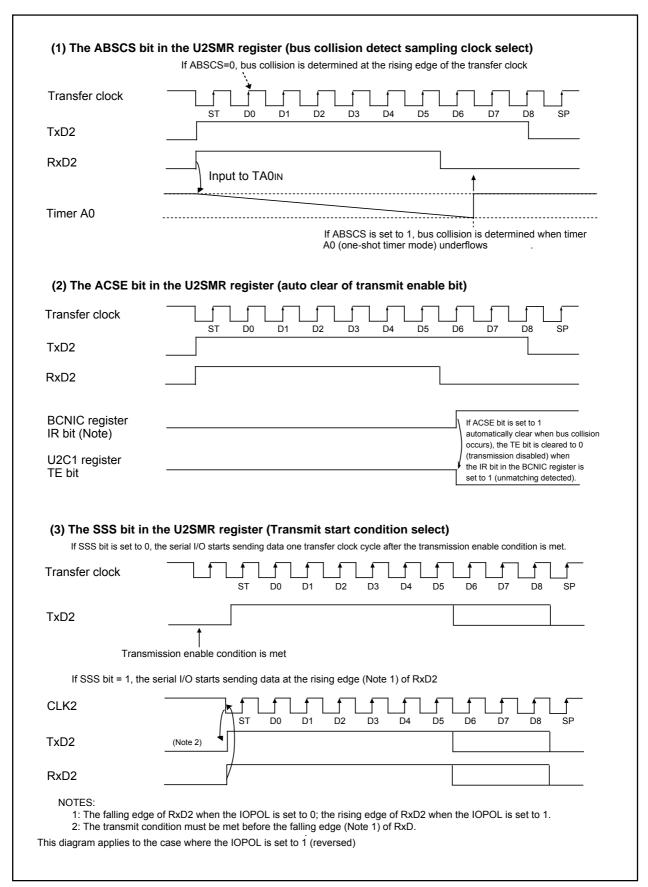


Figure 14.30 Bus Collision Detect Function-Related Bits

14.1.6 Special Mode 4 (SIM Mode) (UART2)

Based on UART mode, this is an SIM interface compatible mode. Direct and inverse formats can be implemented, and this mode allows output of a low from the TxD2 pin when a parity error is detected. **Table 14.18** lists the specifications of SIM mode. **Table 14.19** lists the registers used in the SIM mode and the register values set.

Table 14.18 SIM Mode Specifications

Item	Specification
Transfer data format	Direct format
	Inverse format
Transfer clock	• The CKDIR bit in the U2MR register is set to 0 (internal clock) : fi/ (16(n+1))
	fi = f1SIO, f2SIO, f8SIO, f32SIO. n: Setting value of U2BRG register 0016 to FF16
	The CKDIR bit is set to 1 (external clock): fext/16(n+1)
	fEXT: Input from CLK2 pin. n: Setting value of U2BRG register 0016 to FF16
Transmission start condition	Before transmission can start, the following requirements must be met
	 The TE bit in the U2C1 register is set to 1 (transmission enabled)
	 The TI bit in the U2C1 register is set to 0 (data present in U2TB register)
Reception start condition	Before reception can start, the following requirements must be met
	 The RE bit in the U2C1 register is set to 1 (reception enabled)
	- Start bit detection
Interrupt request	For transmission
generation timing (2)	When the serial I/O finished sending data from the U2TB transfer register (U2IRS bit =1)
	For reception
	When transferring data from the UART2 receive register to the U2RB register (at
	completion of reception)
Error detection	Overrun error (1)
	This error occurs if the serial I/O started receiving the next data before reading the
	U2RB register and received the bit one before the last stop bit in the the next data
	Framing error
	This error occurs when the number of stop bits set is not detected
	Parity error
	During reception, if a parity error is detected, parity error signal is output from the
	TxD2 pin.
	During transmission, a parity error is detected by the level of input to the RxD2 pin
	when a transmission interrupt occurs
	Error sum flag
	This flag is set to 1 when any of the overrun, framing, and parity errors is encountered

NOTES:

- 1. If an overrun error occurs, bits 8 to 0 in the U2RB register are undefined. The IR bit in the S2RIC register remains unchanged.
- 2. A transmit interrupt request is generated by setting the U2IRS bit in the U2C1 register to 1 (transmission complete) and U2ERE bit to 1 (error signal output) after reset. Therefore, when using SIM mode, be sure to clear the IR bit to 0 (no interrupt request) after setting these bits.

Table 14.19 Registers to Be Used and Settings in SIM Mode

Register	Bit	Function
U2TB ⁽¹⁾	0 to 7	Set transmission data
U2RB ⁽¹⁾	0 to 7	Reception data can be read
	OER,FER,PER,SUM	• • • • • • • • • • • • • • • • • • •
U2BRG	0 to 7	Set bit rate
U2MR	SMD2 to SMD0	Set to 1012
	CKDIR	Select the internal clock or external clock
	STPS	Set to 0
	PRY	Set this bit to 1 for direct format or 0 for inverse format
	PRYE	Set to 1
	IOPOL	Set to 0
U2C0	CLK1, CLK0	Select the count source for the U2BRG register
	CRS	Invalid because CRDis set to 1
	TXEPT	Transmit register empty flag
	CRD	Set to 1
	NCH	Set to 0
	CKPOL	Set to 0
	UFORM	Set this bit to 0 for direct format or 1 for inverse format
U2C1	TE	Set this bit to 1 to enable transmission
	TI	Transmit buffer empty flag
	RE	Set this bit to 1 to enable reception
	RI	Reception complete flag
	U2IRS	Set to 1
	U2RRM	Set to 0
	U2LCH	Set this bit to 0 for direct format or 1 for inverse format
	U2ERE	Set to 1
U2SMR ⁽¹⁾	0 to 3	Set to 0
U2SMR2	0 to 7	Set to 0
U2SMR3	0 to 7	Set to 0
U2SMR4	0 to 7	Set to 0

NOTE:

1. Not all register bits are described above. Set those bits to 0 when writing to the registers in SIM mode.

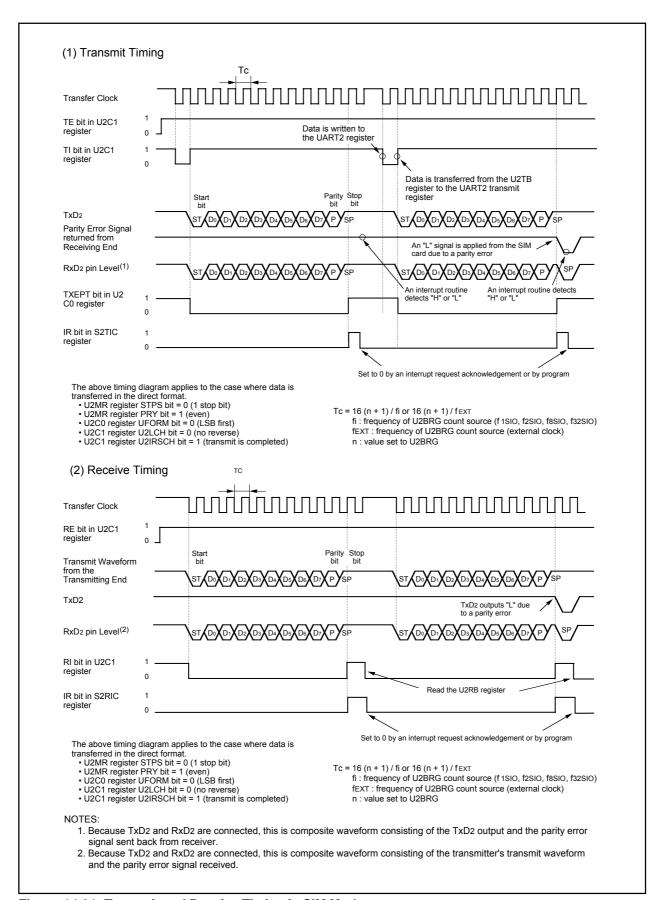


Figure 14.31 Transmit and Receive Timing in SIM Mode

Figure 14.32 shows the example of connecting the SIM interface. Connect TxD2 and RxD2 and apply pull-up.

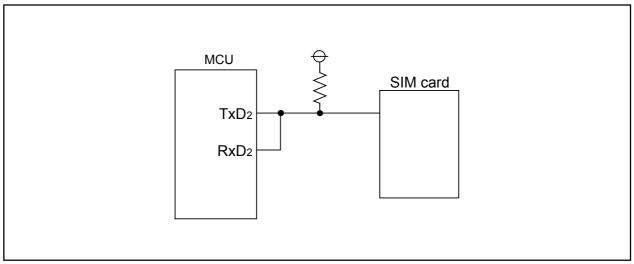


Figure 14.32 SIM Interface Connection

14.1.6.1 Parity Error Signal Output

The parity error signal is enabled by setting the U2ERE bit in the U2C1 register to 1.

· When receiving

The parity error signal is output when a parity error is detected while receiving data. This is achieved by pulling the TxD2 output low with the timing shown in **Figure 14.33**. If the R2RB register is read while outputting a parity error signal, the PER bit is cleared to 0 and at the same time the TxD2 output is returned high.

· When transmitting

A transmission-finished interrupt request is generated at the falling edge of the transfer clock pulse that immediately follows the stop bit. Therefore, whether a parity signal has been returned can be determined by reading the port that shares the RxD2 pin in a transmission-finished interrupt service routine.

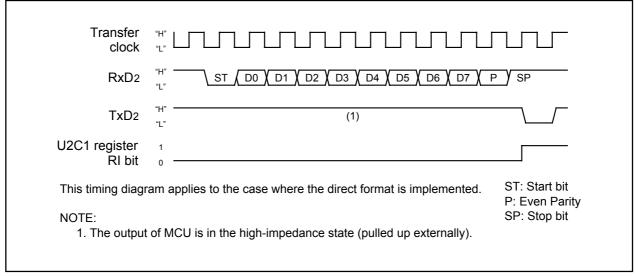


Figure 14.33 Parity Error Signal Output Timing

14.1.6.2 Format

Direct Format

Set the PRY bit in the U2MR register to 1, the UFORM bit in U2C0 register to 0 and the U2LCH bit in U2C1 register to 0.

Inverse Format

Set the PRY bit to 0, UFORM bit to 1 and U2LCH bit to 1.

Figure 14.34 shows the SIM interface format.

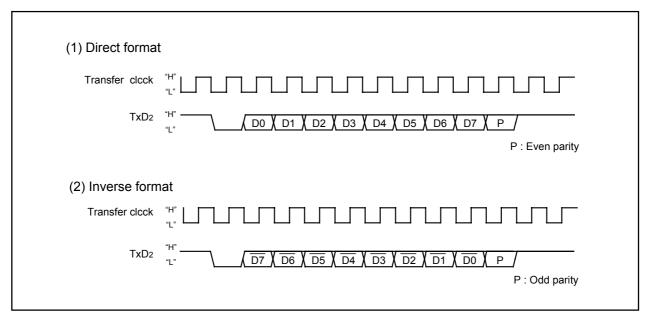


Figure 14.34 SIM Interface Format

14.2 SI/O3 and SI/O4

Note

The SI/O4 interrupt of peripheral function interrupt is not available in the 64-pin package.

SI/O3 and SI/O4 are exclusive clock-synchronous serial I/Os.

Figure 14.35 shows the block diagram of SI/O3 and SI/O4, and **Figure 14.36** shows the SI/O3 and SI/O4-related registers.

Table 14.20 shows the specifications of SI/O3 and SI/O4.

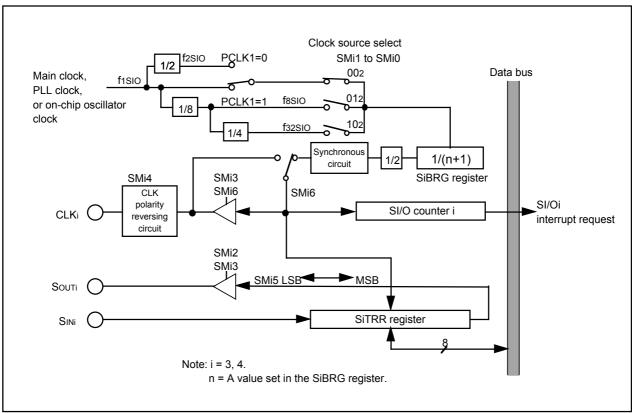


Figure 14.35 SI/O3 and SI/O4 Block Diagram

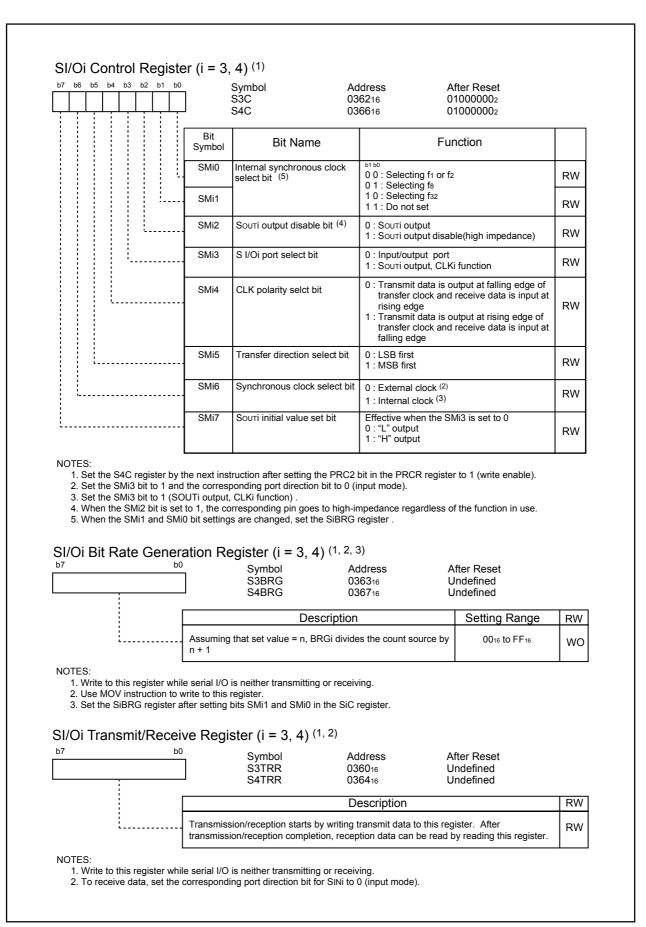


Figure 14.36 S3C and S4C Registers, S3BRG and S4BRG Registers, and S3TRR and S4TRR Registers

Table 14.20 SI/O3 and SI/O4 Specifications

Item	Specification		
Transfer data format	Transfer data length: 8 bits		
Transfer clock	• The SMi6 bit in the SiC (i=3, 4) register is set to 1 (internal clock) : fj/ (2(n+1))		
	fj = f1sio, f2sio, f8sio, f32sio. n=Setting value of SiBRG register 0016 to FF16.		
	SMi6 bit is set to 0 (external clock) : Input from CLKi pin (1)		
Transmission/reception	Before transmission/reception can start, the following requirements must be met		
start condition	Write transmit data to the SiTRR register (2, 3)		
Interrupt request	When the SMi4 bit in the SiC register is set to 0		
generation timing	The rising edge of the last transfer clock pulse ⁽⁴⁾		
	When SMi4 is set to 1		
	The falling edge of the last transfer clock pulse (4)		
CLKi pin fucntion	I/O port, transfer clock input, transfer clock output		
Souti pin function	I/O port, transmit data output, high-impedance		
SINi pin function	I/O port, receive data input		
Select function	LSB first or MSB first selection		
	Whether to start sending/receiving data beginning with bit 0 or beginning with bit 7		
	can be selected		
	• Function for setting an So∪⊤i initial value set function		
	When the SMi6 bit in the SiC register is set to 0 (external clock), the Souti pin		
	output level while not tranmitting can be selected.		
	CLK polarity selection		
	Whether transmit data is output/input timing at the rising edge or falling edge of		
	transfer clock can be selected.		

NOTE:

- 1. To set the SMi6 bit in the SiC register to 0 (external clock), follow the procedure described below.
 - If the SMi4 bit in the SiC register is set to 0, write transmit data to the SiTRR register while input on the CLKi pin is high. The same applies when rewriting the SMi7 bit in the SiC register.
 - If the SMi4 bit is set to 1, write transmit data to the SiTRR register while input on the CLKi pin is low. The same applies when rewriting the SMi7 bit.
 - Because shift operation continues as long as the transfer clock is supplied to the SI/Oi circuit, stop the transfer clock 2. Unlike UART0 to UART2, SI/Oi (i = 3 to 4) is not separated between the transfer register and buffer. Therefore, do not write the next transmit data to the SiTRR register during transmission.
- 3. When the SMi6 bit in the SiC register is set to 1 (internal clock), SOUTI retains the last data for a 1/2 transfer clock period after completion of transfer and, thereafter, goes to a high-impedance state. However, if transmit data is written to the SiTRR register during this period, SOUTI immediately goes to a high-impedance state, with the data hold time thereby reduced.
- 4. When the SMi6 bit in the SiC register is set to 1 (internal clock), the transfer clock stops in the high state if the SMi4 bit is set to 0, or stops in the low state if the SMi4 bit is set to 1.



14.2.1 SI/Oi Operation Timing

Figure 14.37 shows the SI/Oi operation timing

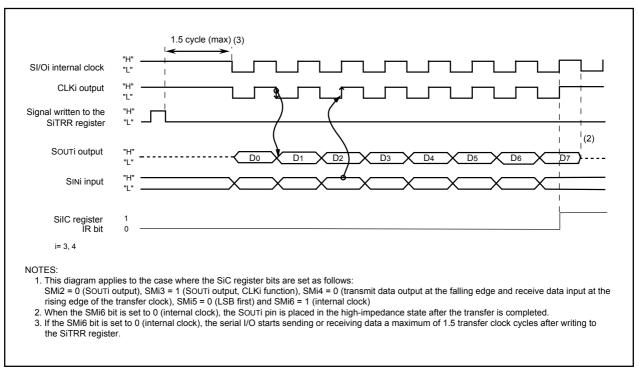


Figure 14.37 SI/Oi Operation Timing

14.2.2 CLK Polarity Selection

The the SMi4 bit in the SiC register allows selection of the polarity of the transfer clock. **Figure 14.38** shows the polarity of the transfer clock.

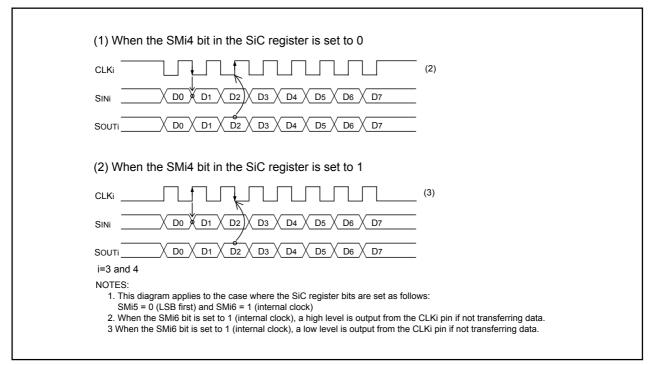


Figure 14.38 Polarity of Transfer Clock

14.2.3 Functions for Setting an Souti Initial Value

If the SMi6 bit in SiC register is set to 0 (external clock), the SouTi pin output level can be fixed high or low when not transferring data. However, when transmitting data consecutively, the last bit (bit 0) value of the last transmitted data is retained between the sccessive data transmissions. **Figure 14.39** shows the timing chart for setting an SouTi initial value and how to set it.

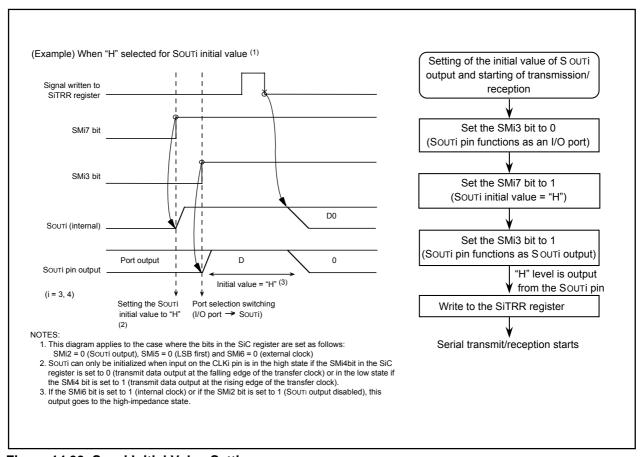


Figure 14.39 Souti Initial Value Setting

15. A/D Converter

Note

Ports P04 to P07(AN04 to AN07), P10 to P13(AN20 to AN23) and P95 to P97(AN25 to AN27) are not available in 64-pin package. Do not use port P04 to P07(AN04 to AN07), P10 to P13(AN20 to AN23) and P95 to P97(AN25 to AN27) as analog input pins in 64-pin package.

The MCU contains one A/D converter circuit based on 10-bit successive approximation method configured with a capacitive-coupling amplifier. The analog inputs share the pins with P100 to P107 (AN0 to AN7), P00 to P07 (AN00 to AN07), and P10 to P13, P93, P95 to P97 (AN20 to AN27), and P90 to P92 (AN30 to AN32). Similarly, ADTRG input shares the pin with P15. Therefore, when using these inputs, make sure the corresponding port direction bits are set to 0 (input mode).

When not using the A/D converter, set the VCUT bit to 0 (Vref unconnected), so that no current will flow from the Vref pin into the resistor ladder, helping to reduce the power consumption of the chip.

The A/D conversion result is stored in the ADi register bits for ANi, AN0i, AN2i (i = 0 to 7), and AN3i pins (i = 0 to 2). **Table 15.1** shows the A/D converter performance. **Figure 15.1** shows the A/D converter block diagram and **Figures 15.2** to **15.4** show the A/D converter associated with registers.

Table 15.1 A/D Converter Performance

Item	Performance		
A/D Conversion Method	Successive approximation (capacitive coupling amplifier)		
Analog Input Voltage (1)	0V to AVcc (Vcc)		
Operating Clock ϕ AD (2)	fAD/divided-by-2 or fAD/divided-by-3 or fAD/divided-by-4 or fAD/divided-by-6		
	or fAD/divided-by-12 or fAD		
Resolution	8-bit or 10-bit (selectable)		
Integral Nonlinearity Error	When AVcc = Vref = 5V		
	With 8-bit resolution: ±2LSB		
	With 10-bit resolution: ±3LSB		
	When AVcc = Vref = 3.3V		
	With 8-bit resolution: ±2LSB		
	With 10-bit resolution: ±5LSB		
Operating Modes	One-shot mode, repeat mode, single sweep mode, repeat sweep mode 0, repeat		
	sweep mode 1, simultaneous sample sweep mode and delayed trigger mode 0,1		
Analog Input Pins	8 pins (AN0 to AN7) + 8 pins (AN00 to AN07) + 8 pins (AN20 to AN27) + 3 pins (AN30		
	to AN32) (80-pin package)		
	8 pins (AN0 to AN7) + 4 pins (AN00 to AN03) + 1 pin (AN24) + 3 pins (AN30 to AN32)		
	(64-pin package)		
Conversion Speed Per Pin	Without sample and hold function		
	8-bit resolution: 49 \$\phiAD cycles, 10-bit resolution: 59 \$\phiAD cycles		
	With sample and hold function		
	8-bit resolution: 28 φAD cycles, 10-bit resolution: 33 φAD cycles		

NOTES:

- 1. Not dependent on use of sample and hold function.
- 2. Set the ϕAD frequency to 10 MHz or less.

Without sample-and-hold function, set the ϕAD frequency to 250kHz or more.

With the sample and hold function, set the ϕAD frequency to 1MHz or more.



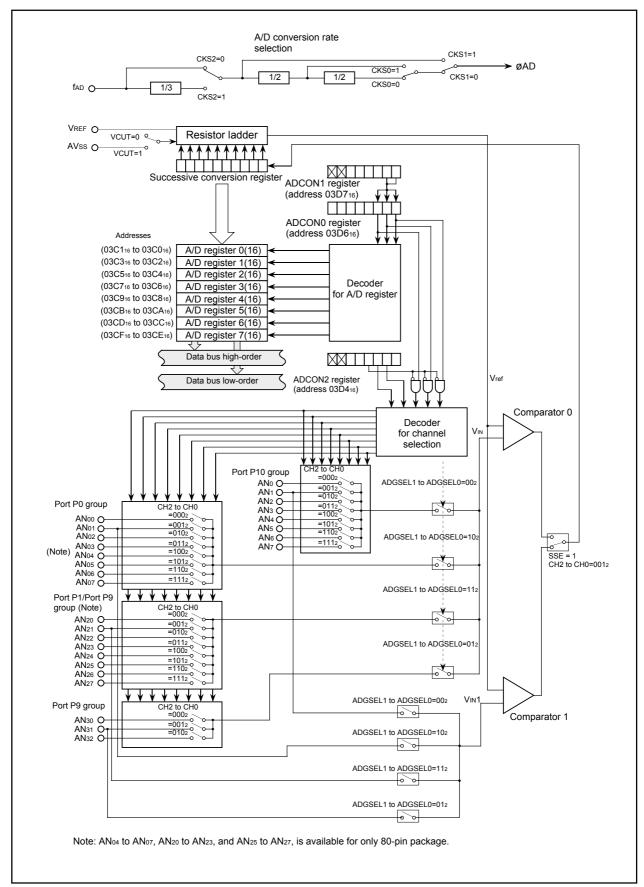
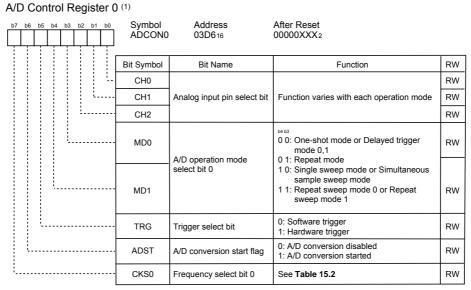


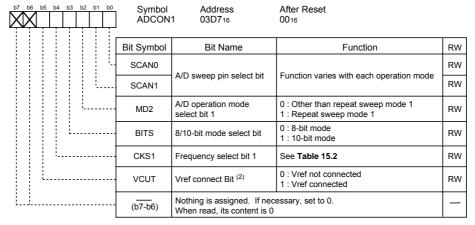
Figure 15.1 A/D Converter Block Diagram



NOTE:

1. If the ADCON0 register is rewritten during A/D conversion, the conversion result will be undefined.

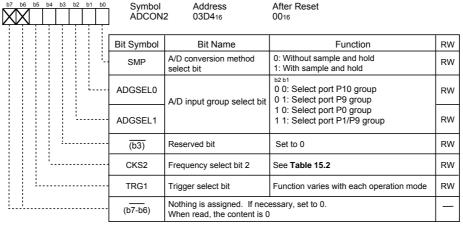
A/D Control Register 1 (1)



NOTES:

- 1. If the ADCON1 register is rewritten during A/D conversion, the conversion result will be undefined.
- If the VCUT bit is reset from 0 (VREF unconnected) to 1 (VREF connected), wait for 1 μs or more before starting A/D conversion.

A/D Control Register 2⁽¹⁾



NOTS

1. If the ADCON2 register is rewritten during A/D conversion, the conversion result will be undefined.

Figure 15.2 ADCON0 to ADCON2 Registers

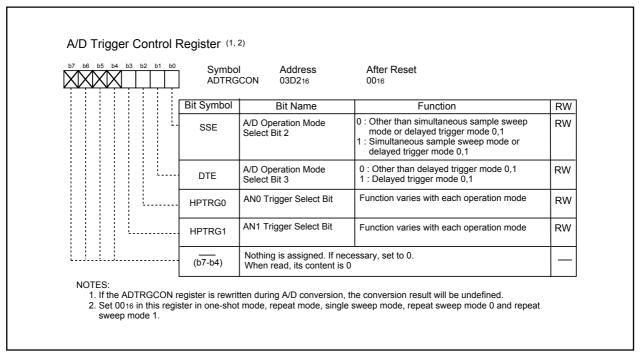


Figure 15.3 ADTRGCON Register

Table 15.2 A/D Conversion Frequency Select

CKS2	CKS1	CKS0	ØAD	
0	0	0	fAD divided by 4	
0	0	1	fAD divided by 2	
0	1	0	fAD	
0	1	1		
1	0	0	fAD divided by 12	
1	0	1	fAD divided by 6	
1	1	0	fAD divided by 3	
1	1	1	TAD divided by 3	

NOTE:

^{1.} ØAD frequency must be under 10 MHz. Combination of the CKS0 bit in the ADCON0 register, the CKS1 bit in the ADCON1 register, and the CKS2 bit in the ADCON2 register selects ØAD.

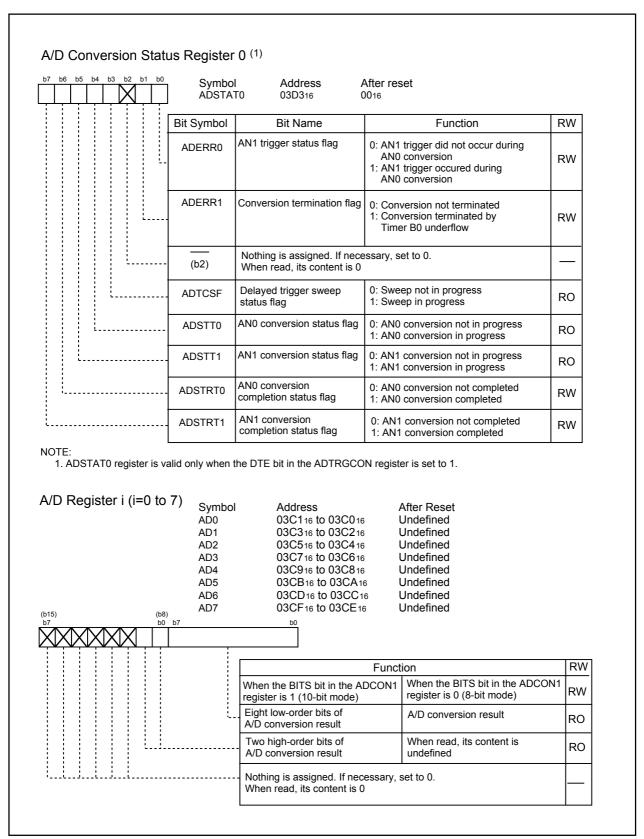
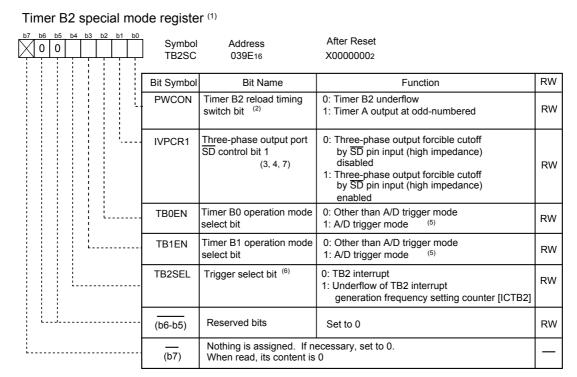


Figure 15.4 ADSTAT0 Register and AD0 to AD7 Registers



NOTES:

- 1. Write to this register after setting the PRC1 bit in the PRCR register to 1 (write enabled).
- 2. If the INV11 bit is 0 (three-phase mode 0) or the INV06 bit is 1 (triangular wave modulation mode), set this bit to 0 (timer B2 underflow).
- 3. When setting the IVPCR1 bit to 1 (three-phase output forcible cutoff by \overline{SD} pin input enabled), Set the PD85 bit to 0 (= input mode).
- 4. Related pins are U(P8₀), Ū(P8₁), V(P7₂), ∇(P7₃), W(P7₄), ∇(P7₅). When a high-level ("H") signal is applied to the \$\overline{\SD}\$ pin and set the IVPCR1 bit to 0 after forcible cutoff, pins U, Ū, V, ∇, W, and \$\overline{\SD}\$ are exit from the high-impedance state. If a low-level ("L") signal is applied to the \$\overline{\SD}\$ pin, three-phase motor control timer output will be disabled (INV03=0). At this time, when the IVPCR1 bit is 0, pins U, Ū, V, ∇, W, and \$\overline{\SD}\$ become programmable I/O ports. When the IVPCR1 bit is set to 1, pins U, Ū, V, ∇, W, and \$\overline{\SD}\$ are placed in a high-impedance state regardless of which function of those pins is used.
- 5. When this bit is used in delayed trigger mode 0, set bits TB0EN and TB1EN to 1 (A/D trigger mode).
- 6. When setting the TB2SEL bit to 1 (underflow of TB2 interrupt generation frequency setting counter[ICTB2]), set the INV02 bit to 1 (three-phase motor control timer function).

Figure 15.5 TB2SC Register

15.1 Operating Modes

15.1.1 One-Shot Mode

In one-shot mode, analog voltage applied to a selected pin is once converted to a digital code. **Table 15.3** shows the one-shot mode specifications. **Figure 15.6** shows the operation example in one-shot mode. **Figure 15.7** shows registers ADCON0 to ADCON2 in one-shot mode.

Table 15.3 One-shot Mode Specifications

Item	Specification		
Function	Bits CH2 to CH0 in the ADCON0 register and registers ADGSEL1 and		
	ADGSEL0 in the ADCON2 register select pins. Analog voltage applied to a		
	selected pin is once converted to a digital code		
A/D Conversion Start	When the TRG bit in the ADCON0 register is 0 (software trigger)		
Condition	Set the ADST bit in the ADCON0 register to 1 (A/D conversion started)		
	When the TRG bit in the ADCON0 register is 1 (hardware trigger)		
	The ADTRG pin input changes state from "H" to "L" after setting the		
	ADST bit to 1 (A/D conversion started)		
A/D Conversion Stop	• A/D conversion completed (If a software trigger is selected, the ADST bit is		
Condition	set to 0 (A/D conversion halted)).		
	Set the ADST bit to 0		
Interrupt Request Generation Timing	A/D conversion completed		
Analog Input Pin	Select one pin from ANo to AN7, AN00 to AN07, AN20 to AN27, AN30 to AN32		
Readout of A/D Conversion Result	Readout one of registers AD0 to AD7 that corresponds to the selected pin		

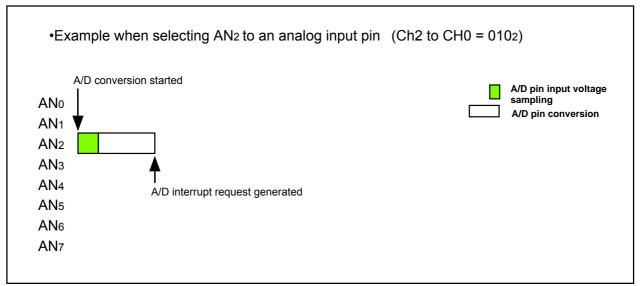


Figure 15.6 Operation Example in One-Shot Mode

15. A/D Converter M16C/29 Group

A/D Control Register 0 (1) Symbol ADCON0 After Reset Address 0 0 03D6₁₆ 00000XXX2 Bit Symbol Bit Name Function RW Analog input pin select bit (2, 3) 0 0 0: Select ANo CH0 RW 0 0 1: Select AN1 0 1 0: Select AN2 0 1 1: Select AN3 RW CH1 1 0 0: Select AN4 1 0 1: Select AN5 1 1 0: Select AN6 CH2 RW 1 1 1: Select AN7 A/D operation mode select bit 0 (3) MD0 RW 0 0: One-shot mode or delayed trigger mode 0,1 MD1 RW 0: Software trigger Trigger select bit TRG RW 1: Hardware trigger (ADTRG trigger) ADST A/D conversion start flag 0: A/D conversion disabled RW 1: A/D conversion started See Table 15.2 CKS0 Frequency select bit 0 RW NOTES

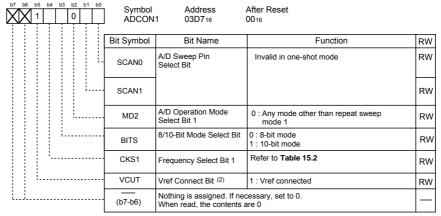
- JIES:

 1. If the ADCON0 register is rewritten during A/D conversion, the conversion result will be undefined.

 2. AN00 to AN07, AN20 to AN27, and AN30 to AN32 can be used in the same way as AN 0 to AN7. Use bits ADGSEL1 and ADGSEL 0 in the ADCON2 register to select the desired pin.

 3. After rewriting bits MD1 and MD0, set bits CH2 to CH0 over again using an another instruction.

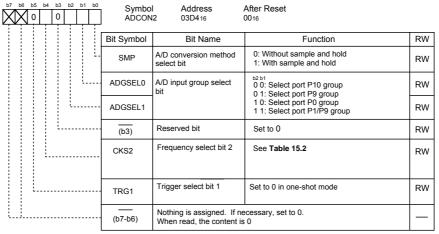
A/D Control Register 1 (1)



NOTES:

- 1. If the ADCON1 register is rewritten during A/D conversion, the conversion result will be undefined.
 2. If the VCUT bit is reset from 0 (Vref unconnected) to 1 (Vref connected), wait for 1 μ s or more before starting

A/D Control Register 2 (1)



NOTE:

1. If the ADCON2 register is rewritten during A/D conversion, the conversion result will be undefined.

Figure 15.7 ADCON0 to ADCON2 Registers in One-Shot Mode

15.1.2 Repeat mode

In repeat mode, analog voltage applied to a selected pin is repeatedly converted to a digital code. **Table 15.4** shows the repeat mode specifications. **Figure 15.8** shows the operation example in repeat mode. **Figure 15.9** shows the ADCON0 to ADCON2 registers in repeat mode.

Table 15.4 Repeat Mode Specifications

Item	Specification
Function	Bits CH2 to CH0 in the ADCON0 register and the ADGSEL1 to ADGSEL0 bits
	in the ADCON2 register select pins. Analog voltage applied to a selected pin
	is repeatedly converted to a digital code
A/D Conversion Start	When the TRG bit in the ADCON0 register is 0 (software trigger)
Condition	Set the ADST bit in the ADCON0 register to 1 (A/D conversion started)
	When the TRG bit in the ADCON0 register is 1 (hardware trigger)
	The ADTRG pin input changes state from "H" to "L" after setting the ADST bit
	to 1 (A/D conversion started)
A/D Conversion Stop Condition	Set the ADST bit to 0 (A/D conversion halted)
Interrupt Request Generation Timing	None generated
Analog Input Pin	Select one pin from ANo to AN7, AN0o to AN07, AN2o to AN27, and AN3o to AN32
Readout of A/D Conversion Result	Readout one of the AD0 to AD7 registers that corresponds to the selected pin

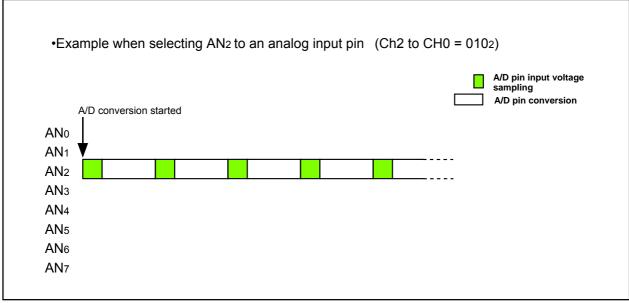


Figure 15.8 Operation Example in Repeat Mode

15. A/D Converter M16C/29 Group

A/D Control Register 0 (1) Symbol ADCON0 Address After Reset 00000XXX2 03D6₁₆ 0 1 Bit Symbol Bit Name Function RW CH0 RW 0.0.0: Select ANo 0 0 1: Select AN1 0 1 0: Select AN2 Analog input pin select bit^(2, 3) 0 1 1: Select AN3 1 0 0: Select AN4 CH1 RW 1 0 1: Select AN5 1 1 0: Select AN6 CH2 RW 1.1.1: Select AN7 RW MD0 A/D operation mode 0 1: Repeat mode select bit 0 (3) RW MD1 0: Software trigger TRG RW Trigger select bit 1: Hardware trigger (ADTRG trigger) 0: A/D conversion disabled ADST A/D conversion start flag RW 1: A/D conversion started CKS0 Frequency select bit 0 See Table 15.2 RW

NOTES:

- 1. If the ADCON0 register is rewritten during A/D conversion, the conversion result will be undefined.
 2. AN00 to AN07, AN20 to AN27, and AN30 to AN32 can be used in the same way as AN0 to AN7. Use bits ADGSEL1
- and ADGSEL 0 in the ADCON2 register to select the desired pin.

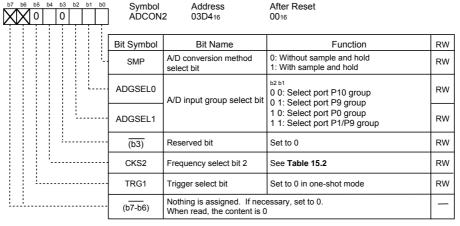
 3. After rewriting bits MD1 and MD0, set bits CH2 to CH0 over again using an another instruction.

A/D Control Register 1 (1)

b7 b6 b5 b4 b3 b2 b1 b0	Symbol ADCON	Address 1 03D7 ₁₆	After Reset 00 ₁₆	
	Bit Symbol	Bit Name	Function	RW
	SCAN0	A/D success size a stant bit	lavalid in same at manda	RW
	SCAN1	A/D sweep pin select bit Invalid in repeat mode	invalid in repeat mode	RW
	MD2	A/D operation mode select bit 1	0: Other than repeat sweep mode 1	RW
	BITS	8/10-bit mode select bit	0: 8-bit mode 1: 10-bit mode	RW
	CKS1	Frequency select bit 1	See Table 15.2	RW
ļ	VCUT	Vref connect bit (2)	1: Vref connected	RW
	(b7-b6)	Nothing is assigned. If nec When read, the content is 0		

- If the ADCON1 register is rewritten during A/D conversion, the conversion result will be undefined.
- 2. If the VCUT bit is reset from 0 (Vref unconnected) to 1 (Vref connected), wait for 1 μs or more before starting A/D conversion

A/D Control Register 2(1)



NOTE:

1. If the ADCON2 register is rewritten during A/D conversion, the conversion result will be undefined.

Figure 15.9 ADCON0 to ADCON2 Registers in Repeat Mode

15.1.3 Single Sweep Mode

In single sweep mode, analog voltages applied to the selected pins are converted one-by-one to a digital code. **Table 15.5** shows the single sweep mode specifications. **Figure 15.10** shows the operation example in single sweep mode. **Figure 15.11** shows the ADCON0 to ADCON2 registers in single sweep mode.

Table 15.5 Single Sweep Mode Specifications

Item	Specification		
Function	Bits SCAN1 to SCAN0 in the ADCON1 register and bits ADGSEL1 and		
	ADGSEL0 in the ADCON2 register select pins. Analog voltage applied to the		
	selected pins is converted one-by-one to a digital code		
A/D Conversion Start Condition	When the TRG bit in the ADCON0 register is 0 (software trigger)		
	Set the ADST bit in the ADCON0 register to 1 (A/D conversion started)		
	When the TRG bit in the ADCON0 register is 1 (hardware trigger)		
	The ADTRG pin input changes state from "H" to "L" after setting the ADST bit		
	to 1 (A/D conversion started)		
A/D Conversion Stop Condition	A/D conversion completed(When selecting a software trigger, the ADST bit		
	is set to 0 (A/D conversion halted)).		
	Set the ADST bit to 0		
Interrupt Request Generation Timing	A/D conversion completed		
Analog Input Pin	Select from ANo to AN1 (2 pins), ANo to AN3 (4 pins), ANo to AN5 (6 pins),		
	AN ₀ to AN ₇ (8 pins) (1)		
Readout of A/D Conversion Result	Readout one of registers AD0 to AD7 that corresponds to the selected pin		

NOTE:

1. AN00 to AN07, AN 20 to AN27, and AN30 to AN32 can be used in the same way as AN0 to AN7. However, all input pins need to belong to the same group.

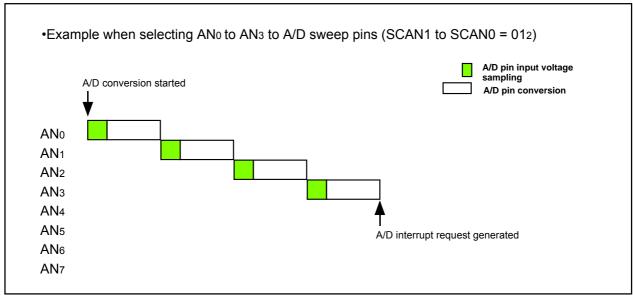


Figure 15.10 Operation Example in Single Sweep Mode

15. A/D Converter M16C/29 Group

A/D Control Register 0 (1) Symbol Address After Reset ADCON0 03D6₁₆ 00000XXX2 1 0 RW Bit Symbol Bit Name Function CH0 RW CH1 RW Analog input pin select bit Invalid in single sweep mode CH2 RW MD0 RW A/D operation mode 1 0: Single sweep mode or Simultaneous select bit 0 sample sweep mode MD1 RW 0: Software trigger 1: Hardware trigger (ADTRG trigger) RW Trigger select bit 0: A/D conversion disabled1: A/D conversion started ADST A/D conversion start flag RW CKS0 Frequency select bit 0 See Table 15.2 RW NOTE 1. If the ADCON0 register is rewritten during A/D conversion, the conversion result will be undefined.

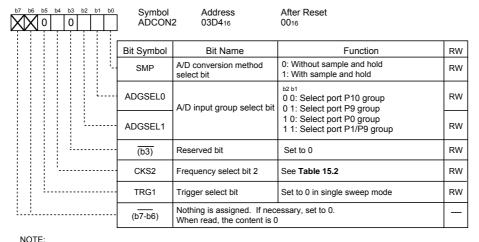
A/D Control Register 1 (1)

b7 b6 b5	b4 b3 b2 b1 b0	Symbol ADCON	Address 1 03D7 ₁₆	After Reset 0016	
		Bit Symbol	Bit Name	Function	RW
		SCAN0	A/D	When single sweep mode is selected, b1 b0 0 0: AN0 to AN1 (2 pins)	RW
	L	SCAN1	A/D sweep pin select bit (2)	0 1: ANo to AN3 (4 pins) 1 0: AN0 to AN5 (6 pins) 1 1: AN0 to AN7 (8 pins)	RW
		MD2	A/D operation mode select bit 1	0: Other than repeat sweep mode 1	RW
		BITS	8/10-bit mode select bit	0: 8-bit mode 1: 10-bit mode	RW
	<u> </u>	CKS1	Frequency select bit 1	See Table 15.2	RW
		VCUT	Vref connect Bit (3)	1: Vref connected	RW
1		(b7-b6)	Nothing is assigned. If nece When read, the content is 0		_

NOTES:

- 1. If the ADCON1 register is rewritten during A/D conversion, the conversion result will be undefined.
 2. AN00 to AN07, AN20 to AN27, and AN30 to AN32 can be used in the same way as AN0 to AN7. Use bits ADGSEL1 and ADGSEL 0 in the ADCON2 register to select the desired pin.
- 3. If the VCUT bit is reset from 0 (Vref unconnected) to 1 (Vref connected), wait for 1 μ s or more before starting A/D conversion

A/D Control Register 2(1)



1. If the ADCON2 register is rewritten during A/D conversion, the conversion result will be undefined.

Figure 15.11 ADCON0 to ADCON2 Registers in Single Sweep Mode

15.1.4 Repeat Sweep Mode 0

In repeat sweep mode 0, analog voltages applied to the selected pins are repeatedly converted to a digital code. **Table 15.6** shows the repeat sweep mode 0 specifications. **Figure 15.12** shows the operation example in repeat sweep mode 0. **Figure 15.13** shows the ADCON0 to ADCON2 registers in repeat sweep mode 0.

Table 15.6 Repeat Sweep Mode 0 Specifications

Item	Specification	
Function	Bits SCAN1 and SCAN0 in the ADCON1 register and bits ADGSEL1 and	
	ADGSEL0 in the ADCON2 register select pins. Analog voltage applied to the	
	selected pins is repeatedly converted to a digital code	
A/D Conversion Start Condition	When the TRG bit in the ADCON0 register is 0 (software trigger)	
	Set the ADST bit in the ADCON0 register to 1 (A/D conversion started)	
	When the TRG bit in the ADCON0 register is 1 (Hardware trigger)	
	The ADTRG pin input changes state from "H" to "L" after setting the ADST bit	
	to 1 (A/D conversion started)	
A/D Conversion Stop Condition	Set the ADST bit to 0 (A/D conversion halted)	
Interrupt Request Generation Timing	None generated	
Analog Input Pin	Select from ANo to AN1 (2 pins), ANo to AN3 (4 pins), ANo to AN5 (6 pins),	
	ANo to AN7 (8 pins) ⁽¹⁾	
Readout of A/D Conversion Result	Readout one of registers AD0 to AD7 that corresponds to the selected pin	

NOTES:

1. AN00 to AN07, AN 20 to AN27, and AN30 to AN32 can be used in the same way as AN0 to AN7. However, all input pins need to belong to the same group.

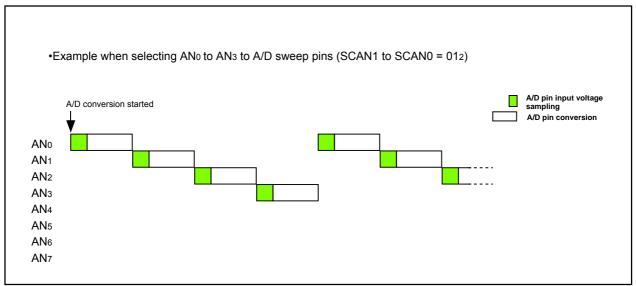


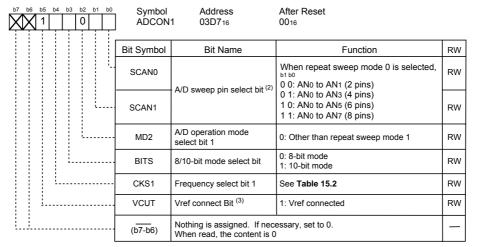
Figure 15.12 Operation Example in Repeat Sweep Mode 0

15. A/D Converter M16C/29 Group

A/D Control Register 0 (1) Symbol Address After Reset ADCON0 03D6₁₆ 00000XXX2 Bit Symbol Bit Name RW Function CHO RW RW CH1 Analog input pin select bit Invalid in repeat sweep mode 0 CH₂ RW MD0 RW A/D operation mode 1 1: Repeat sweep mode 0 or select bit 0 repeat sweep mode 1 MD1 RW 0: Software trigger Trigger select bit TRG RW 1: Hardware trigger (ADTRG trigger) 0: A/D conversion disabled ADST A/D conversion start flag RW 1: A/D conversion started CKS0 Frequency select bit 0 See Table 15.2 RW

NOTE:

A/D Control Register 1 (1)



- If the ADCON1 register is rewritten during A/D conversion, the conversion result will be undefined.
 AN00 to AN07, AN20 to AN27, and AN30 to AN32 can be used in the same way as AN0 to AN7. Use bits ADGSEL1 and ADGSEL 0 in the ADCON2 register to select the desired pin.
- 3. If the VCUT bit is reset from 0 (Vref unconnected) to 1 (Vref connected), wait for 1 μ s or more before starting A/D conversion.

A/D Control Register 2(1)

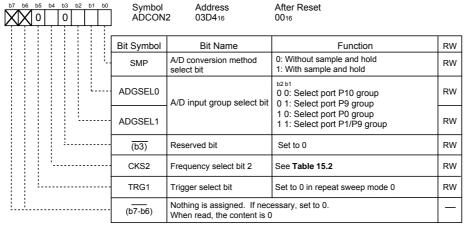


Figure 15.13 ADCON0 to ADCON2 Registers in Repeat Sweep Mode 0

^{1.} If the ADCON0 register is rewritten during A/D conversion, the conversion result will be undefined.

^{1.} If the ADCON2 register is rewritten during A/D conversion, the conversion result will be undefined.

15.1.5 Repeat Sweep Mode 1

In repeat sweep mode 1, analog voltage is applied to the all selected pins are converted to a digital code, with mainly used in the selected pins. **Table 15.7** shows the repeat sweep mode 1 specifications. **Figure 15.14** shows the operation example in repeat sweep mode 1. **Figure 15.15** shows registers ADCON0 to ADCON2 in repeat sweep mode 1.

Table 15.7 Repeat Sweep Mode 1 Specifications

Item	Specification		
Function	Bits SCAN1 and SCAN0 in the ADCON1 register and bits ADGSEL1 and		
	ADGSEL0 in the ADCON2 register mainly select pins. Analog voltage applied		
	to the all selected pins is repeatedly converted to a digital code		
	Example : When selecting ANo		
	Analog voltage is converted to a digital code in the following order		
	$AN0 \rightarrow AN1 \rightarrow AN0 \rightarrow AN2 \rightarrow AN0 \rightarrow AN3$, and so on.		
A/D Conversion Start Condition	When the TRG bit in the ADCON0 register is 0 (software trigger)		
	Set the ADST bit in the ADCON0 register to 1 (A/D conversion started)		
	When the TRG bit in the ADCON0 register is 1 (hardware trigger)		
	The ADTRG pin input changes state from "H" to "L" after setting the ADST bit		
	to 1 (A/D conversion started)		
A/D Conversion Stop Condition	Set the ADST bit to 0 (A/D conversion halted)		
Interrupt Request Generation Timing	None generated		
Analog Input Pins Mainly	Select from ANo (1 pins), ANo to AN1 (2 pins), ANo to AN2 (3 pins), ANo to		
Used in A/D Conversions	AN3 (4 pins) ⁽¹⁾		
Readout of A/D Conversion Result	Readout one of registers AD0 to AD7 that corresponds to the selected pin		

NOTES:

1. AN00 to AN07, AN 20 to AN27, and AN30 to AN32 can be used in the same way as AN0 to AN7. However, all input pins need to belong to the same group.

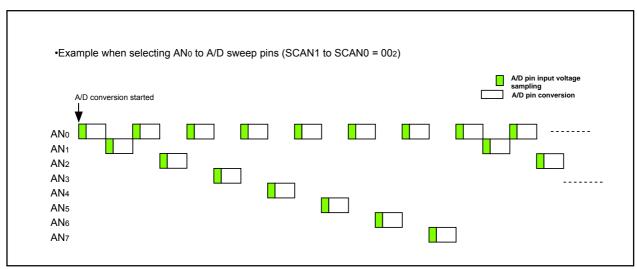


Figure 15.14 Operation Example in Repeat Sweep Mode 1

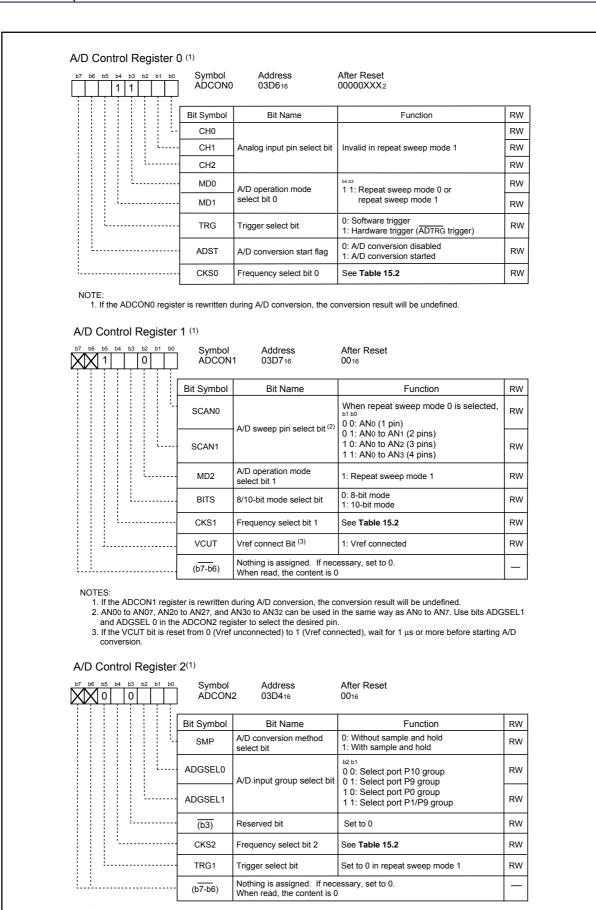


Figure 15.15 ADCON0 to ADCON2 Registers in Repeat Sweep Mode 1

1. If the ADCON2 register is rewritten during A/D conversion, the conversion result will be undefined.

15.1.6 Simultaneous Sample Sweep Mode

In simultaneous sample sweep mode, analog voltages applied to the selected pins are converted one-byone to a digital code. The input voltages of AN0 and AN1 are sampled simultaneously using two circuits
of sample and hold circuit. **Table 15.8** shows the simultaneous sample sweep mode specifications. **Figure 15.16** shows the operation example in simultaneous sample sweep mode. **Figure 15.17** shows
registers ADCON0 to ADCON2 and **Figure 15.18** shows ADTRGCON registers in simultaneous sample
sweep mode. **Table 15.9** shows the trigger select bit setting in simultaneous sample sweep mode. In
simultaneous sample sweep mode, Timer B0 underflow can be selected as a trigger by combining software trigger, ADTRG trigger, Timer B2 underflow, Timer B2 interrupt generation frequency setting counter
underflow or A/D trigger mode of Timer B.

Table 15.8 Simultaneous Sample Sweep Mode Specifications

Item	Specification
Function	Bits SCAN1 and SCAN0 in the ADCON1 register and bits ADGSEL1 and
	ADGSEL0 in the ADCON2 register select pins. Analog voltage applied
	to the selected pins is converted one-by-one to a digital code. At this time,
	the input voltage of ANo and AN1 are sampled simultaneously.
A/D Conversion Start Condition	When the TRG bit in the ADCON0 register is 0 (software trigger)
	Set the ADST bit in the ADCON0 register to 1 (A/D conversion started)
	When the TRG bit in the ADCON0 register is 1 (hardware trigger)
	The trigger is selected by bits TRG1 and HPTRG0 (See Table 15.9)
	The ADTRG pin input changes state from "H" to "L" after setting the ADST
	bit to 1 (A/D conversion started)
	Timer B0, B2 or Timer B2 interrupt generation frequency setting counter
	underflow after setting the ADST bit to 1 (A/D conversion started)
A/D Conversion Stop Condition	A/D conversion completed (If selecting software trigger, the ADST bit is
	automatically set to 0).
	Set the ADST bit to 0 (A/D conversion halted)
Interrupt Generation Timing	A/D conversion completed
Analog Input Pin	Select from ANo to AN1 (2 pins), ANo to AN3 (4 pins), ANo to AN5 (6 pins),
	or AN ₀ to AN ₇ (8 pins) ⁽¹⁾
Readout of A/D conversion result	Readout one of registers AN0 to AN7 that corresponds to the selected pin
NOTE:	

1 ANIOS 45 ANIO

^{1.} AN00 to AN07, AN 20 to AN27, and AN30 to AN32 can be used in the same way as AN0 to AN7. However, all input pins need to belong to the same group.

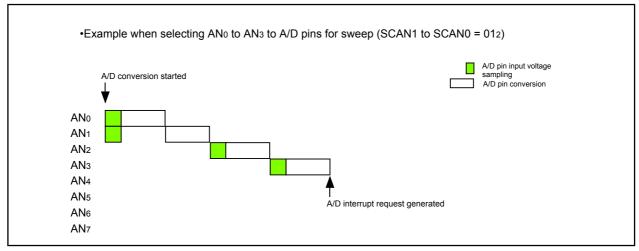


Figure 15.16 Operation Example in Simultaneous Sample Sweep Mode

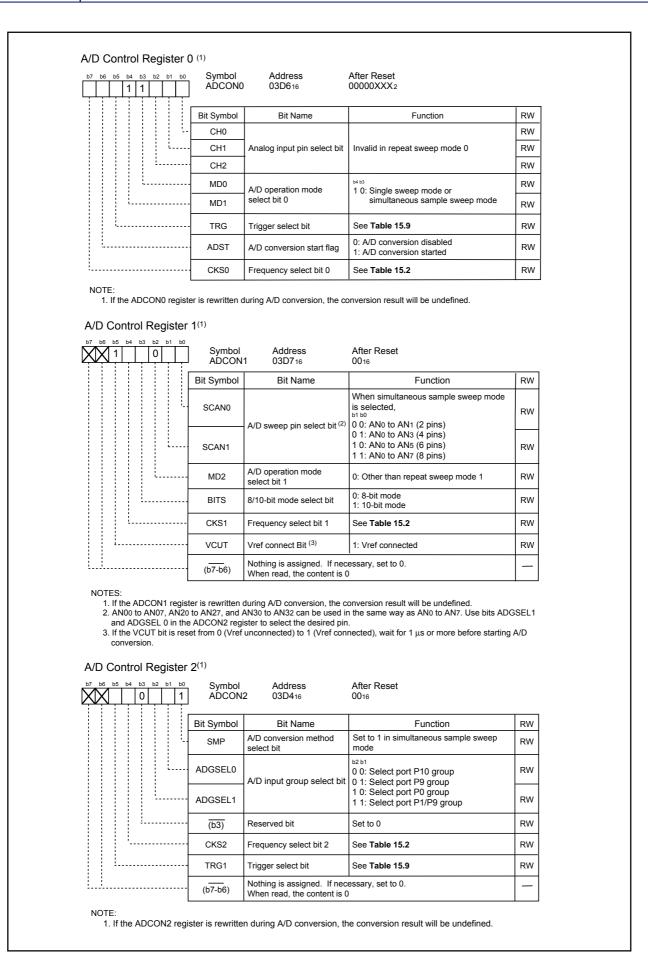


Figure 15.17 ADCON0 to ADCON2 Registers in Simultaneous Sample Sweep Mode

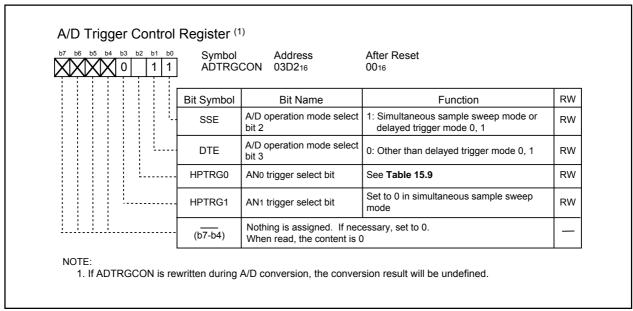


Figure 15.18 ADTRGCON Register in Simultaneous Sample Sweep Mode

Table 15.9 Trigger Select Bit Setting in Simultaneous Sample Sweep Mode

TRG	TRG1	HPTRG0	TRIGGER	
0	-	-	Software trigger	
1	-	1	Timer B0 underflow (1)	
1	0	0	ADTRG	
1	1	0	Timer B2 or Timer B2 interrupt generation frequency setting	
'	•		counter underflow (2)	

NOTES:

- A count can be started for Timer <u>B2</u>, <u>Timer B2</u> interrupt generation frequency setting counter underflow or the INT5 pin falling edge as count start conditions of Timer B0.
- 2. Select Timer B2 or Timer B2 interrupt generation frequency setting counter using the TB2SEL bit in the TB2SC register.

15.1.7 Delayed Trigger Mode 0

In delayed trigger mode 0, analog voltages applied to the selected pins are converted one-by-one to a digital code. The delayed trigger mode 0 used in combination with A/D trigger mode of Timer B. The Timer B0 underflow starts a single sweep conversion. After completing the ANo pin conversion, the AN1 pin is not sampled and converted until the Timer B1 underflow is generated. When the Timer B1 underflow is generated, the single sweep conversion is restarted with the AN1 pin. **Table 15.10** shows the delayed trigger mode 0 specifications. **Figure 15.19** shows the operation example in delayed trigger mode 0. **Figures 15.20** and **15.21** show each flag operation in the ADSTATO register that corresponds to the operation example. **Figure 15.22** shows registers ADCON0 to ADCON2 in delayed trigger mode 0. **Figure 15.23** shows the ADTRGCON register in delayed trigger mode 0 and **Table 15.11** shows the trigger select bit setting in delayed trigger mode 0.

Table 15.10 Delayed Trigger Mode 0 Specifications

Item	Specification
Function	Bits SCAN1 and SCAN0 in the ADCON1 register and bits ADGSEL1 and ADGSEL0
	in the ADCON2 register select pins. Analog voltage applied to the input voltage of
	the selected pins are converted one-by-one to the digital code. At this time, timer B0
	underflow generation starts AN ₀ pin conversion. Timer B1 underflow generation
	starts conversion after the AN1 pin. (1)
A/D Conversion Start	ANo pin conversion start condition
	•When Timer B0 underflow is generated if Timer B0 underflow is generated again
	before Timer B1 underflow is generated , the conversion is not affected
	•When Timer B0 underflow is generated during A/D conversion of pins after the
	AN1 pin, conversion is halted and the sweep is restarted from the AN0 pin again
	AN1 pin conversion start condition
	•When Timer B1 underflow is generated during A/D conversion of the ANo pin, the
	input voltage of the AN1 pin is sampled. The AN1 conversion and the rest of the
	sweep start when ANo conversion is completed.
A/D Conversion Stop	•When single sweep conversion from the ANo pin is completed
Condition	•Set the ADST bit to 0 (A/D conversion halted) ⁽²⁾
Interrupt request	A/D conversion completed
generation timing	
Analog input pin	Select from AN0 to AN1 (2 pins), AN0 to AN3 (4 pins), AN0 to AN5 (6 pins)
	and AN₀ to AN₂ (8 pins) ⁽³⁾
Readout of A/D conversion	Readout one of registers AN0 to AN7 that corresponds to the selected pins
result	

NOTES:

- 1. Set the larger value than the value of the timer B0 register to the timer B1 register. The count source for timer B0 and timer B1 must be the same.
- 2. Do not write 1 (A/D conversion started) to the ADST bit in delayed trigger mode 0. When write 1, unexpected interrupts may be generated.
- 3. AN00 to AN07, AN 20 to AN27, and AN30 to AN32 can be used in the same way as AN0 to AN7. However, all input pins need to belong to the same group.



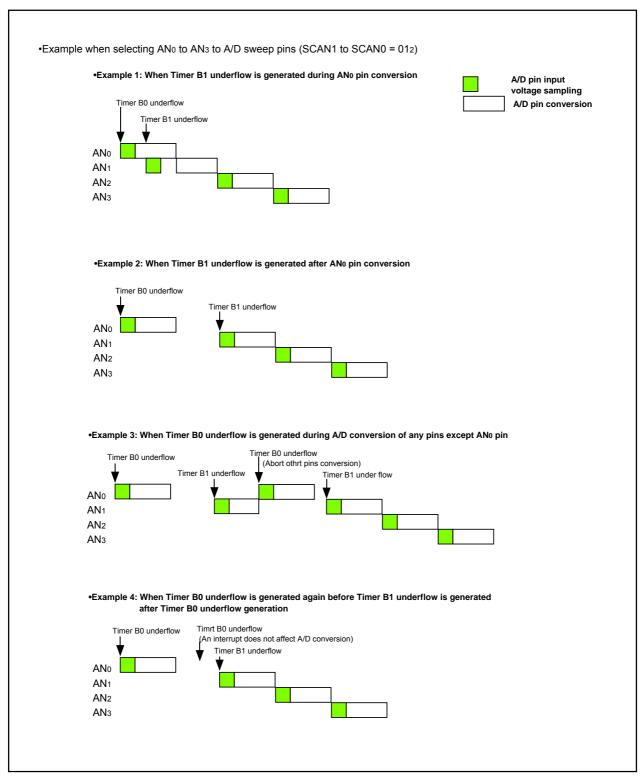


Figure 15.19 Operation Example in Delayed Trigger Mode 0

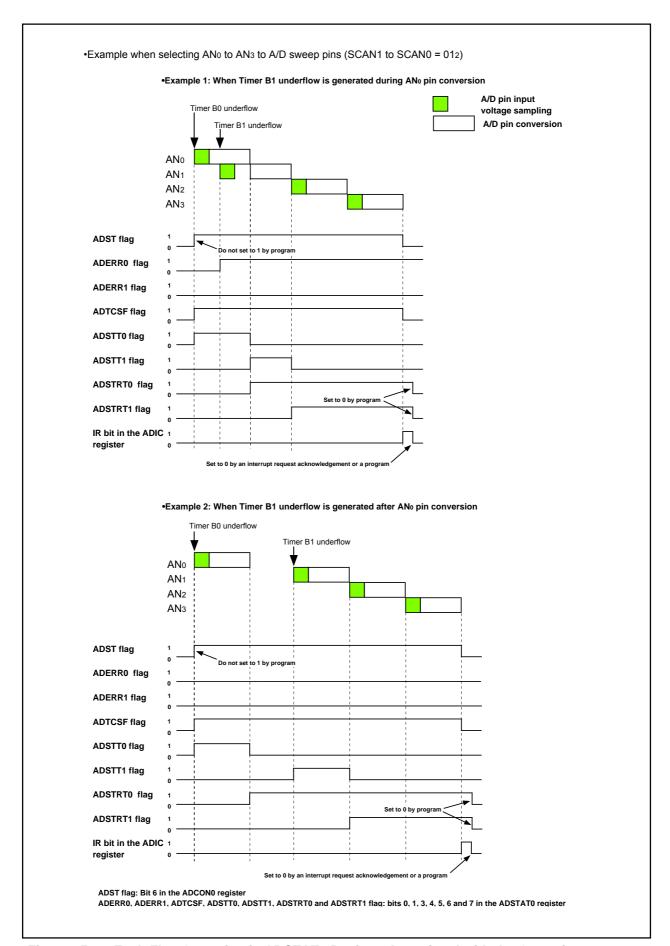


Figure 15.20 Each Flag Operation in ADSTAT0 Register Associated with the Operation Example in Delayed Trigger Mode 0 (1)

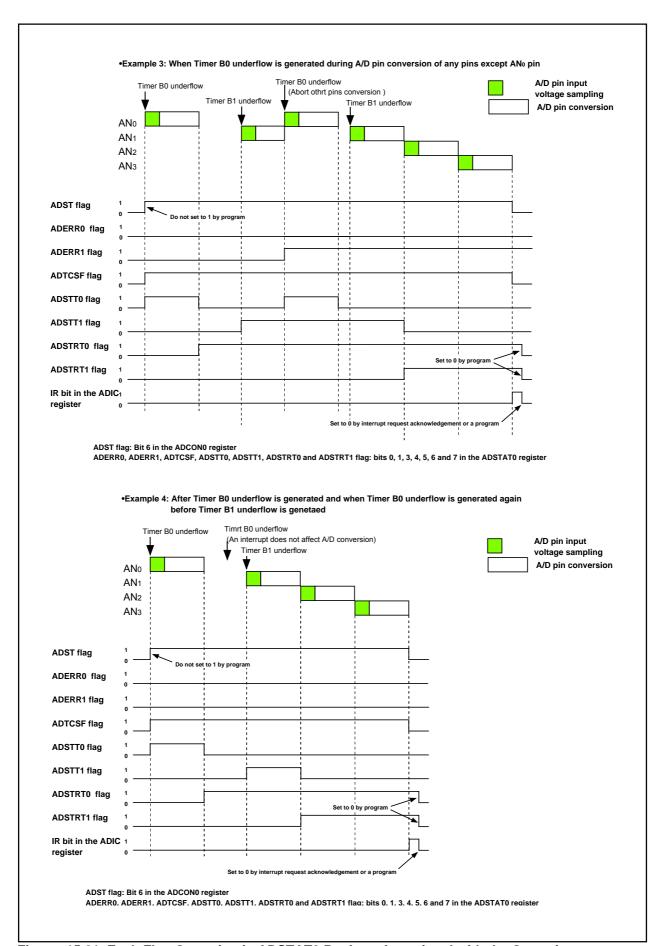


Figure 15.21 Each Flag Operation in ADSTAT0 Register Associated with the Operation Example in Delayed Trigger Mode 0 (2)

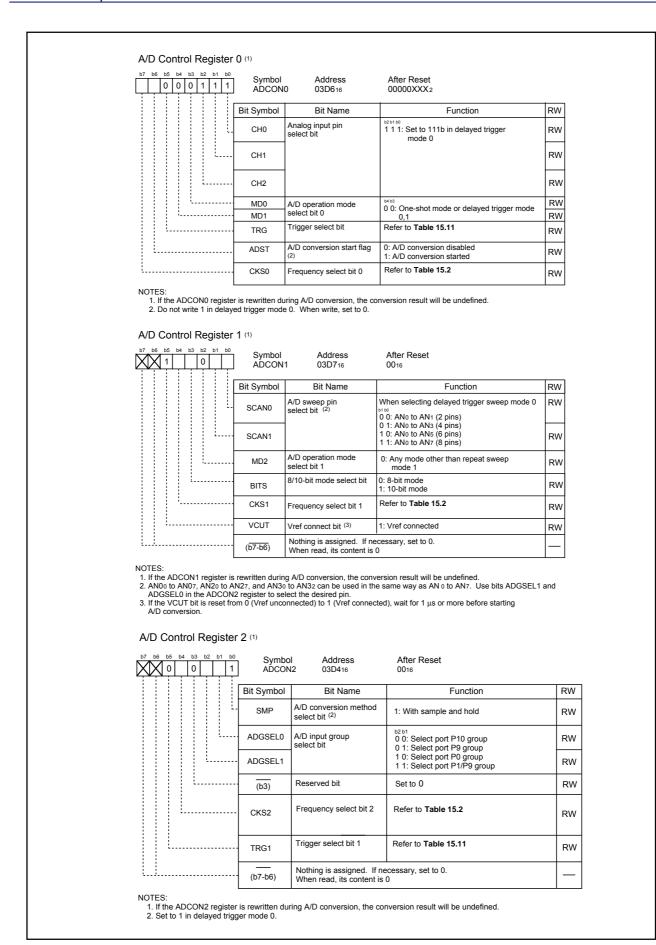


Figure 15.22 ADCON0 to ADCON2 Registers in Delayed Trigger Mode 0

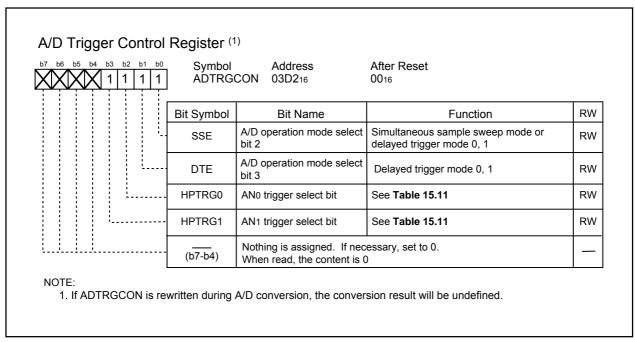


Figure 15.23 ADTRGCON Register in Delayed Trigger Mode 0

Table 15.11 Trigger Select Bit Setting in Delayed Trigger Mode 0

TRG	TRG1	HPTRG0	HPTRG1	Trigger
0	0	1	1	Timer B0, B1 underflow

15.1.8 Delayed Trigger Mode 1

In delayed trigger mode 1, analog voltages applied to the selected pins are converted one-by-one to a digital code. When the input of the $\overline{\text{ADTRG}}$ pin (falling edge) changes state from "H" to "L", a single sweep conversion is started. After completing the ANo pin conversion, the AN1 pin is not sampled and converted until the second $\overline{\text{ADTRG}}$ pin falling edge is generated. When the second $\overline{\text{ADTRG}}$ falling edge is generated, the single sweep conversion of the pins after the AN1 pin is restarted. **Table 15.12** shows the delayed trigger mode 1 specifications. **Figure 15.24** shows the operation example of delayed trigger mode 1. **Figure 15.25** and **15.26** show each flag operation in the ADSTATO register that corresponds to the operation example. **Figure 15.27** shows registers ADCON0 to ADCON2 in delayed trigger mode 1. **Figure 15.28** shows the ADTRGCON register in delayed trigger mode 1. **Table 15.13** shows the trigger select bit setting in delayed trigger mode 1.

Table 15.12 Delayed Trigger Mode 1 Specifications

Item	Specification
Function	Bits SCAN1 and SCAN0 in the ADCON1 register and bits ADGSEL1 and ADGSEL0
	in the ADCON2 register select pins. Analog voltages applied to the selected
	pins are converted one-by-one to a digital code. At this time, the $\overline{\text{ADTRG}}$ pin
	falling edge starts ANo pin conversion and the second ADTRG pin falling edge
	starts conversion of the pins after AN1 pin
A/D Conversion Start	ANo pin conversion start condition
Condition	The ADTRG pin input changes state from "H" to "L" (falling edge) (1)
	AN1 pin conversion start condition (2)
	The ADTRG pin input changes state from "H" to "L" (falling edge)
	•When the second ADTRG pin falling edge is generated during A/D conversion of
	the ANo pin, input voltage of AN1 pin is sampled or after at the time of ADTRG
	falling edge. The conversion of AN1 and the rest of the sweep starts when AN0
	conversion is completed.
	•When the ADTRG pin falling edge is generated again during single sweep
	conversion of pins after the AN1 pin, the conversion is not affected
A/D Conversion Stop	•A/D conversion completed
Condition	•Set the ADST bit to 0 (A/D conversion halted) (3)
Interrupt Request	Single sweep conversion completed
Generation Timing	
Analog Input Pin	Select from ANo to AN1 (2 pins), ANo to AN3 (4 pins), ANo to AN5 (6 pins)
	and ANo to AN7 (8 pins) (4)
Readout of A/D Conversion Result	Readout one of registers AN0 to AN7 that corresponds to the selected pins

NOTES:

- 1. Do not generate the next ADTRG pin falling edge after the AN1 pin conversion is started until all selected pins complete A/D conversion. When an ADTRG pin falling edge is generated again during A/D conversion, its trigger is ignored. The falling edge of ADTRG pin, which was input after all selected pins complete A/D conversion, is considered to be the next AN0 pin conversion start condition.
- 2. The ADTRG pin falling edge is detected synchronized with the operation clock fAD. Therefore, when the ADTRG pin falling edge is generated in shorter periods than fAD, the second ADTRG pin falling edge may not be detected. Do not generate the ADTRG pin falling edge in shorter periods than fAD.
- 3. Do not write 1 (A/D conversion started) to the ADST bit in delayed trigger mode 1. When write 1,unexpected interrupts may be generated.
- 4. AN00 to AN07, AN 20 to AN27, and AN30 to AN32 can be used in the same way as AN0 to AN7. However, all input pins need to belong to the same group.



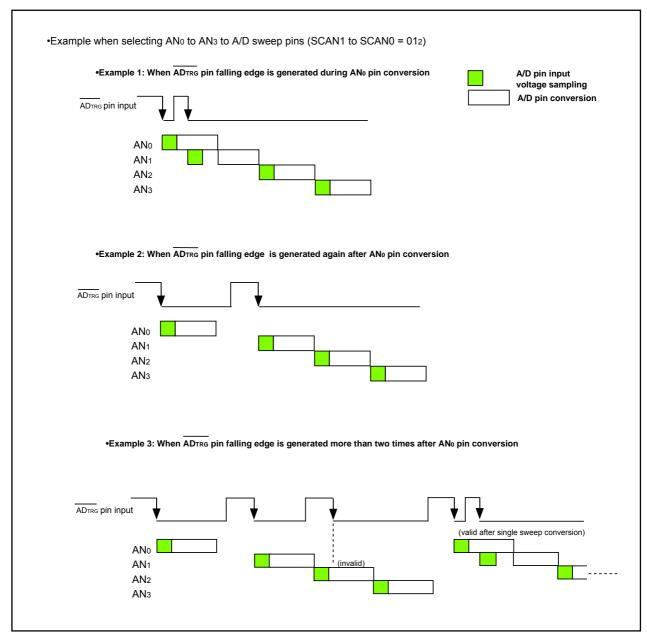


Figure 15.24 Operation Example in Delayed Trigger Mode1

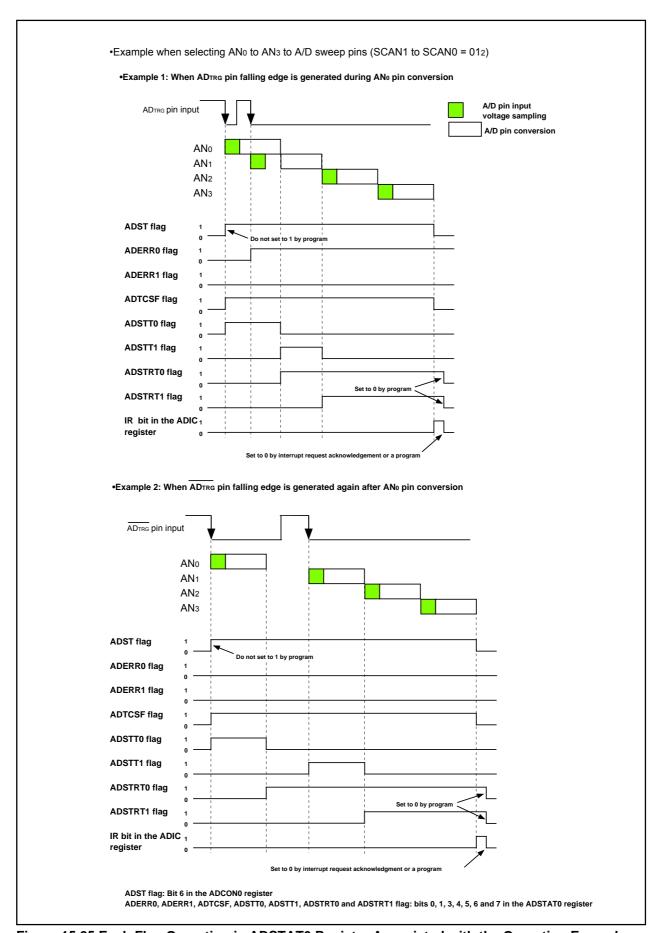


Figure 15.25 Each Flag Operation in ADSTAT0 Register Associated with the Operation Example in Delayed Trigger Mode 1 (1)

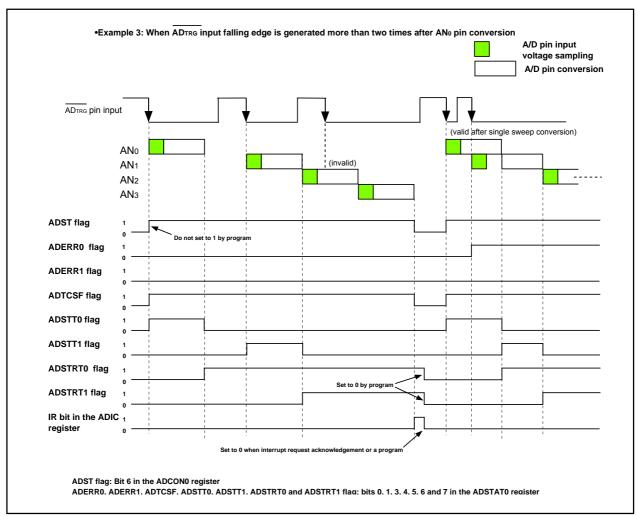


Figure 15.26 Each Flag Operation in ADSTAT0 Register Associated with the Operation Example in Delayed Trigger Mode 1 (2)

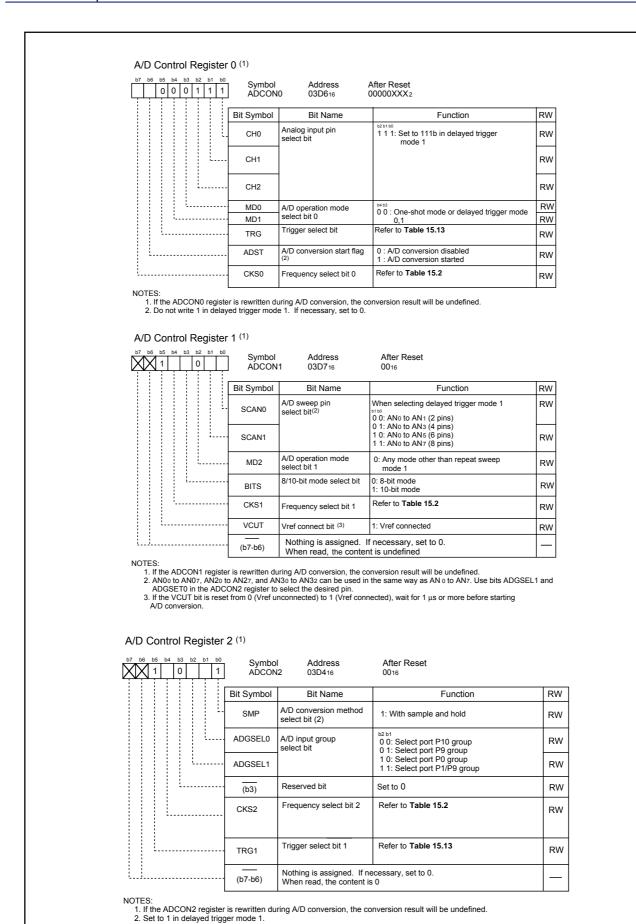


Figure 15.27 ADCON0 to ADCON2 Registers in Delayed Trigger Mode 1

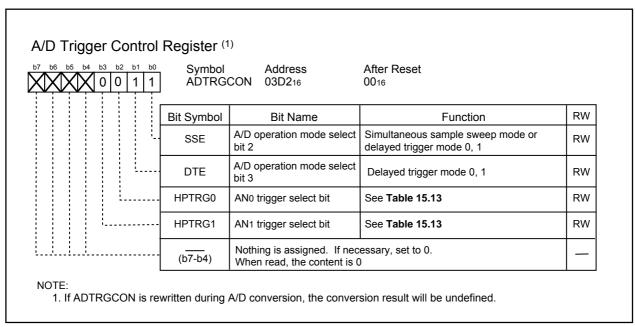


Figure 15.28 ADTRGCON Register in Delayed Trigger Mode 1

Table 15.13 Trigger Select Bit Setting in Delayed Trigger Mode 1

TRG	TRG1	HPTRG0	HPTRG1	Trigger
0	1	0	0	ADTRG

15.2 Resolution Select Function

The BITS bit in the ADCON1 register determines the resolution. When the BITS bit is set to 1 (10-bit precision), the A/D conversion result is stored into bits 0 to 9 in the ADi register (i=0 to 7). When the BITS bit is set to 0 (8-bit precision), the A/D conversion result is stored into bits 7 to 0 in the ADi register.

15.3 Sample and Hold

When the SMP bit in the ADCON 2 register is set to 1 (with the sample and hold function), A/D conversion rate per pin increases to 28 ϕ AD cycles for 8-bit resolution or 33 ϕ AD cycles for 10-bit resolution. The sample and hold function is available in one-shot mode, repeat mode, single sweep mode, repeat sweep mode 0 and repeat sweep mode 1. In these modes, start A/D conversion after selecting whether the sample and hold circuit is to be used or not. In simultaneous sample sweep mode, delayed trigger mode 0 or delayed trigger mode, set to use the Sample and Hold function before starting A/D conversion.

15.4 Power Consumption Reducing Function

When the A/D converter is not used, the VCUT bit in the ADCON1 register isolates the resistor ladder of the A/D converter from the reference voltage input pin (VREF). Power consumption is reduced by shutting off any current flow into the resistor ladder from the VREF pin.

When using the A/D converter, set the VCUT bit to 1 (Vref connected) before setting the ADST bit in the ADCON0 register to 1 (A/D conversion started). Do not set the ADST bit and VCUT bit to 1 simultaneously, nor set the VCUT bit to 0 (Vref unconnected) during A/D conversion.



15.5 Output Impedance of Sensor under A/D Conversion

To carry out A/D conversion properly, charging the internal capacitor C shown in **Figure 15.29** has to be completed within a specified period of time. T (sampling time) as the specified time. Let output impedance of sensor equivalent circuit be R0, MCU's internal resistance be R, precision (error) of the A/D converter be X, and the A/D converter's resolution be Y (Y is 1024 in the 10-bit mode, and 256 in the 8-bit mode).

VC is generally VC = VIN{1-e}
$$-\frac{1}{c(R0+R)}$$
 t }

And when t = T, $VC=VIN-\frac{X}{Y}$ $VIN=VIN(1-\frac{X}{Y})$

$$e^{-\frac{1}{c(R0+R)}} = \frac{X}{Y}$$

$$-\frac{1}{C(R0+R)}T = In \frac{X}{Y}$$
Hence, $R0 = -\frac{T}{C \cdot ln - \frac{X}{Y}} - R$

Figure 15.29 shows analog input pin and externalsensor equivalent circuit. When the difference between VIN and VC becomes 0.1 LSB, we find impedance R0 when voltage between pins. VC changes from 0 to VIN-(0.1/1024) VIN in timer T. (0.1/1024) means that A/D precision drop due to insufficient capacitor chage is held to 0.1LSB at time of A/D conversion in the 10-bit mode. Actual error however is the value of absolute precision added to 0.1LSB. When f(XIN) = 10MHz, T=0.3 μ s in the A/D conversion mode with sample & hold. Output inpedance R0 for sufficiently charging capacitor C within time T is determined as follows.

T = 0.3μs, R = 7.8kΩ, C = 1.5pF, X = 0.1, and Y = 1024. Hence,
$$R0 = -\frac{0.3X10^{-6}}{1.5X10^{-12}\text{-ln}\,\frac{0.1}{1024}} - 7.8 \times 10^3 \cong 13.9 \times 10^3$$

Thus, the allowable output impedance of the sensor circuit capable of thoroughly driving the A/D converter turns out of be approximately $13.9k\Omega$.

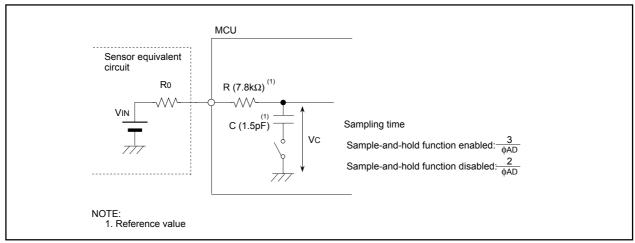


Figure 15.29 Analog Input Pin and External Sensor Equivalent Circuit

16. Multi-master I²C bus Interface

The multi-master I²C bus interface is a serial communication circuit based on Philips I²C bus data transfer format, equipped with arbitration lost detection and synchronous functions. **Figure 16.1** shows a block diagram of the multi-master I²C bus interface and **Table 16.1** lists the multi-master I²C bus interface functions.

The multi-master I²C bus interface consists of the S0D0 register, the S00 register, the S20 register, the S3D0 register, the S4D0 register, the S10 register, the S2D0 register and other control circuits.

Figures 16.2 to **16.8** show the registers associated with the multi-master I²C bus.

Table 16.1 Multi-master I²C bus interface functions

Item	Function		
Format	Based on Philips I ² C bus standard:		
	7-bit addressing format		
	High-speed clock mode		
	Standard clock mode		
Communication mode	Based on Philips I ² C bus standard:		
	Master transmit		
	Master receive		
	Slave transmit		
	Slave receive		
SCL clock frequency	16.1kHz to 400kHz (at VIIC ⁽¹⁾ = 4MHz)		
I/O pin	Serial data line SDAмм(SDA)		
	Serial clock line SDLмм(SCL)		

NOTE:

1. VIIC=I²C system clock

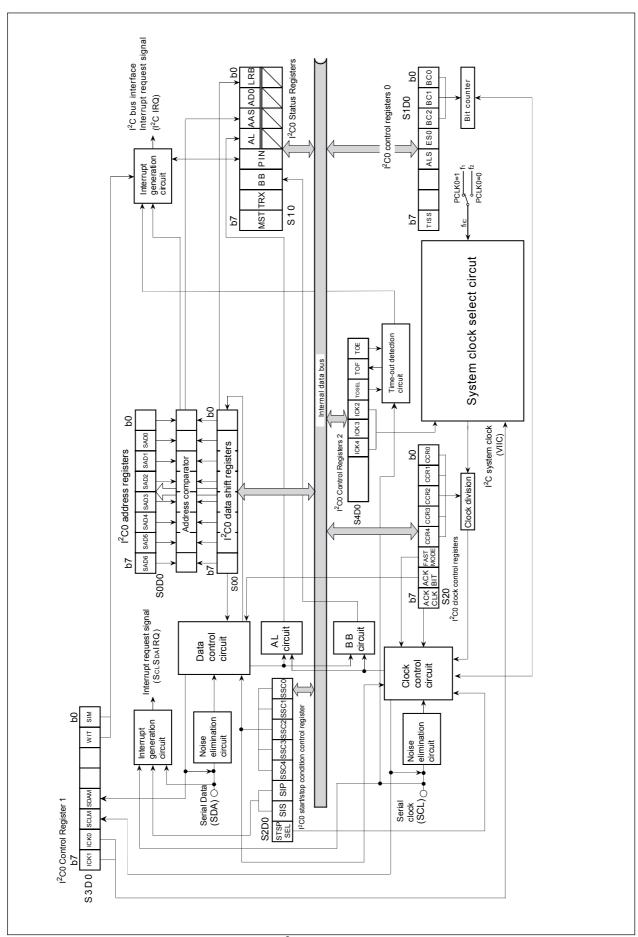


Figure 16.1 Block diagram of multi-master I²C bus interface

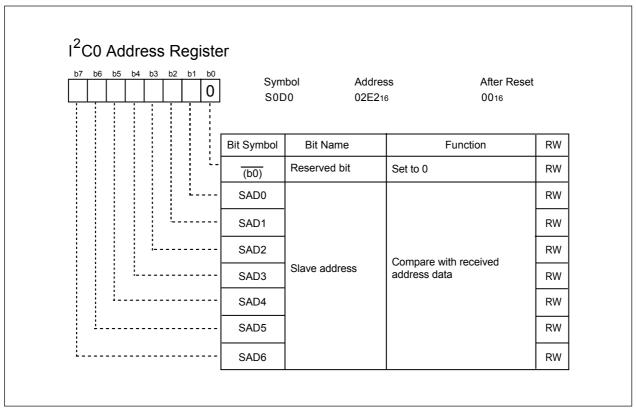


Figure 16.2 S0D0 Register

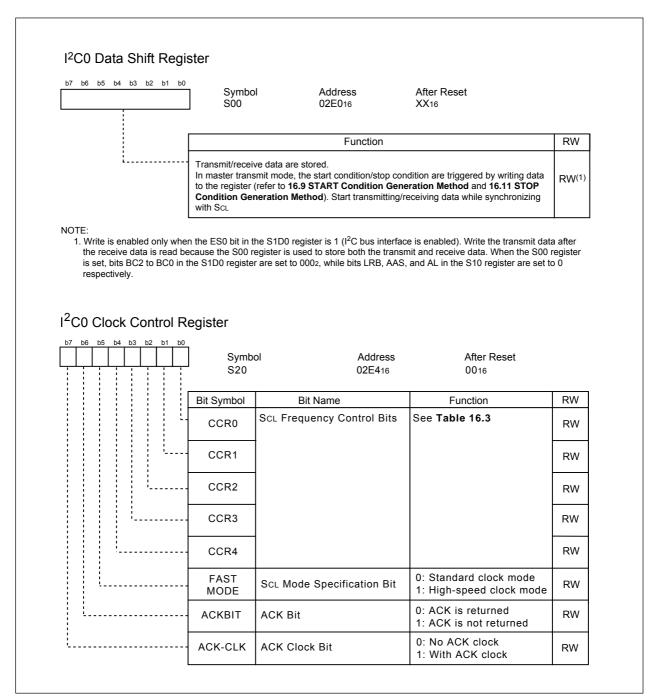


Figure 16.3 S00 and S20 Registers

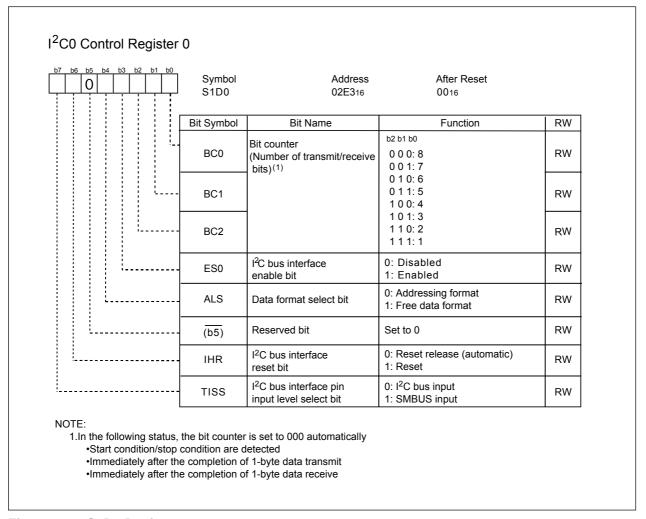


Figure 16.4 S1D0 Register

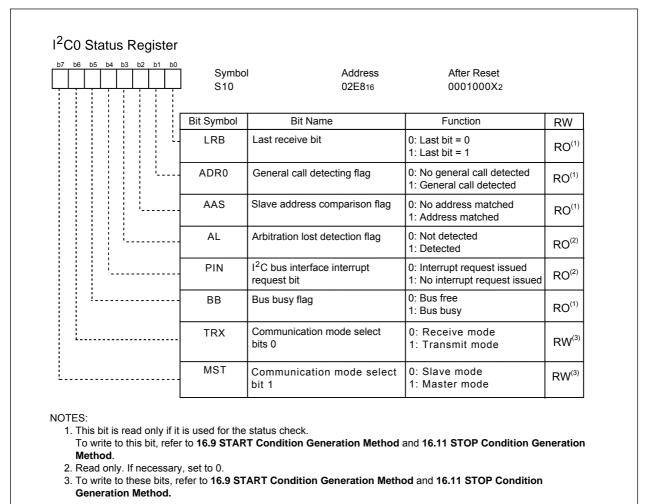
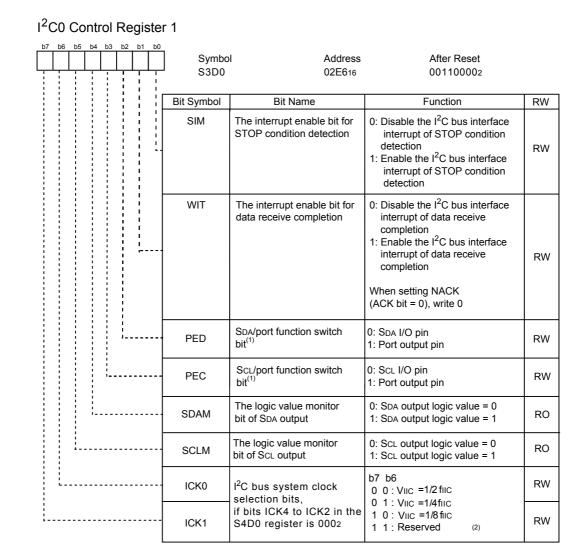


Figure 16.5 S10 Register



NOTE:

- 1. Bits PED and PEC are enabled when the ES0 bit in the S1D0 register is set to 1 (I²C bus interface enabled).
- 2. When the PCLK0 bit in the PCLKR register is set to 0, filc=f2. When the PCLK0 bit in the PCLKR register is set to 1, filc=f1.

Figure 16.6 S3D0 Register

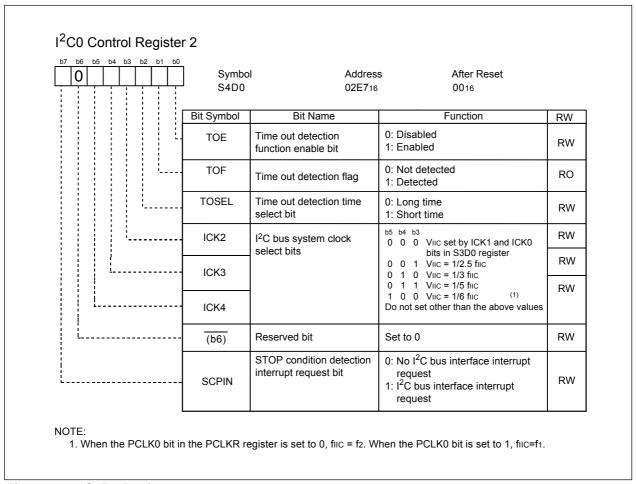


Figure 16.7 S4D0 Register

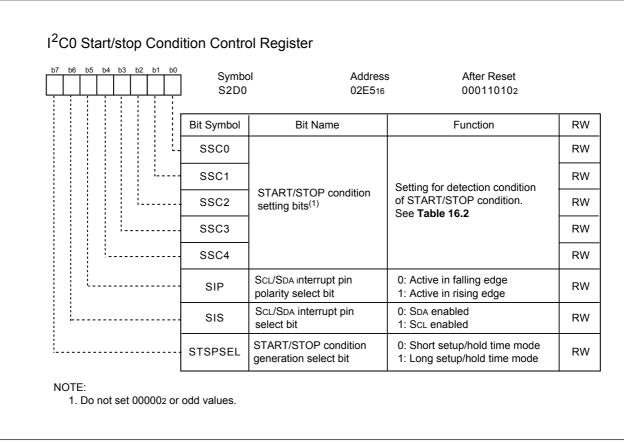


Figure 16.8 S2D0 Register

Table 16.2 Recommended setting (SSC4-SSC0) start/stop condition at each oscillation frequency

Oscillation	I ² C bus system	I ² C bus system	SSC4-SSC0 ⁽¹⁾	SCL release	Setup time	Hold time
f1 (MHz)	clock select	clock(MHz)		time (cycle)	(cycle)	(cycle)
10	1 / 2f1 ⁽²⁾	5	XXX11110	6.2 μs (31)	3.2 μs (16)	3.0 μs (15)
8	1 / 2 _{f1} ⁽²⁾	4	XXX11010	6.75 μs(27)	3.5 μs (14)	3.25 μs(13)
		1	XXX11000	6.25 μs(25)	3.25 μs (13)	3.0 μs (12)
8	1 / 8 _{f1} ⁽²⁾	1	XXX00100	5.0 μs (5)	3.0 μs (3)	2.0 μs (2)
4	1 / 2 _{f1} ⁽²⁾	2	XXX01100	6.5 μs (13)	3.5 μs (7)	3.0 μs (6)
			XXX01010	5.5 μs (11)	3.0 μs (6)	2.5 μs (5)
2	1 / 2 _{f1} ⁽²⁾	1	XXX00100	5.0 μs (5)	3.0 μs (3)	2.0 μs (2)

NOTES:

- 1. Do not set odd values or 000002 to START/STOP condition setting bits (SSC4 to SSC0)
- 2. When the PCLK0 bit in the PCLKR register is set to 1.

16.1 I²C0 Data Shift Register (S00 register)

The S00 register is an 8-bit data shift register to store a received data and to write a transmit data. When a transmit data is written to the S00 register, the transmit data is synchronized with a SCL clock and the data is transferred from bit 7. Then, every one bit of the data is transmitted, the register's content is shifted for one bit to the left. When the SCL clock and the data is imported into the S00 register from bit 0. Every one bit of the data is imported, the register's content is shifted for one bit to the left. **Figure 16.9** shows the timing to store the receive data to the S00 register.

The S00 register can be written when the ES0 bit in the S1D0 register is set to 1 (I²C0 bus interface enabled). If the S00 register is written when the ES0 bit is set to 1 and the MST bit in the S10 register is set to 1 (master mode), the bit counter is reset and the SCL clock is output. Write to the S00 register when the START condition is generatedor when an "L" signal is applied to the SCL pin. The S00 register can be read anytime regardless of the ES0 bit value.

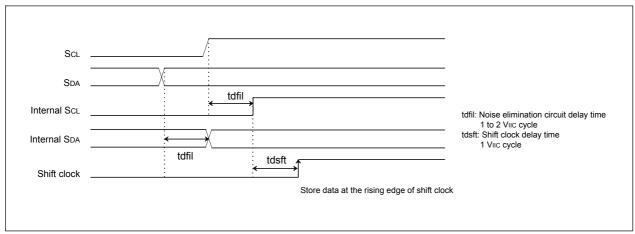


Figure 16.9 The Receive Data Storing Timing of S00 Register

16.2 I²C0 Address Register (S0D0 register)

The S0D0 register consists of bits SAD6 to SAD0, total of 7. At the addressing is formatted, slave address is detected automatically and the 7-bit received address data is compared with the contents of bits SAD6 to SAD0.

16.3 I²C0 Clock Control Register (S20 register)

The S20 register is used to set the ACK control, SCL mode and the SCL frequency.

16.3.1 Bits 0 to 4: SCL Frequency Control Bits (CCR0-CCR4)

These bits control the SCL frequency. See Table 16.3.

16.3.2 Bit 5: SCL Mode Specification Bit (FAST MODE)

The FAST MODE bit selects SCL mode. When the FAST MODE bit is set to 0, standard clock mode is entered. When it is set to 1, high-speed clock mode is entered.

When using the high-speed clock mode I²C bus standard (400 kbit/s maximum) to connect buses, set the FAST MODE bit to 1 (select SCL mode as high-speed clock mode) and use the I²C bus system clock (VIIC) at 4 MHz or more frequency.

16.3.3 Bit 6: ACK Bit (ACKBIT)

The ACKBIT bit sets the SDA status when an ACK clock⁽¹⁾ is generated. When the ACKBIT bit is set to 0, ACK is returned and te clock applied to SDA becomes "L" when ACK clock is generated. When it is set to 1, ACK is not returned and the clock clock applied to SDA maintains "H" at ACK clock generation.

When the ACKBIT bit is set to 0, the address data is received. When the slave address matches with the address data, SDA becomes "L" automatically (ACK is returned). When the slave address and the address data are not matched, SDA becomes "H" (ACK is not returned).

NOTE:

1. ACK clock: Clock for acknowledgment

16.3.4 Bit 7: ACK Clock Bit (ACK-CLK)

The ACK-CLK bit set a clock for data transfer acknowledgement. When the ACK-CLK bit is set to 0, ACK clock is not generated after data is transferred. When it is set to 1, a master generates ACK clock every one-bit data transfer is completed. The device, which transmits address data and control data, leave SDA pin open (apply "H" signal to SDA) when ACK clock is generated. The device which receives data, receives the generated ACKBIT bit.

NOTE:

1.Do not rewrite the S20 register, other than the ACKBIT bit during data transfer. If data is written to other than the ACKBIT bit during transfer, the I²C bus clock circuit is reset and the data may not be transferred successfully.



Setting value of CCR4 to CCR0 SCL frequency (at VIIC=4MHz, unit: kHz) (1) CCR4 CCR3 CCR2 CCR1 CCR0 Standard clock mode High-speed clock mode 0 0 0 Setting disabled Setting disabled 0 0 0 0 1 Setting disabled Setting disabled 0 0 0 1 0 Setting disabled Setting disabled 0 0 0 1 1 _ (2) 333 _ (2) 0 0 1 0 0 250 0 0 1 0 1 100 400 (3) 0 0 1 1 0 83.3 166 500 / CCR value (3) 1000 / CCR value (3) 1 \downarrow \downarrow 1 1 1 1 1 0 1 17.2 34.5 1 1 1 1 0 16.6 33.3 1 1 1 1 1 16.1 32.3

Table 16.3 Setting values of S20 register and SCL frequency

NOTES:

- 1. The duty of the SCL clock output is 50 %. The duty becomes 35 to 45 % only when high-speed clock mode is selected and the CCR value = 5 (400 kHz, at VIIC = 4 MHz). "H" duration of the clock fluctuates from –4 to +2 I²C system clock cycles in standard clock mode, and fluctuates from –2 to +2 I²C system clock cycles in high-speed clock mode. In the case of negative fluctuation, the frequency does not increase because the "L" is extended instead of "H" reduction. These are the values when the SCL clock synchronization by the synchronous function is not performed. The CCR value is the decimal notation value of the CCR4 to CCR0 bits.
- **2.** Each value of the SCL frequency exceeds the limit at VIIC = 4 MHz or more. When using these setting values, use VIIC = 4 MHz or less. Refer to **Figure 16.6**.
- 3. The data formula of SCL frequency is described below:

VIIC/(8 x CCR value) Standard clock mode

 $V_{IIC}/(4 \times CCR \text{ value})$ High-speed clock mode (CCR value $\neq 5$)

VIIC/(2 x CCR value) High-speed clock mode (CCR value = 5)

Do not set 0 to 2 as the CCR value regardless of the VIIC frequency. Set 100 kHz (max.) in standard clock mode and 400 kHz (max.) in high-speed clock mode to the SCL frequency by setting the CCR4 to CCR0 bits.



16.4 I²C0 Control Register 0 (S1D0)

The S1D0 register controls data communication format.

16.4.1 Bits 0 to 2: Bit Counter (BC0-BC2)

Bits BC2 to BC0 decide how many bits are in one byte data transferred next. After the selected numbers of bits are transferred successfully, I²C bus interface interrupt request is gnerated and bits BC2 to BC0 are reset to 0002. At this time, if the ACK-CLK bit in the S20 register is set to 1 (with ACK clock), one bit for ACK clock is added to the numbers of bits selected by the BC2 to BC0 bits.

In addition, bits BC2 to BC0 become 0002 even though the START condition is detected and the address data is transferred in 8 bits.

16.4.2 Bit 3: I²C Interface Enable Bit (ES0)

The ES0 bit enables to use the multi-master I^2C bus interface. When the ES0 bit is set to 0, I^2C bus interface is disabled and the SDA and SCL pins are placed in a high-h-impedance state. When the ES0 bit is set to 1, the interface is enabled.

When the ES0 bit is set to 0, the process is followed.

- 1)The bits in the S10 register are set as MST = 0, TRX = 0, PIN = 1, BB = 0, AL = 0, AAS = 0, ADR0 = 0
- 2)The S00 register cannot be written.
- 3)The TOF bit in the S4D0 register is set to 0 (time-out detection flag is not detected)
- 4)The I²C system clock (VIIC) stops counting while the internal counter and flags are reset.

16.4.3 Bit 4: Data Format Select Bit (ALS)

The ALS bit determines whether the salve address is recognized. When the ALS bit is set to 0, an addressing format is selected and a address data is recognized. Only if the comparison is matched between the slave address stored into the S0D0 register and the received address data or if the general call is received, the data is transferred. When the ALS bit is set to 1, the free data format is selected and the slave address is not recognized.

16.4.4 Bit 6: I²C bus Interface Reset Bit (IHR)

The IHR bit is used to reset the I²C bus interface circuit when the error communication occurs.

When the ES0 bit in the S1D0 register is set to 1 (I²C bus interface is enabled), the hardware is reset by writing 1 to the IHR bit. Flags are processed as follows:

- 1)The bits in the S10 register are set as MST = 0, TRX = 0, PIN to 1, BB = 0, AL = 0, AAS = 0, and ADR0 = 0
- 2)The TOF bit in the S4D0 register is set to 0 (time-out detection flag is not detected)
- 3)The internal counter and flags are reset.

The I²C bus interface circuit is reset after 2.5 VIIC cycles or less, and the IHR bit becomes 0 automatically by writing 1 to the IHR bit. **Figure 16.10** shows the reset timing.



16.4.5 Bit 7: I²C bus Interface Pin Input Level Select Bit (TISS)

The TISS bit selects the input level of the SCL and SDA pins for the multi-master I^2C bus interface. When the TISS bit is set to 1, the P20 and P21 become the SMBus input level.

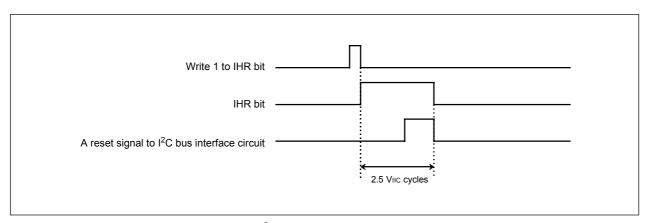


Figure 16.10 The timing of reset to the I²C bus interface circuit

16.5 I²C0 Status Register (S10 register)

The S10 register monitors the I^2C bus interface status. When using the S10 register to check the status, use the 6 low-order bits for read only.

16.5.1 Bit 0: Last Receive Bit (LRB)

The LRB bit stores the last bit value of received data. It can also be used to confirm whether ACK is received. If the ACK-CLK bit in the S20 register is set to 1 (with ACK clock) and ACK is returned when the ACK clock is generated, the LRB bit is set to 0. If ACK is not returned, the LRB bit is set to 1. When the ACK-CLK bit is set to 0 (no ACK clock), the last bit value of received data is input. When writing data to the S00 register, the LRB bit is set to 0.

16.5.2 Bit 1: General Call Detection Flag (ADR0)

When the ALS bit in the S1D0 register is set to 0 (addressing format), this ADR0 flag is set to 1 by receiving the general calls⁽¹⁾,whose address data are all 0, in slave mode.

The ADR0 flag is set to 0 when STOP or START conditions is detected or when the IHR bit in the S1D0 register is set to 1 (reset).

NOTE:

General call: A master device transmits the general call address 0016 to all slaves. When the
master device transmits the general call, all slave devices receive the controlled data after general
call.

16.5.3 Bit 2: Slave Address Comparison Flag (AAS)

The AAS flag indicates a comparison result of the slave address data after enabled by setting the ALS bit in the S1D0 register to 0 (addressing format).

The AAS flag is set to 1 when the 7 bits of the address data are matched with the slave address stored into the S0D0 register, or when a general call is received, in slave receive mode. The AAS flag is set to 0 by writing data to the S00 register. When the ES0 bit in the S1D0 register is set to 0 (I²C bus interface disabled) or when the IHR bit in the S1D0 register is set to 1 (reset), the AAS flag is also set to 0.

16.5.4 Bit 3: Arbitration Lost Detection Flag (AL)⁽¹⁾

In master transmit mode, if an "L" signal is applied to the SDA pin by other than the MCU, the AL flag is set to 1 by determining that the arbitration is los and the TRX bit in the S10 register is set to 0 (receive mode) at the same time. The MST bit in the S10 register is set to 0 (slave mode) after transferring the bytes which lost the arbitration.

The arbitration lost can be detected only in master transmit mode. When writing data to the S00 register, the AL flag is set to 0. When the ES0 bit in the S1D0 register is set to 0 (I²C bus interface disabled) or when the IHR bit in the S1D0 register is set to 1 (reset), the AL flag is set to 0.

NOTE:

1. Arbitration lost: communication disabled as a master



16.5.5 Bit 4: I²C bus Interface Interrupt Request Bit (PIN)

The PIN bit generates an I²C bus interface interrupt request signal. Every one byte data is ransferred, the PIN bit is changed from 1 to 0. At the same time, an I²C bus interface interrupt request is generated. The PIN bit is synchronized with the last clock of the internal transfer clock (when ACK-CLK=1, the last clock is the ACK clock: when the ACK-CLK=0, the last clock is the 8th clock) and it becomes 0. The interrupt request is generated on the falling edge of the PIN bit. When the PIN bit is set to 0, the clock applied to SCL maintains "L" and further clock generation is disabled. When the ACK-CLK bit is set to 1 and the WIT bit in the S3D0 register is set to 1 (enable the I²C bus interface interrupt of data receive completion). The PIN bit is synchronized with the last clock and the falling edge of the ACK clock. Then, the PIN bit is set to 0 and I²C bus interface interrupt request is generated. **Figure 16.11** shows the timing of the I²C bus interface interrupt request generation.

The PIN bit is set to 1 in one of the following conditions:

- •When data is written to the S00 register
- •When data is written to the S20 register (when the WIT bit is set to 1 and the internal WAIT flag is set to 1)
- •When the ES0 bit in the S1D0 register is set to 0 (I²C bus interface disabled)
- •When the IHR bit in the S1D0 register is set to 1(reset)

The PIN bit is set to 0 in one of the following conditions:

- •With completion of 1-byte data transmit (including a case when arbitration lost is detected)
- •With completion of 1-byte data receive
- •When the ALS bit in the S1D0 register is set to 0 (addressing format) and slave address is matched or general call address is received successfully in slave receive mode
- •When the ALS bit is set to 1 (free format) and the address data is received successfully in slave receive mode

16.5.6 Bit 5: Bus Busy Flag (BB)

The BB flag indicates the operating conditions of the bus system. When the BB flag is set to 0, a bus system is not in use and a START condition can be generated. The BB flag is set and reset based on an input signal of the SCL and SDA pins either in master mode or in slave mode. When the START condition is detected, the BB flag is set to 1. On the other hand, when the STOP condition is detected, the BB flag is set to 0. Bits SSC4 to SSC0 in the S2D0 register decide to detect between the START condition and the STOP condition. When the ES0 bit in the S1D0 register is set to 0 (I²C bus interface disabled) or when the IHR bit in the S1D0 register is set to 1 (reset), the BB flag is set to 0. Refer to 16.9 START Condition Generation Method and 16.11 STOP Condition Generation Method.

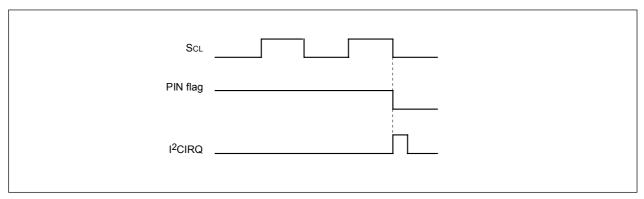


Figure 16.11 Interrupt request signal generation timing



16.5.7 Bit 6: Communication Mode Select Bit (Transfer Direction Select Bit: TRX)

This TRX bit decides a transfer direction for data communication. When the TRX bit is set to 0, receive mode is entered and data is received from a transmit device. When the TRX bit is set to 1, transmit mode is entered, and address data and control data are output to the SDAMM, synchronized with a clock generated in the SCLMM.

The TRX bit is set to 1 automatically in the following condition:

- •In slave mode, when the ALS in the S1D0 register to 0(addressing format), the AAS flag is set to
- 1 (address match) after the address data is received, and the received R/ \overline{W} bit is set to 1

The TRX bit is set to 0 in one of the following conditions:

- •When an arbitration lost is detected
- •When a STOP condition is detected
- When a START condition is detected
- •When a START condition is disabled by the START condition duplicate protect function (1)
- •When the MST bit in the S10 register is set to 0(slave mode) and a start condition is detected
- •When the MST bit is set to 0 and the ACK non-return is detected
- •When the ES0 bit is set to 0(I²C bus interface disabled)
- •When the IHR bit in the S1D0 register is set to 1(reset)

16.5.8 Bit 7: Communication mode select bit (master/slave select bit: MST)

The MST bit selects either master mode or slave mode for data communication. When the MST bit is set to 0, slave mode is entered and the START/STOP condition generated by a master device are received. The data communication is synchronized with the clock generted by the master. When the MST bit is set to 1, master mode is entered and the START/STOP condition is generated.

Additionally, clocks required for the data communication are generated on the SCLMM.

The MST bit is set to 0 in one of the following conditions.

- •After 1-byte data of a master whose arbtration is lost if arbitration lost is detected
- •When a STOP condition is detected
- •When a START condition is detected
- •When a start condition is disabled by the START condition duplicate protect function (1)
- •When the IHR bit in the S1D0 register is set to 1(reset)
- •When the ES0 bit is set to 0(I²C bus interface disabled)

NOTE:

1. START condition duplicate protect function:

When the START condition is generated, after confirming that the BB flag in the S1D0 register is set to 0 (bus free), all the MST, TRX and BB flags are set to 1 at the same time. However, if the BB flag is set to 1 immediately after the BB flag setting is confirmed because a START condition is generated by other master device, bits MST and TRX cannot be written. The duplicate protect function is valid from the rising edge of the BB flag until slave address is received. Refer to 16.9 START Condition Generation Method for details.



16.6 I²C0 Control Register 1 (S3D0 register)

The S3D0 register controls the I²C bus interface circuit.

16.6.1 Bit 0 : Interrupt Enable Bit by STOP Condition (SIM)

The SIM bit enables the I²C bus interface interrupt request by detecting a STOP condition. If the SIM bit is set to 1, the I²C bus interface interrupt request is generated by the STOP condition detect (no need to change in the PIN flag).

16.6.2 Bit 1: Interrupt Enable Bit at the Completion of Data Receive (WIT)

If the WIT bit is set to 1 while the ACK-CLK bit in the S20 register is set to 1 (ACK clock), the I^2C bus interface interrupt request is generated and the PIN bit is set to 1 at the falling edge of the last data bit clock. Then an "L" signal is applied to the SCLMM and the ACK clock generation is controlled. **Table 16.4** and **Figure 16.12** show the interrupt generation timing and the procedure of communication restart. After the communication is restarted, the PIN bit is set to 0 again, synchronized with the falling edge of the ACK clock, and the I^2C bus interface interrupt request is generated.

Table16.4 Timing of Interrupt Generation in Data Receive Mode

I ² C bus Interface Interrupt Generation Timing	Procedure of Communication Restart
1) Synchronized with the falling edge of the	Set the ACK bit in the S20 register.
last data bit clock	Set the PIN bit to 1.
	(Do not write to the S00 register. The ACK clock
	operation may be unstable.)
2) Synchronized with the falling edge of the	Set the S00 register
ACK clock	

The internal WAIT flag can be read by reading the WIT bit. The internal WAIT flag is set to 1 after writing data to the S00 register and it is set to 0 after writing to the S20 register.

Consequently, the I^2C bus interface interrupt request generated by the timing 1) or 2) can be determined. (See **Figure 16.12**)

When the data is transmitted and the address data is received immediately after the START condition, the WAIT flag remains 0 regardless of the WIT bit setting, and the I²C bus interface interrupt request is only generated at the falling edge of the ACK clock. Set the WIT bit to 0 when the ACK-CLK bit in the S20 register is set to 0 (no ACK clock).



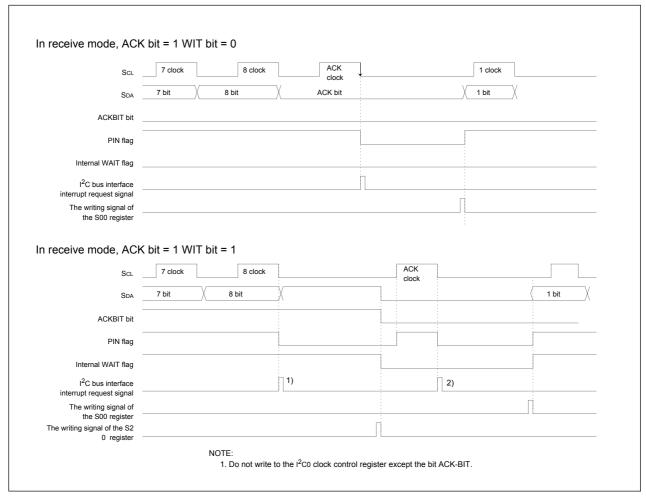


Figure 16.12 The timing of the interrupt generation at the completion of the data receive

16.6.3 Bits 2,3: Port Function Select Bits PED, PEC

If the ES0 bit in the S1D0 register is set to 1 (I^2C bus interface enabled), the SDAMM functions as an output port. When the PED bit is set to 1 and the SCLMM functions as an output port when the PEC bit is set to 1. Then the setting values of bits P2_0 and P2_1 in the port P2 register are output to the I^2C bus, regardless of he internal SCL/SDA output signals. (SCL/SDA pins are onnected to I^2C bus interface circuit)

The bus data can be read by reading the port pi direction register in input mode, regardless of the setting values of the PED and PEC bits. **Table 16.5** shows the port specification.

Table 16.5 Port specifications

	specifications.			
Pin Name	ES9 Bit	PED Bit	P20 Port Direction Register	Function
	0	-	0/1	Port I/O function
P20	1	0	-	SDA I/O function
	1	1	-	SDA input function, port output function
Pin Name	ES0 Bit	PEC Bit	P21 Port Direction Register	Function
	0	-	0/1	Port I/O function
P21	1	0	-	SCL I/O function
	1	1	-	SCL input function, port output funcion

16.6.4 Bits 4,5 : SDA/SCL Logic Output Value Monitor Bits SDAM/SCLM

Bits SDAM/SCLM can monitor the logic value of the SDA and SCL output signals from the I²C bus interface circuit. The SDAM bit monitors the SDA output logic value. The SCLM bit monitors the SCL output logic value. The SDAM and SCLM bits are read-only. If necessary, set them to 0.

16.6.5 Bits 6,7 : I²C System Clock Select Bits ICK0, ICK1

The ICK1 bit, ICK0 bit, bits ICK4 to ICK2 in the S4D0 register, and the PCLK0 bit in the PCLKR register can select the system clock (VIIC) of the I^2C bus interface circuit.

The I^2C bus system clock VIIC can be selected among 1/2 fiIC, 1/2.5 fiIC, 1/3 fiIC, 1/4 fiIC, 1/5 fiIC, 1/6 fiIC and 1/8 fiIC. fiIC can be selected between f1 and f2 by the PCLK0 bit setting.

Table 16.6 I²C system clock select bits

I3CK4[S4D0]	ICK3[S4D0]	ICK2[S4D0]	ICK1[S3D0]	ICK0[S3D0]	I ² C system clock
0	0	0	0	0	VIIC = 1/2 fIIC
0	0	0	0	1	VIIC = 1/4 fIIC
0	0	0	1	0	VIIC = 1/8 fIIC
0	0	1	Х	Х	VIIC = 1/2.5 fIIC
0	1	0	Х	Х	VIIC = 1/3 fIIC
0	1	1	Х	Х	VIIC = 1/5 fIIC
1	0	0	Х	Х	VIIC = 1/6 fIIC

⁽ Do not set the combination other than the above)

16.6.6 Address Receive in STOP/WAIT Mode

When WAIT mode is entered after the CM02 bit in the CM0 register is set to 0 (do not stop the peripheral function clock in wait mode), the I^2C bus interface circuit can receive address data in WAIT mode. However, the I^2C bus interface circuit is not operated in STOP mode or in low power consumption mode, because the I^2C bus system clock VIIC is not supplied.



16.7 I²C0 Control Register 2 (S4D0 Register)

The S4D0 register controls the error communication detection.

If the SCL clock is stopped counting dring data transfer, each device is stopped, staying online. To avoid the situation, the I²C bus interface circuit has a function to detect the time-out when the SCL clock is stopped in high-level ("H") state for a specific period, and to generate an I²C bus interface interrupt request. See **Figure 16.13**.

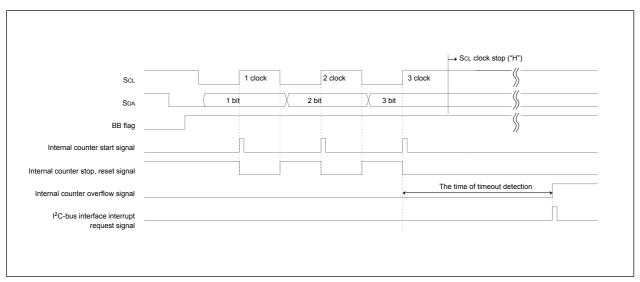


Figure 16.13 The timing of time-out detection

16.7.1 Bit0: Time-Out Detection Function Enable Bit (TOE)

The TOE bit enables the time-out detection function. When the TOE bit is set to 1, time-out is detected and the I²C bus interface interrupt request is generated when the following conditions are met.

- 1) the BB flag in the S10 register is set to 1 (bus busy)
- 2) the SCL clock stops for time-out detection period while high-level ("H") signal is maintained (see **Table 16.7**)

The internal counter measures the time-out detection time and the TOSEL bit selects between two modes, long time and short time. When time-out is detected, set the ES0 bit to 0 (I²C bus interface disabled) and reset the counter.

16.7.2 Bit1: Time-Out Detection Flag (TOF)

The TOF flag indicates the time-out detection. If the internal counter which measures the time-out period overflows, the TOF flag is set to 1 and the I²C bus interface interrupt request is generated at the same time.

16.7.3 Bit2: Time-Out Detection Period Select Bit (TOSEL)

The TOSEL bit selects time-out detection period from long time mode and short time mode. When the TOSEL bit is set to 0, long time mode is selected. When it is set to 1, short time mode is selected, respectively. The internal counter increments as a 16-bit counter in long time mode, while the counter increments as a 14-bit counter in short time mode, based on the I²C system clock (VIIC) as a counter source. **Table 16.7** shows examples of time-out detection period.

Table 16.7 Examples of Time-out Detection Period (Unit: ms)

VIIC(MHz)	Long time mode	Short time mode
4	16.4	4.1
2	32.8	8.2
1	65.6	16.4

16.7.4 Bits 3,4,5: I²C System Clock Select Bits (ICK2-4)

Bits ICK4 to ICK2, and bits ICK1 and ICK0 in the S3D0 register, and the PCLK0 bit in the PCLKR register select the system clock (VIIC) of the I²C bus interface circuit. See **Table 16.6** for the setting values.

16.7.5 Bit7: STOP Condition Detection Interrupt Request Bit (SCPIN)

The SCPIN bit monitors the stop condition detection interrupt. The SCPIN bit is set to 1 when the I^2C bus interface interrupt is generated by detecting the STOP condition. When this bit is set to 0 by program, it becomes 0. However, no change occurs even if it is set to 1.



16.8 I²C0 START/STOP Condition Control Register (S2D0 Register)

The S2D0 register controls the START/STOP condition detections.

16.8.1 Bit0-Bit4: START/STOP Condition Setting Bits (SSC0-SSC4)

The SCL release time and the set-up and hold times are mesured on the base of the I²C bus system clock (VIIC). Therefore, the detection conditions changes, depending on the oscillation frequency (XIN) and the I²C bus system clock select bits. It is necessary to set bits SSC4 to SSC0 to the appropriate value to set the SCL release time, the set-up and hold times by the system clock frequency (See **Table 16.10**). Do not set odd numbers or 000002 to bits SSC4 to SSC0. **Table 16.2** shows the reference value to bits SSC4 to SSC0 at each oscillation frequency in standard clock mode. The detection of START/STOP conditions starts immediately after the ES0 bit in the S1D0 register is set to 1 (I²C bus interface enabled).

16.8.2 Bit5: SCL/SDA Interrupt Pin Polarity Select Bit (SIP)

The The SIP bit detect the rising edge or the falling edge of the SCLMM or SDAMM to generate SCL/SDA interrupts. The SIP bit selects the polarity of the SCLMM or the SDAMM for interrupt.

16.8.3 Bit6: SCL/SDA Interrupt Pin Select Bit (SIS)

The SIS bit selects a pin to enable SCL/SDA interrupt.

NOTE:

1. The SCL/SDA interrupt request may be set when changing the SIP, SIS and ES0 bit settings in the S1D0 register. When using the SCL/SDA interrupt, set the above bits, while the SCL/SDA interrupt is disabled. Then, enable the SCL/SDA interrupt after setting the SCL/SDA bit in the IR register to 0.

16.8.4 Bit7: START/STOP Condition Generation Select Bit (STSPSEL)

The STSPSEL bit selects the set-up/hold times, based on the I2C system clock cycles, when the START/STOP condition is generated (See **Table 16.8**). Set the STSPSEL bit to 1 if the I²C bus system clock frequency is over 4MHz.



16.9 START Condition Generation Method

Set the MST bit, TRX bit and BB flags in the S10 register to 1 and set the PIN bit and 4 low-order bits in the S10 register to 0 simultaneously, to enter START condition standby mode, when the ES0 bit in the S1D0 register is set to 1 (I²C bus interface enabled) and the BB flag is set to 0 (bus free). When the slave address is written to the S00 register next, START condition is generated and the bit counter is reset to 0002 and 1-byte SCL signal is output. The START condition generation timing varies between standard clock mode and high-speed clock mode. See **Figure 16.16 and Table 16.8**.

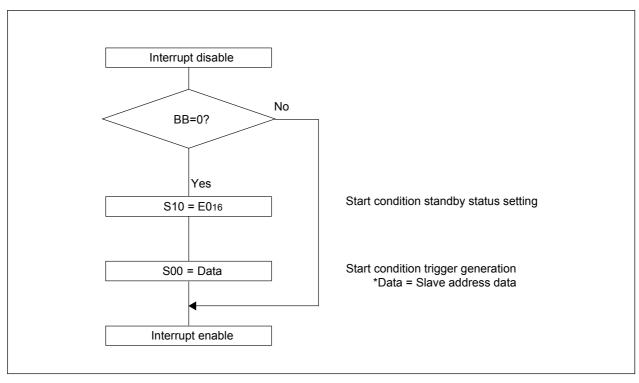


Figure 16.14 Start condition generation flow chart

16.10 START Condition Duplicate Protect Function

A START condition is generated when verifying that the BB flag in the S10 register does not use buses. However, if the BB flag is set to 1 (bus busy) by the START condition which other master device generates immediately after the BB flag is verified, the START condition is suspended by the START condition duplicate protect function. When the START condition duplicate protect function starts, it operates as follows:

- •Disable the start condition standby setting
 If the function has already been set, first exit START condition standby mode and then set bits MST and TRX in the S10 register to 0.
- •Writing to the S00 register is disabled. (The START condition trigger generation is disabled)
- •If the START condition generation is interrupted, the AL flag in the S10 register becomes 1.(arbitration lost detection)

The START condition duplicate protect function is valid between the SDA falling edge of the START condition and the receive completion of the slave address. **Figure16.15** shows the duration of the START condition duplicate protect function.

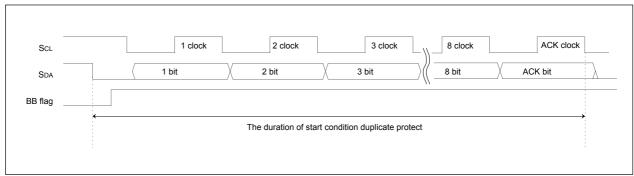


Figure 16.15 The duration of the start condition duplicate protect function

16.11 STOP Condition Generation Method

When the ES0 bit in the S1D0 register is set to 1 (I²C bus interface enabled) and bits MST and TRX in the S10 register are set to 1 at the same time, set the BB flag, PIN bit and 4 low-order bits in the S10 register to 0 simultaneously, to enter STOP condition standby mode. When dummy data is written to the S00 register next, the STOP condition is generated. The STOP condition generation timing varies between standard clock mode and high-speed clock mode. See **Figure 16.17** and **Table 16.8**.

Until the BB flag in the S10 register becomes 0 (bus free) after an instruction to generate the STOP condition is executed, do not write data to registers S10 and S00. Otherwise, the STOP condition waveform may not be generated correctly.

If an input signal level of the ScL pin is set to low ("L") after the instruction to generate the STOP condition is executed, a signal level of the ScL pin becomes high ("H"), and the BB flag is set to 0 (bus free), the MCU outputs an "L" signal to ScL pin.

In that case, the MCU can stop an "L" signal output to the ScL pin by generating the STOP condition, writing 0 to the ES0 bit in the S1D0 register (disabled), or writing 1 to the IHR bit in the S1D0 register (reset release).



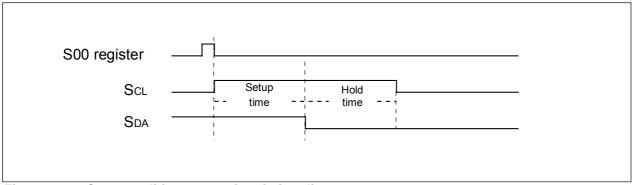


Figure 16.16 Start condition generation timing diagram

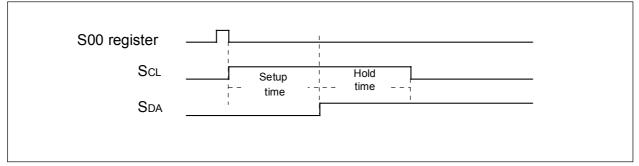


Figure 16.17 Stop condition generation timing diagram

Table 16.8 Start/Stop generation timing table

	Start/Stop Condition Generation Select Bit	Standard Clock Mode	High-speed Clock Mode
Setup time	0	5.0 μs (20 cycles)	2.5 μs (10 cycles)
	1	13.0 μs (52 cycles)	6.5 μs (26 cycles)
Hold time	0	5.0 μs (20 cycles)	2.5 μs (10 cycles)
	1	13.0 μs (52 cycles)	6.5 μs (26 cycles)

N OTE:

As mentioned above, when bits MST and TRX are set to 1, START condition or STOP condition mode is entered by writing 1 or 0 to the BB flag in the S10 register and writing 0 to the PIN bit and 4 low-order bits in the S10 register at the same time. Then SDAMM is left open in the START condition standby mode and SDAMM is set to low-level ("L") in the STOP condition standby mode. When the S00 register is set, the START/STOP conditions are generated. In order to set bits MST and TRX to 1 without generating the START/STOP conditions, write 1 to the 4 low-order bits simultaneously. **Table 16.9** lists functions along with the S10 register settings.

Table 16.9 S10 Register Settings and Functions

	S10 Register Settings						Function	
MST	TRX	BB	PIN	AL	AAS	AS0	LRB	T unction
1	1	1	0	0	0	0	0	Setting up the START condition stand by in master transmit mode
1	1	0	0	0	0	0	0	Setting up the STOP condition stand by in master transmit mode
0/1	0/1	-	0	1	1	1	1	Setting up each communication mode (refer to 16.5 I²C status register)



^{1.} Actual time at the time of VIIC = 4MHz, The contents in () denote cycle numbers.

16.12 START/STOP Condition Detect Operation

Figure 16.18, Figure 16.19 and Table 16.10 show START/STOP condition detect operations. Bits SSC4 to SSC0 in the S2D0 register set the START/STOP conditions. The START/STOP condition can be detected only when the input signal of the SCLMM and SDAMM met the following conditions: the SCL release time, the set-up time, and the hold time (see Table 16.10). The BB flag in the S10 register is set to 1 when the START condition is detected and it is set to 0 when the STOP condition is detected. The BB flag set and reset timing varies between standard clock mode and high-speed clock mode. See Table 16.10.

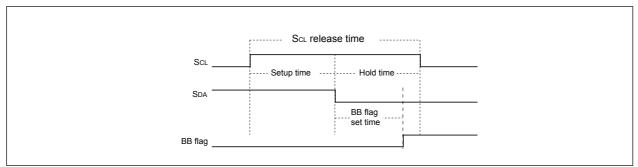


Figure 16.18 Start condition detection timing diagram

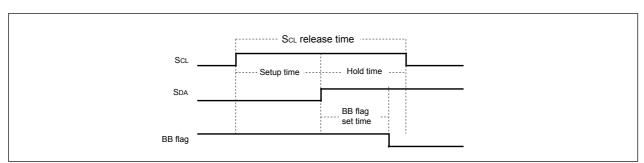


Figure 16.19 Stop condition detection timing diagram

Table 16.10	Start/Stop	detection	timing	table
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	Standard clock mode	High-speed clock mode
SCL release time	SSC value + 1 cycle (6.25μs)	4 cycles (1.0μs)
Setup time	SSC value + 1 cycle < 4.0μs (3.25μs)	2 cycles (0.5μs)
Hold time	$\frac{\text{SSC value}}{2} \text{cycle} < 4.0 \mu \text{s} (3.0 \mu \text{s})$	2 cycles (0.5μs)
BB flag set/reset time	SSC value - 1 +2 cycles (3.375μs)	3.5 cycles (0.875μs)

NOTE:

1. Unit: number of cycle for I²C system clock VIIC

The SSC value is the decimal notation value of bits SSC4 to SSC0. Do not set 0 or odd numbers to the SSC setting. The values in () are examples when the S2D0 register is set to 1816 at VIIC = 4 MHz.



16.13 Address Data Communication

This section describes data transmit control when a master transferes data or a slave receives data in 7-bit address format. **Figure 16.20 (1)** shows a master transmit format.

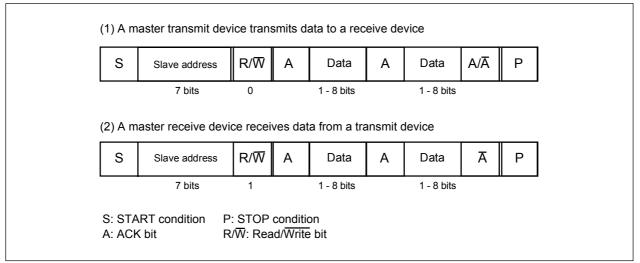


Figure 16.20 Address data communication format

16.13.1 Example of Master Transmit

For example, a master transmits data as shown below when following conditions are met: standard clock mode, SCL clock frequency of 100kHz and ACK clock added.

- 1) Set s slave address to the 7 high-order bits in the S0D0 register
- 2) Set 8516 to the S20 register, 0002 to bits ICK4 to ICK2 in the S4D0 register and 0016 to the S3D0 registe to generate an ACK clock and set SCL clock frequency t 100 kHz (f1=8MHz, filc=f1)
- 3) Set 0016 to the S10 register to reset transmit/receive
- 4) Set 0816 to the S1D0 register to enable data communication
- 5) Confirm whether the bus is free by BB flag setting in the S10 register
- 6) Set E016 to the S10 register to enter START condition standby mode
- 7) Set the destination address in 7 high-order bits and 0 to a least significant bit in the S00 register to generate START condition. At this time, the first byte consisting of SCL and ACK clock are automatically generated
- 8) Set a transmit data to the S00 register. At this time, SCL and an ACK clock are automatically generated
- 9) When transmitting more than 1-byte control data, repeat the above step 8).
- 10) Set C016 in the S10 register to enter STOP condition standby mode if ACK is not returned from the slave receiver or if the transmit is completed
- 11) Write dummy data to the S00 regiser to generate STOP condition



16.13.2 Example of Slave Receive

For example, a slave receives data as shown below when following conditions are met: high-speed clock mode, SCL frequency of 400 kHz, ACK clock added and addressing format.

- 1) Set a slave address in the 7 high-order bits in the S0D0 register
- 2) Set A516 to the S20 register, 0002 to bits ICK4 to ICK2 in the S4D0 register, and 0016 to the S3D0 register to generate an ACK clock and set SCL clock frequency at 400kHz (f1 = 8 MHz, filc = f1)
- 3) Set 0016 to the S10 register to reset transmit/receive mode
- 4) Set 0816 to the S1D0 register to enable data communication
- 5) When a START condition is received, addresses are compared
- 6) •When the transmitted addresses are all 0 (general call), the ADR0 bit in the S10 register is set to 1 and an I²C bus interface interrupt request signal is generated.
 - •When the transmitted addresses match with the address set in 1), the ASS bit in the S10 register is set to 1 and an I²C bus interface interrupt request signal is generated.
 - •In other cases, bits ADR0 and AAS are set to 0 and I²C bus interface interrupt request signal is not generated.
- 7) Write dummy data to the S00 register.
- 8) After receiving 1-byte data, an ACK-CLK bit is automatically returned and an I²C bus interface interrupt request signal is generated.
- 9) To determine whether the ACK should be returned depending on contents in the received data, set dummy data to the S00 register to receive data after setting the WIT bit in te S3D0 register to 1 (enable the I²C bus interface interrupt of data receive completion). Because the I²C bus interface interrupt is generated when the 1-byte data is received, set the ACKBIT bit to 1 or 0 to output a signal from the ACKBIT bit.
- 10) When receiving more than 1-byte control data, repeat steps 7) and 8) or 7) and 9).
- 11) When a STOP condition is detected, the communication is ended.



16.14 Precautions

(1) Access to the registers of I²C bus interface circuit

The following is precautions when read or write the control registers of I²C bus interface circuit

•S00 register

Do not rewrite the S00 register during data transfer. If the bits in the S00 register are rewritten, the bit counter for transfer is reset and data may not be transferred successfully.

S1D0 register

Bits BC2 o BC0 are set to 0002 when START condition is detected or when 1-byte data transfer is completed. Do not read or write the S1D0 register at this timing. Otherwise, data may be read or written unsuccessfully. **Figure 16.22** and **Figure 16.23** show the bit counter reset timing.

•S20 register

Do not rewrite the S20 register except the ACKBIT bit during transfer. If the bits in the S20 register except ACKBIT bit are rewritten, the I²C bus clock circuit is reset and data may be transferred incompletely.

•S3D0 register

Rewrite bits ICK4 to ICK0 in the S3D0 register when the ES0 bit in the S1D0 register is set to 0 (I²C bus interface is disabled). When the WIT bit is read, the internal WAIT flag is read. Therefore, do not use the bit managing instruction(read-modify-write instruction) to access the S3D0 register.

S10 register

Do not use the bit managing instruction (read-modify-write instruction) because all bits in the S10 register will be changed, depending on the communication conditions. Do not read/write when te communication mode select bits, bits MST and TRX, are changing their value. Otherwise, data may be read or written unsuccessfully. **Figure16.21** to **Figure 16.23** show the timing when bits MST and TRX change.



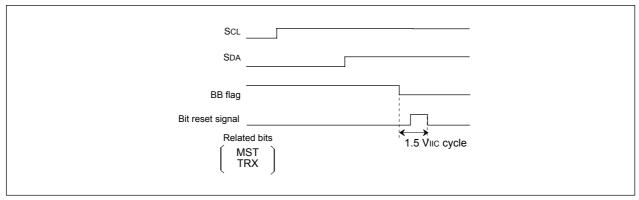


Figure 16.21 The bit reset timing (The STOP condition detection)

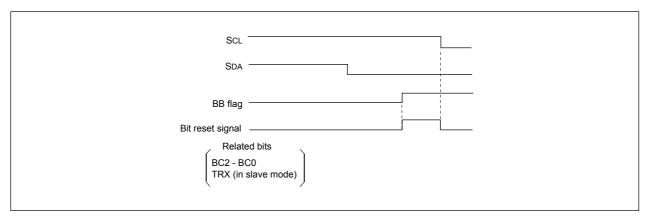


Figure 16.22 The bit reset timing (The START condition detection)

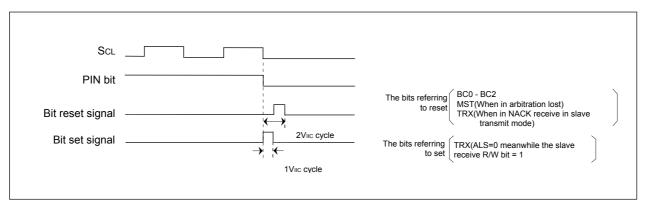


Figure 16.23 Bit set/reset timing (at the completion of data transfer)

(2) Generation of RESTART condition

In order to generate a RESTART condition after 1-byte data transfer, write E016 to the S10 register, enter START condition standby mode and leave the SDAMM open. Generate a START condition trigger by setting the S00 register after inserting a sufficient software wait until the SDAMM outputs a high-level ("H") signal. **Figure 16.24** shows the RESTART condition generation timing.

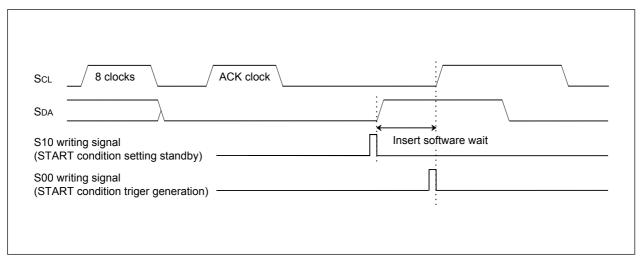


Figure 16.24 The time of generation of RESTART condition

(3) limitation of CPU clock

When the CM07 bit in the CM0 register is set to 1 (subclock), each register of the I²C bus interface circuit cannot be read or written. Read or write data when the CM07 bit is set to 0 (main clock, PLL clock, or on-chip oscillator clock).

17. CAN Module M16C/29 Group

17. CAN Module

The CAN (Controller Area Network) module for the M16C/29 Group of MCUs is a communication controller implementing the CAN 2.0B protocol. The M16C/29 Group contains one CAN module which can transmit and receive messages in both standard (11-bit) ID and extended (29-bit) ID formats.

Figure 17.1 shows a block diagram of the CAN module.

External CAN bus driver and receiver are required.

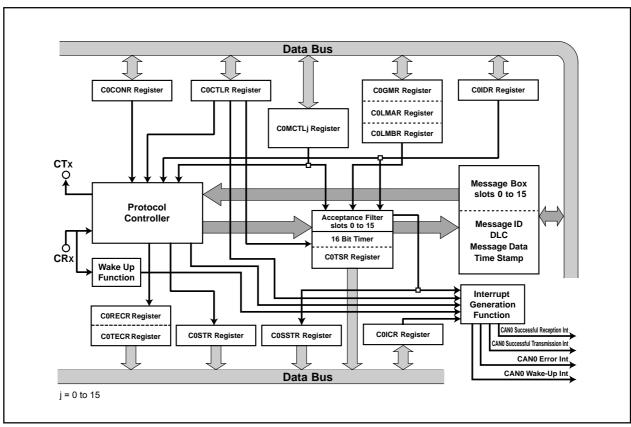


Figure 17.1 Block Diagram of CAN Module

CTx/CRx: CAN I/O pins.

Protocol controller: This controller handles the bus arbitration and the CAN protocol services, i.e. bit

timing, stuffing, error status etc.

Message box: This memory block consists of 16 slots that can be configured either as transmitter

or receiver. Each slot contains an individual ID, data length code, a data field

(8 bytes) and a time stamp.

Acceptance filter: This block performs filtering operation for received messages. For the filtering

operation, the C0GMR register, the C0LMAR register, or the C0LMBR register is

used.

16 bit timer: Used for the time stamp function. When the received message is stored in the

message memory, the timer value is stored as a time stamp.

Wake-up function: CAN0 wake-up interrupt request is generated by a message from the CAN bus.

Interrupt generation function: The interrupt requests are generated by the CAN module. CAN0 successful

reception interrupt, CAN0 successful transmission interrupt, CAN0 error interrupt

and CAN0 wake-up interrupt.

17.1 CAN Module-Related Registers

The CAN0 module has the following registers.

(1) CAN Message Box

A CAN module is equipped with 16 slots (16 bytes or 8 words each). Slots 14 and 15 can be used as Basic CAN.

- Priority of the slots: The smaller the number of the slot, the higher the priority, in both transmission and reception.
- A program can define whether a slot is defined as transmitter or receiver.

(2) Acceptance Mask Registers

A CAN module is equipped with 3 masks for the acceptance filter.

- CAN0 global mask register (C0GMR register: 6 bytes)
 Configuration of the masking condition for acceptance filtering processing to slots 0 to 13
- CAN0 local mask A register (C0LMAR register: 6 bytes)
 Configuration of the masking condition for acceptance filtering processing to slot 14
- CAN0 local mask B register (C0LMBR register: 6 bytes)
 Configuration of the masking condition for acceptance filtering processing to slot 15

(3) CAN SFR Registers

- CAN0 message control register j (C0MCTLj register: 8 bits X 16) (j = 0 to 15)
 Control of transmission and reception of a corresponding slot
- CANi control register (CiCTLR register: 16 bits) (i = 0, 1)
 Control of the CAN protocol
- CAN0 status register (C0STR register: 16 bits)
 Indication of the protocol status
- CANO slot status register (COSSTR register: 16 bits) Indication of the status of contents of each slot
- CAN0 interrupt control register (C0ICR register: 16 bits)
 Selection of "interrupt enabled or disabled" for each slot
- CAN0 extended ID register (C0IDR register: 16 bits)
 Selection of ID format (standard or extended) for each slot
- CAN0 configuration register (C0CONR register: 16 bits)
 Configuration of the bus timing
- CAN0 receive error count register (C0RECR register: 8 bits)
 Indication of the error status of the CAN module in reception: the counter value is incremented or decremented according to the error occurrence.
- CAN0 transmit error count register (C0TECR register: 8 bits)
 Indication of the error status of the CAN module in transmission: the counter value is incremented or decremented according to the error occurrence.
- CAN0 time stamp register (C0TSR register: 16 bits)
 Indication of the value of the time stamp counter
- CAN0 acceptance filter support register (C0AFS register: 16 bits)
 Decoding the received ID for use by the acceptance filter support unit

Explanation of each register is given as follows.



17.1.1 CANO Message Box

Table 17.1 shows the memory mapping of the CAN0 message box.

It is possible to access to the message box in byte or word.

Mapping of the message contents differs from byte access to word access. Byte access or word access can be selected by the MsgOrder bit of the C0CTLR register.

Table 17.1 Memory Mapping of CAN0 Message Box

Address	Message content (Memory mapping)		
Address	Byte access (8 bits)	Word access (16 bits)	
0060 ₁₆ + n • 16 + 0	SID ₁₀ to SID ₆	SID₅ to SID₀	
0060 ₁₆ + n • 16 + 1	SID₅ to SID₀	SID ₁₀ to SID ₆	
0060 ₁₆ + n • 16 + 2	EID ₁₇ to EID ₁₄	EID13 to EID6	
0060 ₁₆ + n • 16 + 3	EID ₁₃ to EID ₆	EID17 to EID14	
0060 ₁₆ + n • 16 + 4	EID₅ to EID₀	Data Length Code (DLC)	
0060 ₁₆ + n • 16 + 5	Data Length Code (DLC)	EID₅ to EID₀	
0060 ₁₆ + n • 16 + 6	Data byte 0	Data byte 1	
0060 ₁₆ + n • 16 + 7	Data byte 1	Data byte 0	
:	:	:	
0060 ₁₆ + n • 16 + 13	Data byte 7	Data byte 6	
0060 ₁₆ + n • 16 + 14	Time stamp high-order byte	Time stamp low-order byte	
0060 ₁₆ + n • 16 + 15	Time stamp low-order byte	Time stamp high-order byte	

n = 0 to 15: the number of the slot

Figures 17.2 and **17.3** show the bit mapping in each slot in byte access and word access. The content of each slot remains unchanged unless transmission or reception of a new message is performed.

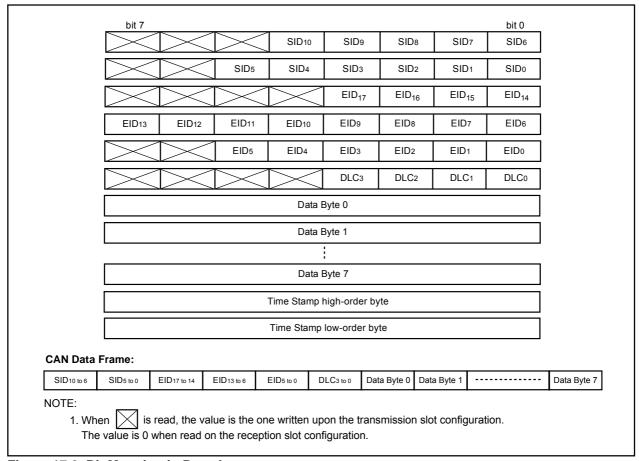


Figure 17.2 Bit Mapping in Byte Access

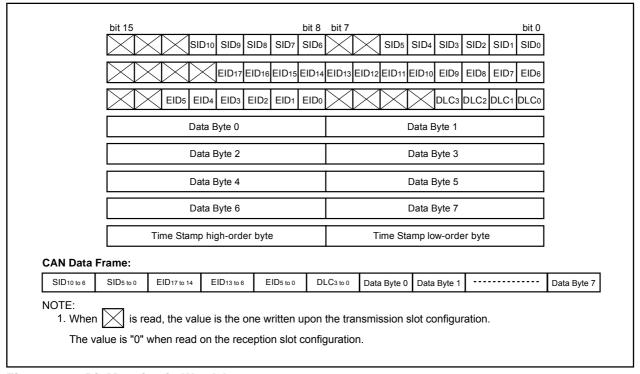


Figure 17.3 Bit Mapping in Word Access

17.1.2 Acceptance Mask Registers

Figures 17.4 and **17.5** show the C0GMR register, the C0LMAR register, and the C0LMBR register, in which bit mapping in byte access and word access are shown.

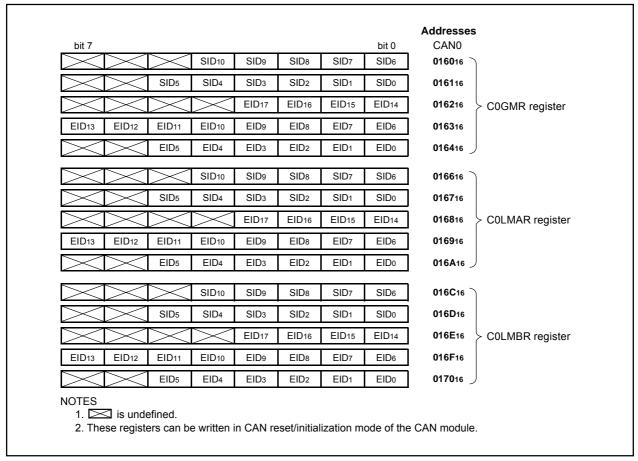


Figure 17.4 Bit Mapping of Mask Registers in Byte Access

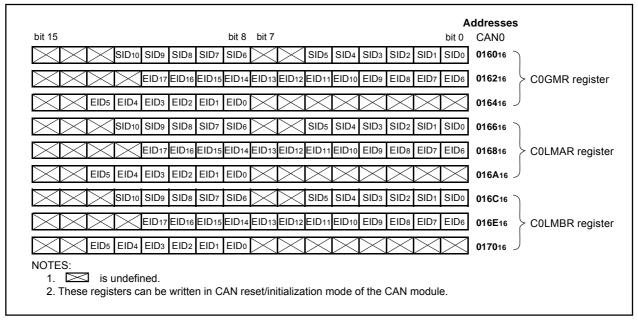


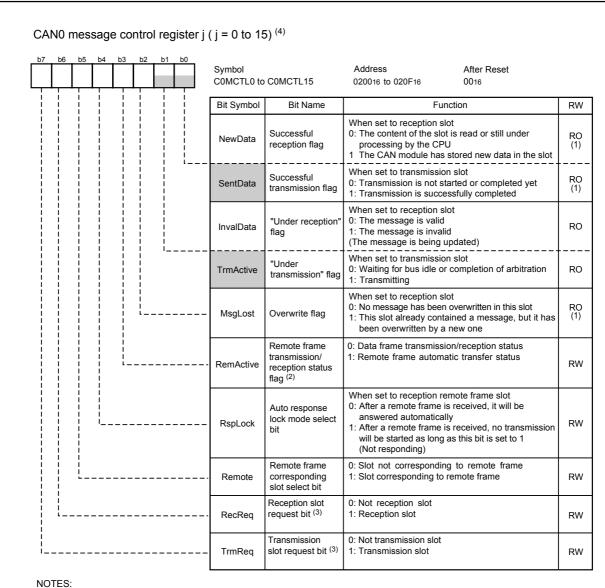
Figure 17.5 Bit Mapping of Mask Registers in Word Access

17. CAN Module M16C/29 Group

17.1.3 CAN SFR Registers

17.1.3.1 COMCTLj Register (j = 0 to 15)

Figure 17.6 shows the C0MCTLj register.

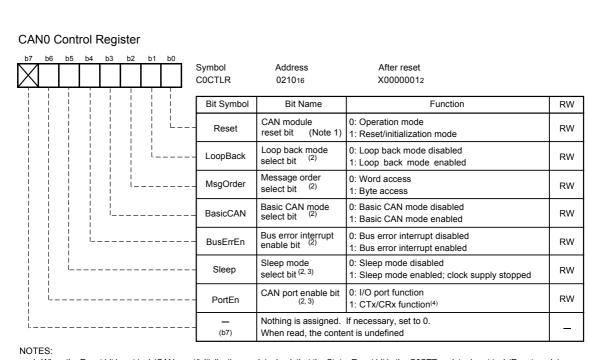


- 1. As for write, only writing 0 is possible. The value of each bit is written when the CAN module enters the respective state.
- 2. In Basic CAN mode, the slots 14 and 15 serve as data format identification flag. If the data frame is received, the RemActive bit is set to 0. If the remote frame is received, the bit is set to 1.
- 3. One slot cannot be defined as reception slot and transmission slot at the same time.
- 4. Set these registers only when the CAN module is in CAN operating mode.

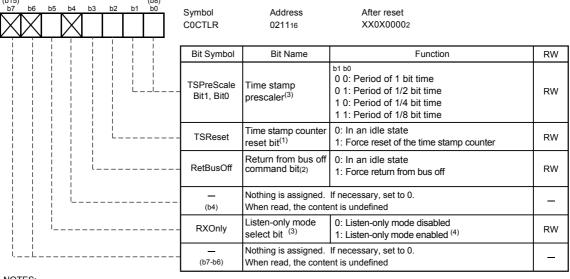
Figure 17.6 C0MCTLj Register

17.1.3.2 C0CTLR Register

Figure 17.7 shows the COCTLR register.



- 1. When the Reset bit is set to 1 (CAN reset/initialization mode), check that the State_Reset bit in the COSTR register is set to 1 (Reset mode).
- 2. Change this bit only in the CAN reset/initialization mode.
- 3. When using CAN0 wake-up interrupt, set these bits to 1.
- 4. When the PortEn bit is set to 1, set the PD9_2 bit in the PD9 register to 0.



NOTES:

- $1. When the \, TSReset \, bit \, is \, set \, to \, 1, \, the \, COTSR \, register \, is \, set \, to \, 0000_{16}. \, \, After \, this, \, the \, bit \, is \, automatically \, set \, to \, 0.000_{16}. \, \, according to \, 1.000_{16}. \, accor$
- 2. When the RetBusOff bit is set to 1, registers CORECR and COTECR are set to 0016. After this, the bit is automatically set to 0.
- 3. Change this bit only in the CAN reset/initialization mode.
- 4. When the listen-only mode is selected, do not request the transmission.

Figure 17.7 C0CTLR Register

17.1.3.3 COSTR Register

Figure 17.8 shows the COSTR register.

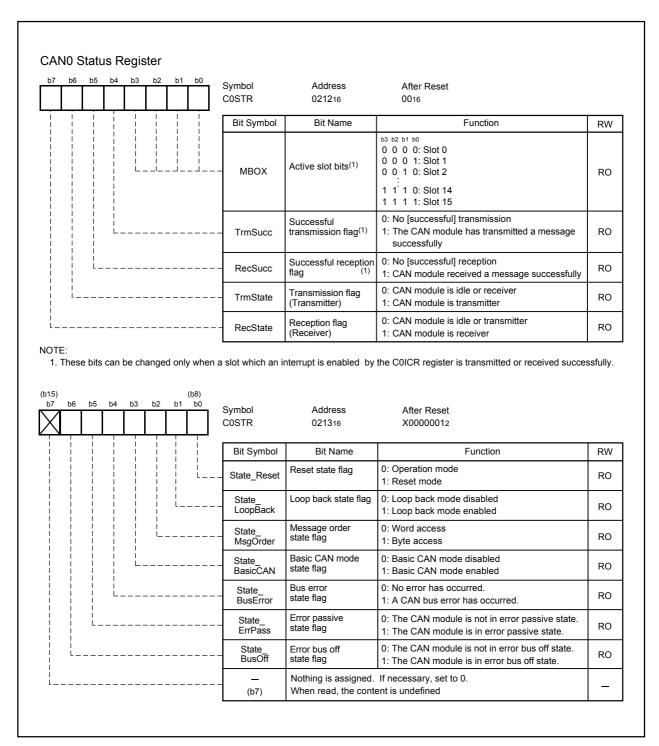


Figure 17.8 COSTR Register

17.1.3.4 COSSTR Register

Figure 17.9 shows the COSSTR register.

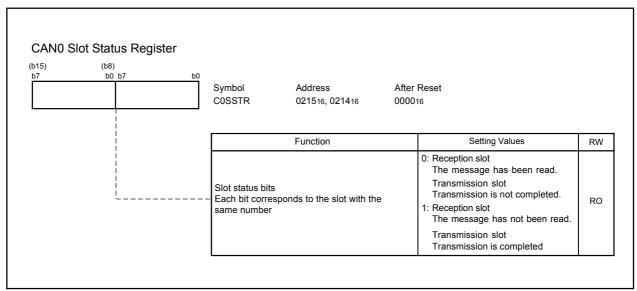


Figure 17.9 COSSTR Register

17.1.3.5 COICR Register

Figure 17.10 shows the COICR register.

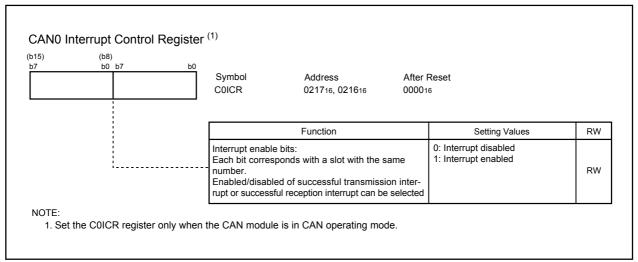


Figure 17.10 C0ICR Register

17.1.3.6 COIDR Register

Figure 17.11 shows the C0IDR register.

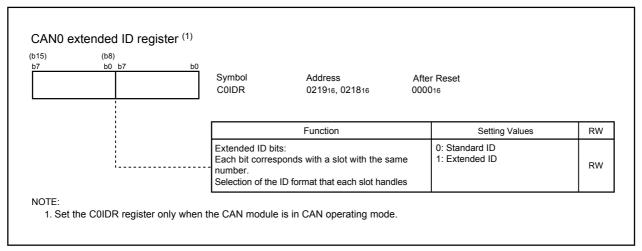


Figure 17.11 C0IDR Register

17.1.3.7 C0CONR Register

Figure 17.12 shows the COCONR register.

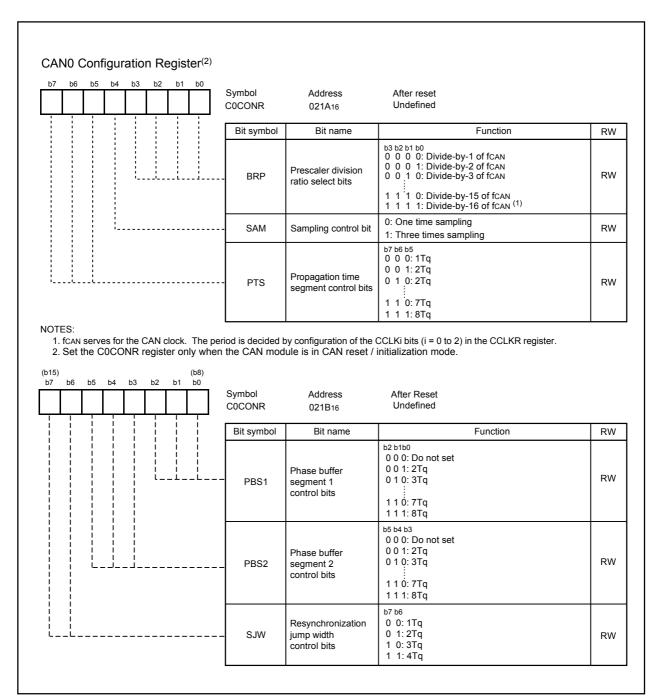


Figure 17.12 C0CONR Register

17.1.3.8 CORECR Register

Figure 17.13 shows the CORECR register.

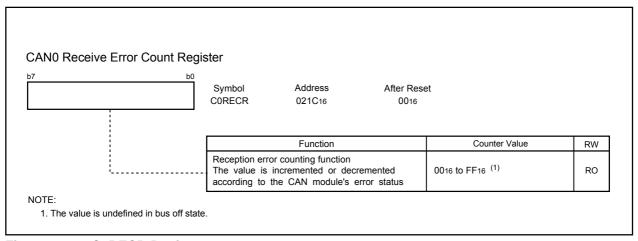


Figure 17.13 CORECR Register

17.1.3.9 COTECR Register

Figure 17.14 shows the C0TECR register.

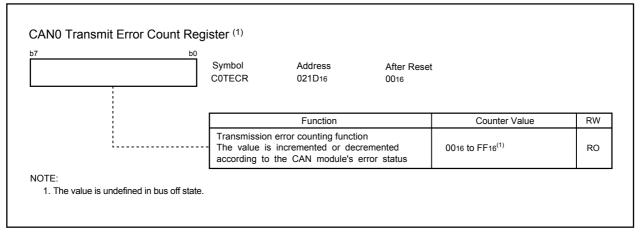


Figure 17.14 C0TECR Register

17.1.3.10 C0TSR Register

Figure 17.15 shows the C0TSR register.

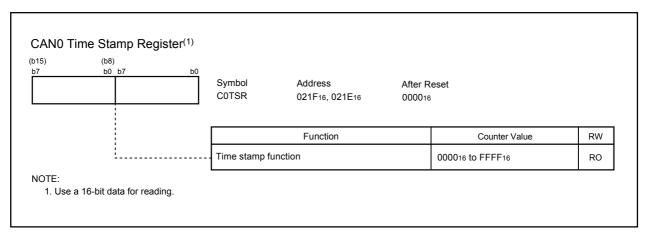


Figure 17.15 C0TSR Register

17.1.3.11 COAFS Register

Figure 17.16 shows the COAFS register.

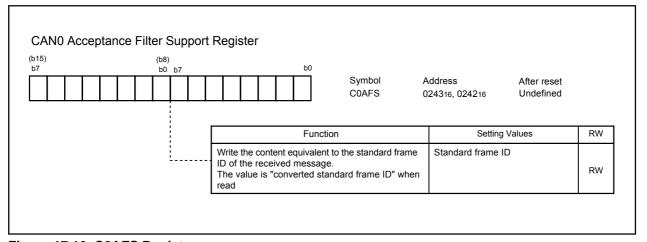


Figure 17.16 C0AFS Register

17.2 Operating Modes

The CAN module has the following four operating modes.

- CAN Reset/Initialization Mode
- CAN Operating Mode
- CAN Sleep Mode
- CAN Interface Sleep Mode

Figure 17.17 shows transition between operating modes.

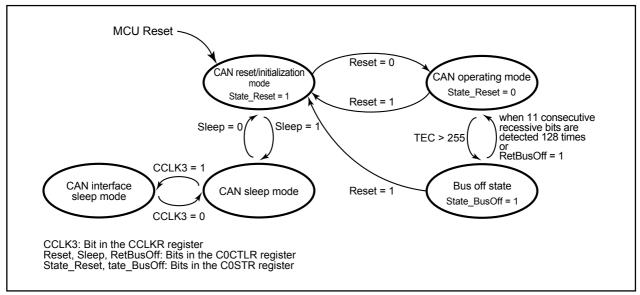


Figure 17.17 Transition Between Operating Modes

17.2.1 CAN Reset/Initialization Mode

The CAN reset/initialization mode is activated upon MCU reset or by setting the Reset bit in the C0CTLR register to 1. If the Reset bit is set to 1, check that the State_Reset bit in the C0STR register is set to 1. Entering the CAN reset/initialization mode initiates the following functions by the module:

- CAN communication is impossible.
- When the CAN reset/initialization mode is activated during an ongoing transmission in operation mode, the module suspends the mode transition until completion of the transmission (successful, arbitration loss, or error detection). Then, the State_Reset bit is set to 1, and the CAN reset/ initialization mode is activated.
- Registers C0MCTLj (j = 0 to 15), C0STR, C0ICR, C0IDR, C0RECR, C0TECR, and C0TSR are initialized. All these registers are locked to prevent CPU modification.
- Registers C0CTLR, C0CONR, C0GMR, C0LMAR, and C0LMBR and the CAN0 message box retain their contents and are available for CPU access.

17.2.2 CAN Operating Mode

The CAN operating mode is activated by setting the Reset bit in the C0CTLR register to 0. If the Reset bit is set to 0, check that the State_Reset bit in the C0STR register is set to 0.

If 11 consecutive recessive bits are detected after entering the CAN operating mode, the module initiates the following functions:

- The module's communication functions are released and it becomes an active node on the network and may transmit and receive CAN messages.
- Release the internal fault confinement logic including receive and transmit error counters. The module may leave the CAN operating mode depending on the error counts.

Within the CAN operating mode, the module may be in three different sub modes, depending on which type of communication functions are performed:

- Module idle : The modules receive and transmit sections are inactive.
- Module receives : The module receives a CAN message sent by another node.
- Module transmits : The module transmits a CAN message. The module may receive its own
 message simultaneously when the LoopBack bit in the C0CTLR register = 1
 (Loop back mode enabled).

Figure 17.18 shows sub modes of the CAN operating mode.

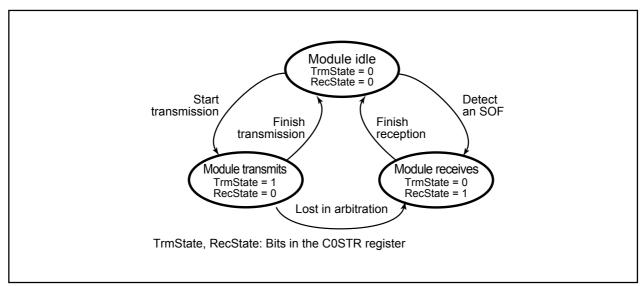


Figure 17.18 Sub Modes of CAN Operating Mode

17.2.3 CAN Sleep Mode

The CAN sleep mode is activated by setting the Sleep bit in the COCTLR register to 1. It should never be activated from the CAN operating mode but only via the CAN reset/initialization mode.

Entering the CAN sleep mode instantly stops the clock supply to the module and thereby reduces power dissipation.

17.2.4 CAN Interface Sleep Mode

The CAN interface sleep mode is activated by setting the CCLK3 bit in the CCLKR register to 1. It should never be activated but only via the CAN sleep mode.

Entering the CAN interface sleep mode instantly stops the clock supply to the CPU Interface in the module and thereby reduces power dissipation.

17.2.5 Bus Off State

The bus off state is entered according to the fault confinement rules of the CAN specification. When returning to the CAN operating mode from the bus off state, the module has the following two cases. In this time, the value of any CAN registers, except registers COSTR, CORECR, and COTECR, does not change.

- (1) When 11 consecutive recessive bits are detected 128 times The module enters instantly into error active state and the CAN communication becomes possible immediately.
- (2) When the RetBusOff bit in the COCTLR register = 1 (Force return from buss off)

 The module enters instantly into error active state, and the CAN communication becomes possible again after 11 consecutive recessive bits are detected.

17.3 Configuration of the CAN Module System Clock

The M16C/29 Group has a CAN module system clock select circuit.

Configuration of the CAN module system clock can be done through manipulating the CCLKR register and the BRP bit in the C0CONR register.

For the CCLKR register, refer to 7. Clock Generation Circuit.

Figure 17.19 shows a block diagram of the clock generation circuit of the CAN module system.

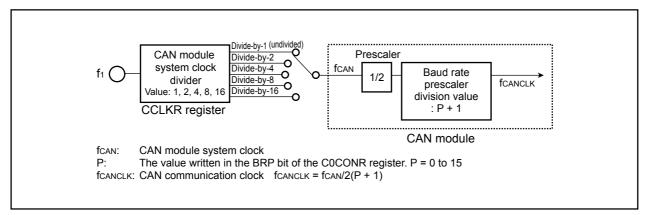


Figure 17.19 Block Diagram of CAN Module System Clock Generation Circuit

17.3.1 Bit Timing Configuration

The bit time consists of the following four segments:

- Synchronization segment (SS)
 This serves for monitoring a falling edge for synchronization.
- Propagation time segment (PTS)
 This segment absorbs physical delay on the CAN network which amounts to double the total sum of delay on the CAN bus, the input comparator delay, and the output driver delay.
- Phase buffer segment 1 (PBS1)
 This serves for compensating the phase error. When the falling edge of the bit falls later than expected, the segment can become longer by the maximum of the value defined in SJW.
- Phase buffer segment 2 (PBS2)
 This segment has the same function as the phase buffer segment 1. When the falling edge of the bit falls earlier than expected, the segment can become shorter by the maximum of the value defined in SJW.

Figure 17.20 shows the bit timing.

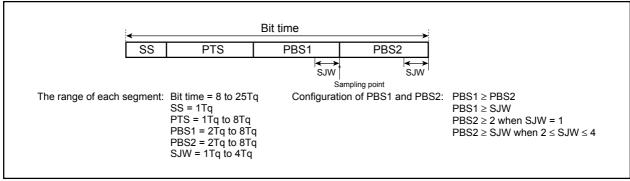


Figure 17.20 Bit Timing

17.3.2 Bit-rate

Bit-rate depends on f1, the division value of the CAN module system clock, the division value of the baud rate prescaler, and the number of Tq of one bit.

Table 17.2 shows the examples of bit-rate.

Table 17.2 Examples of Bit-rate

Bit-rate	20MHz	16MHz	10MHz	8MHz
1Mbps	10Tq (1)	8Tq (1)	_	_
500kbps	10Tq (2)	8Tq (2)	10Tq (1)	8Tq (1)
	20Tq (1)	16Tq (1)	_	_
125kbps	10Tq (8)	8Tq (8)	10Tq (4)	8Tq (4)
	20Tq (4)	16Tq (4)	20Tq (2)	16Tq (2)
83.3kbps	10Tq (12)	8Tq (12)	10Tq (6)	8Tq (6)
	20Tq (6)	16Tq (6)	20Tq (3)	16Tq (3)
33.3kbps	10Tq (30)	8Tq (30)	10Tq (15)	8Tq (15)
	20Tq (15)	16Tq (15)	_	_

NOTE:

1. The number in () indicates a value of "fcan division value" multiplied by "baud rate prescaler division value".

■ Calculation of Bit-rate

 \mathbf{f}_1

2 X "fcan division value (Note 1)" X "baud rate prescaler division value (Note 2)" X "number of Tq of one bit"

Note 1: fcan division value = 1, 2, 4, 8, 16

fcan division value: a value selected in the CCLKR register

Note 2: Baud rate prescaler division value = P + 1 (P: 0 to 15)

P: a value selected in the BRP bit in the C0CONR register

17.4 Acceptance Filtering Function and Masking Function

These functions serve the users to select and receive a facultative message. The C0GMR register, the C0LMAR register, and the C0LMBR register can perform masking to the standard ID and the extended ID of 29 bits. The C0GMR register corresponds to slots 0 to 13, the C0LMAR register corresponds to slot 14, and the C0LMBR register corresponds to slot 15. The masking function becomes valid to 11 bits or 29 bits of a received ID according to the value in the corresponding slot of the C0IDR register upon acceptance filtering operation. When the masking function is employed, it is possible to receive a certain range of IDs. **Figure 17.21** shows correspondence of the mask registers and slots, **Figure 17.22** shows the acceptance function.

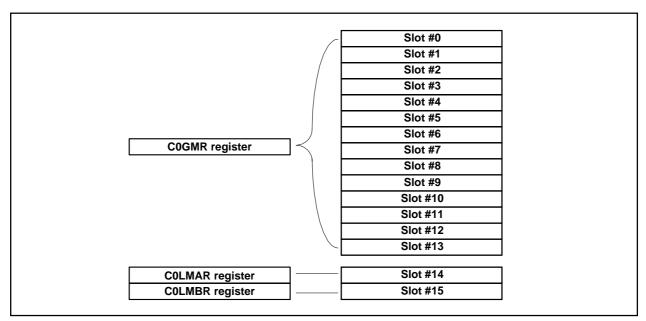


Figure 17.21 Correspondence of Mask Registers to Slots

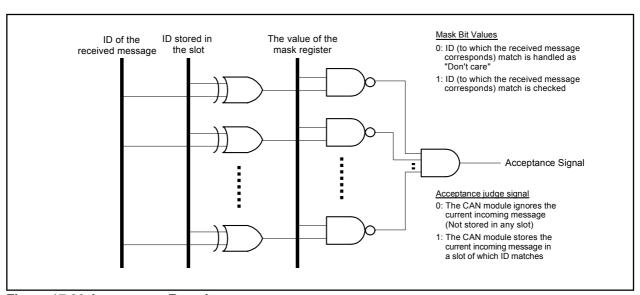


Figure 17.22 Acceptance Function

When using the acceptance function, note the following points.

- (1) When one ID is defined in two slots, the one with a smaller number alone is valid.
- (2) When it is configured that slots 14 and 15 receive all IDs with Basic CAN mode, slots 14 and 15 receive all IDs which are not stored into slots 0 to 13.

17.5 Acceptance Filter Support Unit (ASU)

The acceptance filter support unit has a function to judge valid/invalid of a received ID through table search. The IDs to receive are registered in the data table; a received ID is stored in the COAFS register, and table search is performed with a decoded received ID. The acceptance filter support unit can be used for the IDs of the standard frame only.

The acceptance filter support unit is valid in the following cases.

- When the ID to receive cannot be masked by the acceptance filter. (Example) IDs to receive: 07816, 08716, 11116
- When there are too many IDs to receive; it would take too much time to filter them by software.

Figure 17.23 shows the write and read of the C0AFS register in word access.

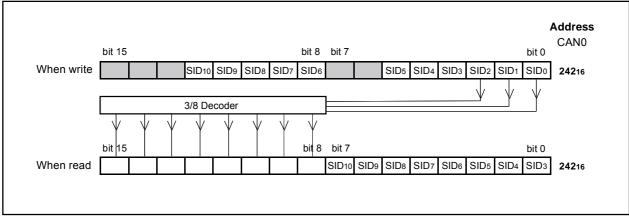


Figure 17.23 Write/read of COAFS Register in Word Access

17.6 BasicCAN Mode

When the BasicCAN bit in the C0CTLR register is set to 1 (Basic CAN mode enabled), slots 14 and 15 correspond to Basic CAN mode. During normal operations, individual slots can select either data frame or remote frame by CPU setting. However, in Basic CAN mode, both frames can be selected.

When slots 14 and 15 are defined as reception slots in Basic CAN mode, received messages are stored in slots 14 and 15 alternately.

The received message data format can be determined by the RemActive bit in the C0MCTLj register (j = 0 to 15).

Figure 17.24 shows the operation of slots 14 and 15 in Basic CAN mode.

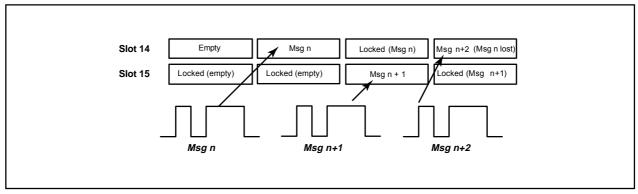


Figure 17.24 Operation of Slots 14 and 15 in Basic CAN Mode

When using Basic CAN mode, note the following points.

- (1) Setting of Basic CAN mode has to be done in CAN reset/initialization mode.
- (2) Select the same ID for slots 14 and 15. Also, setting of the C0LMAR and C0LMBR register has to be the same.
- (3) Define slots 14 and 15 as reception slot only.
- (4) There is no protection available against message overwrite. A message can be overwritten by a new message.
- (5) Slots 0 to 13 can be used in the same way as in normal CAN operating mode.

17.7 Return from Bus off Function

When the protocol controller enters bus off state, it is possible to make it forced return from bus off state by setting the RetBusOff bit in the COCTLR register to 1 (Force return from bus off). At this time, the error state changes from bus off state to error active state. If the RetBusOff bit is set to 1, registers CORECR and COTECR are initialized and the State_Reset bit in the COSTR register is set to 0 (The CAN module is not in error bus off state). However, registers of the CAN module such as COCONR register and the content of each slot are not initialized.

17.8 Time Stamp Counter and Time Stamp Function

When the COTSR register is read, the value of the time stamp counter at the moment is read. The period of the time stamp counter reference clock is the same as that of 1 bit time that is configured by the COCONR register. The time stamp counter functions as a free run counter.

The 1 bit time period can be divided by 1 (undivided), 2, 4 or 8 to produce the time stamp counter reference clock. Use the TSPreScale bit in the C0CTLR register to select the divide-by-n value.

The time stamp counter is equipped with a register that captures the counter value when the protocol controller regards it as a successful reception. The captured value is stored when a time stamp value is stored in a reception slot.

17.9 Listen-Only Mode

When the RXOnly bit in the C0CTLR register is set to 1, the module enters listen-only mode. In listen-only mode, no transmission -- data frames, error frames, and ACK response -- is performed to bus. When listen-only mode is selected, do not request the transmission.



17.10 Reception and Transmission

Configuration of CAN Reception and Transmission Mode

Table 17.3 shows configuration of CAN reception and transmission mode.

Table 17.3 Configuration of CAN Reception and Transmission Mode

TrmReq	RecReq	Remote	RspLock	Communication mode of the slot		
0	0	_	_	Communication environment configuration mode:		
				configure the communication mode of the slot.		
0	1	0	0	Configured as a reception slot for a data frame.		
1	0	1	0	Configured as a transmission slot for a remote frame. (At this time		
				the RemActive = 1.)		
				After completion of transmission, this functions as a reception slot		
				for a data frame. (At this time the RemActive = 0.)		
				However, when an ID that matches on the CAN bus is detected		
				pefore remote frame transmission, this immediately functions as		
				a reception slot for a data frame.		
1	0	0	0	Configured as a transmission slot for a data frame.		
0	1	1	1/0	Configured as a reception slot for a remote frame. (At this time		
				the RemActive = 1.)		
				After completion of reception, this functions as a transmission slot		
				for a data frame. (At this time the RemActive = 0.)		
				However, transmission does not start as long as RspLock bit		
				remains 1; thus no automatic response.		
				Response (transmission) starts when the RspLock bit is set to 0.		

TrmReg, RecReg, Remote, RspLock, RemActive, RspLock: Bits in the C0MCTLj register (j = 0 to 15)

When configuring a slot as a reception slot, note the following points.

- (1) Before configuring a slot as a reception slot, be sure to set the COMCTLj register (j = 0 to 15) to 00₁₆.
- (2) A received message is stored in a slot that matches the condition first according to the result of reception mode configuration and acceptance filtering operation. Upon deciding in which slot to store, the smaller the number of the slot is, the higher priority it has.
- (3) In normal CAN operating mode, when a CAN module transmits a message of which ID matches, the CAN module never receives the transmitted data. In loop back mode, however, the CAN module receives back the transmitted data. In this case, the module does not return ACK.

When configuring a slot as a transmission slot, note the following points.

- (1) Before configuring a slot as a transmission slot, be sure to set the C0MCTLj registers to 00₁₆.
- (2) Set the TrmReq bit in the C0MCTLj register to 0 (not transmission slot) before rewriting a transmission slot.
- (3) A transmission slot should not be rewritten when the TrmActive bit in the C0MCTLj register is 1 (transmitting).

If it is rewritten, an undefined data will be transmitted.



17.10.1 Reception

Figure 17.25 shows the behavior of the module when receiving two consecutive CAN messages, that fit into the slot of the shown C0MCTLj register (j = 0 to 15) and leads to losing/overwriting of the first message.

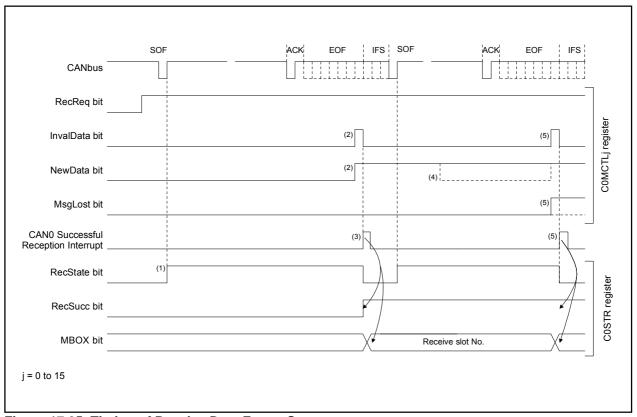


Figure 17.25 Timing of Receive Data Frame Sequence

- (1) On monitoring a SOF on the CAN bus the RecState bit in the COSTR register becomes 1 (CAN module is receiver) immediately, given the module has no transmission pending.
- (2) After successful reception of the message, the NewData bit in the C0MCTLj register (j = 0 to 15) of the receiving slot becomes 1 (stored new data in slot). The InvalData bit in the C0MCTLj register becomes 1 (message is being updated) at the same time and the InvalData bit becomes 0 (message is valid) again after the complete message was transferred to the slot.
- (3) When the interrupt enable bit in the C0ICR register of the receiving slot = 1 (interrupt enabled), the CAN0 successful reception interrupt request is generated and the MBOX bit in the C0STR register is changed. It shows the slot number where the message was stored and the RecSucc bit in the C0STR register is active.
- (4) Read the message out of the slot after setting the New Data bit to 0 (the content of the slot is read or still under processing by the CPU) by program.
- (5) If the NewData bit is set to 0 by program or the next CAN message is received successfully before the receive request for the slot is canceled, the MsgLost bit in the C0MCTLj register is set to 1 (message has been overwritten). The new received message is transferred to the slot. Generating of an interrupt request and change of the C0STR register are same as in 3).

17.10.2 Transmission

Figure 17.26 shows the timing of the transmit sequence.

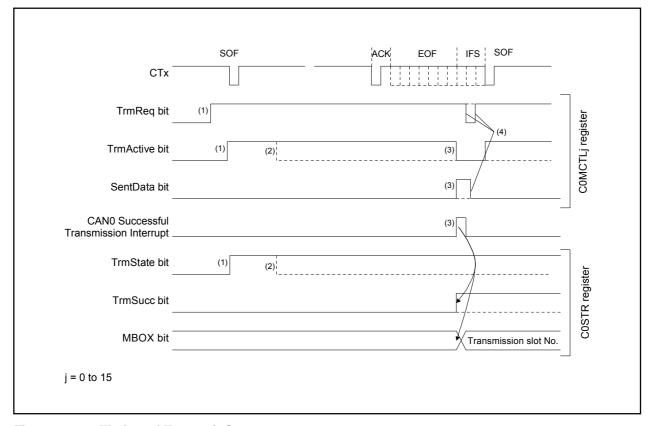


Figure 17.26 Timing of Transmit Sequence

- (1) If the TrmReq bit in the C0MCTLj register (j = 0 to 15) is set to 1 (Transmission slot) in the bus idle state, the TrmActive bit in the C0MCTLj register and the TrmState bit in the C0STR register are set to 1 (Transmitting/Transmitter), and CAN module starts the transmission.
- (2) If the arbitration is lost after the CAN module starts the transmission, the TrmActive and TrmState bits are set to 0.
- (3) If the transmission has been successful without lost in arbitration, the SentData bit in the C0MCTLj register is set to 1 (Transmission is successfully completed) and TrmActive bit in the C0MCTLj register is set to 0 (Waiting for bus idle or completion of arbitration). And when the interrupt enable bits in the C0ICR register = 1 (Interrupt enabled), CAN0 successful transmission interrupt request is generated and the MBOX (the slot number which transmitted the message) and TrmSucc bit in the C0STR register are changed.
- (4) When starting the next transmission, set bits SentData and TrmReq to 0. And set the TrmReq bit to 1 after checking that bits SentData and TrmReq are set to 0.

17.11 CAN Interrupts

The CAN module provides the following CAN interrupts.

- CAN0 Successful Reception Interrupt
- CANO Successful Transmission Interrupt
- CAN0 Error Interrupt

Error Passive State

Error BusOff State

Bus Error (this feature can be disabled separately)

• CAN0 Wake-up Interrupt

When the CPU detects the CAN0 successful reception/transmission interrupt request, the MBOX bit in the C0STR register must be read to determine which slot has generated the interrupt request.



18. CRC Calculation Circuit

The Cyclic Redundancy Check (CRC) calculation detects errors in blocks of data. The MCU uses a generator polynomial of CRC_CCITT ($X^{16} + X^{12} + X^5 + 1$) or CRC-16 ($X^{16} + X^{15} + X^2 + 1$) to generate CRC code.

The CRC code is a 16-bit code generated for a block of a given data length in multiples of bytes. The code is updated in the CRC data register everytime one byte of data is transferred to a CRC input register. The data register must be initialized before use. Generation of CRC code for one byte of data is completed in two machine cycles.

Figure 18.1 shows the block diagram of the CRC circuit. **Figure 18.2** shows the CRC-related registers. **Figure 18.3** shows the calculation example using the CRC_CCITT operation.

18.1 CRC Snoop

The CRC circuit includes the ability to snoop reads and writes to certain SFR addresses. This can be used to accumulate the CRC value on a stream of data without using extra bandwidth to explicitly write data into the CRCIN register. All SFR addresses after 002016 are subject to the CRC snoop. The CRC snoop is useful to snoop the writes to a UART TX buffer, or the reads from a UART RX buffer.

To snoop an SFR address, the target address is written to the CRC snoop Address Register (CRCSAR). The two most significant bits of this register enable snooping on reads or writes to the target address. If the target SFR is written to by the CPU or DMA, and the CRC snoop write bit is set (CRCSW=1), the CRC will latch the data into the CRCIN register. The new CRC code will be set in the CRCD register.

Similarly, if the target SFR is read by the CRC or DMA, and the CRC snoop read bit is set (CRCSR=1), the CRC will latch the data from the target into the CRCIN register and calculate the CRC.

The CRC circuit can only calculate CRC codes on data byte at a time. Therefore, if a target SFR is accessed in word (16 bit), only one low-order byte data is stored into the CRCIN register.

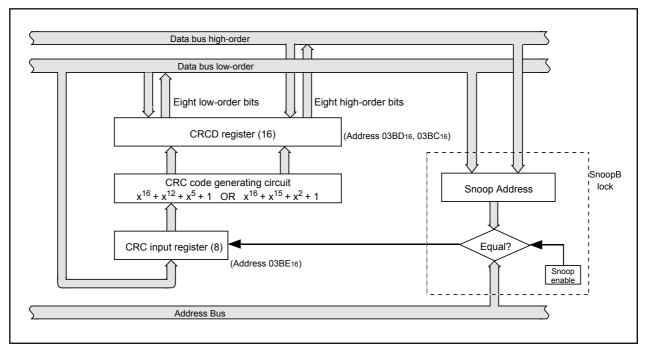


Figure 18.1 CRC circuit block diagram

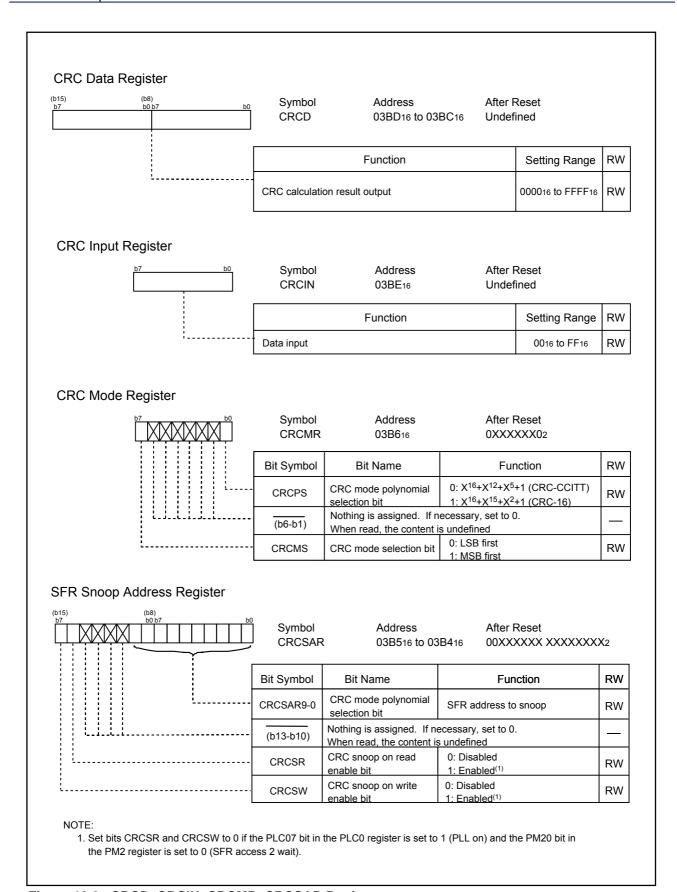


Figure 18.2. CRCD, CRCIN, CRCMR, CRCSAR Register

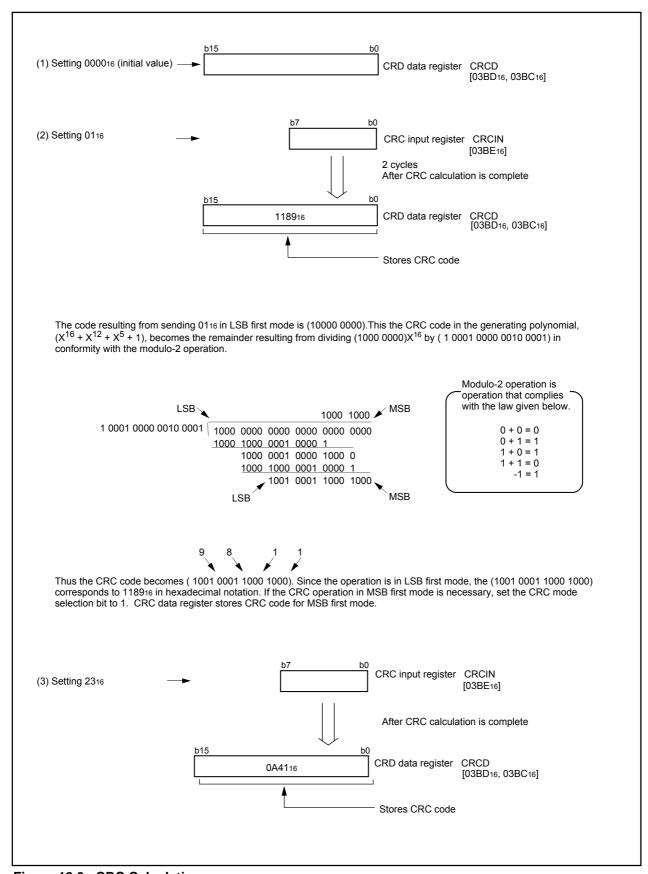


Figure 18.3. CRC Calculation

19. Programmable I/O Ports

Note

Ports P04 to P07, P10 to P14, P34 to P37 and P95 to P97 are not available in 64-pin package.

The programmable input/output ports (hereafter referred to simply as "I/O ports") consist of 71 lines P0, P1, P2, P3, P6, P7, P8, P9, P10 (except P94) for the 80-pin package, or 55 lines P00 to P03, P15 to P17, P2, P30 to P33, P6, P7, P8, P90 to P93, P10 for the 64-pin package. Each port can be set for input or output every line by using a direction register, and can also be chosen to be or not be pulled high in sets of 4 lines.

Figures 19.1 to 19.4 show the I/O ports. Figure 19.5 shows the I/O pins.

Each pin functions as an I/O port, a peripheral function input/output.

For details on how to set peripheral functions, refer to each functional description in this manual. If any pin is used as a peripheral function input, set the direction bit for that pin to 0 (input mode). Any pin used as an output pin for peripheral functions is directed for output no matter how the corresponding direction bit is set.

19.1 Port Pi Direction Register (PDi Register, i = 0 to 3, 6 to 10)

Figure 19.6 shows the direction registers.

This register selects whether the I/O port is to be used for input or output. The bits in this register correspond one for one to each port.

19.2 Port Pi Register (Pi Register, i = 0 to 3, 6 to 10)

Figure 19.7 shows the Pi registers.

Data input/output to and from external devices are accomplished by reading and writing to the Pi register. The Pi register consists of a port latch to hold the output data and a circuit to read the pin status. For ports set for input mode, the input level of the pin can be read by reading the corresponding Pi register, and data can be written to the port latch by writing to the Pi register.

For ports set for output mode, the port latch can be read by reading the corresponding Pi register, and data can be written to the port latch by writing to the Pi register. The data written to the port latch is output from the pin. The bits in the Pi register correspond one for one to each port.

19.3 Pull-up Control Register 0 to 2 (PUR0 to PUR2 Registers)

Figure 19.8 shows registers PUR0 to PUR2.

Registers PUR0 to PUR2 select whether the pins, divided into groups of four pins, are pulled up or not. The pins, selected by setting the bits in registers PUR0 to PUR2 to 1 (pull-up), are pulled up when the direction registers are set to 0 (input mode). The pins are pulled up regardless of the pins' function.

19.4 Port Control Register (PCR Register)

Figure 19.9 shows the port control register.

When the P1 register is read after setting the PCR0 bit in the PCR register to 1, the corresponding port latch can be read no matter how the PD1 register is set.



19.5 Pin Assignment Control Register (PACR)

Figure 19.10 shows the PACR register. After reset, set bits PACR2 to PACR0 in the PACR register before a signal is input or output to each pin. When bits PACR2 to PACR0 are not set, some pins do not function as I/O ports.

Bits PACR2 to PACR0: control pins to be used

Value after reset: 0002.

To select the 80-pin package, set the bits to 0112.

To select the 64-pin package, set the bits to 0102.

U1MAP bit: controls pin assignments for the UART1 function.

To assign the UART1 function to P64/CTS1/RTS1, P65/CLK1, P66/RxD1, and P67/TxD1, set the U1MAP bit to 0 (P67 to P64).

To assign the function to P70/CTS1/RTS1, P71/CLK1, P72/RxD1, and P73/TxD1, set the U1MAP bit to 1 (P73 to P70)

The PRC2 bit in the PRCR protects the PACR register. Set the PACR register after setting the PRC2 bit in the PRCR register.

19.6 Digital Debounce Function

Two digital debounce function circuits are provided. Level is determined when level is held, after applying either a falling edge or rising edge to the pin, longer than the programmed filter width time. This enables noise reduction.

This function is assigned to INT5/INPC17 and NMI/SD. Digital filter width is set in the NDDR register and the P17DDR register respectively. **Figure 19.11** shows the NDDR register and the P17DDR register. Additionally, a digital debounce function is disabled to the port P17 input and the port P85 input.

Filter width: (n+1) x 1/f8 n: count value set in the NDDR register and P17DDR register

The NDDR register and the P17DDR register decrement count value with f8 as the count source. The NDDR register and the P17DDR register indicate count time. Count value is reloaded if a falling edge or a rising edge is applied to the pin.

The NDDR register and the P17DDR register can be set 0016 to FF16 when using the digital debounce function. Setting to FF16 disables the digital filter. See **Figure 19.12** for details.



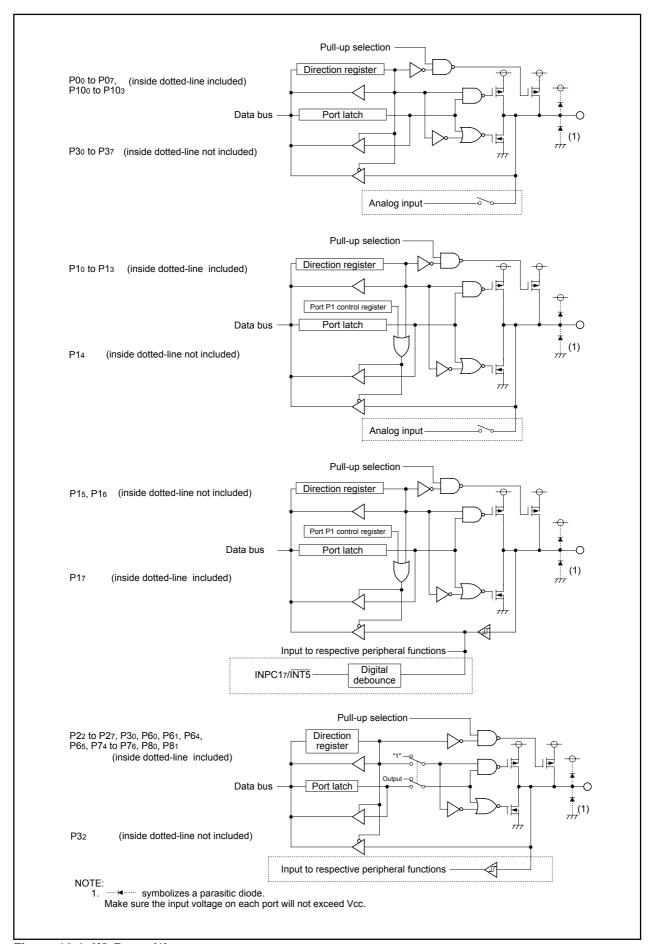


Figure 19.1 I/O Ports (1)

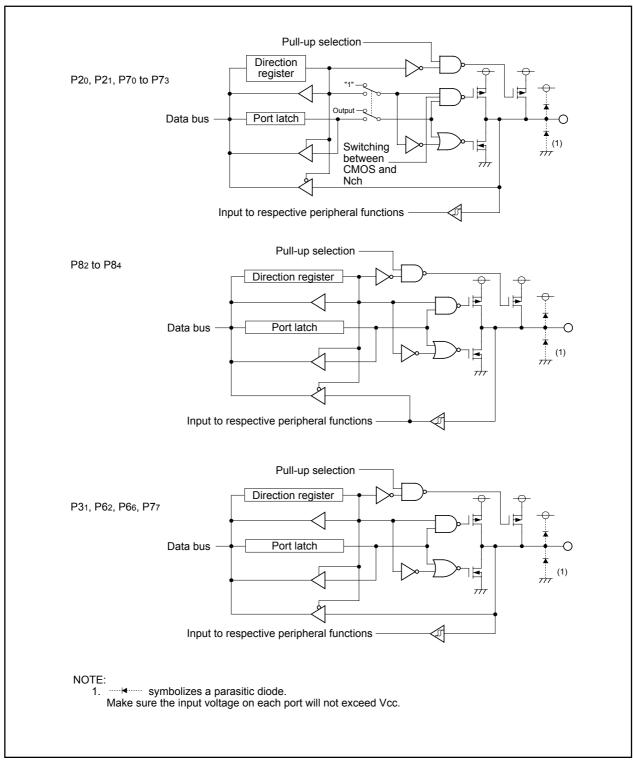


Figure 19.2 I/O Ports (2)

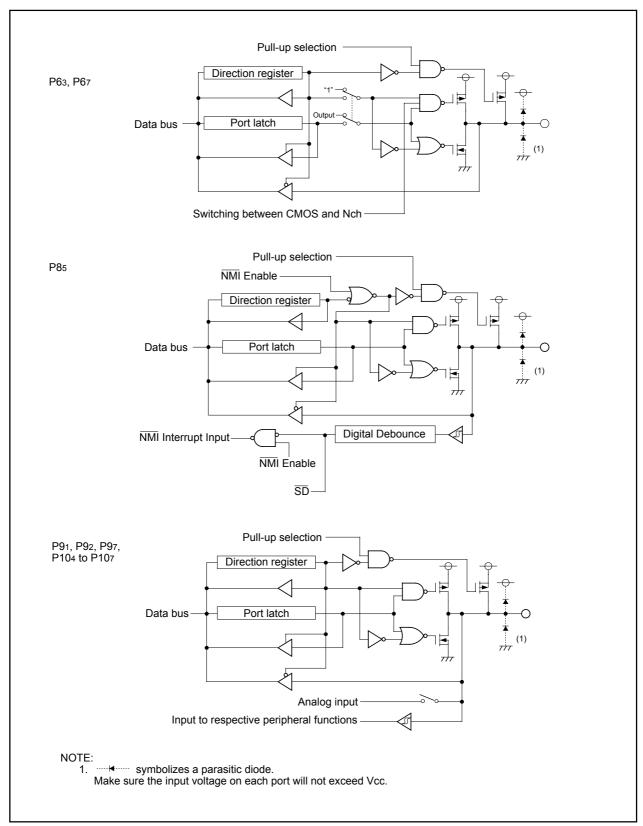


Figure 19.3 I/O Ports (3)

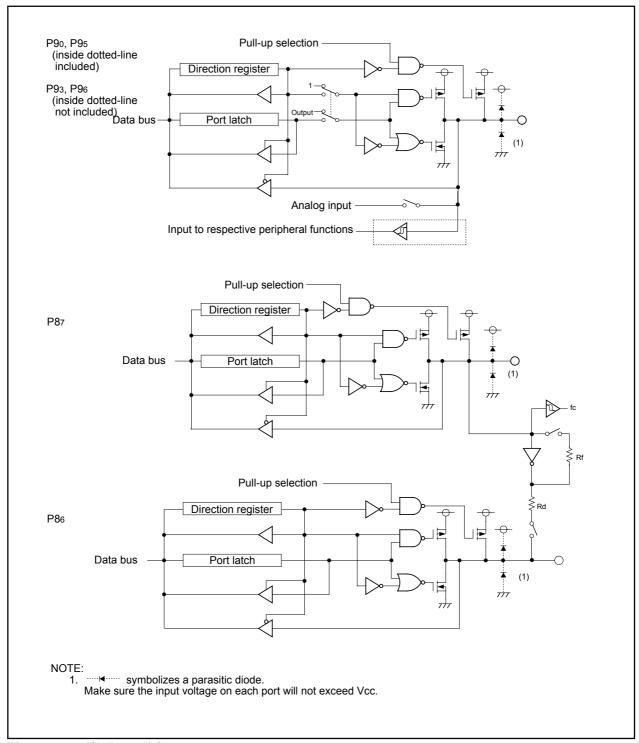


Figure 19.4 I/O Ports (4)

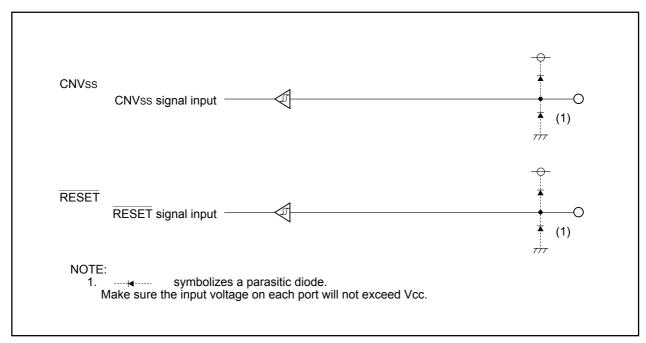


Figure 19.5 I/O Pins

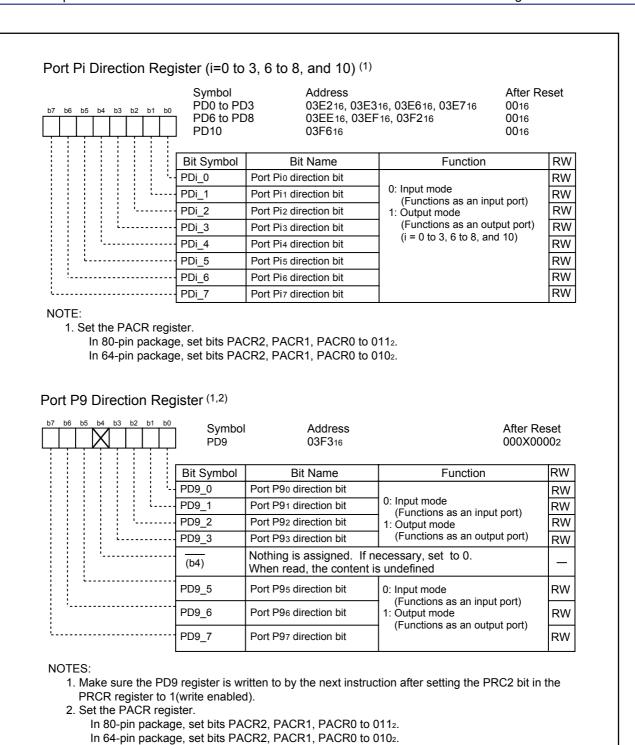


Figure 19.6 PD0 to PD3 and PD6 to PD10 Registers

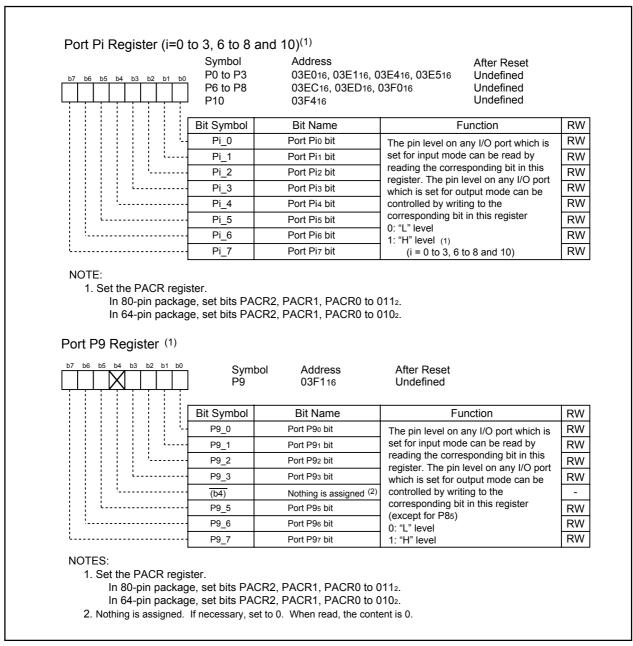
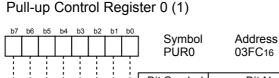


Figure 19.7 P0 to P3 and P6 to P10 Registers



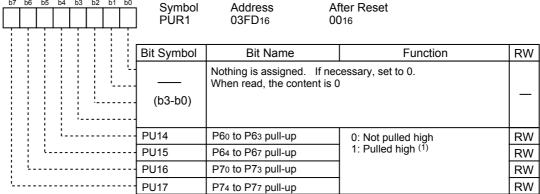
H	++;	4	1	٠,	Ļ	ᆛ	PUR0	03FC16	0	016		
				-	-	1	Bit Symbol	Bit Name		Function	F	RW
					-	Ч	PU00	P00 to P03 pull-up		0: Not pulled up		RW
i	1 1	ij	i	i	i	 	PU01	P04 to P07 pull-up		1: Pulled up (1)	F	RW
				!_		 	PU02	P10 to P13 pull-up				RW
- 1	1 1	- 1	;			 	PU03	P14 to P17 pull-up			F	RW
	1 1	;				 	PU04	P20 to P23 pull-up			F	RW
						 	PU05	P24 to P27 pull-up				RW
	i					 	PU06	P30 to P33 pull-up			F	RW
i						 	PU07	P34 to P37 pull-up			F	RW

After Reset

NOTE:

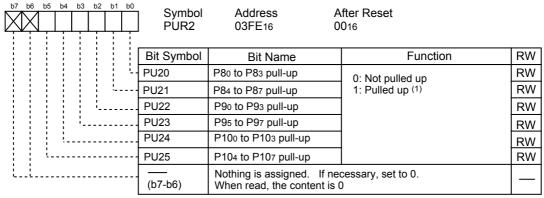
1. The pin for which this bit is 1 (pulled up) and the direction bit is 0 (input mode) is pulled up.

Pull-up Control Register 1



NOTE:

Pull-up Control Register 2



NOTE:

Figure 19.8 PUR0 to PUR2 Registers

^{1.} The pin for which this bit is 1 (pulled up) and the direction bit is 0 (input mode) is pulled up.

^{1.} The pin for which this bit is 1 (pulled up) and the direction bit is 0 (input mode) is pulled up.

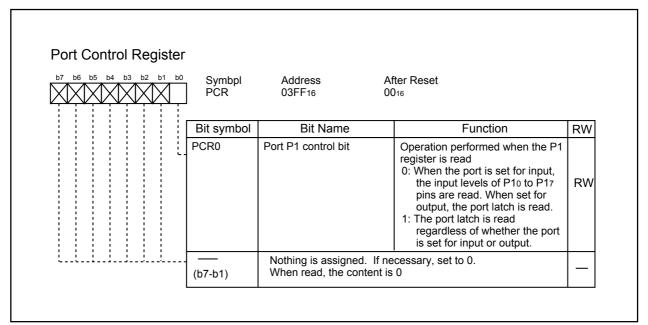


Figure 19.9 PCR Register

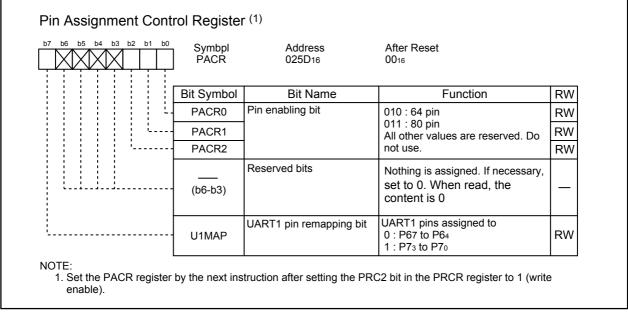


Figure 19.10 PACR Register

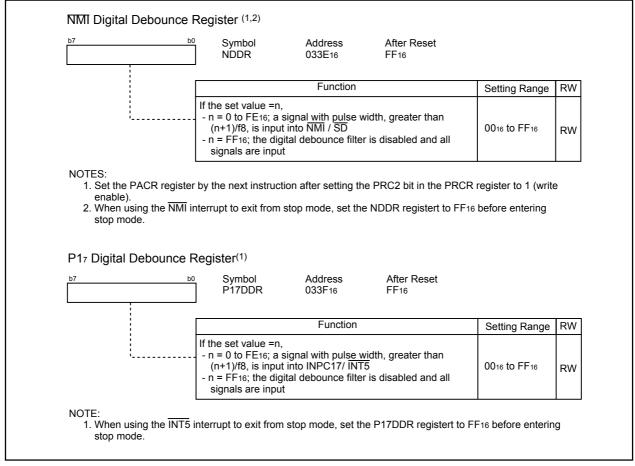


Figure 19.11 NDDR and P17DDR Registers

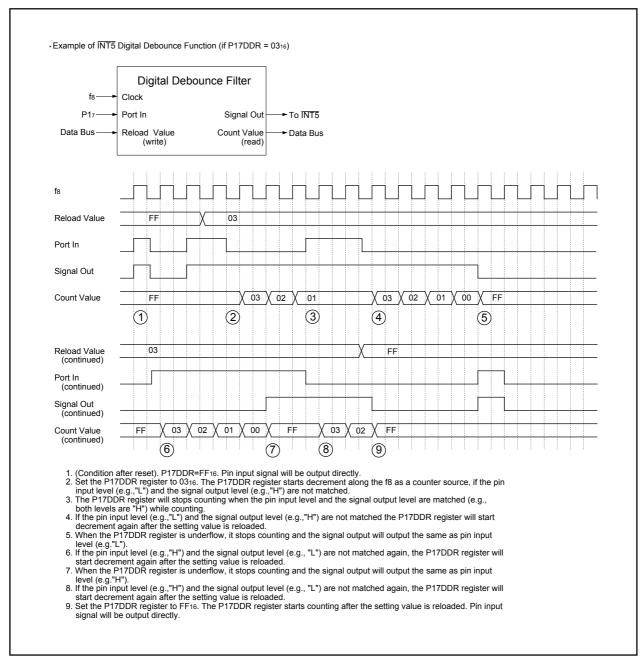


Figure 19.12 Functioning of Digital Debounce Filter

Table 19.1 Unassigned Pin Handling in Single-chip Mode

Pin Name	Setting
Ports P0 to P3, P6 to P10	Enter input mode and connect each pin to Vss via a resistor (pull-down); or enter output mode and leave the pins open (1,2,4)
Xout	Leave pin open (3)
XIN	Connect pin to VCC via a resistor (pull-up) (5)
AVcc	Connect pin to Vcc
AVSS, VREF	Connect pin to Vss

NOTES:

- 1. If the port enters output mode and is left open, it is in input mode before output mode is entered by program after reset. While the port is in input mode, voltage level on the pins is indeterminate and power consumption may increase. Direction register setting may be changed by noise or failure caused by noise. Configure direction register settings regulary to increase the reliability of the program.
- 2. Use the shortest possible wiring to connect the MCU pins to unassigned pins (within 2 cm).
- 3. When the external clock is applied to the XIN pin, set the pin as written above.
- 4. In the 64-pin package, set bits PACR2, PACR1, and PACR0 in the PACR register to 0102. In the 80-pin package, set bits PACR2, PACR1, and PACR0 to 0112.
- 5. When the main clock oscillation is not used, set the CM05 bit in the CM0 register to 1 (main clock stops) to reduce power consumption.

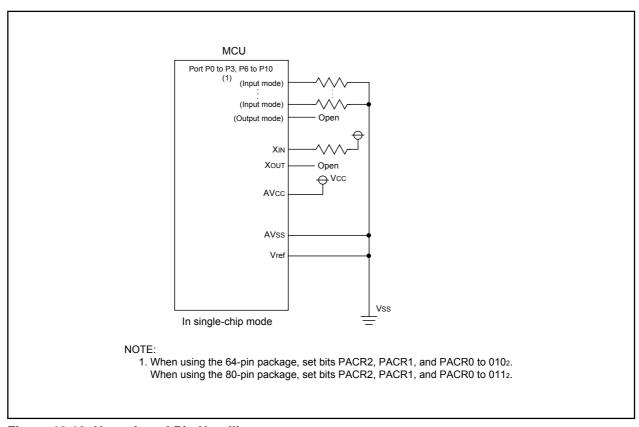


Figure 19.13 Unassigned Pin Handling

20. Flash Memory Version

20.1 Flash Memory Performance

In the flash memory version, rewrite operation to the flash memory can be performed in four modes: CPU rewrite mode, standard serial I/O mode, parallel I/O mode, and CAN I/O mode.

Table 20.1 lists specifications of the flash memory version. (Refer to **Table 1.1** or **Table 1.2** for the items not listed in **Table 20.1**.

Table 20.1 Flash Memory Version Specifications

Item		Specification		
Flash memory operating mode		4 modes (CPU rewrite, standard serial I/O, parallel I/O, CAN I/O) ⁽³⁾		
Erase block		See Figures 20.1 to 20.3 Flash Memory Block Diagram		
Program method		In units of word		
Erase method		Block erase		
Program, erase control method		Program and erase controlled by software command		
Protect method		Blocks 0 to 5 are write protected by FMR16 bit. In addition, the block 0 and block 1 are write protected by FMR02 bit		
Number of commands		5 commands		
Program/Erase	Block 0 to 5 (program area)	100 times 1,000 times (See Tables 1.6 to 1.8)		
Endurance(1)	Block A and B (data are) (2)	100 times 10,000 times (See Tables 1.6 to 1.8)		
Data Retention		20 years (Topr = 55YC)		
ROM code protection		Parallel I/O, standard serial I/O, and CAN I/O modes are supported.		

NOTES:

- 1. Program and erase endurance definition
 - Program and erase endurance are the erase endurance of each block. If the program and erase endurance are n times (n=100,1000,10000), each block can be erased n times. For example, if a 2-Kbyte block A is erased after writing 1 word data 1024 times, each to different addresses, this is counted as one program and erasure. However, data cannot be written to the same address more than once without erasing the block. (Rewrite disabled)
- 2. To use the limited number of erasure efficiently, write to unused address within the block instead of rewrite. Erase block only after all possible address are used. For example, an 8-word program can be written 128 times before erase is necessary. Maintaining an equal number of erasure between Block A and B will also improve efficiency. We recommend keeping track of the number of times erasure is used.
- 3. The M16C/29 Group, T-ver./V-ver. does not support the CAN I/O mode.



Table 20.2. Flash Memory Rewrite Modes Overview

Flash memory rewrite mode	CPU rewrite mode	Standard serial I/O mode	Parallel I/O mode	CAN I/O mode
Function	The user ROM area is rewritten when the CPU excutes software command from the CPU. EW0 mode: Rewrite in area other	The user ROM area is rewritten using a dedicated serial programmer. Standard serial I/O mode 1: Clock synchronous	The user ROM areas are rewritten using a dedicated parallel programmer.	The user ROM areas is rewritten using a dedicated CAN programmer.
	than flash memory EW1 mode: Rewrite in flash memory	serial I/O Standard serial I/O mode 2: UART		
Areas which can be rewritten	User ROM area	User ROM area	User ROM area	User ROM area
Operation mode	Single chip mode	Boot mode	Parallel I/O mode	Boot mode
ROM programmer	None	Serial programmer	Parallel programmer	CAN programmer

20.1.1 Boot Mode

The MCU enters boot mode when a hardware reset is performed while a high-level ("H") signal is applied to pins CNVss and P86 or while an "H" signal is applied to pins CNVss and P16 and a low-level ("L") signal is applied to the P85. A program in the boot ROM area is executed.

The boot ROM area is reserved. The boot ROM area stores the rewrite control program for a standard serial I/O mode before shipping. Do not rewrite the boot ROM area.



20.2 Memory Map

The flash memory contains the user ROM area and the boot ROM area (reserved area). **Figures 20.1** to **20.3** show a block diagram of the flash memory. The user ROM area has space to store the MCU operation program in single-chip mode and two 2-Kbyte spaces: the block A and B.

The user ROM area is divided into several blocks. The user ROM area can be rewritten in CPU rewrite, standard serial I/O, parallel I/O, or CAN I/O mode.

However, to rewrite program in block 0 and 1 in CPU rewrite mode, set the FMR02 bit in the FMR0 register to 1 (block 0, 1 rewrite enabled) and the FMR16 bit in the FMR1 register to 1 (blocks 0 to 5 rewrite enabled). Also, to rewrite program in blocks 2 to 5 in CPU rewrite mode, set the FMR16 bit in the FMR1 register to 1 (blocks 0 to 5 rewrite enabled). When the PM10 bit in the PM1 register is set to 1 (data space access enabled), blocks A and B can be available for use.

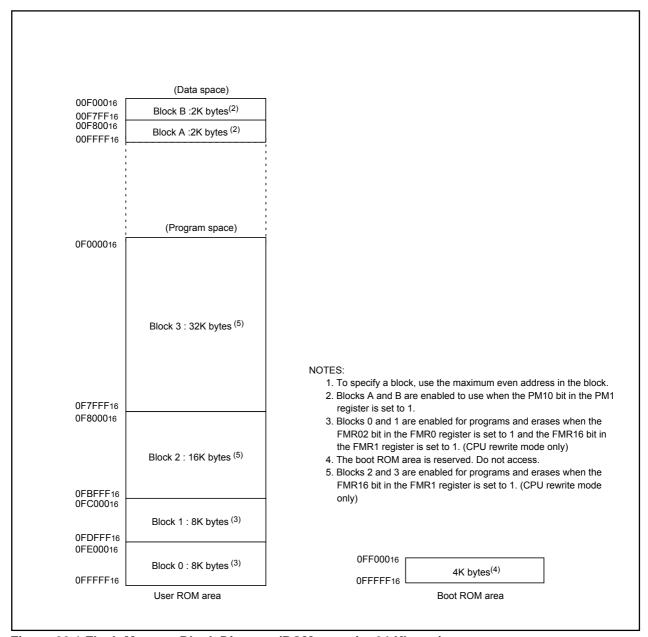


Figure 20.1 Flash Memory Block Diagram (ROM capacity 64 Kbytes)

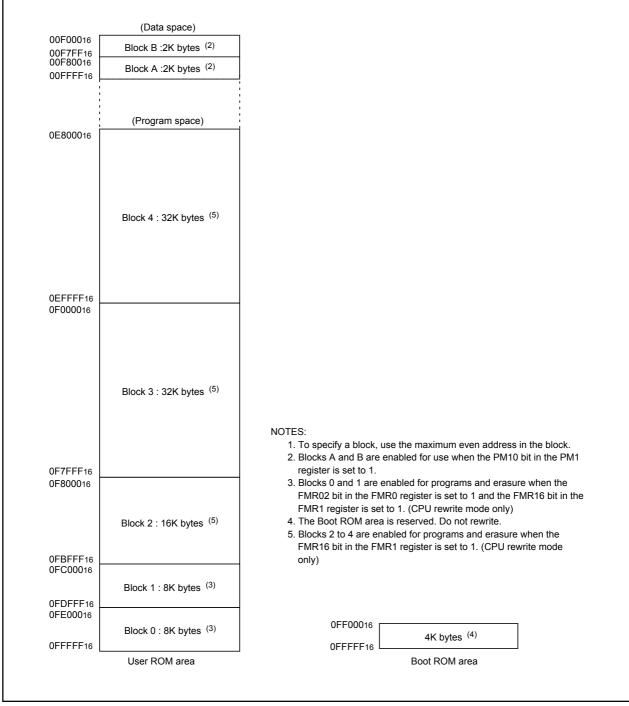


Figure 20.2 Flash Memory Block Diagram (ROM capacity 96 Kbytes)

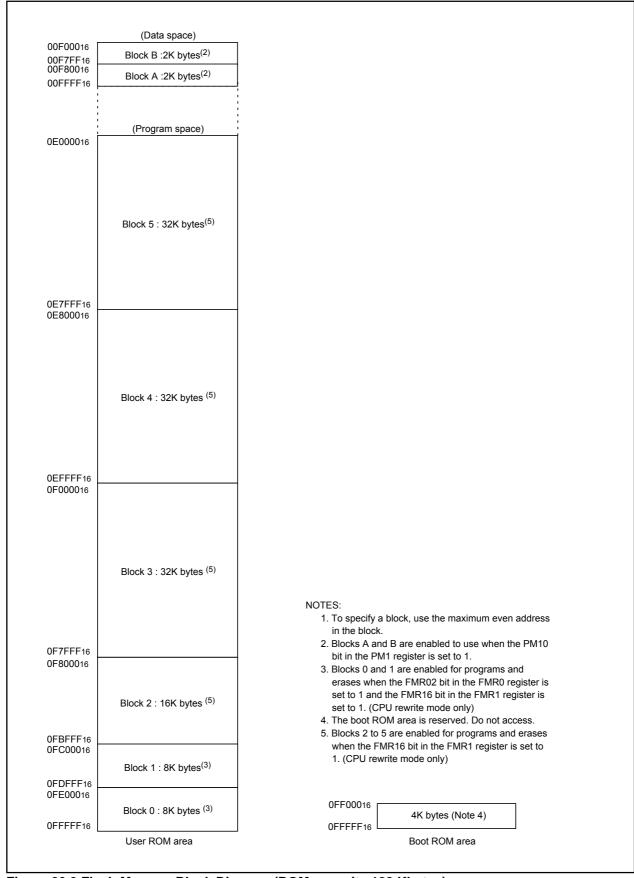


Figure 20.3 Flash Memory Block Diagram (ROM capacity 128 Kbytes)

20.3 Functions To Prevent Flash Memory from Rewriting

The flash memory has a built-in ROM code protect function for parallel I/O mode and a built-in ID code check function for standard input/output mode to prevent the flash memory from reading or rewriting.

20.3.1 ROM Code Protect Function

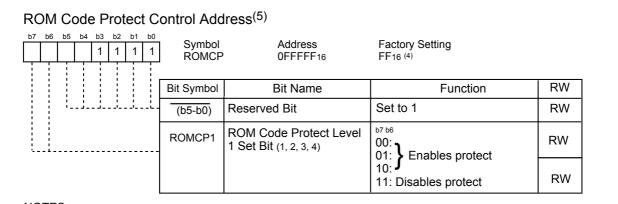
The ROM code protect function disables reading or changing the contents of the on-chip flash memory in parallel I/O mode. **Figure 20.4** shows the ROMCP address. The ROMCP address is located in a user ROM area. To enable ROM code protect, set the ROMCP1 bit to "002", "012", or "102" and set the bit 5 to bit 0 to "1111112".

To cancel ROM code protect, erase the block including the the ROMCP register in CPU rewrite mode or standard serial I/O mode.

20.3.2 ID Code Check Function

Use the ID code check function in standard serial input/output mode. Unless the flash memory is blank, the ID code sent from the programmer and the 7-byte ID code written in the flash memory are compared for match. If the ID codes do not match, the commands sent from the programmer are not acknowledged. The ID code consists of 8-bit data, starting with the first byte, into addresses, 0FFFDF16, 0FFFE316, 0FFFEB16, 0FFFFB16, 0FFFFB16. The flash memory must have a program with the ID code set in these addresses.





- 1. When the ROM code protect is active by the ROMCP1 bit setting, the flash memory is protected against reading or rewriting in parallel I/O mode.
- 2. Set the bit 5 to bit 0 to 11111112 when the ROMCP1 bit is set to a value other than 112. When the bit 5 to bit 0 are set to values other than 11111112, the ROM code protection may not become active by setting the ROMCP1 bit to a value other than 112.
- 3. To make the ROM code protection inactive, erase a block including the ROMCP address in standard serial I/O mode or CPU rewrite mode.
- 4. The ROMCP address is set to FF16 when a block, including the ROMCP address, is erased.
- 5. When a value of the ROMCP address is 0016 or FF16, the ROM code protect function is disabled.

Figure 20.4 ROMCP Address

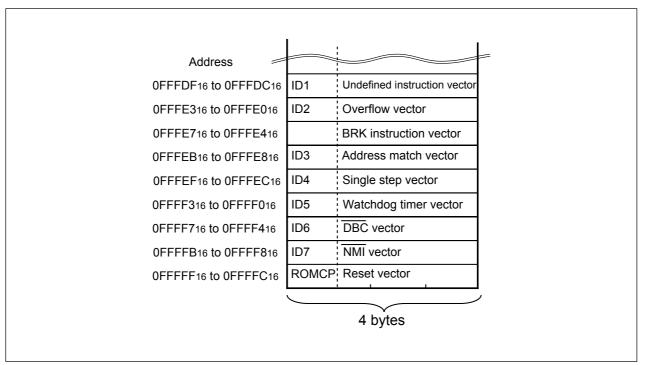


Figure 20.5 Address for ID Code Stored

20.4 CPU Rewrite Mode

In CPU rewrite mode, the user ROM area can be rewritten when the CPU executes software commands. The user ROM area can be rewritten with MCU mounted on a board without using the ROM writer. The program and block erase commands are executed only in the user ROM area.

When the interrupt requests are generated during the erase operation in CPU rewirte mode, the flash memory offers an erase suspend function to suspend the erase operation and process the interrupt operation. During the erase suspend function is operated, the user ROM area can be read by program.

Erase-write(EW) 0 mode and erase-write 1 mode are provided as CPU rewrite mode. **Table 20.3** lists differences between EW mode 0 and EW mode 1. One wait is required for the CPU erase-write control.

Table 20.3 EW Mode 0 and EW Mode 1

Item	EW mode 0	EW mode 1
Operation mode	Single chip mode	Single chip mode
Areas in which a	User ROM area	User ROM area
rewrite control		
program can be located		
Areas where	The rewrite control program must be	The rewrite control program can be
rewrite control	transferred to any other than the flash	excuted in the user ROM area
program can be	memory (e.g., RAM) before being	
executed ⁽²⁾	executed	
Areas which can be	User ROM area	User ROM area
rewritten		However, this excludes blocks with the
		rewrite control program
Software command	None	Program, block erase command
Restrictions		Cannot be executed in a block having
		the rewite control program
		Read Status Register command
		Cannot be executed
Mode after programming	Read Status Register Mode	Read Array mode
or erasing		
CPU state during auto-	Operating	In a hold state (I/O ports retain the state
write and auto-erase		before the command is excuted ⁽¹⁾
Flash memory status	Read the FMR00, FMR06, and	Read the FMR00, FMR06, and FMR07
detection	FMR07 bits in the FMR0 register	bits in the FMR0 registerby program
	by program	
	Execute the read status register	
	command to read bits SR7, SR5,	
	and SR4.	
Condition for transferring	Set bits FMR40 and FMR41 in	The FMR40 bit in the FMR4 register is
to erase-suspend(3)	the FMR4 register to 1 by program.	set to 1 and the interruput request of
NOTEC		an acknowledged interrupt is generated

- 1. Do not generate a DMA transfer.
- 2. Block 1 and Block 0 are enabled for rewrite by setting FMR02 bit in the FMR0 register to 1 and setting FMR16 bit in the FMR1 register to 1. Block 2 to Block 5 are enabled for rewrite by setting FMR16 bit in the FMR1 register to 1.
- 3. The time, until entering erase suspend and reading flash is enabled, is maximum *td(SR-ES)* after satisfying the conditions.



20.4.1 EW Mode 0

The MCU enters CPU rewrite mode by setting the FMR01 bit in the FMR0 register to 1 (CPU rewrite mode enabled) and is ready to accept software commands. EW mode 0 is selected by setting the FMR11 bit in the FMR1 register to 0.

To set the FMR01 bit to 1, set to 1 after first writing 0. The software commands control programming and erasing. The FMR0 register or the status register indicates whether a programming or erasing operations is completed.

When entering the erase-suspend during the auto-erasing, set the FMR40 bit to 1 (erase-suspend enabled) and the FMR41 bit to 1 (suspend request). After waiting for td(SR-ES) and verifying the FMR46 bit is set to 1 (auto-erase stop), access to the user ROM area. When setting the FMR41 bit to 0 (erase restart), auto-erasing is restarted.

20.4.2 EW Mode 1

EW mode 1 is selected by setting the FMR11 bit to 1 after the FMR01 bit is set to 1 (set to 1 after first writing 0).

The FMR0 register indicates whether or not a programming or an erasing operation is completed. Read status register cannot be read in EW mode 1.

When an erase/program command is initiated, the CPU halts all program execution until the command operation is completed or erase-suspend request is generated.

When enabling an erase-suspend function, set the FMR40 bit to 1 (erase suspend enabled) and execute block erase commands. Also, the interrupt to transfer to erase-suspend must be set enabled preliminarily. When entering erase-suspend after td(SR-ES) from an interrupt is requested, interrupts can be accepted.

When an interrupt request is generated, the FMR41 bit is automatically set to 1 (suspend request) and an auto-erasing is suspended. If an auto-erasing has not completed (when the FMR00 bit is 0) after an interrupt process is completed, set the FMR41 bit to 0 (erase restart) and execute block erase commands again.



20.5 Register Description

Figure 20.6 shows the flash memory control register 0 and flash memory control register 1. **Figure 20.7** shows the flash memory control register 4.

20.5.1 Flash Memory Control Register 0 (FMR0)

•FMR 00 Bit

The FMR00 bit indicates the operating state of the flash memory. Its value is 0 while the program, erase, or erase-suspend command is being executed, otherwise, it is 1.

•FMR01 Bit

The MCU can accept commands when the FMR01 bit is set to 1 (CPU rewrite mode). To set the FMR01 bit to 1, first set it to 0 and then 1. The FMR01 bit is set to 0 only by writing 0.

•FMR02 Bit

The combined settings of bits FMR02 and FMR16 enable program and erase in the user ROM area. See **Table 20.4** for setting details. To set the FMR02 bit to 1, first set it to 0 and then 1. The FMR02 bit is valid only when the FMR01 bit is set to 1 (CPU rewrite mode enable).

•FMSTP Bit

The FMSTP bit initializes the flash memory control circuits and minimizes power consumption in the flash memory. Access to the on-chip flash memory is disabled when the FMSTP bit is set to 1. Set the FMSTP bit by program in a space other than the flash memory.

Set the FMSTP bit to 1 if one of the following occurs:

- •A flash memory access error occurs during erasing or programming in EW mode 0 (FMR00 bit does not switch back to 1 (ready)).
- •Low-power consumption mode or on-chip oscillator low-power consumption mode is entered.

Figure 20.10 shows a flow chart illustrating how to start and stop the flash memory before and after entering low power mode. Follow the procedure in this flow chart.

When entering stop or wait mode while the CPU rewrite mode is disabled, do not set the FMR0 register because the on-chip flash memory is automatically turned off and turned back on when exiting.

•FMR06 Bit

The FMR06 bit is a read-only bit indicating an auto-program operation state. The FMR06 bit is set to 1 when a program error occurs; otherwise, it is set to 0. For details, refer to **20.8.4 Full Status Check**.

•FMR07 Bit

The FMR07 bit is a read-only bit indicating an auto-erase operation status. The FMR07 bit is set to 1 when an erase error occurs; otherwise, it is set to 0. For details, refer to **20.8.4 Full Status Check**.

Figure 20.8 shows a EW mode 0 set/reset flowchart, **Figure 20.9** shows a EW mode 1 set/reset flowchart.



20.5.2 Flash Memory Control Register 1 (FMR1)

•FMR11 Bit

EW mode 1 is entered by setting the FMR11 bit to 1 (EW mode 1). The FMR11 bit is valid only when the FMR01 bit is set to 1.

•FMR16 Bit

The combined setting of bits FMR02 and FMR16 enables program and erase in the user ROM area. To set the FMR16 bit to 1, first set it to 0 and then 1. The FMR16 bit is valid only when the FMR01 bit is set to 1 (CPU rewrite mode enable).

•FMR17 Bit

If the FMR17 bit is set to 1 (with wait state), 1 wait state is inserted when blocks A and B are accessed, regardless of the content of the PM17 bit in the PM1 register. The PM17 bit setting is reflected to access other blocks and internal RAM, regardless of the FMR17 bit setting.

Set the FMR17 bit to 1 (with wait state) to rewrite more than 100 times (U7, U9).

Table 20.4 Protection using FMR16 and FMR02

FMR16	FMR02	Block A, Block B	Block 0, Block 1	other user block
0	0	write enabled	write disabled	write disabled
0	1	write enabled	write disabled	write disabled
1	0	write enabled	write disabled	write enabled
1	1	write enabled	write enabled	write enabled

20.5.3 Flash Memory Control Register 4 (FMR4)

•FMR40 Bit

The erase-suspend function is enabled when the FMR40 bit is set to 1 (enabled).

•FMR41 Bit

When the FMR41 bit is set to 1 by program during auto-erasing in EW mode 0, erase-suspend mode is entered. In EW mode 1, the FMR41 bit is automatically set to 1 (suspend request) to enter erase-suspend mode when an enabled interrupt request is generated. Set the FMR41 bit to 0 (erase restart) to restart an auto-erasing operation.

•FMR46 Bit

The FMR46 bit is set to 0 during auto-erasing. It is set to 1 in erase-suspend mode. Do not access to flash memory when the FMR46 bit is set to 0.

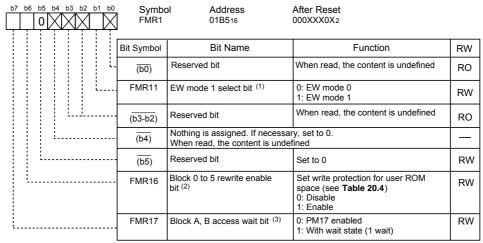


Flash Memory Control Register 0 b6 b5 b4 b3 b2 b1 b0 Symbol Address After Reset 0 0 FMR0 01B716 000000012 RW Bit Symbol Bit Name Function 0: Busy (during writing or erasing) FMR00 RY/BY status flag RO 1: Ready CPU rewrite mode select bit (1) 0: Disables CPU rewrite mode FMR01 (Disables software command) RW 1: Enables CPU rewrite mode (Enables software commands) Block 0, 1 rewrite enable bit (2) Set write protection for user ROM area FMR02 (see Table 20.4) RW 0: Starts flash memory operation Flash memory stop bit (3, 5) **FMSTP** 1: Stops flash memory operation (Enters low-power consumption state RW and flash memory reset) (b5-b4) Reserved bit Set to 0 RW FMR06 Program status flag 0: Successfully completed RO (4) 1: Completion erro 0: Successfully completed FMR07 Erase status flag RO 1: Completion error

NOTES:

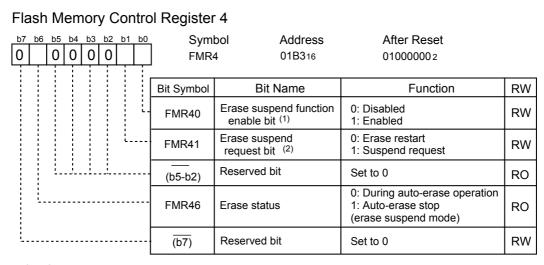
- 1. Set the FMR01 bit to 1 immediately after setting it first to 0. Do not generate an interrupt or a DMA transfer between setting the bit to 0 and setting it to 1. Set this bit while the P85/NMI/SD pin is held "H" when selecting the NMI function. Set by program in a space other than the flash memory in EW mode 0. Set this bit to read alley mode and 0.
- 2. Set this bit to 1 immediately after setting it first to 0 while the FMR01 bit is set to 1. Do not generate an interrupt or a DMA transfer between setting this bit to 0 and setting it to 1.
- 3. Set this bit in a space other than the flash memory by program. When this bit is set to 1, access to flash memory will be denied. To set this bit to 0 after setting it to 1, wait for 10 usec. or more after setting it to 1. To read data from flash memory after setting this bit to 0, maintain tps wait time before accessing flash memory.
- 4. This bit is set to 0 by executing the clear status command.
- 5. This bit is enabled when the FMR01 bit is set to 1 (CPU rewrite mode). If the FMR01 bit is set to 0, this bit can be set to 1 by writing 1 to the FMR01 bit. However, the flash memory does not enter low-power consumption status and it is not initialized.

Flash Memory Control Register 1



- 1. Set the FMR11 bit to 1 immediately after setting it first to 0 while the FMR01 bit is set to 1. Do not generate an interrupt or a DMA transfer between setting the bit to 0 and setting it to 1. Set this bit while the P85/NMI/SD pin is held "H" when the NMI function is selected. If the FMR01 bit is set to 0, the FMR01 bit and FMR11 bit are both set to 0.
- Set this bit to 1 immediately after setting it first to 0 while the FMR01 bit is set to 1. Do not generate an interrupt or a DMA transfer between setting this bit to 0 and setting it to 1.
- 3. When rewriting more than 100 times, set this bit to 1 (with wait state). When the FMR17 bit is set to1(with wait state), regardless of the PM17 bit setting, 1 wait state is inserted when accessing to blocks A and B. The PM17 bit setting is enabled, regardless of the FMR17 bit setting, as to the access to other block and the internal RAM.

Figure 20.6 FMR0 and FMR1 Registers



- 1. Set the FMR40 bit to 1 immediately after setting it first to 0. Do not generate any interrupt or DMA transfer between setting the bit to 0 and setting it to 1. Set by program in space other than the flash memory in EW mode 0.
- 2. The FMR41 bit is valid only when the FMR40 bit is set to 1. The FMR41 bit can be written only between executing an erase command and completing erase (this bit is set to 0 other than the above duration). The FMR41 bit can be set to 0 or 1 by program in EW mode 0. In EW mode 1, the FMR41 bit is automatically set to 1 when the FMR40 bit is 1 and a maskable interrupt is generated during erasing. The FMR41 bit cannot be set to 1 by program (it can be set to 0 by program).

Figure 20.7 FMR4 Register

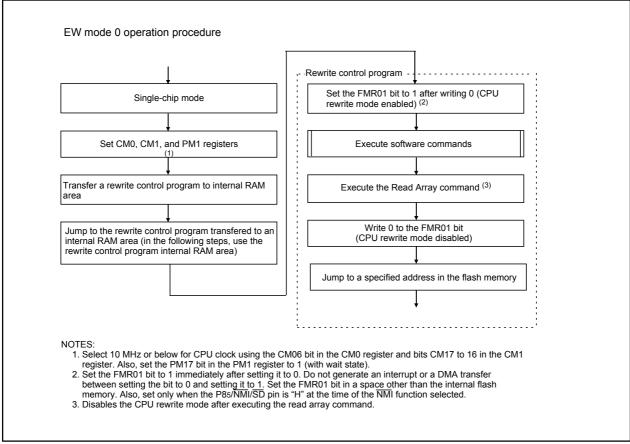


Figure 20.8 Setting and Resetting of EW Mode 0

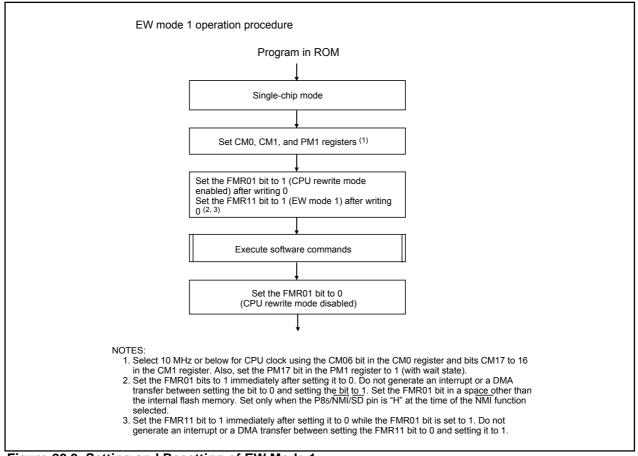


Figure 20.9 Setting and Resetting of EW Mode 1

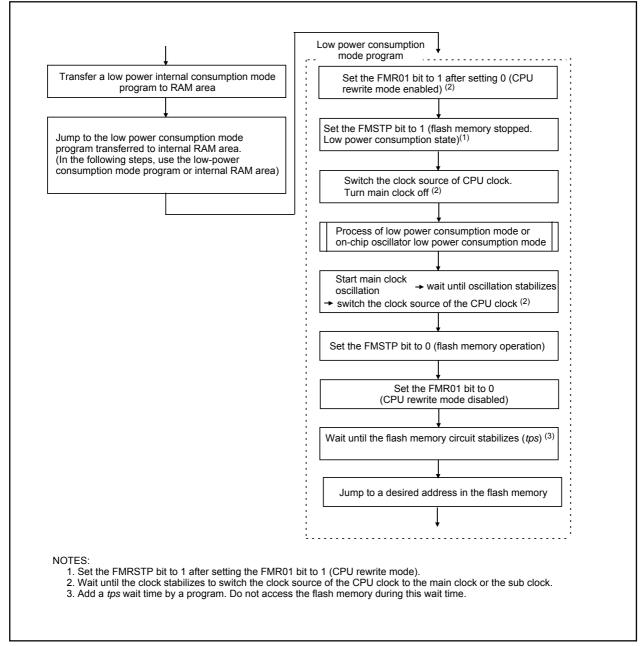


Figure 20.10 Processing Before and After Low Power Dissipation Mode

20.6 Precautions in CPU Rewrite Mode

Described below are the precautions to be observed when rewriting the flash memory in CPU rewrite mode.

20.6.1 Operation Speed

When the CPU clock source is the main clock, set the CPU clock frequency at 10 MHz or less with the CM06 bit in the CM0 register and bits CM17 and CM16 in the CM1 register, before entering CPU rewrite mode (EW mode 0 or EW mode 1). Also, when selecting f3(ROC) of a on-chip oscillator as a CPU clock source, set bits ROCR3 and ROCR2 in the ROCR register to the CPU clock division rate at "divide-by-4" or "divide-by-8", before entering CPU rewrite mode (EW mode 0 or EW mode 1).

In both cases, set the PM17 bit in the PM1 register to 1 (with wait state).

20.6.2 Prohibited Instructions

The following instructions cannot be used in EW mode 0 because the CPU tries to read data in the flash memory: UND instruction, INTO instruction, JMPS instruction, JSRS instruction, and BRK instruction

20.6.3 Interrupts

EW Mode 0

- To use interrupts having vectors in a relocatable vector table, the vectors must be relocated to the RAM area
- The $\overline{\text{NMI}}$ and watchdog timer interrupts are available since registers FMR0 and FMR1 are forcibly reset when either interrupt occurs. However, the interrupt program, which allocates the jump addresses for each interrupt routine to the fixed vector table, is needed. Flash memory rewrite operation is aborted when the $\overline{\text{NMI}}$ or watchdog timer interrupt occurs. Set the FMR01 bit to 1 and execute the rewrite and erase program again after exiting the interrupt routine.
- The address match interrupt can not be used since the CPU tries to read data in the flash memory. EW Mode 1
 - Do not acknowledge any interrupts with vectors in the relocatable vector table or the address match interrupt during the auto program period or auto erase period with erase-suspend function disabled.

20.6.4 How to Access

To set bit FMR01, FMR02, FMR11 or FMR16 to 1, write 1 immediately after setting to 0. Do not generate an interrupt or a DMA transfer between the instruction to set the bit to 0 and the instruction to set it to 1. When the $\overline{\text{NMI}}$ function is selected, set the bit while an "H" signal is applied to the P85/ $\overline{\text{NMI/SD}}$ pin.

20.6.5 Writing in the User ROM Area

20.6.5.1 EW Mode 0

 If the supply voltage drops while rewriting the block where the rewrite control program is stored, the flash memory can not be rewritten, because the rewrite control program is not correctly rewritten. If this error occurs, rewrite the user ROM area in standard serial I/O mode or parallel I/O mode.

20.6.5.2 EW Mode 1

• Do not rewrite the block where the rewrite control program is stored.



20.6.6 DMA Transfer

In EW mode 1, do not generate a DMA transfer while the FMR00 bit in the FMR0 register is set to 0. (during the auto-programming or auto-erasing).

20.6.7 Writing Command and Data

Write the command codes and data to even addresses in the user ROM area.

20.6.8 Wait Mode

When entering wait mode, set the FMR01 bit to 0 (CPU rewrite mode disabled) before executing the WAIT instruction.

20.6.9 Stop Mode

When entering stop mode, the following settings are required:

• Set the FMR01 bit to 0 (CPU rewrite mode disabled) and disable the DMA transfer before setting the CM10 bit to 1 (stop mode).

20.6.10 Low Power Consumption Mode and On-Chip Oscillator-Low Power Consumption Mode

If the CM05 bit is set to 1 (main clock stopped), do not execute the following commands.

- Program
- Block erase



20.7 Software Commands

Read or write 16-bit commands and data from or to even addresses in the user ROM area. When writing a command code, 8 high-order bits (D15–D8) are ignored.

Table 20.5 Software Commands

		First bus cycle	е	Second bus cycle			
Command	Mode	Address	Data (D15 to D0)	Mode	Address	Data (D ₁₅ to D ₀)	
Read array	Write	Х	xxFF16				
Read status register	Write	Х	xx7016	Read	Х	SRD	
Clear status register	Write	Х	xx5016				
Program	Write	WA	xx4016	Write	WA	WD	
Block erase	Write	Х	xx2016	Write	BA	xxD016	

SRD: Status register data (D7 to D0)

WA: Write address (However, even address)

WD: Write data (16 bits)

BA: Highest-order block address (However, even address)

X : Any even address in the user ROM area xx : 8 high-order bits of command code (ignored)

20.7.1 Read Array Command (FF16)

The read array command reads the flash memory.

Read array mode is entered by writing command code xxFF16 in the first bus cycle. Content of a specified address can be read in 16-bit unit after the next bus cycle. The MCU remains in read array mode until an another command is written. Therefore, contents of multiple addresses can be read consecutively.

20.7.2 Read Status Register Command (7016)

The read status register command reads the status register.

By writing command code xx7016 in the first bus cycle, the status register can be read in the second bus cycle (Refer to **20.8 Status Register**). Read an even address in the user ROM area. Do not execute this command in EW mode 1.

20.7.3 Clear Status Register Command (5016)

The clear status register command clears the status register to 0.

By writing xx5016 in the first bus cycle, and bits FMR06 to FMR07 in the FMR0 register and bits SR4 to SR5 in the status register are set to 0.



20.7.4 Program Command (4016)

The program command writes 2-byte data to the flash memory.

Auto program operation (data program and verify) start by writing xx4016 in the first bus cycle and data to the write address specified in the second bus cycle. The address value specified in the first bus cycle must be the same even address as the write address secified in the second bus cycle.

The FMR00 bit in the FMR0 register indicates whether an auto-programming operation has been completed. The FMR00 bit is set to 0 during the auto-program and 1 when the auto-program operation is completed.

After the completion of auto-program operation, the FMR06 bit in the FMR0 register indicates whether or not the auto-program operation has been successfully completed. (Refer to **20.8.4 Full Status Check**). Also, each block can disable programming command (Refer to **Table 20.4**).

An address that is already written cannot be altered or rewritten.

When commands other than the program command are executed immediately after executing the program command, set the same address as the write address specified in the second bus cycle of the program command, to the specified address value in the first bus cycle of the following command.

In EW mode 1, do not execute this command on the blocks where the rewrite control program is allocated.

In EW mode 0, the MCU enters read status register mode as soon as the auto-program operation starts and the status register can be read. The SR7 bit in the status register is set to 0 as soon as the auto-program operation starts. This bit is set to 1 when the auto-program operation is completed. The MCU remains in read status register mode until the read array command is written. After completion of the auto-program operation, the status register indicates whether or not the auto-program operation has been successfully completed.

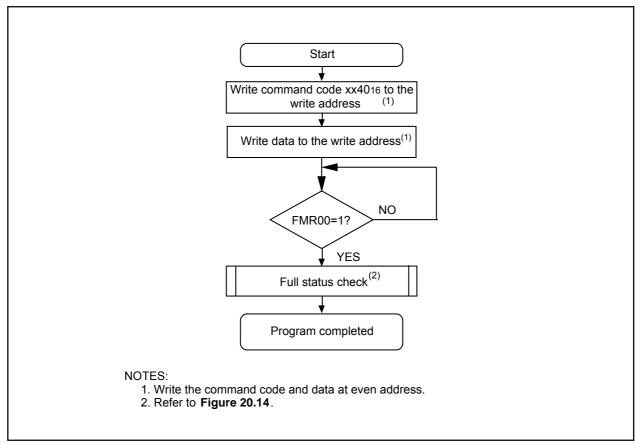


Figure 20.11 Flow Chart of Program Command

20.7.5 Block Erase

Auto erase operation (erase and verify) start in the specified block by writing xx2016 in the first bus cycle and xxD016 to the highest-order even addresse of a block in the second bus cycle.

The FMR00 bit in the FMR0 register indicates whether the auto-erase operation has been completed.

The FMR00 bit is set to 0 (busy) during the auto-erase and 1 (ready) when the auto-erase operation is completed.

When using the erase-suspend function in EW mode 0, verify whether a flash memory has entered erase suspend mode, by the FMR46 bit in the FMR4 register. The FMR46 bit is set to 0 during auto-erase operation and 1 when the auto-erase operation is completed (entering erase-suspend).

After the completion of an auto-erase operation, the FMR07 bit in the FMR0 register indicates whether or not the auto-erase operation has been successfully completed. (Refer to **20.8.4 Full Status Check**). Also, each block can disable erasing. (Refer to **Table 20.4**).

Figure 20.12 shows a flow chart of the block erase command programming when not using the erase-suspend function. **Figure 20.12** shows a flow chart of the block erase command programming when using an erase-suspend function.

In EW mode 1, do not execute this command on the block where the rewrite control program is allocated. In EW mode 0, the MCU enters read status register mode as soon as the auto-erase operation starts and the status register can be read. The SR7 bit in the status register is set to 0 at the same time the auto-erase operation starts. This bit is set to 1 when the auto-erase operation is completed. The MCU remains in read status register mode until the read array command is written.

When the erase error occurs, execute the clear status register command and block erase command at leaset three times until an erase error does not occur.

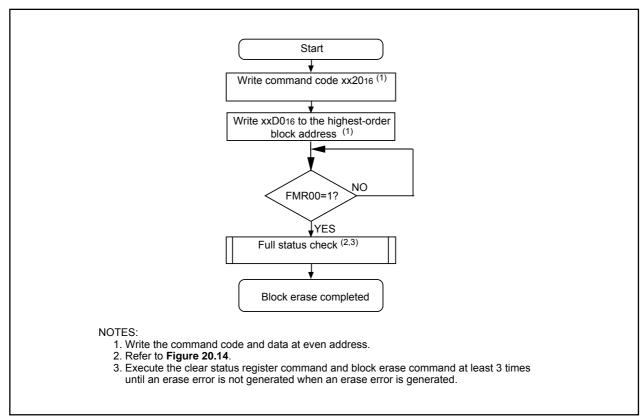


Figure 20.12 Flow Chart of Block Erase Command (when not using erase suspend function)

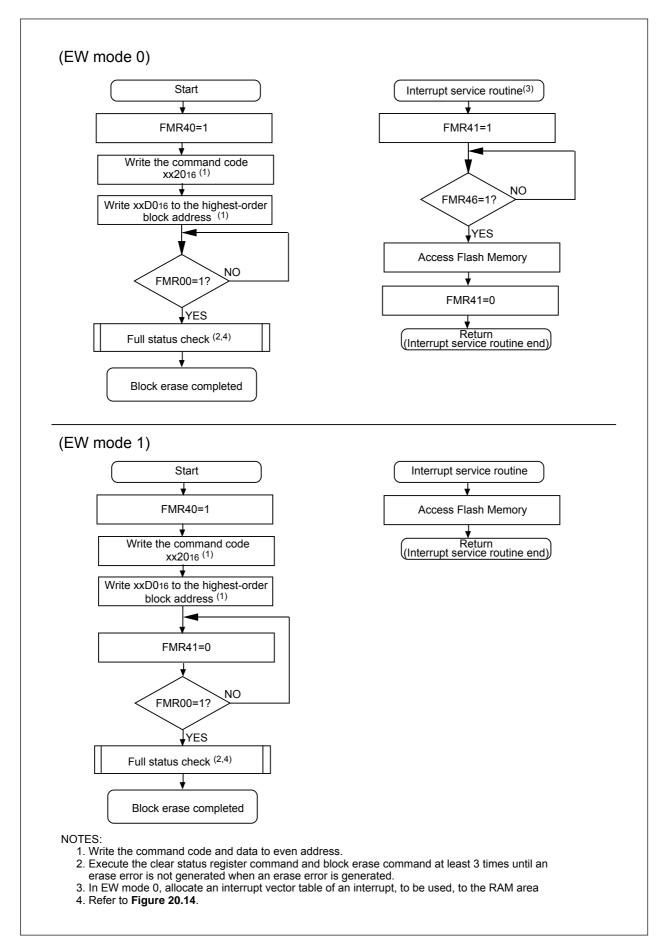


Figure 20.13 Block Erase Command (at use erase suspend)

20.8 Status Register

The status register indicates the operating status of the flash memory and whether or not erase or program operation is successfully completed. Bits FMR00, FMR06, and FMR07 in the FMR0 register indicate the status of the status register.

Table 20.6 lists the status register.

In EW mode 0, the status register can be read in the following cases:

- (1) Any even address in the user ROM area is read after writing the read status register command
- (2) Any even address in the user ROM area is read from when the program or block erase command is executed until when the read array command is executed.

20.8.1 Sequence Status (SR7 and FMR00 Bits)

The sequence status indicates the flash memory operating status. It is set to 0 (busy) while the auto-program and auto-erase operation is being executed and 1 (ready) as soon as these operations are completed. This bit indicates 0 (busy) in erase-suspend mode.

20.8.2 Erase Status (SR5 and FMR07 Bits)

Refer to 20.8.4 Full Status Check.

20.8.3 Program Status (SR4 and FMR06 Bits)

Refer to 20.8.4 Full Status Check.

Table 20.6 Status Register

Bits in the	Bits in the	Status	Con	itents	Value After
SRD Register	Register FMR0 Status Register Name		0	1	Reset
SR7 (D7)	FMR00	Sequence status	Busy	Ready	1
SR6 (D6)		Reserved	-	-	
SR5 (D5)	FMR07	Erase status	Completed normally	Terminated by error	0
SR4 (D4)	FMR06	Program status	Completed normally	Terminated by error	0
SR3 (D3)		Reserved	-	-	
SR2 (D2)		Reserved	-	-	
SR1 (D1)		Reserved	-	-	
SR0 (D0)		Reserved	-	-	

- D7 to D0: Indicates the data bus which is read out when executing the read status register command.
- The FMR07 bit (SR5) and FMR06 bit (SR4) are set to 0 by executing the clear status register command.
- When the FMR07 bit (SR5) or FMR06 bit (SR4) is set to 1, the program and block erase command are not accepted.



20.8.4 Full Status Check

If an error occurs, bits FMR06 to FMR07 in the FMR0 register are set to 1, indicating a specific error. Therefore, execution results can be comfirmed by verifying these status bits (full status check).

Table 20.7 lists errors and FMR0 register state. **Figure 20.14** shows a flow chart of the full status check and handling procedure for each error.

Table 20.7 Errors and FMR0 Register Status

FMR0	register				
(SRD re	RD register)				
status		Error	Error occurrence condition		
FMR07 FMR06					
(SR5)	(SR4)				
1	1	Command	An incorrect commands is written		
	sequence error		• A value other than xxD016 or xxFF16 is written in the second bu		
			cycle of the block erase command ⁽¹⁾		
			When the block erase command is executed on an protected block		
			When the program command is executed on protected blocks		
1	0	Erase error	The block erase command is executed on an unprotected block		
			but the program operation is not successfully completed		
0	1	Program error	• The program command is executed on an unprotected block but		
			the program operation is not successfully completed		

Note 1: The flash memory enters read array mode by writing command code xxFF₁₆ in the second bus cycle of these commands. The command code written in the first bus cycle becomes invalid.

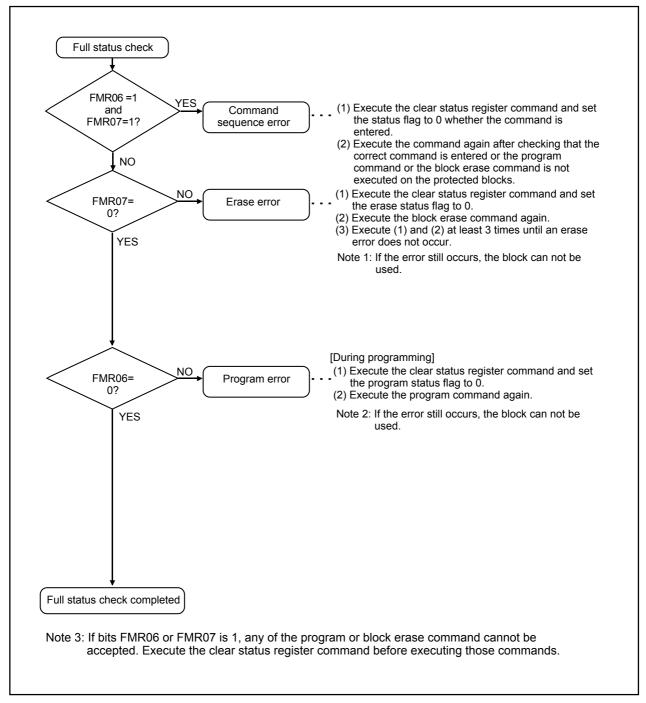


Figure 20.14 Full Status Check and Handling Procedure for Each Error

20.9 Standard Serial I/O Mode

In standard serial I/O mode, the serial programmer supporting the M16C/29 group can be used to rewrite the flash memory user ROM area, while the MCU is mounted on a board. For more information about the serial programmer, contact your serial programmer manufacturer. Refer to the user's manual included with your serial programmer for instruction.

Table 20.8 lists pin description (flash memory standard serial input/output mode). **Figures 20.15** and **20.16** show pin connections for standard serial input/output mode.

20.9.1 ID Code Check Function

The ID code check function determines whether or not the ID codes sent from the serial programmer matches those written in the flash memory. (Refer to **20.3 Functions To Prevent Flash Memory from Rewriting**.)



Table 20.8 Pin Descriptions (Flash Memory Standard Serial I/O Mode)

Pin	Nan	ne	I/O	Descriptio			
Vcc,Vss	Power input			Apply the voltage guaranteed for Program and Erase to Vcc pin and 0 V to Vss pin.			
CNVss	CNVs s		- 1	Connect to Vcc pin.			
RESET	Reset input		ı	Reset input pin. While RESET pin is "L", wait for td(ROC).			
XIN	Clock input		I	Connect a ceramic resonator or crystal oscillator between XIN and			
Хоит	Clock output		0	XOUT pins. To input an externally generated clock, input it to XIN pin and open XOUT pin.			
AVcc, AVss	Analog power	supply input		Connect AVss to Vss and AVcc to Vcc, respectively.			
VREF	Reference volt	tage input	I	Enter the reference voltage for AD conversion.			
P00 to P07	Input port P0		I	Input "H" or "L" signal or leave open.			
P10 to P15, P17	Input port P1		ı	Input "H" or "L" signal or leave open.			
P16	Input port P1		1	Connect this pin to Vcc while RESET pin is "L". (2)			
P20 to P27	Input port P2		I	Input "H" or "L" level signal or leave open.			
P30 to P37	Input port P3		ı	Input "H" or "L" level signal or leave open.			
P60 to P63	Input port P6		I	Input "H" or "L" level signal or leave open.			
P64	BUSY output		0	Standard serial I/O mode 1: BUSY signal output pin Standard serial I/O mode 2: Monitor signal output pin for boot program operation check			
P65	SCLK input		l	Standard serial I/O mode 1: Serial clock input pin Standard serial I/O mode 2: Input "L".			
P66	RxD input		1	Serial data input pin			
P67	TxD output		0	Serial data output pin ⁽¹⁾			
P70 to P77	Input port P7		ı	Input "H" or "L" signal or leave open.			
P80 to P84, P87	Input port P8		I	Input "H" or "L" signal or leave open.			
P85	RP input		- 1	Connect this pin to Vss while RESET pin is "L". (2)			
P86	CE input		I	Connect this pin to Vcc while RESET pin is "L". (2)			
P90 to P92, P95 to P97	Input port P9		I	Input "H" or "L" signal or leave open.			
P93	Input port P93	Normal-ver.	I/O	"H" signal is output for specific time. Input "H" signal or leave open.			
		T-ver./V-ver.	I	Input "H" or "L" signal or leave open.			
P100 to P107	Input port P10		1	Input "H" or "L" signal or leave open.			

- 1. When using standard serial I/O mode 1, to input "H" to the TxD pin is necessary while the RESET pin is held "L". Therefore, connect this pin to Vcc via a resistor. Adjust the pull-up resistor value on a system not to affect a data transfer after reset, because this pin changes to a data-output pin
- 2. Set the following, either or both.
 - -Connect the CE pin to Vcc.
 - -Connect the $\overline{\text{RP}}$ pin to VSS and P16 pin to Vcc.



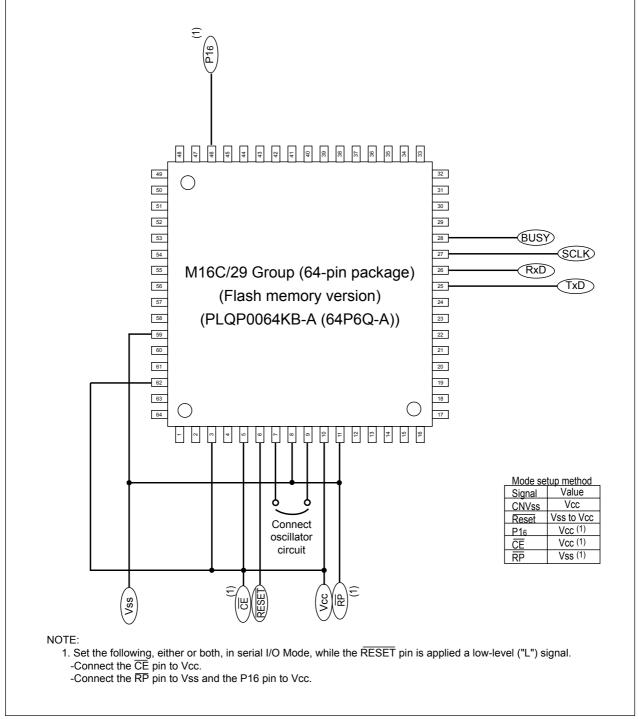


Figure 20.15 Pin Connections for Serial I/O Mode (1)

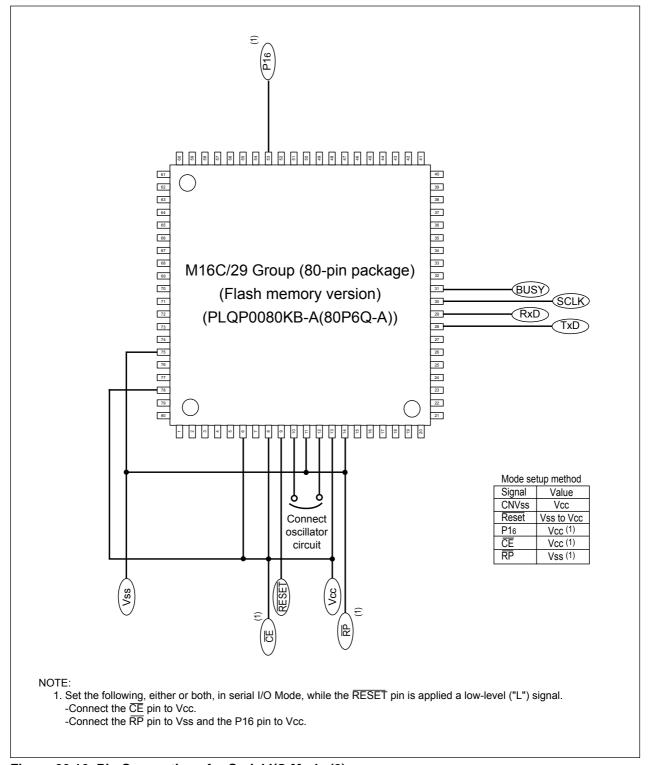
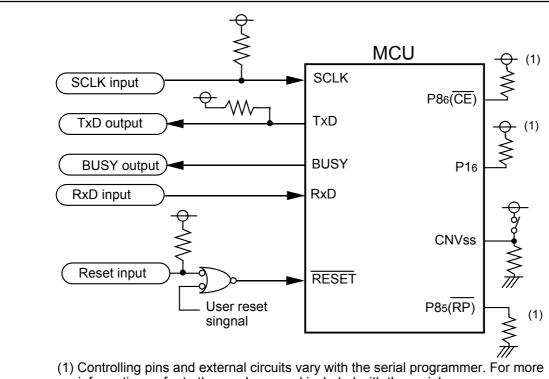


Figure 20.16 Pin Connections for Serial I/O Mode (2)

20.9.2 Example of Circuit Application in Standard Serial I/O Mode

Figure 20.17 shows an example of a circuit application in standard serial I/O mode 1 and Figure 20.18 shows an example of a circuit application in standard serial I/O mode 2. Refer to the user's manual of your serial programmer to handle pins controlled by the serial programmer.



- information, refer to the user's manual included with the serial programmer.
- (2) In this example, a selector controls the input voltage applied to CNVss to switch between single-chip mode and standard serial I/O mode.
- (3) In standard serial input/output mode 1, if the user reset signal becomes "L" while the MCU is communicating with the serial programmer, break the connection between the user reset signal and the RESET pin using a jumper switch.

- Set the following, either or both.
 Connect the <u>CE</u> pin to Vcc

 - Connect the RP pin to Vss and the P16 pin to Vcc

Figure 20.17 Circuit Application in Standard Serial I/O Mode 1

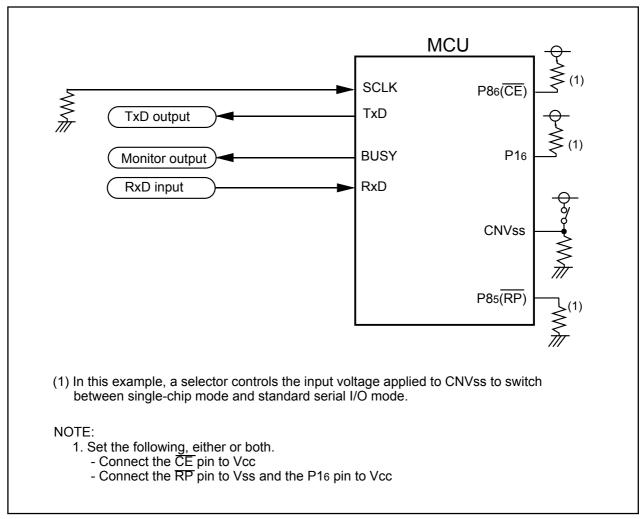


Figure 20.18 Circuit Application in Standard Serial I/O Mode 2

20.10 Parallel I/O Mode

In parallel input/output mode, the user ROM can be rewritten by a parallel programmer supporting the M16C/29 group. Contact your parallel programmer manufacturer for more information on the parallel programmer. Refer to the user's manual included with your parallel programmer for instructions.

20.10.1 ROM Code Protect Function

The ROM code protect function prevents the flash memory from being read or rewritten. (Refer to **20.3 Functions To Prevent Flash Memory from Rewriting**).



20.11 CAN I/O Mode

Note

The CAN I/O mode is not available in M16C/29 T-ver./V-ver.

In CAN I/O mode, the user ROM area can be rewritten while the MCU is mounted on-board by using a CAN programmer which is applicable for the M16C/29 group. For more information about CAN programmers, contact the manufacturer of your CAN programmer. For details on how to use, refer to the user's manual included with your CAN programmer.

Table 20.9 lists pin functions for CAN I/O mode. Figures 20.19 and 20.20 show pin connections for CAN I/O mode.

20.11.1 ID code check function

This function determines whether the ID codes sent from the CAN programmer and those written in the flash memory match.(Refer to **20.3 Functions To Prevent Flash Memory from Rewriting**.)



Table 20.9 Pin Functions for CAN I/O Mode

Pin	Name	I/O	Description				
Vcc,Vss	Power input		Apply the voltage guaranteed for Program and Erase to Vcc pin and 0 V to Vss pin.				
CNVss	CNVss	1	Connect to Vcc pin.				
RESET	Reset input	I	Reset input pin. While RESET pin is "L" level, wait for td(ROC).				
XIN	Clock input	I	Connect a ceramic resonator or crystal oscillator between XIN and				
Хоит	Clock output	0	XOUT pins. To input an externally generated clock, input it to XIN pin and open $XOUT$ pin.				
AVcc, AVss	Analog power supply input		Connect AVss to Vss and AVcc to Vcc, respectively.				
VREF	Reference voltage input	I	Enter the reference voltage for AD from this pin.				
P00 to P07	Input port P0	I	Input "H" or "L" level signal or leave open.				
P10 to P15, P17	Input port P1	I	Input "H" or "L" level signal or leave open.				
P16	Input port P1	I	Connect this pin to Vcc while RESET is low. (Note 1)				
P20 to P27	Input port P2	1	Input "H" or "L" level signal or leave open.				
P30 to P37	Input port P3	I	Input "H" or "L" level signal or leave open.				
P60 to P64, P66	Input port P6	I	Input "H" or "L" level signal or leave open.				
P65	SCLK input	l	Input "L" level signal.				
P67	TxD output	0	Input "H" level signal.				
P70 to P77	Input port P7	I	Input "H" or "L" level signal or leave open.				
P80 to P84, P87	Input port P8	I	Input "H" or "L" level signal or leave open.				
P85	RP input	I	Connect this pin to Vss while RESET is low. (Note 1)				
P86	CE input	I	Connect this pin to Vcc while RESET is low. (Note 1)				
P90 to P91, P95 to P97	Input port P9	I	Input "H" or "L" level signal or leave open.				
P92	CRX input	I	Connect this pin to a CAN transceiver.				
P93	CTX output	0	Connect this pin to a CAN transceiver.				
P100 to P107	Input port P10	I	Input "H" or "L" level signal or leave open.				

- 1. Set following either or both.
 - •Connect the $\overline{\text{CE}}$ pin to Vcc.
 - •Connect the $\overline{\mbox{RP}}$ pin to Vss and the P16 pin to Vcc.

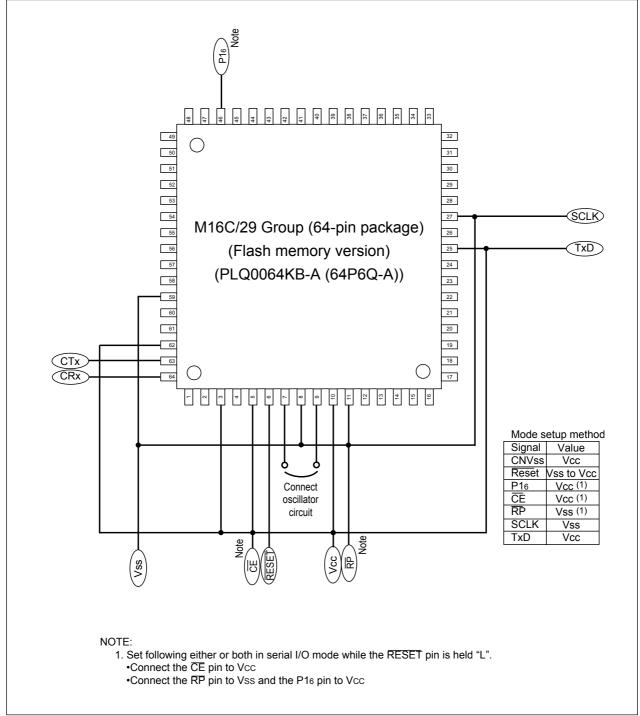


Figure 20.19 Pin Connections for CAN I/O Mode (1)

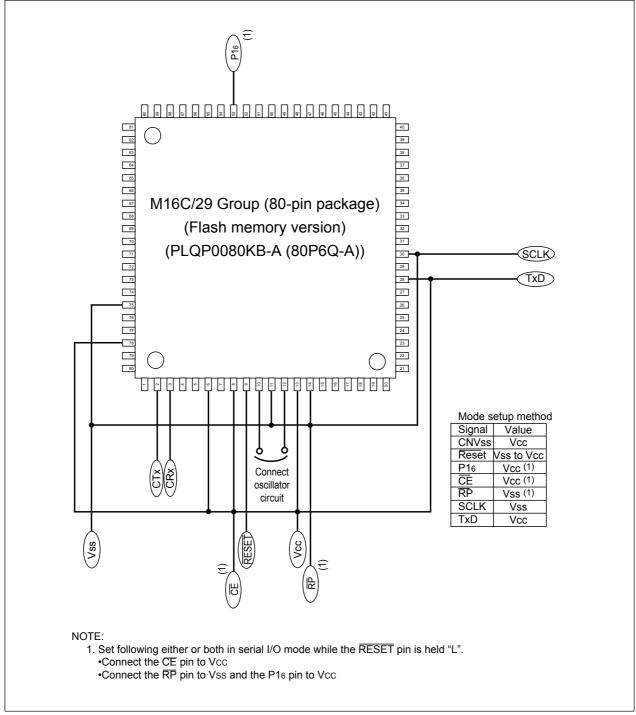


Figure 20.20 Pin Connections for CAN I/O Mode (2)

20.11.2 Example of Circuit Application in CAN I/O Mode

Figure 20.21 shows example of circuit application in CAN I/O mode. Refer to the user's manual for CAN programmer to handle pins controlled by a CAN programmer.

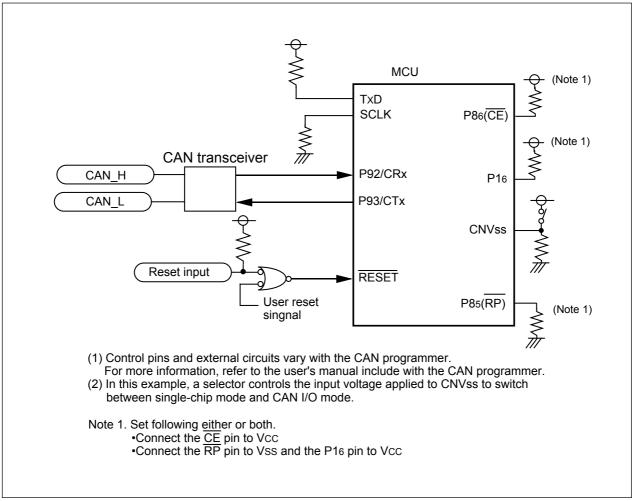


Figure 20.21 Circuit Application in CAN I/O Mode

21. Electrical Characteristics

21.1 Normal version

Table 21.1 Absolute Maximum Ratings

Symbol		Parameter		Condition	Value	Unit
Vcc	Supply Voltage			Vcc=AVcc	-0.3 to 6.5	V
AV∞	Analog Supply \	/oltage		Vcc=AVcc	-0.3 to 6.5	V
Vı	Input Voltage	P00 to P07, P10 to P17, P2 P30 to P37, P60 to P67, P2 P80 to P87, P90 to P93, P2 P100 to P107, XIN, VREF, RESET, CNVSS	70 to P77, 95 to P97,		-0.3 to V∞+0.3	V
Vo	Output Voltage	P0o to P07, P1o to P17, P2 P3o to P37, P6o to P67, P2 P8o to P87, P9o to P93, P2 P10o to P107, XOUT	70 to P77,		-0.3 to V∞+0.3	V
Pd	Power Dissipation	on		-40≤Topr≤85° C	300	mW
		during CPU operation			-20 to 85 / -40 to 85 ⁽¹⁾	° C
Topr	Operating Ambient during flash memory Temperature program and erase		Program Space (Block 0 to Block 5)		0 to 60	° C
		program and erase operation	Data Space (Block A, Block B)		-20 to 85 / -40 to 85 ⁽¹⁾	° C
Tstg	Storage Temper	rature			-65 to 150	° C

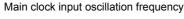
NOTE:

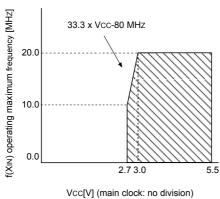
1. Refer to Table 1.6.

Table 21.2 Recommended Operating Conditions (Note 1)

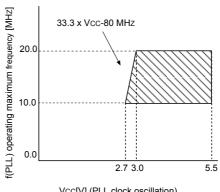
Cumbal		Parameter -			Standard			
Symbol				Min.	Тур.	Max.	Unit	
Vcc	Supply Voltage				2.7		5.5	V
AV∞	Analog Supply Vo	ltage	tage			Vœ		V
Vss	Supply Voltage					0		V
AVss	Analog Supply Vo	ltage				0		V
VIH	Input High ("H")	P00 to P07, P10 to	P17, P20 to P27, P	30 to P37, P60 to P67,	0.7V∞		Vœ	V
	Voltage	P70 to P77, P80 to	P87, P90 to P93, P	95 to P97, P100 to P107				
		XIN, RESET, CN	IVSS		0.8V∞		Vœ	V
		SDAMM, SCLMM	When I ² C bus inpu	t level is selected	0.7V∞		Vœ	V
		SDAMM, SCLMM	When SMBUS inpu	ut level is selected	1.4		Vcc	V
VIL	Input Low ("L")	P00 to P07, P10 to	P17, P20 to P27, P	30 to P37, P60 to P67,	0		0.3V∞	V
	Voltage	P70 to P77, P80 to	P87, P90 to P93, P	95 to P97, P100 to P107				
		XIN, RESET, CN			0		0.2V∞	V
		SDAMM, SCLMM	DA _{MA} SCI _{MM} When I ² C bus input level is selected		0		0.3V∞	V
		,	When SMBUS inpu		0		0.6	V
OH(peak)	Peak Output High ("H") Current			30 to P37, P60 to P67,			-10.0	mA
	,			95 to P97, P100 to P107				
IOH(avg)	Average Output High ("H") Current	1		30 to P37, P60 to P67,			-5.0	mA
	- ' '			95 to P97, P100 to P107			10.0	
OL(peak)	Peak Output Low ("L") Current			30 to P37, P60 to P67,			10.0	mA
la				95 to P97, P100 to P107			5.0	A
IOL(avg)	Average Output Low ("L") Current			30 to P37, P60 to P67,			5.0	mA
f(XIN)	Main Clock Input			95 to P97, P100 to P107 V∞=3.0 to 5.5V	0		20	MHz
I(XIN)	Iviairi Clock iriput v	Oscillation i reque	ricy. /	Vc=2.7 to 3.0V	0		33 X V∞-80	MHz
f(Xcin)	Sub Clock Oscillo	tion Fraguency		VCC=2.7 to 3.0V	0	32.768	50	kHz
,	Sub Clock Oscilla	· •			0.5			MHz
f1(ROC)	On-chip Oscillator				0.5	1 2	2	
f2(ROC)	On-chip Oscillator				·	_	4	MHz
f3(ROC)	On-chip Oscillator			h	8	16	26	MHz
f(PLL)	PLL Clock Oscilla	tion Frequency(4)		V∞=3.0 to 5.5V	10		20	MHz
				V∞=2.7 to 3.0V	10		33 X V∞-80	MHz
f(BCLK)	CPU Operation C			7	0		20	MHz
tsu(PLL)	Wait Time to Stab	oilize PLL Frequer	cy Synthesizer	V∞=5.0V			20	ms
				V∞=3.0V			50	ms

- 1. Referenced to $V\infty$ = 2.7 to 5.5V at Topr = -20 to 85 ° C / -40 to 85 ° C unless otherwise specified. 2. The mean output current is the mean value within 100ms.
- 3. The total IoL(peak) for all ports must be 80mA or less. The total IoH(peak) for all ports must be -80mA or less.
- 4. Relationship among main clock oscillation frequency, PLL clock oscillation frequency and supply voltage.





PLL clock oscillation frequency



Vcc[V] (PLL clock oscillation)

Table 21.3 A/D Conversion Characteristics (Note 1)

Symbol	Parameter		Measurement Condition	S	Standard			
Cymbol	T diameter		Meddarement condition	Min.	Тур.	Max.	Unit	
-	Resolution		V _{REF} =V _{CC}			10	Bits	
	Later and Market and Market	10 bit	VREF=Vcc=5V			±3	LSB	
INL	Integral Nonlinearity Error Absolute Accuracy Differential Nonlinearity Error Offset Error Gain Error Resistor Ladder Jobit Conversion Time	TO DIC	VREF=Vcc=3.3V			±5	LSB	
		8 bit	VREF=Vcc=3.3V			±2	LSB	
		10 bit	VREF=Vcc=5V			±3	LSB	
-		10 bit	VREF=Vcc=3.3V			±5	LSB	
		8 bit	VREF=Vcc=3.3V			±2	LSB	
DNL	Differential Nonlinearity	Error				±1	LSB	
-	Offset Error					±3	LSB	
-	Gain Error					±3	LSB	
RLADDER	Resistor Ladder		VREF=Vcc	10		40	kΩ	
tconv	10-bit Conversion Time Sample & Hold Function Available		VREF=Vcc=5V, φAD=10MHz	3.3			μs	
tconv	8-bit Conversion Time Sample & Hold Function	n Available	VREF=VCC=5V, φAD=10MHz	2.8			μs	
VREF	Reference Voltage			2.0		Vα	V	
VIA	Analog Input Voltage			0		VREF	V	

- 1. Referenced to Voc=AVoc=VREF= 3.3 to 5.5V, Vss=AVss=0V at Topr = -20 to 85 ° C / -40 to 85 ° C unless otherwise specified.
- 2. Keep φAD frequency at 10 MHz or less. Additionally, divide the f_{AD} if Vcc is less than 4.2V, and make φAD frequency equal to or lower than f_{AD}/2.
- 3. When sample & hold function is disabled, keep φAD frequency at 250 kHz or more in addition to the limitation in Note 2. When sample & hold function is enabled, keep φAD frequency at 1 MHz or more in addition to the limitation in Note 2.
- 4. When sample & hold function is enabled, sampling time is 3/ ϕ AD frequency. When sample & hold function is disabled, sampling time is 2/ ϕ AD frequency.



Table 21.4 Flash Memory Version Electrical Characteristics (1) for 100/1000 E/W cycle products [Program Space and Data Space in U3 and U5: Program Space in U7 and U9]

Symbol	Parameter			Standard			
Syllibol				Typ. ⁽²⁾	Max.	Unit	
-	Program and Erase Endurance ⁽³⁾		100/1000	(4, 11)		cycles	
-	Word Program Time (V∞=5.0V, Topr=25° C)			75	600	μs	
-	Block Erase Time	2-Kbyte Block		0.2	9	S	
	(V∞=5.0V, Topr=25° C)	8-Kbyte Block		0.4	9	S	
		16-Kbyte Block		0.7	9	s	
		32-Kbyte Block		1.2	9	s	
td(SR-ES)	Duration between Suspend Request and Erase Suspend				8	ms	
tps	Wait Time to Stabilize Flash Memory Circuit				15	μs	
-	Data Hold Time (5)		20			years	

Table 21.5 Flash Memory Version Electrical Characteristics (6) 10000 E/W cycle products (Option) [Data Space in U7 and U9⁽⁷⁾]

Symbol	Parameter		Standard			
Symbol			Typ. ⁽²⁾	Max.	Unit	
-	Program and Erase Endurance ^(3, 8, 9)	10000(4, 10))		cycles	
-	Word Program Time ($V\infty$ = 5.0 V, Topr = 25° C)		100		μs	
-	Block Erase Time ($V\infty$ = 5.0 V, Topr = 25° C) (2-Kbyte block)		0.3		S	
td(SR-ES)	Duration between Suspend Request and Erase Suspend			8	ms	
tps	Wait Time to Stabilize Flash Memory Circuit			15	μs	
-	Data Hold Time (5)	20			years	

- 1. Referenced to V∞= 2.7 to 5.5 V at Topr = 0 to 60° C (program space), unless otherwise specified.
- 2. Vcc = 5.0 V; Topr = 25° C
- 3. Program and erase endurance is defined as number of program-erase cycles per block. If program and erase endurance is n cycle (n = 100, 1000, 10000), each block can be erased and programmed n

For example, if a 2-Kbyte block A is erased after programming one-word data to each address 1,024 times, this counts as one program and erase endurance. Data cannot be programmed to the same address more than once without erasing the block. (rewrite prohibited).

- 4. Number of E/W cycles for which operation is guranteed (1 to minimum value are guaranteed).
- 5. Topr = 55° C
- 6. Referenced to Vcc= 2.7 to 5.5 V at T_{or}= -40 to 85° C(U7) / -20 to 85° C (U9) unless otherwise specifie.
- 7. Table 21.5 applies for data space in U7 and U9 when program and erase endurance is more than 1,000 cycles. Otherwise, use Table 21.4.
- 8. To reduce the number of program and erase endurance when working with systems requiring numerous rewrites, write to unused word addresses within the block instead of rewrite. Erase block only after all possible addresses are used. For example, an 8-word program can be written 128 times maximum before erase becomes necessary. Maintaining an equal number of times erasure between block A and block B will also improve efficiency. It is recommended to track the total number of erasure performed per block and to limit the number of erasure.
- 9. If an erase error is generated during block erase, execute the clear status register command and block erase command at least 3 times until an erase error is not generated.
- 10. When executing more than 100 times rewrites, set one wait state per block access by setting the FMR17 bit in the FMR1 register 1 to 1 (wait state). When accessing to all other blocks and internal RAM, wait state can be set by the PM17 bit, regardless of the FMR17 bit setting value.
- 11. The program and erase endurance is 100 cycles for program space and data space in U3 and U5; 1,000 cycles for program space in U7 and U9.
- 12. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for further details on the E/W failure rate.

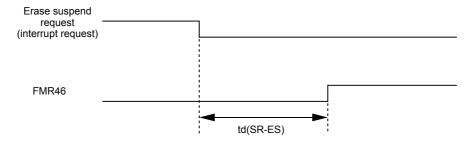




Table 21.6 Low Voltage Detection Circuit Electrical Characteristics (Note 1, Note 3)

Symbol	Parameter	Measurement Condition	Standard			Unit
			Min.	Тур.	Max.	
Vdet4	Low Voltage Detection Voltage ⁽¹⁾	V∞=0.8 to 5.5V	3.2	3.8	4.45	V
Vdet3	Reset Space Detection Voltage ⁽¹⁾		2.3	2.8	3.4	V
Vdet3s	Low Voltage Reset Hold Voltage ⁽²⁾				1.7	V
Vdet3r	Low Voltage Reset Release Voltage		2.35	2.9	3.5	V

- 1. Vdet4 >Vdet3
- 2. Vdet3s is the minmum voltage to maintain brown-out detection reset (hardware reset 2).
- 3. The low Voltage detection circuit is designed to use when $V\infty$ is set to 5V.
- 4. If the supply power voltage is greater than the reset level detection voltage when the reset level detection voltage is less than 2.7V, the operation at f(BCLK) < 10MHz is guranteed. However, A/D conversion, serial I/O, flash memory program and erase are excluded.</p>

Table 21.7 Power Supply Circuit Timing Characteristics

Symbol	Parameter	Measurement Condition	Standard			Unit
			Min.	Тур.	Max.	
td(P-R)	Wait Time to Stabilize Internal Supply Voltage when Power-on	- V∞= 2.7 to 5.5 V			2	ms
td(ROC)	Wait Time to Stabilize Internal On-chip Oscillator when Power-on				40	μs
td(R-S)	STOP Release Time				150	μs
td(W-S)	Low Power Dissipation Mode Wait Mode Release Time				150	μs
td(S-R)	Hardware Reset 2 Release Wait Time	V∞= Vdet3r to 5.5 V		6 ⁽¹⁾	20	ms
td(E-A)	Low Voltage Detection Circuit Operation Start Time	V∞= 2.7 to 5.5 V			20	μs

NOTE:

1. When V∞=5

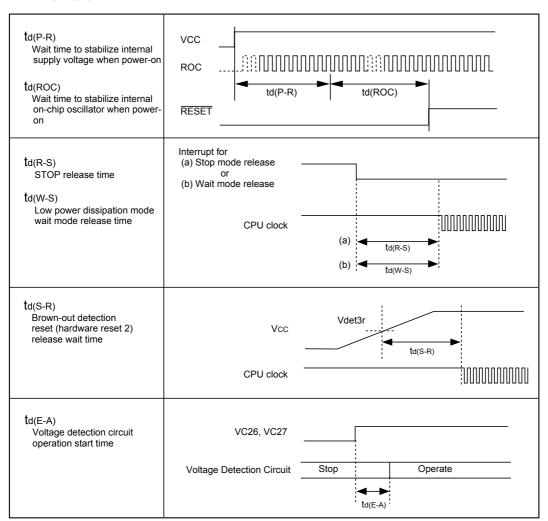


Table 21.8 Electrical Characteristics (Note 1)

Symbol	Parameter		Condition	Standard			Unit		
Symbol		rarameter		Condition	Min.	Тур.	Max.	10111	
Vон	Output High P00 to P07, P10 to P17, P20 to P27, P3			Ioн=-5mA	V∞-2.0		Vα	٧	
	("H") Voltage	P70 to P77, P80 to P87, F	P90 to P93	s, P95 to P97, P100 to P107					
Vон	Output High	P0o to P07, P1o to P17, F	P20 to P27	r, P3o to P37, P6o to P67,	Ioн=-200μA	Vcc-0.3		Vα	V
V OH	("H") Voltage	P70 to P77, P80 to P87, F	P90 to P93	s, P95 to P97, P100 to P107					
				High Power	lo⊢=-1mA	V∞-2.0		Vcc	V
. ,	Output High ((n) voltage	Хоит	Low Power	loн=-0.5mA	V∞-2.0		Vcc	1 V
Voh	Output High /	"Ll"\\/oltogo	Voc. =	High Power	No load applied		2.5		V
	Output High ((H) Voltage	Хсоит	Low Power	No load applied		1.6		\ \
Vol	Output Low	P0o to P07, P1o to P17, F			IaL=5mA			2.0	V
	("L") Voltage	P70 to P77, P80 to P87, F	P90 to P93	s, P95 to P97, P100 to P107					
\	Output Low	P0o to P07, P1o to P17, F			Ια=200μΑ			0.45	V
Vol		P70 to P77, P80 to P87, F	P90 to P93	3, P95 to P97, P100 to P107					
	0.441/	II II) \/-I4	V	High Power	lo=1mA			2.0	
	Output Low ("L") Voltage	"L") Voltage	Хоит	Low Power	IoL=0.5mA			2.0	\ \
Vol	Output Low ("L") Voltage	W W Y 4	.,	High Power	No load applied		0		
		Хсоит	Low Power	No load applied		0		\ \	
VT+-VT-	Hysteresis	TA0in-TA4in, TB0in-TB2i	n, INTo-IN	IT5, NMI, ADTRG, CTS0-		0.2		1.0	V
		CTS2, SCL, SDA, CLK0	-CLK2, TA	20ur-TA4our, Klo-Kl3, Rxdo-					
		RXD2, SIN3, SIN4							
VT+-VT-	Hysteresis	RESET				0.2		2.5	V
VT+-VT-	Hysteresis	XIN				0.2		0.8	V
Іін	Input High	P0o to P07, P1o to P17, F	P20 to P27	, P30 to P37, P60 to P67,	Vi=5V			5.0	μΑ
	("H") Current	P70 to P77, P80 to P87, F	90 to P93	s, P95 to P97, P100 to P107					
		XIN, RESET, CNVss							
lıL	Input Low	P0o to P07, P1o to P17, F	P20 to P27	r, P30 to P37, P60 to P67,	Vi=0V			-5.0	μА
	("L") Current	P70 to P77, P80 to P87, F	P90 to P93	s, P95 to P97, P100 to P107					
		XIN, RESET, CNVss							
RPULLUP	Pull-up	P0o to P07, P1o to P17, F	P20 to P27	r, P30 to P37, P60 to P67,	Vi=0V	30	50	170	kΩ
	Resistance	P70 to P77, P80 to P87, F	P90 to P93	s, P95 to P97, P100 to P107					
Rfxin	Feedback Re	sistance	XIN				1.5		ΜΩ
Rfxcin	Feedback Re	sistance	Xcin				15		ΜΩ
VRAM	RAM Standby	/ Voltage	1		In stop mode	2.0			V
NOTES		<u> </u>							\bot

^{1.} Referenced to Vcc=4.2 to 5.5V, Vss=0V at Topr=-20 to 85 ° C / -40 to 85 ° C, f(BCLK)=20MHz unless otherwise specified.

Table 21.9 Electrical Characteristics (2) (Note 1)

Symbol	Parameter	meter Measurement Condition		5	Standaı	d d	Uni	
Cymbol	i alameter		Measurer	Herit Coridition	Min.	Тур.	Max.	1011
lœ	Power Supply Current	t left open and	Mask ROM	f(BCLK) = 20 MHz, main clock, no division		18	25	mA
	(V∞=4.2 to 5.5V)	other pins are connected to Vss		On-chip oscillation, f _{2(ROC)} selected, f(BCLK) = 1 MHz		2		mA
			Flash memory	f(BCLK) = 20 MHz, main clock, no division		18	25	mA
				On-chip oscillation, f _{2(ROC)} selected, f(BCLK) = 1 MHz		2		mA
			Flash memory program	f(BCLK) = 10 MHz, Vcc = 5.0 V		11		mA
			Flash memory erase	f(BCLK) = 10 MHz, Vcc = 5.0 V		11		mA
Mask ROM	Mask ROM	f(BCLK) = 32 kHz, In low-power consumption mode, Program running on ROM ⁽³⁾		25		μA		
	On-chip oscillation, f _{2(ROC)} selected, f(BCLK) = 1 MHz, In wait mode		50		μА			
			Flash memory	f(BCLK) = 32 kHz, In low-power consumption mode, Program running on RAM ⁽³⁾		25		μА
				f(BCLK) = 32 kHz, In low-power consumption mode, Program running on flash memory ⁽³⁾		450		μА
				On-chip oscillation, f _{2(ROC)} selected, f(BCLK) = 1 MHz, In wait mode ⁽⁴⁾		50		μА
			Mask ROM, Flash memory	f(BCLK) = 32 kHz, In wait mode ⁽²⁾ , Oscillation capacity high		8.5		μА
				f(BCLK) = 32 kHz, In wait mode ⁽²⁾ , Oscillation capacity low		3		μА
			While clock stops, Topr = 25° C		0.8	3	μΑ	
ldet4	Low voltage detec	tion dissipation cu	rent ⁽⁴⁾			0.7	4	μА
ldet3	Reset area detecti	ion dissipation curr	ent ⁽⁴⁾			1.2	8	μА

- 1. Referenced to $V\infty$ = 4.2 to 5.5 V, Vs = 0 V at Topr = -20 to 85° C / -40 to 85° C, f(BCLK) = 20 MHz unless otherwise specified.
- With one timer operates, using fc32.
 This indicates the memory in which the program to be executed exists.
- 4. Idet is dissipation current when the following bit is set to 1 (detection circuit enabled). Idet4: VC27 bit in the VCR2 register Idet3: VC26 bit in the VCR2 register



Timing Requirements

(VCC = 5V, VSS = 0V, at Topr = -20 to 85° C / -40 to 85° C unless otherwise specified)

Table 21.10 External Clock Input (XIN input)

Symbol	Parameter	Stan	Unit	
	raiailletei		Max.	
tc	External Clock Input Cycle Time	50		ns
tw(H)	External Clock Input High ("H") Width	20		ns
tw(L)	External Clock Input Low ("L") Width	20		ns
tr	External Clock Rise Time		9	ns
tf	External Clock Fall Time		9	ns

Timing Requirements

(VCC = 5V, VSS = 0V, at Topr = -20 to 85° C / -40 to 85° C unless otherwise specified)

Table 21.11 Timer A Input (Counter Input in Event Counter Mode)

Coursels al	Parameter	Standard		1.1:4
Symbol		Min.	Max.	Unit
tc(TA)	TAin input cycle time	100		ns
tw(TAH)	TAin input HIGH pulse width	40		ns
tw(TAL)	TAiเท input LOW pulse width	40		ns

Table 21.12 Timer A Input (Gating Input in Timer Mode)

	Parameter	Standard		
Symbol		Min.	Max.	Unit
tc(TA)	TAin input cycle time	400		ns
tw(TAH)	TAin input HIGH pulse width	200		ns
tw(TAL)	TAin input LOW pulse width	200		ns

Table 21.13 Timer A Input (External Trigger Input in One-shot Timer Mode)

Symbol	Parameter	Standard		Linit
Symbol		Min.	Max.	Unit
tc(TA)	TAin input cycle time	200		ns
tw(TAH)	TAim input HIGH pulse width	100		ns
tw(TAL)	TAin input LOW pulse width	100		ns

Table 21.14 Timer A Input (External Trigger Input in Pulse Width Modulation Mode)

Symbol	Parameter	Stan	l lmit	
		Min.	Max.	Unit
tw(TAH)	TAim input HIGH pulse width	100		ns
tw(TAL)	TAil input LOW pulse width	100		ns

Table 21.15 Timer A Input (Counter Increment/decrement Input in Event Counter Mode)

Symbol	December	Star	Unit	
	Parameter			Max.
tc(UP)	TAiout input cycle time	2000		ns
tw(UPH)	TAiout input HIGH pulse width	1000		ns
tw(UPL)	TAiout input LOW pulse width	1000		ns
tsu(UP-TIN)	TAiout input setup time	400		ns
th(TIN-UP)	TAiout input hold time	400		ns

Table 21.16 Timer A Input (Two-phase Pulse Input in Event Counter Mode)

Company of	Parameter	Standard		l lait
Symbol		Min.	Max.	Unit
tc(TA)	TAin input cycle time	800		ns
tsu(TAIN-TAOUT)	TAio∪⊤ input setup time	200		ns
tsu(TAOUT-TAIN)	TAil input setup time	200		ns



Timing Requirements

(VCC = 5V, VSS = 0V, at Topr = -20 to 85° C / -40 to 85° C unless otherwise specified)

Table 21.17 Timer B Input (Counter Input in Event Counter Mode)

Symbol	Parameter	Standard		1.1:4
		Min.	Max.	Unit
tc(TB)	TBiin input cycle time (counted on one edge)	100		ns
tw(TBH)	TBiin input HIGH pulse width (counted on one edge)	40		ns
tw(TBL)	TBin input LOW pulse width (counted on one edge)	40		ns
tc(TB)	TBin input cycle time (counted on both edges)	200		ns
tw(TBH)	TBiin input HIGH pulse width (counted on both edges)	80		ns
tw(TBL)	TBin input LOW pulse width (counted on both edges)	80		ns

Table 21.18 Timer B Input (Pulse Period Measurement Mode)

Symbol	Parameter		Standard	
Symbol			Max.	Unit
tc(TB)	TBiin input cycle time	400		ns
tw(TBH)	TBiin input HIGH pulse width	200		ns
tw(TBL)	TBiin input LOW pulse width	200		ns

Table 21.19 Timer B Input (Pulse Width Measurement Mode)

Symbol	Parameter		Standard	
Symbol			Max.	Unit
tc(TB)	TBin input cycle time	400		ns
tw(TBH)	TBin input HIGH pulse width	200		ns
tw(TBL)	TBiin input LOW pulse width	200		ns

Table 21.20 A /D Trigger Input

Symbol	Parameter	Standard		Unit
Symbol		Min.	Max.	UIIIL
tc(AD)	ADTRG input cycle time (trigger able minimum)	1000		ns
tw(ADL)	ADTRG input LOW pulse width	125		ns

Table 21.21 Serial I/O

Symbol	Parameter	Star	Unit	
Syllibol		Min.	Max.	Offic
tc(CK)	CLKi input cycle time	200		ns
tw(CKH)	CLKi input HIGH pulse width	100		ns
tw(CKL)	CLKi input LOW pulse width	100		ns
td(C-Q)	TxDi output delay time		80	ns
th(C-Q)	TxDi hold time	0		ns
tsu(D-C)	RxDi input setup time	70		ns
th(C-D)	RxDi input hold time	90		ns

Table 21.22 External Interrupt INTi Input

Symbol	Parameter	Standard		Unit
	i arameter	Min.	Max.	Offic
tw(INH)	INTi input HIGH pulse width	250		ns
tw(INL)	INTi input LOW pulse width	250		ns



Timing Requirements

(VCC = 5V, VSS = 0V, at Topr = -20 to 85° C / -40 to 85° C unless otherwise specified)

Table 21.23 Multi-master I²C bus Line

Oaab al	Darameter	Standard clock mode		High-speed	Linit	
Symbol	Parameter	Min.	Max.	Min.	Max.	Unit
tBUF	Bus free time	4.7		1.3		μs
tHD;STA	The hold time in start condition	4.0		0.6		μs
tLOW	The hold time in SCL clock 0 status	4.7		1.3		μs
tR	SCL, SDA signals' rising time		1000	20+0.1Cb	300	ns
tHD;DAT	Data hold time	0		0	0.9	μs
tHIGH	The hold time in SCL clock 1 status	4.0		0.6		μs
tF	SCL, SDA signals' falling time		300	20+0.1Cb	300	ns
tsu;DAT	Data setup time	250		100		ns
tsu;STA	The setup time in restart condition	4.7		0.6		μs
tsu;STO	Stop condition setup time	4.0		0.6		μs

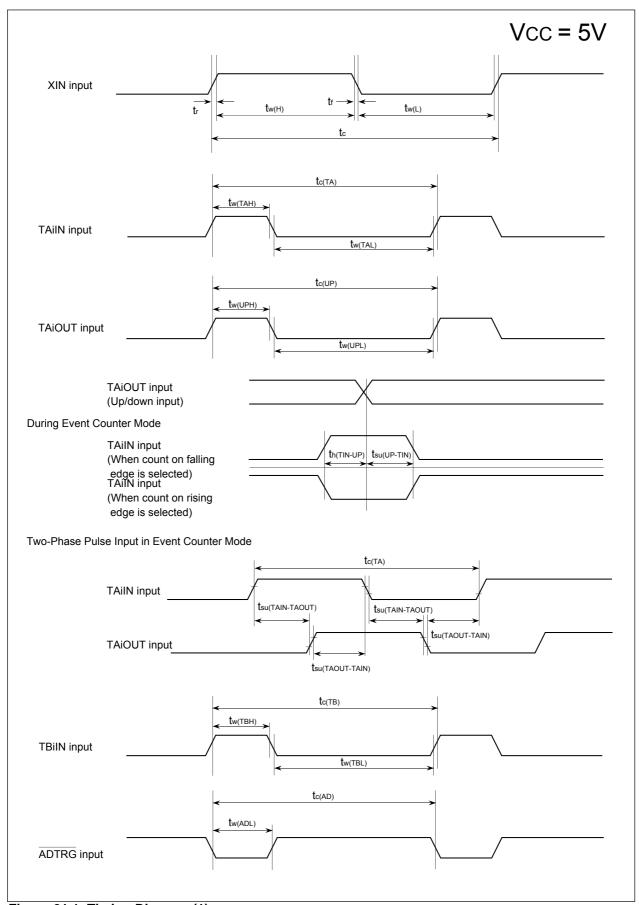


Figure 21.1 Timing Diagram (1)

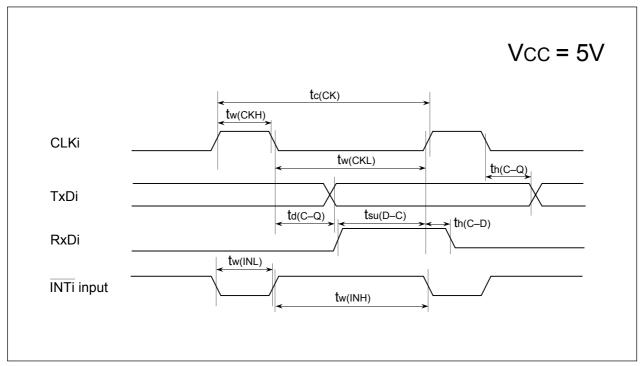


Figure 21.2 Timing Diagram (2)

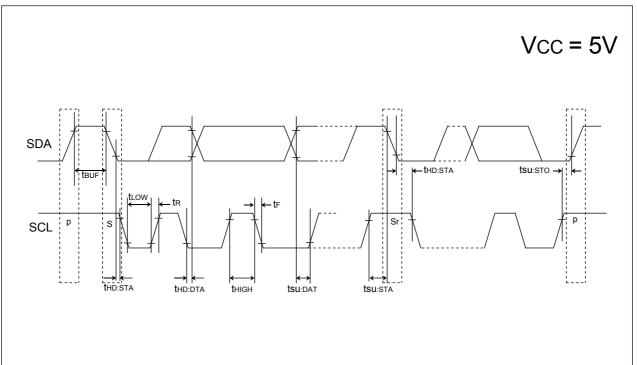


Figure 21.3 Timing Diagram (3)

Table 21.24 Electrical Characteristics (Note 1)

Symbol		Parar	notor		Condition	Sta	andar	b	Unit
Symbol		Falai	iletei		Condition	Min.	Тур.	Max.	Oili
Vон		P00 to P07, P10 to P17, F P70 to P77, P80 to P87, F		7, P3 ₀ to P3 ₇ , P6 ₀ to P6 ₇ , 3, P9 ₅ to P9 ₇ , P10 ₀ to P10 ₇	Iон= -1 mA	Vcc-0.5		Vœ	V
			Холг	High Power	Iон= -0.1 mA	V∞-0.5		Vα	V
Vон	Output High (n) voltage	AOUI	Low Power	Іон= -50 μΑ	V∞-0.5		Vα	\ \
VOH	O. 4 4 - -	W. W. VH	V	High Power	No load applied		2.5		
	Output High ("H") Voltage	Хсоит	Low Power	No load applied		1.6		V
VaL		P00 to P07, P10 to P17, F P70 to P77, P80 to P87, F		7, P30 to P37, P60 to P67, 3, P95 to P97, P100 to P107	IoL= 1 mA			0.5	V
				High Power	IoL= 0.1 mA			0.5	Ţ,
	Output Low ('L") Voltage	Хол	Low Power	IoL = 50 μA			0.5	\ \
Vol				High Power	No load applied		0		
	Output Low ("L") Voltage	Хсоит	Low Power	No load applied		0		\ \
VT+-VT-	Hysteresis	TA0IN-TA4IN, TB0IN-TB2I CTS2, SCL, SDA, CLK0- RXD2, SIN3, SIN4	•	IT5, NMI, ADTRG, CTS0- A20ut-TA4out, Klo-Kl3, Rxdo-				0.8	V
VT+-VT-	Hysteresis	RESET						1.8	V
VT+-VT-	Hysteresis	XIN						0.8	V
lін	Input High ("H") Current			7, P30 to P37, P60 to P67, 3, P95 to P97, P100 to P107	V _I = 3 V			4.0	μА
lıL	Input Low ("L") Current			7, P30 to P37, P60 to P67, 3, P95 to P97, P100 to P107	Vi = 0 V			-4.0	μА
RPULLUP	Pull-up Resistance			7, P30 to P37, P60 to P67, 3, P95 to P97, P100 to P107	VI= 0 V	50	100	500	kΩ
Rfxin	Feedback Re	sistance	XIN				3.0		ΜΩ
Rfxan	Feedback Re	sistance	Xcin				25		ΜΩ
VRAM	RAM Standby	/ Voltage	1		In stop mode	2.0			V

^{1.} Referenced to $V\infty$ = 2.7 to 3.6 V, Vss = 0 V at Topr = -20 to 85 $^{\circ}$ C / -40 to 85 $^{\circ}$ C, f(BCLK) = 10MHz unless otherwise specified.

Table 21.25 Electrical Characteristics (2) (Note 1)

Symbol	Parameter		Magauran	nent Condition	Standard			Unit
Symbol	Parameter		weasuren	nent Condition	Min.	Тур.	Max.	10111
lœ	Power Supply Current	Output pins are left open and	Mask ROM	f(BCLK) = 10 MHz, main clock, no division		8	13	mA
	$(V\infty = 2.7 \text{ to } 3.6V)$	other pins are connected to Vss		On-chip oscillation, f _{2(ROC)} selected, f(BCLK) = 1 MHz		1		mA
			Flash memory	f(BCLK) = 10 MHz, main clock, no division		8	13	mA
			Flash memory program	f(BCLK) = 10 MHz, Vcc = 3.0 V		11		mA
		Fla	Flash memory erase	f(BCLK) = 10 MHz, Vcc= 3.0 V		11		mA
			Mask ROM	f(BCLK) = 32 kHz, In low-power consumption mode, Program running on ROM ⁽³⁾		20		μΑ
				On-chip oscillation, f _{2(ROC)} selected, f(BCLK) = 1 MHz, In wait mode		25		μА
			Flash memory	f(BCLK) = 32 kHz, In low-power consumption mode, Program running on RAM ⁽³⁾		20		μА
				f(BCLK) = 32 kHz, In low-power consumption mode, Program running on flash memory ⁽³⁾		450		μА
				On-chip oscillation, f _{2(ROC)} selected, f(BCLK) = 1 MHz, In wait mode ⁽⁴⁾		45		μА
			Mask ROM, Flash memory	f(BCLK) = 32 kHz, In wait mode ⁽²⁾ , Oscillation capacity high		6.6		μΑ
				f(BCLK) = 32 kHz, In wait mode ⁽²⁾ , Oscillation capacity low		2.2		μΑ
				While clock stops, Topr = 25° C		0.7	3	μΑ
ldet4	Low voltage detection	on dissipation curre	ent ⁽⁴⁾	•		0.6	4	μΑ
ldet3	Reset level detection	n dissipation currer	nt ⁽⁴⁾			1.0	5	μΑ

- 1. Referenced to $V\infty$ = 2.7 to 3.6 V, Vss = 0 V at Topr = -20 to 85 ° C / -40 to 85 ° C, f(BCLK) = 10 MHz unless otherwise specified.
- 2. With one timer operates, using fc32.
- 3. This indicates the memory in which the program to be executed exists.
 4. Idet is dissipation current when the following bit is set to 1 (detection circuit enabled). Idet4: the VC27 bit of the VCR2 register Idet3: the VC26 bit in the VCR2 register



Timing Requirements

(VCC = 3V, VSS = 0V, at Topr = -20 to 85° C / -40 to 85° C unless otherwise specified)

Table 21.26 External Clock Input (XIN input)

Symbol	Parameter -	Standard		Unit
		Min.	Max.	Offic
tc	External clock input cycle time	100		ns
tw(H)	External clock input HIGH pulse width	40		ns
tw(L)	External clock input LOW pulse width	40		ns
tr	External clock rise time		18	ns
tf	External clock fall time		18	ns

Timing Requirements

(VCC = 3V, VSS = 0V, at Topr = -20 to 85° C / -40 to 85° C unless otherwise specified)

Table 21.27 Timer A Input (Counter Input in Event Counter Mode)

Symbol	Parameter	Standard		1.1:4
		Min.	Max.	Unit
tc(TA)	TAin input cycle time	150		ns
tw(TAH)	TAin input HIGH pulse width	60		ns
tw(TAL)	TAin input LOW pulse width	60		ns

Table 21.28 Timer A Input (Gating Input in Timer Mode)

Symbol		Standard		
	Parameter	Min.	Max.	Unit
tc(TA)	TAin input cycle time	600		ns
tw(TAH)	TAin input HIGH pulse width	300		ns
tw(TAL)	TAin input LOW pulse width	300		ns

Table 21.29 Timer A Input (External Trigger Input in One-shot Timer Mode)

Symbol	Parameter	Star	Standard	
	Parameter	Min.	Max.	Unit
tc(TA)	TAin input cycle time	300		ns
tw(TAH)	TAiเท input HIGH pulse width	150		ns
tw(TAL)	TAin input LOW pulse width	150		ns

Table 21.30 Timer A Input (External Trigger Input in Pulse Width Modulation Mode)

Symbol	Parameter	Standard		l lmit
		Min.	Max.	Unit
tw(TAH)	TAin input HIGH pulse width	150		ns
tw(TAL)	TAin input LOW pulse width	150		ns

Table 21.31 Timer A Input (Counter Increment/decrement Input in Event Counter Mode)

Symbol	Parameter	Stan	l lmit	
		Min.	Max.	Unit
tc(UP)	TAiout input cycle time	3000		ns
tw(UPH)	TAiout input HIGH pulse width	1500		ns
tw(UPL)	TAiout input LOW pulse width	1500		ns
tsu(UP-TIN)	TAiout input setup time	600		ns
th(TIN-UP)	TAiout input hold time	600		ns

Table 21.32 Timer A Input (Two-phase Pulse Input in Event Counter Mode)

Symbol	Parameter		Standard		
			Max.	Unit	
tc(TA)	TAin input cycle time	2		μs	
tsu(TAIN-TAOUT)	TAiout input setup time	500		ns	
tsu(TAOUT-TAIN)	TAilN input setup time	500		ns	



Timing Requirements

(VCC = 3V, VSS = 0V, at Topr = -20 to 85° C / -40 to 85° C unless otherwise specified)

Table 21.33 Timer B Input (Counter Input in Event Counter Mode)

Symbol	Description	Star	Linit	
	Parameter	Min.	Max.	Unit
tc(TB)	TBin input cycle time (counted on one edge)	150		ns
tw(TBH)	TBin input HIGH pulse width (counted on one edge)	60		ns
tw(TBL)	TBiin input LOW pulse width (counted on one edge)	60		ns
tc(TB)	TBiin input cycle time (counted on both edges)	300		ns
tw(TBH)	TBin input HIGH pulse width (counted on both edges)	120		ns
tw(TBL)	TBilN input LOW pulse width (counted on both edges)	120		ns

Table 21.34 Timer B Input (Pulse Period Measurement Mode)

Symbol	Parameter		Standard	
			Max.	Unit
tc(TB)	TBiin input cycle time	600		ns
tw(TBH)	TBiin input HIGH pulse width	300		ns
tw(TBL)	TBiin input LOW pulse width	300		ns

Table 21.35 Timer B Input (Pulse Width Measurement Mode)

Symbol	Parameter		Standard		
			Max.	Unit	
tc(TB)	TBiin input cycle time	600		ns	
tw(TBH)	TBiin input HIGH pulse width	300		ns	
tw(TBL)	TBin input LOW pulse width	300		ns	

Table 21.36 A/D Trigger Input

Symbol	Parameter	Standard		Unit	
Symbol	Falanetei		Max.	UIIIL	
tc(AD)	ADTRG input cycle time (trigger able minimum)	1500		ns	
tw(ADL)	ADTRG input LOW pulse width	200		ns	

Table 21.37 Serial I/O

Symbol	Parameter	Standard		Unit
Symbol	raidilletei	Min.	Max.	Offic
tc(CK)	CLKi input cycle time	300		ns
tw(CKH)	CLKi input HIGH pulse width	150		ns
tw(CKL)	CLKi input LOW pulse width	150		ns
td(C-Q)	TxDi output delay time		160	ns
th(C-Q)	TxDi hold time	0		ns
tsu(D-C)	RxDi input setup time	100		ns
th(C-D)	RxDi input hold time	90		ns

Table 21.38 External Interrupt INTi Input

Symbol	Parameter		Parameter Standard	
	Falanicici	Min.	Max.	Unit
tw(INH)	INTi input HIGH pulse width	380		ns
tw(INL)	INTi input LOW pulse width	380		ns

Timing Requirements

(VCC = 3V, VSS = 0V, at Topr = -20 to 85° C / -40 to 85° C unless otherwise specified)

Table 21.39 Multi-master I²C bus Line

O. mala al	Parameter -	Standard clock mode		High-speed	Linit	
Symbol		Min.	Max.	Min.	Max.	Unit
tBUF	Bus free time	4.7		1.3		μs
tHD;STA	The hold time in start condition	4.0		0.6		μs
tLOW	The hold time in SCL clock 0 status	4.7		1.3		μs
tR	SCL, SDA signals' rising time		1000	20+0.1Cb	300	ns
tHD;DAT	Data hold time	0		0	0.9	μs
tHIGH	The hold time in SCL clock 1 status	4.0		0.6		μs
tF	SCL, SDA signals' falling time		300	20+0.1Cb	300	ns
tsu;DAT	Data setup time	250		100		ns
tsu;STA	The setup time in restart condition	4.7		0.6		μs
tsu;STO	Stop condition setup time	4.0		0.6		μs

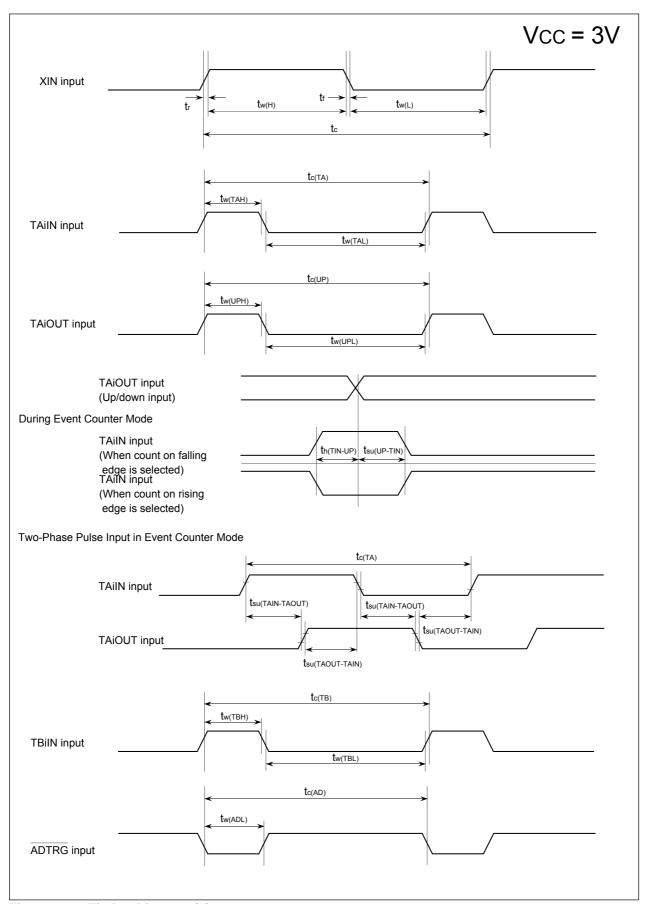


Figure 21.4 Timing Diagram (1)

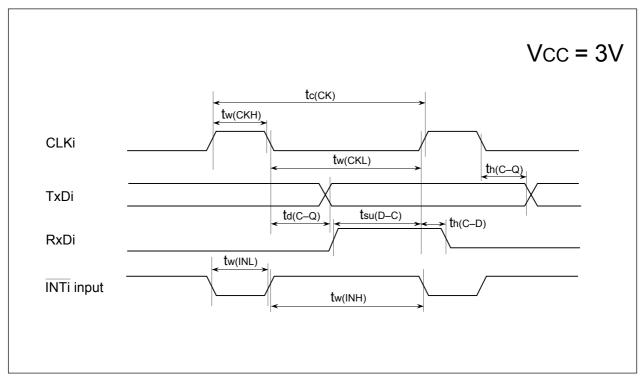


Figure 21.5 Timing Diagram (2)

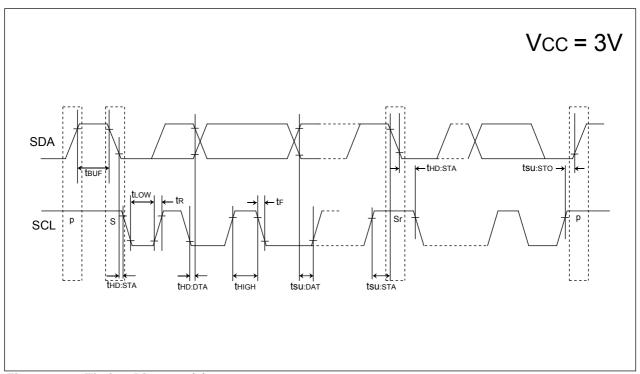


Figure 21.6 Timing Diagram (3)

21.2 T version

Table 21.40 Absolute Maximum Ratings

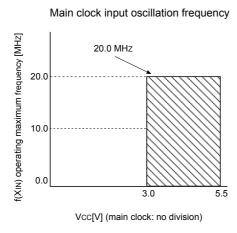
Symbol		Parameter		Condition	Value	Unit
Vcc	Supply Voltage			Vc=AVc	-0.3 to 6.5	V
AV∞	Analog Supply \	/oltage		Vc=AVc	-0.3 to 6.5	V
Vı	Input Voltage	P00 to P07, P10 to P17, F	P20 to P27,			
		P30 to P37, P60 to P67, F	P70 to P77,			
		P80 to P87, P90 to P93, F	95 to P97,		-0.3 to V∞+0.3	V
		P10 ₀ to P10 ₇ ,				
		XIN, VREF, RESET, CNVs	S			
Vo	Output Voltage	P0o to P07, P1o to P17, F				
		P30 to P37, P60 to P67, F				
		P80 to P87, P90 to P93, F	95 to P97,		-0.3 to Vcc+0.3	V
		P10 ₀ to P10 ₇ ,				
		Хоит				
Pd	Power Dissipation	on		-40 <u><</u> Topr <u><</u> 85° C	300	mW
		during CPU operation			-40 to 85	°C
Topr	Operating Ambient	during flash memory	Program Space (Block 0 to Block 5)		0 to 60	° C
	Temperature	Temperature program and erase operation			-40 to 85	°C
Tstg	Storage Temper	rature			-65 to 150	°C

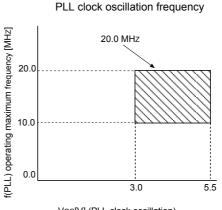
Table 21.41 Recommended Operating Conditions (Note 1)

Symbol	Parameter			Stand	ard	Unit		
Symbol		Parameter		Min.	Тур.	Max.		
Vcc	Supply Voltage				3.0		5.5	V
AV∞	Analog Supply Vo	pply Voltage				Vœ		V
Vss	Supply Voltage					0		V
AVss	Analog Supply Vo	ltage				0		V
VIH	Input High ("H")	P00 to P07, P10 t	o P17, P20 to P27, P3	30 to P37, P60 to P67,	0.7Vcc		Vcc	V
Voltage	P70 to P77, P80 t	o P87, P90 to P93, P9	95 to P97, P100 to P107					
		XIN, RESET, CI	NVSS		0.8Vcc		Vcc	V
		CDA CCI	When I ² C bus input	level is selected	0.7Vcc		Vcc	V
		SDAMM, SCLMM	When SMBUS inpu	t level is selected	1.4		Vcc	V
VIL	Input Low ("L")	P0o to P07, P1o t	o P17, P20 to P27, P3	30 to P37, P60 to P67,	0		0.3Vcc	V
Voltage	Voltage	P70 to P77, P80 t	o P87, P90 to P93, P9	95 to P97, P100 to P107				
	XIN, RESET, CI	NVSS		0		0.2V∞	V	
	SDAMM, SCLMM	When I2C bus input	level is selected	0		0.3V∞	V	
		SDAMM, SCEMM	When SMBUS inpu	t level is selected	0		0.6	V
OH(peak)	Peak Output High	P00 to P07, P10 t	o P17, P20 to P27, P3	30 to P37, P60 to P67,			-10.0	mA
	("H") Current			95 to P97, P100 to P107				
IOH(avg)	Average Output			30 to P37, P60 to P67,			-5.0	mA
	High ("H") Current	F 70 tO F 77, F 80 t	<u> </u>	95 to P97, P100 to P107				
OL(peak)	Peak Output Low ("L") Current			30 to P37, P60 to P67,			10.0	mA
	` ′			95 to P97, P100 to P107				
OL(avg)	Average Output Low ("L") Current			30 to P37, P60 to P67,			5.0	mA
504	` ′			95 to P97, P100 to P107				1
f(XIN)	Main Clock Input	<u>.</u>	ency ⁽⁴⁾		0		20	MHz
f(Xan)	Sub Clock Oscilla					32.768	50	kHz
f ₁ (ROC)	On-chip Oscillator				0.5	1	2	MHz
f2(ROC)	On-chip Oscillator				1	2	4	MHz
f3(ROC)	On-chip Oscillator Frequency 3		8	16	26	MHz		
f(PLL)		PLL Clock Oscillation Frequency ⁽⁴⁾		10		20	MHz	
f(BCLK)		Operation Clock Frequency			0		20	MHz
tsu(PLL)	Wait Time to Stab	ilize PLL Freque	ncy Synthesizer	Vcc=5.0V			20	ms
				V∞=3.0V			50	ms

NOTES:

- 1. Referenced to $V\infty$ = 3.0 to 5.5V at Topr = -40 to 85 ° C unless otherwise specified. 2. The mean output current is the mean value within 100ms. 3. The total loupeak for all ports must be 80mA or less. The total loupeak for all ports must be -80mA or less.
- 4. Relationship among main clock oscillation frequency, PLL clock oscillation frequency and supply voltage.





Vcc[V] (PLL clock oscillation)

Table 21.42 A/D Conversion Characteristics (Note 1)

Symbol	Parameter		Measurement Condition		Standard		
Cymbol	rarameter		Wedstrement Schallon	Min.	Тур.	Max.	Unit
-	Resolution		VREF = VCC			10	Bits
		10 bit	VREF = VCC = 5 V			±3	LSB
INL	Integral Nonlinearity Error	10 bit	VREF = Vcc = 3.3 V			±5	LSB
		8 bit	VREF = Vcc = 3.3 V			±2	LSB
		10 bit	VREF = VCC = 5 V			±3	LSB
-	- Absolute Accuracy	10 bit	VREF = Vcc = 3.3 V			±5	LSB
		8 bit	VREF = Vcc = 3.3 V			±2	LSB
DNL	Differential Nonlinearity	Error				±1	LSB
-	Offset Error					±3	LSB
-	Gain Error					±3	LSB
RLADDER	Resistor Ladder		VREF = VCC	10		40	kΩ
toonv	10-bit Conversion Time Sample & Hold Function		VREF = VCC=5 V, ØAD = 10 MHz	3.3			μs
toonv	8-bit Conversion Time Sample & Hold Function Available		VREF = Vcc = 5 V, ØAD = 10 MHz	2.8			μs
VREF	Reference Voltage			2.0		Vα	V
VIA	Analog Input Voltage			0		VREF	V

- 1. Referenced to Vcc = AVcc = VREF= 3.3 to 5.5 V, Vss = AVss= 0 V at Topr = -40 to 85° C unless otherwise specified.
- 2. Keep ϕAD frequency at 10 MHz or less. Additionally, divide the fxD if V cc is less than 4.2 V, and make ϕAD frequency equal to or lower than fab/2.
- 3. When sample & hold function is disabled, keep ϕAD frequency at 250 kHz or more in addition to the limitation in Note 2. When sample & hold function is enabled, keep ϕAD frequency at 1 MHz or more in addition to the limitation in Note 2.
- 4. When sample & hold function is enabled, sampling time is $3/\phi AD$ frequency. When sample & hold function is disabled, sampling time is 2/ \$\phiAD\$ frequency.



Table 21.43 Flash Memory Version Electrical Characteristics ⁽¹⁾ for 100/1000 E/W cycle products [Program Space and Data Space in U3; Program Space in U7]

Symbol	Parameter			Standard		
Syllibol				Typ. ⁽²⁾	Max.	Unit
-	Program and Erase Endurance ⁽³⁾		100/1000	(4, 11)		cycles
-	Word Program Time (Vcc = 5.0 V, Topr = 25	° C)		75	600	μs
-	Block Erase Time	2-Kbyte Block		0.2	9	s
	(Vcc = 5.0 V, Topr = 25° C)	8-Kbyte Block		0.4	9	S
		16-Kbyte Block		0.7	9	s
		32-Kbyte Block		1.2	9	S
td(SR-ES)	Duration between Suspend Request and Erase Suspend				8	ms
tps	Wait Time to Stabilize Flash Memory Circuit				15	μs
-	Data Hold Time (5)		20			years

Table 21.44 Flash Memory Version Electrical Characteristics (6) for 10000 E/W cycle products

[Data Space in U7⁽⁷⁾]

Symbol	Parameter	Standard			Unit
	Falametei	Min.	Typ. ⁽²⁾	Max.	
-	Program and Erase Endurance ^(3, 8, 9)	10000(4, 10)		cycles
-	Word Program Time (V∞ = 5.0 V, Topr = 25° C)		100		μs
-	Block Erase Time (V∞ = 5.0V, Topr = 25° C) (2-Kbyte block)		0.3		S
td(SR-ES)	Duration between Suspend Request and Erase Suspend			8	ms
tps	Wait Time to Stabilize Flash Memory Circuit			15	μs
-	Data Hold Time (5)	20			years

NOTES:

- 1. Referenced to VCC = 3.0 to 5.5 V at Topr = 0 to 60° C (program space)/ Topr = -40 to 85° C(data space), unless otherwise specified.
- 2. VCC = 5.0 V; TOPR = 25° C
- 3. Program and erase endurance is defined as number of program-erase cycles per block.

 If program and erase endurance is *n* cycle (*n* = 100, 1000, 10000), each block can be erased and programmed *n* cycles.

For example, if a 2-Kbyte block A is erased after programming one-word data to each address 1,024 times, this counts as one program and erase endurance. Data cannot be programmed to the same address more than once without erasing the block. (rewrite prohibited).

- 4. Number of E/W cycles for which operation is guranteed (1 to minimum value are guranteed).
- 5. Topr = 55° C
- 6. Referenced to VCC = 3.0 to 5.5 V at Topr = -40 to 85° C unless otherwise specified.
- Table 21.44 applies for data space in U7 when program and erase endurance is more than 1,000 cycles. Otherwise, use Table 21.43.
- 8. To reduce the number of program and erase endurance when working with systems requiring numerous rewrites, write to unused word addresses within the block instead of rewrite. Erase block only after all possible addresses are used. For example, an 8-word program can be written 128 times maximum before erase becomes necessary. Maintaining an equal number of times erasure between block A and block B will also improve efficiency. It is recommended to track the total number of erasure performed per block and to limit the number of erasure.
- 9. If an erase error is generated during block erase, execute the clear status register command and block erase command at least 3 times until an erase error is not generated.
- 10. When executing more than 100 times rewrites, set one wait state per block access by setting the FMR17 bit in the FMR1 register to 1 (wait state). When accessing to all other blocks and internal RAM, wait state can be set by the PM17 bit, regardless of the FMR17 bit setting value.
- 11. The program and erase endurance is 100 cycles for program space and data space in U3; 1,000 cycles for program space in U7.
- 12. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for further details on the E/W failure rate.

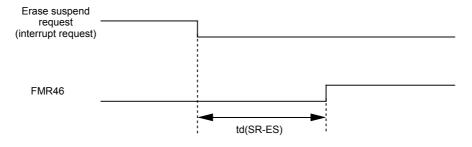




Table 21.45 Power Supply Circuit Timing Characteristics

Symbol	Parameter	Measurement Condition	5	Unit		
		Wedsdrenient Condition	Min.	Тур.	Max.	
td(P-R)	Wait Time to Stabilize Internal Supply Voltage when Power-on	Vcc = 3.0 to 5.5V			2	ms
td(ROC)	Wait Time to Stabilize Internal On-chip Oscillator when Power-on				40	μs
td(R-S)	STOP Release Time ⁽¹⁾				150	μs
td(W-S)	Low Power Dissipation Mode Wait Mode Release Time				150	μs

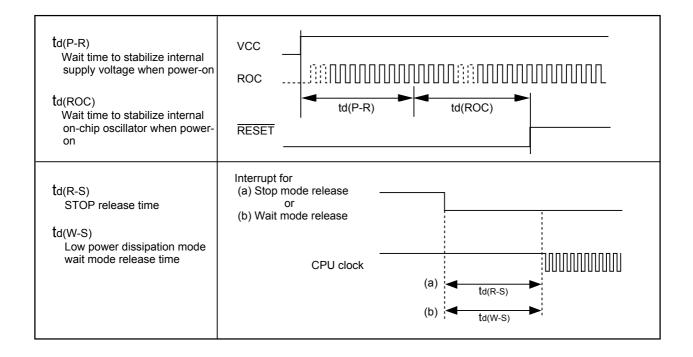


Table 21.46 Electrical Characteristics (Note 1)

Symbol		Parameter		Condition	Sta	andar	d	Unit	
Syllibol		Falai	песеі		Condition	Min.	Тур.	Max.	Offic
Vон		P00 to P07, P10 to P17, F			Iон = -5 mA	V∞-2.0		Vcc	٧
				s, P95 to P97, P100 to P107					
Vон		P0 ₀ to P0 ₇ , P1 ₀ to P1 ₇ , F			Іон = -200 μА	V∞-0.3		Vcc	V
VOIT	("H") Voltage	P7 ₀ to P7 ₇ , P8 ₀ to P8 ₇ , F	P9₀ to P9₃	s, P95 to P97, P100 to P107					
	Output High ("H") Voltage	Холт	High Power	Iон = -1 mA	V∞-2.0		Vœ	V
Vон	Catput riigii (iii) voltage	7.001	Low Power	Iон = -0.5 mA	V∞-2.0		Vcc	•
VOH	O. 4 4 - -	W. W. V14	V	High Power	No load applied		2.5		.,
	Output High ("H") Voltage	Хсоит	Low Power	No load applied		1.6		V
VaL	Output Low	P00 to P07, P10 to P17, F	20 to P27	r, P30 to P37, P60 to P67,	IoL = 5 mA			2.0	V
	("L") Voltage	P70 to P77, P80 to P87, P90 to P93, P95 to P97, P100 to P10		s, P95 to P97, P100 to P107					
VaL	Output Low	P0o to P07, P1o to P17, F	P20 to P27	r, P30 to P37, P60 to P67,	Ιοι = 200 μΑ			0.45	V
Val	("L") Voltage	P70 to P77, P80 to P87, F	P90 to P93	s, P95 to P97, P100 to P107					
	0.441/	II II) \ / - I4	V	High Power	IoL = 1 mA			2.0	.,
	Output Low ("L") Voltage	Xout Low Power	IoL = 0.5 mA			2.0	V		
Vol		High Power		High Power	No load applied		0		
	Output Low ('	ut Low ("L") Voltage	Хсоит	Low Power	No load applied		0		V
VT+-VT-	Hysteresis	TA0in-TA4in, TB0in-TB2i	n, INTo-IN	IT5, NMI, ADTRG, CTS0-		0.2		1.0	V
		CTS2, SCL, SDA, CLK0-	-CLK2, TA	2007-TA400T, KI0-KI3, RXD0-					
		RXD2, SIN3, SIN4							
VT+-VT-	Hysteresis	RESET				0.2		2.5	V
VT+-VT-	Hysteresis	XIN				0.2		0.8	V
Іін	Input High	P0o to P07, P1o to P17, F	P20 to P27	r, P3o to P3r, P6o to P6r,	Vı = 5 V			5.0	μΑ
	("H") Current	P70 to P77, P80 to P87, F	P90 to P93	s, P95 to P97, P100 to P107					
		XIN, RESET, CNVss							
I⊫	Input Low	P00 to P07, P10 to P17, F			Vı = 0 V			-5.0	μΑ
	("L") Current	P70 to P77, P80 to P87, F	P90 to P93	s, P95 to P97, P100 to P107					
		XIN, RESET, CNVss							
RPULLUP	Pull-up	P0 ₀ to P0 ₇ , P1 ₀ to P1 ₇ , F	P20 to P27	7, P30 to P37, P60 to P67,	Vı = 0 V	30	50	170	kΩ
	Resistance	P70 to P77, P80 to P87, F	P90 to P93	3, P95 to P97, P100 to P107					
Rfxin	Feedback Re	sistance	XIN				1.5		МΩ
Rfxan	Feedback Re	sistance	Xcin				15		МΩ
VRAM	RAM Standby	√ Voltage	Ī		In stop mode	2.0			V
NOTES	-								

^{1.} Referenced to Vcc=4.2 to 5.5V, Vss=0V at Topr=-40 to 85 ° C, f(BCLK)=20MHz unless otherwise specified.

Table 21.47 Electrical Characteristics (2) (Note 1)

Vcc = 5V

Symbol	Parameter	rameter Measurement Condition			Standaı	ď	Unit	
Symbol	Farameter		Measuren	ient Condition	Min.	Тур.	Max.	Onit
Ιœ	Power Supply Current	Output pins are left open and	Mask ROM	f(BCLK) = 20 MHz, main clock, no division		18	25	mA
	(Vcc=4.2 to 5.5V)	other pins are connected to Vss		On-chip oscillation, f2(ROC) selected, f(BCLK) = 1 MHz		2		mA
			Flash memory	f(BCLK) = 20 MHz, main clock, no division		18	25	mA
				On-chip oscillation, f2(ROC) selected, f(BCLK) = 1 MHz		2		mA
			Flash memory program	f(BCLK) = 10 MHz, Vcc = 5.0 V		11		mA
			Flash memory erase	f(BCLK) = 10 MHz, Vcc = 5.0 V		11		mA
			Mask ROM	f(BCLK) = 32 kHz, In low-power consumption mode, Program running on ROM ⁽³⁾		25		μΑ
				On-chip oscillation, f _{2(ROC)} selected, f(BCLK) = 1 MHz, In wait mode		50		μА
			Flash memory	f(BCLK) = 32 kHz, In low-power consumption mode, Program running on RAM ⁽³⁾		25		μА
				f(BCLK) = 32 kHz, In low-power consumption mode, Program running on flash memory ⁽³⁾		450		μА
				On-chip oscillation, f _{2(ROC)} selected, f(BCLK) = 1 MHz, In wait mode		50		μА
			Mask ROM, Flash memory	f(BCLK) = 32 kHz, In wait mode ⁽²⁾ , Oscillation capacity high		8.5		μА
				f(BCLK) = 32 kHz, In wait mode ⁽²⁾ , Oscillation capacity low		3		μА
				While clock stops, Topr = 25° C		0.8	3	μА

- 1. Referenced to $V\infty$ = 4.2 to 5.5 V, Vss = 0 V at Topr = -40 to 85 ° C, f(BCLK) = 20 MHz unless otherwise specified.
- With one timer operates, using fc32.
 This indicates the memory in which the program to be executed exists.

Timing Requirements

(VCC = 5V, VSS = 0V, at Topr = -40 to 85°C unless otherwise specified)

Table 21.48 External Clock Input (XIN input)

Symbol	Parameter	Stan	Unit	
		Min.	Max.	Oilit
tc	External Clock Input Cycle Time	50		ns
tw(H)	External Clock Input High ("H") Width	20		ns
tw(L)	External Clock Input Low ("L") Width	20		ns
tr	External Clock Rise Time		9	ns
tf	External Clock Fall Time		9	ns



Timing Requirements

(VCC = 5V, VSS = 0V, at Topr = -40 to 85°C unless otherwise specified)

Table 21.49 Timer A Input (Counter Input in Event Counter Mode)

Symbol	Parameter	Standard		l lait
		Min.	Max.	Unit
tc(TA)	TAin input cycle time	100		ns
tw(TAH)	TAin input HIGH pulse width	40		ns
tw(TAL)	TAin input LOW pulse width	40		ns

Table 21.50 Timer A Input (Gating Input in Timer Mode)

Symbol	_	Standard		
	Parameter	Min.	Max.	Unit
tc(TA)	TAin input cycle time	400		ns
tw(TAH)	TAil input HIGH pulse width	200		ns
tw(TAL)	TAim input LOW pulse width	200		ns

Table 21.51 Timer A Input (External Trigger Input in One-shot Timer Mode)

Symbol	Parameter	Standard		Unit
	raidilletei	Min.	Max.	Offic
tc(TA)	TAin input cycle time	200		ns
tw(TAH)	TAin input HIGH pulse width	100		ns
tw(TAL)	TAin input LOW pulse width	100		ns

Table 21.52 Timer A Input (External Trigger Input in Pulse Width Modulation Mode)

Symbol	Parameter	Standard		Unit
	Parameter	Min.	Max.	Ullit
tw(TAH)	TAin input HIGH pulse width	100		ns
tw(TAL)	TAilN input LOW pulse width	100		ns

Table 21.53 Timer A Input (Counter Increment/decrement Input in Event Counter Mode)

Symbol	Parameter	Star	l lmit	
		Min.	Max.	Unit
tc(UP)	TAiout input cycle time	2000		ns
tw(UPH)	TAiout input HIGH pulse width	1000		ns
tw(UPL)	TAiouT input LOW pulse width	1000		ns
tsu(UP-TIN)	TAiout input setup time	400		ns
th(TIN-UP)	TAiout input hold time	400		ns

Table 21.54 Timer A Input (Two-phase Pulse Input in Event Counter Mode)

Symbol	Darameter	Standard		Lloit
	Parameter	Min.	Max.	Unit
tc(TA)	TAilN input cycle time	800		ns
tsu(TAIN-TAOUT)	TAiout input setup time	200		ns
tsu(TAOUT-TAIN)	TAin input setup time	200		ns



Timing Requirements

(VCC = 5V, VSS = 0V, at Topr = -40 to 85°C unless otherwise specified)

Table 21.55 Timer B Input (Counter Input in Event Counter Mode)

Symbol	Parameter	Stan	Standard		
		Min.	Max.	Unit	
tc(TB)	TBiin input cycle time (counted on one edge)	100		ns	
tw(TBH)	TBiin input HIGH pulse width (counted on one edge)	40		ns	
tw(TBL)	TBin input LOW pulse width (counted on one edge)	40		ns	
tc(TB)	TBin input cycle time (counted on both edges)	200		ns	
tw(TBH)	ТВім input HIGH pulse width (counted on both edges)	80		ns	
tw(TBL)	TBin input LOW pulse width (counted on both edges)	80		ns	

Table 21.56 Timer B Input (Pulse Period Measurement Mode)

Symbol	Parameter	Standard		Unit
	raianietei	Min.	Max.	Offic
tc(TB)	TBiin input cycle time	400		ns
tw(TBH)	TBiin input HIGH pulse width	200		ns
tw(TBL)	TBiin input LOW pulse width	200		ns

Table 21.57 Timer B Input (Pulse Width Measurement Mode)

Symbol	Parameter	Standard		Unit
	i arameter	Min.	Max.	Offic
tc(TB)	TBin input cycle time	400		ns
tw(TBH)	TBin input HIGH pulse width	200		ns
tw(TBL)	TBiin input LOW pulse width	200		ns

Table 21.58 A/D Trigger Input

Symbol	Parameter	Standard		Unit
	r arameter	Min.	Max.	Offic
tc(AD)	ADTRG input cycle time (trigger able minimum)	1000		ns
tw(ADL)	ADTRG input LOW pulse width	125		ns

Table 21.59 Serial I/O

Symbol	Parameter	Standard		Unit
	Faianietei	Min.	Max.	Offic
tc(CK)	CLKi input cycle time	200		ns
tw(CKH)	CLKi input HIGH pulse width	100		ns
tw(CKL)	CLKi input LOW pulse width	100		ns
td(C-Q)	TxDi output delay time		80	ns
th(C-Q)	TxDi hold time	0		ns
tsu(D-C)	RxDi input setup time	70		ns
th(C-D)	RxDi input hold time	90		ns

Table 21.60 External Interrupt INTi Input

Symbol	mbol Parameter	Standard		Unit
Symbol	i arameter	Min. Max.	Max.	
tw(INH)	INTi input HIGH pulse width	250		ns
tw(INL)	INTi input LOW pulse width	250		ns



Timing Requirements

(VCC = 5V, VSS = 0V, at Topr = -40 to 85° C unless otherwise specified)

Table 21.61 Multi-master I²C bus Line

Cumhal	Dovemeter	Standard clock mode		High-speed	1.1:4	
Symbol	Parameter	Min.	Max.	Min.	Max.	Unit
tBUF	Bus free time	4.7		1.3		μs
tHD;STA	The hold time in start condition	4.0		0.6		μs
tLOW	The hold time in SCL clock 0 status	4.7		1.3		μs
tR	SCL, SDA signals' rising time		1000	20+0.1Cb	300	ns
tHD;DAT	Data hold time	0		0	0.9	μs
tHIGH	The hold time in SCL clock 1 status	4.0		0.6		μs
tF	SCL, SDA signals' falling time		300	20+0.1Cb	300	ns
tsu;DAT	Data setup time	250		100		ns
tsu;STA	The setup time in restart condition	4.7		0.6		μs
tsu;STO	Stop condition setup time	4.0		0.6		μs

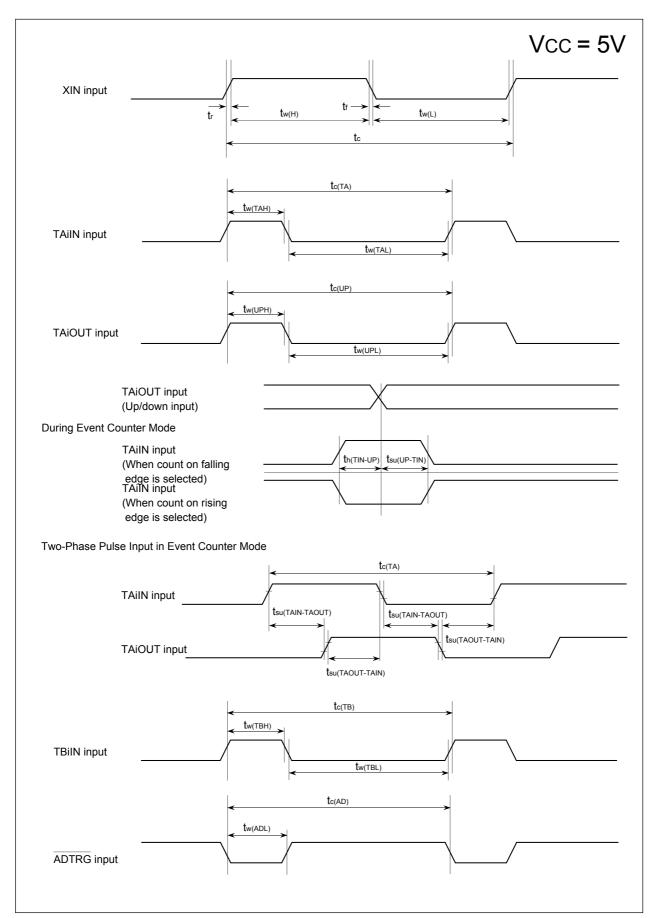


Figure 21.7 Timing Diagram (1)

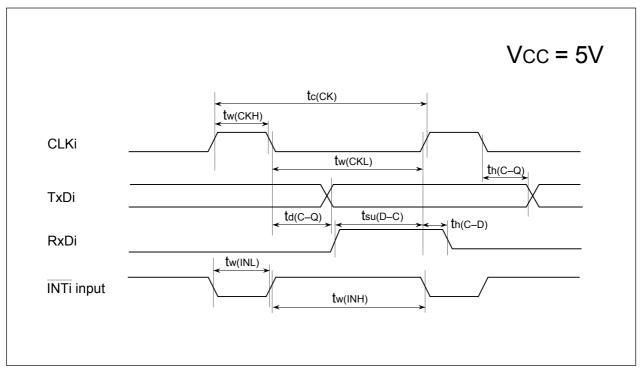


Figure 21.8 Timing Diagram (2)

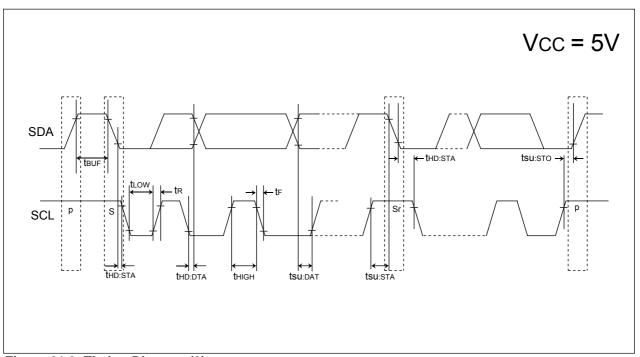


Figure 21.9 Timing Diagram (3)

Table 21.62 Electrical Characteristics (Note)

Vcc = 3V

	Darar	motor		Condition		Standard		
	Faiai	песе		Condition	Min.	Тур.	Max.	Unit
				Iон = -1 mA	V∞-0.5		Vœ	V
	High Power Ich = -0.1 mA		V∞-0.5		Vα	V		
Output High (H) Voltage	XOUI	Low Power	Іон = -50 μΑ	V∞-0.5		Vα	V
0 (((((((((((((((((((III IIIN NA III		High Power	No load applied		2.5		.,
Output High ("H") Voltage	XCOUT	Low Power	No load applied		1.6		V
				IoL = 1 mA			0.5	V
	•		High Power	IoL = 0.1 mA			0.5	.,
Output Low ('L") Voltage	Xout	Low Power	IoL= 50 μA			0.5	V
			High Power	No load applied		0		
Output Low ('	'L") Voltage	Хсоит	Low Power	No load applied		0		V
Hysteresis	CTS2, SCL, SDA, CLK0	-					0.8	V
Hysteresis	· · ·						1.8	V
Hysteresis	XIN						0.8	V
Input High ("H") Current				V _I = 3 V			4.0	μА
Input Low ("L") Current				V1 = 0 V			-4.0	μА
Pull-up Resistance				VI = 0 V	50	100	500	kΩ
Feedback Re	1	XIN	,			3.0		ΜΩ
Feedback Re	sistance	Xcin				25		МΩ
		_		In stop mode	2.0			V
	Output High ("H") Voltage Output High (Output High (Output Low ("L") Voltage Output Low (' Output Low (' Hysteresis Hysteresis Hysteresis Input High ("H") Current Input Low ("L") Current Pull-up Resistance Feedback Re	Output High ("H") Voltage Output High ("H") Voltage Output High ("H") Voltage Output Low ("L") Voltage Hysteresis TAOIN-TA4IN, TBOIN-TB2ICTS2, SCL, SDA, CLKORXO2, SIN3, SIN4 Hysteresis RESET Hysteresis XIN Input High ("H") Current P70 to P07, P10 to P17, F10 to P77, P80 to P87, F10 to P77,	Output High ("H") Voltage P00 to P07, P10 to P17, P20 to P20 to P90 to P970 to P77, P80 to P87, P90 to P90 to P90 to P970 to P77, P80 to P87, P90 to P90 to P90 to P07, P10 to P17, P20 to P20 to P77, P80 to P87, P90 to P90 to P77, P80 to P87, P90 to P90 to P77, P80 to P87, P90 to P77, P80 to P87, P90 to P90 to P70 to P77, P80 to P87, P90 to P90 to P90 to P77, P80 to P87, P90 to P90 to P90 to P77, P80 to P87, P90 to P	Output High ("H") Voltage P00 to P07, P10 to P17, P20 to P27, P30 to P37, P60 to P67, P10 to P107 Output High ("H") Voltage XCUT High Power Low Power Output High ("H") Voltage XCUT High Power Low Power Output Low ("L") Voltage P00 to P07, P10 to P17, P20 to P27, P30 to P37, P60 to P67, P70 to P77, P80 to P87, P90 to P93, P95 to P97, P100 to P107 Output Low ("L") Voltage XCUT High Power Low Power Output Low ("L") Voltage XCUT High Power Low Power Utput Low ("L") Voltage XCUT High Power Low Power Hysteresis TAOIN-TA4IN, TBOIN-TB2IN, INTO-INT5, NMI, ADIRG, CTS0-CTS2, SCL, SDA, CLK0-CLK2, TA2cur-TA4cur, Klo-Kl3, Rxo-Rxo2, SIN3, SIN4 Hysteresis RESET Hysteresis XIN Input High ("H") Current P70 to P77, P80 to P87, P90 to P93, P95 to P97, P100 to P107 XIN, RESET, CNVss Input Low ("L") Current P70 to P77, P80 to P87, P90 to P93, P95 to P97, P100 to P107 XIN, RESET, CNVss Pull-up Resistance P00 to P07, P10 to P17, P20 to P27, P30 to P37, P60 to P67, P70 to P77, P80 to P87, P90 to P93, P95 to P97, P100 to P107 Feedback Resistance XIN	Output High ("H") Voltage	Parameter Condition Min.	Parameter	Parameter Parameter Condition Min. Typ. Max.

^{1.} Referenced to $V\infty$ = 3.0 to 3.6 V, Vss = 0 V at Topr = -40 to 85 ° C, f(BCLK) = 20 MHz unless otherwise specified.

Table 21.63 Electrical Characteristics (2) (Note 1)

Vcc = 3V

Symbol	Parameter		Measuren	nent Condition	5	Standar	d	Unit
Symbol	Farameter		Measuren	lent Condition	Min.	Тур.	Max.	Offic
lα	Power Supply Current	Output pins are left open and	Mask ROM	f(BCLK) = 10 MHz, main clock, no division		8	13	mA
	(Vcc=3.0 to 3.6V)	other pins are connected to Vss		On-chip oscillation, f2(ROC) selected, f(BCLK) = 1 MHz		1		mA
			Flash memory	f(BCLK) = 10 MHz, main clock, no division		8	13	mA
			Flash memory program	f(BCLK) = 10 MHz, Vcc = 3.0 V		11		mA
			Flash memory erase	f(BCLK) = 10MHz, Vcc = 3.0 V		11		mA
			Mask ROM	f(BCLK) = 32 kHz, In low-power consumption mode, Program running on ROM ⁽³⁾		20		μΑ
				On-chip oscillation, f _{2(ROC)} selected, f(BCLK) = 1 MHz, In wait mode		25		μΑ
			Flash memory	f(BCLK) = 32 kHz, In low-power consumption mode, Program running on RAM ⁽³⁾		20		μΑ
				f(BCLK) = 32 kHz, In low-power consumption mode, Program running on flash memory ⁽³⁾		450		μΑ
				On-chip oscillation, f _{2(ROC)} selected, f(BCLK) = 1 MHz, In wait mode		45		μΑ
			Mask ROM, Flash memory	f(BCLK) = 32 kHz, In wait mode ⁽²⁾ , Oscillation capacity high		6.6		μΑ
				f(BCLK) = 32 kHz, In wait mode ⁽²⁾ , Oscillation capacity low	_	2.2		μΑ
				While clock stops, Topr = 25° C		0.7	3	μΑ

- 1. Referenced to $V\infty$ = 3.0 to 3.6 V, Vss = 0 V at Topr = -40 to 85 ° C, f(BCLK) = 20 MHz unless otherwise specified.
- With one timer operates, using fcx.
 This indicates the memory in which the program to be executed exists.

Timing Requirements

(VCC = 3V, VSS = 0V, at Topr = -40 to 85°C unless otherwise specified)

Table 21.64 External Clock Input (XIN input)

Symbol	Dovemeter	Star	Standard	
	Parameter	Min.	Max.	Unit
tc	External clock input cycle time	100		ns
tw(H)	External clock input HIGH pulse width	40		ns
tw(L)	External clock input LOW pulse width	40		ns
tr	External clock rise time		18	ns
tf	External clock fall time		18	ns

Timing Requirements

(VCC = 3V, VSS = 0V, at Topr = -40 to 85°C unless otherwise specified)

Table 21.65 Timer A Input (Counter Input in Event Counter Mode)

Symbol	Downwater	Standard		1.1
	Parameter	Min.	Max.	Unit
tc(TA)	TAin input cycle time	150		ns
tw(TAH)	TAin input HIGH pulse width	60		ns
tw(TAL)	TAin input LOW pulse width	60		ns

Table 21.66 Timer A Input (Gating Input in Timer Mode)

Symbol		Standard		11.3
	Parameter	Min.	Max.	Unit
tc(TA)	TAin input cycle time	600		ns
tw(TAH)	TAin input HIGH pulse width	300		ns
tw(TAL)	TAin input LOW pulse width	300		ns

Table 21.67 Timer A Input (External Trigger Input in One-shot Timer Mode)

Symbol	Deservator	Star	Standard	
	Parameter	Min.	Max.	Unit
tc(TA)	TAin input cycle time	300		ns
tw(TAH)	TAin input HIGH pulse width	150		ns
tw(TAL)	TAin input LOW pulse width	150		ns

Table 21.68 Timer A Input (External Trigger Input in Pulse Width Modulation Mode)

Symbol	Develope	Star	Standard	l lmit
	Parameter	Min. Max.	Unit	
tw(TAH)	TAin input HIGH pulse width	150		ns
tw(TAL)	TAin input LOW pulse width	150		ns

Table 21.69 Timer A Input (Counter Increment/decrement Input in Event Counter Mode)

Symbol	Developed	Standard		Unit
	Parameter	Min. Max.		
tc(UP)	TAiout input cycle time	3000		ns
tw(UPH)	TAiout input HIGH pulse width	1500		ns
tw(UPL)	TAiout input LOW pulse width	1500		ns
tsu(UP-TIN)	TAiout input setup time	600		ns
th(TIN-UP)	TAiout input hold time	600		ns

Table 21.70 Timer A Input (Two-phase Pulse Input in Event Counter Mode)

Symbol	Developed	Standard Min. Max.	ıdard	l lmi4
	Parameter		Unit	
tc(TA)	TAin input cycle time	2		μs
tsu(TAIN-TAOUT)	TAiout input setup time	500		ns
tsu(TAOUT-TAIN)	TAin input setup time	500		ns



Timing Requirements

(VCC = 3V, VSS = 0V, at Topr = -40 to 85°C unless otherwise specified)

Table 21.71 Timer B Input (Counter Input in Event Counter Mode)

Cumphal	Devemates	Stan	Standard	Unit
Symbol	Parameter	Min.	Max.	
tc(TB)	TBiin input cycle time (counted on one edge)	150		ns
tw(TBH)	TBiin input HIGH pulse width (counted on one edge)	60		ns
tw(TBL)	TBin input LOW pulse width (counted on one edge)	60		ns
tc(TB)	TBiin input cycle time (counted on both edges)	300		ns
tw(TBH)	TBiin input HIGH pulse width (counted on both edges)	120		ns
tw(TBL)	TBin input LOW pulse width (counted on both edges)	120		ns

Table 21.72 Timer B Input (Pulse Period Measurement Mode)

Symbol	Parameter	Standard Min. Max.	Unit	
Symbol	Symbol	Min.	Max.	Offic
tc(TB)	TBiin input cycle time	600		ns
tw(TBH)	TBiin input HIGH pulse width	300		ns
tw(TBL)	TBiin input LOW pulse width	300		ns

Table 21.73 Timer B Input (Pulse Width Measurement Mode)

Symbol	Parameter	Star	ndard	Unit
Symbol	ymbol l'alameter	Min.	Max.	Onit
tc(TB)	TBin input cycle time	600		ns
tw(TBH)	TBin input HIGH pulse width	300		ns
tw(TBL)	TBiin input LOW pulse width	300		ns

Table 21.74 A/D Trigger Input

Symbol	Parameter	Standard Min. Max.	Unit	
Symbol	i arameter			
tc(AD)	ADTRG input cycle time (trigger able minimum)	1500		ns
tw(ADL)	ADTRG input LOW pulse width	200		ns

Table 21.75 Serial I/O

Symbol	Parameter	Standard		Unit
Symbol	raidilletei	Min.	Max.	Offic
tc(CK)	CLKi input cycle time	300		ns
tw(CKH)	CLKi input HIGH pulse width	150		ns
tw(CKL)	CLKi input LOW pulse width	150		ns
td(C-Q)	TxDi output delay time		160	ns
th(C-Q)	TxDi hold time	0		ns
tsu(D-C)	RxDi input setup time	100		ns
th(C-D)	RxDi input hold time	90		ns

Table 21.76 External Interrupt INTi Input

Symbol	Parameter	Standard		Unit
	i arameter	Min. Max.	Offic	
tw(INH)	INTi input HIGH pulse width	380		ns
tw(INL)	INTi input LOW pulse width	380		ns



Timing Requirements

(VCC = 3V, VSS = 0V, at Topr = -40 to 85°C unless otherwise specified)

Table 21.77 Multi-master I²C bus Line

O. mala al	Deservator	Standard of	lock mode	High-speed	clock mode	l lait
Symbol	Parameter	Min.	Max.	Min.	Max.	Unit
tBUF	Bus free time	4.7		1.3		μs
tHD;STA	The hold time in start condition	4.0		0.6		μs
tLOW	The hold time in SCL clock 0 status	4.7		1.3		μs
tR	SCL, SDA signals' rising time		1000	20+0.1Cb	300	ns
tHD;DAT	Data hold time	0		0	0.9	μs
tHIGH	The hold time in SCL clock 1 status	4.0		0.6		μs
tF	SCL, SDA signals' falling time		300	20+0.1Cb	300	ns
tsu;DAT	Data setup time	250		100		ns
tsu;STA	The setup time in restart condition	4.7		0.6		μs
tsu;STO	Stop condition setup time	4.0		0.6		μs

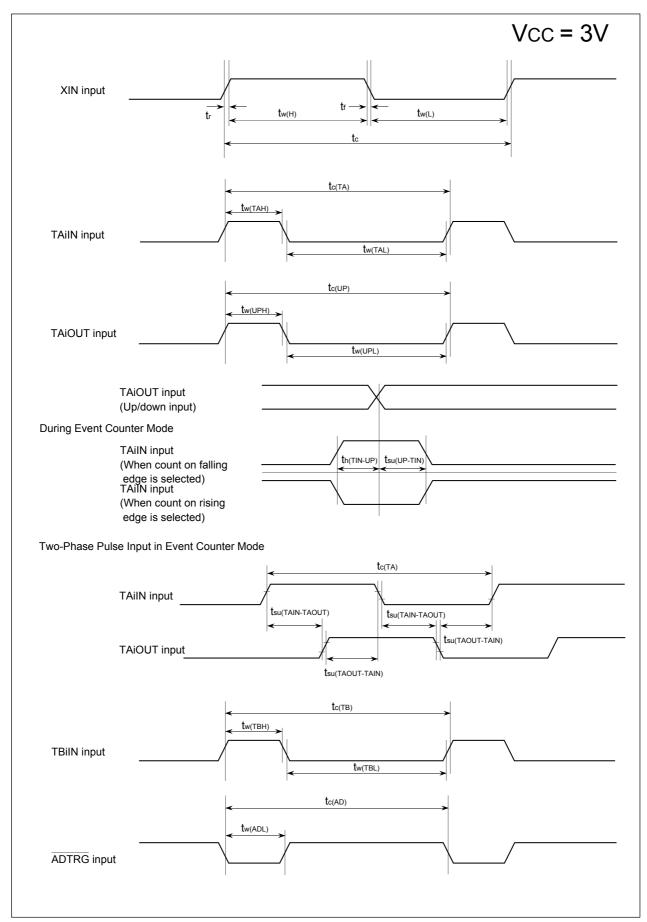


Figure 21.10 Timing Diagram (1)

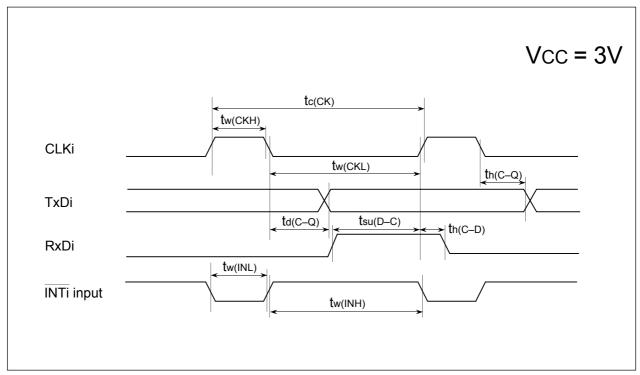


Figure 21.11 Timing Diagram (2)

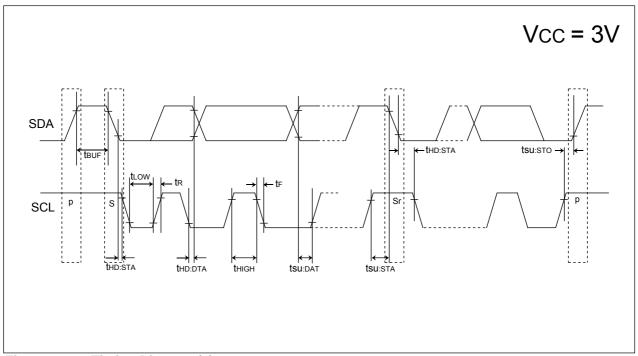


Figure 21.12 Timing Diagram (3)

21.3 V Version

Table 21.78 Absolute Maximum Ratings

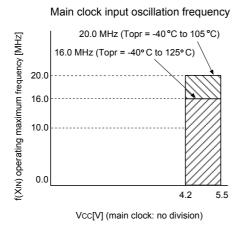
Symbol		Parameter		Condition	Value	Unit
Vœ	Supply Voltage			Vc=AVc	-0.3 to 6.5	V
AV∞	Analog Supply \	/oltage		Vcc=AVcc	-0.3 to 6.5	V
Vı	Input Voltage	P0o to P07, P1o to P17, P2	20 to P27,			
		P30 to P37, P60 to P67, P7	70 to P77,			
		P80 to P87, P90 to P93, P9	95 to P97,		-0.3 to Vcc+0.3	V
		P10 ₀ to P10 ₇ ,				
		XIN, VREF, RESET, CNVSS				
Vo	Output Voltage	P00 to P07, P10 to P17, P2	20 to P27,			
		P3o to P37, P6o to P67, P7o to P77,				
		P80 to P87, P90 to P93, P9	95 to P97,		-0.3 to Vcc+0.3	V
		P10 ₀ to P10 ₇ ,				
		Хоит				
Pd	Dower Dissipation	·		-40 <u><</u> Topr <u><</u> 85° C	300	mW
Pu	Power Dissipation	ווכ		85≤Topr≤125° C	200	mW
		during CPU operation			-40 to 125	° C
Topr	Operating Ambient	during flash memory	Program Space (Block 0 to Block 5)		0 to 60	° C
	Temperature	Temperature program and erase operation			-40 to 125	° C
Tstg	Storage Temper	ature			-65 to 150	° C

Table 21.79 Recommended Operating Conditions (1)

Cumbal		Parameter			Stand	ard	Unit	
Symbol			Parameter		Min.	Тур.	Max.	Unit
Vcc	Supply Voltage				4.2		5.5	V
AV∞	Analog Supply Vo	ltage	tage			Vcc		V
Vss	Supply Voltage					0		V
AVss	Analog Supply Vo	ltage				0		V
VIH	Input High ("H")	P0o to P07, P1o t	o P17, P20 to P27, P	30 to P37, P60 to P67,	0.7 Vcc		Vœ	V
	Voltage	P70 to P77, P80 t	o P87, P90 to P93, P	95 to P97, P100 to P107				
		XIN, RESET, CNVSS			0.8 Vcc		Vœ	V
		004 001	When I2C bus inpu	t level is selected	0.7 Vcc		Vœ	V
		SDAMM, SCLMM	When SMBUS inpu	ut level is selected	1.4		Vœ	V
VIL	Input Low ("L")	P00 to P07, P10 t	o P17, P20 to P27, P	30 to P37, P60 to P67,	0		0.3V∞	V
	Voltage	P70 to P77, P80 to P87, P90 to P93, P95 to P97, P100 to P107						
	XIN, RESET, CN SDAM, SCLM		NVSS		0		0.2V∞	V
			When I ² C bus inpu	t level is selected	0		0.3V∞	V
		SDAMM, SCLMM	When SMBUS inpu	ut level is selected	0		0.6	V
OH(peak)	Peak Output High	1	00 to P07, P10 to P17, P20 to P27, P30 to P37, P60 to P67,				-10.0	mA
	("H") Current	P70 to P77, P80 t	70 to P77, P80 to P87, P90 to P93, P95 to P97, P100 to P107					
OH(avg)	Average Output	P00 to P07, P10 t	o P17, P20 to P27, P	30 to P37, P60 to P67,			-5.0	mA
	High ("H") Current	P70 to P77, P80 t	o P87, P90 to P93, P	95 to P97, P100 to P107				
OL(peak)	Peak Output Low	*		30 to P37, P60 to P67,			10.0	mA
	("L") Current	,		95 to P97, P100 to P107				
OL(avg)	Average Output			30 to P37, P60 to P67,			5.0	mA
	Low ("L") Current			95 to P97, P100 to P107				1
f(XIN)	Main Clock Input	Oscillation Freque	ency ⁽⁴⁾	Topr = -40 to 105 ° C	0		20	MHz
				Topr = -40 to 125 ° C	0		16	MHz
f(Xan)	Sub Clock Oscilla	<u> </u>				32.768	50	kHz
f ₁ (ROC)	On-chip Oscillator				0.5	1	2	MHz
f2(ROC)	On-chip Oscillator	Frequency 2			1	2	4	MHz
f3(ROC)	On-chip Oscillator	Frequency 3			8	16	26	MHz
f(PLL)	PLL Clock Oscilla	tion Frequency ⁽⁴⁾		Topr = -40 to 105 ° C	10		20	MHz
				Topr = -40 to 125 ° C	10		16	MHz
f(BCLK)	CPU Operation C	lock Frequency		Topr = -40 to 105 ° C	0		20	MHz
				Topr = -40 to 125 ° C	0		16	MHz
tsu(PLL)	Wait Time to Stab	ilize PLL Frequer	ncy Synthesizer	Vcc = 5.0 V			20	MHz

NOTES:

- 1. Referenced to $V\infty$ = 4.2 to 5.5 V at Topr = -40 to 125 ° C unless otherwise specified.
- 2. The mean output current is the mean value within 100ms.
- 3. The total Iou(peak) for all ports must be 80 mA or less. The total IoH(peak) for all ports must be -80 mA or less.
- 4. Relationship among main clock oscillation frequency, PLL clock oscillation frequency and supply voltage.



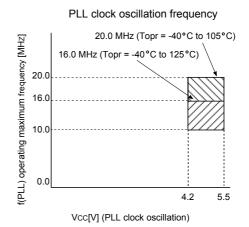


Table 21.80 A/D Conversion Characteristics (1)

Symbol	Parameter		Measurement Condition	S	Standard		
- Symbol	i aramete	iI	Weasurement Condition	Min.	Тур.	Max.	Unit
-	Resolution		VREF = VCC			10	Bits
INL	Integral Nonlinearity	10 bit	V _{REF} = V∞ = 5 V			±3	LSB
Error	8 bit	V _{REF} = V∞ = 5 V			±2	LSB	
	- Absolute Accuracy	10 bit	VREF = VCC = 5 V			±3	LSB
_		8 bit	V _{REF} = V _{CC} = 5 V			±2	LSB
DNL	Differential Nonlinearity	Error				±1	LSB
-	Offset Error					±3	LSB
-	Gain Error					±3	LSB
RLADDER	Resistor Ladder		VREF = VCC	10		40	kΩ
tconv	10-bit Conversion Time Sample & Hold Function	n Available	V _{REF} = V _{CC} = 5 V, φAD = 10 MHz	3.3			μs
toonv	8-bit Conversion Time Sample & Hold Function	n Available	V _{REF} = V∞ = 5 V, φAD = 10 MHz	2.8			μs
VREF	Reference Voltage			2.0		Vœ	V
VIA	Analog Input Voltage			0		VREF	V

NOTES:

- 1. Referenced to Vcc = AVcc = Vrer = 4.2 to 5.5 V, Vss = AVss = 0 V at Topr = -40 to 125 ° C unless otherwise specified.
- 2. Keep ϕAD frequency at 10 MHz or less.
- When sample & hold function is disabled, keep φAD frequency at 250kHz or more in addition to the limitation in Note 2.
 When sample & hold function is enabled, keep φAD frequency at 1MHz or more in addition to the limitation in Note 2.
- 4. When sample & hold function is enabled, sampling time is 3/ φAD frequency. When sample & hold function is disabled, sampling time is 2/ φAD frequency.

Table 21.81 Flash Memory Version Electrical Characteristics (1) for 100/1000 E/W cycle products [Program Space and Data Space in U3; Program Space in U7]

Symbol	Parameter			Standard		
Symbol	Faranietei		Min.	Typ. ⁽²⁾	Max.	Unit
-	Program and Erase Endurance ⁽³⁾		100/1000	100/1000(4, 11)		cycles
-	Word Program Time (Vcc = 5.0 V, Topr = 25° C)			75	600	μs
-	Block Erase Time (Vcc = 5.0 V, Topr = 25° C)	2-Kbyte Block		0.2	9	S
		8-Kbyte Block		0.4	9	S
		16-Kbyte Block		0.7	9	S
		32-Kbyte Block		1.2	9	s
td(SR-ES)	Duration between Suspend Request and	Erase Suspend			8	ms
tps	Wait Time to Stabilize Flash Memory Circuit				15	μs
-	Data Hold Time (5)		20			years

Table 21.82 Flash Memory Version Electrical Characteristics (6) for 10000 E/W cycle products

[Data Space in LIZ (7)]

		Data C	pace III	\mathbf{O}_{I}		
Symbol	Parameter		Standard			
Syllibol			Typ. ⁽²⁾	Max.	Unit	
-	Program and Erase Endurance ^(3, 8, 9)))		cycles	
-	Word Program Time ($V\infty$ = 5.0 V, Topr = 25° C)		100		μs	
-	Block Erase Time (V∞ = 5.0V, Topr = 25° C) (2-Kbyte block)		0.3		S	
td(SR-ES)	Duration between Suspend Request and Erase Suspend			8	ms	
tps	Wait Time to Stabilize Flash Memory Circuit			15	μs	
-	Data Hold Time (5)	20			years	

NOTES:

- 1. Referenced to VCC = 4.2 to 5.5 V at Topr = 0 to 60° C (program space)/ Topr = -40 to 125° C(data space), unless otherwise specified.
- 2. VCC = 5.0 V; TOPR = 25° C
- 3. Program and erase endurance is defined as number of program-erase cycles per block. If program and erase endurance is n cycle (n = 100, 1000, 10000), each block can be erased and programmed ncycles.

For example, if a 2-Kbyte block A is erased after programming one-word data to each address 1,024 times, this counts as one program and erase endurance. Data cannot be programmed to the same address more than once without erasing the block. (rewrite prohibited).

- 4. Number of E/W cycles for which operation is guranteed (1 to minimum value are guranteed).
- 5. Topr = 55° C
- 6. Referenced to VCC = 4.2 to 5.5 V at Topr = -40 to 125° C unless otherwise specified.
- 7. Table 21.82 applies for data space in U7 when program and erase endurance is more than 1,000 cycles. Otherwise, use Table 21.81.
- 8. To reduce the number of program and erase endurance when working with systems requiring numerous rewrites, write to unused word addresses within the block instead of rewrite. Erase block only after all possible addresses are used. For example, an 8-word program can be written 128 times maximum before erase becomes necessary. Maintaining an equal number of times erasure between block A and block B will also improve efficiency. It is recommended to track the total number of erasure performed per block and to limit the number of erasure.
- 9. If an erase error is generated during block erase, execute the clear status register command and block erase command at least 3 times until an erase error is not generated.
- 10. When executing more than 100 times rewrites, set one wait state per block access by setting the FMR17 bit in the FMR1 register to 1 (wait state). When accessing to all other blocks and internal RAM, wait state can be set by the PM17 bit, regardless of the FMR17 bit setting value.
- 11. The program and erase endurance is 100 cycles for program space and data space in U3; 1,000 cycles for program space in U7.
- 12. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for further details on the E/W failure rate.

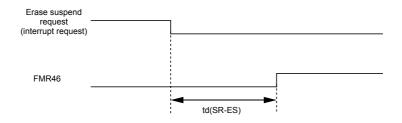




Table 21.83 Power Supply Circuit Timing Characteristics

	100 1 0 Wor Cappiy Circuit Timing Characteriot					
Symbol	Parameter	Measurement Condition	5	Unit		
Tarameter		Wicadarement Condition	Min.	Тур.	Max.	
td(P-R)	Wait Time to Stabilize Internal Supply Voltage when Power-on	Vcc=4.2 to 5.5V			2	ms
td(ROC)	Wait Time to Stabilize Internal On-chip Oscillator when Power-on				40	μs
td(S-R)	STOP Release Time				150	μs
td(E-A)	Low Power Dissipation Mode Wait Mode Release Time				150	μs

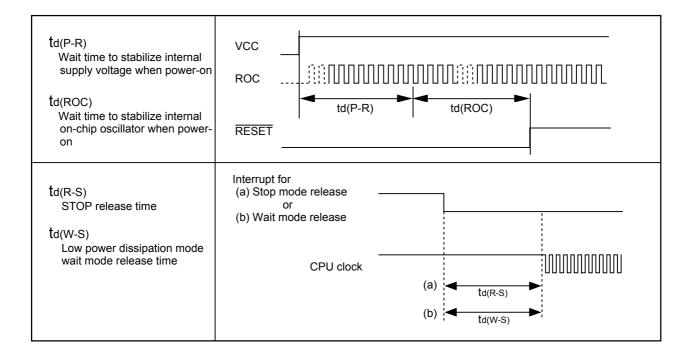


Table 21.84 Electrical Characteristics (1)

Cymbol		Doror	notor		Condition	Sta	andar	d	Unit
Symbol		Parar	neter		Condition	Min.	Тур.	Max.	Unit
Vон	Output High	P0o to P07, P1o to P17, F	P20 to P27	7, P30 to P37, P60 to P67,	Iон = -5 mA	Vcc-2.0		Vα	V
	("H") Voltage	P70 to P77, P80 to P87, F	P90 to P93	3, P95 to P97, P100 to P107					
Vон	Output High	P00 to P07, P10 to P17, F	P20 to P27	7, P30 to P37, P60 to P67,	Іон = -200 μА	V∞-0.3		Vα	V
Var	("H") Voltage	P70 to P77, P80 to P87, F	P90 to P93	3, P95 to P97, P100 to P107					
	Output High ("H") Voltage	Хол	High Power	Iон = -1 mA	V∞-2.0		Vα	V
Mari	Output High (11) Voltage	X	Low Power	Iон = -0.5 mA	V∞-2.0		Vα	\ \ \
Vон	O t t . l l l l . /	W. W. \ / - I4	V	High Power	No load applied		2.5		.,
	Output High ("H") Voltage	Хсоит	Low Power	No load applied		1.6		V
VaL	Output Low	P0o to P07, P1o to P17, F	20 to P27	7, P30 to P37, P60 to P67,	IoL = 5 mA			2.0	V
	("L") Voltage	P70 to P77, P80 to P87, F	P90 to P93	3, P95 to P97, P100 to P107					
VaL	Output Low	P00 to P07, P10 to P17, F	P20 to P27	r, P30 to P37, P60 to P67,	IoL = 200 μA			0.45	V
Val	("L") Voltage	P70 to P77, P80 to P87, F	P90 to P93	3, P95 to P97, P100 to P107					
	0		V	High Power	IoL = 1 mA			2.0	.,
	Output Low ('	'L") Voltage	Холт	Low Power	IoL = 0.5 mA			2.0	V
Vol			Hiç		No load applied		0		
	Output Low ('	"L") Voltage	Хсоит	Low Power	No load applied		0		V
VT+-VT-	Hysteresis	TA0in-TA4in, TB0in-TB2i	n, INTo-IN	IT5, NMI, ADTRG, CTS0-		0.2		1.0	V
		CTS2, SCL, SDA, CLK0	-CLK2, TA	A2our-TA4our, Klo-Kl3, Rxdo-					
		RXD2, SIN3, SIN4							
VT+-VT-	Hysteresis	RESET				0.2		2.5	V
VT+-VT-	Hysteresis	XIN				0.2		0.8	V
lıн	Input High	P0o to P07, P1o to P17, F	P20 to P27	7, P30 to P37, P60 to P67,	Vı = 5 V			5.0	μА
	("H") Current	P70 to P77, P80 to P87, F	90 to P93	3, P95 to P97, P100 to P107					
		XIN, RESET, CNVss							
lıL	Input Low			7, P30 to P37, P60 to P67,	Vı = 0 V			-5.0	μΑ
	("L") Current	P70 to P77, P80 to P87, F	P90 to P93	3, P95 to P97, P100 to P107					
		XIN, RESET, CNVss							
RPULLUP	Pull-up	P0o to P07, P1o to P17, F	P20 to P27	7, P30 to P37, P60 to P67,	Vı = 0 V	30	50	170	kΩ
	Resistance	P70 to P77, P80 to P87, P90 to P93, P95 to P97, P100 to P107							
Rfxin	Feedback Re	sistance	XIN				1.5		МΩ
Rfxcin	Feedback Re	sistance	Xcin				15		МΩ
VRAM	RAM Standby	√ Voltage	1		In stop mode	2.0			V
NOTE:									

NOTE:

^{1.} Referenced to Vcc = 4.2 to 5.5 V, Vss = 0 V at Topr = -40 to 105 $^{\circ}$ C, f(BCLK) = 20 MHz / Vcc = 4.2 to 5.5 V, Vss = 0 V at Topr = -40 to 125 $^{\circ}$ C, f(BCLK) = 16 MHz, unless otherwise specified.

Table 21.85 Electrical Characteristics (2) (1)

Symbol	Parameter	Measurement Condition	Standard			Unit		
Symbol	Farameter	raiameter weastrement Condition	Min.	Тур.	Max.	01111		
lœ	Power Supply Current	Output pins are left open and	Mask ROM	f(BCLK) = 20 MHz, main clock, no division		18	25	mA
	(V∞=4.2 to 5.5V)	other pins are connected to Vss		f(BCLK) = 16 MHz, main clock, no division		14	20	mA
				On-chip oscillation, f _{2(ROC)} selected, f(BCLK) = 1 MHz		2		mA
			, ,	f(BCLK) = 20 MHz, main clock, no division		18	25	mA
				f(BCLK) = 16 MHz, main clock, no division		14	20	mA
				On-chip oscillation, f2(RCC) selected, f(BCLK) = 1 MHz		2		mA
			Flash memory program	f(BCLK) = 10 MHz, Vcc = 5.0 V		11		mA
			Flash memory erase	f(BCLK) = 10 MHz, Vcc = 5.0 V		11		mA
			Mask ROM	f(BCLK) = 32 kHz, In low-power consumption mode, Program running on ROM ⁽³⁾		25		μΑ
				On-chip oscillation, f _{2(ROC)} selected, f(BCLK) = 1 MHz, In wait mode		50		μА
			Flash memory	f(BCLK) = 32 kHz, In low-power consumption mode, Program running on RAM ⁽³⁾		25		μА
				f(BCLK) = 32 kHz, In low-power consumption mode, Program running on flash memory ⁽³⁾		450		μА
				On-chip oscillation, f2(ROC) selected, f(BCLK) = 1 MHz, In wait mode		50		μА
			Mask ROM, Flash memory	f(BCLK) = 32 kHz, In wait mode ⁽²⁾ , Oscillation capacity high		8.5		μА
				f(BCLK) = 32 kHz, In wait mode ⁽²⁾ , Oscillation capacity low		3		μА
				While clock stops, Topr = 25° C		0.8	3	μΑ

NOTES:

^{1.} Referenced to $V\infty$ = 4.2 to 5.5 V, $V\infty$ = 0 V at Topr = -40 to 105 ° C, f(BCLK) = 20MHz / $V\infty$ = 4.2 to 5.5 V, $V\infty$ = 0V at Topr = -40 to 125 ° C, f(BCLK) = 16 MHz, unless otherwise specified.

^{2.} With one timer operates, using fc32.

^{3.} This indicates the memory in which the program to be executed exists.

Timing Requirements

(Vcc=5V, Vss=0V, at Topr=-40 to 125°C unless otherwise specified)

Table 21.86 External Clock Input (XIN input)

Cumbal	Dorometer		Standard		Unit	
Symbol	Parameter		Min. Max.			
to	External Clack Input Cycle Time	Topr=-40° C to 105° C	50		ns	
tc	External Clock Input Cycle Time	Topr=-40° C to 125° C	62.5		ns	
tw _(H)	External Clock Input High ("H") Width	Topr=-40° C to 105° C	20		ns	
LVV(II)	External clock input riight (11) Width	Topr=-40° C to 125° C	25		ns	
traca	External Clock Input Low ("I ") Width	Topr=-40° C to 105° C	20		ns	
tw _(L)	External Clock Input Low ("L") Width	Topr=-40° C to 125° C	25		ns	
tr	External Clock Rise Time	Topr=-40° C to 105° C		9	ns	
u	LATERIAL CIOCK RISE TIME	Topr=-40° C to 125° C		15	ns	
tf	External Clock Fall Time	Topr=-40° C to 105° C		9	ns	
τ	External Clock Fall Time	Topr=-40° C to 125° C		15	ns	

Timing Requirements

(Vcc=5V, Vss=0V, at Topr=-40 to 125°C unless otherwise specified)

Table 21.87 Timer A Input (Counter Input in Event Counter Mode)

Symbol	Parameter		Standard		
	T didinotes	Min.	Max.	Unit	
tc(TA)	TAin Input Cycle Time	100		ns	
tw(tah)	TAin Input High ("H") Width	40		ns	
tw(TAL)	TAin Input Low ("L") Width	40		ns	

Table 21.88 Timer A Input (Gating Input in Timer Mode)

Symbol	Parameter		Standard		
Symbol			Max.	Unit	
tc(TA)	TAin Input Cycle Time	400		ns	
tw(TAH)	TAin Input High ("H") Width	200		ns	
tw(TAL)	TAin Input Low ("L") Width	200		ns	

Table 21.89 Timer A Input (External Trigger Input in One-shot Timer Mode)

Symbol	Parameter		Standard		
Symbol			Max.	Unit	
tc(TA)	TAin Input Cycle Time	200		ns	
tw(TAH)	TAin Input High ("H") Width	100		ns	
tw(TAL)	TAin Input Low ("L") Width	100		ns	

Table 21.90 Timer A Input (External Trigger Input in Pulse Width Modulation Mode)

Symbol	Parameter	Stan	dard	Unit
Symbol	r atameter	Min.	Max.	Offic
tw(TAH)	TAin Input High ("H") Width	100		ns
tw(TAL)	TAin Input Low ("L") Width	100		ns

Table 21.91 Timer A Input (Counter Increment/decrement Input in Event Counter Mode)

Symbol	ymbol Parameter Stand		dard	Unit
Syllibol	Falanetei	Min.	Max.	Offic
tc(UP)	TAiout Input Cycle Time	2000		ns
tw(UPH)	TAiout Input High ("H") Width	1000		ns
tw(UPL)	TAiout Input Low ("L") Width	1000		ns
tsu(UP-TIN)	TAiout Input Setup Time	400		ns
th(TIN-UP)	TAiout Input Hold Time	400		ns

Table 21.92 Timer A Input (Two-phase Pulse Input in Event Counter Mode)

I GDIC Z 1.52	rable 21.32 Timer A input (1 wo phase I also input in Event Gounter mode)				
Symbol	Parameter		Standard		
Symbol	Farantete	Min.	Max.		
tc(TA)	TAin Input Cycle Time	800		ns	
tsu(TAIN-TAOUT)	TAiout Input Setup Time	200		ns	
tsu(TAOUT-TAIN)	TAin Input Setup Time	200		ns	



Timing Requirements

(Vcc=5V, Vss=0V, at Topr=-40 to 125°C unless otherwise specified)

Table 21.93 Timer B Input (Counter Input in Event Counter Mode)

Cumbal	Doromotor	Sta	Standard		
Symbol	Parameter	Min.	Max.	Unit	
tc(TB)	TBin Input Cycle Time (counted on one edge)	100		ns	
tw(TBH)	TBiin Input High ("H") Width (counted on one edge)	40		ns	
tw(TBL)	TBin Input Low ("L") Width (counted on one edge)	40		ns	
tc(TB)	TBin Input Cycle Time (counted on both edges)	200		ns	
tw(TBH)	TBin Input High ("H") Width (counted on both edges)	80		ns	
tw(TBL)	TBin Input Low ("L") Width (counted on both edges)	80		ns	

Table 21.94 Timer B Input (Pulse Period Measurement Mode)

Symbol	Parameter	Standard		Unit
Syllibol	Falanielei	Min.	Max.	Offic
tc(TB)	TBiin Input Cycle Time	400		ns
tw (твн)	TBiin Input High ("H") Width	200		ns
tw(TBL)	TBin Input Low ("L") Width	200		ns

Table 21.95 Timer B Input (Pulse Width Measurement Mode)

Symbol	Parameter	Standa		Unit
Symbol	raidilletei	Min.	Max.	Onit
tc(TB)	TBiin Input Cycle Time	400		ns
tw(TBH)	TBin Input High ("H") Width	200		ns
tw(TBL)	ТВім Input Low ("L") Width	200		ns

Table 21.96 A/D Trigger Input

Symbol	Parameter		Standard		
Syllibol	raidilletei		Max	Unit	
tc(AD)	ADTRG Input Cycle Time (required for trigger)	1000		ns	
tw(ADL)	ADTRG Input Low ("L") Width	125		ns	

Table 21.97 Serial I/O

Cumbal	Parameter		Standard		
Symbol	Parameter	Min.	Max.	Unit	
tc(ck)	CLKi Input Cycle Time	200		ns	
tw(CKH)	CLKi Input High ("H") Width	100		ns	
tw(CKL)	CLKi Input Low ("L") Width	100		ns	
td(C-Q)	TxDi Output Delay Time		80	ns	
th(C-Q)	TxDi Hold Time	0		ns	
tsu(D-C)	RxDi Input Setup Time	70		ns	
th(C-Q)	RxDi Input Hold Time	90		ns	

Table 21.98 External Interrupt INTi Input

Symbol	Parameter	Stan	dard	Unit
Symbol	Falanicici	Min.	Max.	
tw(INH)	INTi Input High ("H") Width	250		ns
tw(INL)	INTi Input Low ("L") Width	250		ns

Timing Requirements

Vcc = 5V

(Vcc=5V, Vss=0V, at Topr=-40 to 125°C unless otherwise specified)

Table 21.99 Multi-master I²C Bus Line

Cumahal	Devemeter	Standard o	clock mode	High-speed	clock mode	l lmit
Symbol	Parameter	Min.	Max.	Min.	Max.	Unit
tBUF	Bus free time	4.7		1.3		μs
tHD;STA	The hold time in start condition	4.0		0.6		μs
tLOW	The hold time in SCL clock "0" status	4.7		1.3		μs
tR	SCL, SDA signals' rising time		1000	20+0.1Cb	300	ns
tHD;DAT	Data hold time	0		0	0.9	μs
tHIGH	The hold time in SCL clock "1" status	4.0		0.6		μs
tF	SCL, SDA signals' falling time		300	20+0.1Cb	300	ns
tsu;DAT	Data setup time	250		100		ns
tsu;STA	The setup time in restart condition	4.7		0.6		μs
tsu;STO	Stop condition setup time	4.0		0.6		μs

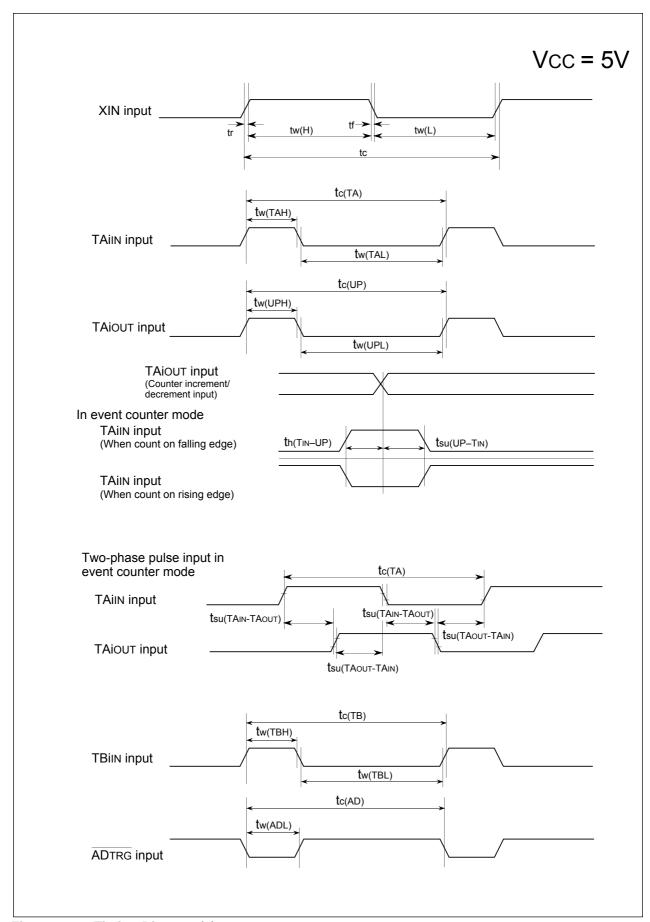


Figure 21.13 Timing Diagram (1)

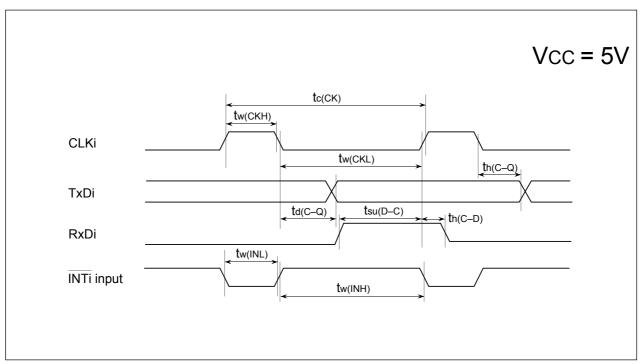


Figure 21.14 Timing Diagram (2)

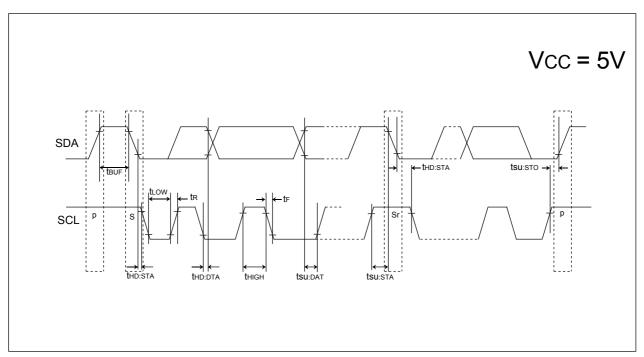


Figure 21.15 Timing Diagram (3)

22. Usage Notes

22.1 SFRs

22.1.1 For 80-Pin Package

Set the IFSR20 bit in the IFSR2A register to 0 after reset and set bits PACR2 to PACR0 in the PACR register to 0112.

22.1.2 For 64-Pin Package

Set the IFSR20bit in the IFSR2A register to 0 after reset and set bits PACR2 to PACR0 in the PACR register to 0102.

22.1.3 Register Setting

Immediate values should be set in the registers containing write-only bits. When establishing a new value by modifying a previous value, write the previous value into RAM as well as the register. Change the contents of the RAM and then transfer the new value to the register.



22.2 Clock Generation Circuit

22.2.1 PLL Frequency Synthesizer

Stabilize supply voltage so that the standard of the power supply ripple is met.

	Symbol					
Symbol	Parameter		Min.	Тур.	Max.	Unit
f(ripple)	Power supply ripple allowable frequency(Vcc	c)			10	kHz
Vp-p(ripple)	Power supply ripple allowabled amplitude	(Vcc=5V)			0.5	V
	voltage	(Vcc=3V)			0.3	V
VCC(DV/DT)	Power supply ripple rising/falling gradient	(Vcc=5V)			0.3	V/ms
		(Vcc=3V)			0.3	V/ms

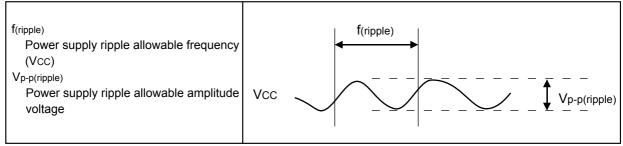


Figure 22.1 Voltage Fluctuation Timing

22.2.2 Power Control

- 1. When exiting stop mode by hardware reset, the device will startup using the on-chip oscillator.
- 2. Set the MR0 bit in the TAiMR register(i=0 to 4) to 0 (pulse is not output) to use the timer A to exit stop mode.
- 3. When entering wait mode, insert a JMP.B instruction before a WAIT instruction. Do not excute any instructions which can generate a write to RAM between the JMP.B and WAIT instructions. Disable the DMA transfers, if a DMA transfer may occur between the JMP.B and WAIT instructions. After the WAIT instruction, insert at least 4 NOP instructions. When entering wait mode, the instruction queue reads ahead the instructions following WAIT, and depending on timing, some of these may execute before the MCU enters wait mode.

Program example when entering wait mode

Program Example: JMP.B L1 ; Insert JMP.B instruction before WAIT instruction L1:

FSET I ; WAIT ; Enter wait mode
NOP ; More than 4 NOP instructions
NOP
NOP
NOP

4. When entering stop mode, insert a JMP.B instruction immediately after executing an instruction which sets the CM10 bit in the CM1 register to 1, and then insert at least 4 NOP instructions. When entering stop mode, the instruction queue reads ahead the instructions following the instruction which sets the CM10 bit to 1 (all clock stops), and, some of these may execute before the MCU enters stop mode or before the interrupt routine for returning from stop mode.

Program example when entering stop mode

Program Example: FSET I
BSET CM10 ; Enter stop mode
JMP.B L2 ; Insert JMP.B instruction
L1:
NOP ; More than 4 NOP instructions
NOP

NOP NOP

5. Wait until the main clock oscillation stabilization time, before switching the CPU clock source to the main clock.

Similarly, wait until the sub clock oscillates stably before switching the CPU clock source to the sub clock.

6. Suggestions to reduce power consumption

(a) Ports

The processor retains the state of each I/O port even when it goes to wait mode or to stop mode. A current flows in active I/O ports. A dash current may flow through the input ports in high impedance state, if the input is floating. When entering wait mode or stop mode, set non-used ports to input and stabilize the potential.

(b) A/D converter

When A/D conversion is not performed, set the VCUT bit in ADiCON1 register to 0 (no Vref connection). When A/D conversion is performed, start the A/D conversion at least 1 μ s or longer after setting the VCUT bit to 1 (Vref connection).

(c) Stopping peripheral functions

Use the CM0 register CM02 bit to stop the unnecessary peripheral functions during wait mode. However, because the peripheral function clock (fc32) generated from the sub-clock does not stop, this measure is not conducive to reducing the power consumption of the chip. If low speed mode or low power dissipation mode is to be changed to wait mode, set the CM02 bit to 0 (do not peripheral function clock stopped when in wait mode), before changing wait mode.

(d) Switching the oscillation-driving capacity

Set the driving capacity to "LOW" when oscillation is stable.



22.3 Protection

Set the PRC2 bit to 1 (write enabled) and then write to any address, and the PRC2 bit will be cleared to 0 (write protected). The registers protected by the PRC2 bit should be changed in the next instruction after setting the PRC2 bit to 1. Make sure no interrupts or DMA transfers will occur between the instruction in which the PRC2 bit is set to 1 and the next instruction.



22.4 Interrupts

22.4.1 Reading Address 0000016

Do not read the address 0000016 in a program. When a maskable interrupt request is accepted, the CPU reads interrupt information (interrupt number and interrupt request priority level) from the address 0000016 during the interrupt sequence. At this time, the IR bit for the accepted interrupt is cleared to 0. If the address 0000016 is read in a program, the IR bit for the interrupt which has the highest priority among the enabled interrupts is cleared to 0. This causes a problem that the interrupt is canceled, or an unexpected interrupt request is generated.

22.4.2 Setting the SP

Set any value in the SP(USP, ISP) before accepting an interrupt. The SP(USP, ISP) is cleared to 000016 after reset. Therefore, if an interrupt is accepted before setting any value in the SP(USP, ISP), the program may go out of control.

22.4.3 NMI Interrupt

- 1. The NMI interrupt is invalid after reset. The NMI interrupt becomes effective by setting the PM24 bit in the PM2 register to "1". Set the PM24 bit to "1" when a high-level signal ("H") is applied to the NMI pin. If the PM24 bit is set to "1" when a low-level signal ("L") is applied, NMI interrupt is generated. Once NMI interrupt is enabled, it will not be disabled unless a reset is applied.
- 2. The input level of the NMI pin can be read by accessing the P8_5 bit in the P8 register.
- 3. When selecting $\overline{\text{NMI}}$ function, stop mode cannot be entered into while input on the $\overline{\text{NMI}}$ pin is low. This is because while input on the $\overline{\text{NMI}}$ pin is low the CM1 register's CM10 bit is fixed to 0.
- 4. When selecting $\overline{\text{NMI}}$ function, do not go to wait mode while input on the $\overline{\text{NMI}}$ pin is low. This is because when input on the $\overline{\text{NMI}}$ pin goes low, the CPU stops but CPU clock remains active; therefore, the current consumption in the chip does not drop. In this case, normal condition is restored by an interrupt generated thereafter.
- 5. When selecting $\overline{\text{NMI}}$ function, the low and high level durations of the input signal to the $\overline{\text{NMI}}$ pin must each be 2 CPU clock cycles + 300 ns or more.
- 6. When using the $\overline{\text{NMI}}$ interrupt for exiting stop mode, set the NDDR register to FF16 (disable digital debounce filter) before entering stop mode.

22.4.4 Changing the Interrupt Generate Factor

If the interrupt generate factor is changed, the IR bit in the interrupt control register for the changed interrupt may inadvertently be set to 1 (interrupt requested). If you changed the interrupt generate factor for an interrupt that needs to be used, be sure to clear the IR bit for that interrupt to 0 (interrupt not requested).

"Changing the interrupt generate factor" referred to here means any act of changing the source, polarity or timing of the interrupt assigned to each software interrupt number. Therefore, if a mode change of any peripheral function involves changing the generate factor, polarity or timing of an interrupt, be sure to clear the IR bit for that interrupt to 0 (interrupt not requested) after making such changes. Refer to the description of each peripheral function for details about the interrupts from peripheral functions.

Figure 22.2 shows the procedure for changing the interrupt generate factor.



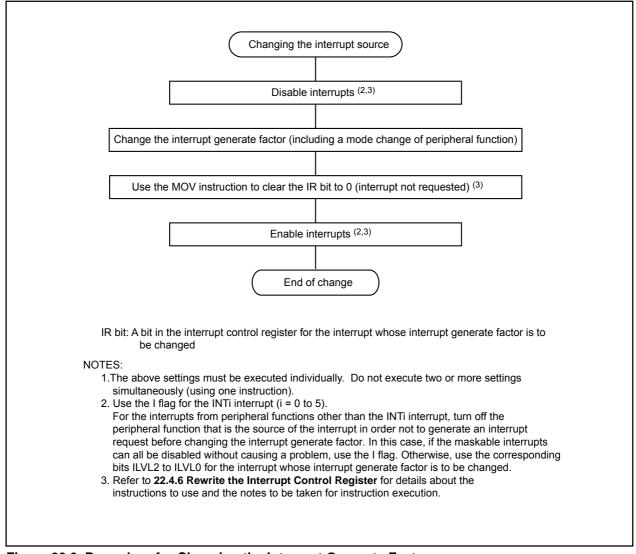


Figure 22.2 Procedure for Changing the Interrupt Generate Factor

22.4.5 INT Interrupt

- 1. Either an "L" level of at least tw(INH) or an "H" level of at least tw(INL) width is necessary for the signal input to pins INTo through INT5 regardless of the CPU operation clock.
- 2. If the POL bit in registers INT0IC to INT5IC or bits IFSR7 to IFSR0 in the IFSR register are changed, the IR bit may inadvertently set to 1 (interrupt requested). Be sure to clear the IR bit to 0 (interrupt not requested) after changing any of those register bits.
- 3. When using the INT5 interrupt for exiting stop mode, set the P17DDR register to FF16 (disable digital debounce filter) before entering stop mode.

22.4.6 Rewrite the Interrupt Control Register

- (1) The interrupt control register for any interrupt should be modified in places where no requests for that interrupt may occur. Otherwise, disable the interrupt before rewriting the interrupt control register.
- (2) To rewrite the interrupt control register for any interrupt after disabling that interrupt, be careful with the instruction to be used.

Changing any bit other than the IR bit

If while executing an instruction, a request for an interrupt controlled by the register being modified occurs, the IR bit in the register may not be set to 1 (interrupt requested), with the result that the interrupt request is ignored. If such a situation presents a problem, use the instructions shown below to modify the register.

Usable instructions: AND, OR, BCLR, BSET

Changing the IR bit

Depending on the instruction used, the IR bit may not always be cleared to 0 (interrupt not requested). Therefore, be sure to use the MOV instruction to clear the IR bit.

(3) When using the I flag to disable an interrupt, refer to the sample program fragments shown below as you set the I flag. (Refer to (2) for details about rewrite the interrupt control registers in the sample program fragments.)

Examples 1 through 3 show how to prevent the I flag from being set to 1 (interrupts enabled) before the interrupt control register is rewrited, due to the internal bus and the instruction queue buffer.

Example 1: Using the NOP instruction to keep the program waiting until the interrupt control register is modified

```
INT_SWITCH1:

FCLR I ; Disable interrupts

AND.B #00h, 0055h ;Set the TA0IC register to 0016

NOP ;

NOP ;

NOP ; Enable interrupts
```

The number of NOP instruction is as follows. PM20 = 1 (1 wait): 2, PM20 = 0 (2 waits): 3

Example 2:Using the dummy read to keep the FSET instruction waiting

INT_SWITCH2:

FCLR I ; Disable interrupts

AND.B #00h, 0055h ; Set the TA0IC register to 0016

MOV.W MEM, R0 ; <u>Dummy read</u>

FSET I ; Enable interrupts

Example 3:Using the POPC instruction to changing the I flag

INT_SWITCH3:

PUSHC FLG

FCLR I ; Disable interrupts

AND.B #00h, 0055h ; Set the TA0IC register to 0016

POPC FLG ; Enable interrupts

22.4.7 Watchdog Timer Interrupt

Initialize the watchdog timer after the watchdog timer interrupt occurs.



22. Usage Notes M16C/29 Group

22.5 DMAC

22.5.1 Write to DMAE Bit in DMiCON Register

When both of the conditions below are met, follow the steps below.

- (a) Conditions
 - The DMAE bit is set to 1 again while it remains set (DMAi is in an active state).
 - A DMA request may occur simultaneously when the DMAE bit is being written.
- (b) Procedure
 - (1) Write 1 to the DMAE bit and DMAS bit in DMiCON register simultaneously⁽¹⁾.
 - (2) Make sure that the DMAi is in an initial state⁽²⁾ in a program.

If the DMAi is not in an initial state, the above steps should be repeated.

NOTES:

- 1. The DMAS bit remains unchanged even if 1 is written. However, if 0 is written to this bit, it is set to 0 (DMA not requested). In order to prevent the DMAS bit from being modified to 0, 1 should be written to the DMAS bit when 1 is written to the DMAE bit. In this way the state of the DMAS bit immediately before being written can be maintained. Similarly, when writing to the DMAE bit with a read-modify-write instruction, 1 should be written to the DMAS bit in order to maintain a DMA request which is generated during execution.
- 2. Read the TCRi register to verify whether the DMAi is in an initial state. If the read value is equal to a value which was written to the TCRi register before DMA transfer start, the DMAi is in an initial state. (If a DMA request occurs after writing to the DMAE bit, the value written to the TCRi register is 1.) If the read value is a value in the middle of transfer, the DMAi is not in an initial state.

22.6 Timers

22.6.1 Timer A

22.6.1.1 Timer A (Timer Mode)

1. The timer remains idle after reset. Set the mode, count source, counter value, etc. using the TAiMR (i = 0 to 4) register and the TAi register before setting the TAiS bit in the TABSR register to 1 (count starts).

Always make sure the TAiMR register is modified while the TAiS bit remains 0 (count stops) regardless whether after reset or not.

- 2. While counting is in progress, the counter value can be read out at any time by reading the TAi register. However, if the TAi register is read at the same time the counter is reloaded, the read value is always FFFF16. If the TAi register is read after setting a value in it, but before the counter starts counting, the read value is the one that has been set in the register.
- 3. If a low-level signal is applied to the \overline{SD} pin when the IVPCR1 bit in the TB2SC register is set to 1 (three-phase output forcible cutoff by input on \overline{SD} pin enabled), the TA10UT, TA20UT and TA40UT pins go to a high-impedance state.

22.6.1.2 Timer A (Event Counter Mode)

- 1. The timer remains idle after reset. Set the mode, count source, counter value, etc. using the TAiMR (i = 0 to 4) register, the TAi register, the UDF register, bits TAZIE, TA0TGL, and TA0TGH in the ONSF register and the TRGSR register before setting the TAiS bit in the TABSR register to 1 (count starts).
 - Always make sure bits TAZIE, TA0TGL, and TA0TGH in the TAiMR register, the UDF register, the ONSF register, and the TRGSR register are modified while the TAiS bit remains 0 (count stops) regardless whether after reset or not.
- 2. While counting is in progress, the counter value can be read out at any time by reading the TAi register. However, if the TAi register is read at the same time the counter is reloaded, the read value is always FFFF16 when the timer counter underflows and 000016 when the timer counter overflows. If the TAi register is read after setting a value in it, but before the counter starts counting, the read value is the one that has been set in the register.
- 3. If a low-level signal is applied to the \overline{SD} pin when the IVPCR1 bit in the TB2SC register is set to 1 (three-phase output forcible cutoff by input on \overline{SD} pin enabled), the TA10UT, TA20UT and TA40UT pins go to a high-impedance state.



22. Usage Notes M16C/29 Group

22.6.1.3 Timer A (One-shot Timer Mode)

1. The timer remains idle after reset. Set the mode, count source, counter value, etc. using the TAiMR (i = 0 to 4) register, the TAi register, bits TA0TGL and TA0TGH in the ONSF register and the TRGSR register before setting the TAiS bit in the TABSR register to 1 (count starts).

Always make sure bits TA0TGL and TA0TGH in the TAiMR register, the ONSF register, and the TRGSR register are modified while the TAiS bit remains 0 (count stops) regardless whether after reset or not.

- 2. When setting TAiS bit to 0 (count stop), the followings occur:
 - A counter stops counting and a content of reload register is reloaded.
 - TAiout pin outputs "L".
 - After one cycle of the CPU clock, the IR bit in TAilC register is set to 1 (interrupt request).
- 3. Output in one-shot timer mode synchronizes with a count source internally generated. When the external trigger has been selected, a maximun delay of one cycle of the count source occurs between the trigger input to TAiIN pin and output in one-shot timer mode.
- 4. The IR bit is set to 1 when timer operation mode is set with any of the following procedures:
 - · Select one-shot timer mode after reset.
 - Change an operation mode from timer mode to one-shot timer mode.
 - Change an operation mode from event counter mode to one-shot timer mode.

To use the timer Ai interrupt (the IR bit), set the IR bit to 0 after the changes listed above have been made.

- 5. When a trigger occurs while the timer is counting, the counter reloads the reload register value, and continues counting after a second trigger is generated and the counter is decremented once. To generate a trigger while counting, space more than one cycle of the timer count source from the first trigger and generate again.
- 6. When selecting the external trigger for the count start conditions in timer A one-shot timer mode, do generate an external trigger 300ns before the count value of timer A is set to 000016. The one-shot timer does not continue counting and may stop.
- 7. If a low-level signal is applied to the SD pin when the IVPCR1 bit in the TB2SC register is set to 1 (three-phase output forcible cutoff by input on SD pin enabled), the TA10UT, TA20UT and TA40UT pins go to a high-impedance state.



22.6.1.4 Timer A (Pulse Width Modulation Mode)

1. The timer remains idle after reset. Set the mode, count source, counter value, etc. using bits TA0TGL and TA0TGH in the TAiMR (i = 0 to 4) register, the TAi register, the ONSF register and the TRGSR register before setting the TAiS bit in the TABSR register to 1 (count starts). Always make sure bits TA0TGL and TA0TGH in the TAiMR register, the ONSF register and the TRGSR register are modified while the TAiS bit remains 0 (count stops) regardless whether after reset or not.

- 2. The IR bit is set to 1 when setting a timer operation mode with any of the following procedures:
 - · Select the PWM mode after reset.
 - Change an operation mode from timer mode to PWM mode.
 - Change an operation mode from event counter mode to PWM mode.

To use the timer Ai interrupt (interrupt request bit), set the IR bit to 0 by program after the above listed changes have been made.

- 3. When setting TAiS register to 0 (count stop) during PWM pulse output, the following action occurs:
 - · Stop counting.
 - When TAiout pin is output "H", output level is set to "L" and the IR bit is set to 1.
 - When TAiout pin is output "L", both output level and the IR bit remains unchanged.
- 4. If a low-level signal is applied to the \overline{SD} pin when the IVPCR1 bit in the TB2SC register is set to 1 (three-phase output forcible cutoff by input on \overline{SD} pin enabled), the TA10UT, TA20UT and TA40UT pins go to a high-impedance state.

22.6.2 Timer B

22.6.2.1 Timer B (Timer Mode)

The timer remains idle after reset. Set the mode, count source, counter value, etc. using the TBiMR
(i = 0 to 2) register and TBi register before setting the TBiS bit in the TABSR register to 1 (count starts).

Always make sure the TBiMR register is modified while the TBiS bit remains 0 (count stops) regardless whether after reset or not.

2. The counter value can be read out at any time by reading the TBi register. However, if this register is read at the same time the counter is reloaded, the read value is always FFFF16. If the TBi register is read after setting a value in it but before the counter starts counting, the read value is the one that has been set in the register.

22.6.2.2 Timer B (Event Counter Mode)

1. The timer remains idle after reset. Set the mode, count source, counter value, etc. using the TBiMR (i = 0 to 2) register and TBi register before setting the TBiS bit in the TABSR register to 1 (count starts).

Always make sure the TBiMR register is modified while the TBiS bit remains 0 (count stops) regardless whether after reset or not.

2. The counter value can be read out at any time by reading the TBi register. However, if this register is read at the same time the counter is reloaded, the read value is always FFFf16. If the TBi register is read after setting a value in it but before the counter starts counting, the read value is the one that has been set in the register.

22.6.2.3 Timer B (Pulse Period/pulse Width Measurement Mode)

- 1. The timer remains idle after reset. Set the mode, count source, etc. using the TBiMR (i = 0 to 2) register before setting the TBiS bit in the TABSR or the TBSR register to 1 (count starts). Always make sure the TBiMR register is modified while the TBiS bit remains 0 (count stops) regardless whether after reset or not. To clear the MR3 bit to 0 by writing to the TBiMR register while the TBiS bit is set to 1 (count starts), be sure to write the same value as previously written to bits TM0D0, TM0D1, MR0, MR1, TCK0, and TCK1 and a 0 to the MR2 bit.
- 2. The IR bit in TBiIC register (i=0 to 2) goes to 1 (interrupt request), when an effective edge of a measurement pulse is input or timer Bi is overflowed. The factor of interrupt request can be determined by use of the MR3 bit in TBiMR register within the interrupt routine.
- 3. If the source of interrupt cannot be identified by the MR3 bit such as when the measurement pulse input and a timer overflow occur at the same time, use another timer to count the number of times timer B has overflowed.
- 4. To set the MR3 bit to 0 (no overflow), set TBiMR register with setting the TBiS bit to 1 and counting the next count source after setting the MR3 bit to 1 (overflow).
- 5. Use the IR bit in TBiIC register to detect only overflows. Use the MR3 bit only to determine the interrupt factor within the interrupt routine.



6. When a count is started and the first effective edge is input, an undefined value is transferred to the reload register. At this time, timer Bi interrupt request is not generated.

- 7. A value of the counter is undefined at the beginning of a count. MR3 may be set to 1 and timer Bi interrupt request may be generated between a count start and an effective edge input.
- 8. For pulse width measurement, pulse widths are successively measured. Use program to check whether the measurement result is an "H" level width or an "L" level width.

22.6.3 Three-phase Motor Control Timer Function

When the IVPCR1 bit in the TB2SC register is set to 1 (three-phase output forced cutoff by SD pin input (high-impedance) enabled), the INV03 bit in the INVC0 register is set to 1 (three-phase motor control timer output enabled), and a low-level ("L") signal is applied to the \overline{SD} pin while a three-phase PWM signal is output, the MCU is forced to cutoff and pins U, \overline{U} , V, \overline{V} , W, and \overline{W} are placed in a high-impedance state and the INV03 bit is set to 0 (three-phase motor control timer output disabled).

To resume the three-phase PWM signal output from pins U, \overline{U} , V, \overline{V} , W, and \overline{W} , set the INV03 bit to 1 and the IVPCR1 bit to 0 (three-phase output forced cutoff disabled) after the \overline{SD} pin level becomes "H". Then set the IVPCR1 bit to 1 (three-phase output forced cutoff enabled) in order to enable the three-phase output forced cutoff function by input to the SD pin again.

The INV03 bit cannot be set to 1 while an "L" signal is input to the \overline{SD} pin. To set the INV03 bit to 1 after forcible cutoff, write 1 to the INV03 bit and read the bit to ensure that it is set to 1 by program. Then set the IVPCR1 bit to 1 after setting it to 0.



22.7 Timer S

22.7.1 Rewrite the G1IR Register

Bits in the G1IR register are not automatically set to 0 (no interrupt requested) even if a requested interrupt is acknowledged. Set each bit to 0 by program after the interrupt requests are verified.

The IC/OC interrupt is generated when any bit in the G1IR register is set to 1 (interrupt requested) after all the bits are set to 0. If conditions to generate an interrupt are met when the G1IR register holds the value other than 0016, the IC/OC interrupt request will not be generated. In order to enable an IC/OC interrupt request again, clear the G1IR register to 0016. Use the following instructions to set each bit in the G1IR register to 0.

Subject instructions: AND, BCL

Figure 22.3 shows an example of IC/OC interrupt i flow chart.

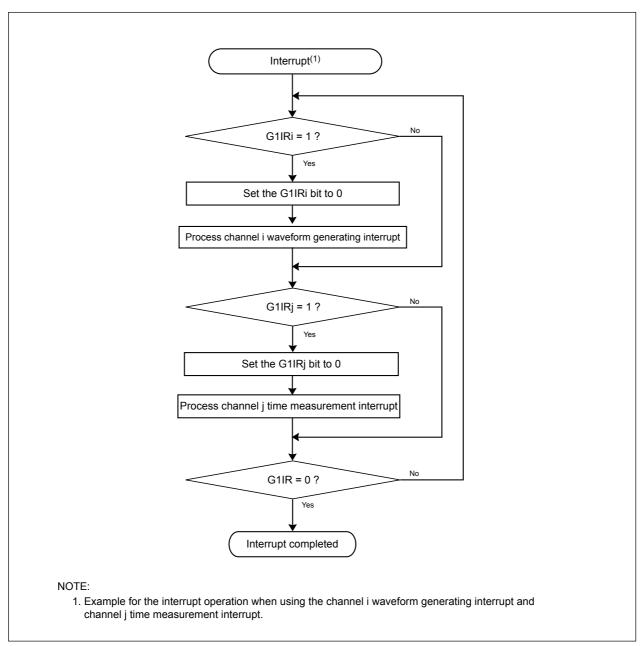


Figure 22.3 IC/OC Interrupt i Flow Chart

22.7.2 Rewrite the ICOCiIC Register

When the interrupt request to the ICOCiIC register is generated during the instruction process, the IR bit may not be set to 1 (interrupt requested) and the interrupt request may not be acknowledged. At that time, when the bit in the G1IR register is held to 1 (interrupt requested), the following IC/OC interrupt request will not be generated. When changing the ICOCiIC register setting, use the following instruction.

Subject instructions: AND, OR, BCLR, BSET

When initializing Timer S, change the ICOCiIC register setting with the request again after setting registers IOCiIC and G1IR to 0016.

22.7.3 Waveform Generating Function

- 1. If the BTS bit in the G1BCR1 register is set to 0 (base timer is reset) when the waveform is generating and the base timer is stopped counting, the waveform output pin keeps the same output level. The output level will be changed when the base timer and the G1POj register match the setting value next time after the base timer starts counting again.
- 2. If the G1POCRj register is set when the waveform is generated, the same setting value of the IVL bit is applied to the waveform generating pin. Do not set the G1POCRj register when the waveform is generating.
- 3. When the RST1 bit in the G1BCR1 register is set to 1 (the base timer is reset by matching the G1PO0 register), the base timer is reset after two clock cycles of fBT1 when the base timer value matches the G1PO0 register value. A high-level ("H") signal is applied to the OUTC10 pin between the base timer value match to the base timer reset.

22.7.4 IC/OC Base Timer Interrupt

If the MCU is operated in the combination selected from **Table 22.1** for use when the RST4 bit in the G1BCR0 register is set to 1 (reset the base timer that matches the G1BTRR register) to reset the base timer, an IC/OC base timer interrupt request is generated twice.

Table 22.1 Uses of IT Bit in the G1BCR0 Register and G1BTRR Register

IT Bit in the G1BCR0 Register	G1BTRR Register
0 (bit 15 in the base timer overflows)	07FFF16 to 0FFFE16
1 (bit 14 in the base timer overflows)	03FFF16 to 0FFFE16 or 0BFFF16 to 0FFFE16

The second IC/OC base timer interrupt request is generated because the base timer overflow request is generated after one fBT1 clock cycle as soon as the base timer is reset.

One of the following conditions must be met in order not to generate the IC/OC base timer interrupt request twice:

- 1) When the RST4 bit is set to 1, set the G1BTRR register with a combination other than what is listed in **Table 22.1**.
- 2) Do not reset the base timer by matching the G1BTRR register. Reset the base timer by matching the G1P00 register. In other words, do not set the RST4 bit to 1 to reset the base timer. Set the RST1 bit in the G1BCR1 register to 1 (reset the base timer that matches the G1P00 register).



22.8 Serial I/O

22.8.1 Clock-Synchronous Serial I/O

22.8.1.1 Transmission/reception

1. With an external clock selected, and choosing the RTS function, the output level of the RTSi pin goes to "L" when the data-receivable status becomes ready, which informs the transmission side that the reception has become ready. The output level of the RTSi pin goes to "H" when reception starts. So if the RTSi pin is connected to the CTSi pin on the transmission side, the circuit can transmission and reception data with consistent timing. With the internal clock, the RTS function has no effect.

2. If a low-level signal is applied to the \overline{SD} pin when the IVPCR1 bit in the TB2SC register is set to 1 (three-phase output forcible cutoff by input on \overline{SD} pin enabled), the P73/RTS2/TxD1(when the U1MAP bit in PACR register is 1) and CLK2 pins go to a high-impedance state.

22.8.1.2 Transmission

When an external clock is selected, the conditions must be met while if the CKPOL bit in the UiC0 register is set to 0 (transmit data output at the falling edge and the receive data taken in at the rising edge of the transfer clock), the external clock is in the high state; if the CKPOL bit in the UiC0 register is set to 1 (transmit data output at the rising edge and the receive data taken in at the falling edge of the transfer clock), the external clock is in the low state.

- The TE bit in UiC1 register is set to 1 (transmission enabled)
- The TI bit in UiC1 register is set to 0 (data present in UiTB register)
- If $\overline{\text{CTS}}$ function is selected, input on the $\overline{\text{CTS}}$ i pin is set to "L"

22.8.1.3 Reception

- 1. In operating the clock-synchronous serial I/O, operating a transmitter generates a shift clock. Fix settings for transmission even when using the device only for reception. Dummy data is output to the outside from the TxDi pin when receiving data.
- 2. When an internal clock is selected, set the TE bit in the UiC1 register (i = 0 to 2) to 1 (transmission enabled) and write dummy data to the UiTB register, and the shift clock will thereby be generated. When an external clock is selected, set the TE bit in the UiC1 register (i = 0 to 2) to 1 and write dummy data to the UiTB register, and the shift clock will be generated when the external clock is fed to the CLKi input pin.
- 3. When successively receiving data, if all bits of the next receive data are prepared in the UARTi receive register while the RE bit in the UiC1 register (i = 0 to 2) is set to 1 (data present in the UiRB register), an overrun error occurs and the UiRB register OER bit is set to 1 (overrun error occurred). In this case, because the content of the UiRB register is undefined, a corrective measure must be taken by programs on the transmit and receive sides so that the valid data before the overrun error occurred will be retransmitted. Note that when an overrun error occurred, the SiRIC register IR bit does not change state.
- 4. To receive data in succession, set dummy data in the lower-order byte of the UiTB register every time reception is made.
- 5. When an external clock is selected, make sure the external clock is in high state if the CKPOL bit is set to 0, and in low state if the CKPOL bit is set to 1 before the following conditions are met:
 - The RE bit in the UiC1 register is set to 1 (reception enabled)
 - The TE bit in the UiC1 register is set to 1 (transmission enabled)
 - The TI bit in the UiC1 register= 0 (data present in the UiTB register)



22.8.2 **UART Mode**

22.8.2.1 Special Mode 1 (I²C bus Mode)

When generating start, stop and restart conditions, set the STSPSEL bit in the U2SMR4 register to 0 and wait for more than half cycle of the transfer clock before setting each condition generate bit (STAREQ, RSTAREQ and STPREQ) from 0 to 1.

22.8.2.2 Special Mode 2

If a low-level signal is applied to the \overline{SD} pin when the IVPCR1 bit in the TB2SC register is set to 1 (three-phase output forcible cutoff by input on \overline{SD} pin enabled), the RTS2 and CLK2 pins go to a high-impedance state.

22.8.2.3 Special Mode 4 (SIM Mode)

A transmit interrupt request is generated by setting the U2C1 register U2IRS bit to 1 (transmission complete) and U2ERE bit to 1 (error signal output) after reset. Therefore, when using SIM mode, be sure to clear the IR bit to 0 (no interrupt request) after setting these bits.

22.8.3 SI/O3, SI/O4

The SOUTi default value which is set to the SOUTi pin by the SMi7 bit approximately 10ns may be output when changing the SMi3 bit from 0 (I/O port) to 1 (SOUTi output and CLKfunction) while the SMi2 bit in the SiC (i=3 and 4) to 0 (SOUTi output) and the SMi6 bit is set to 1 (internal clock). And then the SOUTi pin is held high-impedance.

If the level which is output from the SOUTi pin is a problem when changing the SMi3 bit from 0 to 1, set the default value of the SOUTi pin by the SMi7 bit.



22.9 A/D Converter

1. Set registers ADCON0 (except bit 6), ADCON1, ADCON2 and ADTRGCON when A/D conversion is stopped (before a trigger occurs).

- 2. When the VCUT bit in ADCON1 register is changed from 0 (Vref not connected) to 1 (Vref connected), start A/D conversion after passing 1 μs or longer.
- 3. To prevent noise-induced device malfunction or latchup, as well as to reduce conversion errors, insert capacitors between the AVCC, VREF, and analog input pins (ANi, AN0i, AN2i(i=0 to 7), and AN3i(i=0 to 2)) each and the AVss pin. Similarly, insert a capacitor between the VCC1 pin and the Vss pin. **Figure 22.4** is an example connection of each pin.
- 4. Make sure the port direction bits for those pins that are used as analog inputs are set to 0 (input mode). Also, if the TGR bit in the ADCON0 register is set to 1 (external trigger), make sure the port direction bit for the ADTRG pin is set to 0 (input mode).
- **5.** When using key input interrupts, do not use any of the four AN4 to AN7 pins as analog inputs. (A key input interrupt request is generated when the A/D input voltage goes low.)
- 6. The φAD frequency must be 10 MHz or less. Without sample-and-hold function, limit the φAD frequency to 250kHz or more. With the sample and hold function, limit the φAD frequency to 1MHz or more.
- 7. When changing an A/D operation mode, select analog input pin again in bits CH2 to CH0 in the ADCON0 register and bits SCAN1 to SCAN0 in the ADCON1 register.

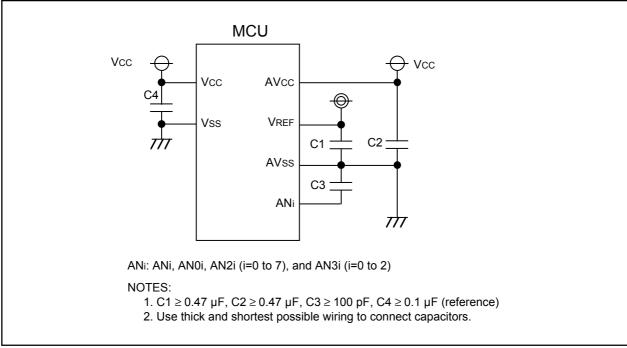


Figure 22.4 Use of capacitors to reduce noise

8. If the CPU reads the ADi register (i = 0 to 7) at the same time the conversion result is stored in the ADi register after completion of A/D conversion, an incorrect value may be stored in the ADi register. This problem occurs when a divide-by-n clock derived from the main clock or a subclock is selected for CPU clock.

- When operating in one-shot, single-sweep mode, simultaneous sample sweep mode, delayed trigger mode 0 or delayed trigger mode 1
 - Check to see that A/D conversion is completed before reading the target ADi register. (Check the ADIC register's IR bit to see if A/D conversion is completed.)
- When operating in repeat mode or repeat sweep mode 0 or 1 Use the main clock for CPU clock directly without dividing it.
- 9. If A/D conversion is forcibly terminated while in progress by setting the ADST bit in the ADCON0 register to 0 (A/D conversion halted), the conversion result of the A/D converter is undefined. The contents of ADi registers irrelevant to A/D conversion may also become undefined. If while A/D conversion is underway the ADST bit is cleared to 0 in a program, ignore the values of all ADi registers.
- 10. When setting the ADST bit in the ADCON register to 0 and terminating forcefully by a program in single sweep conversion mode, A/D delayed trigger mode 0 and A/D delayed trigger mode 1 during A/D converting operation, the A/D interrupt request may be generated. If this causes a problem, set the ADST bit to 0 after an interrupt is disabled.

22.10 Multi-Master I²C bus Interface

22.10.1 Writing to the S00 Register

When the start condition is not generated, the SCL pin may output the short low-signal ("L") by setting the S00 register. Set the register when the SCL pin outputs an "L" signal.

22.10.2 AL Flag

When the arbitration lost is generated and the AL flag in the S10 register is set to 1 (detected), the AL flag can be cleared to 0 (not detected) by writing a transmit data to the S00 register. The AL flag should be cleared at the timing when master geneates the start condition to start a new transfer.



22.11 CAN Module

22.11.1 Reading COSTR Register

The CAN module on the M16C/29 Group updates the status of the COSTR register in a certain period. When the CPU and the CAN module access to the COSTR register at the same time, the CPU has the access priority; the access from the CAN module is disabled. Consequently, when the updating period of the CAN module matches the access period from the CPU, the status of the CAN module cannot be updated. (See **Figure 22.5**)

Accordingly, be careful about the following points so that the access period from the CPU should not match the updating period of the CAN module:

- (1) There should be a wait time of 3fCAN or longer (see **Table 22.2**) before the CPU reads the C0STR register. (See **Figure 22.6**)
- (2) When the CPU polls the COSTR register, the polling period must be 3fcan or longer. (See **Figure 22.7**)

Table 22.2 CAN Module Status Updating Period

	- abio 1111 Orat modalo otalao opadimigi onod		
3fcan period = 3 x X _{IN} (Original oscillation period) x Division value of the CAN c		vision value of the CAN clock (CCLK)	
	(Example 1) Condition X _{IN} 16 MHz CCLK: Divided by 1	$3 f_{CAN} period = 3 \times 62.5 ns \times 1 = 187.5 ns$	
	(Example 2) Condition X _{IN} 16 MHz CCLK: Divided by 2	3fcan period = $3 \times 62.5 \text{ ns} \times 2 = 375 \text{ ns}$	
	(Example 3) Condition X _{IN} 16 MHz CCLK: Divided by 4	$3 f_{CAN} period = 3 \times 62.5 ns \times 4 = 750 ns$	
	(Example 4) Condition X _{IN} 16 MHz CCLK: Divided by 8	3fcan period = $3 \times 62.5 \text{ ns} \times 8 = 1.5 \mu \text{s}$	
	(Example 5) Condition X _{IN} 16 MHz CCLK: Divided by 16	$3f_{CAN}$ period = 3 x 62.5 ns x 16 = 3 μ s	

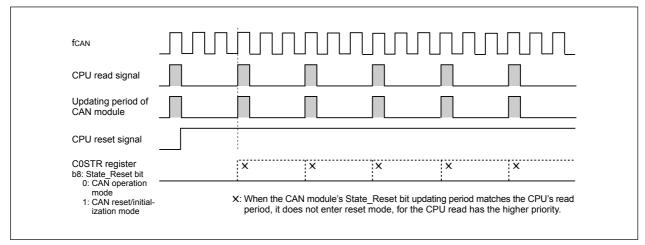


Figure 22.5 When Updating Period of CAN Module Matches Access Period from CPU

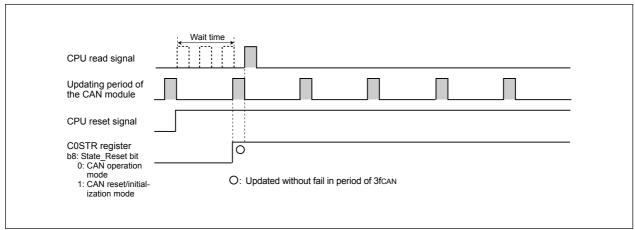


Figure 22.6 With a Wait Time of 3fcan Before CPU Read

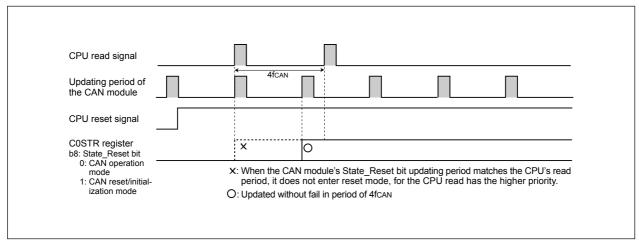
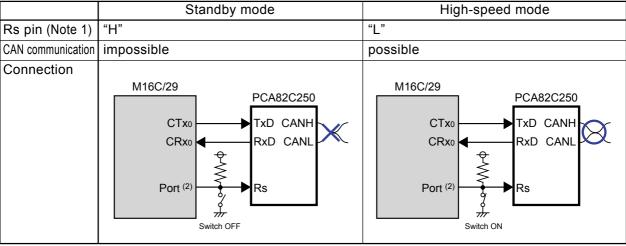


Figure 22.7 When Polling Period of CPU is 3fcan or Longer

22.11.2 CAN Transceiver in Boot Mode

When programming the flash memory in boot mode via CAN bus, the operation mode of CAN transceiver should be set to "high-speed mode" or "normal operation mode". If the operation mode is controlled by the MCU, CAN transceiver must be set the operation mode to "high-speed mode" or "normal operation mode" before programming the flash memory by changing the switch etc. **Tables 22.3 and 22.4** show pin connections of CAN transceiver.

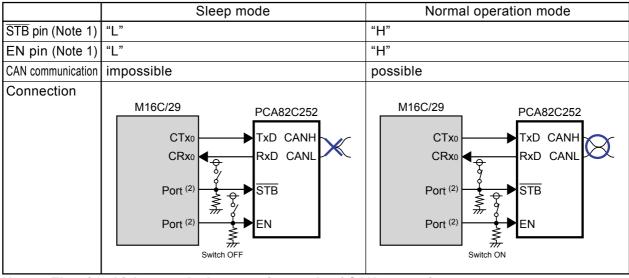
Table 22.3 Pin Connections of CAN Transceiver (In case of PCA82C250: Philips product)



Note 1: The pin which controls the operation mode of CAN transceiver.

Note 2: Connect to enabled port to control CAN transceiver.

Table 22.4 Pin Connections of CAN Transceiver (In case of PCA82C252: Philips product)



Note 1: The pin which controls the operation mode of CAN transceiver.

Note 2: Connect to enabled port to control CAN transceiver.

22.12 Programmable I/O Ports

1. If a low-level signal is applied to the \overline{SD} pin when the IVPCR1 bit in the TB2SC register is set to 1 (three-phase output forcible cutoff by input on \overline{SD} pin enabled), the P72 to P75, P80 and P81 pins go to a high-impedance state.

- 2. The input threshold voltage of pins differs between programmable input/output ports and peripheral functions.
 - Therefore, if any pin is shared by a programmable input/output port and a peripheral function and the input level at this pin is outside the range of recommended operating conditions VIH and VIL (neither "high" nor "low"), the input level may be determined differently depending on which side—the programmable input/output port or the peripheral function—is currently selected.
- 3. When the SM32 bit in the S3C register is set to 1, the P32 pin goes to high-impedance state. When the SM42 bit in the S4C register is set to 1, the P96 pin goes to high-impedance state.
- 4. When the INV03 bit in the INVC0 register is 1(three-phase motor control timer output enabled), an "L" input on the P85 /NMI/SD pin, has the following effect.
 - •When the TB2SC register IVPCR1 bit is set to 1 (three-phase output forcible cutoff by input on \overline{SD} pin enabled), the U/ \overline{U} / V/ \overline{V} / W/ \overline{W} pins go to a high-impedance state.
 - •When the TB2SC register IVPCR1 bit is set to 0 (three-phase output forcible cutoff by input on \overline{SD} pin disabled), the U/ \overline{U} / V/ \overline{V} / W/ \overline{W} pins go to a normal port.

Therefore, the P85 pin can not be used as programmable I/O port when the INV03 bit is set to 1. When the \overline{SD} function isn't used, set to 0 (Input) in PD85 and pullup to H in the P85 $\overline{NMI/SD}$ pin from outside.



22.13 Electric Characteristic Differences Between Mask ROM and Flash Memory Version

Flash memory version and mask ROM version may have different characteristics, operating margin, noise tolerated dose, noise width dose in electrical characteristics due to internal ROM, different layout pattern, etc. When switching to the mask ROM version, conduct equivalent tests as system evaluation tests conducted in the flash memory version.



22.14 Mask ROM Version

22.14.1 Internal ROM Area

In the masked ROM version, do not write to internal ROM area. Writing to the area may increase power consumption.

22.14.2 Reserved Bit

The b3 to b0 in addresses 0FFFFF16 are reserved bits. Set these bits to 11112.



22.15 Flash Memory Version

22.15.1 Functions to Inhibit Rewriting Flash Memory Rewrite

ID codes are stored in addresses 0FFFDF16, 0FFFE316, 0FFFEB16, 0FFFF316, 0FFFF716, and 0FFFFB16. If wrong data are written to theses addresses, the flash memory cannot be read or written in standard serial I/O mode.

The ROMCP register is mapped in address 0FFFF16. If wrong data is written to this address, the flash memory cannot be read or written in parallel I/O mode.

In the flash memory version of MCU, these addresses are allocated to the vector addresses ("H") of fixed vectors. The b3 to b0 in address 0FFFFF16 are reserved bits. Set these bits to 11112.

22.15.2 Stop Mode

When the MCU enters stop mode, execute the instruction which sets the CM10 bit to 1 (stop mode) after setting the FMR01 bit to 0 (CPU rewrite mode disabled) and disabling the DMA transfer.

22.15.3 Wait Mode

When the MCU enters wait mode, excute the WAIT instruction after setting the FMR01 bit to 0 (CPU rewrite mode disabled).

22.15.4 Low PowerDissipation Mode, On-Chip Oscillator Low Power Dissipation Mode

If the CM05 bit is set to 1 (main clock stop), the following commands must not be executed.

- Program
- Block erase

22.15.5 Writing Command and Data

Write the command code and data at even addresses.

22.15.6 Program Command

Write xx4016 in the first bus cycle and write data to the write address in the second bus cycle, and an auto program operation (data program and verify) will start. Make sure the address value specified in the first bus cycle is the same even address as the write address specified in the second bus cycle.

22.15.7 Operation Speed

When CPU clock source is main clock, before entering CPU rewrite mode (EW mode 0 or 1), select 10 MHz or less for BCLK using the CM06 bit in the CM0 register and bits CM17 to CM16 in the CM1 register. Also, when CPU clock is f3(ROC) on-chip oscillator clock, before entering CPU rewrite mode (EW mode 0 or 1), set the ROCR3 to ROCR2 bits in the ROCR register to "divide by 4" or "divide by 8". On both cases, set the PM17 bit in the PM1 register to 1 (with wait state).

22.15.8 Instructions Inhibited Against Use

The following instructions cannot be used in EW mode 0 because the flash memory's internal data is referenced: UND instruction, INTO instruction, JMPS instruction, JSRS instruction, and BRK instruction



22.15.9 Interrupts

EW Mode 0

• Any interrupt which has a vector in the variable vector table can be used providing that its vector is transferred into the RAM area.

- The NMI and watchdog timer interrupts can be used because the FMR0 register and FMR1 register
 are initialized when one of those interrupts occurs. The jump addresses for those interrupt service
 routines should be set in the fixed vector table.
 - Because the rewrite operation is halted when a $\overline{\text{NMI}}$ or watchdog timer interrupt occurs, the rewrite program must be executed again after exiting the interrupt service routine.
- The address match interrupt cannot be used because the flash memory's internal data is referenced.

EW Mode 1

- Make sure that any interrupt which has a vector in the variable vector table or address match interrupt will not be accepted during the auto program period or auto erase period with erase-suspend function disabled.
- The NMI interrupt can be used because the FMR0 register and FMR1 register are initialized when this interrupt occurs. The jump address for the interrupt service routine should be set in the fixed vector table.
 - Because the rewrite operation is halted when a $\overline{\text{NMI}}$ interrupt occurs, the rewrite program must be executed again after exiting the interrupt service routine.

22.15.10 How to Access

To set the FMR01, FMR02, FMR11 or FMR16 bit to 1, set the subject bit to 1 immediately after setting to 0. Do not generate an interrupt or a DMA transfer between the instruction to set the bit to 0 and the instruction to set the bit to 1. Set the bit when the PM24 bit is set to 1 ($\overline{\text{NMI}}$ funciton) and an high-level ("H") signal is applied to the $\overline{\text{NMI}}$ pin.

22.15.11 Writing in the User ROM Area

EW Mode 0

• If the power supply voltage drops while rewriting any block in which the rewrite control program is stored, a problem may occur that the rewrite control program is not correctly rewritten and, consequently, the flash memory becomes unable to be rewritten thereafter. In this case, standard serial I/O or parallel I/O mode should be used.

EW Mode 1

• Avoid rewriting any block in which the rewrite control program is stored.

22.15.12 DMA Transfer

In EW mode 1, make sure that no DMA transfers will occur while the FMR00 bit in the FMR0 register is set to 0(during the auto program or auto erase period).

22.15.13 Regarding Programming/Erasure Times and Execution Time

As the number of programming/erasure times increases, so does the execution time for software commands (Program, and Block Erase).

The software commands are aborted by hardware reset 1, brown-out detection reset (hardware reset 2), NMI interrupt, and watchdog timer interrupt. If a software command is aborted by such reset or interrupt, the affected block must be erased before reexecuting the aborted command.



22.15.14 Definition of Programming/Erasure Times

"Number of programs and erasure" refers to the number of erasure per block.

If the number of program and erasure is n (n=100 1,000 10,000) each block can be erased n times. For example, if a 2K byte block A is erased after writing 1 word data 1024 times, each to a different address, this is counted as one program and erasure. However, data cannot be written to the same address more than once without erasing the block. (Rewrite prohibited)

22.15.15 Flash Memory Version Electrical Characteristics 10,000 E/W cycle products (Normal: U7, U9; T-ver./V-ver.: U7)

When Block A or B E/W cycles exceed 100, set the FMR17 bit in the FMR1 register to 1 (1 wait) to select one wait state per block access for products U7 and U9. When the FMR17 bit is set to 1, one wait state is inserted per access to Block A or B - regardless of the value of the PM17 bit. Wait state insertion during access to all other blocks, as well as to internal RAM, is controlled by the PM17 bit - regardless of the setting of the FMR17 bit.

To use the limited number of erasure efficiently, write to unused address within the block instead of rewite. Erase block only after all possible address are used. For example, an 8-word program can be written 128 times before erase becomes necessary.

Maintaining an equal number of erasure between Block A and B will also improve efficiency.

We recommend keeping track of the number of times erasure is used.

22.15.16 Boot Mode

An undefined value is sometimes output in the I/O port until the internal power supply becomes stable when "H" is applied to the CNVss pin and "L" is applied to the RESET pin.

When setting the CNVss pin to "H", the following procedure is required:

- (1) Apply an "L" signal to the RESET pin and the CNVss pin.
- (2) Bring Vcc to more than 2.7V, and wait at least 2 msec. (Internal power supply stable waiting time)
- (3) Apply an "H" signal to the CNVss pin.
- (4) Apply an "H" signal to the RESET pin.

When the CNVss pin is "H" and RESET pin is "L", P67 pin is connected to the pull-up resister.



22.16 Noise

Connect a bypass capacitor (approximately $0.1\mu F$) across the Vcc and Vss pins using the shortest and thicker possible wiring. **Figure 22.8** shows the bypass capacitor connection.

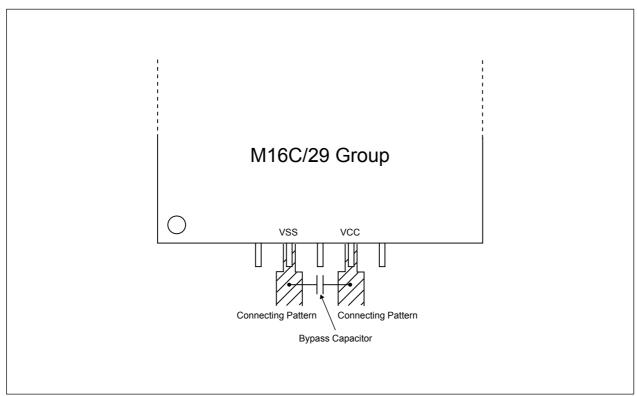


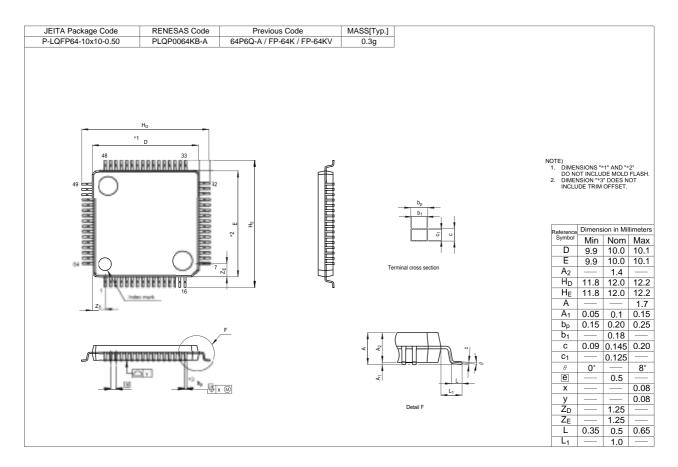
Figure 22.8 Bypass Capacitor Connection

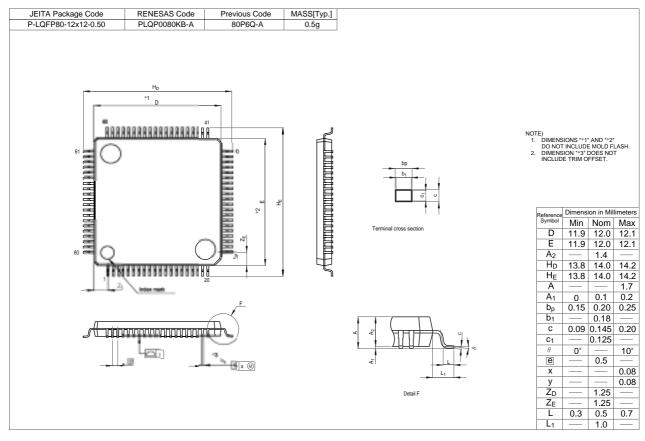
22.17 Instruction for a Device Use

When handling a device, extra attention is necessary to prevent it from crashing during the electrostatic discharge period.



Appendix 1. Package Dimensions





Appendix 2. Functional Comparison

Appendix 2.1 Difference between M16C/28 Group and M16C/29 Group (Normal-ver.) (1)

Item	Description	M16C/28(Normal-ver.)	M16C/29(Normal-ver.)	
Clock Generation Circuit	Clock output function (function of b1 to b0 bits in the CM0 register)	Not available (reserved bit)	Available (clock output function select bit)	
Protection	Function of the PRC0 bit	Enable to set the CM0, CM1, CM2, POCR, PLC0 and PCLKR registers	Enable to set the CM0, CM1, CM2, POCR, PLC0, PCLKR and CCLKR registers	
Interrupt	The IFSR20 bit setting in the IFSR2A register	Set to 1	Set to 0	
	The b1 bit in the IFSR2A register	Not available (reseved bit)	Interrupt cause switching bit (0: A/D conversion, 1:key input)	
	The b2 bit in the IFSR2A register	Not available (reseved bit)	Interrupt cause switching bit (0: CAN0 wake-up/ error)	
	Interrupt cause in the Interrupt number 13	Key input interrupt	CAN0 error	
	Interrupt cause in the Interrupt number 14	Key input interrupt	A/D, key input interrupt	
Three-phase Motor Control Timer	Three-phase port switching function (function of 035816)	Not available (reserved register)	Available (port function select register)	
A/D	Number of A/D input pin	24 channels (excluding AN ₃₀ to AN ₃₂)	27 channels (including AN ₃₀ to AN ₃₂)	
	Delayed trigger mode 0	Not available in the 1st chip version and chip version A	Available	
	Delayed trigger mode 1	Not available in the 1st chip version and chip version A	Available	
CAN module	compatible to 2.0B	Not available (all related registers are reserved registers)	Available (1 channel)	
CRC Calculation	Available (compatible to CRC-CCITT and CRC-16 methods)	Not available (all related registers are reserved registers)	Available (1 circuit)	
Pin Function	2 pins (80-pin/85-pin package), 62 pins (64-pin package)	P93/AN24	P93/AN24/CTX	
	3 pins (80-pin/85-pin package), 64 pins (64-pin package)	P92/TB2IN	P92/AN32/TB2IN/CRX	
	4 pins (80-pin/85-pin package), 1 pin (64-pin package)	P91/TB1IN	P91/AN31/TB1IN	
	5 pins (80-pin/85-pin package), 2 pins (64-pin package)	P90/TB0IN	P90/AN30/TB0in/CLKout	
Flash Memory	P93 in standard serial I/O mode	I (other than 128 Kbyte version) I/O (128 Kbyte version)	CTX output	

I: Input O: Output I/O: Input and output

NOTE



Since the M16C/28 group uses the common emulator used in the M16C/29 group, all the functions are available for M16C/28. When evaluating M16C/28 group, do not access to the SFR which is not built-in the M16C/28 gorup. Refere to hardware manual for details and electrical characteristics.

Appendix 2.2 Difference between M16C/28 and M16C/29 Group (T-ver./V-ver.) (1)

Item	Description	Description M16C/28(T-ver./V-ver.)	
Protection	Function of the PRC0 bit	Enable to set the CM0, CM1, CM2, POCR, PLC0 and PCLKR registers	Enable to set the CM0, CM1, CM2, POCR, PLC0, PCLKR and CCLKR registers
Interrupt	The IFSR20 bit setting in the IFSR2A register	Set to 1	Set to 0
	The b1 bit in the IFSR2A register	Not available (reserved bit)	Interrupt cause switching bit (0: A/D conversion, 1:key input)
	The b2 bit in the IFSR2A register	Not available (reserved bit)	Interrupt cause switching bit (0: CAN0 wake-up/ error)
	Interrupt cause in the Interrupt number 13	Key input interrupt	CAN0 error
	Interrupt cause in the Interrupt number 14	Key input interrupt	A/D, key input interrupt
CAN module	compatible to 2.0B	Not available (all related registers are reserved registers)	Available (1 channel)
Pin Function	2 pins (80-pin/85-pin package), 62 pins (64-pin package)	P93/AN24	P93/AN24/CTX
	3 pins (80-pin/85-pin package), 64 pins (64-pin package)	P92/TB2IN	P92/AN32/TB2IN/CRX

I: Input O: Output I/O: Input and output

NOTE:

Since the M16C/28 group uses the common emulator used in the M16C/29 group, all the functions are available for M16C/28. When evaluating M16C/28 group, do not access to the SFR which is not built-in the M16C/28 gorup. Refere to hardware manual for details and electrical characteristics.

M16C/29 Group Register Index

Register Index

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VCR1 39

VCR2 39

W

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WDTS 90



Rev.	Date		Description
		Page	Summary
0.70	Mar/ 29/Y04	1	"1. Overview" and "1.1. Application" are partly revised.
		2, 3	Table 1.2.1 and 1.2.2 are partly revised.
		8, 9	Figure 1.5.1 and 1.5.2 are partly revised.
		10	Table 1.6.1 is revised.
		22	Figure 4.8 is partly revised.
		28	Section "5.5 Voltage Detection Circuit" and Figure 5.5.2 are partly revised.
		30	Figure 5.5.3 is partly revised.
		31	Figure 5.5.4 is partly revised.
		32	Section "5.5.1 Voltage Detection Interrupt" and "5.5.1.1.1 Limitations of Stop
			Mode" are partly revised.
		36	Figure 7.1 is partly revised.
		37	Figure 7.2 is partly revised.
		38	Figure 7.3 is partly revised.
		39	Figure 7.5 is partly revised.
		40	Figure 7.6 is partly revised.
		41	"CCLKR register" of Figure 7.7 is partly revised.
		42	Section "7.1 Main clock" is partly revised.
		45	Figure 7.4.1 is partly revised.
		46	Section "7.5 CPU Clock and Peripheral Function Clock" and "7.5.2 Peripheral
			Function Clock" are partly revised.
		54	Section "7.7 System Clock Protective Function" and "7.8 Oscillation Stop and Re-
			oscillation Detect Function" are partly revised.
		57	Figure 8.1 is partly revised.
		64	Figure 9.3.1 is partly revised.
		65	IFSR2A registerin Figure 9.3.2 is partly revised.
		66	Section "9.3.2 IR Bit" is partly revised.
		67	Section "9.4 Interrupt Sequence" is partly revised.
		68	Section "9.4.1 Interrupt Response Time" and Figure9.4.1.1 are partly revised.
		73	Section "9.6 INT Interrupt" is partly revised.
		74	Section "9.9 CAN0 Wake-up Interrupt" is partly revised.
		94	"Divide ratio" of Table 12.1.1.1 is partly revised.
		102	"8-bit PWM" of Table 12.1.4.1 is partly revised.
		106	"Timer Bi register" in Figure 12.2.3 is partly revised.
		111	Section "12.2.4 A-D Trigger mode" and Table 12.2.4.1 are partly revised.
		112	Figure 12.2.4.2 is partly revised.
		115	Figure 12.3.2 is partly revised.
		117	"Timer B2 interrupt occurences fequency set counter" in Figure 12.3.4 is partly
			revised.
		119	Figure 12.3.6 is partly revised.

Rev.	Date		Description
		Page	Summary
		122	"Figure 12.3.9 PFCR register and TPRC register" is deleted.
		125	Figure 12.3.1.2.1 and the section 12.3.1.2.4 are partly revised.
		126	Section "Three-phase/Port Output Switch Function" and "Figure 12.3.2.1 PFCR
			register and TPRC register" are added.
		166	"UART 2 special mode register 2" in Figure 14.1.8 is partly revised.
		167	"UART 2 special mode register 3" in Figure 14.1.9 is partly revised.
		210	Note 1 in Table 15.1.1.1 is deleted.
		213	Figure 15.4 is partly revised.
		214	Figure 15.5 is partly revised.
		219	Section "15.1.3 Single Sweep mode" is partly revised.
		221	Section "15.1.4 Repeat Sweep mode 0" is partly revised.
		223	Section "15.1.5 Repeat Sweep mode 1" is partly revised.
		225	Section "15.1.6 Simultaneous Sample Sweep Mode", Table 15.1.6.1, and Figure
			15.1.6.1 are partly revised.
		228	Section "15.1.7 Delayed Trigger Mode 0" and Table 15.1.7.1 are partly revised.
		229	Figure 15.1.7.1 is partly revised.
		230, 231	Figure 15.1.7.2 and 15.1.7.3 are partly revised.
		232	Figure 15.1.7.3 is deleted.
		235	Section "15.1.8 Delayed Trigger Mode 1" and Table 15.1.8.1 are partly revised.
		241	Figure 15.5.1 is partly revised.
		276 to 300	Chapter "17. CAN Module" is revised.
		301	Chapter "18. CRC Calculation Circuit" is partly revised.
		303	Figure 18.3 is partly revised.
		304	Chapter "19. Programmable I/O ports" is partly revised.
		305	Section "19.5 Pin Assignment Control Register" is partly revised.
		313	"Pull-up control register" in Figure 19.3.1 is partly revised.
		320	Table 20.4 and 20.5 and Note 6 and 10 are partly revised.
		321	Note 3 in Table 20.6 is added.
		342	Table 20.43 and 20.44 and Note 10 are partly revised.
		343	Note 3 in Table 20.45 is added.
		360 to 372	Section "20.3 V version" is deleted.
		373	Table 21.1 is partly revised.
		282	Section "•FMR01 Bit", "•FMR02 Bit" and "•FMSTP Bit" are partly revised.
		383	Section "•FMR16 Bit", "• FMR17 Bit" and "FMR41 Bit" are partly revised.
		384	Figure 21.5.1 is revised.
		387	Figure 21.5.1.3 is partly revised.
		392	Section "21.4.2 EW1 Mode" is partly revised.
			Section "21.6.4 How to Access" is partly revised.
			Section "21.7.5. Block Erase" is partly revised.

Rev.	Date		Description
		Page	Summary
		399	Figure 21.9.1 is partly revised.
		400	Figure 21.9.2 is partly revised.
		403	Section "21.10.1 ROM Code Protect Function" is partly revised.
		404	Section "21.11.1 ROM Code Protect Function" is partly revised.
			Table 21.11.1 is revised.
		405	Figure 21.11.1 is revised.
		406	Figure 21.11.2 is revised.
		407	Figure 21.11.3 is revised.
0.71	April/15/Y04	B-1 to B-3	"Quick Reference to Page Classified by Address" are revised.
		B-4, B-5	"Quick Reference to Page Classified by Address" are partly revised.
		2,3	Table 1.2.1 and Table 1.2.2 is partly revised.
		6,7	Table 1.4.1 to 1.4.3 is partly revised.
		14	Not e2 in Figure 3.1 is added.
		15 to 20	Figure 4.1 to Figure 4.6 are revised.
		21, 22, 25	Figure 4.7, Figure 4.8 and Figure 4.11 are partly revised.
		29	Section "5.5 Voltage Detection Circuit" is partly revised.
		33	Figure 5.5.1.1.2.1 is partly revised.
		34	Figure 6.2 is partly revised.
		40	The PM2 register in Figure 7.6 is partly revised.
		64	Figure 9.3.1 is partly revised.
		65	The IFSR2A register in Figure 9.3.2 is partly revised.
		112	Figure 12.2.4.2 is partly revised.
		119	Figure 12.3.6 is partly revised.
		126	Section "12.3.2 Three-phase/Port Output Switch Function" is revised. Figure
			"12.3.2.1. Usage Example of Three-phse/Port output switch function" is added.
		130	Figure 13.2 is partly revised.
		134 137	Figure 13.6 is partly revised. Figure 13.10 is partly revised.
		162	"UARTi receive buffer register" in Figure 14.1.4 is partly revised.
		170	Table 14.1.1.2 is partly revised.
		177 184	Table 14.1.2.2 is partly revised.
		214	Figure 14.1.3.1 is partly revised. Figure 15.5 is partly revised.
		230, 231	
		233	Figure 15.1.7.5 is partly revised.
		235	Section "15.1.8 Delayed Trigger Mode 1" is partly revised.
		236, 237	Figure 15.1.8.2 and Figure 15.1.8.3 are partly revised.
		240	Section "15.3 Sample and Hold" and Figure 15.5.1 are partly revised.
		244	Figure 16.2 is partly revised.
		321	Table 20.4 and Table 20.5 are partly revised.
		342	Table 20.43 and Table 20.44 are partly revised.

Summary evised. Mode" is partly revised. e 1.2.2 are partly revised. 1.4.3 are partly revised. revised. ure 1.5.2 are partly revised. evised. evised. revised.
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eviseu.
are Reset 2" is partly revised.
Detection Circuit" is revised.
art / Warm start" is added.
evised.
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e 20.7 are partly revised.
evised.
s partly revised.
revised.
s partly revised.
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on Circuit Electrical Characteristics" is deleted.
revised.
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s partly revised.
revised.
s partly revised.
revised.
(on-chip oscillator, A/D)
e 1.2.2 are partly revised.
and figure1.4.2 to 1.4.6 are added.
et 2" is partly revised.
Detection Reset" is partly revised.
vised.
s partly revised. b7 to b4 bit in Figure 7.4 is revised.
vised.
Figure 7.6 is partly revised.
tion Mode" is partly revised.
.1 is partly revised.
and Re-oscillation Detect Function" is partly revised.

Rev.	Date		Description
		Page	Summary
		66	"9.3 Interrupt Control" is partly revised.
		76	"9.6 INT Interrupt" and "9.7 NMI Interrupt" are partly revised.
		77	"9.8 Key Input Interrupt" and "9.9 CAN0 Wake-up Interrupt" are partly revised.
		80	"10. Watchdog Timer" is partly revised.
		80, 81	"10.1 Count source protective mode" is partly revised.
		81	Note 2 in Figure 10.2 is revised.
		118	Figure 12.3.1 is partly revised.
		121	"Three-phase output buffer register" in Figure 12.3.4 is partly revised.
		133 to 138	Figure 13.1 to 13.6 are partly revised.
		141	"Function enable register" in Figure 13.9 is partly revised.
		150	Table 13.4.1 is partly revised.
		161	"13.6 I/O Port Function Select" is partly revised.
		198	Figure 14.1.4.1 is partly revised.
		209	Figure 14.2.1 is partly revised.
		210	Figure 14.2.2 is partly revised.
		214	"Integral Nonlinearity Error" in Table 15.1 is partly revised.
		253,254	Figure 16.6 and Figure 16.7 are partly revised.
		261	"16.5.4 Bit 3: Arbitration lost detection flag" is partly revised.
		266	"16.6.5 I2C system clock select bits" and Talbe 16.6 are partly revised.
		275	"9)" in "16.13.2 Example of Slave Receive" is revised.
		296	"17.3 Configuration of the CAN Module System Clock" is partly revised.
		306	"18.1 CRC snoop" is partly revised.
		337	Table 20.25 is partly revised.
		368	"21.1 Flash Memory Performance" is partly revised.
		367,368	"21.2 Memory Map" is partly revised.
		372	"21.4 CPU Rewrite Mode" is partly revised.
		373	"21.4.1 EW0 Mode" and "21.4.2 EW1 Mode" are partly revised.
		374	"FMR01 Bit" is partly revised.
		375	"FMR17 Bit" is partly revised.
		383	"21.7.4 Program Command (4016)" is partly revised.
		390	Table 21.9.1 and Note 2 are partly revised.
		391,392	Figure 21.9.1 and Figure 21.9.2 are partly revised.
		393,394	Figure 21.9.2.1 and Figure 21.9.2.2 are partly revised.
		396	Table 21.11.1 and Note 1 are partly revised.
		397,398	Figure 21.11.1 and Figure 21.11.2 are partly revised.
		399	Figure 21.11.3 is partly revised.
1.10	10/10/06	All Pages	Package code changed: 80P6Q-A to PLQP0080KB-A, 64P6Q-A to PLQP0064KB-A
			Words standardized: Low voltage detection, CPU clock, MCU, SDA2, SCL2

Rev.	Date		Description
		Page	Summary
			Overview
		2	• Table 1.1 and 1.2 Performance Outline Voltage detection circuit are modified,
			note 3 is modified
		4 - 5	• Figure 1.1 and 1.2 Block Diagrams are updated
		6 - 7	Table 1.3 to 1.5 Product Lists are updated
		8	Figure 1.3 Produt Numbering System is modified
		9	Tables 1.6 to 1.8 Product Code B3, B7, D3, D5, D7, D9 are deleted
			Tables 1.9 to 1.11 Product Code Mask ROM versions are newly added
		13 - 17	Table 1.9 and 1.10 Pin Characteristics for 80-, and 64-pin Packages are added
		18	Table 1.11 Pin Description Tables are modified
			Memory
		23	Figure 3.1 Memory Map 48Kbyte memory size is deleted
			Special Function Register
		24 - 34	Table 4.1 to 4.11 SFR Information values after reset
		24	Table 4.1 SFR Information(1) Note 3 is deleted
			Reset
		35	• 5.1.2 Hardware Reset 2 Note is modified, description is modified
		38	• 5.5 Voltage Dection Circuit modified
			• Figure 5.4 Voltage Detection Circuit Block modified, WDC5 bit circuit deleted
			Processor Mode
		44	• Figure 6.1 PM1 Register Note 2 information partially added
		45	• Figure 6.2 PM2 Register added
		46	• Figure 6.3 Bus Block Diagram and Table 6.1 Accessible Area and Bus
			Cycle added
			Clock Generation Circuit
		47	Table 7.1 Clock Generation Circuit Specifications Oscillation stop, restart
			function modified
		48	• Figure 7.1 Clock Generation Circuit Upper portion of figure is modified
		50	Figure 7.4 ROCR Register Bit conents are modified
		52	• Figure 7.6 PCLKR Register and PM2 Register Note 2 is modified
		54	Figure 7.8 Examples of Main Clock Connection Circuit is modified
		55	• Figure 7.9 Examples of Sub Clock Connection Circuit is modified
			• 7.5.2 Peripheral Function Clock (f1, f2, f8, f32, f1SIO, f2SIO, f8SIO, f32SIO,
			fAD, fC32, fCAN0) revised
		59	• 7.6.1 Normal Operation Mode Information is modified
		60	• Table 7.4 Setting Clock Related Bit and Modes Multi-master I2C bus interrupt
			and Timer S interrupt added
		61	Table 7.5 Pin Status in Wait Mode newly added
			Table 7.6 Interrupts to Exit Wait Mode modified

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		63	• Figure 7.11 State Transition to Stop Mode and Wait Mode modified, Note 7 is added
		64	• Figure 7.12 State Transition in Normal Mode modified, note 5 deleted, note 6
			and 7 are simplified
		65	Table 7.7 Allowed Transition and Setting note 2 partially modified, table con
			tents are partially modified
		68	Figure 7.13 Procedure to Switch Clock Source From On-chip Oscillator
			Clock to Main Clock is modified
			Interrupt
		70	Note is newly added
		73	Table 9.1 Fixed Vector Tables Note 2 is added
			Watchdog Timer
		89	Additional information of the WDTS register is inserted
		90	Figure 10.1 Watchdog Timer Block Diagram modified
			Figure 10.2 WDC Register and WDTS Register All notes are deleted
		-	• 10.2 Cold Start/Warm Start Section is deleted
			DMAC
		96	Note is added
			Timer
		105	• Figure 12.6 TRGSR Register Note 2 added
		117	• 12.2 Timer B Description of A/D trigger mode modified
			Figure 12.15 Timer B Block Diagram "A/D trigger mode" is added
		123	• 12.2.4 A/D Trigger Mode Description modified
		129	• Figure 12.28 IDB0 Register, IDB1 Register, DTT Register, and ICTB2 Regis-
			ter Information of bit 7 and 6 modified
		131	Figure 12.30 TB2SC Register Note 4 added, contents modified
		133	• Figure 12.32 TA1MR Register, TA2MR Register, TA4MR Register MR0 bit is
			modified
		134	• Figure 12.33 Triangular Wave Modulation Operation Description modified
		135	• Figure 12.34 Sawtooth Wave Modulation Operation Description modified
		139	• Figure 12.38 TPRC Register Bit map is modified
			Timer S
		142	• Figure 13.2 G1BT and G1BCR0 Registers Function of G1BT register modified,
			note 3 is added, function of bits 5 to 3 modified, description patially modified
		143	• Figure 13.3 G1BCR1 Register Note 1 is partially added
		146	• Figure 13.6 G1TM0 to G1TM7 Registers Note 3 and 4 are added
		151-166	• Table 13.2, 13.5, 13,8, 13.9 and 13.10 Output wave form and Selectable func-
			tion are modified
		155	Figure 13.15 Base Timer Reset Operation by Base Timer Reset Register
			Base timer overflow request line is added, base timer interrupt line is modified,

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			note 1 is added
		160	• Figure 13.21 Prescaler Function and Gate Function Note 1 modified
		166	Table 13.10 SR Waveform Output Mode Specifications Specification modified
		167	• Figure 13.24 Set/Reset Waveform Output Mode Description for (1) Free-run-
			ning operation modified, register names modified
		168	Table 13.11 Pin Setting for Time Measurement and Waveform Generating
			Functions Description of port direction modified
			Serial I/O
		170	Note is modified
		171	• Figure 14.1 Block Diagram of UARTi (i = 0 to 2) PLL clock is added to the
			upper portion of diagram
		174	• Figure 14.4 U0TB to U2TB, U0RB to U2RB, U0BRG to U2BRG Registers
			Note 2 is modified, note 3 is newly added
		175	• Figure 14.5 U0MR Register, U1MR Register Bit map is modified
		176	• Figure 14.6 U0C0 Register Note 3 modified, Note 4 to 7 are added
			• Figure 14.6 U2C0 Register Note 2 is added
		177	• Figure 14.7 PACR Register added
		180	• Table 14.1 Clock Synchronous Serial I/O Mode Specifications Select func-
			tion modified, note 2 modified
		182	Table 14.3 Pin Functions Note 1 added
			Table 14.4 P64 Pin Functions Note 1 added
		183	• Figure 14.10 Typical transmit/receive timings in clock synchronous serial I/
			O mode Example of receive timing: figure modified
		184	• 14.1.1.1 Counter Measre for Communication Error Occurs newly added
		185	• 14.1.1.2 CLK Polarity Select Function Newly added
		186	• Figure 14.14 Transfer Clock Output From Multiple Pins Note 2 added
		187	• 14.1.1.7 CTS/RTS separate function (UART0) modified
			• Figure 14.15 CTS/RTS Separate Function Usage Note 1 added
		188	• Table 14.5 UART Mode Specifications Select function modified, note 1 modi-
		400	fied
		190	• Table 14.7 I/O Pin Functions in UART Mode Note 1 added
		400	• Table 14.8 P64 Pin Functions in UART Mode Note 2 added
		192	• Figure 14.17 Receive Operation RTSi line is modified
			• 14.1.2.1 Bit Rates newly added
		100	• Table 14.9 Example of Bit Rates and Settings newly added
		193	• 14.1.2.2 Counter Measure for Communication Error newly added
		195	• 14.1.2.6 CTS/RTS Separate Function (UART0) P70 pin is added
		106	• Figure 14.21 CTS/RTS Separate Function Note 1 added
		196	• Table 14.10 I ² C mode Specifications Note 2 modified

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		214	• Figure 14.31 Transmit and Received Timing in SIM Mode partially modified
		217	• 14.2 SI/O3 and SI/O4 Note added
		218	• Figure 14.36 S3C and S4C Registers Note 5 is added
			• Figure 14.36 S3BRG and S4BRG Registers Note 3 is added
		220	Figure 14.38 Polarity of Transfer Clock figure modified
		221	• 14.2.3 Functions for Setting an SOUTi Initial Value Description modified
			A/D Converter
		222	Note added
			Table 15.1 A/D Converter Performance Integral Nonlinearity Error modified
		224	• Figure 15.2 ADCON2 Registers b2-b1 function modified
		227	• Figure 15.5 TB2SC Register Reserved bit map modified
		229	• Figure 15.7 ADCON0 to ADCON2 Registers in One-shot Mode ADCON2
			register: b2-b1 function modified
		231	• Figure 15.9 ADCON0 to ADCON2 Registers in Repeat Mode ADCON2 regis-
			ter: b2-b1 function modified
		233	• Figure 15.11 ADCON0 to ADCON2 Registers in Single Sweep Mode
			ADCON2 register: b2-b1 function modified
		235	• Figure 15.13 ADCON0 to ADCON2 Registers in Repeat Sweep Mode 0
			ADCON2 register: b2-b1 function modified
		237	• Figure 15.15 ADCON0 to ADCON2 Registers in Repeat Sweep Mode 1
			ADCON2 register: b2-b1 function modified
		239	• Figure 15.17 ADCON0 to ADCON2 Registers in Simultaneous Sample
			Sweep Mode ADCON2 register: b2-b1 function modified
		241	Table 15.10 Delayed Trigger Mode 1 Specifications Note 1 is modified
		245	• Figure 15.22 ADCON0 to ADCON2 Registers in Delayed Trigger Mode 0
			ADCON2 register: b2-b1 function modified
		251	• Figure 15.27 ADCON0 to ADCON2 Registers in Delayed Trigger Mode 1
			ADCON2 register: b2-b1 function modified
		254	• 15.5 Analog Input Pin and External Sensor Equivalent Circuit Example is
			deleted
			• 15.5 Output Impedance of Sensor under A/D Conversion is added
			• Figure 15.29 Analog Input Pin and External Sensor Equivalent Circuit Note
			1 is added
		-	Precaution of Using A/D Converter deleted
			Multi-master I ² C bus INTERFACE
		255	• Table 16.1 Multi-master I ² C bus Interface Functions I/O pin added
		256	• Figure 16.1 Block Diagram of Multi-master I ² C bus Interface Bit name and
			register name are modified
		257	• Figure 16.2 S0D0 Register Bit map is modified

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		258	• Figure 16.3 S00 Register Note is modified
		259	• Figure 16.4 S1D0 Register Reserved bit map modified
		260	• Figure 16.5 S10 Register b7-b6 modified
		262	• Figure 16.7 S4D0 Register Bit reserved map is modified
		269	• 16.5.1 Bit 0: Last Receive Bit (LRB) modified
			• 16.5.2 Bit 1: General call detection flag (ADR0) modified, note 1 modified
			• 16.5.3 Bit 2: Slave address comparison flag (AAS) modified
		270	• 16.5.5 Bit 4: I ² C Bus Interface Interrupt Request Bit (PIN) modified
			• 16.5.6 Bit 5: Bus Busy Flag (BB) Bit names are modified
		271	• 16.5.8 Bit 7: Communication Mode Select bit (MST) modified
		276	• 16.7.1 Bit0: Time-Out Detection Function Enable Bit (TOE) is modified
			• 16.7.5 Bit7: STOP Condition Detection Interrupt Request Bit (SCPIN) is
			modified
		279	• 16.11 Stop Condition Generation Method Description added
		282	• 16.13 Address Data Communication modified
			CAN Module
		292	• Figure 17.6 C0MCTLj Register RspLock bit's name changed, note 2 revised
		293	• Figure 17.7 C0CTLR Register Note 4 added, functions partially modified
		294	• Figure 17.8 C0STR Register Note 1 deleted, functions partially modified
		298	• Figure 17.13 C0RECR Register Note 2 deleted, note 1 partially modified
			• Figure 17.14 C0TECR Register Note 1 modified, note is relocated
		299	• Figure 17.15 C0TSR Register Note 1 modified
		300	• Figure 17.17 Transition Between Operational Modes Partially modified
		301	• 17.2.3 CAN Sleep Mode Partially deleted
		304	Table 17.2 Example of Bit-Rate 24-MHz is deleted
		308	• 17.8 Time Stamp Counter and Time Stamp Function Partially deleted
		310	• Figure 17.25 Timing of Receive Data Frame Sequence IF to IFS
		311	• Figure 17.26 Timing of Transmit Sequence IF to IFS
			CRC Calculation Circuit
		313	•18.1 CRC Snoop Description partially added
			Programmable I/O Ports
		316	Note added
			• 19.3 Pull-up Control Register 0 to 2 Description partially added
		317	• 19.6 Digital Debounce Function Filter width formula modified
		318-321	• Figure 19.1 I/O Ports (1) to Figure 19.4 I/O Ports (4) are modified
		326	• Figure 19.10 PACR Register Note 1 is modified
		327	• Figure 19.11 NDDR and P17DDR Register Functions modified, notes are added
		328	• Figure 19.12 Functioning of Digital Debounce Filter modified, procedure note
			modified

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		329	Table 19.1 Unassigned Pin Handling in Single-chip Mode Note 5 added
			Flash Memory Version
		330	• 20.1 Flash Memory Performance Description partially deleted
			Table 20.14 Flash Memory Version Specifications Note 3 added
		331	• 20.1.1 Boot Mode added
		332	• 20.2 Memory Map Description is modified
		335	• 20.3.1 ROM Code Protect Function Description is modified
		336	• Figure 20.4 ROMCP Address is modified
		337	Table 20.3 EW Mode 0 and EW Mode 1 Note 2 is modified
		339	• 20.5.1 Flash Memory Control Register 0 FMR01 Bit and FMR02 Bit: descrip-
			tion is modified
		340	• 20.5.2 Flash Memory Control Register 1 (FMR1) FMR6 Bit is modified,
			FMR17 Bit is modified
		341	• Figure 20.6 FMR0 and FMR1 Registers FMR0 register: note 3 modified, value
			after reset modified; FMR1 register: note 3 modified, reserved bit map modified
		342	• Figure 20.7 FMR4 Register Note 2 is modified
		345	• 20.6.3 Interrupts EW1 mode modified
			• 20.6.4 How to Access FMR16 bit is added
		346	• 20.6.9 Stop Mode modified
		352	Table 20.7 Errors and FMR0 Register Status Register name modified
		355	Table 20.8 Pin Functions Pin settings are partially modified
			Electrical Characteristics
			• V version is newly added
		366	• Table 21.1 Absolute Maximum Ratings Parameters of Pd and Topr are modi-
			fied
		367	• Table 21.2 Recommended Operating Conditions VIH and VIL are modified
		368	Table 21.3 A/D Conversion Characeristics tSAMP deleted, note 4 added
		369	• Table 21.4 Flash Memory Version Electrical Characteristics: Standard val-
			ues of Program and Erase Endrance cycle modified, tps added
			• Table 21.5 Flash Memory Version Electrical Characteristics: tps added, data
			hold time added, note 1, 3, 8 modified, note 11 and 12 added
		370	• Table 21.6 Low Voltage Detection Circuit Electrical Characteristics Note 4
			added
			• Table 21.7 Power Supply Circuit from Timing CharacteristicsL Note 2 & 3
			are deleted, figure modified
		372	Table 21.9 Electrical Characteristics(2) Note 5 is added
		380	Table 21.25 Electrical Characteristics(2) Note 5 is added
		387	• Table 21.40 Absolute Maximum Ratings Parameters of Pd and Topr are modi-
			fied

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		388	• Table 21.41 Recommended Operating Conditions VIH and VIL are modified
		389	Table 21.42 A/D Conversion Characeristics tSAMP deleted, note 4 added
		390	• Table 21.43 Flash Memory Version Electrical Characteristics: Standard val-
			ues of Program and Erase Endrance cycle modified, tps added
			• Table 21.44 Flash Memory Version Electrical Characteristics: tps added,
			data hold time added, note 1, 3, 8 modified, note 11 and 12 added
		391	• Table 21.45 Power Supply Circuit from Timing CharacteristicsL Note 2 & 3
			are deleted, td(S-R) and td(E-A) are deleted, figure modified
		393	Table 21.47 Electrical Characteristics(2) Note 4 is added
		401	Table 21.63 Electrical Characteristics(2) Note 4 is added
			Precautions
		422	• 22.2.1 PLL Frequency Synthesizer modified
		423	• 22.2.2 Power Control Subsection sequence modified, 2., 3. and 4. information modified
		425	• 22.4.3 NMI Interrupt 2. information partially deleted, 6. information added
		426	• 22.4.5 INT Interrupt 3. information added
		427	• 22.4.6 Rewrite the Interrupt Control Register Example 1 is modified
		431	• 22.6.1.3 Timer A (One-shot Timer Mode) 6. information added
		434	• 22.6.3 Three-phase Motor Control Timer Function newly added
		435	• 22.7.1 Rewrite the G1 IR Register description modified
			• Figure 22.3 IC/OC Interrupt Flow Chart newly added
		436	• 22.7.2 Rewrite the ICOCiIC Register newly added
			• 22.7.3 Waveform Generating Function newly added
			• 22.7.4 IC/OC Base Timer Interrupt newly added
		438	• 22.8.2.1 Special Mode (I ² C bus Mode) added
			• 22.8.2.3 SI/O3, SI/O4 added
		441	• 22.10 Multi-master I ² C bus Interface added
		445	• 22.12 Programmable I/O Ports 2. and 3. information modified
		447	• 20.14 Mask ROM Version is added
		448	• 22.15.1 Functions to Inhibit Rewriting Flash Memory Rewrite modified
			• 22.15.2 Stop Mode modified
			• 22.16.4 Low Power Disspation Mode, On-chip Oscillator Low Power Dissi-
			pation Mode modified
			• 22.15.7 Operating Speed modified
		449	• 22.15.9 Interrupts modified
			• 22.15.13 Regarding Programming/Erasure Times and Execution Time
			modified
		450	• 22.15.14 Definition of Programming/Erasure Times added
			• 22.15.15 Flash Memory version Electrical Characteristics 10,000 E/W cycle

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			products (U7, U9) added
			• 22.15.16 Boot Mode added
		451	• 22.16 Noise added
		452	• 20.17 Instruction fo Device Use added
			Appendix 1. Package Dimensions
		453	Dimensions are updated
		454-455	Appendix 2. Functional Comparison added
1.11	Dec.11,2006		Clock Generation Circuit
		54	• Figure 7.8 Examples of Main Clock Connection Circuit Note 2 added
			Interrupts
		88	Table 9.6 PC Value Saved in Stack Area When Address Match Interrupt
			Request Is Acknowledged Table contents partially modified, note added
			Serial I/O
		198	• Table 14.11 Registers to Be Used and Settings in I ² C bus Mode Note Relo-
			cated
			CAN Module
		297	• Figure 17.12 C0CONR Register Note 2 modified
			Electrical Characteristics
		372	• Table 21.9 Electrical Characteristics (2) Mask ROM data added, value par-
			tially changed: 420 to 450
		379	Table 21.24 Electrical Characteristics Note 1 modified
		380	• Table 21.25 Electrical Characteristics Mask ROM data added, note 1 modified
		391	• Table 21.45 Power Supply Circuit Timing Characteristics figure for td(P-R)
			and td(ROC) added, Mask ROM data added
		393	• Table 21.47 Electrical Characteristics (2) Mask ROM data added, value
			paritally changed
		400	Table 21.62 Electrical Characteristics Note 1 modified
		401	• Table 21.63 Electrical Characteristics Mask ROM data added, note 1 modified
		412	• Table 21.83 Power Supply Circuit Timing Characteristics figure for td(P-R)
			and td(ROC) added, Mask ROM data added
		414	• Table 21.85 Electrical Characteristics (2) Mask ROM data added, value
			paritally changed
			Usage Notes
		-	Table numbers and Figure numbers are revised
		421	• 22.1.3 Register Setting added
		447	• 22.14.1 Internal ROM Area Description added
1.12	Mar.30, 2007		Overview
		1	• 1.1 Features modified
		2, 3	note on trademark modified

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		9	Tables 1.6 to 1.8 Product Codes modified
		19, 20	Table 1.14 Pin Description pin description on I/O ports modified
			Reset
		37	• Figure 5.2 Reset Sequence Vcc and ROC timings modified
			Processor Mode
		45	• Figure 6.2 PM2 Register Description on notes 5 and 6 modified
			Clock Generation Circuit
		52	• Figure 7.6 PM2 Register Description on notes 5 and 6 modified
		64	• Figure 7.12 State Transition in Normal Mode note 2 modified
			Protection
		69	Description on protection modified
			• Figure 8.1 PRCR Register note 1 modified
			Interrupts
		88	Table 9.6 PC Value Saved in Stack Area When Address Match Interrupt
			Request I Acknowledged instruction modified
			Watchdog Timer
		90	• Figure10.2 WDTS Register modified
			• 10.1 Count Source Protective Mode description modified
			Timer
		129	• Figure 12.28 ICTB2 Register modified
			Multi-Master I ² C bus Interface
		256	• Figure 16.1 Block Diagram of Multi-Master I ² C bus Interface modified
			Flash Memory Version
		335	• 20.3.1 ROM Code Protect Function register name modified
		340	• 20.5.2 Flash Memory Control Register 1 description on FMR17 bit modified
		341	• Figure 20.6 FMR1 Register note 2 modified
		343	• Figure 20.9 Setting and Resetting of EW Mode 1 modified
			Electrical Characteristics
		369	• Table 21.5 Flash Memory Version Electrical Characteristics note 10 modi-
			fied
		370	Timing figure for td(P-R) and td(ROC) modified
		372	• Table 21.9 Electrical Characteristics parameter and measurement condition modified, note 5 deleted
		380	, in the second of the second
		300	• Table 21.25 Electrical Characteristics measurement condition modified, note 5 deleted
		390	• Tables 21.43 and 44 Flash Memory Version Electrical Characteristics note
			10 modified
		391	Timing figure for td(P-R) and td(ROC) modified
		393	• Table 21.47 Electrical Characteristics parameter and condition modified, note
		- 550	Table 21117 2199111941 Characteristics parameter and contained, note

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			4 deleted
		401	• Table 21.63 Elctrical Characteristics measurement condition modified, note 4
			deleted
		411	•Tables 21.81 and 21.82 Flash Memory Version Electrical Characteristics
			note 10 modified
		412	•Timing figure for td(P-R) and td(ROC) modified
		414	•Table 21.85 Electrical Characteristics measurment condition modified, note 4
			deleted
			Usage Notes
		439	•Figure 22.4 Use of Capacitors to Reduce Noise note 1 modified
		449	•22.15.10 How to Access description modified
		450	•22.15.15 Flash Memory Version Electrical Characteristics 10,000 E/W Cycle
			Products description modified

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